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Stellaris® LM3S1J11 Microcontroller

DATA SHEET

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Revision History

The revision history table notes changes made between the indicated revisions of the LM3S1J11 data sheet.

Table 1. Revision History

Date	Revision	Description
October 2012	13442.2549	 Marked LM3S1J11 device as not recommended for new designs (NRND). Device is in production to support existing customers, but TI does not recommend using this part in a new design.
		■ Clarified that all GPIO signals are 5-V tolerant when configured as inputs except for PB0 and PB1, which are limited to 3.6 V.
		In the Watchdog Timers chapter, added information on servicing the watchdog timer to the Initialization and Configuration section.
		■ In the General-Purpose Timers chapter, added note to the GPTMTnV registers that in 16-bit mode, only the lower 16-bits of the register can be written with a new value. Writes to the prescaler bits have no effect.
		■ Corrected reset for the UART Raw Interrupt Status (UARTRIS) register.
		In the Electrical Characteristics chapter, added clarifying footnote to the GPIO Module Characteristics table.
		Additional minor data sheet clarifications and corrections.
January 2012	11425	■ In System Control chapter:
		Clarified that an external LDO cannot be used.
		Clarified system clock requirements when the ADC module is in operation.
		 Added important note to write the RCC register before the RCC2 register.
		■ In Hibernation chapter:
		Changed terminology from non-volatile memory to battery-backed memory.
		 Numerous clarifications, including adding a section "System Implementation".
		Clarified Hibernation module register reset conditions.
		■ In Internal Memory chapter, clarified programming and use of the non-volatile registers.
		In GPIO chapter, corrected "GPIO Pins With Non-Zero Reset Values" table and added note that if the same signal is assigned to two different GPIO port pins, the signal is assigned to the port with the lowest letter.
		■ In Timer chapter, clarified timer modes and interrupts.
		■ In ADC chapter, added "ADC Input Equivalency Diagram".
		■ In UART chapter, clarified interrupt behavior.
		In SSI chapter, corrected SSIClk in the figure "Synchronous Serial Frame Format (Single Transfer)" and clarified behavior of transmit bits in interrupt registers.
		■ In I ² C chapter, corrected bit and register reset values for IDLE bit in I ² C Master Control/Status (I2CMCS) register.
		■ In Analog Comparators chapter, clarified internal reference programming.

Table 1. Revision History (continued)

Date	Revision	Description
		■ In Signal Tables chapter, clarified VDDC and LDO pin descriptions.
		■ In Electrical Characteristics chapter:
		 In Maximum Ratings table, deleted parameter "Input voltage for a GPIO configured as an analog input".
		 In Recommended DC Operating Conditions table, corrected values for I_{OH} parameter.
		 In Load Conditions figure, corrected value for C_L parameter.
		 In JTAG Characteristics, table, corrected values for parameters "TCK clock Low time" and "TCK clock High time".
		 In LDO Regulator Characteristics table, added clarifying footnote to C_{LDO} parameter.
		 In System Clock Characteristics with ADC Operation table, added clarifying footnote to F_{sysadc} parameter.
		 In Sleep Modes AC Characteristics table, split parameter "Time to wake from interrupt" into sleep mode and deep-sleep mode parameters.
		 In SSI Characteristics table, corrected value for parameter "SSICIk cycle time".
		Deleted erroneously included Ethernet Controller tables, since this part does not have Ethernet.
		 In Analog Comparator Characteristics table, added parameter "Input voltage range" and corrected values for parameter "Input common mode voltage range".
		 In Analog Comparator Voltage Reference Characteristics table, corrected values for absolute accuracy parameters.
		Deleted table "USB Controller DC Characteristics".
		In Nominal Power Consumption table, added parameter for sleep mode.
		 In Maximum Current Consumption section, changed reference value for MOSC and temperature in tables that follow.
		Deleted table "External VDDC Source Current Specifications".
		Additional minor data sheet clarifications and corrections.

Table 1. Revision History (continued)

Date	Revision	Description
July 2011	9970	■ Corrected "Reset Sources" table.
		■ Added missing PICAL (PIOSC Calibrate) bit to DC4 register.
		■ Added Important Note that RCC register must be written before RCC2 register.
		■ Added a note that all GPIO signals are 5-V tolerant when configured as inputs except for PB0 and PB1, which are limited to 3.6 V.
		■ Note that the state of the HSE bit in the UARTCTL register has no effect on clock generation in ISO 7816 smart card mode (when the SMART bit in the UARTCTL register is set).
		■ Corrected LIN Mode bit names in UART Interrupt Clear (UARTICR) register.
		■ Corrected pin number for RST in table "Connections for Unused Signals" (other pin tables were correct).
		■ In the "Operating Characteristics" chapter:
		In the "Thermal Characteristics" table, the Thermal resistance value was changed.
		$-$ In the "ESD Absolute Maximum Ratings" table, the V_{ESDCDM} parameter was changed and the V_{ESDMM} parameter was deleted.
		■ The "Electrical Characteristics" chapter was reorganized by module. In addition, some of the Recommended DC Operating Conditions, LDO Regulator, Clock, GPIO, Hibernation Module, ADC, and SSI characteristics were finalized.
		■ Added missing ordering table.
		Additional minor data sheet clarifications and corrections.
March 2011	9538	■ Clarified "Reset Control" section in the "System Control" chapter.
		■ Corrected USB PLL speed in "Main Clock Tree" diagram.
		■ Corrected reset value for Run-Mode Clock Configuration (RCC) register.
		Clarified Hibernation module initialization and configuration.
		■ Corrected reset value for DMA Channel Wait-on-Request Status (DMAWAITSTAT) register.
		■ Corrected "GPIO Pins With Non-Zero Reset Values" table.
		■ Clarified that that the timer reload only happens in periodic mode.
		■ Clarified that only bit 0 in the Watchdog Control (WDTCTL) register is protected from writes once set.
		■ Added "Sample Averaging Example" diagram to ADC chapter.
		■ Corrected "SSI Timing for SPI Frame Format" figure.
		■ In "Electrical Characteristics" chapter:
		 Deleted T_{PORMIN} parameter from "Power Characteristics" table, and deleted corresponding diagram.
		 Added t_{ADCSAMP} sample time parameter to "ADC Characteristics" table.
l		■ Additional minor data sheet clarifications and corrections.

Table 1. Revision History (continued)

Date	Revision	Description
January 2011	9161	 Added missing ADC external voltage reference content, including missing ADC Control (ADCCTL) register.
		Clarified Main Oscillator verification circuit sequence.
		Added note that there must be a delay of 3 system clocks after the module clock is enabled before any of that module's registers are accessed.
		Clarified initialization and configuration procedure in "Analog Comparators" chapter.
		■ In Electrical Characteristics chapter:
		 Added specification for maximum input voltage on a non-power pin when the microcontroller is unpowered (V_{NON} parameter in Maximum Ratings table).
		 Replaced Preliminary Current Consumption Specifications with Nominal Power Consumption, Maximum Current Specifications, and Typical Current Consumption vs. Frequency sections.
		 Clarified Reset, and Power and Brown-out Characteristics and added a new specification for powering down before powering back up.
		 Added characteristics required when using an external regulator to provide power for V_{DDC}.
		Additional minor data sheet clarifications and corrections.
December 2010	8832	 Information on Advanced Encryption Standard (AES) cryptography tables and Cyclic Redundancy Check (CRC) error detection functionality was inadvertently omitted from some datasheets. This has been added.
		■ In APINT register, changed bit name from SYSRESETREQ to SYSRESREQ.
		■ Added DEBUG (Debug Priority) bit field to SYSPRI3 register.
		Clarified Flash memory caution.
		Restructured the General-Purpose Timer chapter to combine duplicated text.
		■ Combined High and Low bit fields in GPTMTAILR, GPTMTAMATCHR, GPTMTAR, GPTMTAV, GPTMTBILR, GPTMTAMATCHR, GPTMTBR and GPTMTBV registers for compatibility with future releases.
		■ Removed mention of false-start bit detection in the UART chapter. This feature is not supported.
		■ Changed I ² C master and slave register base addresses and offsets to be relative to I ² C module base, so register base and offsets were changed for all I ² C slave registers.
		■ In Electrical Characteristics chapter:
		 Added single-ended clock source input voltage values to "Recommended DC Operating Conditions" table.
		Deleted Oscillation mode value from "MOSC Oscillator Input Characteristics" table.
		 Added T_{VDD2_3} supply voltage parameter to "Reset Characteristics" table.
		Added "Power-On Reset and Voltage Parameters" timing diagram.
		 Added t_{VDDRISE_HIB} supply voltage parameter to "Hibernation Module AC Characteristics" table.
		 Added "VDD Ramp when Waking from Hibernation" timing diagram.

Table 1. Revision History (continued)

Date	Revision	Description
September 2010	7794	■ Reorganized ARM Cortex-M3 Processor Core, Memory Map and Interrupts chapters, creating two new chapters, The Cortex-M3 Processor and Cortex-M3 Peripherals. Much additional content was added, including all the Cortex-M3 registers.
		■ Changed register names to be consistent with StellarisWare [®] names: the Cortex-M3 Interrupt Control and Status (ICSR) register to the Interrupt Control and State (INTCTRL) register, and the Cortex-M3 Interrupt Set Enable (SETNA) register to the Interrupt 0-31 Set Enable (EN0) register.
		 ■ In the System Control chapter: Corrected Reset Sources table (see Table 5-3 on page 175). Added section "Special Considerations for Reset."
		■ In the Hibernation Module chapter, added section "Special Considerations When Using a 4.194304-MHz Crystal".
		 In the Internal Memory chapter: Added clarification of instruction execution during Flash operations. Deleted ROM Version (RMVER) register as it is not used.
		■ Modified Figure 9-1 on page 394 and Figure 9-2 on page 395 to clarify operation of the GPIO inputs when used as an alternate function.
		■ Corrected GPIOAMSEL bit field in GPIO Analog Mode Select (GPIOAMSEL) register to be eight-bits wide, bits[7:0].
		■ In General-Purpose Timers chapter, clarified operation of the 32-bit RTC mode.
		■ In Operating Characteristics chapter, corrected Thermal resistance (junction to ambient) value to 32.
		 In Electrical Characteristics chapter: Added "Input voltage for a GPIO configured as an analog input" value to Table 20-1 on page 797. Added I_{LKG} parameter (GPIO input leakage current) to Table 20-20 on page 807. Corrected Nom values for I_{HIB_NORTC} and I_{HIB_RTC} in Table 20-28 on page 812. Corrected reset timing in Table 20-5 on page 801. Corrected values for t_{WAKE_TO_HIB} in Table 20-18 on page 806. Specified Max value for V_{REFA} in Table 20-22 on page 809. Corrected values for t_{CLKRF} (SSIC1k rise/fall time) in Table 20-24 on page 809. Added I²C Characteristics table (see Table 20-25 on page 811).
		 Added dimensions for Tray and Tape and Reel shipping mediums.
June 2010	7413	■ In "Thermal Characteristics" table, corrected thermal resistance value from 34 to 32.
June 2010	7299	■ Removed 4.194304-MHz crystal as a source for the system clock and PLL.
		Summarized ROM contents descriptions in the "Internal Memory" chapter and removed various ROM appendices.
		■ Clarified DMA channel terminology: changed name of DMA Channel Alternate Select (DMACHALT) register to DMA Channel Assignment (DMACHASGN) register, changed CHALT bit field to CHASGN, and changed terminology from primary and alternate channels to primary and secondary channels.
		■ In Signal Tables chapter, added table "Connections for Unused Signals."
		■ In "Electrical Characteristics" chapter:
		In "Reset Characteristics" table, corrected Supply voltage (VDD) rise time.
		 Clarified figure "SDRAM Initialization and Load Mode Register Timing".

Table 1. Revision History (continued)

Date	Revision	Description
May 2010	7164	■ Added data sheets for five new Stellaris® Tempest-class parts: LM3S1R26, LM3S1621, LM3S1B21, LM3S9781, and LM3S9B81.
		Additional minor data sheet clarifications and corrections.
May 2010	7101	Added pin table "Possible Pin Assignments for Alternate Functions", which lists the signals based on number of possible pin assignments. This table can be used to plan how to configure the pins for a particular functionality. Additional minor data short clarifications and corrections.
		Additional minor data sheet clarifications and corrections.
March 2010	6983	Extended TBRL bit field in GPTMTBR register.
		Additional minor data sheet clarifications and corrections.
March 2010	6912	■ Renamed the USER_DBG register to the BOOTCFG register in the Internal Memory chapter. Added information on how to use a GPIO pin to force the ROM Boot Loader to execute on reset.
		Added three figures to the ADC chapter on sample phase control.
February 2010	6790	■ Added 108-ball BGA package.
		■ In "System Control" chapter: - Clarified functional description for external reset and brown-out reset. - Clarified Debug Access Port operation after Sleep modes. - Corrected the reset value of the Run-Mode Clock Configuration 2 (RCC2) register.
		■ In "Internal Memory" chapter, clarified wording on Flash memory access errors and added a section on interrupts to the Flash memory description.
		■ Added clarification about timer operating modes and added register descriptions for the GPTM Timer n Prescale Match (GPTMTnPMR) registers.
		■ Clarified register descriptions for GPTM Timer A Value (GPTMTAV) and GPTM Timer B Value (GPTMTBV) registers.
		■ Corrected the reset value of the ADC Sample Sequence Result FIFO n (ADCSSFIFOn) registers.
		■ Added ADC Sample Phase Control (ADCSPC) register at offset 0x24.
		■ Added caution note to the I ² C Master Timer Period (I2CMTPR) register description and changed field width to 7 bits.
		 Made these changes to the Operating Characteristics chapter: Added storage temperature ratings to "Temperature Characteristics" table Added "ESD Absolute Maximum Ratings" table
		■ Made these changes to the Electrical Characteristics chapter: - In "Flash Memory Characteristics" table, corrected Mass erase time - Added sleep and deep-sleep wake-up times ("Sleep Modes AC Characteristics" table) - In "Reset Characteristics" table, corrected units for supply voltage (VDD) rise time - Added table entry for VDD3ON power consumption to Table 20-28 on page 812. ■ Added additional DriverLib functions to appendix.
		· ·

Table 1. Revision History (continued)

Date	Revision	Description
October 2009	6458	■ Released new 1000, 3000, 5000 and 9000 series Stellaris [®] devices.
		■ The IDCODE value was corrected to be 0x4BA0.0477.
		■ Clarified that the NMISET bit in the ICSR register in the NVIC is also a source for NMI.
		Clarified the use of the LDO.
		■ To clarify clock operation, reorganized clocking section, changed the USEFRACT bit to the DIV400 bit and the FRACT bit to the SYSDIV2LSB bit in the RCC2 register, added tables, and rewrote descriptions.
		■ Corrected bit description of the DSDIVORIDE field in the DSLPCLKCFG register.
		■ Removed the DSFLASHCFG register at System Control offset 0x14C as it does not function correctly.
		■ Removed the MAXADC1SPD and MAXADC0SPD fields from the DCGC0 as they have no function in deep-sleep mode.
		■ Corrected address offsets for the Flash Write Buffer (FWBn) registers.
		■ Added Flash Control (FCTL) register at Internal memory offset 0x0F8 to help control frequent power cycling when hibernation is not used.
		■ Changed the name of the EPI channels for clarification: EPI0_TX became EPI0_WFIFO and EPI0_RX became EPI0_NBRFIFO. This change was also made in the DC7 bit descriptions.
		■ Removed the DMACHIS register at DMA module offset 0x504 as it does not function correctly.
		■ Corrected alternate channel assignments for the µDMA controller.
		■ Major improvements to the EPI chapter.
		■ EPISDRAMCFG2 register was deleted as its function is not needed.
		■ Clarified PWM source for ADC triggering
		■ Changed SSI set up and hold times to be expressed in system clocks, not ns.
		■ Updated Electrical Characteristics chapter with latest data. Changes were made to Hibernation, ADC and EPI content.
		Additional minor data sheet clarifications and corrections.

Table 1. Revision History (continued)

Date	Revision	Description
July 2009	5930	■ Corrected values for MAXADC0SPD and MAXADC1SPD bits in DC1, RCGC0, SCGC0, and DCGC0 registers.
		■ Corrected figure "TI Synchronous Serial Frame Format (Single Transfer)".
		■ Changed HIB pin from type TTL to type OD.
		■ Made a number of corrections to the Electrical Characteristics chapter:
		 Deleted V_{BAT} and V_{REFA} parameters from and added footnotes to Recommended DC Operating Conditions table.
		Modified Hibernation Module DC Characteristics table.
		Deleted Nominal and Maximum Current Specifications section.
		 Deleted SDRAM Read Command Timing, SDRAM Write Command Timing, SDRAM Write Burst Timing, SDRAM Precharge Command Timing and SDRAM CAS Latency Timing figures and replaced with SDRAM Read Timing and SDRAM Write Timing figures.
		Modified Host-Bus 8/16 Mode Write Timing figure.
		Modified General-Purpose Mode Read and Write Timing figure.
		Major changes to ADC Characteristics tables, including adding additional tables and diagram.
		Corrected ordering part numbers.
		Additional minor data sheet clarifications and corrections.
June 2009	5779	■ In System Control chapter, clarified power-on reset and external reset pin descriptions in "Reset Sources" section.
		■ Added missing comparator output pin bits to DC3 register; reset value changed as well.
		Clarified explanation of nonvolatile register programming in Internal Memory chapter.
		■ Added explanation of reset value to FMPRE0/1/2/3, FMPPE0/1/2/3, USER_DBG, and USER_REG0 registers.
		■ In Request Type Support table in DMA chapter, corrected general-purpose timer row.
		■ In General-Purpose Timers chapter, clarified DMA operation.
		■ Added table "Preliminary Current Consumption" to Characteristics chapter.
		■ Corrected Nom and Max values in "Hibernation Detailed Current Specifications" table.
		■ Corrected Nom and Max values in EPI Characteristics table.
		■ Added "CSn to output invalid" parameter to EPI table "EPI Host-Bus 8 and Host-Bus 16 Interface Characteristics" and figure "Host-Bus 8/16 Mode Read Timing".
		■ Corrected INL, DNL, OFF and GAIN values in ADC Characteristics table.
		■ Updated ROM DriverLib appendix with RevC0 functions.
		■ Updated part ordering numbers.
		Additional minor data sheet clarifications and corrections.
May 2009	5285	Started tracking revision history.

About This Document

This data sheet provides reference information for the LM3S1J11 microcontroller, describing the functional blocks of the system-on-chip (SoC) device designed around the ARM® Cortex™-M3 core.

Audience

This manual is intended for system software developers, hardware designers, and application developers.

About This Manual

This document is organized into sections that correspond to each major feature.

Related Documents

The following related documents are available on the Stellaris[®] web site at www.ti.com/stellaris:

- Stellaris® Errata
- ARM® Cortex™-M3 Errata
- Cortex™-M3/M4 Instruction Set Technical User's Manual
- Stellaris® Boot Loader User's Guide
- Stellaris® Graphics Library User's Guide
- Stellaris® Peripheral Driver Library User's Guide
- Stellaris® ROM User's Guide

The following related documents are also referenced:

- ARM® Debug Interface V5 Architecture Specification
- ARM® Embedded Trace Macrocell Architecture Specification
- IEEE Standard 1149.1-Test Access Port and Boundary-Scan Architecture

This documentation list was current as of publication date. Please check the web site for additional documentation, including application notes and white papers.

Documentation Conventions

This document uses the conventions shown in Table 2 on page 35.

Table 2. Documentation Conventions

Notation	Meaning
General Register Nota	tion
REGISTER	APB registers are indicated in uppercase bold. For example, PBORCTL is the Power-On and Brown-Out Reset Control register. If a register name contains a lowercase n, it represents more than one register. For example, SRCRn represents any (or all) of the three Software Reset Control registers: SRCR0 , SRCR1 , and SRCR2 .
bit	A single bit in a register.
bit field	Two or more consecutive and related bits.
offset 0xnnn	A hexadecimal increment to a register's address, relative to that module's base address as specified in Table 2-4 on page 73.
Register N	Registers are numbered consecutively throughout the document to aid in referencing them. The register number has no meaning to software.
reserved	Register bits marked <i>reserved</i> are reserved for future use. In most cases, reserved bits are set to 0; however, user software should not rely on the value of a reserved bit. To provide software compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
yy:xx	The range of register bits inclusive from xx to yy. For example, 31:15 means bits 15 through 31 in that register.
Register Bit/Field Types	This value in the register bit diagram indicates whether software running on the controller can change the value of the bit field.
RC	Software can read this field. The bit or field is cleared by hardware after reading the bit/field.
RO	Software can read this field. Always write the chip reset value.
R/W	Software can read or write this field.
R/WC	Software can read or write this field. Writing to it with any value clears the register.
R/W1C	Software can read or write this field. A write of a 0 to a W1C bit does not affect the bit value in the register. A write of a 1 clears the value of the bit in the register; the remaining bits remain unchanged.
	This register type is primarily used for clearing interrupt status bits where the read operation provides the interrupt status and the write of the read value clears only the interrupts being reported at the time the register was read.
R/W1S	Software can read or write a 1 to this field. A write of a 0 to a R/W1S bit does not affect the bit value in the register.
W1C	Software can write this field. A write of a 0 to a W1C bit does not affect the bit value in the register. A write of a 1 clears the value of the bit in the register; the remaining bits remain unchanged. A read of the register returns no meaningful data.
	This register is typically used to clear the corresponding bit in an interrupt register.
WO	Only a write by software is valid; a read of the register returns no meaningful data.
Register Bit/Field Reset Value	This value in the register bit diagram shows the bit/field value after any reset, unless noted.
0	Bit cleared to 0 on chip reset.
1	Bit set to 1 on chip reset.
-	Nondeterministic.
Pin/Signal Notation	
[]	Pin alternate function; a pin defaults to the signal without the brackets.
pin	Refers to the physical connection on the package.
signal	Refers to the electrical signal encoding of a pin.

Table 2. Documentation Conventions (continued)

Notation	Meaning
assert a signal	Change the value of the signal from the logically False state to the logically True state. For active High signals, the asserted signal value is 1 (High); for active Low signals, the asserted signal value is 0 (Low). The active polarity (High or Low) is defined by the signal name (see SIGNAL and SIGNAL below).
deassert a signal	Change the value of the signal from the logically True state to the logically False state.
SIGNAL	Signal names are in uppercase and in the Courier font. An overbar on a signal name indicates that it is active Low. To assert SIGNAL is to drive it Low; to deassert SIGNAL is to drive it High.
SIGNAL	Signal names are in uppercase and in the Courier font. An active High signal has no overbar. To assert Signal is to drive it High; to deassert Signal is to drive it Low.
Numbers	
Х	An uppercase X indicates any of several values is allowed, where X can be any legal pattern. For example, a binary value of 0X00 can be either 0100 or 0000, a hex value of 0xX is 0x0 or 0x1, and so on.
0x	Hexadecimal numbers have a prefix of 0x. For example, 0x00FF is the hexadecimal number FF.
	All other numbers within register tables are assumed to be binary. Within conceptual information, binary numbers are indicated with a b suffix, for example, 1011b, and decimal numbers are written without a prefix or suffix.

1 Architectural Overview

Texas Instruments is the industry leader in bringing 32-bit capabilities and the full benefits of ARM[®] Cortex[™]-M-based microcontrollers to the broadest reach of the microcontroller market. For current users of 8- and 16-bit MCUs, Stellaris[®] with Cortex-M offers a direct path to the strongest ecosystem of development tools, software and knowledge in the industry. Designers who migrate to Stellaris benefit from great tools, small code footprint and outstanding performance. Even more important, designers can enter the ARM ecosystem with full confidence in a compatible roadmap from \$1 to 1 GHz. For users of current 32-bit MCUs, the Stellaris family offers the industry's first implementation of Cortex-M3 and the Thumb-2 instruction set. With blazingly-fast responsiveness, Thumb-2 technology combines both 16-bit and 32-bit instructions to deliver the best balance of code density and performance. Thumb-2 uses 26 percent less memory than pure 32-bit code to reduce system cost while delivering 25 percent better performance. The Texas Instruments Stellaris family of microcontrollers—the first ARM Cortex-M3 based controllers— brings high-performance 32-bit computing to cost-sensitive embedded microcontroller applications.

1.1 Overview

The Stellaris LM3S1J11 microcontroller combines complex integration and high performance with the following feature highlights:

- ARM Cortex-M3 Processor Core
- High Performance: 50-MHz operation; 60 DMIPS performance
- 128 KB single-cycle Flash memory
- 20 KB single-cycle SRAM
- Internal ROM loaded with StellarisWare[®] software
- Advanced Communication Interfaces: UART, SSI, I2C
- System Integration: general-purpose timers, watchdog timers, DMA, general-purpose I/Os
- Analog support: analog and digital comparators, Analog-to-Digital Converters (ADC), on-chip voltage regulator
- JTAG and ARM Serial Wire Debug (SWD)
- 100-pin LQFP package
- 108-ball BGA package
- Industrial (-40°C to 85°C) temperature range

Figure 1-1 on page 38 depicts the features on the Stellaris LM3S1J11 microcontroller. Note that there are two on-chip buses that connect the core to the peripherals. The Advanced Peripheral Bus (APB) bus is the legacy bus. The Advanced High-Performance Bus (AHB) bus provides better back-to-back access performance than the APB bus.

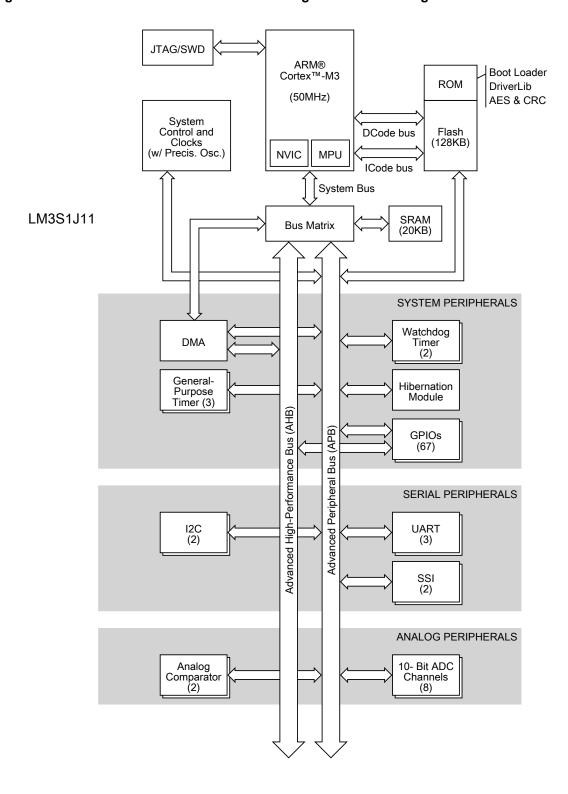


Figure 1-1. Stellaris LM3S1J11 Microcontroller High-Level Block Diagram

For applications requiring extreme conservation of power, the LM3S1J11 microcontroller features a battery-backed Hibernation module to efficiently power down the LM3S1J11 to a low-power state during extended periods of inactivity. With a power-up/power-down sequencer, a continuous time counter (RTC), a pair of match registers, an APB interface to the system bus, and dedicated battery-backed memory, the Hibernation module positions the LM3S1J11 microcontroller perfectly for battery applications.

In addition, the LM3S1J11 microcontroller offers the advantages of ARM's widely available development tools, System-on-Chip (SoC) infrastructure IP applications, and a large user community. Additionally, the microcontroller uses ARM's Thumb®-compatible Thumb-2 instruction set to reduce memory requirements and, thereby, cost. Finally, the LM3S1J11 microcontroller is code-compatible to all members of the extensive Stellaris family; providing flexibility to fit precise needs.

Texas Instruments offers a complete solution to get to market quickly, with evaluation and development boards, white papers and application notes, an easy-to-use peripheral driver library, and a strong support, sales, and distributor network.

1.2 Target Applications

The Stellaris family is positioned for cost-conscious applications requiring significant control processing and connectivity capabilities such as:

- Gaming equipment
- Home and commercial site monitoring and control
- Motion control
- Medical instrumentation
- Test and measurement equipment
- Factory automation
- Fire and security
- Lighting control
- Transportation

1.3 Features

The LM3S1J11 microcontroller component features and general function are discussed in more detail in the following section.

1.3.1 ARM Cortex-M3 Processor Core

All members of the Stellaris product family, including the LM3S1J11 microcontroller, are designed around an ARM Cortex-M3 processor core. The ARM Cortex-M3 processor provides the core for a high-performance, low-cost platform that meets the needs of minimal memory implementation, reduced pin count, and low power consumption, while delivering outstanding computational performance and exceptional system response to interrupts.

1.3.1.1 Processor Core (see page 54)

- 32-bit ARM Cortex-M3 architecture optimized for small-footprint embedded applications
- 50-MHz operation; 60 DMIPS performance
- Outstanding processing performance combined with fast interrupt handling

- Thumb-2 mixed 16-/32-bit instruction set delivers the high performance expected of a 32-bit ARM core in a compact memory size usually associated with 8- and 16-bit devices, typically in the range of a few kilobytes of memory for microcontroller-class applications
 - Single-cycle multiply instruction and hardware divide
 - Atomic bit manipulation (bit-banding), delivering maximum memory utilization and streamlined peripheral control
 - Unaligned data access, enabling data to be efficiently packed into memory
- Fast code execution permits slower processor clock or increases sleep mode time
- Harvard architecture characterized by separate buses for instruction and data
- Efficient processor core, system and memories
- Hardware division and fast digital-signal-processing orientated multiply accumulate
- Saturating arithmetic for signal processing
- Deterministic, high-performance interrupt handling for time-critical applications
- Memory protection unit (MPU) to provide a privileged mode for protected operating system functionality
- Enhanced system debug with extensive breakpoint and trace capabilities
- Serial Wire Debug and Serial Wire Trace reduce the number of pins required for debugging and tracing
- Migration from the ARM7 processor family for better performance and power efficiency
- Optimized for single-cycle Flash memory usage
- Ultra-low power consumption with integrated sleep modes

1.3.1.2 System Timer (SysTick) (see page 96)

ARM Cortex-M3 includes an integrated system timer, SysTick. SysTick provides a simple, 24-bit, clear-on-write, decrementing, wrap-on-zero counter with a flexible control mechanism. The counter can be used in several different ways, for example:

- An RTOS tick timer that fires at a programmable rate (for example, 100 Hz) and invokes a SysTick routine
- A high-speed alarm timer using the system clock
- A variable rate alarm or signal timer—the duration is range-dependent on the reference clock used and the dynamic range of the counter
- A simple counter used to measure time to completion and time used
- An internal clock-source control based on missing/meeting durations.

1.3.1.3 Nested Vectored Interrupt Controller (NVIC) (see page 97)

The LM3S1J11 controller includes the ARM Nested Vectored Interrupt Controller (NVIC). The NVIC and Cortex-M3 prioritize and handle all exceptions in Handler Mode. The processor state is automatically stored to the stack on an exception and automatically restored from the stack at the end of the Interrupt Service Routine (ISR). The interrupt vector is fetched in parallel to the state saving, enabling efficient interrupt entry. The processor supports tail-chaining, meaning that back-to-back interrupts can be performed without the overhead of state saving and restoration. Software can set eight priority levels on 7 exceptions (system handlers) and 34 interrupts.

- Deterministic, fast interrupt processing: always 12 cycles, or just 6 cycles with tail-chaining
- External non-maskable interrupt signal (NMI) available for immediate execution of NMI handler for safety critical applications
- Dynamically reprioritizable interrupts
- Exceptional interrupt handling via hardware implementation of required register manipulations

1.3.1.4 System Control Block (SCB) (see page 99)

The SCB provides system implementation information and system control, including configuration, control, and reporting of system exceptions.

1.3.1.5 Memory Protection Unit (MPU) (see page 99)

The MPU supports the standard ARM7 Protected Memory System Architecture (PMSA) model. The MPU provides full support for protection regions, overlapping protection regions, access permissions, and exporting memory attributes to the system.

1.3.2 On-Chip Memory

The LM3S1J11 microcontroller is integrated with the following set of on-chip memory and features:

- 20 KB single-cycle SRAM
- 128 KB single-cycle Flash memory
- Internal ROM loaded with StellarisWare software:
 - Stellaris Peripheral Driver Library
 - Stellaris Boot Loader
 - Advanced Encryption Standard (AES) cryptography tables
 - Cyclic Redundancy Check (CRC) error detection functionality

1.3.2.1 SRAM (see page 295)

The LM3S1J11 microcontroller provides 20 KB of single-cycle on-chip SRAM. The internal SRAM of the Stellaris devices is located at offset 0x2000.0000 of the device memory map.

Because read-modify-write (RMW) operations are very time consuming, ARM has introduced *bit-banding* technology in the Cortex-M3 processor. With a bit-band-enabled processor, certain regions in the memory map (SRAM and peripheral space) can use address aliases to access individual bits in a single, atomic operation.

Data can be transferred to and from the SRAM using the Micro Direct Memory Access Controller (μDMA) .

1.3.2.2 Flash Memory (see page 297)

The LM3S1J11 microcontroller provides 128 KB of single-cycle on-chip Flash memory. The Flash memory is organized as a set of 1-KB blocks that can be individually erased. Erasing a block causes the entire contents of the block to be reset to all 1s. These blocks are paired into a set of 2-KB blocks that can be individually protected. The blocks can be marked as read-only or execute-only, providing different levels of code protection. Read-only blocks cannot be erased or programmed, protecting the contents of those blocks from being modified. Execute-only blocks cannot be erased or programmed, and can only be read by the controller instruction fetch mechanism, protecting the contents of those blocks from being read by either the controller or by a debugger.

1.3.2.3 ROM (see page 295)

The LM3S1J11 ROM is preprogrammed with the following software and programs:

- Stellaris Peripheral Driver Library
- Stellaris Boot Loader
- Advanced Encryption Standard (AES) cryptography tables
- Cyclic Redundancy Check (CRC) error-detection functionality

The Stellaris Peripheral Driver Library is a royalty-free software library for controlling on-chip peripherals with a boot-loader capability. The library performs both peripheral initialization and control functions, with a choice of polled or interrupt-driven peripheral support. In addition, the library is designed to take full advantage of the stellar interrupt performance of the ARM Cortex-M3 core. No special pragmas or custom assembly code prologue/epilogue functions are required. For applications that require in-field programmability, the royalty-free Stellaris Boot Loader can act as an application loader and support in-field firmware updates.

The Advanced Encryption Standard (AES) is a publicly defined encryption standard used by the U.S. Government. AES is a strong encryption method with reasonable performance and size. In addition, it is fast in both hardware and software, is fairly easy to implement, and requires little memory. The Texas Instruments encryption package is available with full source code, and is based on lesser general public license (LGPL) source. An LGPL means that the code can be used within an application without any copyleft implications for the application (the code does not automatically become open source). Modifications to the package source, however, must be open source.

CRC (Cyclic Redundancy Check) is a technique to validate a span of data has the same contents as when previously checked. This technique can be used to validate correct receipt of messages (nothing lost or modified in transit), to validate data after decompression, to validate that Flash memory contents have not been changed, and for other cases where the data needs to be validated. A CRC is preferred over a simple checksum (e.g. XOR all bits) because it catches changes more readily.

1.3.3 Serial Communications Peripherals

The LM3S1J11 controller supports both asynchronous and synchronous serial communications with:

- Three UARTs with IrDA and ISO 7816 support (one UART with modem flow control and status)
- Two I²C modules
- Two Synchronous Serial Interface modules (SSI)

The following sections provide more detail on each of these communications functions.

1.3.3.1 **UART** (see page 589)

A Universal Asynchronous Receiver/Transmitter (UART) is an integrated circuit used for RS-232C serial communications, containing a transmitter (parallel-to-serial converter) and a receiver (serial-to-parallel converter), each clocked separately.

The LM3S1J11 microcontroller includes three fully programmable 16C550-type UARTs. Although the functionality is similar to a 16C550 UART, this UART design is not register compatible. The UART can generate individually masked interrupts from the Rx, Tx, modem flow control, modem status, and error conditions. The module generates a single combined interrupt when any of the interrupts are asserted and are unmasked.

The three UARTs have the following features:

- Programmable baud-rate generator allowing speeds up to 3.125 Mbps for regular speed (divide by 16) and 6.25 Mbps for high speed (divide by 8)
- Separate 16x8 transmit (TX) and receive (RX) FIFOs to reduce CPU interrupt service loading
- Programmable FIFO length, including 1-byte deep operation providing conventional double-buffered interface
- FIFO trigger levels of 1/8, 1/4, 1/2, 3/4, and 7/8
- Standard asynchronous communication bits for start, stop, and parity
- Line-break generation and detection
- Fully programmable serial interface characteristics
 - 5, 6, 7, or 8 data bits
 - Even, odd, stick, or no-parity bit generation/detection
 - 1 or 2 stop bit generation
- IrDA serial-IR (SIR) encoder/decoder providing
 - Programmable use of IrDA Serial Infrared (SIR) or UART input/output
 - Support of IrDA SIR encoder/decoder functions for data rates up to 115.2 Kbps half-duplex
 - Support of normal 3/16 and low-power (1.41-2.23 µs) bit durations
 - Programmable internal clock generator enabling division of reference clock by 1 to 256 for low-power mode bit duration
- Support for communication with ISO 7816 smart cards
- Full modem handshake support (on UART1)
- LIN protocol support
- Standard FIFO-level and End-of-Transmission interrupts

- Efficient transfers using Micro Direct Memory Access Controller (μDMA)
 - Separate channels for transmit and receive
 - Receive single request asserted when data is in the FIFO; burst request asserted at programmed FIFO level
 - Transmit single request asserted when there is space in the FIFO; burst request asserted at programmed FIFO level

1.3.3.2 I^2C (see page 695)

The Inter-Integrated Circuit (I^2C) bus provides bi-directional data transfer through a two-wire design (a serial data line SDA and a serial clock line SCL). The I^2C bus interfaces to external I^2C devices such as serial memory (RAMs and ROMs), networking devices, LCDs, tone generators, and so on. The I^2C bus may also be used for system testing and diagnostic purposes in product development and manufacture.

Each device on the I²C bus can be designated as either a master or a slave. Each I²C module supports both sending and receiving data as either a master or a slave and can operate simultaneously as both a master and a slave. Both the I²C master and slave can generate interrupts.

The LM3S1J11 microcontroller includes two I²C modules with the following features:

- Devices on the I²C bus can be designated as either a master or a slave
 - Supports both transmitting and receiving data as either a master or a slave
 - Supports simultaneous master and slave operation
- Four I²C modes
 - Master transmit
 - Master receive
 - Slave transmit
 - Slave receive
- Two transmission speeds: Standard (100 Kbps) and Fast (400 Kbps)
- Master and slave interrupt generation
 - Master generates interrupts when a transmit or receive operation completes (or aborts due to an error)
 - Slave generates interrupts when data has been transferred or requested by a master or when a START or STOP condition is detected
- Master with arbitration and clock synchronization, multimaster support, and 7-bit addressing mode

1.3.3.3 SSI (see page 653)

Synchronous Serial Interface (SSI) is a four-wire bi-directional communications interface that converts data between parallel and serial. The SSI module performs serial-to-parallel conversion on data

received from a peripheral device, and parallel-to-serial conversion on data transmitted to a peripheral device. The SSI module can be configured as either a master or slave device. As a slave device, the SSI module can also be configured to disable its output, which allows a master device to be coupled with multiple slave devices. The TX and RX paths are buffered with separate internal FIFOs.

The SSI module also includes a programmable bit rate clock divider and prescaler to generate the output serial clock derived from the SSI module's input clock. Bit rates are generated based on the input clock and the maximum bit rate is determined by the connected peripheral.

The LM3S1J11 microcontroller includes two SSI modules with the following features:

- Programmable interface operation for Freescale SPI, MICROWIRE, or Texas Instruments synchronous serial interfaces
- Master or slave operation
- Programmable clock bit rate and prescaler
- Separate transmit and receive FIFOs, each 16 bits wide and 8 locations deep
- Programmable data frame size from 4 to 16 bits
- Internal loopback test mode for diagnostic/debug testing
- Standard FIFO-based interrupts and End-of-Transmission interrupt
- Efficient transfers using Micro Direct Memory Access Controller (µDMA)
 - Separate channels for transmit and receive
 - Receive single request asserted when data is in the FIFO; burst request asserted when FIFO contains 4 entries
 - Transmit single request asserted when there is space in the FIFO; burst request asserted when FIFO contains 4 entries

1.3.4 System Integration

The LM3S1J11 microcontroller provides a variety of standard system functions integrated into the device, including:

- Direct Memory Access Controller (DMA)
- System control and clocks including on-chip precision 16-MHz oscillator
- Three 32-bit timers (up to six 16-bit)
- Six Capture Compare PWM (CCP) pins
- Lower-power battery-backed Hibernation module
- Real-Time Clock in Hibernation module
- Two Watchdog Timers
 - One timer runs off the main oscillator
 - One timer runs off the precision internal oscillator

- Up to 67 GPIOs, depending on configuration
 - Highly flexible pin muxing allows use as GPIO or one of several peripheral functions
 - Independently configurable to 2, 4 or 8 mA drive capability
 - Up to 4 GPIOs can have 18 mA drive capability

The following sections provide more detail on each of these functions.

1.3.4.1 Direct Memory Access (see page 331)

The LM3S1J11 microcontroller includes a Direct Memory Access (DMA) controller, known as micro-DMA (μ DMA). The μ DMA controller provides a way to offload data transfer tasks from the Cortex-M3 processor, allowing for more efficient use of the processor and the available bus bandwidth. The μ DMA controller can perform transfers between memory and peripherals. It has dedicated channels for each supported on-chip module and can be programmed to automatically perform transfers between peripherals and memory as the peripheral is ready to transfer more data. The μ DMA controller provides the following features:

- ARM PrimeCell® 32-channel configurable µDMA controller
- Support for memory-to-memory, memory-to-peripheral, and peripheral-to-memory in multiple transfer modes
 - Basic for simple transfer scenarios
 - Ping-pong for continuous data flow
 - Scatter-gather for a programmable list of arbitrary transfers initiated from a single request
- Highly flexible and configurable channel operation
 - Independently configured and operated channels
 - Dedicated channels for supported on-chip modules
 - Primary and secondary channel assignments
 - One channel each for receive and transmit path for bidirectional modules
 - Dedicated channel for software-initiated transfers
 - Per-channel configurable priority scheme
 - Optional software-initiated requests for any channel
- Two levels of priority
- Design optimizations for improved bus access performance between µDMA controller and the processor core
 - µDMA controller access is subordinate to core access
 - RAM striping
 - Peripheral bus segmentation
- Data sizes of 8, 16, and 32 bits

- Transfer size is programmable in binary steps from 1 to 1024
- Source and destination address increment size of byte, half-word, word, or no increment
- Maskable peripheral requests

1.3.4.2 System Control and Clocks (see page 174)

System control determines the overall operation of the device. It provides information about the device, controls power-saving features, controls the clocking of the device and individual peripherals, and handles reset detection and reporting.

- Device identification information: version, part number, SRAM size, Flash memory size, and so on
- Power control
 - On-chip fixed Low Drop-Out (LDO) voltage regulator
 - Hibernation module handles the power-up/down 3.3 V sequencing and control for the core digital logic and analog circuits
 - Low-power options for microcontroller: Sleep and Deep-sleep modes with clock gating
 - Low-power options for on-chip modules: software controls shutdown of individual peripherals and memory
 - 3.3-V supply brown-out detection and reporting via interrupt or reset
- Multiple clock sources for microcontroller system clock
 - Precision Oscillator (PIOSC): On-chip resource providing a 16 MHz ±1% frequency at room temperature
 - 16 MHz ±3% across temperature
 - · Can be recalibrated with 7-bit trim resolution
 - Software power down control for low power modes
 - Main Oscillator (MOSC): A frequency-accurate clock source by one of two means: an external single-ended clock source is connected to the OSC0 input pin, or an external crystal is connected across the OSC0 input and OSC1 output pins.
 - External crystal used with or without on-chip PLL: select supported frequencies from 1 MHz to 16.384 MHz.
 - · External oscillator: from DC to maximum device speed
 - Internal 30-kHz Oscillator: on chip resource providing a 30 kHz ± 50% frequency, used during power-saving modes
 - 32.768-kHz external oscillator for the Hibernation Module: eliminates need for additional crystal for main clock source
- Flexible reset sources
 - Power-on reset (POR)
 - Reset pin assertion

- Brown-out reset (BOR) detector alerts to system power drops
- Software reset
- Watchdog timer reset
- MOSC failure

1.3.4.3 Programmable Timers (see page 444)

Programmable timers can be used to count or time external events that drive the Timer input pins. Each GPTM block provides two 16-bit timers/counters that can be configured to operate independently as timers or event counters, or configured to operate as one 32-bit timer or one 32-bit Real-Time Clock (RTC). Timers can also be used to trigger analog-to-digital (ADC) conversions.

The General-Purpose Timer Module (GPTM) contains three GPTM blocks with the following functional options:

- Operating modes:
 - 16- or 32-bit programmable one-shot timer
 - 16- or 32-bit programmable periodic timer
 - 16-bit general-purpose timer with an 8-bit prescaler
 - 32-bit Real-Time Clock (RTC) when using an external 32.768-KHz clock as the input
 - 16-bit input-edge count- or time-capture modes
 - 16-bit PWM mode with software-programmable output inversion of the PWM signal
- Count up or down
- Six Capture Compare PWM pins (CCP)
- Daisy chaining of timer modules to allow a single timer to initiate multiple timing events
- ADC event trigger
- User-enabled stalling when the microcontroller asserts CPU Halt flag during debug (excluding RTC mode)
- Ability to determine the elapsed time between the assertion of the timer interrupt and entry into the interrupt service routine.
- Efficient transfers using Micro Direct Memory Access Controller (μDMA)
 - Dedicated channel for each timer
 - Burst request generated on timer interrupt

1.3.4.4 CCP Pins (see page 451)

Capture Compare PWM pins (CCP) can be used by the General-Purpose Timer Module to time/count external events using the CCP pin as an input. Alternatively, the GPTM can generate a simple PWM output on the CCP pin.

The LM3S1J11 microcontroller includes six Capture Compare PWM pins (CCP) that can be programmed to operate in the following modes:

- Capture: The GP Timer is incremented/decremented by programmed events on the CCP input. The GP Timer captures and stores the current timer value when a programmed event occurs.
- Compare: The GP Timer is incremented/decremented by programmed events on the CCP input. The GP Timer compares the current value with a stored value and generates an interrupt when a match occurs.
- PWM: The GP Timer is incremented/decremented by the system clock. A PWM signal is generated based on a match between the counter value and a value stored in a match register and is output on the CCP pin.

1.3.4.5 Hibernation Module (see page 267)

The Hibernation module provides logic to switch power off to the main processor and peripherals and to wake on external or time-based events. The Hibernation module includes power-sequencing logic and has the following features:

- 32-bit real-time counter (RTC)
 - Two 32-bit RTC match registers for timed wake-up and interrupt generation
 - RTC predivider trim for making fine adjustments to the clock rate
- Two mechanisms for power control
 - System power control using discrete external regulator
 - On-chip power control using internal switches under register control
- Dedicated pin for waking using an external signal
- RTC operational and hibernation memory valid as long as V_{BAT} is valid
- Low-battery detection, signaling, and interrupt generation
- Clock source from a 32.768-kHz external oscillator or a 4.194304-MHz crystal; 32.768-kHz external oscillator can be used for main controller clock
- 64 32-bit words of battery-backed memory to save state during hibernation
- Programmable interrupts for RTC match, external wake, and low battery events

1.3.4.6 Watchdog Timers (see page 491)

A watchdog timer is used to regain control when a system has failed due to a software error or to the failure of an external device to respond in the expected way. The Stellaris Watchdog Timer can generate an interrupt or a reset when a time-out value is reached. In addition, the Watchdog Timer is ARM FiRM-compliant and can be configured to generate an interrupt to the microcontroller on its first time-out, and to generate a reset signal on its second time-out. Once the Watchdog Timer has been configured, the lock register can be written to prevent the timer configuration from being inadvertently altered.

The LM3S1J11 microcontroller has two Watchdog Timer modules: Watchdog Timer 0 uses the system clock for its timer clock; Watchdog Timer 1 uses the PIOSC as its timer clock. The Stellaris Watchdog Timer module has the following features:

- 32-bit down counter with a programmable load register
- Separate watchdog clock with an enable
- Programmable interrupt generation logic with interrupt masking
- Lock register protection from runaway software
- Reset generation logic with an enable/disable
- User-enabled stalling when the microcontroller asserts the CPU Halt flag during debug

1.3.4.7 Programmable GPIOs (see page 389)

General-purpose input/output (GPIO) pins offer flexibility for a variety of connections. The Stellaris GPIO module is comprised of nine physical GPIO blocks, each corresponding to an individual GPIO port. The GPIO module is FiRM-compliant (compliant to the ARM Foundation IP for Real-Time Microcontrollers specification) and supports 0-67 programmable input/output pins. The number of GPIOs available depends on the peripherals being used (see "Signal Tables" on page 748 for the signals available to each GPIO pin).

- Up to 67 GPIOs, depending on configuration
- Highly flexible pin muxing allows use as GPIO or one of several peripheral functions
- 5-V-tolerant in input configuration
- Two means of port access: either Advanced High-Performance Bus (AHB) with better back-to-back access performance, or the legacy Advanced Peripheral Bus (APB) for backwards-compatibility with existing code
- Fast toggle capable of a change every clock cycle for ports on AHB, every two clock cycles for ports on APB
- Programmable control for GPIO interrupts
 - Interrupt generation masking
 - Edge-triggered on rising, falling, or both
 - Level-sensitive on High or Low values
- Bit masking in both read and write operations through address lines
- Can be used to initiate an ADC sample sequence
- Pins configured as digital inputs are Schmitt-triggered
- Programmable control for GPIO pad configuration
 - Weak pull-up or pull-down resistors

- 2-mA, 4-mA, and 8-mA pad drive for digital communication; up to four pads can sink 18-mA for high-current applications
- Slew rate control for the 8-mA drive
- Open drain enables
- Digital input enables

1.3.5 Analog

The LM3S1J11 microcontroller provides analog functions integrated into the device, including:

- 10-bit Analog-to-Digital Converter (ADC) with eight analog input channels and a sample rate of one million samples/second
- Two analog comparators
- Eight digital comparators
- On-chip voltage regulator

The following provides more detail on these analog functions.

1.3.5.1 ADC (see page 516)

An analog-to-digital converter (ADC) is a peripheral that converts a continuous analog voltage to a discrete digital number. The Stellaris ADC module features 10-bit conversion resolution and supports eight input channels plus an internal temperature sensor. Four buffered sample sequencers allow rapid sampling of up to eight analog input sources without controller intervention. Each sample sequencer provides flexible programming with fully configurable input source, trigger events, interrupt generation, and sequencer priority. The ADC module has a digital comparator function that allows the conversion value to be diverted to a comparison unit that provides eight digital comparators.

The LM3S1J11 microcontroller provides one ADC module with the following features:

- Eight analog input channels
- Single-ended and differential-input configurations
- On-chip internal temperature sensor
- Maximum sample rate of one million samples/second
- Optional phase shift in sample time programmable from 22.5° to 337.5°
- Four programmable sample conversion sequencers from one to eight entries long, with corresponding conversion result FIFOs
- Flexible trigger control
 - Controller (software)
 - Timers
 - Analog Comparators

- GPIO
- Hardware averaging of up to 64 samples
- Digital comparison unit providing eight digital comparators
- Converter uses an internal 3-V reference or an external reference
- Power and ground for the analog circuitry is separate from the digital power and ground
- Efficient transfers using Micro Direct Memory Access Controller (μDMA)
 - Dedicated channel for each sample sequencer
 - ADC module uses burst requests for DMA

1.3.5.2 Analog Comparators (see page 733)

An analog comparator is a peripheral that compares two analog voltages and provides a logical output that signals the comparison result. The LM3S1J11 microcontroller provides two independent integrated analog comparators that can be configured to drive an output or generate an interrupt or ADC event.

The comparator can provide its output to a device pin, acting as a replacement for an analog comparator on the board, or it can be used to signal the application via interrupts or triggers to the ADC to cause it to start capturing a sample sequence. The interrupt generation and ADC triggering logic is separate. This means, for example, that an interrupt can be generated on a rising edge and the ADC triggered on a falling edge.

The LM3S1J11 microcontroller provides two independent integrated analog comparators with the following functions:

- Compare external pin input to external pin input or to internal programmable voltage reference
- Compare a test voltage against any one of the following voltages:
 - An individual external reference voltage
 - A shared single external reference voltage
 - A shared internal reference voltage

1.3.6 JTAG and ARM Serial Wire Debug (see page 162)

The Joint Test Action Group (JTAG) port is an IEEE standard that defines a Test Access Port and Boundary Scan Architecture for digital integrated circuits and provides a standardized serial interface for controlling the associated test logic. The TAP, Instruction Register (IR), and Data Registers (DR) can be used to test the interconnections of assembled printed circuit boards and obtain manufacturing information on the components. The JTAG Port also provides a means of accessing and controlling design-for-test features such as I/O pin observation and control, scan testing, and debugging. Texas Instruments replaces the ARM SW-DP and JTAG-DP with the ARM Serial Wire JTAG Debug Port (SWJ-DP) interface. The SWJ-DP interface combines the SWD and JTAG debug ports into one module providing all the normal JTAG debug and test functionality plus real-time access to system memory without halting the core or requiring any target resident code. The SWJ-DP interface has the following features:

■ IEEE 1149.1-1990 compatible Test Access Port (TAP) controller

- Four-bit Instruction Register (IR) chain for storing JTAG instructions
- IEEE standard instructions: BYPASS, IDCODE, SAMPLE/PRELOAD, EXTEST and INTEST
- ARM additional instructions: APACC, DPACC and ABORT
- Integrated ARM Serial Wire Debug (SWD)
 - Serial Wire JTAG Debug Port (SWJ-DP)
 - Flash Patch and Breakpoint (FPB) unit for implementing breakpoints
 - Data Watchpoint and Trace (DWT) unit for implementing watchpoints, trigger resources, and system profiling
 - Instrumentation Trace Macrocell (ITM) for support of printf style debugging
 - Trace Port Interface Unit (TPIU) for bridging to a Trace Port Analyzer

1.3.7 Packaging and Temperature

- Industrial-range (-40°C to 85°C) 100-pin RoHS-compliant LQFP package
- Industrial-range (-40°C to 85°C) 108-ball RoHS-compliant BGA package

1.4 Hardware Details

Details on the pins and package can be found in the following sections:

- "Pin Diagram" on page 746
- "Signal Tables" on page 748
- "Operating Characteristics" on page 796
- "Electrical Characteristics" on page 797
- "Package Information" on page 841

2 The Cortex-M3 Processor

The ARM® Cortex[™]-M3 processor provides a high-performance, low-cost platform that meets the system requirements of minimal memory implementation, reduced pin count, and low power consumption, while delivering outstanding computational performance and exceptional system response to interrupts. Features include:

- 32-bit ARM® Cortex™-M3 architecture optimized for small-footprint embedded applications
- 50-MHz operation; 60 DMIPS performance
- Outstanding processing performance combined with fast interrupt handling
- Thumb-2 mixed 16-/32-bit instruction set delivers the high performance expected of a 32-bit ARM core in a compact memory size usually associated with 8- and 16-bit devices, typically in the range of a few kilobytes of memory for microcontroller-class applications
 - Single-cycle multiply instruction and hardware divide
 - Atomic bit manipulation (bit-banding), delivering maximum memory utilization and streamlined peripheral control
 - Unaligned data access, enabling data to be efficiently packed into memory
- Fast code execution permits slower processor clock or increases sleep mode time
- Harvard architecture characterized by separate buses for instruction and data
- Efficient processor core, system and memories
- Hardware division and fast digital-signal-processing orientated multiply accumulate
- Saturating arithmetic for signal processing
- Deterministic, high-performance interrupt handling for time-critical applications
- Memory protection unit (MPU) to provide a privileged mode for protected operating system functionality
- Enhanced system debug with extensive breakpoint and trace capabilities
- Serial Wire Debug and Serial Wire Trace reduce the number of pins required for debugging and tracing
- Migration from the ARM7 processor family for better performance and power efficiency
- Optimized for single-cycle Flash memory usage
- Ultra-low power consumption with integrated sleep modes

The Stellaris[®] family of microcontrollers builds on this core to bring high-performance 32-bit computing to cost-sensitive embedded microcontroller applications, such as factory automation and control, industrial control power devices, building and home automation, and stepper motor control.

This chapter provides information on the Stellaris implementation of the Cortex-M3 processor, including the programming model, the memory model, the exception model, fault handling, and power management.

For technical details on the instruction set, see the $Cortex^{TM}$ -M3/M4 Instruction Set Technical User's Manual.

2.1 Block Diagram

The Cortex-M3 processor is built on a high-performance processor core, with a 3-stage pipeline Harvard architecture, making it ideal for demanding embedded applications. The processor delivers exceptional power efficiency through an efficient instruction set and extensively optimized design, providing high-end processing hardware including a range of single-cycle and SIMD multiplication and multiply-with-accumulate capabilities, saturating arithmetic and dedicated hardware division.

To facilitate the design of cost-sensitive devices, the Cortex-M3 processor implements tightly coupled system components that reduce processor area while significantly improving interrupt handling and system debug capabilities. The Cortex-M3 processor implements a version of the Thumb® instruction set based on Thumb-2 technology, ensuring high code density and reduced program memory requirements. The Cortex-M3 instruction set provides the exceptional performance expected of a modern 32-bit architecture, with the high code density of 8-bit and 16-bit microcontrollers.

The Cortex-M3 processor closely integrates a nested interrupt controller (NVIC), to deliver industry-leading interrupt performance. The Stellaris NVIC includes a non-maskable interrupt (NMI) and provides eight interrupt priority levels. The tight integration of the processor core and NVIC provides fast execution of interrupt service routines (ISRs), dramatically reducing interrupt latency. The hardware stacking of registers and the ability to suspend load-multiple and store-multiple operations further reduce interrupt latency. Interrupt handlers do not require any assembler stubs which removes code overhead from the ISRs. Tail-chaining optimization also significantly reduces the overhead when switching from one ISR to another. To optimize low-power designs, the NVIC integrates with the sleep modes, including Deep-sleep mode, which enables the entire device to be rapidly powered down.

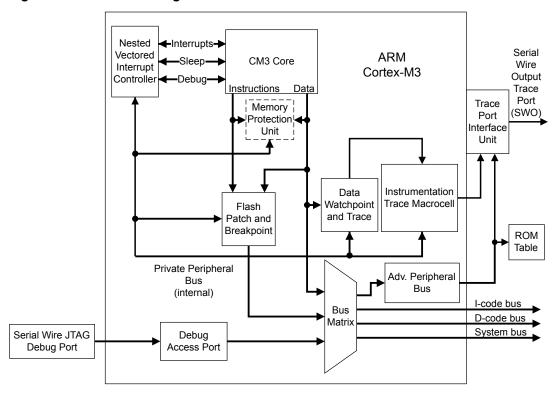


Figure 2-1. CPU Block Diagram

2.2 Overview

2.2.1 System-Level Interface

The Cortex-M3 processor provides multiple interfaces using AMBA® technology to provide high-speed, low-latency memory accesses. The core supports unaligned data accesses and implements atomic bit manipulation that enables faster peripheral controls, system spinlocks, and thread-safe Boolean data handling.

The Cortex-M3 processor has a memory protection unit (MPU) that provides fine-grain memory control, enabling applications to implement security privilege levels and separate code, data and stack on a task-by-task basis.

2.2.2 Integrated Configurable Debug

The Cortex-M3 processor implements a complete hardware debug solution, providing high system visibility of the processor and memory through either a traditional JTAG port or a 2-pin Serial Wire Debug (SWD) port that is ideal for microcontrollers and other small package devices. The Stellaris implementation replaces the ARM SW-DP and JTAG-DP with the ARM CoreSight™-compliant Serial Wire JTAG Debug Port (SWJ-DP) interface. The SWJ-DP interface combines the SWD and JTAG debug ports into one module. See the *ARM® Debug Interface V5 Architecture Specification* for details on SWJ-DP.

For system trace, the processor integrates an Instrumentation Trace Macrocell (ITM) alongside data watchpoints and a profiling unit. To enable simple and cost-effective profiling of the system trace events, a Serial Wire Viewer (SWV) can export a stream of software-generated messages, data trace, and profiling information through a single pin.

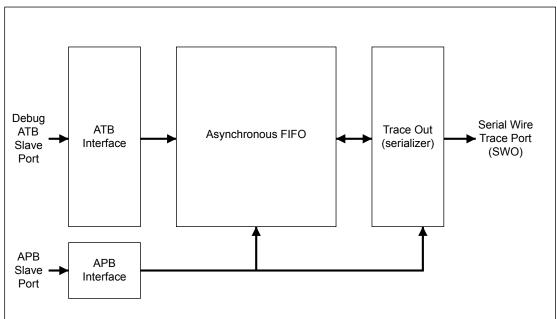
The Flash Patch and Breakpoint Unit (FPB) provides up to eight hardware breakpoint comparators that debuggers can use. The comparators in the FPB also provide remap functions of up to eight words in the program code in the CODE memory region. This enables applications stored in a read-only area of Flash memory to be patched in another area of on-chip SRAM or Flash memory. If a patch is required, the application programs the FPB to remap a number of addresses. When those addresses are accessed, the accesses are redirected to a remap table specified in the FPB configuration.

For more information on the Cortex-M3 debug capabilities, see the ARM® Debug Interface V5 Architecture Specification.

2.2.3 Trace Port Interface Unit (TPIU)

The TPIU acts as a bridge between the Cortex-M3 trace data from the ITM, and an off-chip Trace Port Analyzer, as shown in Figure 2-2 on page 57.

Figure 2-2. TPIU Block Diagram



2.2.4 Cortex-M3 System Component Details

The Cortex-M3 includes the following system components:

- SysTick
 - A 24-bit count-down timer that can be used as a Real-Time Operating System (RTOS) tick timer or as a simple counter (see "System Timer (SysTick)" on page 96).
- Nested Vectored Interrupt Controller (NVIC)
 - An embedded interrupt controller that supports low latency interrupt processing (see "Nested Vectored Interrupt Controller (NVIC)" on page 97).
- System Control Block (SCB)

The programming model interface to the processor. The SCB provides system implementation information and system control, including configuration, control, and reporting of system exceptions (see "System Control Block (SCB)" on page 99).

■ Memory Protection Unit (MPU)

Improves system reliability by defining the memory attributes for different memory regions. The MPU provides up to eight different regions and an optional predefined background region (see "Memory Protection Unit (MPU)" on page 99).

2.3 Programming Model

This section describes the Cortex-M3 programming model. In addition to the individual core register descriptions, information about the processor modes and privilege levels for software execution and stacks is included.

2.3.1 Processor Mode and Privilege Levels for Software Execution

The Cortex-M3 has two modes of operation:

Thread mode

Used to execute application software. The processor enters Thread mode when it comes out of reset.

■ Handler mode

Used to handle exceptions. When the processor has finished exception processing, it returns to Thread mode.

In addition, the Cortex-M3 has two privilege levels:

Unprivileged

In this mode, software has the following restrictions:

- Limited access to the MSR and MRS instructions and no use of the CPS instruction
- No access to the system timer, NVIC, or system control block
- Possibly restricted access to memory or peripherals
- Privileged

In this mode, software can use all the instructions and has access to all resources.

In Thread mode, the **CONTROL** register (see page 72) controls whether software execution is privileged or unprivileged. In Handler mode, software execution is always privileged.

Only privileged software can write to the **CONTROL** register to change the privilege level for software execution in Thread mode. Unprivileged software can use the SVC instruction to make a supervisor call to transfer control to privileged software.

2.3.2 Stacks

The processor uses a full descending stack, meaning that the stack pointer indicates the last stacked item on the memory. When the processor pushes a new item onto the stack, it decrements the stack pointer and then writes the item to the new memory location. The processor implements two stacks:

the main stack and the process stack, with a pointer for each held in independent registers (see the **SP** register on page 62).

In Thread mode, the **CONTROL** register (see page 72) controls whether the processor uses the main stack or the process stack. In Handler mode, the processor always uses the main stack. The options for processor operations are shown in Table 2-1 on page 59.

Table 2-1. Summary of Processor Mode, Privilege Level, and Stack Use

Processor Mode	Use	Privilege Level	Stack Used
Thread	Applications	Privileged or unprivileged ^a	Main stack or process stack a
Handler	Exception handlers	Always privileged	Main stack

a. See CONTROL (page 72).

2.3.3 Register Map

Figure 2-3 on page 59 shows the Cortex-M3 register set. Table 2-2 on page 60 lists the Core registers. The core registers are not memory mapped and are accessed by register name, so the base address is n/a (not applicable) and there is no offset.

Figure 2-3. Cortex-M3 Register Set

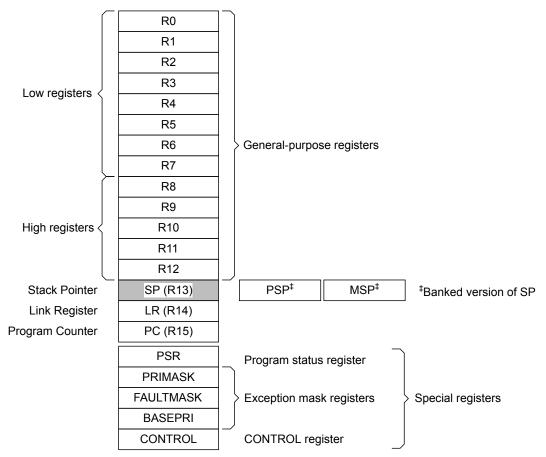


Table 2-2. Processor Register Map

Offset	Name	Туре	Reset	Description	See page
-	R0	R/W	-	Cortex General-Purpose Register 0	61
-	R1	R/W	-	Cortex General-Purpose Register 1	61
-	R2	R/W	-	Cortex General-Purpose Register 2	61
-	R3	R/W	-	Cortex General-Purpose Register 3	61
-	R4	R/W	-	Cortex General-Purpose Register 4	61
-	R5	R/W	-	Cortex General-Purpose Register 5	61
-	R6	R/W	-	Cortex General-Purpose Register 6	61
-	R7	R/W	-	Cortex General-Purpose Register 7	61
-	R8	R/W	-	Cortex General-Purpose Register 8	61
-	R9	R/W	-	Cortex General-Purpose Register 9	61
-	R10	R/W	-	Cortex General-Purpose Register 10	61
-	R11	R/W	-	Cortex General-Purpose Register 11	61
-	R12	R/W	-	Cortex General-Purpose Register 12	61
-	SP	R/W	-	Stack Pointer	62
-	LR	R/W	0xFFFF.FFFF	Link Register	63
-	PC	R/W	-	Program Counter	64
-	PSR	R/W	0x0100.0000	Program Status Register	65
-	PRIMASK	R/W	0x0000.0000	Priority Mask Register	69
-	FAULTMASK	R/W	0x0000.0000	Fault Mask Register	70
-	BASEPRI	R/W	0x0000.0000	Base Priority Mask Register	71
-	CONTROL	R/W	0x0000.0000	Control Register	72

2.3.4 Register Descriptions

This section lists and describes the Cortex-M3 registers, in the order shown in Figure 2-3 on page 59. The core registers are not memory mapped and are accessed by register name rather than offset.

Note: The register type shown in the register descriptions refers to type during program execution in Thread mode and Handler mode. Debug access can differ.

Register 1: Cortex General-Purpose Register 0 (R0)

Register 2: Cortex General-Purpose Register 1 (R1)

Register 3: Cortex General-Purpose Register 2 (R2)

Register 4: Cortex General-Purpose Register 3 (R3)

Register 5: Cortex General-Purpose Register 4 (R4)

Register 6: Cortex General-Purpose Register 5 (R5)

Register 7: Cortex General-Purpose Register 6 (R6)

Register 8: Cortex General-Purpose Register 7 (R7)

Register 9: Cortex General-Purpose Register 8 (R8)

Register 10: Cortex General-Purpose Register 9 (R9)

Register 11: Cortex General-Purpose Register 10 (R10)

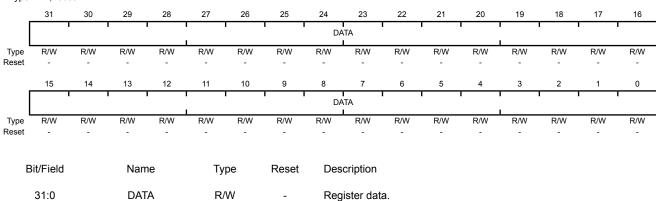
Register 12: Cortex General-Purpose Register 11 (R11)

Register 13: Cortex General-Purpose Register 12 (R12)

The **Rn** registers are 32-bit general-purpose registers for data operations and can be accessed from either privileged or unprivileged mode.

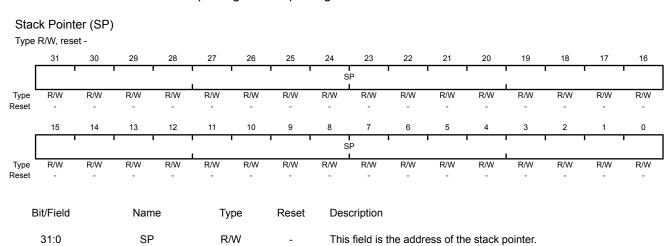
Cortex General-Purpose Register 0 (R0)

Type R/W, reset -



Register 14: Stack Pointer (SP)

The **Stack Pointer (SP)** is register R13. In Thread mode, the function of this register changes depending on the ASP bit in the **Control Register (CONTROL)** register. When the ASP bit is clear, this register is the **Main Stack Pointer (MSP)**. When the ASP bit is set, this register is the **Process Stack Pointer (PSP)**. On reset, the ASP bit is clear, and the processor loads the **MSP** with the value from address 0x0000.0000. The **MSP** can only be accessed in privileged mode; the **PSP** can be accessed in either privileged or unprivileged mode.



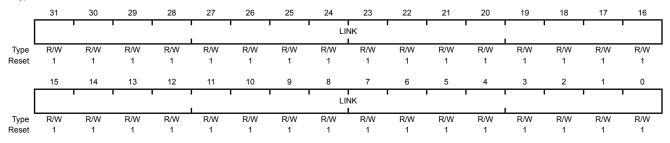
Register 15: Link Register (LR)

The **Link Register (LR)** is register R14, and it stores the return information for subroutines, function calls, and exceptions. **LR** can be accessed from either privileged or unprivileged mode.

EXC_RETURN is loaded into **LR** on exception entry. See Table 2-10 on page 89 for the values and description.

Link Register (LR)

Type R/W, reset 0xFFFF.FFF



Bit/Field Name Type Reset Description

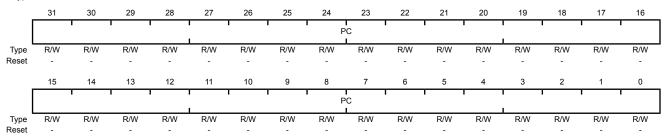
31:0 LINK R/W 0xFFF.FFF This field is the return address.

Register 16: Program Counter (PC)

The **Program Counter (PC)** is register R15, and it contains the current program address. On reset, the processor loads the **PC** with the value of the reset vector, which is at address 0x0000.0004. Bit 0 of the reset vector is loaded into the THUMB bit of the **EPSR** at reset and must be 1. The **PC** register can be accessed in either privileged or unprivileged mode.

Program Counter (PC)





Bit/Field	Name	Type	Reset	Description
31:0	PC	R/W	_	This field is the current program address

Register 17: Program Status Register (PSR)

Note: This register is also referred to as **xPSR**.

The **Program Status Register (PSR)** has three functions, and the register bits are assigned to the different functions:

- Application Program Status Register (APSR), bits 31:27,
- Execution Program Status Register (EPSR), bits 26:24, 15:10
- Interrupt Program Status Register (IPSR), bits 6:0

The **PSR**, **IPSR**, and **EPSR** registers can only be accessed in privileged mode; the **APSR** register can be accessed in either privileged or unprivileged mode.

APSR contains the current state of the condition flags from previous instruction executions.

EPSR contains the Thumb state bit and the execution state bits for the If-Then (IT) instruction or the Interruptible-Continuable Instruction (ICI) field for an interrupted load multiple or store multiple instruction. Attempts to read the **EPSR** directly through application software using the MSR instruction always return zero. Attempts to write the **EPSR** using the MSR instruction in application software are always ignored. Fault handlers can examine the **EPSR** value in the stacked **PSR** to determine the operation that faulted (see "Exception Entry and Return" on page 87).

IPSR contains the exception type number of the current Interrupt Service Routine (ISR).

These registers can be accessed individually or as a combination of any two or all three registers, using the register name as an argument to the MSR or MRS instructions. For example, all of the registers can be read using **PSR** with the MRS instruction, or **APSR** only can be written to using **APSR** with the MSR instruction. page 65 shows the possible register combinations for the **PSR**. See the MRS and MSR instruction descriptions in the *Cortex™-M3/M4 Instruction Set Technical User's Manual* for more information about how to access the program status registers.

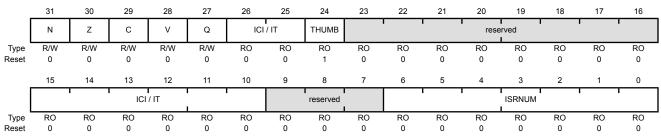
Table 2-3. PSR Register Combinations

Register	Туре	Combination
PSR	R/W ^{a, b}	APSR, EPSR, and IPSR
IEPSR	RO	EPSR and IPSR
IAPSR	R/W ^a	APSR and IPSR
EAPSR	R/W ^b	APSR and EPSR

- a. The processor ignores writes to the IPSR bits.
- b. Reads of the EPSR bits return zero, and the processor ignores writes to these bits.

Program Status Register (PSR)

Type R/W, reset 0x0100.0000



Bit/Field	Name	Туре	Reset	Description
31	N	R/W	0	APSR Negative or Less Flag
				Value Description
				1 The previous operation result was negative or less than.
				The previous operation result was positive, zero, greater than, or equal.
				The value of this bit is only meaningful when accessing PSR or APSR .
30	Z	R/W	0	APSR Zero Flag
				Value Description
				1 The previous operation result was zero.
				The previous operation result was non-zero.
				The value of this bit is only meaningful when accessing PSR or APSR .
29	С	R/W	0	APSR Carry or Borrow Flag
				Value Description
				The previous add operation resulted in a carry bit or the previous subtract operation did not result in a borrow bit.
				The previous add operation did not result in a carry bit or the previous subtract operation resulted in a borrow bit.
				The value of this bit is only meaningful when accessing PSR or APSR .
28	٧	R/W	0	APSR Overflow Flag
				Value Description
				1 The previous operation resulted in an overflow.
				O The previous operation did not result in an overflow.
				The value of this bit is only meaningful when accessing PSR or APSR .
27	Q	R/W	0	APSR DSP Overflow and Saturation Flag
				Value Description
				1 DSP Overflow or saturation has occurred.
				0 DSP overflow or saturation has not occurred since reset or since the bit was last cleared.
				The value of this bit is only meaningful when accessing PSR or APSR .
				This bit is cleared by software using an \mathtt{MRS} instruction.

Bit/Field	Name	Туре	Reset	Description
26:25	ICI / IT	RO	0x0	EPSR ICI / IT status
				These bits, along with bits 15:10, contain the Interruptible-Continuable Instruction (ICI) field for an interrupted load multiple or store multiple instruction or the execution state bits of the IT instruction.
				When EPSR holds the ICI execution state, bits 26:25 are zero.
				The If-Then block contains up to four instructions following an IT instruction. Each instruction in the block is conditional. The conditions for the instructions are either all the same, or some can be the inverse of others. See the <i>Cortex™-M3/M4 Instruction Set Technical User's Manual</i> for more information.
				The value of this field is only meaningful when accessing PSR or EPSR .
24	THUMB	RO	1	EPSR Thumb State
				This bit indicates the Thumb state and should always be set. The following can clear the THUMB bit:
				■ The BLX, BX and POP{PC} instructions
				■ Restoration from the stacked xPSR value on an exception return
				■ Bit 0 of the vector value on an exception entry or reset
				Attempting to execute instructions when this bit is clear results in a fault or lockup. See "Lockup" on page 91 for more information.
				The value of this bit is only meaningful when accessing PSR or EPSR .
23:16	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:10	ICI / IT	RO	0x0	EPSR ICI / IT status
				These bits, along with bits 26:25, contain the Interruptible-Continuable Instruction (ICI) field for an interrupted load multiple or store multiple instruction or the execution state bits of the IT instruction.
				When an interrupt occurs during the execution of an LDM, STM, PUSH or POP instruction, the processor stops the load multiple or store multiple instruction operation temporarily and stores the next register operand in the multiple operation to bits 15:12. After servicing the interrupt, the processor returns to the register pointed to by bits 15:12 and resumes execution of the multiple load or store instruction. When EPSR holds the ICI execution state, bits 11:10 are zero.
				The If-Then block contains up to four instructions following a 16-bit IT instruction. Each instruction in the block is conditional. The conditions for the instructions are either all the same, or some can be the inverse of others. See the <i>Cortex™-M3/M4 Instruction Set Technical User's Manual</i> for more information.
				The value of this field is only meaningful when accessing PSR or EPSR .
9:7	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description	
6:0	ISRNUM	RO	0x00	IPSR ISR N	umber
				This field co Service Rou	ntains the exception type number of the current Interrupt tine (ISR).
				Value	Description
				0x00	Thread mode
				0x01	Reserved
				0x02	NMI
				0x03	Hard fault
				0x04	Memory management fault
				0x05	Bus fault
				0x06	Usage fault
				0x07-0x0A	Reserved
				0x0B	SVCall
				0x0C	Reserved for Debug
				0x0D	Reserved
				0x0E	PendSV
				0x0F	SysTick
				0x10	Interrupt Vector 0
				0x11	Interrupt Vector 1
				0x46	Interrupt Vector 54
				0x47-0x7F	Reserved
				Co "Evene	tion Turner" on north 90 for more information

See "Exception Types" on page 82 for more information.

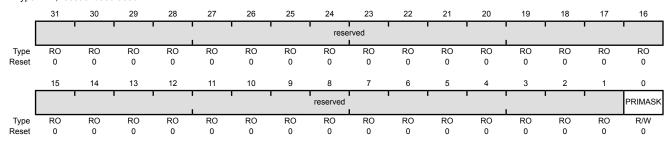
The value of this field is only meaningful when accessing **PSR** or **IPSR**.

Register 18: Priority Mask Register (PRIMASK)

The **PRIMASK** register prevents activation of all exceptions with programmable priority. Reset, non-maskable interrupt (NMI), and hard fault are the only exceptions with fixed priority. Exceptions should be disabled when they might impact the timing of critical tasks. This register is only accessible in privileged mode. The MSR and MRS instructions are used to access the **PRIMASK** register, and the CPS instruction may be used to change the value of the **PRIMASK** register. See the Cortex™-M3/M4 Instruction Set Technical User's Manual for more information on these instructions. For more information on exception priority levels, see "Exception Types" on page 82.

Priority Mask Register (PRIMASK)

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	PRIMASK	R/W	0	Priority Mask

Value Description

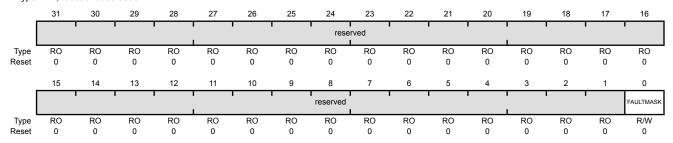
- Prevents the activation of all exceptions with configurable priority.
- 0 No effect.

Register 19: Fault Mask Register (FAULTMASK)

The **FAULTMASK** register prevents activation of all exceptions except for the Non-Maskable Interrupt (NMI). Exceptions should be disabled when they might impact the timing of critical tasks. This register is only accessible in privileged mode. The MSR and MRS instructions are used to access the **FAULTMASK** register, and the CPS instruction may be used to change the value of the **FAULTMASK** register. See the *Cortex™-M3/M4 Instruction Set Technical User's Manual* for more information on these instructions. For more information on exception priority levels, see "Exception Types" on page 82.

Fault Mask Register (FAULTMASK)

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	FAULTMASK	R/W	0	Fault Mask

Value Description

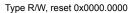
- 1 Prevents the activation of all exceptions except for NMI.
- 0 No effect.

The processor clears the FAULTMASK bit on exit from any exception handler except the NMI handler.

Register 20: Base Priority Mask Register (BASEPRI)

The **BASEPRI** register defines the minimum priority for exception processing. When **BASEPRI** is set to a nonzero value, it prevents the activation of all exceptions with the same or lower priority level as the **BASEPRI** value. Exceptions should be disabled when they might impact the timing of critical tasks. This register is only accessible in privileged mode. For more information on exception priority levels, see "Exception Types" on page 82.

Base Priority Mask Register (BASEPRI)

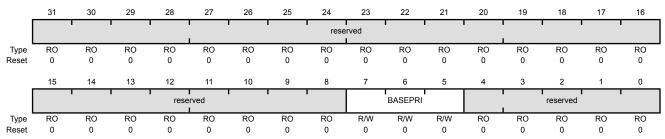


4:0

reserved

RO

0x0



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7.5	DACEDDI	DAM	0.40	Page Priority

Any exception that has a programmable priority level with the same or lower priority as the value of this field is masked. The **PRIMASK** register can be used to mask all exceptions with programmable priority levels. Higher priority exceptions have lower priority levels.

Value Description 0x0 All exceptions are unmasked. 0x1 All exceptions with priority level 1-7 are masked. 0x2 All exceptions with priority level 2-7 are masked. 0x3 All exceptions with priority level 3-7 are masked. All exceptions with priority level 4-7 are masked. 0x4 All exceptions with priority level 5-7 are masked. 0x5 All exceptions with priority level 6-7 are masked. 0x60x7 All exceptions with priority level 7 are masked.

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 21: Control Register (CONTROL)

The **CONTROL** register controls the stack used and the privilege level for software execution when the processor is in Thread mode. This register is only accessible in privileged mode.

Handler mode always uses **MSP**, so the processor ignores explicit writes to the ASP bit of the **CONTROL** register when in Handler mode. The exception entry and return mechanisms automatically update the **CONTROL** register based on the EXC_RETURN value (see Table 2-10 on page 89). In an OS environment, threads running in Thread mode should use the process stack and the kernel and exception handlers should use the main stack. By default, Thread mode uses **MSP**. To switch the stack pointer used in Thread mode to **PSP**, either use the MSR instruction to set the ASP bit, as detailed in the *Cortex*TM-*M3/M4 Instruction Set Technical User's Manual*, or perform an exception return to Thread mode with the appropriate EXC_RETURN value, as shown in Table 2-10 on page 89.

Note: When changing the stack pointer, software must use an ISB instruction immediately after the MSR instruction, ensuring that instructions after the ISB execute use the new stack pointer. See the *Cortex*TM-*M3/M4 Instruction Set Technical User's Manual*.

Control Register (CONTROL)

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:2	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	ASP	R/W	0	Active Stack Pointer
				Value Description
				1 PSP is the current stack pointer.
				0 MSP is the current stack pointer
				In Handler mode, this bit reads as zero and ignores writes. The Cortex-M3 updates this bit automatically on exception return.
0	TMPL	R/W	0	Thread Mode Privilege Level
				Value Description

Value Description

- 1 Unprivileged software can be executed in Thread mode.
- Only privileged software can be executed in Thread mode.

2.3.5 Exceptions and Interrupts

The Cortex-M3 processor supports interrupts and system exceptions. The processor and the Nested Vectored Interrupt Controller (NVIC) prioritize and handle all exceptions. An exception changes the normal flow of software control. The processor uses Handler mode to handle all exceptions except for reset. See "Exception Entry and Return" on page 87 for more information.

The NVIC registers control interrupt handling. See "Nested Vectored Interrupt Controller (NVIC)" on page 97 for more information.

2.3.6 Data Types

The Cortex-M3 supports 32-bit words, 16-bit halfwords, and 8-bit bytes. The processor also supports 64-bit data transfer instructions. All instruction and data memory accesses are little endian. See "Memory Regions, Types and Attributes" on page 75 for more information.

2.4 Memory Model

This section describes the processor memory map, the behavior of memory accesses, and the bit-banding features. The processor has a fixed memory map that provides up to 4 GB of addressable memory.

The memory map for the LM3S1J11 controller is provided in Table 2-4 on page 73. In this manual, register addresses are given as a hexadecimal increment, relative to the module's base address as shown in the memory map.

The regions for SRAM and peripherals include bit-band regions. Bit-banding provides atomic operations to bit data (see "Bit-Banding" on page 77).

The processor reserves regions of the Private peripheral bus (PPB) address range for core peripheral registers (see "Cortex-M3 Peripherals" on page 96).

Note: Within the memory map, all reserved space returns a bus fault when read or written.

Table 2-4. Memory Map

Start	End	Description	For details, see page
Memory	<u>'</u>	·	•
0x0000.0000	0x0001.FFFF	On-chip Flash	303
0x0002.0000	0x00FF.FFFF	Reserved	-
0x0100.0000	0x1FFF.FFFF	Reserved for ROM	295
0x2000.0000	0x2000.4FFF	Bit-banded on-chip SRAM	295
0x2000.5000	0x21FF.FFFF	Reserved	-
0x2200.0000	0x2209.FFFF	Bit-band alias of bit-banded on-chip SRAM starting at 0x2000.0000	295
0x220A.0000	0x3FFF.FFFF	Reserved	-
FiRM Peripherals	-		
0x4000.0000	0x4000.0FFF	Watchdog timer 0	494
0x4000.1000	0x4000.1FFF	Watchdog timer 1	494
0x4000.2000	0x4000.3FFF	Reserved	-
0x4000.4000	0x4000.4FFF	GPIO Port A	401
0x4000.5000	0x4000.5FFF	GPIO Port B 401	
0x4000.6000	0x4000.6FFF	GPIO Port C	401

Table 2-4. Memory Map (continued)

Start	End	Description	For details, see page
0x4000.7000	0x4000.7FFF	GPIO Port D	401
0x4000.8000	0x4000.8FFF	SSI0	667
0x4000.9000	0x4000.9FFF	SSI1	667
0x4000.A000	0x4000.BFFF	Reserved	-
0x4000.C000	0x4000.CFFF	UART0	603
0x4000.D000	0x4000.DFFF	UART1	603
0x4000.E000	0x4000.EFFF	UART2	603
0x4000.F000	0x4001.FFFF	Reserved	-
Peripherals			I
0x4002.0000	0x4002.0FFF	I ² C 0	711
0x4002.1000	0x4002.1FFF	I ² C 1	711
0x4002.2000	0x4002.3FFF	Reserved	-
0x4002.4000	0x4002.4FFF	GPIO Port E	401
0x4002.5000	0x4002.5FFF	GPIO Port F	401
0x4002.6000	0x4002.6FFF	GPIO Port G	401
0x4002.7000	0x4002.7FFF	GPIO Port H	401
0x4002.8000	0x4002.FFFF	Reserved	-
0x4003.0000	0x4003.0FFF	Timer 0	460
0x4003.1000	0x4003.1FFF	Timer 1	460
0x4003.2000	0x4003.2FFF	Timer 2	460
0x4003.3000	0x4003.7FFF	Reserved	-
0x4003.8000	0x4003.8FFF	ADC0	534
0x4003.9000	0x4003.BFFF	Reserved	-
0x4003.C000	0x4003.CFFF	Analog Comparators	733
0x4003.D000	0x4003.DFFF	GPIO Port J	401
0x4003.E000	0x4005.7FFF	Reserved	-
0x4005.8000	0x4005.8FFF	GPIO Port A (AHB aperture)	401
0x4005.9000	0x4005.9FFF	GPIO Port B (AHB aperture)	401
0x4005.A000	0x4005.AFFF	GPIO Port C (AHB aperture)	401
0x4005.B000	0x4005.BFFF	GPIO Port D (AHB aperture)	401
0x4005.C000	0x4005.CFFF	GPIO Port E (AHB aperture)	401
0x4005.D000	0x4005.DFFF	GPIO Port F (AHB aperture)	401
0x4005.E000	0x4005.EFFF	GPIO Port G (AHB aperture)	401
0x4005.F000	0x4005.FFFF	GPIO Port H (AHB aperture)	401
0x4006.0000	0x4006.0FFF	GPIO Port J (AHB aperture)	401
0x4006.1000	0x400F.BFFF	Reserved	-
0x400F.C000	0x400F.CFFF	Hibernation Module	277
0x400F.D000	0x400F.DFFF	Flash memory control	303
0x400F.E000	0x400F.EFFF	System control	192
0x400F.F000	0x400F.FFFF	μDMA 352	
0x4010.0000	0x41FF.FFFF	Reserved	-

Start	End	Description	For details, see page
0x4200.0000	0x43FF.FFFF	Bit-banded alias of 0x4000.0000 through 0x400F.FFFF	-
0x4400.0000	0xDFFF.FFFF	Reserved	-
Private Peripheral Bus			
0xE000.0000	0xE000.0FFF	Instrumentation Trace Macrocell (ITM)	56
0xE000.1000	0xE000.1FFF	Data Watchpoint and Trace (DWT)	56
0xE000.2000	0xE000.2FFF	Flash Patch and Breakpoint (FPB)	56
0xE000.3000	0xE000.DFFF	Reserved	-
0xE000.E000	0xE000.EFFF	Cortex-M3 Peripherals (SysTick, NVIC, MPU and SCB)	104
0xE000.F000	0xE003.FFFF	Reserved	-
0xE004.0000	0xE004.0FFF	Trace Port Interface Unit (TPIU)	57
0xE004.1000	0xFFFF.FFFF	Reserved	-

2.4.1 Memory Regions, Types and Attributes

The memory map and the programming of the MPU split the memory map into regions. Each region has a defined memory type, and some regions have additional memory attributes. The memory type and attributes determine the behavior of accesses to the region.

The memory types are:

- Normal: The processor can re-order transactions for efficiency and perform speculative reads.
- Device: The processor preserves transaction order relative to other transactions to Device or Strongly Ordered memory.
- Strongly Ordered: The processor preserves transaction order relative to all other transactions.

The different ordering requirements for Device and Strongly Ordered memory mean that the memory system can buffer a write to Device memory but must not buffer a write to Strongly Ordered memory.

An additional memory attribute is Execute Never (XN), which means the processor prevents instruction accesses. A fault exception is generated only on execution of an instruction executed from an XN region.

2.4.2 Memory System Ordering of Memory Accesses

For most memory accesses caused by explicit memory access instructions, the memory system does not guarantee that the order in which the accesses complete matches the program order of the instructions, providing the order does not affect the behavior of the instruction sequence. Normally, if correct program execution depends on two memory accesses completing in program order, software must insert a memory barrier instruction between the memory access instructions (see "Software Ordering of Memory Accesses" on page 76).

However, the memory system does guarantee ordering of accesses to Device and Strongly Ordered memory. For two memory access instructions A1 and A2, if both A1 and A2 are accesses to either Device or Strongly Ordered memory, and if A1 occurs before A2 in program order, A1 is always observed before A2.

2.4.3 Behavior of Memory Accesses

Table 2-5 on page 76 shows the behavior of accesses to each region in the memory map. See "Memory Regions, Types and Attributes" on page 75 for more information on memory types and the XN attribute. Stellaris devices may have reserved memory areas within the address ranges shown below (refer to Table 2-4 on page 73 for more information).

Table 2-5. Memory Access Behavior

Address Range	Memory Region	Memory Type	Execute Never (XN)	Description
0x0000.0000 - 0x1FFF.FFF	Code	Normal	-	This executable region is for program code. Data can also be stored here.
0x2000.0000 - 0x3FFF.FFFF	SRAM	Normal	-	This executable region is for data. Code can also be stored here. This region includes bit band and bit band alias areas (see Table 2-6 on page 78).
0x4000.0000 - 0x5FFF.FFF	Peripheral	Device	XN	This region includes bit band and bit band alias areas (see Table 2-7 on page 78).
0x6000.0000 - 0x9FFF.FFFF	External RAM	Normal	-	This executable region is for data.
0xA000.0000 - 0xDFFF.FFFF	External device	Device	XN	This region is for external device memory.
0xE000.0000- 0xE00F.FFFF	Private peripheral bus	Strongly Ordered	XN	This region includes the NVIC, system timer, and system control block.
0xE010.0000- 0xFFFF.FFF	Reserved	-	-	-

The Code, SRAM, and external RAM regions can hold programs. However, it is recommended that programs always use the Code region because the Cortex-M3 has separate buses that can perform instruction fetches and data accesses simultaneously.

The MPU can override the default memory access behavior described in this section. For more information, see "Memory Protection Unit (MPU)" on page 99.

The Cortex-M3 prefetches instructions ahead of execution and speculatively prefetches from branch target addresses.

2.4.4 Software Ordering of Memory Accesses

The order of instructions in the program flow does not always guarantee the order of the corresponding memory transactions for the following reasons:

- The processor can reorder some memory accesses to improve efficiency, providing this does not affect the behavior of the instruction sequence.
- The processor has multiple bus interfaces.
- Memory or devices in the memory map have different wait states.
- Some memory accesses are buffered or speculative.

"Memory System Ordering of Memory Accesses" on page 75 describes the cases where the memory system guarantees the order of memory accesses. Otherwise, if the order of memory accesses is critical, software must include memory barrier instructions to force that ordering. The Cortex-M3 has the following memory barrier instructions:

- The Data Memory Barrier (DMB) instruction ensures that outstanding memory transactions complete before subsequent memory transactions.
- The Data Synchronization Barrier (DSB) instruction ensures that outstanding memory transactions complete before subsequent instructions execute.
- The Instruction Synchronization Barrier (ISB) instruction ensures that the effect of all completed memory transactions is recognizable by subsequent instructions.

Memory barrier instructions can be used in the following situations:

- MPU programming
 - If the MPU settings are changed and the change must be effective on the very next instruction, use a DSB instruction to ensure the effect of the MPU takes place immediately at the end of context switching.
 - Use an ISB instruction to ensure the new MPU setting takes effect immediately after programming the MPU region or regions, if the MPU configuration code was accessed using a branch or call. If the MPU configuration code is entered using exception mechanisms, then an ISB instruction is not required.

Vector table

If the program changes an entry in the vector table and then enables the corresponding exception, use a DMB instruction between the operations. The DMB instruction ensures that if the exception is taken immediately after being enabled, the processor uses the new exception vector.

Self-modifying code

If a program contains self-modifying code, use an ISB instruction immediately after the code modification in the program. The ISB instruction ensures subsequent instruction execution uses the updated program.

Memory map switching

If the system contains a memory map switching mechanism, use a \mbox{DSB} instruction after switching the memory map in the program. The \mbox{DSB} instruction ensures subsequent instruction execution uses the updated memory map.

■ Dynamic exception priority change

When an exception priority has to change when the exception is pending or active, use DSB instructions after the change. The change then takes effect on completion of the DSB instruction.

Memory accesses to Strongly Ordered memory, such as the System Control Block, do not require the use of DMB instructions.

For more information on the memory barrier instructions, see the *Cortex*™-*M3/M4 Instruction Set Technical User's Manual*.

2.4.5 Bit-Banding

A bit-band region maps each word in a bit-band alias region to a single bit in the bit-band region. The bit-band regions occupy the lowest 1 MB of the SRAM and peripheral memory regions. Accesses to the 32-MB SRAM alias region map to the 1-MB SRAM bit-band region, as shown in Table 2-6 on page 78. Accesses to the 32-MB peripheral alias region map to the 1-MB peripheral bit-band

region, as shown in Table 2-7 on page 78. For the specific address range of the bit-band regions, see Table 2-4 on page 73.

Note: A word access to the SRAM or the peripheral bit-band alias region maps to a single bit in the SRAM or peripheral bit-band region.

A word access to a bit band address results in a word access to the underlying memory, and similarly for halfword and byte accesses. This allows bit band accesses to match the access requirements of the underlying peripheral.

Table 2-6. SRAM Memory Bit-Banding Regions

Address Range		Memory Region	Instruction and Data Accesses	
Start	End	Welliory Region	Instruction and Data Accesses	
0x2000.0000	0x2000.4FFF	SRAM bit-band region	Direct accesses to this memory range behave as SRAM memory accesses, but this region is also bit addressable through bit-band alias.	
0x2200.0000	0x2209.FFFF	SRAM bit-band alias	Data accesses to this region are remapped to bit band region. A write operation is performed as read-modify-write. Instruction accesses are not remapped.	

Table 2-7. Peripheral Memory Bit-Banding Regions

Address Range		Memory Region	Instruction and Data Accesses	
Start	End	Welliory Region	instruction and Data Accesses	
0x4000.0000	0x400F.FFFF		Direct accesses to this memory range behave as peripheral memory accesses, but this region is also bit addressable through bit-band alias.	
0x4200.0000	0x43FF.FFFF		Data accesses to this region are remapped to bit band region. A write operation is performed as read-modify-write. Instruction accesses are not permitted.	

The following formula shows how the alias region maps onto the bit-band region:

```
bit_word_offset = (byte_offset x 32) + (bit_number x 4)
bit_word_addr = bit_band_base + bit_word_offset
```

where:

bit word offset

The position of the target bit in the bit-band memory region.

bit word addr

The address of the word in the alias memory region that maps to the targeted bit.

bit_band_base

The starting address of the alias region.

byte offset

The number of the byte in the bit-band region that contains the targeted bit.

bit number

The bit position, 0-7, of the targeted bit.

Figure 2-4 on page 79 shows examples of bit-band mapping between the SRAM bit-band alias region and the SRAM bit-band region:

■ The alias word at 0x23FF.FFE0 maps to bit 0 of the bit-band byte at 0x200F.FFFF:

```
0x23FF.FFE0 = 0x2200.0000 + (0x000F.FFFF*32) + (0*4)
```

■ The alias word at 0x23FF.FFFC maps to bit 7 of the bit-band byte at 0x200F.FFFF:

```
0x23FF.FFFC = 0x2200.0000 + (0x000F.FFFF*32) + (7*4)
```

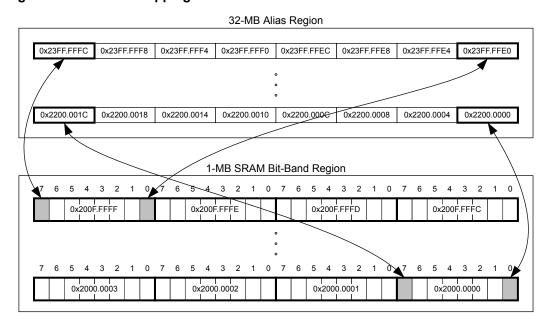
■ The alias word at 0x2200.0000 maps to bit 0 of the bit-band byte at 0x2000.0000:

```
0x2200.0000 = 0x2200.0000 + (0*32) + (0*4)
```

■ The alias word at 0x2200.001C maps to bit 7 of the bit-band byte at 0x2000.0000:

```
0x2200.001C = 0x2200.0000 + (0*32) + (7*4)
```

Figure 2-4. Bit-Band Mapping



2.4.5.1 Directly Accessing an Alias Region

Writing to a word in the alias region updates a single bit in the bit-band region.

Bit 0 of the value written to a word in the alias region determines the value written to the targeted bit in the bit-band region. Writing a value with bit 0 set writes a 1 to the bit-band bit, and writing a value with bit 0 clear writes a 0 to the bit-band bit.

Bits 31:1 of the alias word have no effect on the bit-band bit. Writing 0x01 has the same effect as writing 0xFF. Writing 0x00 has the same effect as writing 0x0E.

When reading a word in the alias region, 0x0000.0000 indicates that the targeted bit in the bit-band region is clear and 0x0000.0001 indicates that the targeted bit in the bit-band region is set.

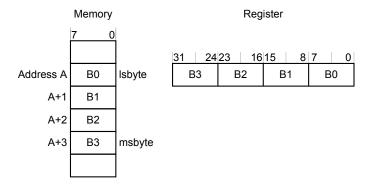
2.4.5.2 Directly Accessing a Bit-Band Region

"Behavior of Memory Accesses" on page 76 describes the behavior of direct byte, halfword, or word accesses to the bit-band regions.

2.4.6 Data Storage

The processor views memory as a linear collection of bytes numbered in ascending order from zero. For example, bytes 0-3 hold the first stored word, and bytes 4-7 hold the second stored word. Data is stored in little-endian format, with the least-significant byte (Isbyte) of a word stored at the lowest-numbered byte, and the most-significant byte (msbyte) stored at the highest-numbered byte. Figure 2-5 on page 80 illustrates how data is stored.

Figure 2-5. Data Storage



2.4.7 Synchronization Primitives

The Cortex-M3 instruction set includes pairs of synchronization primitives which provide a non-blocking mechanism that a thread or process can use to obtain exclusive access to a memory location. Software can use these primitives to perform a guaranteed read-modify-write memory update sequence or for a semaphore mechanism.

A pair of synchronization primitives consists of:

- A Load-Exclusive instruction, which is used to read the value of a memory location and requests exclusive access to that location.
- A Store-Exclusive instruction, which is used to attempt to write to the same memory location and returns a status bit to a register. If this status bit is clear, it indicates that the thread or process gained exclusive access to the memory and the write succeeds; if this status bit is set, it indicates that the thread or process did not gain exclusive access to the memory and no write was performed.

The pairs of Load-Exclusive and Store-Exclusive instructions are:

- The word instructions LDREX and STREX
- The halfword instructions LDREXH and STREXH
- The byte instructions LDREXB and STREXB

Software must use a Load-Exclusive instruction with the corresponding Store-Exclusive instruction.

To perform an exclusive read-modify-write of a memory location, software must:

- 1. Use a Load-Exclusive instruction to read the value of the location.
- **2.** Modify the value, as required.
- 3. Use a Store-Exclusive instruction to attempt to write the new value back to the memory location.
- **4.** Test the returned status bit.

If the status bit is clear, the read-modify-write completed successfully. If the status bit is set, no write was performed, which indicates that the value returned at step 1 might be out of date. The software must retry the entire read-modify-write sequence.

Software can use the synchronization primitives to implement a semaphore as follows:

- 1. Use a Load-Exclusive instruction to read from the semaphore address to check whether the semaphore is free.
- 2. If the semaphore is free, use a Store-Exclusive to write the claim value to the semaphore address.
- **3.** If the returned status bit from step 2 indicates that the Store-Exclusive succeeded, then the software has claimed the semaphore. However, if the Store-Exclusive failed, another process might have claimed the semaphore after the software performed step 1.

The Cortex-M3 includes an exclusive access monitor that tags the fact that the processor has executed a Load-Exclusive instruction. The processor removes its exclusive access tag if:

- It executes a CLREX instruction.
- It executes a Store-Exclusive instruction, regardless of whether the write succeeds.
- An exception occurs, which means the processor can resolve semaphore conflicts between different threads.

For more information about the synchronization primitive instructions, see the *Cortex™-M3/M4 Instruction Set Technical User's Manual*.

2.5 Exception Model

The ARM Cortex-M3 processor and the Nested Vectored Interrupt Controller (NVIC) prioritize and handle all exceptions in Handler Mode. The processor state is automatically stored to the stack on an exception and automatically restored from the stack at the end of the Interrupt Service Routine (ISR). The vector is fetched in parallel to the state saving, enabling efficient interrupt entry. The processor supports tail-chaining, which enables back-to-back interrupts to be performed without the overhead of state saving and restoration.

Table 2-8 on page 84 lists all exception types. Software can set eight priority levels on seven of these exceptions (system handlers) as well as on 34 interrupts (listed in Table 2-9 on page 84).

Priorities on the system handlers are set with the NVIC **System Handler Priority n (SYSPRIn)** registers. Interrupts are enabled through the NVIC **Interrupt Set Enable n (ENn)** register and prioritized with the NVIC **Interrupt Priority n (PRIn)** registers. Priorities can be grouped by splitting

priority levels into preemption priorities and subpriorities. All the interrupt registers are described in "Nested Vectored Interrupt Controller (NVIC)" on page 97.

Internally, the highest user-programmable priority (0) is treated as fourth priority, after a Reset, Non-Maskable Interrupt (NMI), and a Hard Fault, in that order. Note that 0 is the default priority for all the programmable priorities.

Important: After a write to clear an interrupt source, it may take several processor cycles for the NVIC to see the interrupt source de-assert. Thus if the interrupt clear is done as the last action in an interrupt handler, it is possible for the interrupt handler to complete while the NVIC sees the interrupt as still asserted, causing the interrupt handler to be re-entered errantly. This situation can be avoided by either clearing the interrupt source at the beginning of the interrupt handler or by performing a read or write after the write to clear the interrupt source (and flush the write buffer).

See "Nested Vectored Interrupt Controller (NVIC)" on page 97 for more information on exceptions and interrupts.

2.5.1 Exception States

Each exception is in one of the following states:

- Inactive. The exception is not active and not pending.
- **Pending.** The exception is waiting to be serviced by the processor. An interrupt request from a peripheral or from software can change the state of the corresponding interrupt to pending.
- Active. An exception that is being serviced by the processor but has not completed.

Note: An exception handler can interrupt the execution of another exception handler. In this case, both exceptions are in the active state.

■ **Active and Pending.** The exception is being serviced by the processor, and there is a pending exception from the same source.

2.5.2 Exception Types

The exception types are:

- Reset. Reset is invoked on power up or a warm reset. The exception model treats reset as a special form of exception. When reset is asserted, the operation of the processor stops, potentially at any point in an instruction. When reset is deasserted, execution restarts from the address provided by the reset entry in the vector table. Execution restarts as privileged execution in Thread mode.
- NMI. A non-maskable Interrupt (NMI) can be signaled using the NMI signal or triggered by software using the Interrupt Control and State (INTCTRL) register. This exception has the highest priority other than reset. NMI is permanently enabled and has a fixed priority of -2. NMIs cannot be masked or prevented from activation by any other exception or preempted by any exception other than reset.
- Hard Fault. A hard fault is an exception that occurs because of an error during exception processing, or because an exception cannot be managed by any other exception mechanism. Hard faults have a fixed priority of -1, meaning they have higher priority than any exception with configurable priority.

- Memory Management Fault. A memory management fault is an exception that occurs because of a memory protection related fault, including access violation and no match. The MPU or the fixed memory protection constraints determine this fault, for both instruction and data memory transactions. This fault is used to abort instruction accesses to Execute Never (XN) memory regions, even if the MPU is disabled.
- **Bus Fault.** A bus fault is an exception that occurs because of a memory-related fault for an instruction or data memory transaction such as a prefetch fault or a memory access fault. This fault can be enabled or disabled.
- **Usage Fault.** A usage fault is an exception that occurs because of a fault related to instruction execution, such as:
 - An undefined instruction
 - An illegal unaligned access
 - Invalid state on instruction execution
 - An error on exception return

An unaligned address on a word or halfword memory access or division by zero can cause a usage fault when the core is properly configured.

- **SVCall.** A supervisor call (SVC) is an exception that is triggered by the SVC instruction. In an OS environment, applications can use SVC instructions to access OS kernel functions and device drivers.
- **Debug Monitor.** This exception is caused by the debug monitor (when not halting). This exception is only active when enabled. This exception does not activate if it is a lower priority than the current activation.
- **PendSV.** PendSV is a pendable, interrupt-driven request for system-level service. In an OS environment, use PendSV for context switching when no other exception is active. PendSV is triggered using the **Interrupt Control and State (INTCTRL)** register.
- SysTick. A SysTick exception is an exception that the system timer generates when it reaches zero when it is enabled to generate an interrupt. Software can also generate a SysTick exception using the Interrupt Control and State (INTCTRL) register. In an OS environment, the processor can use this exception as system tick.
- Interrupt (IRQ). An interrupt, or IRQ, is an exception signaled by a peripheral or generated by a software request and fed through the NVIC (prioritized). All interrupts are asynchronous to instruction execution. In the system, peripherals use interrupts to communicate with the processor. Table 2-9 on page 84 lists the interrupts on the LM3S1J11 controller.

For an asynchronous exception, other than reset, the processor can execute another instruction between when the exception is triggered and when the processor enters the exception handler.

Privileged software can disable the exceptions that Table 2-8 on page 84 shows as having configurable priority (see the **SYSHNDCTRL** register on page 140 and the **DIS0** register on page 113).

For more information about hard faults, memory management faults, bus faults, and usage faults, see "Fault Handling" on page 89.

Table 2-8. Exception Types

Exception Type	Vector Number	Priority ^a	Vector Address or Offset ^b	Activation
-	0	-	0x0000.0000	Stack top is loaded from the first entry of the vector table on reset.
Reset	1	-3 (highest)	0x0000.0004	Asynchronous
Non-Maskable Interrupt (NMI)	2	-2	0x0000.0008	Asynchronous
Hard Fault	3	-1	0x0000.000C	-
Memory Management	4	programmable ^c	0x0000.0010	Synchronous
Bus Fault	5	programmable ^c	0x0000.0014	Synchronous when precise and asynchronous when imprecise
Usage Fault	6	programmable ^c	0x0000.0018	Synchronous
-	7-10	-	-	Reserved
SVCall	11	programmable ^c	0x0000.002C	Synchronous
Debug Monitor	12	programmable ^c	0x0000.0030	Synchronous
-	13	-	-	Reserved
PendSV	14	programmable ^c	0x0000.0038	Asynchronous
SysTick	15	programmable ^c	0x0000.003C	Asynchronous
Interrupts	16 and above	programmable ^d	0x0000.0040 and above	Asynchronous

a. 0 is the default priority for all the programmable priorities.

Table 2-9. Interrupts

Vector Number	Interrupt Number (Bit in Interrupt Registers)	Vector Address or Offset	Description
0-15	-	0x0000.0000 - 0x0000.003C	Processor exceptions
16	0	0x0000.0040	GPIO Port A
17	1	0x0000.0044	GPIO Port B
18	2	0x0000.0048	GPIO Port C
19	3	0x0000.004C	GPIO Port D
20	4	0x0000.0050	GPIO Port E
21	5	0x0000.0054	UART0
22	6	0x0000.0058	UART1
23	7	0x0000.005C	SSI0
24	8	0x0000.0060	I ² C0
25-29	9-13	-	Reserved
30	14	0x0000.0078	ADC0 Sequence 0
31	15	0x0000.007C	ADC0 Sequence 1
32	16	0x0000.0080	ADC0 Sequence 2
33	17	0x0000.0084	ADC0 Sequence 3
34	18	0x0000.0088	Watchdog Timers 0 and 1
35	19	0x0000.008C	Timer 0A

b. See "Vector Table" on page 85.

c. See SYSPRI1 on page 137.

d. See **PRIn** registers on page 121.

Table 2-9. Interrupts (continued)

Vector Number	Interrupt Number (Bit in Interrupt Registers)	Vector Address or Offset	Description
36	20	0x0000.0090	Timer 0B
37	21	0x0000.0094	Timer 1A
38	22	0x0000.0098	Timer 1B
39	23	0x0000.009C	Timer 2A
40	24	0x0000.00A0	Timer 2B
41	25	0x0000.00A4	Analog Comparator 0
42	26	0x0000.00A8	Analog Comparator 1
43	27	-	Reserved
44	28	0x0000.00B0	System Control
45	29	0x0000.00B4	Flash Memory Control
46	30	0x0000.00B8	GPIO Port F
47	31	0x0000.00BC	GPIO Port G
48	32	0x0000.00C0	GPIO Port H
49	33	0x0000.00C4	UART2
50	34	0x0000.00C8	SSI1
51-52	35-36	-	Reserved
53	37	0x0000.00D4	I ² C1
54-58	38-42	-	Reserved
59	43	0x0000.00EC	Hibernation Module
60-61	44-45	-	Reserved
62	46	0x0000.00F8	μDMA Software
63	47	0x0000.00FC	μDMA Error
64-69	48-53	-	Reserved
70	54	0x0000.0118	GPIO Port J

2.5.3 Exception Handlers

The processor handles exceptions using:

- Interrupt Service Routines (ISRs). Interrupts (IRQx) are the exceptions handled by ISRs.
- Fault Handlers. Hard fault, memory management fault, usage fault, and bus fault are fault exceptions handled by the fault handlers.
- **System Handlers.** NMI, PendSV, SVCall, SysTick, and the fault exceptions are all system exceptions that are handled by system handlers.

2.5.4 Vector Table

The vector table contains the reset value of the stack pointer and the start addresses, also called exception vectors, for all exception handlers. The vector table is constructed using the vector address or offset shown in Table 2-8 on page 84. Figure 2-6 on page 86 shows the order of the exception vectors in the vector table. The least-significant bit of each vector must be 1, indicating that the exception handler is Thumb code

Figure 2-6. Vector Table

Exception number	IRQ number	Offset	Vector
70	54	0v0118	IRQ54
18 17 16 15 14 13 12 11 10 9	2 1 0 -1 -2	0x00118 0x004C 0x0048 0x0044 0x0040 0x003C 0x003S	IRQ2 IRQ1 IRQ0 Systick PendSV Reserved Reserved for Debug SVCall
7 6 5 4 3 2	-10 -11 -12 -13 -14	0x0018 0x0014 0x0010 0x000C 0x0008 0x0004 0x0000	Usage fault Bus fault Memory management fault Hard fault NMI Reset Initial SP value

On system reset, the vector table is fixed at address 0x0000.0000. Privileged software can write to the **Vector Table Offset (VTABLE)** register to relocate the vector table start address to a different memory location, in the range 0x0000.0200 to 0x3FFF.FE00 (see "Vector Table" on page 85). Note that when configuring the **VTABLE** register, the offset must be aligned on a 512-byte boundary.

2.5.5 Exception Priorities

As Table 2-8 on page 84 shows, all exceptions have an associated priority, with a lower priority value indicating a higher priority and configurable priorities for all exceptions except Reset, Hard fault, and NMI. If software does not configure any priorities, then all exceptions with a configurable priority have a priority of 0. For information about configuring exception priorities, see page 137 and page 121.

Note: Configurable priority values for the Stellaris implementation are in the range 0-7. This means that the Reset, Hard fault, and NMI exceptions, with fixed negative priority values, always have higher priority than any other exception.

For example, assigning a higher priority value to IRQ[0] and a lower priority value to IRQ[1] means that IRQ[1] has higher priority than IRQ[0]. If both IRQ[1] and IRQ[0] are asserted, IRQ[1] is processed before IRQ[0].

If multiple pending exceptions have the same priority, the pending exception with the lowest exception number takes precedence. For example, if both IRQ[0] and IRQ[1] are pending and have the same priority, then IRQ[0] is processed before IRQ[1].

When the processor is executing an exception handler, the exception handler is preempted if a higher priority exception occurs. If an exception occurs with the same priority as the exception being handled, the handler is not preempted, irrespective of the exception number. However, the status of the new interrupt changes to pending.

2.5.6 Interrupt Priority Grouping

To increase priority control in systems with interrupts, the NVIC supports priority grouping. This grouping divides each interrupt priority register entry into two fields:

- An upper field that defines the group priority
- A lower field that defines a subpriority within the group

Only the group priority determines preemption of interrupt exceptions. When the processor is executing an interrupt exception handler, another interrupt with the same group priority as the interrupt being handled does not preempt the handler.

If multiple pending interrupts have the same group priority, the subpriority field determines the order in which they are processed. If multiple pending interrupts have the same group priority and subpriority, the interrupt with the lowest IRQ number is processed first.

For information about splitting the interrupt priority fields into group priority and subpriority, see page 131.

2.5.7 Exception Entry and Return

Descriptions of exception handling use the following terms:

- **Preemption.** When the processor is executing an exception handler, an exception can preempt the exception handler if its priority is higher than the priority of the exception being handled. See "Interrupt Priority Grouping" on page 87 for more information about preemption by an interrupt. When one exception preempts another, the exceptions are called nested exceptions. See "Exception Entry" on page 88 more information.
- **Return.** Return occurs when the exception handler is completed, and there is no pending exception with sufficient priority to be serviced and the completed exception handler was not handling a late-arriving exception. The processor pops the stack and restores the processor state to the state it had before the interrupt occurred. See "Exception Return" on page 88 for more information.
- **Tail-Chaining.** This mechanism speeds up exception servicing. On completion of an exception handler, if there is a pending exception that meets the requirements for exception entry, the stack pop is skipped and control transfers to the new exception handler.
- Late-Arriving. This mechanism speeds up preemption. If a higher priority exception occurs during state saving for a previous exception, the processor switches to handle the higher priority exception and initiates the vector fetch for that exception. State saving is not affected by late arrival because the state saved is the same for both exceptions. Therefore, the state saving continues uninterrupted. The processor can accept a late arriving exception until the first instruction of the exception handler of the original exception enters the execute stage of the processor. On

return from the exception handler of the late-arriving exception, the normal tail-chaining rules apply.

2.5.7.1 Exception Entry

Exception entry occurs when there is a pending exception with sufficient priority and either the processor is in Thread mode or the new exception is of higher priority than the exception being handled, in which case the new exception preempts the original exception.

When one exception preempts another, the exceptions are nested.

Sufficient priority means the exception has more priority than any limits set by the mask registers (see **PRIMASK** on page 69, **FAULTMASK** on page 70, and **BASEPRI** on page 71). An exception with less priority than this is pending but is not handled by the processor.

When the processor takes an exception, unless the exception is a tail-chained or a late-arriving exception, the processor pushes information onto the current stack. This operation is referred to as *stacking* and the structure of eight data words is referred to as *stack frame*.

R12
R3
R2
R1
R0
IRQ top of stack

Figure 2-7. Exception Stack Frame

Immediately after stacking, the stack pointer indicates the lowest address in the stack frame.

The stack frame includes the return address, which is the address of the next instruction in the interrupted program. This value is restored to the **PC** at exception return so that the interrupted program resumes.

In parallel to the stacking operation, the processor performs a vector fetch that reads the exception handler start address from the vector table. When stacking is complete, the processor starts executing the exception handler. At the same time, the processor writes an EXC_RETURN value to the **LR**, indicating which stack pointer corresponds to the stack frame and what operation mode the processor was in before the entry occurred.

If no higher-priority exception occurs during exception entry, the processor starts executing the exception handler and automatically changes the status of the corresponding pending interrupt to active.

If another higher-priority exception occurs during exception entry, known as late arrival, the processor starts executing the exception handler for this exception and does not change the pending status of the earlier exception.

2.5.7.2 Exception Return

Exception return occurs when the processor is in Handler mode and executes one of the following instructions to load the EXC RETURN value into the **PC**:

■ An LDM or POP instruction that loads the PC

- A BX instruction using any register
- An LDR instruction with the PC as the destination

EXC_RETURN is the value loaded into the **LR** on exception entry. The exception mechanism relies on this value to detect when the processor has completed an exception handler. The lowest four bits of this value provide information on the return stack and processor mode. Table 2-10 on page 89 shows the EXC_RETURN values with a description of the exception return behavior.

EXC_RETURN bits 31:4 are all set. When this value is loaded into the **PC**, it indicates to the processor that the exception is complete, and the processor initiates the appropriate exception return sequence.

Table 2-10. Exception Return Behavior

EXC_RETURN[31:0]	Description
0xFFFF.FFF0	Reserved
0xFFFF.FFF1	Return to Handler mode.
	Exception return uses state from MSP.
	Execution uses MSP after return.
0xFFFF.FFF2 - 0xFFFF.FFF8	Reserved
0xFFFF.FFF9	Return to Thread mode.
	Exception return uses state from MSP.
	Execution uses MSP after return.
0xFFFF.FFFA - 0xFFFF.FFFC	Reserved
0xFFFF.FFFD	Return to Thread mode.
	Exception return uses state from PSP.
	Execution uses PSP after return.
0xFFFF.FFFE - 0xFFFF.FFFF	Reserved

2.6 Fault Handling

Faults are a subset of the exceptions (see "Exception Model" on page 81). The following conditions generate a fault:

- A bus error on an instruction fetch or vector table load or a data access.
- An internally detected error such as an undefined instruction or an attempt to change state with a BX instruction.
- Attempting to execute an instruction from a memory region marked as Non-Executable (XN).
- An MPU fault because of a privilege violation or an attempt to access an unmanaged region.

2.6.1 Fault Types

Table 2-11 on page 89 shows the types of fault, the handler used for the fault, the corresponding fault status register, and the register bit that indicates the fault has occurred. See page 144 for more information about the fault status registers.

Table 2-11. Faults

Fault	Handler	Fault Status Register	Bit Name
Bus error on a vector read	Hard fault	Hard Fault Status (HFAULTSTAT)	VECT

Table 2-11. Faults (continued)

Fault	Handler	Fault Status Register	Bit Name
Fault escalated to a hard fault	Hard fault	Hard Fault Status (HFAULTSTAT)	FORCED
MPU or default memory mismatch on instruction access	Memory management fault	Memory Management Fault Status (MFAULTSTAT)	IERR ^a
MPU or default memory mismatch on data access	Memory management fault	Memory Management Fault Status (MFAULTSTAT)	DERR
MPU or default memory mismatch on exception stacking	Memory management fault	Memory Management Fault Status (MFAULTSTAT)	MSTKE
MPU or default memory mismatch on exception unstacking	Memory management fault	Memory Management Fault Status (MFAULTSTAT)	MUSTKE
Bus error during exception stacking	Bus fault	Bus Fault Status (BFAULTSTAT)	BSTKE
Bus error during exception unstacking	Bus fault	Bus Fault Status (BFAULTSTAT)	BUSTKE
Bus error during instruction prefetch	Bus fault	Bus Fault Status (BFAULTSTAT)	IBUS
Precise data bus error	Bus fault	Bus Fault Status (BFAULTSTAT)	PRECISE
Imprecise data bus error	Bus fault	Bus Fault Status (BFAULTSTAT)	IMPRE
Attempt to access a coprocessor	Usage fault	Usage Fault Status (UFAULTSTAT)	NOCP
Undefined instruction	Usage fault	Usage Fault Status (UFAULTSTAT)	UNDEF
Attempt to enter an invalid instruction set state ^b	Usage fault	Usage Fault Status (UFAULTSTAT)	INVSTAT
Invalid EXC_RETURN value	Usage fault	Usage Fault Status (UFAULTSTAT)	INVPC
Illegal unaligned load or store	Usage fault	Usage Fault Status (UFAULTSTAT)	UNALIGN
Divide by 0	Usage fault	Usage Fault Status (UFAULTSTAT)	DIV0

a. Occurs on an access to an XN region even if the MPU is disabled.

2.6.2 Fault Escalation and Hard Faults

All fault exceptions except for hard fault have configurable exception priority (see **SYSPRI1** on page 137). Software can disable execution of the handlers for these faults (see **SYSHNDCTRL** on page 140).

Usually, the exception priority, together with the values of the exception mask registers, determines whether the processor enters the fault handler, and whether a fault handler can preempt another fault handler as described in "Exception Model" on page 81.

In some situations, a fault with configurable priority is treated as a hard fault. This process is called priority escalation, and the fault is described as *escalated to hard fault*. Escalation to hard fault occurs when:

- A fault handler causes the same kind of fault as the one it is servicing. This escalation to hard fault occurs because a fault handler cannot preempt itself because it must have the same priority as the current priority level.
- A fault handler causes a fault with the same or lower priority as the fault it is servicing. This situation happens because the handler for the new fault cannot preempt the currently executing fault handler.
- An exception handler causes a fault for which the priority is the same as or lower than the currently executing exception.

b. Attempting to use an instruction set other than the Thumb instruction set, or returning to a non load-store-multiple instruction with ICI continuation.

■ A fault occurs and the handler for that fault is not enabled.

If a bus fault occurs during a stack push when entering a bus fault handler, the bus fault does not escalate to a hard fault. Thus if a corrupted stack causes a fault, the fault handler executes even though the stack push for the handler failed. The fault handler operates but the stack contents are corrupted.

Note: Only Reset and NMI can preempt the fixed priority hard fault. A hard fault can preempt any exception other than Reset, NMI, or another hard fault.

2.6.3 Fault Status Registers and Fault Address Registers

The fault status registers indicate the cause of a fault. For bus faults and memory management faults, the fault address register indicates the address accessed by the operation that caused the fault, as shown in Table 2-12 on page 91.

Table 2-12. Fault Status and Fault Address Registers

Handler	Status Register Name	Address Register Name	Register Description
Hard fault	Hard Fault Status (HFAULTSTAT)	-	page 150
Memory management	Memory Management Fault Status	Memory Management Fault	page 144
fault	(MFAULTSTAT)	Address (MMADDR)	page 151
Bus fault	Bus Fault Status (BFAULTSTAT)	Bus Fault Address	page 144
		(FAULTADDR)	page 152
Usage fault	Usage Fault Status (UFAULTSTAT)	-	page 144

2.6.4 Lockup

The processor enters a lockup state if a hard fault occurs when executing the NMI or hard fault handlers. When the processor is in the lockup state, it does not execute any instructions. The processor remains in lockup state until it is reset, an NMI occurs, or it is halted by a debugger.

Note: If the lockup state occurs from the NMI handler, a subsequent NMI does not cause the processor to leave the lockup state.

2.7 Power Management

The Cortex-M3 processor sleep modes reduce power consumption:

- Sleep mode stops the processor clock.
- Deep-sleep mode stops the system clock and switches off the PLL and Flash memory.

The SLEEPDEEP bit of the **System Control (SYSCTRL)** register selects which sleep mode is used (see page 133). For more information about the behavior of the sleep modes, see "System Control" on page 188.

This section describes the mechanisms for entering sleep mode and the conditions for waking up from sleep mode, both of which apply to Sleep mode and Deep-sleep mode.

2.7.1 Entering Sleep Modes

This section describes the mechanisms software can use to put the processor into one of the sleep modes.

The system can generate spurious wake-up events, for example a debug operation wakes up the processor. Therefore, software must be able to put the processor back into sleep mode after such an event. A program might have an idle loop to put the processor back to sleep mode.

2.7.1.1 Wait for Interrupt

The wait for interrupt instruction, WFI, causes immediate entry to sleep mode unless the wake-up condition is true (see "Wake Up from WFI or Sleep-on-Exit" on page 92). When the processor executes a WFI instruction, it stops executing instructions and enters sleep mode. See the Cortex™-M3/M4 Instruction Set Technical User's Manual for more information.

2.7.1.2 Wait for Event

The wait for event instruction, WFE, causes entry to sleep mode conditional on the value of a one-bit event register. When the processor executes a WFE instruction, it checks the event register. If the register is 0, the processor stops executing instructions and enters sleep mode. If the register is 1, the processor clears the register and continues executing instructions without entering sleep mode.

If the event register is 1, the processor must not enter sleep mode on execution of a WFE instruction. Typically, this situation occurs if an SEV instruction has been executed. Software cannot access this register directly.

See the *Cortex*™-*M3/M4 Instruction Set Technical User's Manual* for more information.

2.7.1.3 Sleep-on-Exit

If the SLEEPEXIT bit of the **SYSCTRL** register is set, when the processor completes the execution of all exception handlers, it returns to Thread mode and immediately enters sleep mode. This mechanism can be used in applications that only require the processor to run when an exception occurs.

2.7.2 Wake Up from Sleep Mode

The conditions for the processor to wake up depend on the mechanism that cause it to enter sleep mode.

2.7.2.1 Wake Up from WFI or Sleep-on-Exit

Normally, the processor wakes up only when the NVIC detects an exception with sufficient priority to cause exception entry. Some embedded systems might have to execute system restore tasks after the processor wakes up and before executing an interrupt handler. Entry to the interrupt handler can be delayed by setting the PRIMASK bit and clearing the FAULTMASK bit. If an interrupt arrives that is enabled and has a higher priority than current exception priority, the processor wakes up but does not execute the interrupt handler until the processor clears PRIMASK. For more information about **PRIMASK** and **FAULTMASK**, see page 69 and page 70.

2.7.2.2 Wake Up from WFE

The processor wakes up if it detects an exception with sufficient priority to cause exception entry.

In addition, if the SEVONPEND bit in the **SYSCTRL** register is set, any new pending interrupt triggers an event and wakes up the processor, even if the interrupt is disabled or has insufficient priority to cause exception entry. For more information about **SYSCTRL**, see page 133.

2.8 Instruction Set Summary

The processor implements a version of the Thumb instruction set. Table 2-13 on page 93 lists the supported instructions.

Note: In Table 2-13 on page 93:

- Angle brackets, <>, enclose alternative forms of the operand
- Braces, {}, enclose optional operands
- The Operands column is not exhaustive
- Op2 is a flexible second operand that can be either a register or a constant
- Most instructions can use an optional condition code suffix

For more information on the instructions and operands, see the instruction descriptions in the *Cortex*™-*M3/M4 Instruction Set Technical User's Manual*.

Table 2-13. Cortex-M3 Instruction Summary

Mnemonic	Operands	Brief Description	Flags
ADC, ADCS	{Rd,} Rn, Op2	Add with carry	N,Z,C,V
ADD, ADDS	{Rd,} Rn, Op2	Add	N,Z,C,V
ADD, ADDW	{Rd,} Rn , #imm12	Add	N,Z,C,V
ADR	Rd, label	Load PC-relative address	-
AND, ANDS	{Rd,} Rn, Op2	Logical AND	N,Z,C
ASR, ASRS	Rd, Rm, <rs #n></rs #n>	Arithmetic shift right	N,Z,C
В	label	Branch	-
BFC	Rd, #lsb, #width	Bit field clear	-
BFI	Rd, Rn, #lsb, #width	Bit field insert	-
BIC, BICS	{Rd,} Rn, Op2	Bit clear	N,Z,C
BKPT	#imm	Breakpoint	-
BL	label	Branch with link	-
BLX	Rm	Branch indirect with link	-
BX	Rm	Branch indirect	-
CBNZ	Rn, label	Compare and branch if non-zero	-
CBZ	Rn, label	Rn, label Compare and branch if zero	
CLREX	-	Clear exclusive	-
CLZ	Rd, Rm	Count leading zeros -	
CMN	Rn, Op2	Compare negative N,Z	
CMP	Rn, Op2	Compare N,Z	
CPSID	i	Change processor state, disable interrupts	
CPSIE	i	Change processor state, enable interrupts	
DMB	-	Data memory barrier -	
DSB	-	Data synchronization barrier -	
EOR, EORS	{Rd,} Rn, Op2	Exclusive OR N,Z,C	
ISB	-	Instruction synchronization barrier	-
IT	-	If-Then condition block	-

Table 2-13. Cortex-M3 Instruction Summary (continued)

Mnemonic	Operands	Brief Description	Flags
LDM	Rn{!}, reglist	Load multiple registers, increment after	-
LDMDB, LDMEA	Rn{!}, reglist	Load multiple registers, decrement before	-
LDMFD, LDMIA	Rn{!}, reglist	Rn{!}, reglist Load multiple registers, increment after	
LDR	Rt, [Rn, #offset]	Load register with word	-
LDRB, LDRBT	Rt, [Rn, #offset]	Load register with byte	-
LDRD	Rt, Rt2, [Rn, #offset]	Load register with two bytes	-
LDREX	Rt, [Rn, #offset]	Load register exclusive	-
LDREXB	Rt, [Rn]	Load register exclusive with byte	-
LDREXH	Rt, [Rn]	Load register exclusive with halfword	-
LDRH, LDRHT	Rt, [Rn, #offset]	Load register with halfword	-
LDRSB, LDRSBT	Rt, [Rn, #offset]	Load register with signed byte	-
LDRSH, LDRSHT	Rt, [Rn, #offset]	Load register with signed halfword	-
LDRT	Rt, [Rn, #offset]	Load register with word	-
LSL, LSLS	Rd, Rm, <rs #n></rs #n>	Logical shift left	N,Z,C
LSR, LSRS	Rd, Rm, <rs #n></rs #n>	Logical shift right	N,Z,C
MLA	Rd, Rn, Rm, Ra	Multiply with accumulate, 32-bit result	-
MLS	Rd, Rn, Rm, Ra	Multiply and subtract, 32-bit result	-
MOV, MOVS	Rd, Op2	Move N	
MOV, MOVW	Rd, #imm16	Move 16-bit constant	N,Z,C
MOVT	Rd, #imm16	Move top	-
MRS	Rd, spec_reg	Move from special register to general register	-
MSR	spec_reg, Rm	Move from general register to special register	N,Z,C,V
MUL, MULS	{Rd,} Rn, Rm	Multiply, 32-bit result	N,Z
MVN, MVNS	Rd, Op2	Move NOT	N,Z,C
NOP	-	No operation	-
ORN, ORNS	{Rd,} Rn, Op2	Logical OR NOT	N,Z,C
ORR, ORRS	{Rd,} Rn, Op2	Logical OR	N,Z,C
POP	reglist	Pop registers from stack	-
PUSH	reglist	Push registers onto stack	-
RBIT	Rd, Rn	Reverse bits	-
REV	Rd, Rn	Reverse byte order in a word	-
REV16	Rd, Rn	Reverse byte order in each halfword	
REVSH	Rd, Rn	Reverse byte order in bottom halfword and sign extend	-
ROR, RORS	Rd, Rm, <rs #n></rs #n>		
RRX, RRXS	Rd, Rm	Rotate right with extend	N,Z,C
RSB, RSBS	{Rd,} Rn, Op2	Reverse subtract	N,Z,C,V
SBC, SBCS	{Rd,} Rn, Op2	Subtract with carry	N,Z,C,V
SBFX	Rd, Rn, #lsb, #width	Signed bit field extract	-

Table 2-13. Cortex-M3 Instruction Summary (continued)

Mnemonic	Operands	Brief Description	Flags
SDIV	{Rd,} Rn, Rm	Signed divide	-
SEV	-	Send event	-
SMLAL	RdLo, RdHi, Rn, Rm	Signed multiply with accumulate (32x32+64), 64-bit result	-
SMULL	RdLo, RdHi, Rn, Rm	Signed multiply (32x32), 64-bit result	-
SSAT	Rd, #n, Rm {,shift #s}	Signed saturate	Q
STM	Rn{!}, reglist	Store multiple registers, increment after	-
STMDB, STMEA	Rn{!}, reglist	Store multiple registers, decrement before	-
STMFD, STMIA	Rn{!}, reglist	Store multiple registers, increment after	-
STR	Rt, [Rn {, #offset}]	Store register word	-
STRB, STRBT	Rt, [Rn {, #offset}]	Store register byte	-
STRD	Rt, Rt2, [Rn {, #offset}]	Store register two words	-
STREX	Rt, Rt, [Rn {, #offset}]	Store register exclusive	-
STREXB	Rd, Rt, [Rn]	Store register exclusive byte	-
STREXH	Rd, Rt, [Rn]	Store register exclusive halfword	-
STRH, STRHT	Rt, [Rn {, #offset}]	Store register halfword	-
STRSB, STRSBT	Rt, [Rn {, #offset}]	Store register signed byte	-
STRSH, STRSHT	Rt, [Rn {, #offset}]	Store register signed halfword	-
STRT	Rt, [Rn {, #offset}]	Store register word	-
SUB, SUBS	{Rd,} Rn, Op2	Subtract	N,Z,C,V
SUB, SUBW	{Rd,} Rn, #imm12	Subtract 12-bit constant	N,Z,C,V
SVC	#imm	Supervisor call	-
SXTB	{Rd,} Rm {,ROR #n}	Sign extend a byte	-
SXTH	{Rd,} Rm {,ROR #n}	Sign extend a halfword	-
TBB	[Rn, Rm]	Table branch byte	-
TBH	[Rn, Rm, LSL #1]	Table branch halfword	-
TEQ	Rn, Op2	Test equivalence	N,Z,C
TST	Rn, Op2	Test	N,Z,C
UBFX	Rd, Rn, #lsb, #width	Unsigned bit field extract	-
UDIV	{Rd,} Rn, Rm	Unsigned divide	-
UMLAL	RdLo, RdHi, Rn, Rm	Unsigned multiply with accumulate (32x32+32+32), 64-bit result	-
UMULL	RdLo, RdHi, Rn, Rm	Unsigned multiply (32x 2), 64-bit result	-
USAT	Rd, #n, Rm {,shift #s}	Unsigned Saturate	Q
UXTB	{Rd,} Rm, {,ROR #n}	Zero extend a Byte	-
UXTH	{Rd,} Rm, {,ROR #n}	Zero extend a Halfword	-
WFE	-	Wait for event	-
WFI	-	Wait for interrupt	-

3 Cortex-M3 Peripherals

This chapter provides information on the Stellaris[®] implementation of the Cortex-M3 processor peripherals, including:

SysTick (see page 96)

Provides a simple, 24-bit clear-on-write, decrementing, wrap-on-zero counter with a flexible control mechanism.

- Nested Vectored Interrupt Controller (NVIC) (see page 97)
 - Facilitates low-latency exception and interrupt handling
 - Controls power management
 - Implements system control registers
- System Control Block (SCB) (see page 99)

Provides system implementation information and system control, including configuration, control, and reporting of system exceptions.

■ Memory Protection Unit (MPU) (see page 99)

Supports the standard ARMv7 Protected Memory System Architecture (PMSA) model. The MPU provides full support for protection regions, overlapping protection regions, access permissions, and exporting memory attributes to the system.

Table 3-1 on page 96 shows the address map of the Private Peripheral Bus (PPB). Some peripheral register regions are split into two address regions, as indicated by two addresses listed.

Table 3-1. Core Peripheral Register Region	Γable 3-1. Core Pe⊦	ripheral Re	gister Regions
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Address	Core Peripheral	Description (see page)
0xE000.E010-0xE000.E01F	System Timer	96
0xE000.E100-0xE000.E4EF	Nested Vectored Interrupt Controller	97
0xE000.EF00-0xE000.EF03		
0xE000.E008-0xE000.E00F	System Control Block	99
0xE000.ED00-0xE000.ED3F		
0xE000.ED90-0xE000.EDB8	Memory Protection Unit	99

3.1 Functional Description

This chapter provides information on the Stellaris implementation of the Cortex-M3 processor peripherals: SysTick, NVIC, SCB and MPU.

3.1.1 System Timer (SysTick)

Cortex-M3 includes an integrated system timer, SysTick, which provides a simple, 24-bit clear-on-write, decrementing, wrap-on-zero counter with a flexible control mechanism. The counter can be used in several different ways, for example as:

- An RTOS tick timer that fires at a programmable rate (for example, 100 Hz) and invokes a SysTick routine.
- A high-speed alarm timer using the system clock.

- A variable rate alarm or signal timer—the duration is range-dependent on the reference clock used and the dynamic range of the counter.
- A simple counter used to measure time to completion and time used.
- An internal clock source control based on missing/meeting durations. The COUNT bit in the STCTRL control and status register can be used to determine if an action completed within a set duration, as part of a dynamic clock management control loop.

The timer consists of three registers:

- SysTick Control and Status (STCTRL): A control and status counter to configure its clock, enable the counter, enable the SysTick interrupt, and determine counter status.
- SysTick Reload Value (STRELOAD): The reload value for the counter, used to provide the counter's wrap value.
- SysTick Current Value (STCURRENT): The current value of the counter.

When enabled, the timer counts down on each clock from the reload value to zero, reloads (wraps) to the value in the **STRELOAD** register on the next clock edge, then decrements on subsequent clocks. Clearing the **STRELOAD** register disables the counter on the next wrap. When the counter reaches zero, the COUNT status bit is set. The COUNT bit clears on reads.

Writing to the **STCURRENT** register clears the register and the COUNT status bit. The write does not trigger the SysTick exception logic. On a read, the current value is the value of the register at the time the register is accessed.

The SysTick counter runs on the system clock. If this clock signal is stopped for low power mode, the SysTick counter stops. Ensure software uses aligned word accesses to access the SysTick registers.

Note: When the processor is halted for debugging, the counter does not decrement.

3.1.2 Nested Vectored Interrupt Controller (NVIC)

This section describes the Nested Vectored Interrupt Controller (NVIC) and the registers it uses. The NVIC supports:

- 34 interrupts.
- A programmable priority level of 0-7 for each interrupt. A higher level corresponds to a lower priority, so level 0 is the highest interrupt priority.
- Low-latency exception and interrupt handling.
- Level and pulse detection of interrupt signals.
- Dynamic reprioritization of interrupts.
- Grouping of priority values into group priority and subpriority fields.
- Interrupt tail-chaining.
- An external Non-maskable interrupt (NMI).

The processor automatically stacks its state on exception entry and unstacks this state on exception exit, with no instruction overhead, providing low latency exception handling.

3.1.2.1 Level-Sensitive and Pulse Interrupts

The processor supports both level-sensitive and pulse interrupts. Pulse interrupts are also described as edge-triggered interrupts.

A level-sensitive interrupt is held asserted until the peripheral deasserts the interrupt signal. Typically this happens because the ISR accesses the peripheral, causing it to clear the interrupt request. A pulse interrupt is an interrupt signal sampled synchronously on the rising edge of the processor clock. To ensure the NVIC detects the interrupt, the peripheral must assert the interrupt signal for at least one clock cycle, during which the NVIC detects the pulse and latches the interrupt.

When the processor enters the ISR, it automatically removes the pending state from the interrupt (see "Hardware and Software Control of Interrupts" on page 98 for more information). For a level-sensitive interrupt, if the signal is not deasserted before the processor returns from the ISR, the interrupt becomes pending again, and the processor must execute its ISR again. As a result, the peripheral can hold the interrupt signal asserted until it no longer needs servicing.

3.1.2.2 Hardware and Software Control of Interrupts

The Cortex-M3 latches all interrupts. A peripheral interrupt becomes pending for one of the following reasons:

- The NVIC detects that the interrupt signal is High and the interrupt is not active.
- The NVIC detects a rising edge on the interrupt signal.
- Software writes to the corresponding interrupt set-pending register bit, or to the **Software Trigger Interrupt (SWTRIG)** register to make a Software-Generated Interrupt pending. See the INT bit in the **PEND0** register on page 115 or **SWTRIG** on page 123.

A pending interrupt remains pending until one of the following:

- The processor enters the ISR for the interrupt, changing the state of the interrupt from pending to active. Then:
 - For a level-sensitive interrupt, when the processor returns from the ISR, the NVIC samples
 the interrupt signal. If the signal is asserted, the state of the interrupt changes to pending,
 which might cause the processor to immediately re-enter the ISR. Otherwise, the state of the
 interrupt changes to inactive.
 - For a pulse interrupt, the NVIC continues to monitor the interrupt signal, and if this is pulsed
 the state of the interrupt changes to pending and active. In this case, when the processor
 returns from the ISR the state of the interrupt changes to pending, which might cause the
 processor to immediately re-enter the ISR.
 - If the interrupt signal is not pulsed while the processor is in the ISR, when the processor returns from the ISR the state of the interrupt changes to inactive.
- Software writes to the corresponding interrupt clear-pending register bit
 - For a level-sensitive interrupt, if the interrupt signal is still asserted, the state of the interrupt does not change. Otherwise, the state of the interrupt changes to inactive.

For a pulse interrupt, the state of the interrupt changes to inactive, if the state was pending
or to active, if the state was active and pending.

3.1.3 System Control Block (SCB)

The System Control Block (SCB) provides system implementation information and system control, including configuration, control, and reporting of the system exceptions.

3.1.4 Memory Protection Unit (MPU)

This section describes the Memory protection unit (MPU). The MPU divides the memory map into a number of regions and defines the location, size, access permissions, and memory attributes of each region. The MPU supports independent attribute settings for each region, overlapping regions, and export of memory attributes to the system.

The memory attributes affect the behavior of memory accesses to the region. The Cortex-M3 MPU defines eight separate memory regions, 0-7, and a background region.

When memory regions overlap, a memory access is affected by the attributes of the region with the highest number. For example, the attributes for region 7 take precedence over the attributes of any region that overlaps region 7.

The background region has the same memory access attributes as the default memory map, but is accessible from privileged software only.

The Cortex-M3 MPU memory map is unified, meaning that instruction accesses and data accesses have the same region settings.

If a program accesses a memory location that is prohibited by the MPU, the processor generates a memory management fault, causing a fault exception and possibly causing termination of the process in an OS environment. In an OS environment, the kernel can update the MPU region setting dynamically based on the process to be executed. Typically, an embedded OS uses the MPU for memory protection.

Configuration of MPU regions is based on memory types (see "Memory Regions, Types and Attributes" on page 75 for more information).

Table 3-2 on page 99 shows the possible MPU region attributes. See the section called "MPU Configuration for a Stellaris Microcontroller" on page 103 for guidelines for programming a microcontroller implementation.

Table 3-2. Memory Attributes Summary

Memory Type	Description
Strongly Ordered	All accesses to Strongly Ordered memory occur in program order.
Device	Memory-mapped peripherals
Normal	Normal memory

To avoid unexpected behavior, disable the interrupts before updating the attributes of a region that the interrupt handlers might access.

Ensure software uses aligned accesses of the correct size to access MPU registers:

- Except for the MPU Region Attribute and Size (MPUATTR) register, all MPU registers must be accessed with aligned word accesses.
- The MPUATTR register can be accessed with byte or aligned halfword or word accesses.

The processor does not support unaligned accesses to MPU registers.

When setting up the MPU, and if the MPU has previously been programmed, disable unused regions to prevent any previous region settings from affecting the new MPU setup.

3.1.4.1 Updating an MPU Region

To update the attributes for an MPU region, the MPU Region Number (MPUNUMBER), MPU Region Base Address (MPUBASE) and MPUATTR registers must be updated. Each register can be programmed separately or with a multiple-word write to program all of these registers. You can use the MPUBASEx and MPUATTRx aliases to program up to four regions simultaneously using an STM instruction.

Updating an MPU Region Using Separate Words

This example simple code configures one region:

Disable a region before writing new region settings to the MPU if you have previously enabled the region being changed. For example:

```
; R1 = region number
; R2 = size/enable
; R3 = attributes
; R4 = address
                        ; 0xE000ED98, MPU region number register ; Region Number
LDR R0,=MPUNUMBER
STR R1, [R0, #0x0]
BIC R2, R2, #1
                           ; Disable
STRH R2, [R0, #0x8]
STR R4, [R0, #0x4]
STRH R3, [R0, #0xA]
                           ; Region Size and Enable
                           ; Region Base Address
                           ; Region Attribute
ORR R2, #1
                            ; Enable
STRH R2, [R0, #0x8]
                           ; Region Size and Enable
```

Software must use memory barrier instructions:

- Before MPU setup, if there might be outstanding memory transfers, such as buffered writes, that might be affected by the change in MPU settings.
- After MPU setup, if it includes memory transfers that must use the new MPU settings.

However, memory barrier instructions are not required if the MPU setup process starts by entering an exception handler, or is followed by an exception return, because the exception entry and exception return mechanism cause memory barrier behavior.

Software does not need any memory barrier instructions during MPU setup, because it accesses the MPU through the Private Peripheral Bus (PPB), which is a Strongly Ordered memory region.

For example, if all of the memory access behavior is intended to take effect immediately after the programming sequence, then a DSB instruction and an ISB instruction should be used. A DSB is required after changing MPU settings, such as at the end of context switch. An ISB is required if the code that programs the MPU region or regions is entered using a branch or call. If the programming sequence is entered using a return from exception, or by taking an exception, then an ISB is not required.

Updating an MPU Region Using Multi-Word Writes

The MPU can be programmed directly using multi-word writes, depending how the information is divided. Consider the following reprogramming:

```
; R1 = region number
; R2 = address
; R3 = size, attributes in one
LDR R0, =MPUNUMBER ; 0xE000ED98, MPU region number register
STR R1, [R0, #0x0] ; Region Number
STR R2, [R0, #0x4] ; Region Base Address
STR R3, [R0, #0x8] ; Region Attribute, Size and Enable
```

An STM instruction can be used to optimize this:

```
; R1 = region number
; R2 = address
; R3 = size, attributes in one
LDR R0, =MPUNUMBER ; 0xE000ED98, MPU region number register
STM R0, {R1-R3} ; Region number, address, attribute, size and enable
```

This operation can be done in two words for pre-packed information, meaning that the **MPU Region Base Address (MPUBASE)** register (see page 157) contains the required region number and has the VALID bit set. This method can be used when the data is statically packed, for example in a boot loader:

Subregions

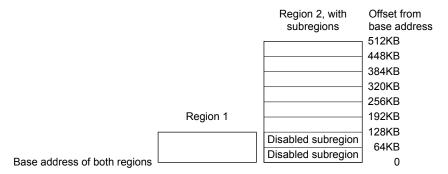
Regions of 256 bytes or more are divided into eight equal-sized subregions. Set the corresponding bit in the SRD field of the **MPU Region Attribute and Size (MPUATTR)** register (see page 159) to disable a subregion. The least-significant bit of the SRD field controls the first subregion, and the most-significant bit controls the last subregion. Disabling a subregion means another region overlapping the disabled range matches instead. If no other enabled region overlaps the disabled subregion, the MPU issues a fault.

Regions of 32, 64, and 128 bytes do not support subregions. With regions of these sizes, the SRD field must be configured to 0×0.0 , otherwise the MPU behavior is unpredictable.

Example of SRD Use

Two regions with the same base address overlap. Region one is 128 KB, and region two is 512 KB. To ensure the attributes from region one apply to the first 128 KB region, configure the SRD field for region two to 0x03 to disable the first two subregions, as Figure 3-1 on page 102 shows.

Figure 3-1. SRD Use Example



3.1.4.2 MPU Access Permission Attributes

The access permission bits, TEX, S, C, B, AP, and XN of the **MPUATTR** register, control access to the corresponding memory region. If an access is made to an area of memory without the required permissions, then the MPU generates a permission fault.

Table 3-3 on page 102 shows the encodings for the TEX, C, B, and S access permission bits. All encodings are shown for completeness, however the current implementation of the Cortex-M3 does not support the concept of cacheability or shareability. Refer to the section called "MPU Configuration for a Stellaris Microcontroller" on page 103 for information on programming the MPU for Stellaris implementations.

Table 3-3. TEX, S, C, and B Bit Field Encoding

TEX	S	С	В	Memory Type	Shareability	Other Attributes
000b	x ^a	0	0	Strongly Ordered	Shareable	-
000	x ^a	0	1	Device	Shareable	-
000	0	1	0	Normal	Not shareable	
000	1	1	0	Normal	Shareable	Outer and inner
000	0	1	1	Normal	Not shareable	write-through. No write allocate.
000	1	1	1	Normal	Shareable	
001	0	0	0	Normal	Not shareable	Outer and inner
001	1	0	0	Normal	Shareable	noncacheable.
001	x ^a	0	1	Reserved encoding	-	-
001	x ^a	1	0	Reserved encoding	-	-
001	0	1	1	Normal	Not shareable	Outer and inner
001	1	1	1	Normal	Shareable	write-back. Write and read allocate.
010	x ^a	0	0	Device	Not shareable	Nonshared Device.
010	x ^a	0	1	Reserved encoding	-	-
010	x ^a	1	x ^a	Reserved encoding	-	-

Table 3-3. TEX, S, C, and B Bit Field Encoding (continued)

TEX	S	С	В	Memory Type	Shareability	Other Attributes
1BB	0	Α	А	Normal	Not shareable	Cached memory (BB =
1BB	1	А	А	Normal	Shareable	outer policy, AA = inner policy).
						See Table 3-4 for the encoding of the AA and BB bits.

a. The MPU ignores the value of this bit.

Table 3-4 on page 103 shows the cache policy for memory attribute encodings with a TEX value in the range of 0x4-0x7.

Table 3-4. Cache Policy for Memory Attribute Encoding

Encoding, AA or BB	Corresponding Cache Policy
00	Non-cacheable
01	Write back, write and read allocate
10	Write through, no write allocate
11	Write back, no write allocate

Table 3-5 on page 103 shows the AP encodings in the **MPUATTR** register that define the access permissions for privileged and unprivileged software.

Table 3-5. AP Bit Field Encoding

AP Bit Field	Privileged Permissions	Unprivileged Permissions	Description
000	No access	No access	All accesses generate a permission fault.
001	R/W	No access	Access from privileged software only.
010	R/W	RO	Writes by unprivileged software generate a permission fault.
011	R/W	R/W	Full access.
100	Unpredictable	Unpredictable	Reserved.
101	RO	No access	Reads by privileged software only.
110	RO	RO	Read-only, by privileged or unprivileged software.
111	RO	RO	Read-only, by privileged or unprivileged software.

MPU Configuration for a Stellaris Microcontroller

Stellaris microcontrollers have only a single processor and no caches. As a result, the MPU should be programmed as shown in Table 3-6 on page 103.

Table 3-6. Memory Region Attributes for Stellaris Microcontrollers

Memory Region	TEX	S	С	В	Memory Type and Attributes
Flash memory	000b	0	1	0	Normal memory, non-shareable, write-through
Internal SRAM	000b	1	1	0	Normal memory, shareable, write-through
External SRAM	000b	1	1	1	Normal memory, shareable, write-back, write-allocate
Peripherals	000b	1	0	1	Device memory, shareable

In current Stellaris microcontroller implementations, the shareability and cache policy attributes do not affect the system behavior. However, using these settings for the MPU regions can make the application code more portable. The values given are for typical situations.

3.1.4.3 MPU Mismatch

When an access violates the MPU permissions, the processor generates a memory management fault (see "Exceptions and Interrupts" on page 73 for more information). The **MFAULTSTAT** register indicates the cause of the fault. See page 144 for more information.

3.2 Register Map

Table 3-7 on page 104 lists the Cortex-M3 Peripheral SysTick, NVIC, MPU and SCB registers. The offset listed is a hexadecimal increment to the register's address, relative to the Core Peripherals base address of 0xE000.E000.

Note: Register spaces that are not used are reserved for future or internal use. Software should not modify any reserved memory address.

Table 3-7. Peripherals Register Map

Offset	Name	Туре	Reset	Description	See page					
System Timer (SysTick) Registers										
0x010	STCTRL	R/W	0x0000.0004	SysTick Control and Status Register	107					
0x014	STRELOAD	R/W	0x0000.0000	SysTick Reload Value Register	109					
0x018	STCURRENT	R/WC	0x0000.0000	SysTick Current Value Register	110					
Nested V	ectored Interrupt Control	ler (NVIC)	Registers		<u> </u>					
0x100	EN0	R/W	0x0000.0000	Interrupt 0-31 Set Enable	111					
0x104	EN1	R/W	0x0000.0000	Interrupt 32-54 Set Enable	112					
0x180	DIS0	R/W	0x0000.0000	Interrupt 0-31 Clear Enable	113					
0x184	DIS1	R/W	0x0000.0000	Interrupt 32-54 Clear Enable	114					
0x200	PEND0	R/W	0x0000.0000	Interrupt 0-31 Set Pending	115					
0x204	PEND1	R/W	0x0000.0000	Interrupt 32-54 Set Pending	116					
0x280	UNPEND0	R/W	0x0000.0000	Interrupt 0-31 Clear Pending	117					
0x284	UNPEND1	R/W	0x0000.0000	Interrupt 32-54 Clear Pending	118					
0x300	ACTIVE0	RO	0x0000.0000	Interrupt 0-31 Active Bit	119					
0x304	ACTIVE1	RO	0x0000.0000	Interrupt 32-54 Active Bit	120					
0x400	PRI0	R/W	0x0000.0000	Interrupt 0-3 Priority	121					
0x404	PRI1	R/W	0x0000.0000	Interrupt 4-7 Priority	121					
0x408	PRI2	R/W	0x0000.0000	Interrupt 8-11 Priority	121					
0x40C	PRI3	R/W	0x0000.0000	Interrupt 12-15 Priority	121					
0x410	PRI4	R/W	0x0000.0000	Interrupt 16-19 Priority	121					

Table 3-7. Peripherals Register Map (continued)

Offset Name		me Type Rese		Description	See page
0x414	PRI5	R/W	0x0000.0000	Interrupt 20-23 Priority	121
0x418	PRI6	R/W	0x0000.0000	Interrupt 24-27 Priority	121
0x41C	PRI7	R/W	0x0000.0000	Interrupt 28-31 Priority	121
0x420	PRI8	R/W	0x0000.0000	Interrupt 32-35 Priority	121
0x424	PRI9	R/W	0x0000.0000	Interrupt 36-39 Priority	121
0x428	PRI10	R/W	0x0000.0000	Interrupt 40-43 Priority	121
0x42C	PRI11	R/W	0x0000.0000	Interrupt 44-47 Priority	121
0x430	PRI12	R/W	0x0000.0000	Interrupt 48-51 Priority	121
0x434	PRI13	R/W	0x0000.0000	Interrupt 52-54 Priority	121
0xF00	SWTRIG	WO	0x0000.0000	Software Trigger Interrupt	123
System C	ontrol Block (SCB) R	egisters			
800x0	ACTLR	R/W	0x0000.0000	Auxiliary Control	124
0xD00	CPUID	RO	0x412F.C230	CPU ID Base	126
0xD04	INTCTRL	R/W	0x0000.0000	Interrupt Control and State	127
0xD08	VTABLE	R/W	0x0000.0000	Vector Table Offset	130
0xD0C	APINT	R/W	0xFA05.0000	Application Interrupt and Reset Control	131
0xD10	SYSCTRL	R/W	0x0000.0000	System Control	133
0xD14	CFGCTRL	R/W	0x0000.0200	Configuration and Control	135
0xD18	SYSPRI1	R/W	0x0000.0000	System Handler Priority 1	137
0xD1C	SYSPRI2	R/W	0x0000.0000	System Handler Priority 2	138
0xD20	SYSPRI3	R/W	0x0000.0000	System Handler Priority 3	139
0xD24	SYSHNDCTRL	R/W	0x0000.0000	System Handler Control and State	140
0xD28	FAULTSTAT	R/W1C	0x0000.0000	Configurable Fault Status	144
0xD2C	HFAULTSTAT	R/W1C	0x0000.0000	Hard Fault Status	150
0xD34	MMADDR	R/W	-	Memory Management Fault Address	151
0xD38	FAULTADDR	R/W	-	Bus Fault Address	152
Memory I	Protection Unit (MPU)	Registers			
0xD90	MPUTYPE	RO	0x0000.0800	MPU Type	153
0xD94	MPUCTRL	R/W	0x0000.0000	MPU Control	154
0xD98	MPUNUMBER	R/W	0x0000.0000	MPU Region Number	156
0xD9C	MPUBASE	R/W	0x0000.0000	MPU Region Base Address	157
0xDA0	MPUATTR	R/W	0x0000.0000	MPU Region Attribute and Size	159

Table 3-7. Peripherals Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0xDA4	MPUBASE1	R/W	0x0000.0000	MPU Region Base Address Alias 1	157
0xDA8	MPUATTR1	R/W	0x0000.0000	MPU Region Attribute and Size Alias 1	159
0xDAC	MPUBASE2	R/W	0x0000.0000	MPU Region Base Address Alias 2	157
0xDB0	MPUATTR2	R/W	0x0000.0000	MPU Region Attribute and Size Alias 2	159
0xDB4	MPUBASE3	R/W	0x0000.0000	MPU Region Base Address Alias 3	157
0xDB8	MPUATTR3	R/W	0x0000.0000	MPU Region Attribute and Size Alias 3	159

3.3 System Timer (SysTick) Register Descriptions

This section lists and describes the System Timer registers, in numerical order by address offset.

Register 1: SysTick Control and Status Register (STCTRL), offset 0x010

Note: This register can only be accessed from privileged mode.

The SysTick **STCTRL** register enables the SysTick features.

SysTick Control and Status Register (STCTRL)

Base 0xE000.E000 Offset 0x010 Type R/W, reset 0x0000.0004

October 06, 2012

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
				•				reserved	i	•	'			' '		COUNT
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
[î .			reserved			1	î	ì		CLK_SRC	INTEN	ENABLE
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	R/W 1	R/W 0	R/W 0
В	it/Field		Nam	ne	Ту	ре	Reset	Des	cription							
	31:17		reserv	ved	R	0	0x000	O00 Software should not rely on the value of a compatibility with future products, the value preserved across a read-modify-write oper			value o	of a reserv				
	16		COU	NT	R	0	0	Cou	nt Flag							
								Value Description								
								O The SysTick timer has not counted to 0 since this bit was read.				nce the	ast time			
								1		,	sTick tim was rea		counted	to 0 since	e the las	st time
										eared by a		the regis	ster or if	the STCU	IRREN1	registe
								Mas the o Deb	terTyp COUNT b	e bit in the bit is not of the face V5 /	ne AHB- changed	AP Con by the c	trol Re glebugge	oit is cleare gister is co er read. Se n for more	lear. Ot	herwise N <i>RM</i> ®
	15:3		reserv	ved	R	0	0x000	Software should not rely on the value of a rese compatibility with future products, the value of preserved across a read-modify-write operatio		of a reserv						
	2		CLK_S	SRC	R/	W	1	Cloc	k Sourc	e						
								Valu	ue Desc	cription						
								0		rnal refe		ock. (Not	implem	nented for	most S	tellaris

System clock

be set in order for SysTick to operate.

Because an external reference clock is not implemented, this bit must

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Bit/Field	Name	Туре	Reset	Description			
1	INTEN	R/W	0	Interrupt Enable			
				Value	Description		
				0	Interrupt generation is disabled. Software can use the COUNT bit to determine if the counter has ever reached 0.		
				1	An interrupt is generated to the NVIC when SysTick counts to 0. $ \\$		
0	ENABLE	R/W	0	Enable			
				Value	Description		
				0	The counter is disabled.		
				1	Enables SysTick to operate in a multi-shot way. That is, the counter loads the RELOAD value and begins counting down. On reaching 0, the COUNT bit is set and an interrupt is generated if enabled by INTEN. The counter then loads the RELOAD value again and begins counting.		

Register 2: SysTick Reload Value Register (STRELOAD), offset 0x014

Note: This register can only be accessed from privileged mode.

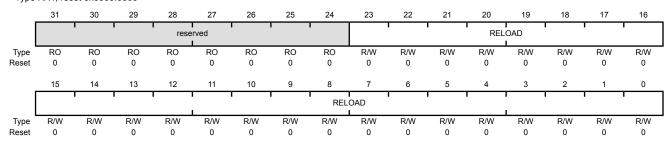
The **STRELOAD** register specifies the start value to load into the **SysTick Current Value** (**STCURRENT**) register when the counter reaches 0. The start value can be between 0x1 and 0x00FF.FFFF. A start value of 0 is possible but has no effect because the SysTick interrupt and the COUNT bit are activated when counting from 1 to 0.

SysTick can be configured as a multi-shot timer, repeated over and over, firing every N+1 clock pulses, where N is any value from 1 to 0x00FF.FFFF. For example, if a tick interrupt is required every 100 clock pulses, 99 must be written into the RELOAD field.

SysTick Reload Value Register (STRELOAD)

Base 0xE000.E000

Offset 0x014 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:24	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
23:0	RELOAD	R/W	0x00.0000	Reload Value

Value to load into the **SysTick Current Value (STCURRENT)** register when the counter reaches 0.

Register 3: SysTick Current Value Register (STCURRENT), offset 0x018

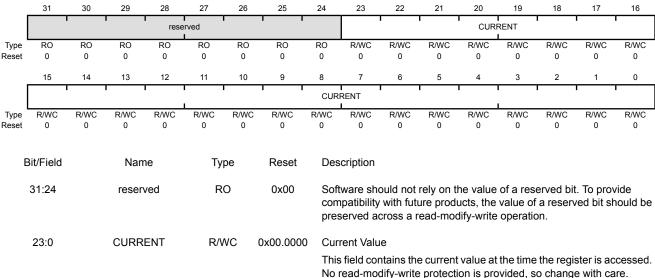
Note: This register can only be accessed from privileged mode.

The **STCURRENT** register contains the current value of the SysTick counter.

SysTick Current Value Register (STCURRENT)

Base 0xE000.E000 Offset 0x018

Type R/WC, reset 0x0000.0000



No read-modify-write protection is provided, so change with care.

This register is write-clear. Writing to it with any value clears the register.

Clearing this register also clears the COUNT bit of the **STCTRL** register.

3.4 NVIC Register Descriptions

This section lists and describes the NVIC registers, in numerical order by address offset.

The NVIC registers can only be fully accessed from privileged mode, but interrupts can be pended while in unprivileged mode by enabling the **Configuration and Control (CFGCTRL)** register. Any other unprivileged mode access causes a bus fault.

Ensure software uses correctly aligned register accesses. The processor does not support unaligned accesses to NVIC registers.

An interrupt can enter the pending state even if it is disabled.

Before programming the **VTABLE** register to relocate the vector table, ensure the vector table entries of the new vector table are set up for fault handlers, NMI, and all enabled exceptions such as interrupts. For more information, see page 130.

Register 4: Interrupt 0-31 Set Enable (EN0), offset 0x100

Note: This register can only be accessed from privileged mode.

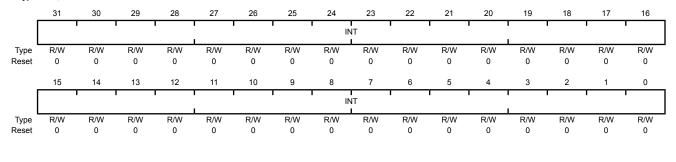
The **EN0** register enables interrupts and shows which interrupts are enabled. Bit 0 corresponds to Interrupt 0; bit 31 corresponds to Interrupt 31.

See Table 2-9 on page 84 for interrupt assignments.

If a pending interrupt is enabled, the NVIC activates the interrupt based on its priority. If an interrupt is not enabled, asserting its interrupt signal changes the interrupt state to pending, but the NVIC never activates the interrupt, regardless of its priority.

Interrupt 0-31 Set Enable (EN0)

Base 0xE000.E000 Offset 0x100 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:0	INT	R/W	0x0000.0000	Interrupt Enable

Value	Description
0	On a read, indicates the interrupt is disabled.
	On a write, no effect.
1	On a read, indicates the interrupt is enabled.
	On a write, enables the interrupt.

A bit can only be cleared by setting the corresponding ${\tt INT[n]}$ bit in the DISn register.

Register 5: Interrupt 32-54 Set Enable (EN1), offset 0x104

Note: This register can only be accessed from privileged mode.

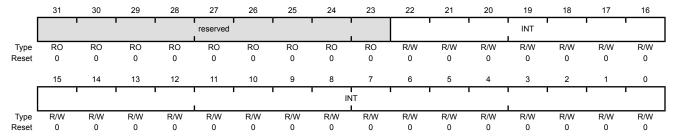
The **EN1** register enables interrupts and shows which interrupts are enabled. Bit 0 corresponds to Interrupt 32; bit 22 corresponds to Interrupt 54. See Table 2-9 on page 84 for interrupt assignments.

If a pending interrupt is enabled, the NVIC activates the interrupt based on its priority. If an interrupt is not enabled, asserting its interrupt signal changes the interrupt state to pending, but the NVIC never activates the interrupt, regardless of its priority.

Interrupt 32-54 Set Enable (EN1)

Base 0xE000.E000 Offset 0x104

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:23	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
22:0	INT	R/W	0x00.0000	Interrupt Enable

Value	Description
0	On a read, indicates the interrupt is disabled.
	On a write, no effect.
1	On a read, indicates the interrupt is enabled.
	On a write, enables the interrupt

A bit can only be cleared by setting the corresponding ${\tt INT[n]}$ bit in the **DIS1** register.

Register 6: Interrupt 0-31 Clear Enable (DIS0), offset 0x180

Note: This register can only be accessed from privileged mode.

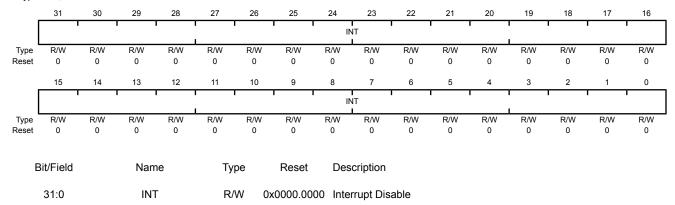
The **DIS0** register disables interrupts. Bit 0 corresponds to Interrupt 0; bit 31 corresponds to Interrupt 31.

See Table 2-9 on page 84 for interrupt assignments.

Interrupt 0-31 Clear Enable (DIS0)

Base 0xE000.E000 Offset 0x180

Type R/W, reset 0x0000.0000



Value Description

- On a read, indicates the interrupt is disabled.
 - On a write, no effect.
- 1 On a read, indicates the interrupt is enabled.

On a write, clears the corresponding INT[n] bit in the **EN0** register, disabling interrupt [n].

Register 7: Interrupt 32-54 Clear Enable (DIS1), offset 0x184

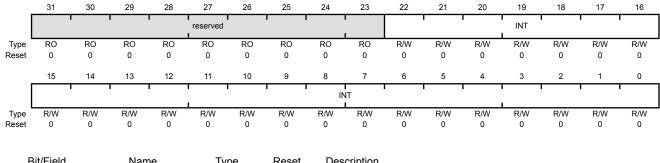
Note: This register can only be accessed from privileged mode.

The **DIS1** register disables interrupts. Bit 0 corresponds to Interrupt 32; bit 22 corresponds to Interrupt 54. See Table 2-9 on page 84 for interrupt assignments.

Interrupt 32-54 Clear Enable (DIS1)

Base 0xE000.E000

Offset 0x184
Type R/W, reset 0x0000.0000



Bit/Field	Name	туре	Reset	Description
31:23	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
22:0	INT	R/W	0x00.0000	Interrupt Disable

- On a read, indicates the interrupt is disabled. On a write, no effect.
 - On a read, indicates the interrupt is enabled.

Register 8: Interrupt 0-31 Set Pending (PEND0), offset 0x200

Note: This register can only be accessed from privileged mode.

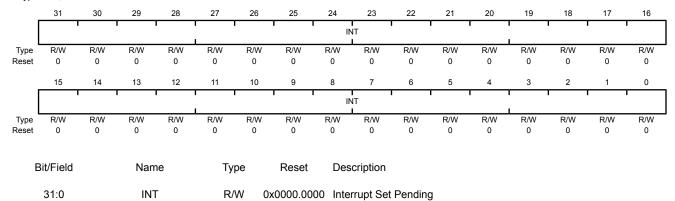
The **PEND0** register forces interrupts into the pending state and shows which interrupts are pending. Bit 0 corresponds to Interrupt 0; bit 31 corresponds to Interrupt 31.

See Table 2-9 on page 84 for interrupt assignments.

Interrupt 0-31 Set Pending (PEND0)

Base 0xE000.E000 Offset 0x200

Type R/W, reset 0x0000.0000



Value	Description
0	On a read, indicates that the interrupt is not pending.
	On a write, no effect.
1	On a read, indicates that the interrupt is pending.

On a write, the corresponding interrupt is set to pending even if it is disabled.

If the corresponding interrupt is already pending, setting a bit has no effect.

A bit can only be cleared by setting the corresponding ${\tt INT[n]}$ bit in the <code>UNPENDO</code> register.

Register 9: Interrupt 32-54 Set Pending (PEND1), offset 0x204

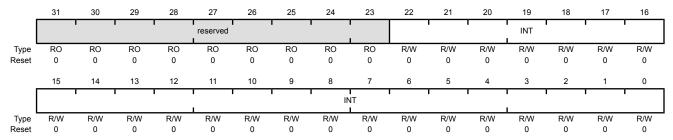
Note: This register can only be accessed from privileged mode.

The **PEND1** register forces interrupts into the pending state and shows which interrupts are pending. Bit 0 corresponds to Interrupt 32; bit 22 corresponds to Interrupt 54. See Table 2-9 on page 84 for interrupt assignments.

Interrupt 32-54 Set Pending (PEND1)

Base 0xE000.E000 Offset 0x204

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:23	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
22:0	INT	R/W	0x00.0000	Interrupt Set Pending

Value	Description
0	On a read, indicates that the interrupt is not pending.
	On a write, no effect.
1	On a read, indicates that the interrupt is pending.
	On a write, the corresponding interrupt is set to pending even if it is disabled.

If the corresponding interrupt is already pending, setting a bit has no effect.

A bit can only be cleared by setting the corresponding ${\tt INT[n]}$ bit in the UNPEND1 register.

Register 10: Interrupt 0-31 Clear Pending (UNPEND0), offset 0x280

Note: This register can only be accessed from privileged mode.

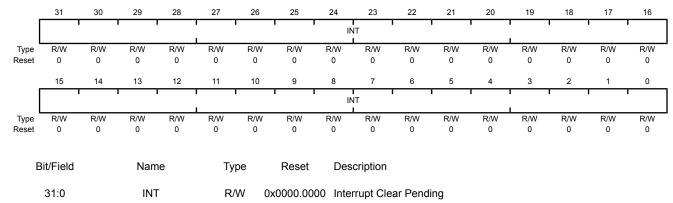
The **UNPEND0** register shows which interrupts are pending and removes the pending state from interrupts. Bit 0 corresponds to Interrupt 0; bit 31 corresponds to Interrupt 31.

See Table 2-9 on page 84 for interrupt assignments.

Interrupt 0-31 Clear Pending (UNPEND0)

Base 0xE000.E000 Offset 0x280

Type R/W, reset 0x0000.0000



- On a read, indicates that the interrupt is not pending.
 On a write, no effect.
- On a read, indicates that the interrupt is pending.

 On a write, clears the corresponding INT[n] bit in the **PEND0** register, so that interrupt [n] is no longer pending.

 Setting a bit does not affect the active state of the corresponding interrupt.

Register 11: Interrupt 32-54 Clear Pending (UNPEND1), offset 0x284

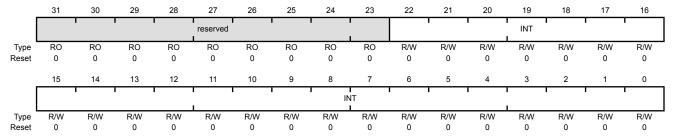
Note: This register can only be accessed from privileged mode.

The UNPEND1 register shows which interrupts are pending and removes the pending state from interrupts. Bit 0 corresponds to Interrupt 32; bit 22 corresponds to Interrupt 54. See Table 2-9 on page 84 for interrupt assignments.

Interrupt 32-54 Clear Pending (UNPEND1)

Base 0xE000.E000 Offset 0x284

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:23	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
22:0	INT	R/W	0x00.0000	Interrupt Clear Pending

- On a read, indicates that the interrupt is not pending. On a write, no effect.
- On a read, indicates that the interrupt is pending. 1 On a write, clears the corresponding INT[n] bit in the PEND1 register, so that interrupt [n] is no longer pending. Setting a bit does not affect the active state of the corresponding interrupt.

Register 12: Interrupt 0-31 Active Bit (ACTIVE0), offset 0x300

Note: This register can only be accessed from privileged mode.

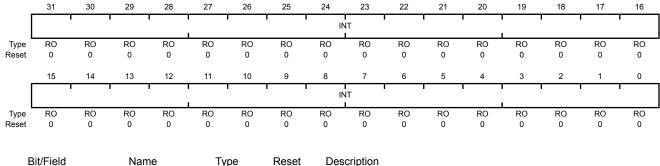
The ACTIVEO register indicates which interrupts are active. Bit 0 corresponds to Interrupt 0; bit 31 corresponds to Interrupt 31.

See Table 2-9 on page 84 for interrupt assignments.

Caution – Do not manually set or clear the bits in this register.

Interrupt 0-31 Active Bit (ACTIVE0)

Base 0xE000.E000 Offset 0x300 Type RO, reset 0x0000.0000



INT 31:0 RO 0x0000.0000 Interrupt Active

- 0 The corresponding interrupt is not active.
- The corresponding interrupt is active, or active and pending.

Register 13: Interrupt 32-54 Active Bit (ACTIVE1), offset 0x304

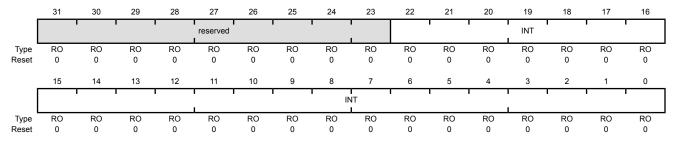
Note: This register can only be accessed from privileged mode.

The ACTIVE1 register indicates which interrupts are active. Bit 0 corresponds to Interrupt 32; bit 22 corresponds to Interrupt 54. See Table 2-9 on page 84 for interrupt assignments.

Caution – Do not manually set or clear the bits in this register.

Interrupt 32-54 Active Bit (ACTIVE1)

Base 0xE000.E000 Offset 0x304 Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:23	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
22:0	INT	RO	0x00.0000	Interrupt Active

- 0 The corresponding interrupt is not active.
- 1 The corresponding interrupt is active, or active and pending.

Register 14: Interrupt 0-3 Priority (PRI0), offset 0x400
Register 15: Interrupt 4-7 Priority (PRI1), offset 0x404
Register 16: Interrupt 8-11 Priority (PRI2), offset 0x408
Register 17: Interrupt 12-15 Priority (PRI3), offset 0x40C
Register 18: Interrupt 16-19 Priority (PRI4), offset 0x410
Register 19: Interrupt 20-23 Priority (PRI5), offset 0x414
Register 20: Interrupt 24-27 Priority (PRI6), offset 0x418
Register 21: Interrupt 28-31 Priority (PRI7), offset 0x41C
Register 22: Interrupt 32-35 Priority (PRI8), offset 0x420
Register 23: Interrupt 36-39 Priority (PRI9), offset 0x424
Register 24: Interrupt 40-43 Priority (PRI10), offset 0x428
Register 25: Interrupt 44-47 Priority (PRI11), offset 0x42C
Register 26: Interrupt 48-51 Priority (PRI12), offset 0x430
Register 27: Interrupt 52-54 Priority (PRI13), offset 0x434

Note: This register can only be accessed from privileged mode.

The **PRIn** registers provide 3-bit priority fields for each interrupt. These registers are byte accessible. Each register holds four priority fields that are assigned to interrupts as follows:

PRIn Register Bit Field	Interrupt
Bits 31:29	Interrupt [4n+3]
Bits 23:21	Interrupt [4n+2]
Bits 15:13	Interrupt [4n+1]
Bits 7:5	Interrupt [4n]

See Table 2-9 on page 84 for interrupt assignments.

Each priority level can be split into separate group priority and subpriority fields. The PRIGROUP field in the **Application Interrupt and Reset Control (APINT)** register (see page 131) indicates the position of the binary point that splits the priority and subpriority fields.

These registers can only be accessed from privileged mode.

Interrupt 0-3 Priority (PRI0)

Base 0xE000.E000 Offset 0x400 Type R/W, reset 0x0000.0000

ı	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		INTD	ı			reserved				INTC			1	reserved		
Type Reset	R/W 0	R/W 0	R/W 0	RO 0	RO 0	RO 0	RO 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		INTB	Ι			reserved				INTA				reserved		
Type Reset	R/W 0	R/W 0	R/W 0	RO 0	RO 0	RO 0	RO 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	RO 0	RO 0	RO 0	RO 0
F	Bit/Field		Nam	ne	Ту	ne	Reset	Des	cription							
									•							
	31:29		INT	D	R/	W	0x0		rrupt Prid	•	•					
														terrupt wi		
								PRI		on). Th	e lower			eater the		
	28:24		reserv	rod.	R	0	0x0			_		ho valuo	of a ros	erved bit.	To prov	ido
	20.24		16361	/eu	IX	O	0.00							a reserv		
								pres	served a	cross a r	ead-mod	dify-write	operation	on.		
	23:21		INT	С	R/	W	0x0	Inte	rrupt Prio	ority for I	nterrupt	[4n+2]				
														terrupt wi		
								PRI		on). Th	e lower			eater the		
										_						
	20:16		reserv	/ed	R	0	0x0							erved bit. a reserv		
												dify-write				00.00
	15:13		INT	В	R/	W	0x0	Inte	rrupt Pric	ority for I	nterrupt	[4n+1]				
														terrupt wi		
								-	-				•	Priority eater the	•	•
									espondir						. ,	
	12:8		reserv	/ed	R	0	0x0							erved bit.		
												ucts, the dify-write		f a reserv	ed bit sh	ould be
	7:5		INT	A	R/	W	0x0	Inte	rrupt Prid	ority for I	nterrupt	[4n]				
									•	•	-		or the int	terrupt wi	th the nu	ımber
								PRI		on). Th	e lower			Priority re eater the		
	4:0		reserv	/ed	R	0	0x0				-			erved bit.	•	

Register 28: Software Trigger Interrupt (SWTRIG), offset 0xF00

Note: Only privileged software can enable unprivileged access to the SWTRIG register.

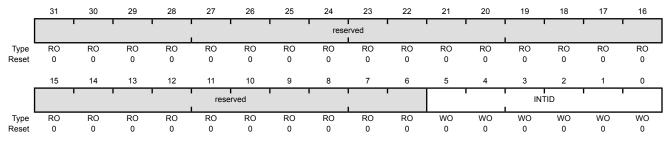
Writing an interrupt number to the **SWTRIG** register generates a Software Generated Interrupt (SGI). See Table 2-9 on page 84 for interrupt assignments.

When the MAINPEND bit in the **Configuration and Control (CFGCTRL)** register (see page 135) is set, unprivileged software can access the **SWTRIG** register.

Software Trigger Interrupt (SWTRIG)

Base 0xE000.E000 Offset 0xF00

Type WO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:6	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5:0	INTID	WO	0x00	Interrupt ID

This field holds the interrupt ID of the required SGI. For example, a value of 0x3 generates an interrupt on IRQ3.

3.5 System Control Block (SCB) Register Descriptions

This section lists and describes the System Control Block (SCB) registers, in numerical order by address offset. The SCB registers can only be accessed from privileged mode.

All registers must be accessed with aligned word accesses except for the **FAULTSTAT** and **SYSPRI1-SYSPRI3** registers, which can be accessed with byte or aligned halfword or word accesses. The processor does not support unaligned accesses to system control block registers.

Register 29: Auxiliary Control (ACTLR), offset 0x008

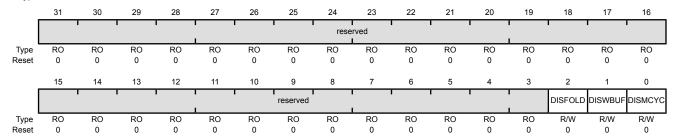
Note: This register can only be accessed from privileged mode.

The ACTLR register provides disable bits for IT folding, write buffer use for accesses to the default memory map, and interruption of multi-cycle instructions. By default, this register is set to provide optimum performance from the Cortex-M3 processor and does not normally require modification.

Auxiliary Control (ACTLR)

Base 0xE000.E000 Offset 0x008

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:3	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

2 **DISFOLD** R/W 0 Disable IT Folding

Value Description

0 No effect.

1 Disables IT folding.

In some situations, the processor can start executing the first instruction in an IT block while it is still executing the IT instruction. This behavior is called IT folding, and improves performance, However, IT folding can cause jitter in looping. If a task must avoid jitter, set the <code>DISFOLD</code> bit before executing the task, to disable IT folding.

DISWBUF Disable Write Buffer 1 R/W 0

Value Description

0 No effect.

1 Disables write buffer use during default memory map accesses. In this situation, all bus faults are precise bus faults but performance is decreased because any store to memory must complete before the processor can execute the next instruction.

This bit only affects write buffers implemented in the Note: Cortex-M3 processor.

Bit/Field	Name	Type	Reset	Description
0	DISMCYC	R/W	0	Disable Interrupts of Multiple Cycle Instructions
				Value Description
				0 No effect.
				Disables interruption of load multiple and store multiple instructions. In this situation, the interrupt latency of the processor is increased because any LDM or STM must complete before the processor can stack the current state and enter the interrupt handler.

Register 30: CPU ID Base (CPUID), offset 0xD00

Note: This register can only be accessed from privileged mode.

The CPUID register contains the ARM® Cortex™-M3 processor part number, version, and implementation information.

CPU ID Base (CPUID)

Base 0xE000.E000

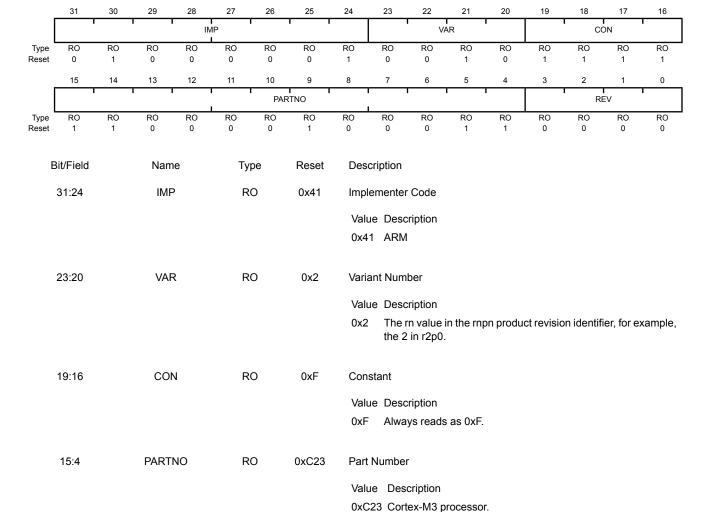
3:0

REV

RO

0x0

Offset 0xD00 Type RO, reset 0x412F.C230



Value Description

Revision Number

The pn value in the rnpn product revision identifier, for example, the 0 in r2p0.

Register 31: Interrupt Control and State (INTCTRL), offset 0xD04

Note: This register can only be accessed from privileged mode.

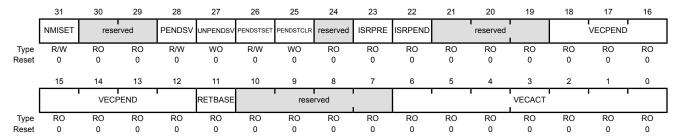
The **INCTRL** register provides a set-pending bit for the NMI exception, and set-pending and clear-pending bits for the PendSV and SysTick exceptions. In addition, bits in this register indicate the exception number of the exception being processed, whether there are preempted active exceptions, the exception number of the highest priority pending exception, and whether any interrupts are pending.

When writing to **INCTRL**, the effect is unpredictable when writing a 1 to both the PENDSV and UNPENDSV bits, or writing a 1 to both the PENDSTSET and PENDSTCLR bits.

Interrupt Control and State (INTCTRL)

Base 0xE000.E000 Offset 0xD04

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description	
31	NMISET	R/W	0	NMI Set Pendir	ıq

Value Description

- On a read, indicates an NMI exception is not pending.
 On a write, no effect.
- On a read, indicates an NMI exception is pending.
 On a write, changes the NMI exception state to pending.

Because NMI is the highest-priority exception, normally the processor enters the NMI exception handler as soon as it registers the setting of this bit, and clears this bit on entering the interrupt handler. A read of this bit by the NMI exception handler returns 1 only if the NMI signal is reasserted while the processor is executing that handler.

30:29	reserved	RO	0x0

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

28 PENDSV R/W 0 PendSV Set Pending

Value Description

- On a read, indicates a PendSV exception is not pending.

 On a write, no effect.
- On a read, indicates a PendSV exception is pending.
 On a write, changes the PendSV exception state to pending.

Setting this bit is the only way to set the PendSV exception state to pending. This bit is cleared by writing a 1 to the ${\tt UNPENDSV}$ bit.

Bit/Field	Name	Туре	Reset	Description
27	UNPENDSV	WO	0	PendSV Clear Pending
				Value Description On a write, no effect. On a write, removes the pending state from the PendSV exception.
				This bit is write only; on a register read, its value is unknown.
26	PENDSTSET	R/W	0	SysTick Set Pending
				 Value Description On a read, indicates a SysTick exception is not pending. On a write, no effect. On a read, indicates a SysTick exception is pending. On a write, changes the SysTick exception state to pending.
25	PENDSTCLR	WO	0	This bit is cleared by writing a 1 to the PENDSTCLR bit.
	, 2.1551-021	0	v	 SysTick Clear Pending Value Description On a write, no effect. On a write, removes the pending state from the SysTick exception. This bit is write only; on a register read, its value is unknown.
24	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
23	ISRPRE	RO	0	Debug Interrupt Handling
				Value Description O The release from halt does not take an interrupt. The release from halt takes an interrupt. This bit is only meaningful in Debug mode and reads as zero when the processor is not in Debug mode.
22	ISRPEND	RO	0	Interrupt Pending
				Value Description 0 No interrupt is pending. 1 An interrupt is pending. This bit provides status for all interrupts excluding NMI and Faults.
21:19	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
18:12	VECPEND	RO	0x00	Interrupt Pending Vector Number This field contains the exception number of the highest priority pending enabled exception. The value indicated by this field includes the effect of the BASEPRI and FAULTMASK registers, but not any effect of the PRIMASK register.
				Value Description
				0x00 No exceptions are pending
				0x01 Reserved
				0x02 NMI
				0x03 Hard fault
				0x04 Memory management fault
				0x05 Bus fault
				0x06 Usage fault
				0x07-0x0A Reserved
				0x0B SVCall
				0x0C Reserved for Debug
				0x0D Reserved
				0x0E PendSV
				0x0F SysTick
				0x10 Interrupt Vector 0
				0x11 Interrupt Vector 1
				0x46 Interrupt Vector 54
				0x47-0x7F Reserved
				SATI SATI TROSSITOS
11	RETBASE	RO	0	Return to Base
				Value Description
				O There are preempted active exceptions to execute.
				1 There are no active exceptions, or the currently executing exception is the only active exception.
				This bit provides status for all interrupts excluding NMI and Faults. This bit only has meaning if the processor is currently executing an ISR (the Interrupt Program Status (IPSR) register is non-zero).
10:7	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6:0	VECACT	RO	0x00	Interrupt Pending Vector Number
				This field contains the active exception number. The exception numbers can be found in the description for the VECPEND field. If this field is clear, the processor is in Thread mode. This field contains the same value as the ISRNUM field in the IPSR register.
				Subtract 16 from this value to obtain the IRQ number required to index into the Interrupt Set Enable (ENn), Interrupt Clear Enable (DISn), Interrupt Set Pending (PENDn), Interrupt Clear Pending (UNPENDn), and Interrupt Priority (PRIn) registers (see page 65).

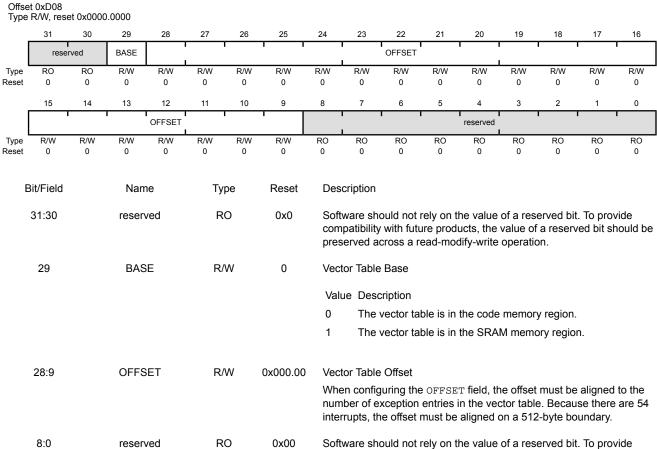
Register 32: Vector Table Offset (VTABLE), offset 0xD08

Note: This register can only be accessed from privileged mode.

The **VTABLE** register indicates the offset of the vector table base address from memory address 0x0000.0000.

Vector Table Offset (VTABLE)

Base 0xE000.E000



compatibility with future products, the value of a reserved bit should be

Register 33: Application Interrupt and Reset Control (APINT), offset 0xD0C

Note: This register can only be accessed from privileged mode.

The **APINT** register provides priority grouping control for the exception model, endian status for data accesses, and reset control of the system. To write to this register, 0x05FA must be written to the VECTKEY field, otherwise the write is ignored.

The PRIGROUP field indicates the position of the binary point that splits the INTx fields in the **Interrupt Priority (PRIx)** registers into separate group priority and subpriority fields. Table 3-8 on page 131 shows how the PRIGROUP value controls this split. The bit numbers in the Group Priority Field and Subpriority Field columns in the table refer to the bits in the INTA field. For the INTB field, the corresponding bits are 15:13; for INTC, 23:21; and for INTD, 31:29.

Note: Determining preemption of an exception uses only the group priority field.

Table 3-8. Interrupt Priority Levels

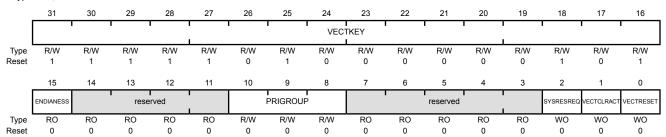
PRIGROUP Bit Field	Binary Point ^a	Group Priority Field		Group Priorities	Subpriorities
0x0 - 0x4	bxxx.	[7:5]	None	8	1
0x5	bxx.y	[7:6]	[5]	4	2
0x6	bx.yy	[7]	[6:5]	2	4
0x7	b.yyy	None	[7:5]	1	8

a. INTx field showing the binary point. An x denotes a group priority field bit, and a y denotes a subpriority field bit.

Application Interrupt and Reset Control (APINT)

Base 0xE000.E000 Offset 0xD0C

Type R/W, reset 0xFA05.0000



Bit/Field	Name	Туре	Reset	Description
31:16	VECTKEY	R/W	0xFA05	Register Key
				This field is used to guard against accidental writes to this register. 0x05FA must be written to this field in order to change the bits in this register. On a read, 0xFA05 is returned.
15	ENDIANESS	RO	0	Data Endianess
				The Stellaris implementation uses only little-endian mode so this is cleared to $0. \ \ $
14:11	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
10:8	PRIGROUP	R/W	0x0	Interrupt Priority Grouping This field determines the split of group priority from subpriority (see Table 3-8 on page 131 for more information).
7:3	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	SYSRESREQ	WO	0	System Reset Request
				Value Description
				0 No effect.
				1 Resets the core and all on-chip peripherals except the Debug interface.
				This bit is automatically cleared during the reset of the core and reads as 0.
1	VECTCLRACT	WO	0	Clear Active NMI / Fault
				This bit is reserved for Debug use and reads as 0. This bit must be written as a 0, otherwise behavior is unpredictable.
0	VECTRESET	WO	0	System Reset
				This bit is reserved for Debug use and reads as 0. This bit must be written as a 0, otherwise behavior is unpredictable.

Register 34: System Control (SYSCTRL), offset 0xD10

Note: This register can only be accessed from privileged mode.

The SYSCTRL register controls features of entry to and exit from low-power state.

System Control (SYSCTRL)

Base 0xE000.E000

Offset 0xD10
Type R/W, reset 0x0000.0000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1	1	1	1	1	1	rese	rved		J			1		1
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		1	1	1	1	reserved	1					SEVONPEND	reserved	SLEEPDEEP	SLEEPEXIT	reserved
Type	RO	RO	RO	RO	RO	reserved	RO	RO	RO	RO	RO	SEVONPEND R/W	reserved RO	SLEEPDEEP	SLEEPEXIT R/W	reserved RO
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0		RO 0	RO 0	RO 0	RO 0	RO 0					

31:5	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	SEVONPEND	R/W	0	Wake Up on Pending

Value Description

- Only enabled interrupts or events can wake up the processor; disabled interrupts are excluded.
- 1 Enabled events and all interrupts, including disabled interrupts, can wake up the processor.

When an event or interrupt enters the pending state, the event signal wakes up the processor from $\mathtt{WFE}.$ If the processor is not waiting for an event, the event is registered and affects the next WFE.

The processor also wakes up on execution of a SEV instruction or an external event.

3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	SLEEPDEEP	R/W	0	Deep Sleep Enable

Value Description

- 0 Use Sleep mode as the low power mode.
- Use Deep-sleep mode as the low power mode.

Bit/Field	Name	Туре	Reset	Description
1	SLEEPEXIT	R/W	0	Sleep on ISR Exit
				Value Description
				When returning from Handler mode to Thread mode, do not sleep when returning to Thread mode.
				When returning from Handler mode to Thread mode, enter sleep or deep sleep on return from an ISR.
				Setting this bit enables an interrupt-driven application to avoid returning to an empty main application.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 35: Configuration and Control (CFGCTRL), offset 0xD14

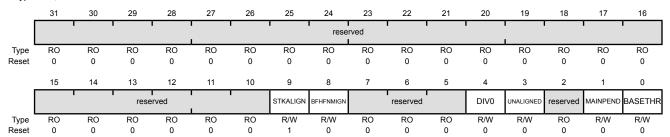
Note: This register can only be accessed from privileged mode.

The **CFGCTRL** register controls entry to Thread mode and enables: the handlers for NMI, hard fault and faults escalated by the **FAULTMASK** register to ignore bus faults; trapping of divide by zero and unaligned accesses; and access to the **SWTRIG** register by unprivileged software (see page 123).

Configuration and Control (CFGCTRL)

Base 0xE000.E000 Offset 0xD14

Type R/W, reset 0x0000.0200



Bit/Field	Name	Туре	Reset	Description
31:10	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
9	STKALIGN	R/W	1	Stack Alignment on Exception Entry
				Value Description
				0 The stack is 4-byte aligned.
				1 The stack is 8-byte aligned.
				On exception entry, the processor uses bit 9 of the stacked PSR to indicate the stack alignment. On return from the exception, it uses this stacked bit to restore the correct stack alignment.
8	BFHFNMIGN	R/W	0	Ignore Bus Fault in NMI and Fault
				This bit enables handlers with priority -1 or -2 to ignore data bus faults caused by load and store instructions. The setting of this bit applies to the hard fault, NMI, and FAULTMASK escalated handlers.
				Value Description
				0 Data bus faults caused by load and store instructions cause a lock-up.
				1 Handlers running at priority -1 and -2 ignore data bus faults caused by load and store instructions.
				Set this bit only when the handler and its data are in absolutely safe memory. The normal use of this bit is to probe system devices and bridges to detect control path problems and fix them.
7:5	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
4	DIV0	R/W	0	Trap on Divide by 0 This bit enables faulting or halting when the processor executes an SDIV or UDIV instruction with a divisor of 0.
				Value Description
				O Do not trap on divide by 0. A divide by zero returns a quotient of 0.
				1 Trap on divide by 0.
3	UNALIGNED	R/W	0	Trap on Unaligned Access
				Value Description
				0 Do not trap on unaligned halfword and word accesses.
				1 Trap on unaligned halfword and word accesses. An unaligned access generates a usage fault.
				Unaligned ${\tt LDM},{\tt STM},{\tt LDRD},$ and ${\tt STRD}$ instructions always fault regardless of whether ${\tt UNALIGNED}$ is set.
2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	MAINPEND	R/W	0	Allow Main Interrupt Trigger
				Value Description
				0 Disables unprivileged software access to the SWTRIG register.
				1 Enables unprivileged software access to the SWTRIG register (see page 123).
0	BASETHR	R/W	0	Thread State Control
				Value Description
				The processor can enter Thread mode only when no exception is active.
				The processor can enter Thread mode from any level under the control of an EXC_RETURN value (see "Exception Return" on page 88 for more information).

Register 36: System Handler Priority 1 (SYSPRI1), offset 0xD18

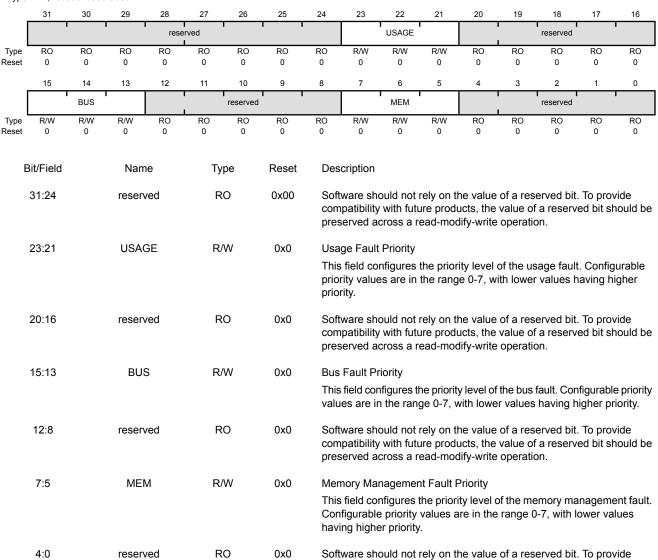
Note: This register can only be accessed from privileged mode.

The **SYSPRI1** register configures the priority level, 0 to 7 of the usage fault, bus fault, and memory management fault exception handlers. This register is byte-accessible.

System Handler Priority 1 (SYSPRI1)

Base 0xE000.E000 Offset 0xD18

Type R/W, reset 0x0000.0000



compatibility with future products, the value of a reserved bit should be

Register 37: System Handler Priority 2 (SYSPRI2), offset 0xD1C

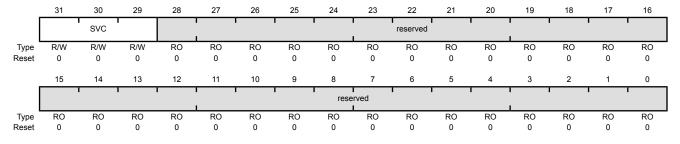
Note: This register can only be accessed from privileged mode.

The SYSPRI2 register configures the priority level, 0 to 7 of the SVCall handler. This register is byte-accessible.

System Handler Priority 2 (SYSPRI2)

Base 0xE000.E000

Offset 0xD1C Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:29	SVC	R/W	0x0	SVCall Priority This field configures the priority level of SVCall. Configurable priority
28:0	reserved	RO	0x000.0000	values are in the range 0-7, with lower values having higher priority. Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be

Register 38: System Handler Priority 3 (SYSPRI3), offset 0xD20

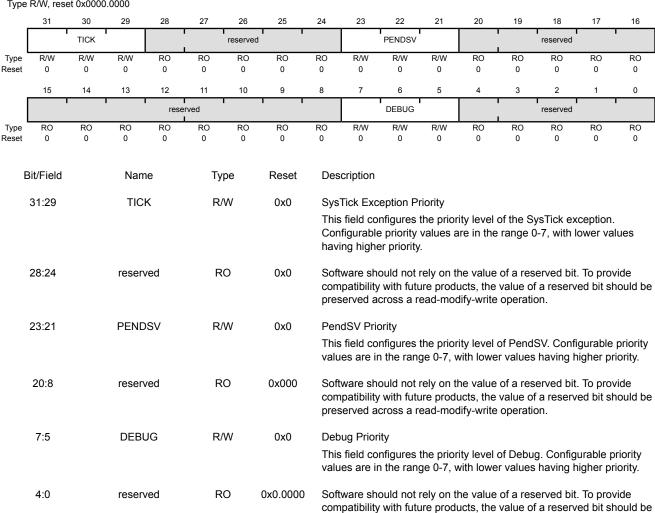
Note: This register can only be accessed from privileged mode.

The SYSPRI3 register configures the priority level, 0 to 7 of the SysTick exception and PendSV handlers. This register is byte-accessible.

System Handler Priority 3 (SYSPRI3)

Base 0xE000.E000 Offset 0xD20

Type R/W, reset 0x0000.0000



Register 39: System Handler Control and State (SYSHNDCTRL), offset 0xD24

Note: This register can only be accessed from privileged mode.

The **SYSHNDCTRL** register enables the system handlers, and indicates the pending status of the usage fault, bus fault, memory management fault, and SVC exceptions as well as the active status of the system handlers.

If a system handler is disabled and the corresponding fault occurs, the processor treats the fault as a hard fault.

This register can be modified to change the pending or active status of system exceptions. An OS kernel can write to the active bits to perform a context switch that changes the current exception type.

Caution – Software that changes the value of an active bit in this register without correct adjustment to the stacked content can cause the processor to generate a fault exception. Ensure software that writes to this register retains and subsequently restores the current active status.

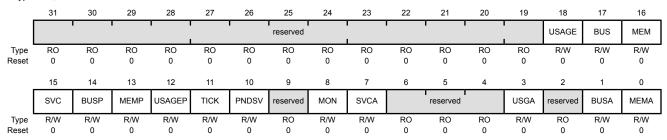
If the value of a bit in this register must be modified after enabling the system handlers, a read-modify-write procedure must be used to ensure that only the required bit is modified.

System Handler Control and State (SYSHNDCTRL)

Base 0xE000.E000

Offset 0xD24

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:19	reserved	RO	0x000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
18	USAGE	R/W	0	Usage Fault Enable
				Value Description
				O Disables the usage fault exception.
				1 Enables the usage fault exception.
17	BUS	R/W	0	Bus Fault Enable
				Value Description
				0 Disables the bus fault exception.

Enables the bus fault exception.

Bit/Field	Name	Туре	Reset	Description
16	MEM	R/W	0	Memory Management Fault Enable
				Value Description
				0 Disables the memory management fault exception.
				1 Enables the memory management fault exception.
15	SVC	R/W	0	SVC Call Pending
				Value Description
				0 An SVC call exception is not pending.
				1 An SVC call exception is pending.
				This bit can be modified to change the pending status of the SVC call exception.
14	BUSP	R/W	0	Bus Fault Pending
				Value Description
				0 A bus fault exception is not pending.
				1 A bus fault exception is pending.
				This bit can be modified to change the pending status of the bus fault exception.
13	MEMP	R/W	0	Memory Management Fault Pending
				Value Description
				O A memory management fault exception is not pending.
				1 A memory management fault exception is pending.
				This bit can be modified to change the pending status of the memory management fault exception.
12	USAGEP	R/W	0	Usage Fault Pending
				Value Description
				0 A usage fault exception is not pending.
				1 A usage fault exception is pending.
				This bit can be modified to change the pending status of the usage fault exception.
11	TICK	R/W	0	SysTick Exception Active
				Value Description
				0 A SysTick exception is not active.
				1 A SysTick exception is active.
				This bit can be modified to change the active status of the SysTick exception, however, see the Caution above before setting this bit.

Bit/Field	Name	Туре	Reset	Description
10	PNDSV	R/W	0	PendSV Exception Active
				Value Description
				0 A PendSV exception is not active.
				1 A PendSV exception is active.
				This bit can be modified to change the active status of the PendSV exception, however, see the Caution above before setting this bit.
9	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	MON	R/W	0	Debug Monitor Active
				Value Description
				0 The Debug monitor is not active.
				1 The Debug monitor is active.
7	SVCA	R/W	0	SVC Call Active
				Value Description
				0 SVC call is not active.
				1 SVC call is active.
				This bit can be modified to change the active status of the SVC call exception, however, see the Caution above before setting this bit.
6:4	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	USGA	R/W	0	Usage Fault Active
				Value Description
				0 Usage fault is not active.
				1 Usage fault is active.
				This bit can be modified to change the active status of the usage fault exception, however, see the Caution above before setting this bit.
2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	BUSA	R/W	0	Bus Fault Active
				Value Description
				0 Bus fault is not active.
				1 Bus fault is active.
				This bit can be modified to change the active status of the bus fault exception, however, see the Caution above before setting this bit.

Bit/Field	Name	Туре	Reset	Description
0	MEMA	R/W	0	Memory Management Fault Active
				Value Description 0 Memory management fault is not active. 1 Memory management fault is active. This bit can be modified to change the active status of the memory management fault exception, however, see the Caution above before setting this bit.

Register 40: Configurable Fault Status (FAULTSTAT), offset 0xD28

Note: This register can only be accessed from privileged mode.

The **FAULTSTAT** register indicates the cause of a memory management fault, bus fault, or usage fault. Each of these functions is assigned to a subregister as follows:

- Usage Fault Status (UFAULTSTAT), bits 31:16
- Bus Fault Status (BFAULTSTAT), bits 15:8
- Memory Management Fault Status (MFAULTSTAT), bits 7:0

FAULTSTAT is byte accessible. **FAULTSTAT** or its subregisters can be accessed as follows:

- The complete **FAULTSTAT** register, with a word access to offset 0xD28
- The **MFAULTSTAT**, with a byte access to offset 0xD28
- The MFAULTSTAT and BFAULTSTAT, with a halfword access to offset 0xD28
- The **BFAULTSTAT**, with a byte access to offset 0xD29
- The **UFAULTSTAT**, with a halfword access to offset 0xD2A

Bits are cleared by writing a 1 to them.

In a fault handler, the true faulting address can be determined by:

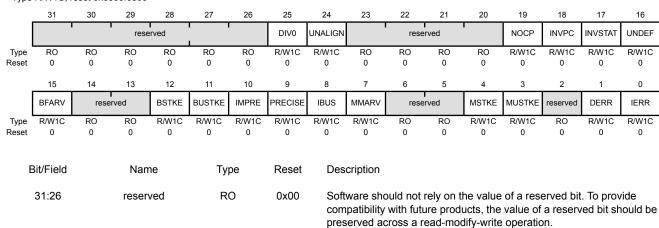
- Read and save the Memory Management Fault Address (MMADDR) or Bus Fault Address (FAULTADDR) value.
- 2. Read the MMARV bit in MFAULTSTAT, or the BFARV bit in BFAULTSTAT to determine if the MMADDR or FAULTADDR contents are valid.

Software must follow this sequence because another higher priority exception might change the **MMADDR** or **FAULTADDR** value. For example, if a higher priority handler preempts the current fault handler, the other fault might change the **MMADDR** or **FAULTADDR** value.

Configurable Fault Status (FAULTSTAT)

Base 0xE000.E000 Offset 0xD28

Type R/W1C, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
25	DIV0	R/W1C	0	Divide-by-Zero Usage Fault
				Value Description
				No divide-by-zero fault has occurred, or divide-by-zero trapping is not enabled.
				1 The processor has executed an SDIV or UDIV instruction with a divisor of 0.
				When this bit is set, the PC value stacked for the exception return points to the instruction that performed the divide by zero.
				Trapping on divide-by-zero is enabled by setting the DIV0 bit in the Configuration and Control (CFGCTRL) register (see page 135).
				This bit is cleared by writing a 1 to it.
24	UNALIGN	R/W1C	0	Unaligned Access Usage Fault
				Value Description
				No unaligned access fault has occurred, or unaligned access trapping is not enabled.
				1 The processor has made an unaligned memory access.
				Unaligned LDM, STM, LDRD, and STRD instructions always fault regardless of the configuration of this bit.
				Trapping on unaligned access is enabled by setting the UNALIGNED bit in the CFGCTRL register (see page 135).
				This bit is cleared by writing a 1 to it.
23:20	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
19	NOCP	R/W1C	0	No Coprocessor Usage Fault
				Value Description
				O A usage fault has not been caused by attempting to access a coprocessor.
				1 The processor has attempted to access a coprocessor.
				This bit is cleared by writing a 1 to it.
18	INVPC	R/W1C	0	Invalid PC Load Usage Fault
				Value Description
				O A usage fault has not been caused by attempting to load an invalid PC value.
				The processor has attempted an illegal load of EXC_RETURN to the PC as a result of an invalid context or an invalid EXC_RETURN value.
				When this bit is set, the PC value stacked for the exception return points to the instruction that tried to perform the illegal load of the PC .
				This bit is cleared by writing a 1 to it.

Bit/Field	Name	Туре	Reset	Description
17	INVSTAT	R/W1C	0	Invalid State Usage Fault
				Value Description
				O A usage fault has not been caused by an invalid state.
				1 The processor has attempted to execute an instruction that makes illegal use of the EPSR register.
				When this bit is set, the PC value stacked for the exception return points to the instruction that attempted the illegal use of the Execution Program Status Register (EPSR) register.
				This bit is not set if an undefined instruction uses the EPSR register.
				This bit is cleared by writing a 1 to it.
16	UNDEF	R/W1C	0	Undefined Instruction Usage Fault
				Value Description
				0 A usage fault has not been caused by an undefined instruction.
				1 The processor has attempted to execute an undefined instruction.
				When this bit is set, the PC value stacked for the exception return points to the undefined instruction.
				An undefined instruction is an instruction that the processor cannot decode.
				This bit is cleared by writing a 1 to it.
15	BFARV	R/W1C	0	Bus Fault Address Register Valid
				Value Description
				The value in the Bus Fault Address (FAULTADDR) register is not a valid fault address.
				1 The FAULTADDR register is holding a valid fault address.
				This bit is set after a bus fault, where the address is known. Other faults can clear this bit, such as a memory management fault occurring later.
				If a bus fault occurs and is escalated to a hard fault because of priority, the hard fault handler must clear this bit. This action prevents problems if returning to a stacked active bus fault handler whose FAULTADDR register value has been overwritten.
				This bit is cleared by writing a 1 to it.
14:13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Type	Reset	Description
12	BSTKE	R/W1C	0	Stack Bus Fault
				Value Description
				0 No bus fault has occurred on stacking for exception entry.
				Stacking for an exception entry has caused one or more bus faults.
				When this bit is set, the SP is still adjusted but the values in the context area on the stack might be incorrect. A fault address is not written to the FAULTADDR register.
				This bit is cleared by writing a 1 to it.
11	BUSTKE	R/W1C	0	Unstack Bus Fault
				Value Description
				No bus fault has occurred on unstacking for a return from exception.
				1 Unstacking for a return from exception has caused one or more bus faults.
				This fault is chained to the handler. Thus, when this bit is set, the original return stack is still present. The SP is not adjusted from the failing return, a new save is not performed, and a fault address is not written to the FAULTADDR register.
				This bit is cleared by writing a 1 to it.
10	IMPRE	R/W1C	0	Imprecise Data Bus Error
				Value Description
				O An imprecise data bus error has not occurred.
				A data bus error has occurred, but the return address in the stack frame is not related to the instruction that caused the error.
				When this bit is set, a fault address is not written to the FAULTADDR register.
				This fault is asynchronous. Therefore, if the fault is detected when the priority of the current process is higher than the bus fault priority, the bus fault becomes pending and becomes active only when the processor returns from all higher-priority processes. If a precise fault occurs before the processor enters the handler for the imprecise bus fault, the handler detects that both the IMPRE bit is set and one of the precise fault status bits is set.
				This bit is cleared by writing a 1 to it.
9	PRECISE	R/W1C	0	Precise Data Bus Error
				Value Description
				0 A precise data bus error has not occurred.
				A data bus error has occurred, and the PC value stacked for the exception return points to the instruction that caused the fault.
				When this bit is set, the fault address is written to the FAULTADDR register.
				-

This bit is cleared by writing a 1 to it.

Bit/Field	Name	Туре	Reset	Description
8	IBUS	R/W1C	0	Instruction Bus Error
				Value Description
				O An instruction bus error has not occurred.
				1 An instruction bus error has occurred.
				The processor detects the instruction bus error on prefetching an instruction, but sets this bit only if it attempts to issue the faulting instruction.
				When this bit is set, a fault address is not written to the FAULTADDR register.
				This bit is cleared by writing a 1 to it.
7	MMARV	R/W1C	0	Memory Management Fault Address Register Valid
				Value Description
				The value in the Memory Management Fault Address (MMADDR) register is not a valid fault address.
				1 The MMADDR register is holding a valid fault address.
				If a memory management fault occurs and is escalated to a hard fault because of priority, the hard fault handler must clear this bit. This action prevents problems if returning to a stacked active memory management fault handler whose MMADDR register value has been overwritten.
				This bit is cleared by writing a 1 to it.
6:5	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	MSTKE	R/W1C	0	Stack Access Violation
				Value Description
				No memory management fault has occurred on stacking for exception entry.
				Stacking for an exception entry has caused one or more access violations.
				When this bit is set, the SP is still adjusted but the values in the context area on the stack might be incorrect. A fault address is not written to the MMADDR register.
				This bit is cleared by writing a 1 to it.

This bit is cleared by writing a 1 to it.

Bit/Field	Name	Туре	Reset	Description
3	MUSTKE	R/W1C	0	Unstack Access Violation
				Value Description
				No memory management fault has occurred on unstacking for a return from exception.
				1 Unstacking for a return from exception has caused one or more access violations.
				This fault is chained to the handler. Thus, when this bit is set, the original return stack is still present. The SP is not adjusted from the failing return, a new save is not performed, and a fault address is not written to the MMADDR register.
				This bit is cleared by writing a 1 to it.
2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	DERR	R/W1C	0	Data Access Violation
				Value Description
				0 A data access violation has not occurred.
				1 The processor attempted a load or store at a location that does not permit the operation.
				When this bit is set, the PC value stacked for the exception return points to the faulting instruction and the address of the attempted access is written to the MMADDR register.
				This bit is cleared by writing a 1 to it.
0	IERR	R/W1C	0	Instruction Access Violation
				Value Description
				O An instruction access violation has not occurred.
				1 The processor attempted an instruction fetch from a location that does not permit execution.
				This fault occurs on any access to an XN region, even when the MPU is disabled or not present.
				When this bit is set, the PC value stacked for the exception return points to the faulting instruction and the address of the attempted access is

not written to the **MMADDR** register.

This bit is cleared by writing a 1 to it.

Register 41: Hard Fault Status (HFAULTSTAT), offset 0xD2C

Note: This register can only be accessed from privileged mode.

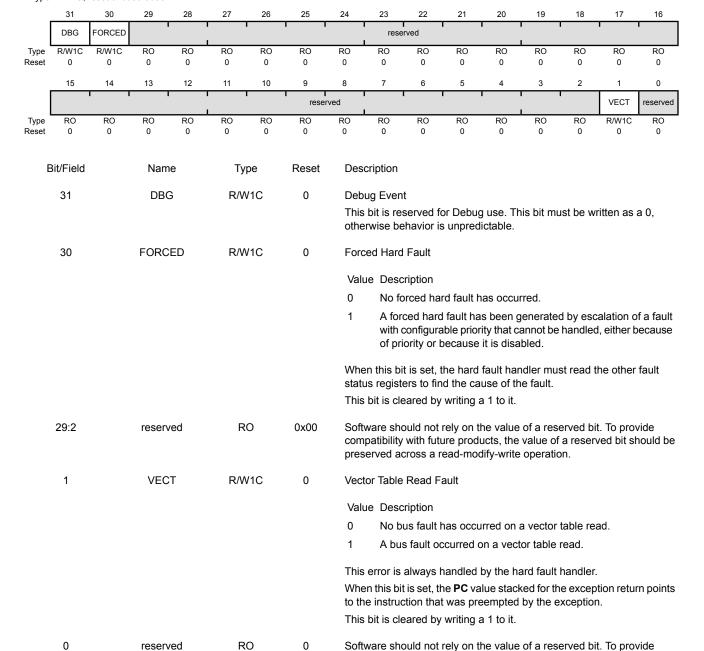
The **HFAULTSTAT** register gives information about events that activate the hard fault handler.

Bits are cleared by writing a 1 to them.

Hard Fault Status (HFAULTSTAT)

Base 0xE000.E000

Offset 0xD2C Type R/W1C, reset 0x0000.0000



compatibility with future products, the value of a reserved bit should be

preserved across a read-modify-write operation.

Register 42: Memory Management Fault Address (MMADDR), offset 0xD34

Note: This register can only be accessed from privileged mode.

The MMADDR register contains the address of the location that generated a memory management fault. When an unaligned access faults, the address in the MMADDR register is the actual address that faulted. Because a single read or write instruction can be split into multiple aligned accesses, the fault address can be any address in the range of the requested access size. Bits in the Memory Management Fault Status (MFAULTSTAT) register indicate the cause of the fault and whether the value in the MMADDR register is valid (see page 144).

Memory Management Fault Address (MMADDR)

Base 0xE000.E000 Offset 0xD34 Type R/W, reset -

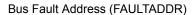


When the ${\tt MMARV}$ bit of **MFAULTSTAT** is set, this field holds the address of the location that generated the memory management fault.

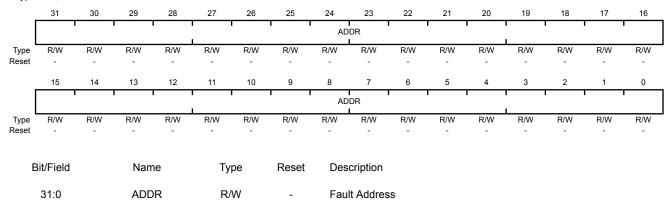
Register 43: Bus Fault Address (FAULTADDR), offset 0xD38

Note: This register can only be accessed from privileged mode.

The **FAULTADDR** register contains the address of the location that generated a bus fault. When an unaligned access faults, the address in the **FAULTADDR** register is the one requested by the instruction, even if it is not the address of the fault. Bits in the **Bus Fault Status (BFAULTSTAT)** register indicate the cause of the fault and whether the value in the **FAULTADDR** register is valid (see page 144).



Base 0xE000.E000 Offset 0xD38 Type R/W, reset -



When the FAULTADDRV bit of **BFAULTSTAT** is set, this field holds the address of the location that generated the bus fault.

3.6 Memory Protection Unit (MPU) Register Descriptions

This section lists and describes the Memory Protection Unit (MPU) registers, in numerical order by address offset.

The MPU registers can only be accessed from privileged mode.

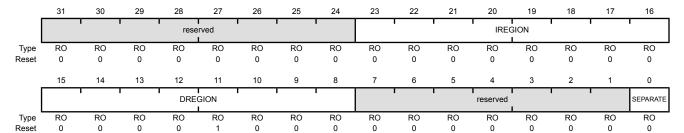
Register 44: MPU Type (MPUTYPE), offset 0xD90

Note: This register can only be accessed from privileged mode.

The **MPUTYPE** register indicates whether the MPU is present, and if so, how many regions it supports.

MPU Type (MPUTYPE)

Base 0xE000.E000 Offset 0xD90 Type RO, reset 0x0000.0800



Bit/Field	Name	Type	Reset	Description
31:24	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
23:16	IREGION	RO	0x00	Number of I Regions This field indicates the number of supported MPU instruction regions. This field always contains 0x00. The MPU memory map is unified and is described by the DREGION field.
15:8	DREGION	RO	0x08	Number of D Regions Value Description 0x08 Indicates there are eight supported MPU data regions.
7:1	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	SEPARATE	RO	0	Separate or Unified MPU

Value Description

Indicates the MPU is unified.

Register 45: MPU Control (MPUCTRL), offset 0xD94

Note: This register can only be accessed from privileged mode.

The **MPUCTRL** register enables the MPU, enables the default memory map background region, and enables use of the MPU when in the hard fault, Non-maskable Interrupt (NMI), and **Fault Mask Register (FAULTMASK)** escalated handlers.

When the ENABLE and PRIVDEFEN bits are both set:

- For privileged accesses, the default memory map is as described in "Memory Model" on page 73. Any access by privileged software that does not address an enabled memory region behaves as defined by the default memory map.
- Any access by unprivileged software that does not address an enabled memory region causes a memory management fault.

Execute Never (XN) and Strongly Ordered rules always apply to the System Control Space regardless of the value of the ENABLE bit.

When the ENABLE bit is set, at least one region of the memory map must be enabled for the system to function unless the PRIVDEFEN bit is set. If the PRIVDEFEN bit is set and no regions are enabled, then only privileged software can operate.

When the ENABLE bit is clear, the system uses the default memory map, which has the same memory attributes as if the MPU is not implemented (see Table 2-5 on page 76 for more information). The default memory map applies to accesses from both privileged and unprivileged software.

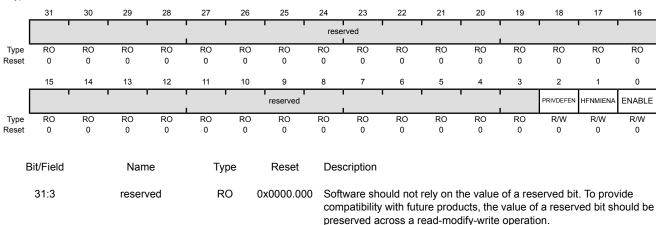
When the MPU is enabled, accesses to the System Control Space and vector table are always permitted. Other areas are accessible based on regions and whether PRIVDEFEN is set.

Unless HFNMIENA is set, the MPU is not enabled when the processor is executing the handler for an exception with priority -1 or -2. These priorities are only possible when handling a hard fault or NMI exception or when **FAULTMASK** is enabled. Setting the HFNMIENA bit enables the MPU when operating with these two priorities.

MPU Control (MPUCTRL)

Base 0xE000.E000 Offset 0xD94

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
2	PRIVDEFEN	R/W	0	MPU Default Region This bit enables privileged software access to the default memory map. Value Description
				Old If the MPU is enabled, this bit disables use of the default memory map. Any memory access to a location not covered by any enabled region causes a fault.
				1 If the MPU is enabled, this bit enables use of the default memory map as a background region for privileged software accesses.
				When this bit is set, the background region acts as if it is region number -1. Any region that is defined and enabled has priority over this default map.
				If the MPU is disabled, the processor ignores this bit.
1	HFNMIENA	R/W	0	MPU Enabled During Faults
				This bit controls the operation of the MPU during hard fault, NMI, and FAULTMASK handlers.
				Value Description
				The MPU is disabled during hard fault, NMI, and FAULTMASK handlers, regardless of the value of the ENABLE bit.
				1 The MPU is enabled during hard fault, NMI, and FAULTMASK handlers.
				When the MPU is disabled and this bit is set, the resulting behavior is unpredictable.
0	ENABLE	R/W	0	MPU Enable
				Value Description
				0 The MPU is disabled.
				1 The MPU is enabled.
				When the MPU is disabled and the ${\tt HFNMIENA}$ bit is set, the resulting behavior is unpredictable.

Register 46: MPU Region Number (MPUNUMBER), offset 0xD98

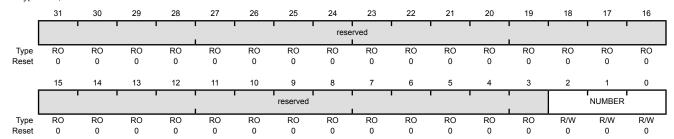
Note: This register can only be accessed from privileged mode.

The MPUNUMBER register selects which memory region is referenced by the MPU Region Base Address (MPUBASE) and MPU Region Attribute and Size (MPUATTR) registers. Normally, the required region number should be written to this register before accessing the MPUBASE or the MPUATTR register. However, the region number can be changed by writing to the MPUBASE register with the VALID bit set (see page 157). This write updates the value of the REGION field.

MPU Region Number (MPUNUMBER)

Base 0xE000.E000 Offset 0xD98

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:3	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2:0	NUMBER	R/W	0x0	MPU Region to Access

This field indicates the MPU region referenced by the **MPUBASE** and **MPUATTR** registers. The MPU supports eight memory regions.

Register 47: MPU Region Base Address (MPUBASE), offset 0xD9C

Register 48: MPU Region Base Address Alias 1 (MPUBASE1), offset 0xDA4

Register 49: MPU Region Base Address Alias 2 (MPUBASE2), offset 0xDAC

Register 50: MPU Region Base Address Alias 3 (MPUBASE3), offset 0xDB4

Note: This register can only be accessed from privileged mode.

The MPUBASE register defines the base address of the MPU region selected by the MPU Region Number (MPUNUMBER) register and can update the value of the MPUNUMBER register. To change the current region number and update the MPUNUMBER register, write the MPUBASE register with the VALID bit set.

The ADDR field is bits 31:*N* of the **MPUBASE** register. Bits (*N*-1):5 are reserved. The region size, as specified by the SIZE field in the **MPU Region Attribute and Size (MPUATTR)** register, defines the value of *N* where:

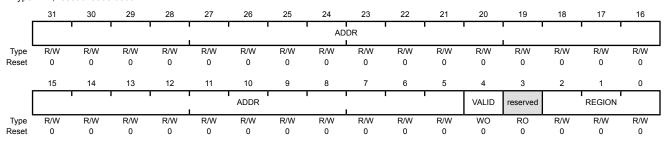
 $N = Log_2$ (Region size in bytes)

If the region size is configured to 4 GB in the **MPUATTR** register, there is no valid ADDR field. In this case, the region occupies the complete memory map, and the base address is 0x0000.0000.

The base address is aligned to the size of the region. For example, a 64-KB region must be aligned on a multiple of 64 KB, for example, at 0x0001.0000 or 0x0002.0000.

MPU Region Base Address (MPUBASE)

Base 0xE000.E000 Offset 0xD9C Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:5	ADDR	R/W	0x0000.000	Base Address Mask

Bits 31:N in this field contain the region base address. The value of N depends on the region size, as shown above. The remaining bits (N-1):5 are reserved.

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
4	VALID	WO	0	Region Number Valid
				Value Description
				The MPUNUMBER register is not changed and the processor updates the base address for the region specified in the MPUNUMBER register and ignores the value of the REGION field.
				The MPUNUMBER register is updated with the value of the REGION field and the base address is updated for the region specified in the REGION field.
				This bit is always read as 0.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2:0	REGION	R/W	0x0	Region Number On a write, contains the value to be written to the MPUNUMBER register. On a read, returns the current region number in the MPUNUMBER register.

Register 51: MPU Region Attribute and Size (MPUATTR), offset 0xDA0

Register 52: MPU Region Attribute and Size Alias 1 (MPUATTR1), offset 0xDA8

Register 53: MPU Region Attribute and Size Alias 2 (MPUATTR2), offset 0xDB0

Register 54: MPU Region Attribute and Size Alias 3 (MPUATTR3), offset 0xDB8

Note: This register can only be accessed from privileged mode.

The **MPUATTR** register defines the region size and memory attributes of the MPU region specified by the **MPU Region Number (MPUNUMBER)** register and enables that region and any subregions.

The **MPUATTR** register is accessible using word or halfword accesses with the most-significant halfword holding the region attributes and the least-significant halfword holds the region size and the region and subregion enable bits.

The MPU access permission attribute bits, XN, AP, TEX, S, C, and B, control access to the corresponding memory region. If an access is made to an area of memory without the required permissions, then the MPU generates a permission fault.

The SIZE field defines the size of the MPU memory region specified by the **MPUNUMBER** register as follows:

(Region size in bytes) = $2^{(SIZE+1)}$

The smallest permitted region size is 32 bytes, corresponding to a SIZE value of 4. Table 3-9 on page 159 gives example SIZE values with the corresponding region size and value of N in the MPU Region Base Address (MPUBASE) register.

Table 3-9. Example SIZE Field Values

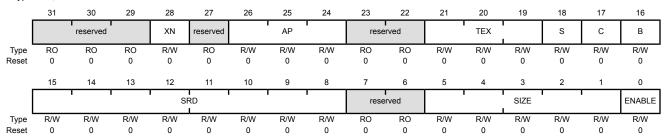
SIZE Encoding	Region Size	Value of N ^a	Note
00100b (0x4)	32 B	5	Minimum permitted size
01001b (0x9)	1 KB	10	-
10011b (0x13)	1 MB	20	-
11101b (0x1D)	1 GB	30	-
11111b (0x1F)	4 GB	No valid ADDR field in MPUBASE ; the region occupies the complete memory map.	Maximum possible size

a. Refers to the N parameter in the MPUBASE register (see page 157).

MPU Region Attribute and Size (MPUATTR)

Base 0xE000.E000 Offset 0xDA0

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:29	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
28	XN	R/W	0	Instruction Access Disable
				Value Description
				0 Instruction fetches are enabled.
				1 Instruction fetches are disabled.
27	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
26:24	AP	R/W	0	Access Privilege
				For information on using this bit field, see Table 3-5 on page 103.
23:22	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
21:19	TEX	R/W	0x0	Type Extension Mask
				For information on using this bit field, see Table 3-3 on page 102.
18	S	R/W	0	Shareable For information on using this bit, see Table 3-3 on page 102.
17	С	R/W	0	Cacheable
				For information on using this bit, see Table 3-3 on page 102.
16	В	R/W	0	Bufferable
				For information on using this bit, see Table 3-3 on page 102.
15:8	SRD	R/W	0x00	Subregion Disable Bits
				Value Description
				O The corresponding subregion is enabled.
				1 The corresponding subregion is disabled.
				Region sizes of 128 bytes and less do not support subregions. When writing the attributes for such a region, configure the SRD field as 0x00. See the section called "Subregions" on page 101 for more information.
7:6	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5:1	SIZE	R/W	0x0	Region Size Mask
				The SIZE field defines the size of the MPU memory region specified by the MPUNUMBER register. Refer to Table 3-9 on page 159 for more information.

Bit/Field	Name	Туре	Reset	Description
0	ENABLE	R/W	0	Region Enable
				Value Description
				0 The region is disabled.
				1 The region is enabled.

4 JTAG Interface

The Joint Test Action Group (JTAG) port is an IEEE standard that defines a Test Access Port and Boundary Scan Architecture for digital integrated circuits and provides a standardized serial interface for controlling the associated test logic. The TAP, Instruction Register (IR), and Data Registers (DR) can be used to test the interconnections of assembled printed circuit boards and obtain manufacturing information on the components. The JTAG Port also provides a means of accessing and controlling design-for-test features such as I/O pin observation and control, scan testing, and debugging.

The JTAG port is comprised of four pins: TCK, TMS, TDI, and TDO. Data is transmitted serially into the controller on TDI and out of the controller on TDO. The interpretation of this data is dependent on the current state of the TAP controller. For detailed information on the operation of the JTAG port and TAP controller, please refer to the *IEEE Standard 1149.1-Test Access Port and Boundary-Scan Architecture*.

The Stellaris[®] JTAG controller works with the ARM JTAG controller built into the Cortex-M3 core by multiplexing the TDO outputs from both JTAG controllers. ARM JTAG instructions select the ARM TDO output while Stellaris JTAG instructions select the Stellaris TDO output. The multiplexer is controlled by the Stellaris JTAG controller, which has comprehensive programming for the ARM, Stellaris, and unimplemented JTAG instructions.

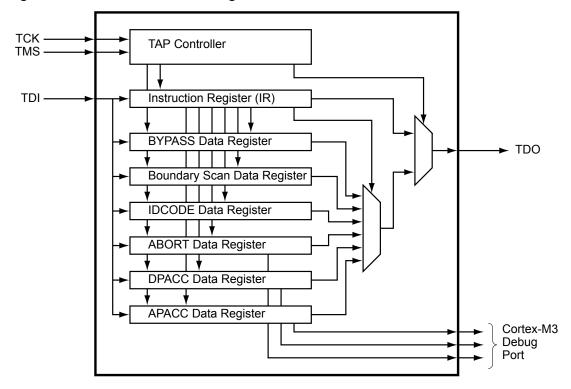
The Stellaris JTAG module has the following features:

- IEEE 1149.1-1990 compatible Test Access Port (TAP) controller
- Four-bit Instruction Register (IR) chain for storing JTAG instructions
- IEEE standard instructions: BYPASS, IDCODE, SAMPLE/PRELOAD, EXTEST and INTEST
- ARM additional instructions: APACC, DPACC and ABORT
- Integrated ARM Serial Wire Debug (SWD)
 - Serial Wire JTAG Debug Port (SWJ-DP)
 - Flash Patch and Breakpoint (FPB) unit for implementing breakpoints
 - Data Watchpoint and Trace (DWT) unit for implementing watchpoints, trigger resources, and system profiling
 - Instrumentation Trace Macrocell (ITM) for support of printf style debugging
 - Trace Port Interface Unit (TPIU) for bridging to a Trace Port Analyzer

See the ARM® Debug Interface V5 Architecture Specification for more information on the ARM JTAG controller.

4.1 Block Diagram

Figure 4-1. JTAG Module Block Diagram



4.2 Signal Description

The following table lists the external signals of the JTAG/SWD controller and describes the function of each. The JTAG/SWD controller signals are alternate functions for some GPIO signals, however note that the reset state of the pins is for the JTAG/SWD function. The JTAG/SWD controller signals are under commit protection and require a special process to be configured as GPIOs, see "Commit Control" on page 397. The column in the table below titled "Pin Mux/Pin Assignment" lists the GPIO pin placement for the JTAG/SWD controller signals. The AFSEL bit in the **GPIO Alternate Function Select (GPIOAFSEL)** register (page 412) is set to choose the JTAG/SWD function. The number in parentheses is the encoding that must be programmed into the PMCn field in the **GPIO Port Control (GPIOPCTL)** register (page 430) to assign the JTAG/SWD controller signals to the specified GPIO port pin. For more information on configuring GPIOs, see "General-Purpose Input/Outputs (GPIOs)" on page 389.

Table 4-1. JTAG_SWD_SWO Signals (100LQFP)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
SWCLK	80	PC0 (3)	1	TTL	JTAG/SWD CLK.
SWDIO	79	PC1 (3)	I/O	TTL	JTAG TMS and SWDIO.
SWO	77	PC3 (3)	0	TTL	JTAG TDO and SWO.
TCK	80	PC0 (3)	1	TTL	JTAG/SWD CLK.
TDI	78	PC2 (3)	1	TTL	JTAG TDI.
TDO	77	PC3 (3)	0	TTL	JTAG TDO and SWO.

Table 4-1. JTAG_SWD_SWO Signals (100LQFP) (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
TMS	79	PC1 (3)	I	TTL	JTAG TMS and SWDIO.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

Table 4-2. JTAG_SWD_SWO Signals (108BGA)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
SWCLK	A9	PC0 (3)	1	TTL	JTAG/SWD CLK.
SWDIO	В9	PC1 (3)	I/O	TTL	JTAG TMS and SWDIO.
SWO	A10	PC3 (3)	0	TTL	JTAG TDO and SWO.
TCK	A9	PC0 (3)	I	TTL	JTAG/SWD CLK.
TDI	B8	PC2 (3)	I	TTL	JTAG TDI.
TDO	A10	PC3 (3)	0	TTL	JTAG TDO and SWO.
TMS	В9	PC1 (3)	I	TTL	JTAG TMS and SWDIO.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

4.3 Functional Description

A high-level conceptual drawing of the JTAG module is shown in Figure 4-1 on page 163. The JTAG module is composed of the Test Access Port (TAP) controller and serial shift chains with parallel update registers. The TAP controller is a simple state machine controlled by the TCK and TMS inputs. The current state of the TAP controller depends on the sequence of values captured on TMS at the rising edge of TCK. The TAP controller determines when the serial shift chains capture new data, shift data from TDI towards TDO, and update the parallel load registers. The current state of the TAP controller also determines whether the Instruction Register (IR) chain or one of the Data Register (DR) chains is being accessed.

The serial shift chains with parallel load registers are comprised of a single Instruction Register (IR) chain and multiple Data Register (DR) chains. The current instruction loaded in the parallel load register determines which DR chain is captured, shifted, or updated during the sequencing of the TAP controller.

Some instructions, like EXTEST and INTEST, operate on data currently in a DR chain and do not capture, shift, or update any of the chains. Instructions that are not implemented decode to the BYPASS instruction to ensure that the serial path between TDI and TDO is always connected (see Table 4-4 on page 170 for a list of implemented instructions).

See "JTAG and Boundary Scan" on page 798 for JTAG timing diagrams.

Note: Of all the possible reset sources, only Power-On reset (POR) and the assertion of the RST input have any effect on the JTAG module. The pin configurations are reset by both the RST input and POR, whereas the internal JTAG logic is only reset with POR. See "Reset Sources" on page 175 for more information on reset.

4.3.1 JTAG Interface Pins

The JTAG interface consists of four standard pins: TCK, TMS, TDI, and TDO. These pins and their associated state after a power-on reset or reset caused by the RST input are given in Table 4-3. Detailed information on each pin follows. Refer to "General-Purpose Input/Outputs (GPIOs)" on page 389 for information on how to reprogram the configuration of these pins.

Table 4-3. JTAG Port Pins State after Power-On Reset or RST assertion

Pin Name	Data Direction	Internal Pull-Up	Internal Pull-Down	Drive Strength	Drive Value
TCK	Input	Enabled	Disabled	N/A	N/A
TMS	Input	Enabled	Disabled	N/A	N/A
TDI	Input	Enabled	Disabled	N/A	N/A
TDO	Output	Enabled	Disabled	2-mA driver	High-Z

4.3.1.1 Test Clock Input (TCK)

The ${ t TCK}$ pin is the clock for the JTAG module. This clock is provided so the test logic can operate independently of any other system clocks and to ensure that multiple JTAG TAP controllers that are daisy-chained together can synchronously communicate serial test data between components. During normal operation, ${ t TCK}$ is driven by a free-running clock with a nominal 50% duty cycle. When necessary, ${ t TCK}$ can be stopped at 0 or 1 for extended periods of time. While ${ t TCK}$ is stopped at 0 or 1, the state of the TAP controller does not change and data in the JTAG Instruction and Data Registers is not lost.

By default, the internal pull-up resistor on the TCK pin is enabled after reset, assuring that no clocking occurs if the pin is not driven from an external source. The internal pull-up and pull-down resistors can be turned off to save internal power as long as the TCK pin is constantly being driven by an external source (see page 418 and page 420).

4.3.1.2 Test Mode Select (TMS)

The TMS pin selects the next state of the JTAG TAP controller. TMS is sampled on the rising edge of TCK. Depending on the current TAP state and the sampled value of TMS, the next state may be entered. Because the TMS pin is sampled on the rising edge of TCK, the *IEEE Standard 1149.1* expects the value on TMS to change on the falling edge of TCK.

Holding TMS high for five consecutive TCK cycles drives the TAP controller state machine to the Test-Logic-Reset state. When the TAP controller enters the Test-Logic-Reset state, the JTAG module and associated registers are reset to their default values. This procedure should be performed to initialize the JTAG controller. The JTAG Test Access Port state machine can be seen in its entirety in Figure 4-2 on page 166.

By default, the internal pull-up resistor on the TMS pin is enabled after reset. Changes to the pull-up resistor settings on GPIO Port C should ensure that the internal pull-up resistor remains enabled on PC1/TMS; otherwise JTAG communication could be lost (see page 418).

4.3.1.3 Test Data Input (TDI)

The TDI pin provides a stream of serial information to the IR chain and the DR chains. TDI is sampled on the rising edge of TCK and, depending on the current TAP state and the current instruction, may present this data to the proper shift register chain. Because the TDI pin is sampled on the rising edge of TCK, the *IEEE Standard 1149.1* expects the value on TDI to change on the falling edge of TCK.

By default, the internal pull-up resistor on the TDI pin is enabled after reset. Changes to the pull-up resistor settings on GPIO Port C should ensure that the internal pull-up resistor remains enabled on PC2/TDI; otherwise JTAG communication could be lost (see page 418).

4.3.1.4 Test Data Output (TDO)

The TDO pin provides an output stream of serial information from the IR chain or the DR chains. The value of TDO depends on the current TAP state, the current instruction, and the data in the

chain being accessed. In order to save power when the JTAG port is not being used, the TDO pin is placed in an inactive drive state when not actively shifting out data. Because TDO can be connected to the TDI of another controller in a daisy-chain configuration, the *IEEE Standard 1149.1* expects the value on TDO to change on the falling edge of TCK.

By default, the internal pull-up resistor on the TDO pin is enabled after reset, assuring that the pin remains at a constant logic level when the JTAG port is not being used. The internal pull-up and pull-down resistors can be turned off to save internal power if a High-Z output value is acceptable during certain TAP controller states (see page 418 and page 420).

4.3.2 JTAG TAP Controller

The JTAG TAP controller state machine is shown in Figure 4-2. The TAP controller state machine is reset to the Test-Logic-Reset state on the assertion of a Power-On-Reset (POR). In order to reset the JTAG module after the microcontroller has been powered on, the TMS input must be held HIGH for five TCK clock cycles, resetting the TAP controller and all associated JTAG chains. Asserting the correct sequence on the TMS pin allows the JTAG module to shift in new instructions, shift in data, or idle during extended testing sequences. For detailed information on the function of the TAP controller and the operations that occur in each state, please refer to *IEEE Standard 1149.1*.

Test Logic Reset 0 Run Test Idle Select DR Scar Select IR Scar 0 0 Capture DR Capture IR 0 0 Shift DR Shift IR 1 1 Exit 1 DR Exit 1 IR 0 0 Pause DR Pause IR 1 Exit 2 DR Exit 2 IR 1 Update DR Update IR 1 0 1 0

Figure 4-2. Test Access Port State Machine

4.3.3 Shift Registers

The Shift Registers consist of a serial shift register chain and a parallel load register. The serial shift register chain samples specific information during the TAP controller's CAPTURE states and allows

this information to be shifted out on TDO during the TAP controller's SHIFT states. While the sampled data is being shifted out of the chain on TDO, new data is being shifted into the serial shift register on TDI. This new data is stored in the parallel load register during the TAP controller's UPDATE states. Each of the shift registers is discussed in detail in "Register Descriptions" on page 170.

4.3.4 Operational Considerations

Certain operational parameters must be considered when using the JTAG module. Because the JTAG pins can be programmed to be GPIOs, board configuration and reset conditions on these pins must be considered. In addition, because the JTAG module has integrated ARM Serial Wire Debug, the method for switching between these two operational modes is described below.

4.3.4.1 **GPIO** Functionality

When the microcontroller is reset with either a POR or RST, the JTAG/SWD port pins default to their JTAG/SWD configurations. The default configuration includes enabling digital functionality (DEN[3:0] set in the **Port C GPIO Digital Enable (GPIODEN)** register), enabling the pull-up resistors (PUE[3:0] set in the **Port C GPIO Pull-Up Select (GPIOPUR)** register), disabling the pull-down resistors (PDE[3:0] cleared in the **Port C GPIO Pull-Down Select (GPIOPDR)** register) and enabling the alternate hardware function (AFSEL[3:0] set in the **Port C GPIO Alternate Function Select (GPIOAFSEL)** register) on the JTAG/SWD pins. See page 412, page 418, page 420, and page 423.

It is possible for software to configure these pins as GPIOs after reset by clearing AFSEL[3:0] in the **Port C GPIOAFSEL** register. If the user does not require the JTAG/SWD port for debugging or board-level testing, this provides four more GPIOs for use in the design.

Caution – It is possible to create a software sequence that prevents the debugger from connecting to the Stellaris microcontroller. If the program code loaded into flash immediately changes the JTAG pins to their GPIO functionality, the debugger may not have enough time to connect and halt the controller before the JTAG pin functionality switches. As a result, the debugger may be locked out of the part. This issue can be avoided with a software routine that restores JTAG functionality based on an external or software trigger.

The GPIO commit control registers provide a layer of protection against accidental programming of critical hardware peripherals. Protection is provided for the NMI pin (PB7) and the four JTAG/SWD pins (PC[3:0]). Writes to protected bits of the GPIO Alternate Function Select (GPIOAFSEL) register (see page 412), GPIO Pull Up Select (GPIOPUR) register (see page 418), GPIO Pull-Down Select (GPIOPDR) register (see page 420), and GPIO Digital Enable (GPIODEN) register (see page 423) are not committed to storage unless the GPIO Lock (GPIOLOCK) register (see page 425) has been unlocked and the appropriate bits of the GPIO Commit (GPIOCR) register (see page 426) have been set.

4.3.4.2 Communication with JTAG/SWD

Because the debug clock and the system clock can be running at different frequencies, care must be taken to maintain reliable communication with the JTAG/SWD interface. In the Capture-DR state, the result of the previous transaction, if any, is returned, together with a 3-bit ACK response. Software should check the ACK response to see if the previous operation has completed before initiating a new transaction. Alternatively, if the system clock is at least 8 times faster than the debug clock (TCK or SWCLK), the previous operation has enough time to complete and the ACK bits do not have to be checked.

4.3.4.3 Recovering a "Locked" Microcontroller

Note: Performing the sequence below restores the non-volatile registers discussed in "Non-Volatile Register Programming" on page 300 to their factory default values. The mass erase of the Flash memory caused by the sequence below occurs prior to the non-volatile registers being restored.

If software configures any of the JTAG/SWD pins as GPIO and loses the ability to communicate with the debugger, there is a debug port unlock sequence that can be used to recover the microcontroller. Performing a total of ten JTAG-to-SWD and SWD-to-JTAG switch sequences while holding the microcontroller in reset mass erases the Flash memory. The debug port unlock sequence is:

- 1. Assert and hold the RST signal.
- 2. Apply power to the device.
- 3. Perform steps 1 and 2 of the JTAG-to-SWD switch sequence on the section called "JTAG-to-SWD Switching" on page 169.
- **4.** Perform steps 1 and 2 of the SWD-to-JTAG switch sequence on the section called "SWD-to-JTAG Switching" on page 169.
- **5.** Perform steps 1 and 2 of the JTAG-to-SWD switch sequence.
- **6.** Perform steps 1 and 2 of the SWD-to-JTAG switch sequence.
- 7. Perform steps 1 and 2 of the JTAG-to-SWD switch sequence.
- **8.** Perform steps 1 and 2 of the SWD-to-JTAG switch sequence.
- **9.** Perform steps 1 and 2 of the JTAG-to-SWD switch sequence.
- **10.** Perform steps 1 and 2 of the SWD-to-JTAG switch sequence.
- **11.** Perform steps 1 and 2 of the JTAG-to-SWD switch sequence.
- **12.** Perform steps 1 and 2 of the SWD-to-JTAG switch sequence.
- **13.** Release the \overline{RST} signal.
- 14. Wait 400 ms.
- **15.** Power-cycle the microcontroller.

4.3.4.4 ARM Serial Wire Debug (SWD)

In order to seamlessly integrate the ARM Serial Wire Debug (SWD) functionality, a serial-wire debugger must be able to connect to the Cortex-M3 core without having to perform, or have any knowledge of, JTAG cycles. This integration is accomplished with a SWD preamble that is issued before the SWD session begins.

The switching preamble used to enable the SWD interface of the SWJ-DP module starts with the TAP controller in the Test-Logic-Reset state. From here, the preamble sequences the TAP controller through the following states: Run Test Idle, Select DR, Select IR, Test Logic Reset, Test Logic Reset, Run Test Idle, Run Test Idle, Select DR, Select IR, Test Logic Reset, Test Logic Reset, Run Test Idle, Run Test Idle, Select DR, Select IR, and Test Logic Reset states.

Stepping through this sequence of the TAP state machine enables the SWD interface and disables the JTAG interface. For more information on this operation and the SWD interface, see the *ARM® Debug Interface V5 Architecture Specification*.

Because this sequence is a valid series of JTAG operations that could be issued, the ARM JTAG TAP controller is not fully compliant to the *IEEE Standard 1149.1*. This instance is the only one where the ARM JTAG TAP controller does not meet full compliance with the specification. Due to the low probability of this sequence occurring during normal operation of the TAP controller, it should not affect normal performance of the JTAG interface.

JTAG-to-SWD Switching

To switch the operating mode of the Debug Access Port (DAP) from JTAG to SWD mode, the external debug hardware must send the switching preamble to the microcontroller. The 16-bit TMS command for switching to SWD mode is defined as b1110.0111.1001.1110, transmitted LSB first. This command can also be represented as 0xE79E when transmitted LSB first. The complete switch sequence should consist of the following transactions on the TCK/SWCLK and TMS/SWDIO signals:

- 1. Send at least 50 TCK/SWCLK cycles with TMS/SWDIO High to ensure that both JTAG and SWD are in their reset/idle states.
- 2. Send the 16-bit JTAG-to-SWD switch command, 0xE79E, on TMS.
- 3. Send at least 50 TCK/SWCLK cycles with TMS/SWDIO High to ensure that if SWJ-DP was already in SWD mode, the SWD goes into the line reset state before sending the switch sequence.

SWD-to-JTAG Switching

To switch the operating mode of the Debug Access Port (DAP) from SWD to JTAG mode, the external debug hardware must send a switch command to the microcontroller. The 16-bit TMS command for switching to JTAG mode is defined as b1110.0111.0011.1100, transmitted LSB first. This command can also be represented as 0xE73C when transmitted LSB first. The complete switch sequence should consist of the following transactions on the TCK/SWCLK and TMS/SWDIO signals:

- 1. Send at least 50 TCK/SWCLK cycles with TMS/SWDIO High to ensure that both JTAG and SWD are in their reset/idle states.
- 2. Send the 16-bit SWD-to-JTAG switch command, 0xE73C, on TMS.
- 3. Send at least 50 TCK/SWCLK cycles with TMS/SWDIO High to ensure that if SWJ-DP was already in JTAG mode, the JTAG goes into the Test Logic Reset state before sending the switch sequence.

4.4 Initialization and Configuration

After a Power-On-Reset or an external reset (\overline{RST}), the JTAG pins are automatically configured for JTAG communication. No user-defined initialization or configuration is needed. However, if the user application changes these pins to their GPIO function, they must be configured back to their JTAG functionality before JTAG communication can be restored. To return the pins to their JTAG functions, enable the four JTAG pins (PC[3:0]) for their alternate function using the **GPIOAFSEL** register. In addition to enabling the alternate functions, any other changes to the GPIO pad configurations on the four JTAG pins (PC[3:0]) should be returned to their default settings.

4.5 Register Descriptions

The registers in the JTAG TAP Controller or Shift Register chains are not memory mapped and are not accessible through the on-chip Advanced Peripheral Bus (APB). Instead, the registers within the JTAG controller are all accessed serially through the TAP Controller. These registers include the Instruction Register and the six Data Registers.

4.5.1 Instruction Register (IR)

The JTAG TAP Instruction Register (IR) is a four-bit serial scan chain connected between the JTAG TDI and TDO pins with a parallel load register. When the TAP Controller is placed in the correct states, bits can be shifted into the IR. Once these bits have been shifted into the chain and updated, they are interpreted as the current instruction. The decode of the IR bits is shown in Table 4-4. A detailed explanation of each instruction, along with its associated Data Register, follows.

IR[3:0]	Instruction	Description
0x0	EXTEST	Drives the values preloaded into the Boundary Scan Chain by the SAMPLE/PRELOAD instruction onto the pads.
0x1	INTEST	Drives the values preloaded into the Boundary Scan Chain by the SAMPLE/PRELOAD instruction into the controller.
0x2	SAMPLE / PRELOAD	Captures the current I/O values and shifts the sampled values out of the Boundary Scan Chain while new preload data is shifted in.
0x8	ABORT	Shifts data into the ARM Debug Port Abort Register.
0xA	DPACC	Shifts data into and out of the ARM DP Access Register.
0xB	APACC	Shifts data into and out of the ARM AC Access Register.
0xE	IDCODE	Loads manufacturing information defined by the <i>IEEE Standard 1149.1</i> into the IDCODE chain and shifts it out.
0xF	BYPASS	Connects TDI to TDO through a single Shift Register chain.
All Others	Reserved	Defaults to the BYPASS instruction to ensure that \mathtt{TDI} is always connected to \mathtt{TDO} .

4.5.1.1 EXTEST Instruction

The EXTEST instruction is not associated with its own Data Register chain. Instead, the EXTEST instruction uses the data that has been preloaded into the Boundary Scan Data Register using the SAMPLE/PRELOAD instruction. When the EXTEST instruction is present in the Instruction Register, the preloaded data in the Boundary Scan Data Register associated with the outputs and output enables are used to drive the GPIO pads rather than the signals coming from the core. With tests that drive known values out of the controller, this instruction can be used to verify connectivity. While the EXTEST instruction is present in the Instruction Register, the Boundary Scan Data Register can be accessed to sample and shift out the current data and load new data into the Boundary Scan Data Register.

4.5.1.2 INTEST Instruction

The INTEST instruction is not associated with its own Data Register chain. Instead, the INTEST instruction uses the data that has been preloaded into the Boundary Scan Data Register using the SAMPLE/PRELOAD instruction. When the INTEST instruction is present in the Instruction Register, the preloaded data in the Boundary Scan Data Register associated with the inputs are used to drive the signals going into the core rather than the signals coming from the GPIO pads. With tests that drive known values into the controller, this instruction can be used for testing. It is important to note that although the RST input pin is on the Boundary Scan Data Register chain, it is only observable.

While the INTEST instruction is present in the Instruction Register, the Boundary Scan Data Register can be accessed to sample and shift out the current data and load new data into the Boundary Scan Data Register.

4.5.1.3 SAMPLE/PRELOAD Instruction

The SAMPLE/PRELOAD instruction connects the Boundary Scan Data Register chain between TDI and TDO. This instruction samples the current state of the pad pins for observation and preloads new test data. Each GPIO pad has an associated input, output, and output enable signal. When the TAP controller enters the Capture DR state during this instruction, the input, output, and output-enable signals to each of the GPIO pads are captured. These samples are serially shifted out on TDO while the TAP controller is in the Shift DR state and can be used for observation or comparison in various tests.

While these samples of the inputs, outputs, and output enables are being shifted out of the Boundary Scan Data Register, new data is being shifted into the Boundary Scan Data Register from TDI. Once the new data has been shifted into the Boundary Scan Data Register, the data is saved in the parallel load registers when the TAP controller enters the Update DR state. This update of the parallel load register preloads data into the Boundary Scan Data Register that is associated with each input, output, and output enable. This preloaded data can be used with the EXTEST and INTEST instructions to drive data into or out of the controller. See "Boundary Scan Data Register" on page 172 for more information.

4.5.1.4 ABORT Instruction

The ABORT instruction connects the associated ABORT Data Register chain between TDI and TDO. This instruction provides read and write access to the ABORT Register of the ARM Debug Access Port (DAP). Shifting the proper data into this Data Register clears various error bits or initiates a DAP abort of a previous request. See the "ABORT Data Register" on page 173 for more information.

4.5.1.5 DPACC Instruction

The DPACC instruction connects the associated DPACC Data Register chain between TDI and TDO. This instruction provides read and write access to the DPACC Register of the ARM Debug Access Port (DAP). Shifting the proper data into this register and reading the data output from this register allows read and write access to the ARM debug and status registers. See "DPACC Data Register" on page 173 for more information.

4.5.1.6 APACC Instruction

The APACC instruction connects the associated APACC Data Register chain between TDI and TDO. This instruction provides read and write access to the APACC Register of the ARM Debug Access Port (DAP). Shifting the proper data into this register and reading the data output from this register allows read and write access to internal components and buses through the Debug Port. See "APACC Data Register" on page 173 for more information.

4.5.1.7 IDCODE Instruction

The IDCODE instruction connects the associated IDCODE Data Register chain between TDI and TDO. This instruction provides information on the manufacturer, part number, and version of the ARM core. This information can be used by testing equipment and debuggers to automatically configure input and output data streams. IDCODE is the default instruction loaded into the JTAG Instruction Register when a Power-On-Reset (POR) is asserted, or the Test-Logic-Reset state is entered. See "IDCODE Data Register" on page 172 for more information.

4.5.1.8 BYPASS Instruction

The BYPASS instruction connects the associated BYPASS Data Register chain between TDI and TDO. This instruction is used to create a minimum length serial path between the TDI and TDO ports. The BYPASS Data Register is a single-bit shift register. This instruction improves test efficiency by allowing components that are not needed for a specific test to be bypassed in the JTAG scan chain by loading them with the BYPASS instruction. See "BYPASS Data Register" on page 172 for more information.

4.5.2 Data Registers

The JTAG module contains six Data Registers. These serial Data Register chains include: IDCODE, BYPASS, Boundary Scan, APACC, DPACC, and ABORT and are discussed in the following sections.

4.5.2.1 IDCODE Data Register

The format for the 32-bit IDCODE Data Register defined by the *IEEE Standard 1149.1* is shown in Figure 4-3. The standard requires that every JTAG-compliant microcontroller implement either the IDCODE instruction or the BYPASS instruction as the default instruction. The LSB of the IDCODE Data Register is defined to be a 1 to distinguish it from the BYPASS instruction, which has an LSB of 0. This definition allows auto-configuration test tools to determine which instruction is the default instruction.

The major uses of the JTAG port are for manufacturer testing of component assembly and program development and debug. To facilitate the use of auto-configuration debug tools, the IDCODE instruction outputs a value of 0x4BA0.0477. This value allows the debuggers to automatically configure themselves to work correctly with the Cortex-M3 during debug.

Figure 4-3. IDCODE Register Format



4.5.2.2 BYPASS Data Register

The format for the 1-bit BYPASS Data Register defined by the *IEEE Standard 1149.1* is shown in Figure 4-4. The standard requires that every JTAG-compliant microcontroller implement either the BYPASS instruction or the IDCODE instruction as the default instruction. The LSB of the BYPASS Data Register is defined to be a 0 to distinguish it from the IDCODE instruction, which has an LSB of 1. This definition allows auto-configuration test tools to determine which instruction is the default instruction.

Figure 4-4. BYPASS Register Format

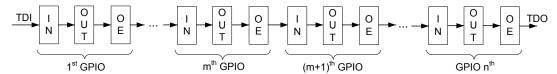
4.5.2.3 Boundary Scan Data Register

The format of the Boundary Scan Data Register is shown in Figure 4-5. Each GPIO pin, starting with a GPIO pin next to the JTAG port pins, is included in the Boundary Scan Data Register. Each

GPIO pin has three associated digital signals that are included in the chain. These signals are input, output, and output enable, and are arranged in that order as shown in the figure.

When the Boundary Scan Data Register is accessed with the SAMPLE/PRELOAD instruction, the input, output, and output enable from each digital pad are sampled and then shifted out of the chain to be verified. The sampling of these values occurs on the rising edge of TCK in the Capture DR state of the TAP controller. While the sampled data is being shifted out of the Boundary Scan chain in the Shift DR state of the TAP controller, new data can be preloaded into the chain for use with the EXTEST and INTEST instructions. The EXTEST instruction forces data out of the controller, and the INTEST instruction forces data into the controller.

Figure 4-5. Boundary Scan Register Format



4.5.2.4 APACC Data Register

The format for the 35-bit APACC Data Register defined by ARM is described in the *ARM® Debug Interface V5 Architecture Specification*.

4.5.2.5 DPACC Data Register

The format for the 35-bit DPACC Data Register defined by ARM is described in the *ARM® Debug Interface V5 Architecture Specification*.

4.5.2.6 ABORT Data Register

The format for the 35-bit ABORT Data Register defined by ARM is described in the *ARM® Debug Interface V5 Architecture Specification*.

5 System Control

System control configures the overall operation of the device and provides information about the device. Configurable features include reset control, NMI operation, power control, clock control, and low-power modes.

5.1 Signal Description

The following table lists the external signals of the System Control module and describes the function of each. The NMI signal is the alternate function for the GPIO PB7 signal and functions as a GPIO after reset. PB7 is under commit protection and requires a special process to be configured as any alternate function or to subsequently return to the GPIO function, see "Commit Control" on page 397. The column in the table below titled "Pin Mux/Pin Assignment" lists the GPIO pin placement for the NMI signal. The AFSEL bit in the **GPIO Alternate Function Select (GPIOAFSEL)** register (page 412) should be set to choose the NMI function. The number in parentheses is the encoding that must be programmed into the PMCn field in the **GPIO Port Control (GPIOPCTL)** register (page 430) to assign the NMI signal to the specified GPIO port pin. For more information on configuring GPIOs, see "General-Purpose Input/Outputs (GPIOs)" on page 389. The remaining signals (with the word "fixed" in the Pin Mux/Pin Assignment column) have a fixed pin assignment and function.

Table 5-1. System Control & Clocks Signals (100LQFP)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
NMI	89	PB7 (4)	1	TTL	Non-maskable interrupt.
osc0	48	fixed	I	Analog	Main oscillator crystal input or an external clock reference input.
OSC1	49	fixed	0	Analog	Main oscillator crystal output. Leave unconnected when using a single-ended clock source.
RST	64	fixed	1	TTL	System reset input.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

Table 5-2. System Control & Clocks Signals (108BGA)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
NMI	A8	PB7 (4)	1	TTL	Non-maskable interrupt.
OSC0	L11	fixed	I	Analog	Main oscillator crystal input or an external clock reference input.
OSC1	M11	fixed	0	Analog	Main oscillator crystal output. Leave unconnected when using a single-ended clock source.
RST	H11	fixed	1	TTL	System reset input.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

5.2 Functional Description

The System Control module provides the following capabilities:

- Device identification, see "Device Identification" on page 175
- Local control, such as reset (see "Reset Control" on page 175), power (see "Power Control" on page 180) and clock control (see "Clock Control" on page 181)

■ System control (Run, Sleep, and Deep-Sleep modes), see "System Control" on page 188

5.2.1 Device Identification

Several read-only registers provide software with information on the microcontroller, such as version, part number, SRAM size, Flash memory size, and other features. See the **DID0** (page 193), **DID1** (page 220), **DC0-DC9** (page 222) and **NVMSTAT** (page 239) registers.

5.2.2 Reset Control

This section discusses aspects of hardware functions during reset as well as system software requirements following the reset sequence.

5.2.2.1 Reset Sources

The LM3S1J11 microcontroller has six sources of reset:

- 1. Power-on reset (POR) (see page 176).
- **2.** External reset input pin (\overline{RST}) assertion (see page 176).
- 3. Internal brown-out (BOR) detector (see page 178).
- **4.** Software-initiated reset (with the software reset registers) (see page 178).
- **5.** A watchdog timer reset condition violation (see page 179).
- 6. MOSC failure (see page 180).

Table 5-3 provides a summary of results of the various reset operations.

Table 5-3. Reset Sources

Reset Source	Core Reset?	JTAG Reset?	On-Chip Peripherals Reset?
Power-On Reset	Yes	Yes	Yes
RST	Yes	Yes	Yes
Brown-Out Reset	Yes	Yes	Yes
Software System Request Reset using the SYSRESREQ bit in the APINT register.	Yes	Yes	Yes
Software System Request Reset using the VECTRESET bit in the APINT register.	Yes	No	No
Software Peripheral Reset	No	Yes	Yes ^a
Watchdog Reset	Yes	Yes	Yes
MOSC Failure Reset	Yes	Yes	Yes

a. Programmable on a module-by-module basis using the Software Reset Control Registers.

After a reset, the **Reset Cause (RESC)** register is set with the reset cause. The bits in this register are sticky and maintain their state across multiple reset sequences, except when an internal POR is the cause, in which case, all the bits in the **RESC** register are cleared except for the POR indicator. A bit in the **RESC** register can be cleared by writing a 0.

At any reset that resets the core, the user has the opportunity to direct the core to execute the ROM Boot Loader or the application in Flash memory by using any GPIO signal as configured in the **Boot Configuration (BOOTCFG)** register.

At reset, the ROM is mapped over the Flash memory so that the ROM boot sequence is always executed. The boot sequence executed from ROM is as follows:

- 1. The BA bit (below) is cleared such that ROM is mapped to 0x01xx.xxxx and Flash memory is mapped to address 0x0.
- 2. The **BOOTCFG** register is read. If the EN bit is clear, the status of the specified GPIO pin is compared with the specified polarity. If the status matches the specified polarity, the ROM is mapped to address 0x0000.0000 and execution continues out of the ROM Boot Loader.
- 3. If the status doesn't match the specified polarity, the data at address 0x0000.0004 is read, and if the data at this address is 0xFFFF.FFFF, the ROM is mapped to address 0x0000.0000 and execution continues out of the ROM Boot Loader.
- **4.** If there is valid data at address 0x0000.0004, the stack pointer (**SP**) is loaded from Flash memory at address 0x0000.0000 and the program counter (**PC**) is loaded from address 0x0000.0004. The user application begins executing.

For example, if the **BOOTCFG** register is written and committed with the value of 0x0000.3C01, then PB7 is examined at reset to determine if the ROM Boot Loader should be executed. If PB7 is Low, the core unconditionally begins executing the ROM boot loader. If PB7 is High, then the application in Flash memory is executed if the reset vector at location 0x0000.0004 is not 0xFFFF.FFFF. Otherwise, the ROM boot loader is executed.

5.2.2.2 Power-On Reset (POR)

The internal Power-On Reset (POR) circuit monitors the power supply voltage (V_{DD}) and generates a reset signal to all of the internal logic including JTAG when the power supply ramp reaches a threshold value (V_{TH}). The microcontroller must be operating within the specified operating parameters when the on-chip power-on reset pulse is complete (see "Power and Brown-Out" on page 800). For applications that require the use of an external reset signal to hold the microcontroller in reset longer than the internal POR, the \overline{RST} input may be used as discussed in "External \overline{RST} Pin" on page 176.

The Power-On Reset sequence is as follows:

- 1. The microcontroller waits for internal POR to go inactive.
- 2. The internal reset is released and the core loads from memory the initial stack pointer, the initial program counter, and the first instruction designated by the program counter, and then begins execution.

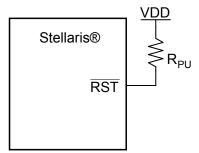
The internal POR is only active on the initial power-up of the microcontroller and when the microcontroller wakes from hibernation. The Power-On Reset timing is shown in Figure 20-4 on page 800.

5.2.2.3 External RST Pin

Note: It is recommended that the trace for the $\overline{\mathtt{RST}}$ signal must be kept as short as possible. Be sure to place any components connected to the $\overline{\mathtt{RST}}$ signal as close to the microcontroller as possible.

If the application only uses the internal POR circuit, the $\overline{\text{RST}}$ input must be connected to the power supply (V_{DD}) through an optional pull-up resistor (0 to 100K Ω) as shown in Figure 5-1 on page 177.

Figure 5-1. Basic RST Configuration



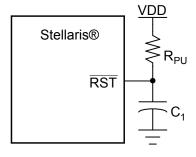
 R_{PU} = 0 to 100 k Ω

The external reset pin (RST) resets the microcontroller including the core and all the on-chip peripherals except the JTAG TAP controller (see "JTAG Interface" on page 162). The external reset sequence is as follows:

- 1. The external reset pin (\overline{RST}) is asserted for the duration specified by T_{MIN} and then de-asserted (see "Reset" on page 801).
- 2. The internal reset is released and the core loads from memory the initial stack pointer, the initial program counter, and the first instruction designated by the program counter, and then begins execution.

To improve noise immunity and/or to delay reset at power up, the $\overline{\mathtt{RST}}$ input may be connected to an RC network as shown in Figure 5-2 on page 177.

Figure 5-2. External Circuitry to Extend Power-On Reset

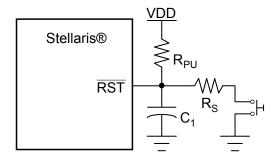


 R_{PU} = 1 k Ω to 100 k Ω

 $C_1 = 1 \text{ nF to } 10 \mu\text{F}$

If the application requires the use of an external reset switch, Figure 5-3 on page 178 shows the proper circuitry to use.

Figure 5-3. Reset Circuit Controlled by Switch



Typical R_{PU} = 10 $k\Omega$

Typical $R_S = 470 \Omega$

 $C_1 = 10 \text{ nF}$

The R_{PLI} and C₁ components define the power-on delay.

The external reset timing is shown in Figure 20-7 on page 801.

5.2.2.4 Brown-Out Reset (BOR)

The microcontroller provides a brown-out detection circuit that triggers if the power supply (V_{DD}) drops below a brown-out threshold voltage (V_{BTH}) . If a brown-out condition is detected, the system may generate an interrupt or a system reset. The default condition is to generate an interrupt, so BOR must be enabled. Brown-out resets are controlled with the **Power-On and Brown-Out Reset Control (PBORCTL)** register. The BORIOR bit in the **PBORCTL** register must be set for a brown-out condition to trigger a reset; if BORIOR is clear, an interrupt is generated. When a Brown-out condition occurs during a Flash PROGRAM or ERASE operation, a full system reset is always triggered without regard to the setting in the **PBORCTL** register.

The brown-out reset sequence is as follows:

- **1.** When V_{DD} drops below V_{BTH} , an internal BOR condition is set.
- 2. If the BOR condition exists, an internal reset is asserted.
- 3. The internal reset is released and the microcontroller fetches and loads the initial stack pointer, the initial program counter, the first instruction designated by the program counter, and begins execution.
- **4.** The internal BOR condition is reset after 500 μs to prevent another BOR condition from being set before software has a chance to investigate the original cause.

The result of a brown-out reset is equivalent to that of an assertion of the external $\overline{\mathtt{RST}}$ input, and the reset is held active until the proper V_{DD} level is restored. The **RESC** register can be examined in the reset interrupt handler to determine if a Brown-Out condition was the cause of the reset, thus allowing software to determine what actions are required to recover.

The internal Brown-Out Reset timing is shown in Figure 20-5 on page 800.

5.2.2.5 Software Reset

Software can reset a specific peripheral or generate a reset to the entire microcontroller.

Peripherals can be individually reset by software via three registers that control reset signals to each on-chip peripheral (see the **SRCRn** registers, page 261). If the bit position corresponding to a peripheral is set and subsequently cleared, the peripheral is reset. The encoding of the reset registers is consistent with the encoding of the clock gating control for peripherals and on-chip functions (see "System Control" on page 188).

The entire microcontroller, including the core, can be reset by software by setting the SYSRESREQ bit in the **Application Interrupt and Reset Control (APINT)** register. The software-initiated system reset sequence is as follows:

- 1. A software microcontroller reset is initiated by setting the SYSRESREQ bit.
- 2. An internal reset is asserted.
- **3.** The internal reset is deasserted and the microcontroller loads from memory the initial stack pointer, the initial program counter, and the first instruction designated by the program counter, and then begins execution.

The core only can be reset by software by setting the VECTRESET bit in the APINT register. The software-initiated core reset sequence is as follows:

- 1. A core reset is initiated by setting the VECTRESET bit.
- 2. An internal reset is asserted.
- **3.** The internal reset is deasserted and the microcontroller loads from memory the initial stack pointer, the initial program counter, and the first instruction designated by the program counter, and then begins execution.

The software-initiated system reset timing is shown in Figure 20-8 on page 801.

5.2.2.6 Watchdog Timer Reset

The Watchdog Timer module's function is to prevent system hangs. The LM3S1J11 microcontroller has two Watchdog Timer modules in case one watchdog clock source fails. One watchdog is run off the system clock and the other is run off the Precision Internal Oscillator (PIOSC). Each module operates in the same manner except that because the PIOSC watchdog timer module is in a different clock domain, register accesses must have a time delay between them. The watchdog timer can be configured to generate an interrupt to the microcontroller on its first time-out and to generate a reset on its second time-out.

After the watchdog's first time-out event, the 32-bit watchdog counter is reloaded with the value of the **Watchdog Timer Load (WDTLOAD)** register and resumes counting down from that value. If the timer counts down to zero again before the first time-out interrupt is cleared, and the reset signal has been enabled, the watchdog timer asserts its reset signal to the microcontroller. The watchdog timer reset sequence is as follows:

- 1. The watchdog timer times out for the second time without being serviced.
- 2. An internal reset is asserted.
- 3. The internal reset is released and the microcontroller loads from memory the initial stack pointer, the initial program counter, and the first instruction designated by the program counter, and then begins execution.

For more information on the Watchdog Timer module, see "Watchdog Timers" on page 491.

The watchdog reset timing is shown in Figure 20-9 on page 802.

5.2.3 Non-Maskable Interrupt

The microcontroller has three sources of non-maskable interrupt (NMI):

- The assertion of the NMI signal
- A main oscillator verification error
- The NMISET bit in the Interrupt Control and State (INTCTRL) register in the Cortex[™]-M3 (see page 127).

Software must check the cause of the interrupt in order to distinguish among the sources.

5.2.3.1 NMI Pin

The NMI signal is the alternate function for GPIO port pin PB7. The alternate function must be enabled in the GPIO for the signal to be used as an interrupt, as described in "General-Purpose Input/Outputs (GPIOs)" on page 389. Note that enabling the NMI alternate function requires the use of the GPIO lock and commit function just like the GPIO port pins associated with JTAG/SWD functionality, see page 426. The active sense of the NMI signal is High; asserting the enabled NMI signal above V_{IH} initiates the NMI interrupt sequence.

5.2.3.2 Main Oscillator Verification Failure

The LM3S1J11 microcontroller provides a main oscillator verification circuit that generates an error condition if the oscillator is running too fast or too slow. If the main oscillator verification circuit is enabled and a failure occurs, a power-on reset is generated and control is transferred to the NMI handler. The NMI handler is used to address the main oscillator verification failure because the necessary code can be removed from the general reset handler, speeding up reset processing. The detection circuit is enabled by setting the CVAL bit in the **Main Oscillator Control (MOSCCTL)** register. The main oscillator verification error is indicated in the main oscillator fail status (MOSCFAIL) bit in the **Reset Cause (RESC)** register. The main oscillator verification circuit action is described in more detail in "Main Oscillator Verification Circuit" on page 188.

5.2.4 Power Control

The Stellaris[®] microcontroller provides an integrated LDO regulator that is used to provide power to the majority of the microcontroller's internal logic. Figure 5-4 shows the power architecture.

An external LDO may not be used.

Note: VDDA must be supplied with a voltage that meets the specification in Table 20-2 on page 797, or the microcontroller does not function properly. VDDA is the supply for all of the analog circuitry on the device, including the clock circuitry.

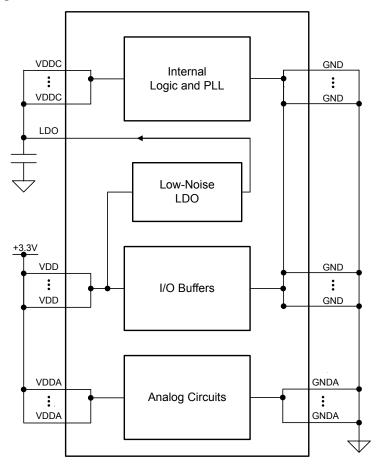


Figure 5-4. Power Architecture

5.2.5 Clock Control

System control determines the control of clocks in this part.

5.2.5.1 Fundamental Clock Sources

There are multiple clock sources for use in the microcontroller:

- Precision Internal Oscillator (PIOSC). The precision internal oscillator is an on-chip clock source that is the clock source the microcontroller uses during and following POR. It does not require the use of any external components and provides a clock that is 16 MHz ±1% at room temperature and ±3% across temperature. The PIOSC allows for a reduced system cost in applications that require an accurate clock source. If the main oscillator is required, software must enable the main oscillator following reset and allow the main oscillator to stabilize before changing the clock reference. If the Hibernation Module clock source is a 32.768-kHz oscillator, the precision internal oscillator can be trimmed by software based on a reference clock for increased accuracy.
- Main Oscillator (MOSC). The main oscillator provides a frequency-accurate clock source by one of two means: an external single-ended clock source is connected to the OSCO input pin, or an external crystal is connected across the OSCO input and OSC1 output pins. If the PLL is being used, the crystal value must be one of the supported frequencies between 3.579545 MHz to

16.384 MHz (inclusive). If the PLL is not being used, the crystal may be any one of the supported frequencies between 1 MHz to 16.384 MHz. The single-ended clock source range is from DC through the specified speed of the microcontroller. The supported crystals are listed in the XTAL bit field in the **RCC** register (see page 204).

- Internal 30-kHz Oscillator. The internal 30-kHz oscillator provides an operational frequency of 30 kHz ± 50%. It is intended for use during Deep-Sleep power-saving modes. This power-savings mode benefits from reduced internal switching and also allows the MOSC to be powered down.
- **Hibernation Module Clock Source.** The Hibernation module can be clocked in one of two ways. The first way is a 4.194304-MHz crystal connected to the xosc0 and xosc1 pins. This clock signal is divided by 128 internally to produce the 32.768-kHz clock reference. The second way is a 32.768-kHz oscillator connected to the xosc0 pin. The 32.768-kHz oscillator can be used for the system clock, thus eliminating the need for an additional crystal or oscillator. The Hibernation module clock source is intended to provide the system with a real-time clock source and may also provide an accurate source of Deep-Sleep or Hibernate mode power savings.

The internal system clock (SysClk), is derived from any of the above sources plus two others: the output of the main internal PLL and the precision internal oscillator divided by four (4 MHz \pm 1%). The frequency of the PLL clock reference must be in the range of 3.579545 MHz to 16.384 MHz (inclusive). Table 5-4 on page 182 shows how the various clock sources can be used in a system.

Clock Source	Drive PLL?		Used as SysClk?	
Precision Internal Oscillator	Yes	BYPASS = 0, OSCSRC = 0x1	Yes	BYPASS = 1, OSCSRC = 0x1
Precision Internal Oscillator divide by 4 (4 MHz ± 1%)	No	-	Yes	BYPASS = 1, OSCSRC = 0x2
Main Oscillator	Yes	BYPASS = 0, OSCSRC = 0x0	Yes	BYPASS = 1, OSCSRC = 0x0
Internal 30-kHz Oscillator	No	-	Yes	BYPASS = 1, OSCSRC = 0x3
Hibernation Module 32.768-kHz Oscillator	No	-	Yes	BYPASS = 1, OSCSRC2 = 0x7
Hibernation Module 4.194304-MHz Crystal	No	-	No	-

5.2.5.2 Clock Configuration

The Run-Mode Clock Configuration (RCC) and Run-Mode Clock Configuration 2 (RCC2) registers provide control for the system clock. The RCC2 register is provided to extend fields that offer additional encodings over the RCC register. When used, the RCC2 register field values are used by the logic over the corresponding field in the RCC register. In particular, RCC2 provides for a larger assortment of clock configuration options. These registers control the following clock functionality:

- Source of clocks in sleep and deep-sleep modes
- System clock derived from PLL or other clock source
- Enabling/disabling of oscillators and PLL
- Clock divisors

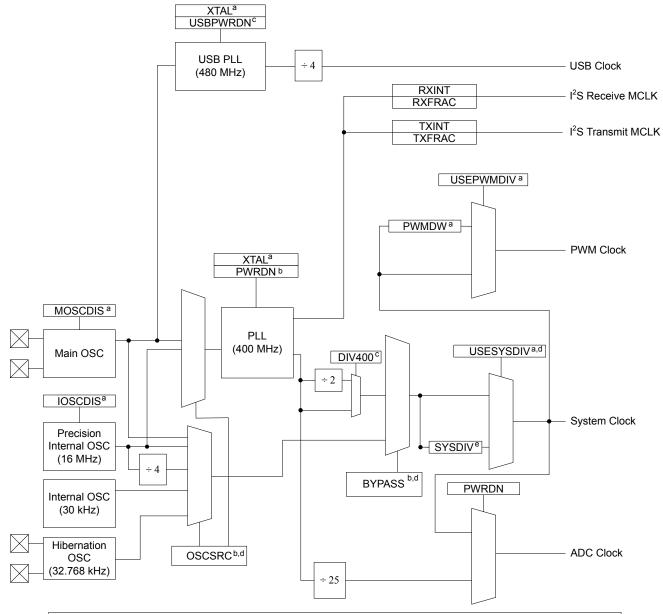
Crystal input selection

Important: Write the **RCC** register prior to writing the **RCC2** register. If a subsequent write to the **RCC** register is required, include another register access after writing the **RCC** register and before writing the **RCC2** register.

Figure 5-5 shows the logic for the main clock tree. The peripheral blocks are driven by the system clock signal and can be individually enabled/disabled. When the PLL is enabled, the ADC clock signal is automatically divided down to 16 MHz from the PLL output for proper ADC operation.

Note: When the ADC module is in operation, the system clock must be at least 16 MHz.

Figure 5-5. Main Clock Tree



- a. Control provided by RCC register bit/field.
- b. Control provided by RCC register bit/field or RCC2 register bit/field, if overridden with RCC2 register bit USERCC2.
- c. Control provided by RCC2 register bit/field.
- d. Also may be controlled by **DSLPCLKCFG** when in deep sleep mode.
- e. Control provided by **RCC** register SYSDIV field, **RCC2** register SYSDIV2 field if overridden with USERCC2 bit, or [SYSDIV2,SYSDIV2LSB] if both USERCC2 and DIV400 bits are set.

Note: The figure above shows all features available on all Stellaris® Tempest-class microcontrollers. Not all peripherals may be available on this device.

Using the SYSDIV and SYSDIV2 Fields

In the RCC register, the SYSDIV field specifies which divisor is used to generate the system clock from either the PLL output or the oscillator source (depending on how the BYPASS bit in this register

is configured). When using the PLL, the VCO frequency of 400 MHz is predivided by 2 before the divisor is applied. Table 5-5 shows how the SYSDIV encoding affects the system clock frequency, depending on whether the PLL is used (BYPASS=0) or another clock source is used (BYPASS=1). The divisor is equivalent to the SYSDIV encoding plus 1. For a list of possible clock sources, see Table 5-4 on page 182.

Table 5-5. Possible System Clock Frequencies Using the SYSDIV Field

SYSDIV	Divisor	Frequency (BYPASS=0)	Frequency (BYPASS=1)	StellarisWare [®] Parameter ^a
0x0	/1	reserved	Clock source frequency/1	SYSCTL_SYSDIV_1
0x1	/2	reserved	Clock source frequency/2	SYSCTL_SYSDIV_2
0x2	/3	reserved	Clock source frequency/3	SYSCTL_SYSDIV_3
0x3	/4	50 MHz	Clock source frequency/4	SYSCTL_SYSDIV_4
0x4	/5	40 MHz	Clock source frequency/5	SYSCTL_SYSDIV_5
0x5	/6	33.33 MHz	Clock source frequency/6	SYSCTL_SYSDIV_6
0x6	/7	28.57 MHz	Clock source frequency/7	SYSCTL_SYSDIV_7
0x7	/8	25 MHz	Clock source frequency/8	SYSCTL_SYSDIV_8
0x8	/9	22.22 MHz	Clock source frequency/9	SYSCTL_SYSDIV_9
0x9	/10	20 MHz	Clock source frequency/10	SYSCTL_SYSDIV_10
0xA	/11	18.18 MHz	Clock source frequency/11	SYSCTL_SYSDIV_11
0xB	/12	16.67 MHz	Clock source frequency/12	SYSCTL_SYSDIV_12
0xC	/13	15.38 MHz	Clock source frequency/13	SYSCTL_SYSDIV_13
0xD	/14	14.29 MHz	Clock source frequency/14	SYSCTL_SYSDIV_14
0xE	/15	13.33 MHz	Clock source frequency/15	SYSCTL_SYSDIV_15
0xF	/16	12.5 MHz (default)	Clock source frequency/16	SYSCTL_SYSDIV_16

a. This parameter is used in functions such as SysCtlClockSet() in the Stellaris Peripheral Driver Library.

The SYSDIV2 field in the **RCC2** register is 2 bits wider than the SYSDIV field in the **RCC** register so that additional larger divisors up to /64 are possible, allowing a lower system clock frequency for improved Deep Sleep power consumption. When using the PLL, the VCO frequency of 400 MHz is predivided by 2 before the divisor is applied. The divisor is equivalent to the SYSDIV2 encoding plus 1. Table 5-6 shows how the SYSDIV2 encoding affects the system clock frequency, depending on whether the PLL is used (BYPASS2=0) or another clock source is used (BYPASS2=1). For a list of possible clock sources, see Table 5-4 on page 182.

Table 5-6. Examples of Possible System Clock Frequencies Using the SYSDIV2 Field

SYSDIV2	Divisor	Frequency (BYPASS2=0)	Frequency (BYPASS2=1)	StellarisWare Parameter ^a
0x00	/1	reserved	Clock source frequency/1	SYSCTL_SYSDIV_1
0x01	/2	reserved	Clock source frequency/2	SYSCTL_SYSDIV_2
0x02	/3	reserved	Clock source frequency/3	SYSCTL_SYSDIV_3
0x03	/4	50 MHz	Clock source frequency/4	SYSCTL_SYSDIV_4
0x04	/5	40 MHz	Clock source frequency/5	SYSCTL_SYSDIV_5
0x09	/10	20 MHz	Clock source frequency/10	SYSCTL_SYSDIV_10

Table 5-6. Examples of Possible System Clock Frequencies Using the SYSDIV2 Field (continued)

SYSDIV2		Frequency (BYPASS2=0)	Frequency (BYPASS2=1)	StellarisWare Parameter ^a
0x3F	/64	3.125 MHz	Clock source frequency/64	SYSCTL_SYSDIV_64

a. This parameter is used in functions such as SysCtlClockSet() in the Stellaris Peripheral Driver Library.

To allow for additional frequency choices when using the PLL, the DIV400 bit is provided along with the SYSDIV2LSB bit. When the DIV400 bit is set, bit 22 becomes the LSB for SYSDIV2. In this situation, the divisor is equivalent to the (SYSDIV2 encoding with SYSDIV2LSB appended) plus one. Table 5-7 shows the frequency choices when DIV400 is set. When the DIV400 bit is clear, SYSDIV2LSB is ignored, and the system clock frequency is determined as shown in Table 5-6 on page 185.

Table 5-7. Examples of Possible System Clock Frequencies with DIV400=1

SYSDIV2	SYSDIV2LSB	Divisor	Frequency (BYPASS2=0) ^a	StellarisWare Parameter ^b
0x00	reserved	/2	reserved	-
0.04	0	/3	reserved	-
0x01	1	/4	reserved	-
0x02	0	/5	reserved	-
UXUZ			reserved	-
0.003		/7	reserved	-
0x03	1	/8	50 MHz	SYSCTL_SYSDIV_4
0 /9 1 /10		/9	44.44 MHz	SYSCTL_SYSDIV_4_5
		40 MHz	SYSCTL_SYSDIV_5	
0x3F	0	/127	3.15 MHz	SYSCTL_SYSDIV_63_5
UXOF	1	/128	3.125 MHz	SYSCTL_SYSDIV_64

a. Note that DIV400 and SYSDIV2LSB are only valid when BYPASS2=0.

5.2.5.3 Precision Internal Oscillator Operation (PIOSC)

The microcontroller powers up with the PIOSC running. If another clock source is desired, the PIOSC must remain enabled as it is used for internal functions. The PIOSC can only be disabled during Deep-Sleep mode. It can be powered down by setting the IOSCDIS bit in the RCC register.

The PIOSC generates a 16-MHz clock with a $\pm 1\%$ accuracy at room temperatures. Across the extended temperature range, the accuracy is $\pm 3\%$. At the factory, the PIOSC is set to 16 MHz at room temperature, however, the frequency can be trimmed for other voltage or temperature conditions using software in one of three ways:

- Default calibration: clear the UTEN bit and set the UPDATE bit in the **Precision Internal Oscillator** Calibration (PIOSCCAL) register.
- User-defined calibration: The user can program the UT value to adjust the PIOSC frequency. As the UT value increases, the generated period increases. To commit a new UT value, first set the UTEN bit, then program the UT field, and then set the UPDATE bit. The adjustment finishes within a few clock periods and is glitch free.

b. This parameter is used in functions such as SysCtlClockSet() in the Stellaris Peripheral Driver Library.

■ Automatic calibration using the Hibernation module with a functioning 32.768-kHz clock source: Set the CAL bit in the PIOSCCAL register; the results of the calibration are shown in the RESULT field in the Precision Internal Oscillator Statistic (PIOSCSTAT) register. After calibration is complete, the PIOSC is trimmed using the trimmed value returned in the CT field.

5.2.5.4 Crystal Configuration for the Main Oscillator (MOSC)

The main oscillator supports the use of a select number of crystals. If the main oscillator is used by the PLL as a reference clock, the supported range of crystals is 3.579545 to 16.384 MHz, otherwise, the range of supported crystals is 1 to 16.384 MHz.

The XTAL bit in the **RCC** register (see page 204) describes the available crystal choices and default programming values.

Software configures the **RCC** register XTAL field with the crystal number. If the PLL is used in the design, the XTAL field value is internally translated to the PLL settings.

5.2.5.5 Main PLL Frequency Configuration

The main PLL is disabled by default during power-on reset and is enabled later by software if required. Software specifies the output divisor to set the system clock frequency and enables the main PLL to drive the output. The PLL operates at 400 MHz, but is divided by two prior to the application of the output divisor, unless the DIV400 bit in the **RCC2** register is set.

To configure the PIOSC to be the clock source for the main PLL, program the OSCRC2 field in the Run-Mode Clock Configuration 2 (RCC2) register to be 0x1.

If the main oscillator provides the clock reference to the main PLL, the translation provided by hardware and used to program the PLL is available for software in the **XTAL** to **PLL Translation** (**PLLCFG**) register (see page 208). The internal translation provides a translation within \pm 1% of the targeted PLL VCO frequency. Table 20-8 on page 803 shows the actual PLL frequency and error for a given crystal choice.

The Crystal Value field (XTAL) in the **Run-Mode Clock Configuration (RCC)** register (see page 204) describes the available crystal choices and default programming of the **PLLCFG** register. Any time the XTAL field changes, the new settings are translated and the internal PLL settings are updated.

5.2.5.6 PLL Modes

- Normal: The PLL multiplies the input clock reference and drives the output.
- Power-Down: Most of the PLL internal circuitry is disabled and the PLL does not drive the output.

The modes are programmed using the RCC/RCC2 register fields (see page 204 and page 211).

5.2.5.7 PLL Operation

If a PLL configuration is changed, the PLL output frequency is unstable until it reconverges (relocks) to the new setting. The time between the configuration change and relock is T_{READY} (see Table 20-7 on page 802). During the relock time, the affected PLL is not usable as a clock reference.

The PLL is changed by one of the following:

- Change to the XTAL value in the **RCC** register—writes of the same value do not cause a relock.
- Change in the PLL from Power-Down to Normal mode.

A counter clocked by the system clock is used to measure the T_{READY} requirement. If the system clock is the main oscillator and it is running off an 8.192 MHz or slower external oscillator clock, the down counter is set to 0x1200 (that is, ~600 μ s at an 8.192 MHz). If the system clock is running off the PIOSC or an external oscillator clock that is faster than 8.192 MHz, the down counter is set to 0x2400. Hardware is provided to keep the PLL from being used as a system clock until the T_{READY} condition is met after one of the two changes above. It is the user's responsibility to have a stable clock source (like the main oscillator) before the **RCC/RCC2** register is switched to use the PLL.

If the main PLL is enabled and the system clock is switched to use the PLL in one step, the system control hardware continues to clock the microcontroller from the oscillator selected by the RCC/RCC2 register until the main PLL is stable (T_{READY} time met), after which it changes to the PLL. Software can use many methods to ensure that the system is clocked from the main PLL, including periodically polling the PLLLRIS bit in the Raw Interrupt Status (RIS) register, and enabling the PLL Lock interrupt.

5.2.5.8 Main Oscillator Verification Circuit

The clock control includes circuitry to ensure that the main oscillator is running at the appropriate frequency. The circuit monitors the main oscillator frequency and signals if the frequency is outside of the allowable band of attached crystals.

The detection circuit is enabled using the CVAL bit in the **Main Oscillator Control (MOSCCTL)** register. If this circuit is enabled and detects an error, the following sequence is performed by the hardware:

- 1. The MOSCFAIL bit in the Reset Cause (RESC) register is set.
- 2. If the internal oscillator (PIOSC) is disabled, it is enabled.
- **3.** The system clock is switched from the main oscillator to the PIOSC.
- **4.** An internal power-on reset is initiated that lasts for 32 PIOSC periods.
- 5. Reset is de-asserted and the processor is directed to the NMI handler during the reset sequence.

5.2.6 System Control

For power-savings purposes, the **RCGCn**, **SCGCn**, and **DCGCn** registers control the clock gating logic for each peripheral or block in the system while the microcontroller is in Run, Sleep, and Deep-Sleep mode, respectively. These registers are located in the System Control register map starting at offsets 0x600, 0x700, and 0x800, respectively. There must be a delay of 3 system clocks after a peripheral module clock is enabled in the **RCGC** register before any module registers are accessed.

There are four levels of operation for the microcontroller defined as:

- Run mode
- Sleep mode
- Deep-Sleep mode
- Hibernate mode

The following sections describe the different modes in detail.

Caution – If the Cortex-M3 Debug Access Port (DAP) has been enabled, and the device wakes from a low power sleep or deep-sleep mode, the core may start executing code before all clocks to peripherals have been restored to their Run mode configuration. The DAP is usually enabled by software tools accessing the JTAG or SWD interface when debugging or flash programming. If this condition occurs, a Hard Fault is triggered when software accesses a peripheral with an invalid clock.

A software delay loop can be used at the beginning of the interrupt routine that is used to wake up a system from a WFI (Wait For Interrupt) instruction. This stalls the execution of any code that accesses a peripheral register that might cause a fault. This loop can be removed for production software as the DAP is most likely not enabled during normal execution.

Because the DAP is disabled by default (power on reset), the user can also power cycle the device. The DAP is not enabled unless it is enabled through the JTAG or SWD interface.

5.2.6.1 Run Mode

In Run mode, the microcontroller actively executes code. Run mode provides normal operation of the processor and all of the peripherals that are currently enabled by the **RCGCn** registers. The system clock can be any of the available clock sources including the PLL.

5.2.6.2 Sleep Mode

In Sleep mode, the clock frequency of the active peripherals is unchanged, but the processor and the memory subsystem are not clocked and therefore no longer execute code. Sleep mode is entered by the Cortex-M3 core executing a WFI (Wait for Interrupt) instruction. Any properly configured interrupt event in the system brings the processor back into Run mode. See "Power Management" on page 91 for more details.

Peripherals are clocked that are enabled in the **SCGCn** registers when auto-clock gating is enabled (see the **RCC** register) or the **RCGCn** registers when the auto-clock gating is disabled. The system clock has the same source and frequency as that during Run mode.

5.2.6.3 Deep-Sleep Mode

In Deep-Sleep mode, the clock frequency of the active peripherals may change (depending on the Run mode clock configuration) in addition to the processor clock being stopped. An interrupt returns the microcontroller to Run mode from one of the sleep modes; the sleep modes are entered on request from the code. Deep-Sleep mode is entered by first setting the SLEEPDEEP bit in the **System Control (SYSCTRL)** register (see page 133) and then executing a WFI instruction. Any properly configured interrupt event in the system brings the processor back into Run mode. See "Power Management" on page 91 for more details.

The Cortex-M3 processor core and the memory subsystem are not clocked in Deep-Sleep mode. Peripherals are clocked that are enabled in the **DCGCn** registers when auto-clock gating is enabled (see the **RCC** register) or the **RCGCn** registers when auto-clock gating is disabled. The system clock source is specified in the **DSLPCLKCFG** register. When the **DSLPCLKCFG** register is used, the internal oscillator source is powered up, if necessary, and other clocks are powered down. If the PLL is running at the time of the WFI instruction, hardware powers the PLL down and overrides the SYSDIV field of the active **RCC/RCC2** register, to be determined by the DSDIVORIDE setting in the **DSLPCLKCFG** register, up to /16 or /64 respectively. When the Deep-Sleep exit event occurs, hardware brings the system clock back to the source and frequency it had at the onset of Deep-Sleep mode before enabling the clocks that had been stopped during the Deep-Sleep duration. If the PIOSC is used as the PLL reference clock source, it may continue to provide the clock during Deep-Sleep. See page 215.

5.2.6.4 Hibernate Mode

In this mode, the power supplies are turned off to the main part of the microcontroller and only the Hibernation module's circuitry is active. An external wake event or RTC event is required to bring the microcontroller back to Run mode. The Cortex-M3 processor and peripherals outside of the Hibernation module see a normal "power on" sequence and the processor starts running code. Software can determine if the microcontroller has been restarted from Hibernate mode by inspecting the Hibernation module registers. For more information on the operation of Hibernate mode, see "Hibernation Module" on page 267.

5.3 Initialization and Configuration

The PLL is configured using direct register writes to the RCC/RCC2 register. If the RCC2 register is being used, the USERCC2 bit must be set and the appropriate RCC2 bit/field is used. The steps required to successfully change the PLL-based system clock are:

- 1. Bypass the PLL and system clock divider by setting the BYPASS bit and clearing the USESYS bit in the RCC register, thereby configuring the microcontroller to run off a "raw" clock source and allowing for the new PLL configuration to be validated before switching the system clock to the PLL.
- 2. Select the crystal value (XTAL) and oscillator source (OSCSRC), and clear the PWRDN bit in RCC/RCC2. Setting the XTAL field automatically pulls valid PLL configuration data for the appropriate crystal, and clearing the PWRDN bit powers and enables the PLL and its output.
- 3. Select the desired system divider (SYSDIV) in RCC/RCC2 and set the USESYS bit in RCC. The SYSDIV field determines the system frequency for the microcontroller.
- 4. Wait for the PLL to lock by polling the PLLLRIS bit in the Raw Interrupt Status (RIS) register.
- 5. Enable use of the PLL by clearing the BYPASS bit in RCC/RCC2.

5.4 Register Map

Table 5-8 on page 190 lists the System Control registers, grouped by function. The offset listed is a hexadecimal increment to the register's address, relative to the System Control base address of 0x400F.E000.

Note: Spaces in the System Control register space that are not used are reserved for future or internal use. Software should not modify any reserved memory address.

Additional Flash and ROM registers defined in the System Control register space are described in the "Internal Memory" on page 294.

Table 5-8. System Control Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	DID0	RO	-	Device Identification 0	193
0x004	DID1	RO	-	Device Identification 1	220
800x0	DC0	RO	0x004F.003F	Device Capabilities 0	222
0x010	DC1	RO	-	Device Capabilities 1	223
0x014	DC2	RO	0x0307.5037	Device Capabilities 2	225

Table 5-8. System Control Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0x018	DC3	RO	0xBFFF.0FC0	Device Capabilities 3	227
0x01C	DC4	RO	0x0004.31FF	Device Capabilities 4	229
0x020	DC5	RO	0x0000.0000	Device Capabilities 5	231
0x024	DC6	RO	0x0000.0000	Device Capabilities 6	232
0x028	DC7	RO	0xFFFF.FFFF	Device Capabilities 7	233
0x02C	DC8	RO	0x0000.00FF	Device Capabilities 8 ADC Channels	237
0x030	PBORCTL	R/W	0x0000.7FFD	Brown-Out Reset Control	195
0x040	SRCR0	R/W	0x00000000	Software Reset Control 0	261
0x044	SRCR1	R/W	0x00000000	Software Reset Control 1	263
0x048	SRCR2	R/W	0x00000000	Software Reset Control 2	265
0x050	RIS	RO	0x0000.0000	Raw Interrupt Status	196
0x054	IMC	R/W	0x0000.0000	Interrupt Mask Control	198
0x058	MISC	R/W1C	0x0000.0000	Masked Interrupt Status and Clear	200
0x05C	RESC	R/W	-	Reset Cause	202
0x060	RCC	R/W	0x0780.3AD1	Run-Mode Clock Configuration	204
0x064	PLLCFG	RO	-	XTAL to PLL Translation	208
0x06C	GPIOHBCTL	R/W	0x0000.0000	GPIO High-Performance Bus Control	209
0x070	RCC2	R/W	0x07C0.6810	Run-Mode Clock Configuration 2	211
0x07C	MOSCCTL	R/W	0x0000.0000	Main Oscillator Control	214
0x100	RCGC0	R/W	0x00000040	Run Mode Clock Gating Control Register 0	240
0x104	RCGC1	R/W	0x00000000	Run Mode Clock Gating Control Register 1	246
0x108	RCGC2	R/W	0x00000000	Run Mode Clock Gating Control Register 2	255
0x110	SCGC0	R/W	0x00000040	Sleep Mode Clock Gating Control Register 0	242
0x114	SCGC1	R/W	0x00000000	Sleep Mode Clock Gating Control Register 1	249
0x118	SCGC2	R/W	0x00000000	Sleep Mode Clock Gating Control Register 2	257
0x120	DCGC0	R/W	0x00000040	Deep Sleep Mode Clock Gating Control Register 0	244
0x124	DCGC1	R/W	0x00000000	Deep-Sleep Mode Clock Gating Control Register 1	252
0x128	DCGC2	R/W	0x00000000	Deep Sleep Mode Clock Gating Control Register 2	259
0x144	DSLPCLKCFG	R/W	0x0780.0000	Deep Sleep Clock Configuration	215
0x150	PIOSCCAL	R/W	0x0000.0000	Precision Internal Oscillator Calibration	217
0x154	PIOSCSTAT	RO	0x0000.0040	Precision Internal Oscillator Statistics	219
0x190	DC9	RO	0x0000.00FF	Device Capabilities 9 ADC Digital Comparators	238

Table 5-8. System Control Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0x1A0	NVMSTAT	RO	0x0000.0001	Non-Volatile Memory Information	239

5.5 Register Descriptions

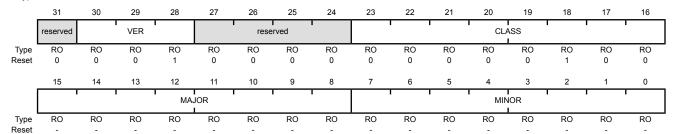
All addresses given are relative to the System Control base address of 0x400F.E000.

Register 1: Device Identification 0 (DID0), offset 0x000

This register identifies the version of the microcontroller. Each microcontroller is uniquely identified by the combined values of the CLASS field in the **DID0** register and the PARTNO field in the **DID1** register.

Device Identification 0 (DID0)

Base 0x400F.E000 Offset 0x000 Type RO, reset -



Bit/Field	Name	Type	Reset	Description
31	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
30:28	VER	RO	0x1	DID0 Version
				This field defines the DID0 register format version. The version number is numeric. The value of the \mathtt{VER} field is encoded as follows (all other encodings are reserved):
				Value Description
				0x1 Second version of the DID0 register format.
27:24	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
23:16	CLASS	RO	0x04	Device Class

The CLASS field value identifies the internal design from which all mask sets are generated for all microcontrollers in a particular product line. The CLASS field value is changed for new product lines, for changes in fab process (for example, a remap or shrink), or any case where the MAJOR or MINOR fields require differentiation from prior microcontrollers. The value of the CLASS field is encoded as follows (all other encodings are reserved):

Value Description

0x04 Stellaris® Tempest-class microcontrollers

Bit/Field	Name	Туре	Reset	Description
15:8	MAJOR	RO	-	Major Revision This field specifies the major revision number of the microcontroller. The major revision reflects changes to base layers of the design. The major revision number is indicated in the part number as a letter (A for first revision, B for second, and so on). This field is encoded as follows:
				Value Description
				0x0 Revision A (initial device)
				0x1 Revision B (first base layer revision)
				0x2 Revision C (second base layer revision)
				and so on.
7:0	MINOR	RO	-	Minor Revision
				This field specifies the minor revision number of the microcontroller. The minor revision reflects changes to the metal layers of the design. The MINOR field value is reset when the MAJOR field is changed. This field is numeric and is encoded as follows:
				Value Description
				0x0 Initial device, or a major revision update.
				0x1 First metal layer change.
				0x2 Second metal layer change.
				and so on.

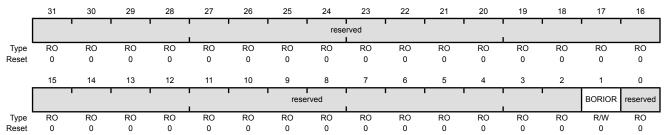
Register 2: Brown-Out Reset Control (PBORCTL), offset 0x030

This register is responsible for controlling reset conditions after initial power-on reset.

Brown-Out Reset Control (PBORCTL)

Base 0x400F.E000 Offset 0x030

Type R/W, reset 0x0000.7FFD



Bit/Field	Name	Type	Reset	Description
31:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	BORIOR	R/W	0	BOR Interrupt or Reset
				Value Description
				O A Brown Out Event causes an interrupt to be generated to the interrupt controller.
				1 A Brown Out Event causes a reset of the microcontroller.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

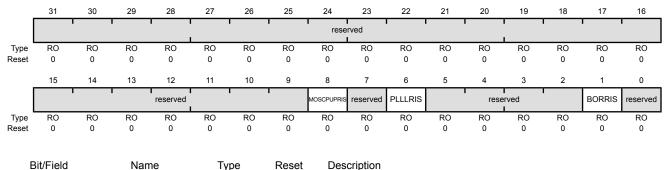
Register 3: Raw Interrupt Status (RIS), offset 0x050

This register indicates the status for system control raw interrupts. An interrupt is sent to the interrupt controller if the corresponding bit in the **Interrupt Mask Control (IMC)** register is set. Writing a 1 to the corresponding bit in the **Masked Interrupt Status and Clear (MISC)** register clears an interrupt status bit.

Raw Interrupt Status (RIS)

Base 0x400F.E000

Offset 0x050 Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:9	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	MOSCPUPRIS	RO	0	MOSC Power Up Raw Interrupt Status
				Value Description
				Sufficient time has passed for the MOSC to reach the expected frequency. The value for this power-up time is indicated by T _{MOSC START} .
				O Sufficient time has not passed for the MOSC to reach the expected frequency.
				This bit is cleared by writing a 1 to the MOSCPUPMIS bit in the MISC register.
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	PLLLRIS	RO	0	PLL Lock Raw Interrupt Status
				Value Description
				The PLL timer has reached T _{READY} indicating that sufficient time has passed for the PLL to lock.
				0 The PLL timer has not reached T _{READY} .
				This bit is cleared by writing a 1 to the ${\tt PLLLMIS}$ bit in the \textbf{MISC} register.
5:2	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
1	BORRIS	RO	0	Brown-Out Reset Raw Interrupt Status
				Value Description
				1 A brown-out condition is currently active.
				0 A brown-out condition is not currently active.
				Note the BORIOR bit in the PBORCTL register must be cleared to cause an interrupt due to a Brown Out Event.
				This bit is cleared by writing a 1 to the BORMIS bit in the MISC register.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

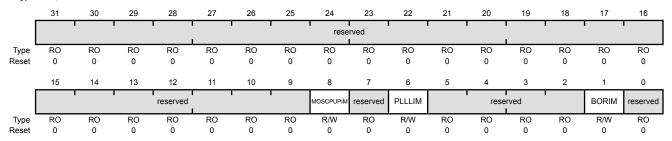
Register 4: Interrupt Mask Control (IMC), offset 0x054

This register contains the mask bits for system control raw interrupts. A raw interrupt, indicated by a bit being set in the Raw Interrupt Status (RIS) register, is sent to the interrupt controller if the corresponding bit in this register is set.

Interrupt Mask Control (IMC)

Base 0x400F.E000

Offset 0x054 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:9	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	MOSCPUPIM	R/W	0	MOSC Power Up Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the MOSCPUPRIS bit in the RIS register is set.
				O The MOSCPUPRIS interrupt is suppressed and not sent to the interrupt controller.
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	PLLLIM	R/W	0	PLL Lock Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the PLLLRIS bit in the RIS register is set.
				O The PLLLRIS interrupt is suppressed and not sent to the interrupt controller.
5:2	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
1	BORIM	R/W	0	Brown-Out Reset Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the BORRIS bit in the RIS register is set.
				O The BORRIS interrupt is suppressed and not sent to the interrupt controller.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

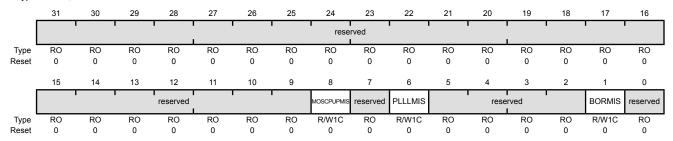
Register 5: Masked Interrupt Status and Clear (MISC), offset 0x058

On a read, this register gives the current masked status value of the corresponding interrupt in the Raw Interrupt Status (RIS) register. All of the bits are R/W1C, thus writing a 1 to a bit clears the corresponding raw interrupt bit in the RIS register (see page 196).

Masked Interrupt Status and Clear (MISC)

Base 0x400F.E000 Offset 0x058

Type R/W1C, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:9	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	MOSCPUPMIS	R/W1C	0	MOSC Power Up Masked Interrupt Status

Value Description

When read, a 1 indicates that an unmasked interrupt was signaled because sufficient time has passed for the MOSC PLL

Writing a 1 to this bit clears it and also the MOSCPUPRIS bit in the RIS register.

0 When read, a 0 indicates that sufficient time has not passed for the MOSC PLL to lock.

A write of 0 has no effect on the state of this bit.

7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	PLLLMIS	R/W1C	0	PLL Lock Masked Interrupt Status

Value Description

- 1 When read, a 1 indicates that an unmasked interrupt was signaled because sufficient time has passed for the PLL to lock. Writing a 1 to this bit clears it and also the PLLLRIS bit in the RIS register.
- 0 When read, a 0 indicates that sufficient time has not passed for the PLL to lock.

A write of 0 has no effect on the state of this bit.

Bit/Field	Name	Туре	Reset	Description
5:2	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	BORMIS	R/W1C	0	BOR Masked Interrupt Status
				Value Description
				When read, a 1 indicates that an unmasked interrupt was signaled because of a brown-out condition.
				Writing a 1 to this bit clears it and also the BORRIS bit in the RIS register.
				When read, a 0 indicates that a brown-out condition has not occurred.
				A write of 0 has no effect on the state of this bit.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 6: Reset Cause (RESC), offset 0x05C

This register is set with the reset cause after reset. The bits in this register are sticky and maintain their state across multiple reset sequences, except when an power-on reset is the cause, in which case, all bits other than POR in the **RESC** register are cleared.

Reset Cause (RESC)

Base 0x400F.E000 Offset 0x05C Type R/W, reset -

Bit/Field

5

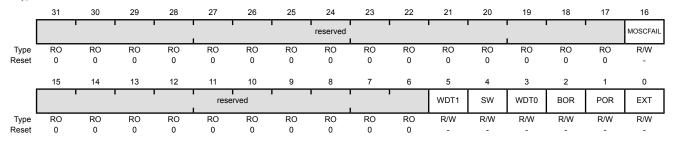
Name

WDT1

Type

R/W

Reset



Description

		.) -		
31:17	reserved	RO	0x000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
16	MOSCFAIL	R/W	-	MOSC Failure Reset
				Value Description
				When read, this bit indicates that the MOSC circuit was enabled for clock validation and failed, generating a reset event.
				When read, this bit indicates that a MOSC failure has not generated a reset since the previous power-on reset.
				Writing a 0 to this bit clears it.
15:6	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Value Description

Watchdog Timer 1 Reset

- When read, this bit indicates that Watchdog Timer 1 timed out and generated a reset.
- When read, this bit indicates that Watchdog Timer 1 has not generated a reset since the previous power-on reset.
 Writing a 0 to this bit clears it.

Bit/Field	Name	Туре	Reset	Description
4	SW	R/W	-	Software Reset
				Value Description
				When read, this bit indicates that a software reset has caused a reset event.
				When read, this bit indicates that a software reset has not generated a reset since the previous power-on reset.
				Writing a 0 to this bit clears it.
3	WDT0	R/W	-	Watchdog Timer 0 Reset
				Value Description
				When read, this bit indicates that Watchdog Timer 0 timed out and generated a reset.
				When read, this bit indicates that Watchdog Timer 0 has not generated a reset since the previous power-on reset.
				Writing a 0 to this bit clears it.
2	BOR	R/W	-	Brown-Out Reset
				Value Description
				When read, this bit indicates that a brown-out reset has caused a reset event.
				When read, this bit indicates that a brown-out reset has not generated a reset since the previous power-on reset.
				Writing a 0 to this bit clears it.
1	POR	R/W	-	Power-On Reset
				Value Description
				When read, this bit indicates that a power-on reset has caused a reset event.
				When read, this bit indicates that a power-on reset has not generated a reset.
				Writing a 0 to this bit clears it.
0	EXT	R/W	-	External Reset
				Value Description
				When read, this bit indicates that an external reset (RST assertion) has caused a reset event.
				When read, this bit indicates that an external reset (RST assertion) has not caused a reset event since the previous power-on reset.
				Writing a 0 to this bit clears it.

Register 7: Run-Mode Clock Configuration (RCC), offset 0x060

The bits in this register configure the system clock and oscillators.

Important: Write the RCC register prior to writing the RCC2 register. If a subsequent write to the RCC register is required, include another register access after writing the RCC register and before writing the RCC2 register.

Run-Mode Clock Configuration (RCC)

Base 0x400F.E000 Offset 0x060

Type R/W, reset 0x0780.3AD1

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	1	rese	erved		ACG		SYS	SDIV		USESYSDIV			rese	rved		
Type	RO	RO	RO	RO	R/W	R/W	R/W	R/W	R/W	R/W	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	1	1	1	1	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	rese	rved	PWRDN	reserved	BYPASS			XTAL			osc	SRC	rese	rved	IOSCDIS	MOSCDIS
Туре	RO	RO	R/W	RO	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	RO	RO	R/W	R/W
Reset	0	0	1	1	1	0	1	0	1	1	0	1	0	0	0	1

Bit/Field	Name	Type	Reset	Description
31:28	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
27	ACG	R/W	0	Auto Clock Gating

Auto Clock Gating

This bit specifies whether the system uses the Sleep-Mode Clock Gating Control (SCGCn) registers and Deep-Sleep-Mode Clock Gating Control (DCGCn) registers if the microcontroller enters a Sleep or Deep-Sleep mode (respectively).

Value Description

- The SCGCn or DCGCn registers are used to control the clocks distributed to the peripherals when the microcontroller is in a sleep mode. The SCGCn and DCGCn registers allow unused peripherals to consume less power when the microcontroller is in a sleep mode.
- 0 The Run-Mode Clock Gating Control (RCGCn) registers are used when the microcontroller enters a sleep mode.

The RCGCn registers are always used to control the clocks in Run mode.

26:23 **SYSDIV** R/W 0xF System Clock Divisor

Specifies which divisor is used to generate the system clock from either the PLL output or the oscillator source (depending on how the BYPASS bit in this register is configured). See Table 5-5 on page 185 for bit encodings.

If the SYSDIV value is less than MINSYSDIV (see page 223), and the PLL is being used, then the MINSYSDIV value is used as the divisor.

If the PLL is not being used, the ${\tt SYSDIV}$ value can be less than MINSYSDIV.

Bit/Field	Name	Type	Reset	Description
22	USESYSDIV	R/W	0	Enable System Clock Divider
				Value Description
				The system clock divider is the source for the system clock. The system clock divider is forced to be used when the PLL is selected as the source.
				If the USERCC2 bit in the RCC2 register is set, then the SYSDIV2 field in the RCC2 register is used as the system clock divider rather than the SYSDIV field in this register.
				0 The system clock is used undivided.
21:14	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
13	PWRDN	R/W	1	PLL Power Down
				Value Description
				1 The PLL is powered down. Care must be taken to ensure that another clock source is functioning and that the BYPASS bit is set before setting this bit.
				0 The PLL is operating normally.
12	reserved	RO	1	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
11	BYPASS	R/W	1	PLL Bypass
				Value Description
				The system clock is derived from the OSC source and divided by the divisor specified by SYSDIV.
				The system clock is the PLL output clock divided by the divisor specified by SYSDIV.
				See Table 5-5 on page 185 for programming guidelines

See Table 5-5 on page 185 for programming guidelines.

Note: The ADC must be clocked from the PLL or directly from a 16-MHz clock source to operate properly.

Bit/Field	Name	Type	Reset	Description
10:6	XTAL	R/W	0x0B	Crystal Value

This field specifies the crystal value attached to the main oscillator. The encoding for this field is provided below. Depending on the crystal used, the PLL frequency may not be exactly 400 MHz, see Table 20-8 on page 803 for more information.

Value	Crystal Frequency (MHz) Not Using the PLL	Crystal Frequency (MHz) Using the PLL
0x00	1.000 MHz	reserved
0x01	1.8432 MHz	reserved
0x02	2.000 MHz	reserved
0x03	2.4576 MHz	reserved
0x04	3.5795	45 MHz
0x05	3.686	4 MHz
0x06	4 N	1Hz
0x07	4.096	6 MHz
80x0	4.915	2 MHz
0x09	5 N	ИНz
0x0A	5.12	MHz
0x0B	6 MHz (re	eset value)
0x0C	6.144	MHz
0x0D	7.372	8 MHz
0x0E	8 N	1Hz
0x0F	8.192	2 MHz
0x10	10.0	MHz
0x11	12.0	MHz
0x12	12.28	8 MHz
0x13	13.56	6 MHz
0x14	14.318	18 MHz
0x15	16.0	MHz
0x16	16.38	4 MHz

Bit/Field	Name	Туре	Reset	Description
5:4	OSCSRC	R/W	0x1	Oscillator Source Selects the input source for the OSC. The values are:
				Value Input Source 0x0 MOSC Main oscillator 0x1 PIOSC Precision internal oscillator (default) 0x2 PIOSC/4 Precision internal oscillator / 4 0x3 30 kHz 30-kHz internal oscillator
				For additional oscillator sources, see the RCC2 register.
3:2	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	IOSCDIS	R/W	0	Precision Internal Oscillator Disable Value Description 1 The precision internal oscillator (PIOSC) is disabled. 0 The precision internal oscillator is enabled.
0	MOSCDIS	R/W	1	Main Oscillator Disable Value Description 1 The main oscillator is disabled (default). 0 The main oscillator is enabled.

Register 8: XTAL to PLL Translation (PLLCFG), offset 0x064

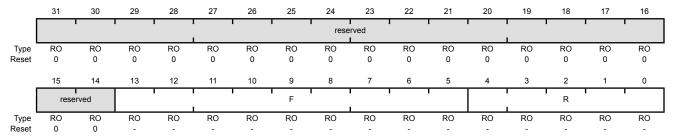
This register provides a means of translating external crystal frequencies into the appropriate PLL settings. This register is initialized during the reset sequence and updated anytime that the XTAL field changes in the **Run-Mode Clock Configuration (RCC)** register (see page 204).

The PLL frequency is calculated using the PLLCFG field values, as follows:

PLLFreq = OSCFreq * F / (R + 1)

XTAL to PLL Translation (PLLCFG)

Base 0x400F.E000 Offset 0x064 Type RO, reset -



Bit/Field	Name	Type	Reset	Description
31:14	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
13:5	F	RO	-	PLL F Value This field specifies the value supplied to the PLL's F input.
4:0	R	RO	-	PLL R Value This field specifies the value supplied to the PLL's R input.

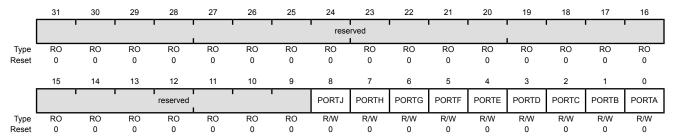
Register 9: GPIO High-Performance Bus Control (GPIOHBCTL), offset 0x06C

This register controls which internal bus is used to access each GPIO port. When a bit is clear, the corresponding GPIO port is accessed across the legacy Advanced Peripheral Bus (APB) bus and through the APB memory aperture. When a bit is set, the corresponding port is accessed across the Advanced High-Performance Bus (AHB) bus and through the AHB memory aperture. Each GPIO port can be individually configured to use AHB or APB, but may be accessed only through one aperture. The AHB bus provides better back-to-back access performance than the APB bus. The address aperture in the memory map changes for the ports that are enabled for AHB access (see Table 9-7 on page 400).

GPIO High-Performance Bus Control (GPIOHBCTL)

Base 0x400F.E000 Offset 0x06C

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:9	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	PORTJ	R/W	0	Port J Advanced High-Performance Bus
				This bit defines the memory aperture for Port J.
				Value Description
				1 Advanced High-Performance Bus (AHB)
				0 Advanced Peripheral Bus (APB). This bus is the legacy bus.
7	PORTH	R/W	0	Port H Advanced High-Performance Bus
				This bit defines the memory aperture for Port H.
				Value Description
				1 Advanced High-Performance Bus (AHB)
				0 Advanced Peripheral Bus (APB). This bus is the legacy bus.
6	PORTG	R/W	0	Port G Advanced High-Performance Bus
				This bit defines the memory aperture for Port G.
				Value Description

0

Advanced High-Performance Bus (AHB)

Advanced Peripheral Bus (APB). This bus is the legacy bus.

Bit/Field	Name	Туре	Reset	Description
5	PORTF	R/W	0	Port F Advanced High-Performance Bus This bit defines the memory aperture for Port F.
				Value Description 1 Advanced High-Performance Bus (AHB) 0 Advanced Peripheral Bus (APB). This bus is the legacy bus.
4	PORTE	R/W	0	Port E Advanced High-Performance Bus This bit defines the memory aperture for Port E.
				Value Description
				1 Advanced High-Performance Bus (AHB)
				0 Advanced Peripheral Bus (APB). This bus is the legacy bus.
3	PORTD	R/W	0	Port D Advanced High-Performance Bus
				This bit defines the memory aperture for Port D.
				Value Description
				1 Advanced High-Performance Bus (AHB)
				0 Advanced Peripheral Bus (APB). This bus is the legacy bus.
2	PORTC	R/W	0	Port C Advanced High-Performance Bus
				This bit defines the memory aperture for Port C.
				Value Description
				1 Advanced High-Performance Bus (AHB)
				0 Advanced Peripheral Bus (APB). This bus is the legacy bus.
1	PORTB	R/W	0	Port B Advanced High-Performance Bus
				This bit defines the memory aperture for Port B.
				Value Description
				1 Advanced High-Performance Bus (AHB)
				0 Advanced Peripheral Bus (APB). This bus is the legacy bus.
0	PORTA	R/W	0	Port A Advanced High-Performance Bus
				This bit defines the memory aperture for Port A.
				Value Description
				1 Advanced High-Performance Bus (AHB)
				0 Advanced Peripheral Bus (APB). This bus is the legacy bus.

Register 10: Run-Mode Clock Configuration 2 (RCC2), offset 0x070

This register overrides the RCC equivalent register fields, as shown in Table 5-9, when the USERCC2 bit is set, allowing the extended capabilities of the RCC2 register to be used while also providing a means to be backward-compatible to previous parts. Each RCC2 field that supersedes an RCC field is located at the same LSB bit position; however, some RCC2 fields are larger than the corresponding RCC field.

Table 5-9. RCC2 Fields that Override RCC Fields

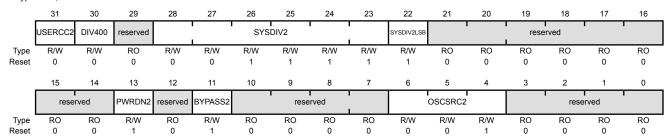
RCC2 Field	Overrides RCC Field
SYSDIV2, bits[28:23]	SYSDIV, bits[26:23]
PWRDN2, bit[13]	PWRDN, bit[13]
BYPASS2, bit[11]	BYPASS, bit[11]
oscsrc2, bits[6:4]	OSCSRC, bits[5:4]

Important: Write the **RCC** register prior to writing the **RCC2** register. If a subsequent write to the **RCC** register is required, include another register access after writing the **RCC** register and before writing the **RCC2** register.

Run-Mode Clock Configuration 2 (RCC2)

Base 0x400F.E000 Offset 0x070

Type R/W, reset 0x07C0.6810



Bit/Field	Name	Туре	Reset	Description
31	USERCC2	R/W	0	Use RCC2
				Value Description 1 The RCC2 register fields override the RCC register fields.
				The RCC register fields are used, and the fields in RCC2 are ignored.
30	DIV400	R/W	0	Divide PLL as 400 MHz vs. 200 MHz This bit, along with the SYSDIV2LSB bit, allows additional frequency

choices.

Value Description

- 1 Append the SYSDIV2LSB bit to the SYSDIV2 field to create a 7 bit divisor using the 400 MHz PLL output, see Table 5-7 on page 186.
- 0 Use SYSDIV2 as is and apply to 200 MHz predivided PLL output. See Table 5-6 on page 185 for programming guidelines.

Bit/Field	Name	Type	Reset	Description
29	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
28:23	SYSDIV2	R/W	0x0F	System Clock Divisor 2 Specifies which divisor is used to generate the system clock from either the PLL output or the oscillator source (depending on how the BYPASS2 bit is configured). SYSDIV2 is used for the divisor when both the USESYSDIV bit in the RCC register and the USERCC2 bit in this register are set. See Table 5-6 on page 185 for programming guidelines.
22	SYSDIV2LSB	R/W	1	Additional LSB for SYSDIV2
				When DIV400 is set, this bit becomes the LSB of SYSDIV2. If DIV400 is clear, this bit is not used. See Table 5-6 on page 185 for programming guidelines.
				This bit can only be set or cleared when DIV400 is set.
21:14	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
13	PWRDN2	R/W	1	Power-Down PLL 2
				Value Description
				1 The PLL is powered down.
				0 The PLL operates normally.
12	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
11	BYPASS2	R/W	1	PLL Bypass 2
				Value Description
				The system clock is derived from the OSC source and divided by the divisor specified by SYSDIV2.
				The system clock is the PLL output clock divided by the divisor specified by SYSDIV2.
				See Table 5-6 on page 185 for programming guidelines.
				Note: The ADC must be clocked from the PLL or directly from a 16-MHz clock source to operate properly.
10:7	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
6:4	OSCSRC2	R/W	0x1	Oscillator Source 2 Selects the input source for the OSC. The values are:
				Value Description
				0x0 MOSC
				Main oscillator
				0x1 PIOSC
				Precision internal oscillator
				0x2 PIOSC/4
				Precision internal oscillator / 4
				0x3
				30-kHz internal oscillator
				0x4-0x6 Reserved
				0x7 32.768 kHz
				32.768-kHz external oscillator
3:0	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

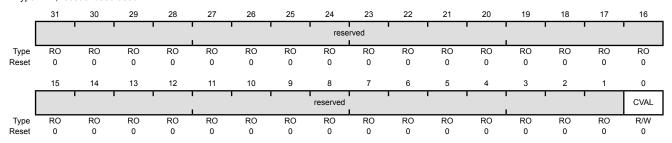
Register 11: Main Oscillator Control (MOSCCTL), offset 0x07C

This register provides the ability to enable the MOSC clock verification circuit. When enabled, this circuit monitors the frequency of the MOSC to verify that the oscillator is operating within specified limits. If the clock goes invalid after being enabled, the microcontroller issues a power-on reset and reboots to the NMI handler.

Main Oscillator Control (MOSCCTL)

Base 0x400F.E000

Offset 0x07C Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	CVAL	R/W	0	Clock Validation for MOSC

Value Description

- 1 The MOSC monitor circuit is enabled.
- 0 The MOSC monitor circuit is disabled.

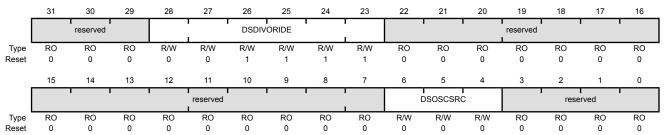
Register 12: Deep Sleep Clock Configuration (DSLPCLKCFG), offset 0x144

This register provides configuration information for the hardware control of Deep Sleep Mode.

Deep Sleep Clock Configuration (DSLPCLKCFG)

Base 0x400F.E000 Offset 0x144

Type R/W, reset 0x0780.0000



Bit/Field	Name	Туре	Reset	Description
31:29	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

28:23 **DSDIVORIDE** R/W 0x0F Divider Field Override

> If Deep-Sleep mode is enabled when the PLL is running, the PLL is disabled. This 6-bit field contains a system divider field that overrides the ${\tt SYSDIV}$ field in the RCC register or the ${\tt SYSDIV2}$ field in the RCC2 register during Deep Sleep. This divider is applied to the source selected by the **DSOSCSRC** field.

Value Description 0x0 /1 0x1 /2 0x2 /3 /4 0x3 0x3F /64

22:7 RO 0x000 reserved Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be

preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description		
6:4	DSOSCSRC	R/W	0x0	Clock Source Specifies the clock source during Deep-Sleep mode.		
				Value	Descript	tion
				0x0	MOSC	
					Use the main oscillator as the source.	
					Note:	If the PIOSC is being used as the clock reference for the PLL, the PIOSC is the clock source instead of MOSC in Deep-Sleep mode.
				0x1	PIOSC	
					Use the precision internal 16-MHz oscillator as the source.	
				0x2	Reserved	
				0x3	30 kHz	
					Use the	30-kHz internal oscillator as the source.
				0x4-0x6	6 Reserved	
				0x7	32.768 kHz	
					Use the as the s	Hibernation module 32.768-kHz external oscillator ource.
3:0	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.		

Register 13: Precision Internal Oscillator Calibration (PIOSCCAL), offset 0x150

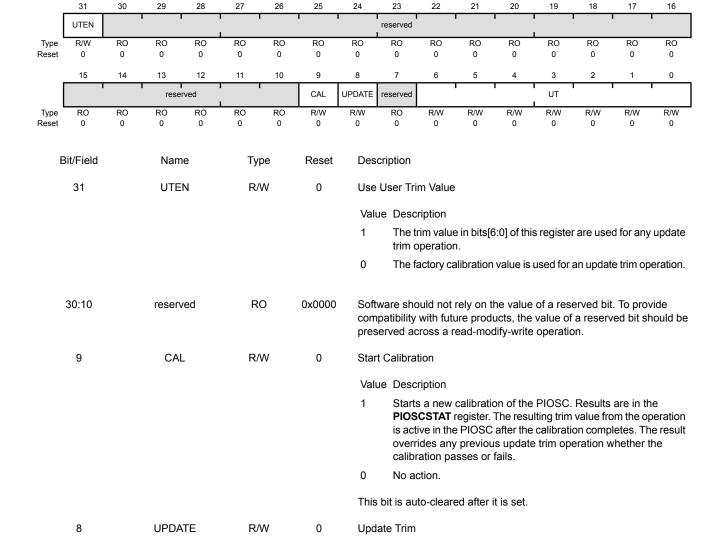
This register provides the ability to update or recalibrate the precision internal oscillator. Note that a 32.768-kHz oscillator must be used as the Hibernation module clock source for the user to be able to calibrate the PIOSC.

Precision Internal Oscillator Calibration (PIOSCCAL)

Base 0x400F.E000 Offset 0x150

7

Type R/W, reset 0x0000.0000



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Value Description

No action

This bit is auto-cleared after the update.

preserved across a read-modify-write operation.

Updates the PIOSC trim value with the UT bit or the DT bit in

the PIOSCSTAT register. Used with UTEN.

Software should not rely on the value of a reserved bit. To provide

compatibility with future products, the value of a reserved bit should be

1

0

0

RO

reserved

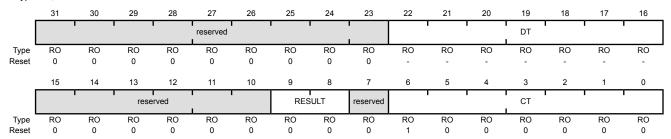
Bit/Field	Name	Type	Reset	Description
6:0	UT	R/W	0x0	User Trim Value User trim value that can be loaded into the PIOSC. Refer to "Main PLL Frequency Configuration" on page 187 for more information on calibrating the PIOSC.

Register 14: Precision Internal Oscillator Statistics (PIOSCSTAT), offset 0x154

This register provides the user information on the PIOSC calibration. Note that a 32.768-kHz oscillator must be used as the Hibernation module clock source for the user to be able to calibrate the PIOSC.

Precision Internal Oscillator Statistics (PIOSCSTAT)

Base 0x400F.E000 Offset 0x154 Type RO, reset 0x0000.0040



Bit/Field	Name	Туре	Reset	Description		
31:23	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.		
22:16	DT	RO	-	Default Trim Value This field contains the default trim value. This value is loaded into the PIOSC after every full power-up.		
15:10	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.		
9:8	RESULT	RO	0	Calibration Result		
				Value Description 0x0 Calibration has not been attempted. 0x1 The last calibration operation completed to meet 1% accuracy. 0x2 The last calibration operation failed to meet 1% accuracy. 0x3 Reserved		
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.		
6:0	СТ	RO	0x40	Calibration Trim Value		
				This field contains the trim value from the last calibration operation. After		

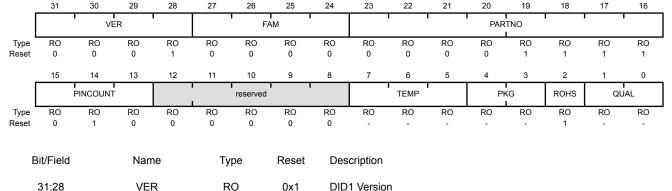
factory calibration \mathtt{CT} and \mathtt{DT} are the same.

Register 15: Device Identification 1 (DID1), offset 0x004

This register identifies the device family, part number, temperature range, pin count, and package type. Each microcontroller is uniquely identified by the combined values of the CLASS field in the **DID0** register and the PARTNO field in the **DID1** register.

Device Identification 1 (DID1)

Base 0x400F.E000 Offset 0x004 Type RO, reset -



28	VER	RO	UXT	DID'I Version
				This field defines the DID1 register format version. The version number is numeric. The value of the VER field is encoded as follows (all other encodings are reserved):

Value Description

0x1 Second version of the **DID1** register format.

27:24	FAM	RO	0x0	Family

This field provides the family identification of the device within the Luminary Micro product portfolio. The value is encoded as follows (all other encodings are reserved):

Value Description

0x0 Stellaris family of microcontollers, that is, all devices with external part numbers starting with LM3S.

23:16 PARTNO RO 0x0F Part Number

This field provides the part number of the device within the family. The value is encoded as follows (all other encodings are reserved):

Value Description

0x0F LM3S1J11

15:13 PINCOUNT RO 0x2 Package Pin Count

This field specifies the number of pins on the device package. The value is encoded as follows (all other encodings are reserved):

Value Description

0x2 100-pin package

Bit/Field	Name	Туре	Reset	Description
12:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:5	TEMP	RO	-	Temperature Range This field specifies the temperature rating of the device. The value is encoded as follows (all other encodings are reserved):
				Value Description
				0x0 Commercial temperature range (0°C to 70°C)
				0x1 Industrial temperature range (-40°C to 85°C)
				0x2 Extended temperature range (-40°C to 105°C)
4:3	PKG	RO	-	Package Type This field specifies the package type. The value is encoded as follows (all other encodings are reserved):
				Value Description 0x0 SOIC package 0x1 LQFP package 0x2 BGA package
2	ROHS	RO	1	RoHS-Compliance This bit specifies whether the device is RoHS-compliant. A 1 indicates the part is RoHS-compliant.
1:0	QUAL	RO	-	Qualification Status This field specifies the qualification status of the device. The value is encoded as follows (all other encodings are reserved):
				Value Description 0x0 Engineering Sample (unqualified) 0x1 Pilot Production (unqualified) 0x2 Fully Qualified

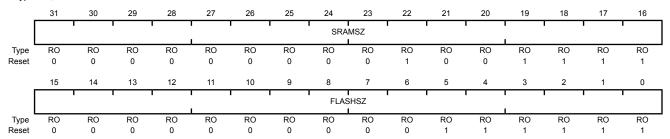
Register 16: Device Capabilities 0 (DC0), offset 0x008

This register is predefined by the part and can be used to verify features.

Device Capabilities 0 (DC0)

Base 0x400F.E000 Offset 0x008

Type RO, reset 0x004F.003F



Bit/Field	Name	Type	Reset	Description
31:16	SRAMSZ	RO	0x004F	SRAM Size Indicates the size of the on-chip SRAM memory. Value Description 0x004F 20 KB of SRAM
15:0	FLASHSZ	RO	0x003F	Flash Size

Indicates the size of the on-chip flash memory.

Value Description

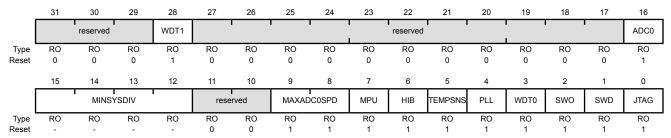
0x003F 128 KB of Flash

Register 17: Device Capabilities 1 (DC1), offset 0x010

This register is predefined by the part and can be used to verify features. If any bit is clear in this register, the module is not present. The corresponding bit in the RCGC0, SCGC0, and DCGC0 registers cannot be set.

Device Capabilities 1 (DC1)

Base 0x400F.E000 Offset 0x010 Type RO, reset -



Bit/Field	Name	Type	Reset	Description		
31:29	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.		
28	WDT1	RO	1	Watchdog Timer 1 Present		
				When set, indicates that watchdog timer 1 is present.		
27:17	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should b preserved across a read-modify-write operation.		
16	ADC0	RO	1	ADC Module 0 Present		
				When set, indicates that ADC module 0 is present		
15:12	MINSYSDIV	RO	-	System Clock Divider		
				Minimum 4-bit divider value for system clock. The reset value is hardware-dependent. See the RCC register for how to change the system clock divisor using the SYSDIV bit.		
				Value Description		
				0x1 Specifies an 80-MHz CPU clock with a PLL divider of 2.5.		
				0x2 Specifies a 66.67-MHz CPU clock with a PLL divider of 3.		
				0x3 Specifies a 50-MHz CPU clock with a PLL divider of 4.		
				0x7 Specifies a 25-MHz clock with a PLL divider of 8.		
				0x9 Specifies a 20-MHz clock with a PLL divider of 10.		
11:10	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.		

Bit/Field	Name	Туре	Reset	Description
9:8	MAXADC0SPD	RO	0x3	Max ADC0 Speed This field indicates the maximum rate at which the ADC samples data.
				Value Description 0x3 1M samples/second
7	MPU	RO	1	MPU Present When set, indicates that the Cortex-M3 Memory Protection Unit (MPU) module is present. See the "Cortex-M3 Peripherals" chapter for details on the MPU.
6	HIB	RO	1	Hibernation Module Present When set, indicates that the Hibernation module is present.
5	TEMPSNS	RO	1	Temp Sensor Present When set, indicates that the on-chip temperature sensor is present.
4	PLL	RO	1	PLL Present When set, indicates that the on-chip Phase Locked Loop (PLL) is present.
3	WDT0	RO	1	Watchdog Timer 0 Present When set, indicates that watchdog timer 0 is present.
2	SWO	RO	1	SWO Trace Port Present When set, indicates that the Serial Wire Output (SWO) trace port is present.
1	SWD	RO	1	SWD Present When set, indicates that the Serial Wire Debugger (SWD) is present.
0	JTAG	RO	1	JTAG Present When set, indicates that the JTAG debugger interface is present.

Register 18: Device Capabilities 2 (DC2), offset 0x014

This register is predefined by the part and can be used to verify features. If any bit is clear in this register, the module is not present. The corresponding bit in the RCGC0, SCGC0, and DCGC0 registers cannot be set.

Device Capabilities 2 (DC2)

Base 0x400F.E000 Offset 0x014

13

12

reserved

I2C0

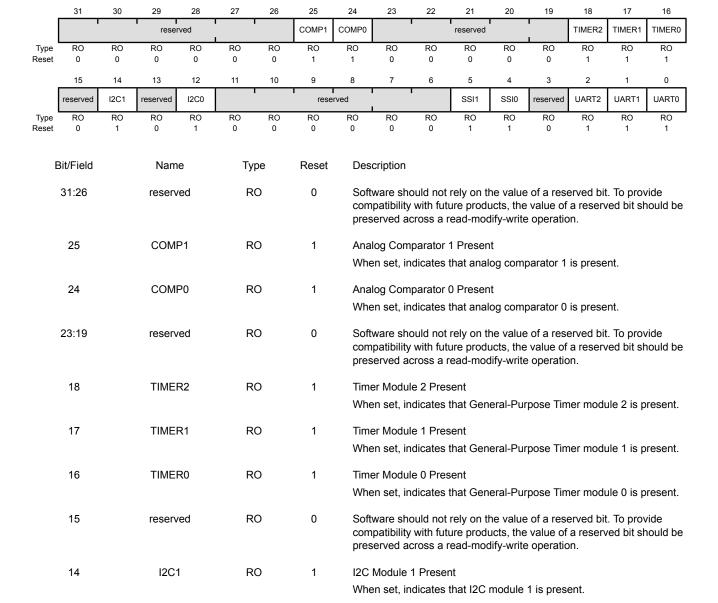
RO

RO

0

1

Type RO, reset 0x0307.5037



I2C Module 0 Present

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be

preserved across a read-modify-write operation.

When set, indicates that I2C module 0 is present.

Bit/Field	Name	Туре	Reset	Description
11:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SSI1	RO	1	SSI Module 1 Present When set, indicates that SSI module 1 is present.
4	SSI0	RO	1	SSI Module 0 Present When set, indicates that SSI module 0 is present.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	UART2	RO	1	UART Module 2 Present When set, indicates that UART module 2 is present.
1	UART1	RO	1	UART Module 1 Present When set, indicates that UART module 1 is present.
0	UART0	RO	1	UART Module 0 Present When set, indicates that UART module 0 is present.

Register 19: Device Capabilities 3 (DC3), offset 0x018

This register is predefined by the part and can be used to verify features. If any bit is clear in this register, the module is not present. The corresponding bit in the RCGC0, SCGC0, and DCGC0 registers cannot be set.

Device Capabilities 3 (DC3)

Base 0x400F.E000 Offset 0x018 Type RO, reset 0xBFFF.0FC0

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	32KHZ	reserved	CCP5	CCP4	CCP3	CCP2	CCP1	CCP0	ADC0AIN7	ADC0AIN6	ADC0AIN5	ADC0AIN4	ADC0AIN3	ADC0AIN2	ADC0AIN1	ADC0AIN0
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	1	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		rese	rved		C10	C1PLUS	C1MINUS	C0O	COPLUS	COMINUS			rese	rved		
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31	32KHZ	RO	1	32KHz Input Clock Available When set, indicates an even CCP pin is present and can be used as a 32-KHz input clock.
30	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
29	CCP5	RO	1	CCP5 Pin Present When set, indicates that Capture/Compare/PWM pin 5 is present.
28	CCP4	RO	1	CCP4 Pin Present When set, indicates that Capture/Compare/PWM pin 4 is present.
27	CCP3	RO	1	CCP3 Pin Present When set, indicates that Capture/Compare/PWM pin 3 is present.
26	CCP2	RO	1	CCP2 Pin Present When set, indicates that Capture/Compare/PWM pin 2 is present.
25	CCP1	RO	1	CCP1 Pin Present When set, indicates that Capture/Compare/PWM pin 1 is present.
24	CCP0	RO	1	CCP0 Pin Present When set, indicates that Capture/Compare/PWM pin 0 is present.
23	ADC0AIN7	RO	1	ADC Module 0 AIN7 Pin Present When set, indicates that ADC module 0 input pin 7 is present.
22	ADC0AIN6	RO	1	ADC Module 0 AIN6 Pin Present When set, indicates that ADC module 0 input pin 6 is present.
21	ADC0AIN5	RO	1	ADC Module 0 AIN5 Pin Present When set, indicates that ADC module 0 input pin 5 is present.

Bit/Field	Name	Туре	Reset	Description
20	ADC0AIN4	RO	1	ADC Module 0 AIN4 Pin Present When set, indicates that ADC module 0 input pin 4 is present.
19	ADC0AIN3	RO	1	ADC Module 0 AIN3 Pin Present When set, indicates that ADC module 0 input pin 3 is present.
18	ADC0AIN2	RO	1	ADC Module 0 AIN2 Pin Present When set, indicates that ADC module 0 input pin 2 is present.
17	ADC0AIN1	RO	1	ADC Module 0 AIN1 Pin Present When set, indicates that ADC module 0 input pin 1 is present.
16	ADC0AIN0	RO	1	ADC Module 0 AIN0 Pin Present When set, indicates that ADC module 0 input pin 0 is present.
15:12	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
11	C10	RO	1	C1o Pin Present When set, indicates that the analog comparator 1 output pin is present.
10	C1PLUS	RO	1	C1+ Pin Present When set, indicates that the analog comparator 1 (+) input pin is present.
9	C1MINUS	RO	1	C1- Pin Present When set, indicates that the analog comparator 1 (-) input pin is present.
8	C0O	RO	1	C0o Pin Present When set, indicates that the analog comparator 0 output pin is present.
7	C0PLUS	RO	1	C0+ Pin Present When set, indicates that the analog comparator 0 (+) input pin is present.
6	COMINUS	RO	1	C0- Pin Present When set, indicates that the analog comparator 0 (-) input pin is present.
5:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

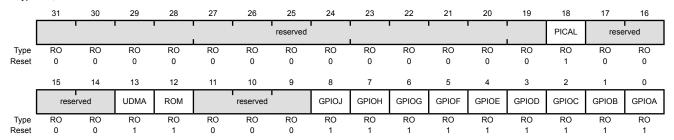
Register 20: Device Capabilities 4 (DC4), offset 0x01C

This register is predefined by the part and can be used to verify features. If any bit is clear in this register, the module is not present. The corresponding bit in the RCGC0, SCGC0, and DCGC0 registers cannot be set.

Device Capabilities 4 (DC4)

Base 0x400F.E000

Offset 0x01C Type RO, reset 0x0004.31FF



Bit/Field	Name	Туре	Reset	Description
31:19	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
18	PICAL	RO	1	PIOSC Calibrate When set, indicates that the PIOSC can be calibrated.
17:14	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
13	UDMA	RO	1	Micro-DMA Module Present When set, indicates that the micro-DMA module present.
12	ROM	RO	1	Internal Code ROM Present When set, indicates that internal code ROM is present.
11:9	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	GPIOJ	RO	1	GPIO Port J Present When set, indicates that GPIO Port J is present.
7	GPIOH	RO	1	GPIO Port H Present When set, indicates that GPIO Port H is present.
6	GPIOG	RO	1	GPIO Port G Present When set, indicates that GPIO Port G is present.
5	GPIOF	RO	1	GPIO Port F Present When set, indicates that GPIO Port F is present.
4	GPIOE	RO	1	GPIO Port E Present When set, indicates that GPIO Port E is present.

Bit/Field	Name	Type	Reset	Description
3	GPIOD	RO	1	GPIO Port D Present When set, indicates that GPIO Port D is present.
2	GPIOC	RO	1	GPIO Port C Present When set, indicates that GPIO Port C is present.
1	GPIOB	RO	1	GPIO Port B Present When set, indicates that GPIO Port B is present.
0	GPIOA	RO	1	GPIO Port A Present When set, indicates that GPIO Port A is present.

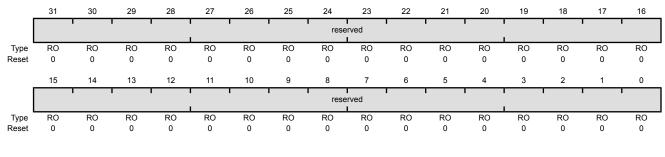
Register 21: Device Capabilities 5 (DC5), offset 0x020

This register is predefined by the part and can be used to verify features. If any bit is clear in this register, the module is not present. The corresponding bit in the RCGC0, SCGC0, and DCGC0 registers cannot be set.

Device Capabilities 5 (DC5)

Base 0x400F.E000

Offset 0x020 Type RO, reset 0x0000.0000



Bit/Field Type Reset Description Name 31:0 RO reserved 0

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

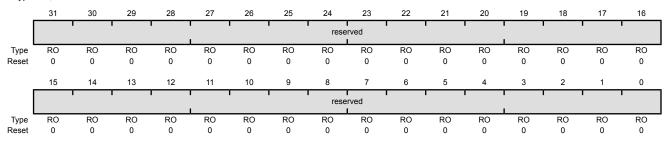
Register 22: Device Capabilities 6 (DC6), offset 0x024

This register is predefined by the part and can be used to verify features. If any bit is clear in this register, the module is not present. The corresponding bit in the RCGC0, SCGC0, and DCGC0 registers cannot be set.

Device Capabilities 6 (DC6)

Base 0x400F.E000

Offset 0x024
Type RO, reset 0x0000.0000



Bit/Field Reset Description Name Type 31:0 reserved RO 0

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 23: Device Capabilities 7 (DC7), offset 0x028

This register is predefined by the part and can be used to verify uDMA channel features. A 1 indicates the channel is available on this device; a 0 that the channel is only available on other devices in the family. Most channels have primary and secondary assignments. If the primary function is not available on this microcontroller, the secondary function becomes the primary function. If the secondary function is not available, the primary function is the only option.

Device Capabilities 7 (DC7)

Base 0x400F.E000 Offset 0x028 Type RO, reset 0xFFFF.FFF

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	reserved	DMACH30	DMACH29	DMACH28	DMACH27	DMACH26	DMACH25	DMACH24	DMACH23	DMACH22	DMACH21	DMACH20	DMACH19	DMACH18	DMACH17	DMACH16
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	DMACH15	DMACH14	DMACH13	DMACH12	DMACH11	DMACH10	DMACH9	DMACH8	DMACH7	DMACH6	DMACH5	DMACH4	DMACH3	DMACH2	DMACH1	DMACH0
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1

Bit/Field	Name	Туре	Reset	Description
31	reserved	RO	1	Reserved Reserved for uDMA channel 31.
30	DMACH30	RO	1	SW When set, indicates uDMA channel 30 is available for software transfers.
29	DMACH29	RO	1	I2S0_TX / CAN1_TX When set, indicates uDMA channel 29 is available and connected to the transmit path of I2S module 0. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of CAN module 1 transmit.
28	DMACH28	RO	1	I2S0_RX / CAN1_RX When set, indicates uDMA channel 28 is available and connected to the receive path of I2S module 0. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of CAN module 1 receive.
27	DMACH27	RO	1	CAN1_TX / ADC1_SS3 When set, indicates uDMA channel 27 is available and connected to the transmit path of CAN module 1. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of ADC module 1 Sample Sequencer 3.
26	DMACH26	RO	1	CAN1_RX / ADC1_SS2 When set, indicates uDMA channel 26 is available and connected to the receive path of CAN module 1. If the corresponding bit in the

DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of ADC module 1 Sample Sequencer

Bit/Field	Name	Туре	Reset	Description
25	DMACH25	RO	1	SSI1_TX / ADC1_SS1 When set, indicates uDMA channel 25 is available and connected to the transmit path of SSI module 1. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of ADC module 1 Sample Sequencer 1.
24	DMACH24	RO	1	SSI1_RX / ADC1_SS0 When set, indicates uDMA channel 24 is available and connected to the receive path of SSI module 1. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of ADC module 1 Sample Sequencer 0.
23	DMACH23	RO	1	UART1_TX / CAN2_TX When set, indicates uDMA channel 23 is available and connected to the transmit path of UART module 1. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of CAN module 2 transmit.
22	DMACH22	RO	1	UART1_RX / CAN2_RX When set, indicates uDMA channel 22 is available and connected to the receive path of UART module 1. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of CAN module 2 receive.
21	DMACH21	RO	1	Timer1B / EPI0_WFIFO When set, indicates uDMA channel 21 is available and connected to Timer 1B. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of EPI module 0 write FIFO (WRIFO).
20	DMACH20	RO	1	Timer1A / EPI0_NBRFIFO When set, indicates uDMA channel 20 is available and connected to Timer 1A. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of EPI module 0 non-blocking read FIFO (NBRFIFO).
19	DMACH19	RO	1	Timer0B / Timer1B When set, indicates uDMA channel 19 is available and connected to Timer 0B. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 1B.
18	DMACH18	RO	1	Timer0A / Timer1A When set, indicates uDMA channel 18 is available and connected to Timer 0A. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 1A.
17	DMACH17	RO	1	ADC0_SS3 When set, indicates uDMA channel 17 is available and connected to ADC module 0 Sample Sequencer 3.
16	DMACH16	RO	1	ADC0_SS2 When set, indicates uDMA channel 16 is available and connected to ADC module 0 Sample Sequencer 2.

Bit/Field	Name	Туре	Reset	Description
15	DMACH15	RO	1	ADC0_SS1 / Timer2B
				When set, indicates uDMA channel 15 is available and connected to ADC module 0 Sample Sequencer 1. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 2B.
14	DMACH14	RO	1	ADC0_SS0 / Timer2A
				When set, indicates uDMA channel 14 is available and connected to ADC module 0 Sample Sequencer 0. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 2A.
13	DMACH13	RO	1	CAN0_TX / UART2_TX
				When set, indicates uDMA channel 13 is available and connected to the transmit path of CAN module 0. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of UART module 2 transmit.
12	DMACH12	RO	1	CAN0_RX / UART2_RX
				When set, indicates uDMA channel 12 is available and connected to the receive path of CAN module 0. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of UART module 2 receive.
11	DMACH11	RO	1	SSI0_TX/SSI1_TX
				When set, indicates uDMA channel 11 is available and connected to the transmit path of SSI module 0. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of SSI module 1 transmit.
10	DMACH10	RO	1	SSI0_RX / SSI1_RX
				When set, indicates uDMA channel 10 is available and connected to the receive path of SSI module 0. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of SSI module 1 receive.
9	DMACH9	RO	1	UART0_TX / UART1_TX
				When set, indicates uDMA channel 9 is available and connected to the transmit path of UART module 0. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of UART module 1 transmit.
8	DMACH8	RO	1	UART0_RX / UART1_RX
				When set, indicates uDMA channel 8 is available and connected to the receive path of UART module 0. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of UART module 1 receive.
7	DMACH7	RO	1	ETH_TX / Timer2B
				When set, indicates uDMA channel 7 is available and connected to the transmit path of the Ethernet module. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 2B.

Bit/Field	Name	Туре	Reset	Description
6	DMACH6	RO	1	ETH_RX / Timer2A When set, indicates uDMA channel 6 is available and connected to the receive path of the Ethernet module. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 2A.
5	DMACH5	RO	1	USB_EP3_TX / Timer2B When set, indicates uDMA channel 5 is available and connected to the transmit path of USB endpoint 3. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 2B.
4	DMACH4	RO	1	USB_EP3_RX / Timer2A When set, indicates uDMA channel 4 is available and connected to the receive path of USB endpoint 3. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 2A.
3	DMACH3	RO	1	USB_EP2_TX / Timer3B When set, indicates uDMA channel 3 is available and connected to the transmit path of USB endpoint 2. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 3B.
2	DMACH2	RO	1	USB_EP2_RX / Timer3A When set, indicates uDMA channel 2 is available and connected to the receive path of USB endpoint 2. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of Timer 3A.
1	DMACH1	RO	1	USB_EP1_TX / UART2_TX When set, indicates uDMA channel 1 is available and connected to the transmit path of USB endpoint 1. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of UART module 2 transmit.
0	DMACH0	RO	1	USB_EP1_RX / UART2_RX When set, indicates uDMA channel 0 is available and connected to the receive path of USB endpoint 1. If the corresponding bit in the DMACHASGN register is set, the channel is connected instead to the secondary channel assignment of UART module 2 receive.

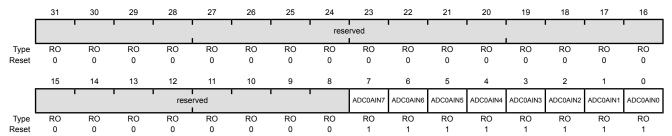
Register 24: Device Capabilities 8 ADC Channels (DC8), offset 0x02C

This register is predefined by the part and can be used to verify features.

Device Capabilities 8 ADC Channels (DC8)

Base 0x400F.E000 Offset 0x02C

Type RO, reset 0x0000.00FF



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	ADC0AIN7	RO	1	ADC Module 0 AIN7 Pin Present When set, indicates that ADC module 0 input pin 7 is present.
6	ADC0AIN6	RO	1	ADC Module 0 AIN6 Pin Present When set, indicates that ADC module 0 input pin 6 is present.
5	ADC0AIN5	RO	1	ADC Module 0 AIN5 Pin Present When set, indicates that ADC module 0 input pin 5 is present.
4	ADC0AIN4	RO	1	ADC Module 0 AIN4 Pin Present When set, indicates that ADC module 0 input pin 4 is present.
3	ADC0AIN3	RO	1	ADC Module 0 AIN3 Pin Present When set, indicates that ADC module 0 input pin 3 is present.
2	ADC0AIN2	RO	1	ADC Module 0 AIN2 Pin Present When set, indicates that ADC module 0 input pin 2 is present.
1	ADC0AIN1	RO	1	ADC Module 0 AIN1 Pin Present When set, indicates that ADC module 0 input pin 1 is present.
0	ADC0AIN0	RO	1	ADC Module 0 AIN0 Pin Present When set, indicates that ADC module 0 input pin 0 is present.

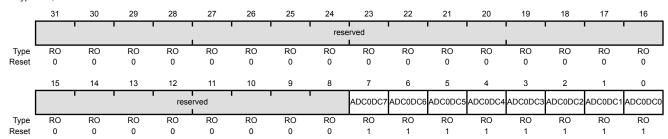
Register 25: Device Capabilities 9 ADC Digital Comparators (DC9), offset 0x190

This register is predefined by the part and can be used to verify features.

Device Capabilities 9 ADC Digital Comparators (DC9)

Base 0x400F.E000

Offset 0x190 Type RO, reset 0x0000.00FF



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	ADC0DC7	RO	1	ADC0 DC7 Present When set, indicates that ADC module 0 Digital Comparator 7 is present.
6	ADC0DC6	RO	1	ADC0 DC6 Present When set, indicates that ADC module 0 Digital Comparator 6 is present.
5	ADC0DC5	RO	1	ADC0 DC5 Present When set, indicates that ADC module 0 Digital Comparator 5 is present.
4	ADC0DC4	RO	1	ADC0 DC4 Present When set, indicates that ADC module 0 Digital Comparator 4 is present.
3	ADC0DC3	RO	1	ADC0 DC3 Present When set, indicates that ADC module 0 Digital Comparator 3 is present.
2	ADC0DC2	RO	1	ADC0 DC2 Present When set, indicates that ADC module 0 Digital Comparator 2 is present.
1	ADC0DC1	RO	1	ADC0 DC1 Present When set, indicates that ADC module 0 Digital Comparator 1 is present.
0	ADC0DC0	RO	1	ADC0 DC0 Present When set, indicates that ADC module 0 Digital Comparator 0 is present.

Register 26: Non-Volatile Memory Information (NVMSTAT), offset 0x1A0

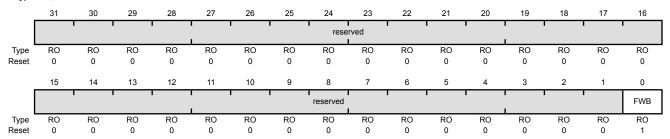
This register is predefined by the part and can be used to verify features.

Non-Volatile Memory Information (NVMSTAT)

Base 0x400F.E000 Offset 0x1A0

D:4/E: -1-4

Type RO, reset 0x0000.0001



Bit/Field	Name	туре	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	FWB	RO	1	32 Word Flash Write Buffer Active

When set, indicates that the 32 word Flash memory write buffer feature is active.

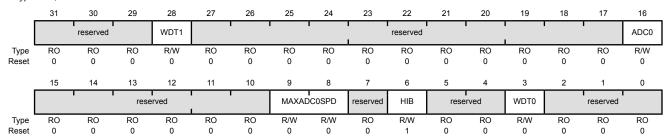
Register 27: Run Mode Clock Gating Control Register 0 (RCGC0), offset 0x100

This register controls the clock gating logic in normal Run mode. Each bit controls a clock enable for a given interface, function, or module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled (saving power). If the module is unclocked, reads or writes to the module generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional modules are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or modules to control. This configuration is implemented to assure reasonable code compatibility with other family and future parts. **RCGC0** is the clock configuration register for running operation, **SCGC0** for Sleep operation, and **DCGC0** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Run Mode Clock Gating Control Register 0 (RCGC0)

Base 0x400F.E000

Offset 0x100 Type R/W, reset 0x00000040



Bit/Field	Name	Туре	Reset	Description
31:29	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
28	WDT1	R/W	0	WDT1 Clock Gating Control This bit controls the clock gating for the Watchdog Timer module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
27:17	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
16	ADC0	R/W	0	ADC0 Clock Gating Control This bit controls the clock gating for ADC module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
15:10	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
9:8	MAXADC0SPD	R/W	0	ADC0 Sample Speed This field sets the rate at which ADC0 samples data. You cannot set the rate higher than the maximum rate. You can set the sample rate by setting the MAXADC0 SPD bit as follows (all other encodings are reserved):
				Value Description
				0x3 1M samples/second
				0x2 500K samples/second
				0x1 250K samples/second
				0x0 125K samples/second
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	HIB	R/W	1	HIB Clock Gating Control This bit controls the clock gating for the Hibernation module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
5:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	WDT0	R/W	0	WDT0 Clock Gating Control
				This bit controls the clock gating for the Watchdog Timer module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
2:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 28: Sleep Mode Clock Gating Control Register 0 (SCGC0), offset 0x110

This register controls the clock gating logic in Sleep mode. Each bit controls a clock enable for a given interface, function, or module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled (saving power). If the module is unclocked, reads or writes to the module generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional modules are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or modules to control. This configuration is implemented to assure reasonable code compatibility with other family and future parts. **RCGC0** is the clock configuration register for running operation, **SCGC0** for Sleep operation, and **DCGC0** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Sleep Mode Clock Gating Control Register 0 (SCGC0)

Base 0x400F.E000 Offset 0x110

Type R/W, reset 0x00000040

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		reserved		WDT1						reserved					1	ADC0
Туре	RO	RO	RO	R/W	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		1 1	rese	rved			MAXAD	COSPD	reserved	HIB	rese	rved	WDT0		reserved	
Туре	RO	RO	RO	RO	RO	RO	R/W	R/W	RO	R/W	RO	RO	R/W	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:29	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
28	WDT1	R/W	0	WDT1 Clock Gating Control
				This bit controls the clock gating for Watchdog Timer module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
27:17	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
16	ADC0	R/W	0	ADC0 Clock Gating Control
				This bit controls the clock gating for ADC module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
15:10	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
9:8	MAXADC0SPD	R/W	0	ADC0 Sample Speed This field sets the rate at which ADC module 0 samples data. You cannot set the rate higher than the maximum rate. You can set the sample rate by setting the MAXADC0SPD bit as follows (all other encodings are reserved):
				Value Description 0x3 1M samples/second 0x2 500K samples/second 0x1 250K samples/second 0x0 125K samples/second
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	HIB	R/W	1	HIB Clock Gating Control This bit controls the clock gating for the Hibernation module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
5:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	WDT0	R/W	0	WDT0 Clock Gating Control This bit controls the clock gating for the Watchdog Timer module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
2:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 29: Deep Sleep Mode Clock Gating Control Register 0 (DCGC0), offset 0x120

This register controls the clock gating logic in Deep-Sleep mode. Each bit controls a clock enable for a given interface, function, or module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled (saving power). If the module is unclocked, reads or writes to the module generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional modules are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or modules to control. This configuration is implemented to assure reasonable code compatibility with other family and future parts. **RCGC0** is the clock configuration register for running operation, **SCGC0** for Sleep operation, and **DCGC0** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Deep Sleep Mode Clock Gating Control Register 0 (DCGC0)

Base 0x400F.E000 Offset 0x120

Type R/W, reset 0x00000040

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		reserved		WDT1						reserved					1	ADC0
Туре	RO	RO	RO	R/W	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		' '			reserved	1		1		HIB	rese	rved	WDT0		reserved	
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W	RO	RO	R/W	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:29	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
28	WDT1	R/W	0	WDT1 Clock Gating Control
				This bit controls the clock gating for the Watchdog Timer module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
27:17	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
16	ADC0	R/W	0	ADC0 Clock Gating Control
				This bit controls the clock gating for ADC module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
15:7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
6	HIB	R/W	1	HIB Clock Gating Control This bit controls the clock gating for the Hibernation module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
5:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	WDT0	R/W	0	WDT0 Clock Gating Control This bit controls the clock gating for the Watchdog Timer module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
2:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

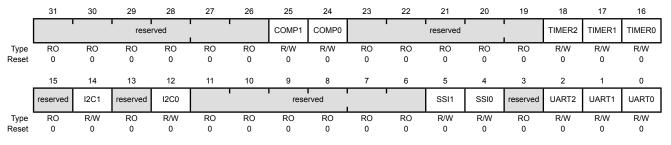
Register 30: Run Mode Clock Gating Control Register 1 (RCGC1), offset 0x104

This register controls the clock gating logic in normal Run mode. Each bit controls a clock enable for a given interface, function, or module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled (saving power). If the module is unclocked, reads or writes to the module generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional modules are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or modules to control. This configuration is implemented to assure reasonable code compatibility with other family and future parts. **RCGC1** is the clock configuration register for running operation, **SCGC1** for Sleep operation, and **DCGC1** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Run Mode Clock Gating Control Register 1 (RCGC1)

Base 0x400F.E000 Offset 0x104

Offset 0x104 Type R/W, reset 0x00000000



Bit/Field	Name	Туре	Reset	Description
31:26	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
25	COMP1	R/W	0	Analog Comparator 1 Clock Gating
				This bit controls the clock gating for analog comparator 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
24	COMP0	R/W	0	Analog Comparator 0 Clock Gating
				This bit controls the clock gating for analog comparator 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
23:19	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
18	TIMER2	R/W	0	Timer 2 Clock Gating Control
				This bit controls the clock gating for General-Purpose Timer module 2. If set, the module receives a clock and functions. Otherwise, the module

is unclocked and disabled. If the module is unclocked, a read or write

to the module generates a bus fault.

Bit/Field	Name	Туре	Reset	Description
17	TIMER1	R/W	0	Timer 1 Clock Gating Control This bit controls the clock gating for General-Purpose Timer module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
16	TIMER0	R/W	0	Timer 0 Clock Gating Control This bit controls the clock gating for General-Purpose Timer module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
15	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
14	I2C1	R/W	0	I2C1 Clock Gating Control This bit controls the clock gating for I2C module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	I2C0	R/W	0	I2C0 Clock Gating Control This bit controls the clock gating for I2C module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
11:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SSI1	R/W	0	SSI1 Clock Gating Control This bit controls the clock gating for SSI module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
4	SSI0	R/W	0	SSI0 Clock Gating Control This bit controls the clock gating for SSI module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	UART2	R/W	0	UART2 Clock Gating Control This bit controls the clock gating for UART module 2. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.

Bit/Field	Name	Type	Reset	Description
1	UART1	R/W	0	UART1 Clock Gating Control This bit controls the clock gating for UART module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
0	UART0	R/W	0	UART0 Clock Gating Control This bit controls the clock gating for UART module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.

Register 31: Sleep Mode Clock Gating Control Register 1 (SCGC1), offset 0x114

This register controls the clock gating logic in Sleep mode. Each bit controls a clock enable for a given interface, function, or module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled (saving power). If the module is unclocked, reads or writes to the module generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional modules are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or modules to control. This configuration is implemented to assure reasonable code compatibility with other family and future parts. **RCGC1** is the clock configuration register for running operation, **SCGC1** for Sleep operation, and **DCGC1** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Sleep Mode Clock Gating Control Register 1 (SCGC1)

Base 0x400F.E000 Offset 0x114 Type R/W, reset 0x00000000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
	ľ		rese	rved	 		COMP1	COMP0			reserved			TIMER2	TIMER1	TIMER0	
Type	RO	RO	RO	RO	RO	RO	R/W	R/W	RO	RO	RO	RO	RO	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	reserved	I2C1	reserved	I2C0			rese	rved			SSI1	SSI0	reserved	UART2	UART1	UART0	
Type	RO	R/W	RO	R/W	RO	RO	RO	RO	RO	RO	R/W	R/W	RO	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	

Bit/Field	Name	Туре	Reset	Description
31:26	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
25	COMP1	R/W	0	Analog Comparator 1 Clock Gating
				This bit controls the clock gating for analog comparator 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
24	COMP0	R/W	0	Analog Comparator 0 Clock Gating
				This bit controls the clock gating for analog comparator 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
23:19	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
18	TIMER2	R/W	0	Timer 2 Clock Gating Control
				This bit controls the clock gating for General-Purpose Timer module 2. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write

to the module generates a bus fault.

Bit/Field	Name	Туре	Reset	Description
17	TIMER1	R/W	0	Timer 1 Clock Gating Control This bit controls the clock gating for General-Purpose Timer module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
16	TIMER0	R/W	0	Timer 0 Clock Gating Control This bit controls the clock gating for General-Purpose Timer module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
15	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
14	I2C1	R/W	0	I2C1 Clock Gating Control This bit controls the clock gating for I2C module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	I2C0	R/W	0	I2C0 Clock Gating Control This bit controls the clock gating for I2C module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
11:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SSI1	R/W	0	SSI1 Clock Gating Control This bit controls the clock gating for SSI module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
4	SSI0	R/W	0	SSI0 Clock Gating Control This bit controls the clock gating for SSI module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	UART2	R/W	0	UART2 Clock Gating Control This bit controls the clock gating for UART module 2. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.

Bit/Field	Name	Туре	Reset	Description
1	UART1	R/W	0	UART1 Clock Gating Control This bit controls the clock gating for UART module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
0	UART0	R/W	0	UARTO Clock Gating Control This bit controls the clock gating for UART module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.

Register 32: Deep-Sleep Mode Clock Gating Control Register 1 (DCGC1), offset 0x124

This register controls the clock gating logic in Deep-Sleep mode. Each bit controls a clock enable for a given interface, function, or module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled (saving power). If the module is unclocked, reads or writes to the module generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional modules are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or modules to control. This configuration is implemented to assure reasonable code compatibility with other family and future parts. **RCGC1** is the clock configuration register for running operation, **SCGC1** for Sleep operation, and **DCGC1** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Deep-Sleep Mode Clock Gating Control Register 1 (DCGC1)

Base 0x400F.E000 Offset 0x124

Type R/W, reset 0x00000000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
	ľ		rese	rved	ı		COMP1	COMP0			reserved		_	TIMER2	TIMER1	TIMER0	
Type	RO	RO	RO	RO	RO	RO	R/W	R/W	RO	RO	RO	RO	RO	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	reserved	I2C1	reserved	I2C0	reserved						SSI1	SSI0	reserved	UART2	UART1	UART0	
Type	RO	R/W	RO	R/W	RO	RO	RO	RO	RO	RO	R/W	R/W	RO	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	

Bit/Field	Name	Туре	Reset	Description
31:26	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
25	COMP1	R/W	0	Analog Comparator 1 Clock Gating
				This bit controls the clock gating for analog comparator 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
24	COMP0	R/W	0	Analog Comparator 0 Clock Gating
				This bit controls the clock gating for analog comparator 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
23:19	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
18	TIMER2	R/W	0	Timer 2 Clock Gating Control
				This bit controls the clock gating for General-Purpose Timer module 2. If set, the module receives a clock and functions. Otherwise, the module

is unclocked and disabled. If the module is unclocked, a read or write

to the module generates a bus fault.

Bit/Field	Name	Туре	Reset	Description
17	TIMER1	R/W	0	Timer 1 Clock Gating Control
				This bit controls the clock gating for General-Purpose Timer module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
16	TIMER0	R/W	0	Timer 0 Clock Gating Control
				This bit controls the clock gating for General-Purpose Timer module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
15	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
14	I2C1	R/W	0	I2C1 Clock Gating Control
				This bit controls the clock gating for I2C module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	I2C0	R/W	0	I2C0 Clock Gating Control
				This bit controls the clock gating for I2C module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
11:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SSI1	R/W	0	SSI1 Clock Gating Control
				This bit controls the clock gating for SSI module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
4	SSI0	R/W	0	SSI0 Clock Gating Control
				This bit controls the clock gating for SSI module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	UART2	R/W	0	UART2 Clock Gating Control
				This bit controls the clock gating for UART module 2. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.

Bit/Field	Name	Туре	Reset	Description
1	UART1	R/W	0	UART1 Clock Gating Control This bit controls the clock gating for UART module 1. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
0	UART0	R/W	0	UART0 Clock Gating Control This bit controls the clock gating for UART module 0. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.

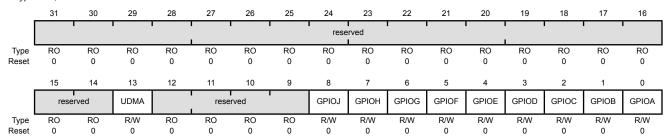
Register 33: Run Mode Clock Gating Control Register 2 (RCGC2), offset 0x108

This register controls the clock gating logic in normal Run mode. Each bit controls a clock enable for a given interface, function, or module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled (saving power). If the module is unclocked, reads or writes to the module generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional modules are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or modules to control. This configuration is implemented to assure reasonable code compatibility with other family and future parts. **RCGC2** is the clock configuration register for running operation, **SCGC2** for Sleep operation, and **DCGC2** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Run Mode Clock Gating Control Register 2 (RCGC2)

Base 0x400F.E000

Offset 0x108
Type R/W, reset 0x00000000



Bit/Field	Name	Туре	Reset	Description
31:14	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
13	UDMA	R/W	0	Micro-DMA Clock Gating Control
				This bit controls the clock gating for micro-DMA. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
12:9	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	GPIOJ	R/W	0	Port J Clock Gating Control
				This bit controls the clock gating for Port J. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
7	GPIOH	R/W	0	Port H Clock Gating Control
				This bit controls the clock gating for Port H. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled.

bus fault.

If the module is unclocked, a read or write to the module generates a

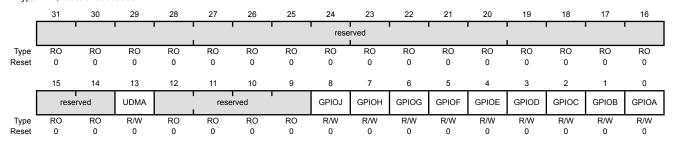
Bit/Field	Name	Type	Reset	Description
6	GPIOG	R/W	0	Port G Clock Gating Control This bit controls the clock gating for Port G. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
5	GPIOF	R/W	0	Port F Clock Gating Control This bit controls the clock gating for Port F. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
4	GPIOE	R/W	0	Port E Clock Gating Control Port E Clock Gating Control. This bit controls the clock gating for Port E. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
3	GPIOD	R/W	0	Port D Clock Gating Control Port D Clock Gating Control. This bit controls the clock gating for Port D. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
2	GPIOC	R/W	0	Port C Clock Gating Control This bit controls the clock gating for Port C. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
1	GPIOB	R/W	0	Port B Clock Gating Control This bit controls the clock gating for Port B. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
0	GPIOA	R/W	0	Port A Clock Gating Control This bit controls the clock gating for Port A. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.

Register 34: Sleep Mode Clock Gating Control Register 2 (SCGC2), offset 0x118

This register controls the clock gating logic in Sleep mode. Each bit controls a clock enable for a given interface, function, or module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled (saving power). If the module is unclocked, reads or writes to the module generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional modules are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or modules to control. This configuration is implemented to assure reasonable code compatibility with other family and future parts. **RCGC2** is the clock configuration register for running operation, **SCGC2** for Sleep operation, and **DCGC2** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Sleep Mode Clock Gating Control Register 2 (SCGC2)

Base 0x400F.E000 Offset 0x118 Type R/W, reset 0x00000000



Bit/Field	Name	Туре	Reset	Description
31:14	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
13	UDMA	R/W	0	Micro-DMA Clock Gating Control
				This bit controls the clock gating for micro-DMA. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
12:9	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	GPIOJ	R/W	0	Port J Clock Gating Control
				This bit controls the clock gating for Port J. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
7	GPIOH	R/W	0	Port H Clock Gating Control
				This bit controls the clock gating for Port H. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a

bus fault

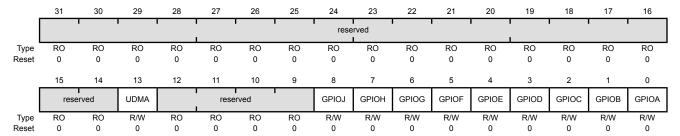
Bit/Field	Name	Туре	Reset	Description
6	GPIOG	R/W	0	Port G Clock Gating Control This bit controls the clock gating for Port G. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
5	GPIOF	R/W	0	Port F Clock Gating Control This bit controls the clock gating for Port F. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
4	GPIOE	R/W	0	Port E Clock Gating Control Port E Clock Gating Control. This bit controls the clock gating for Port E. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
3	GPIOD	R/W	0	Port D Clock Gating Control Port D Clock Gating Control. This bit controls the clock gating for Port D. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
2	GPIOC	R/W	0	Port C Clock Gating Control This bit controls the clock gating for Port C. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
1	GPIOB	R/W	0	Port B Clock Gating Control This bit controls the clock gating for Port B. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
0	GPIOA	R/W	0	Port A Clock Gating Control This bit controls the clock gating for Port A. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.

Register 35: Deep Sleep Mode Clock Gating Control Register 2 (DCGC2), offset 0x128

This register controls the clock gating logic in Deep-Sleep mode. Each bit controls a clock enable for a given interface, function, or module. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled (saving power). If the module is unclocked, reads or writes to the module generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional modules are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or modules to control. This configuration is implemented to assure reasonable code compatibility with other family and future parts. **RCGC2** is the clock configuration register for running operation, **SCGC2** for Sleep operation, and **DCGC2** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Deep Sleep Mode Clock Gating Control Register 2 (DCGC2)

Base 0x400F.E000 Offset 0x128 Type R/W, reset 0x00000000



Bit/Field	Name	Type	Reset	Description
31:14	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
13	UDMA	R/W	0	Micro-DMA Clock Gating Control
				This bit controls the clock gating for micro-DMA. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
12:9	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	GPIOJ	R/W	0	Port J Clock Gating Control
				This bit controls the clock gating for Port J. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
7	GPIOH	R/W	0	Port H Clock Gating Control
				This bit controls the clock gating for Port H. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled.

bus fault.

If the module is unclocked, a read or write to the module generates a

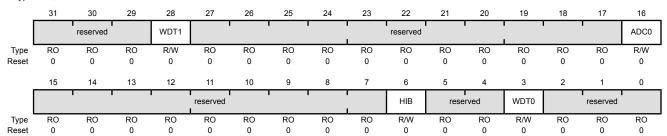
Bit/Field	Name	Туре	Reset	Description
6	GPIOG	R/W	0	Port G Clock Gating Control This bit controls the clock gating for Port G. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
5	GPIOF	R/W	0	Port F Clock Gating Control This bit controls the clock gating for Port F. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
4	GPIOE	R/W	0	Port E Clock Gating Control Port E Clock Gating Control. This bit controls the clock gating for Port E. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
3	GPIOD	R/W	0	Port D Clock Gating Control Port D Clock Gating Control. This bit controls the clock gating for Port D. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
2	GPIOC	R/W	0	Port C Clock Gating Control This bit controls the clock gating for Port C. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
1	GPIOB	R/W	0	Port B Clock Gating Control This bit controls the clock gating for Port B. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.
0	GPIOA	R/W	0	Port A Clock Gating Control This bit controls the clock gating for Port A. If set, the module receives a clock and functions. Otherwise, the module is unclocked and disabled. If the module is unclocked, a read or write to the module generates a bus fault.

Register 36: Software Reset Control 0 (SRCR0), offset 0x040

This register allows individual modules to be reset. Writes to this register are masked by the bits in the Device Capabilities 1 (DC1) register.

Software Reset Control 0 (SRCR0)

Base 0x400F.E000 Offset 0x040 Type R/W, reset 0x00000000



Bit/Field	Name	Туре	Reset	Description
31:29	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
28	WDT1	R/W	0	WDT1 Reset Control When this bit is set, Watchdog Timer module 1 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
27:17	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
16	ADC0	R/W	0	ADC0 Reset Control
				When this bit is set, ADC module 0 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
15:7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	HIB	R/W	0	HIB Reset Control
				When this bit is set, the Hibernation module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
5:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	WDT0	R/W	0	WDT0 Reset Control
				When this bit is set, Watchdog Timer module 0 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.

Bit/Field	Name	Type	Reset	Description
2:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

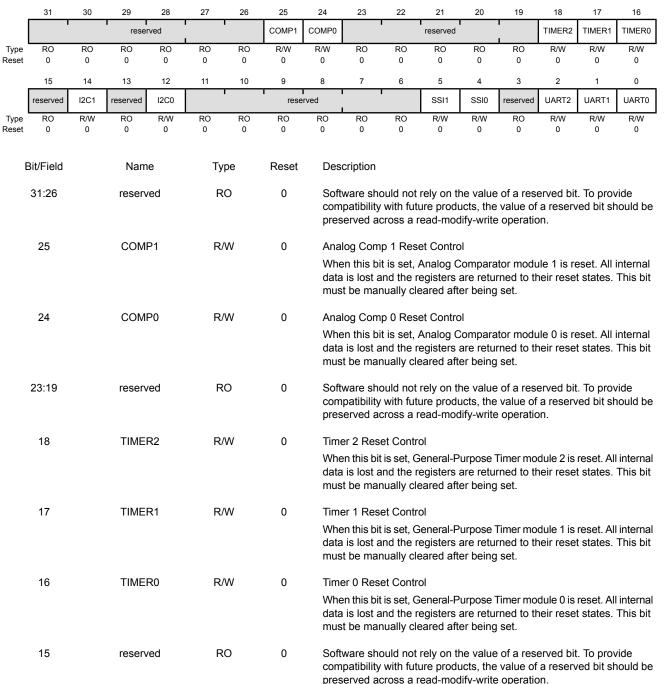
Register 37: Software Reset Control 1 (SRCR1), offset 0x044

This register allows individual modules to be reset. Writes to this register are masked by the bits in the Device Capabilities 2 (DC2) register.

Software Reset Control 1 (SRCR1)

Base 0x400F.E000

Offset 0x044 Type R/W, reset 0x00000000



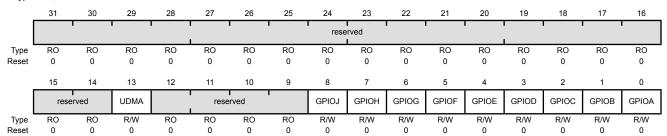
Bit/Field	Name	Туре	Reset	Description
14	I2C1	R/W	0	I2C1 Reset Control When this bit is set, I2C module 1 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	I2C0	R/W	0	I2C0 Reset Control When this bit is set, I2C module 0 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
11:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SSI1	R/W	0	SSI1 Reset Control When this bit is set, SSI module 1 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
4	SSIO	R/W	0	SSI0 Reset Control When this bit is set, SSI module 0 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	UART2	R/W	0	UART2 Reset Control When this bit is set, UART module 2 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
1	UART1	R/W	0	UART1 Reset Control When this bit is set, UART module 1 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
0	UART0	R/W	0	UART0 Reset Control When this bit is set, UART module 0 is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.

Register 38: Software Reset Control 2 (SRCR2), offset 0x048

This register allows individual modules to be reset. Writes to this register are masked by the bits in the Device Capabilities 4 (DC4) register.

Software Reset Control 2 (SRCR2)

Base 0x400F.E000 Offset 0x048 Type R/W, reset 0x00000000



Bit/Field	Name	Туре	Reset	Description
31:14	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
13	UDMA	R/W	0	Micro-DMA Reset Control When this bit is set, uDMA module is reset. All internal data is lost and
				the registers are returned to their reset states. This bit must be manually cleared after being set.
12:9	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	GPIOJ	R/W	0	Port J Reset Control
				When this bit is set, Port J module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
7	GPIOH	R/W	0	Port H Reset Control
				When this bit is set, Port H module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
6	GPIOG	R/W	0	Port G Reset Control
				When this bit is set, Port G module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
5	GPIOF	R/W	0	Port F Reset Control
				When this bit is set, Port F module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
4	GPIOE	R/W	0	Port E Reset Control
				When this bit is set, Port E module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.

Bit/Field	Name	Туре	Reset	Description
3	GPIOD	R/W	0	Port D Reset Control When this bit is set, Port D module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
2	GPIOC	R/W	0	Port C Reset Control When this bit is set, Port C module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
1	GPIOB	R/W	0	Port B Reset Control When this bit is set, Port B module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.
0	GPIOA	R/W	0	Port A Reset Control When this bit is set, Port A module is reset. All internal data is lost and the registers are returned to their reset states. This bit must be manually cleared after being set.

6 Hibernation Module

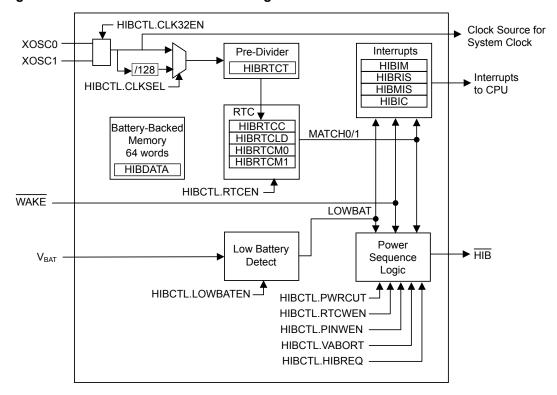
The Hibernation Module manages removal and restoration of power to provide a means for reducing power consumption. When the processor and peripherals are idle, power can be completely removed with only the Hibernation module remaining powered. Power can be restored based on an external signal or at a certain time using the built-in Real-Time Clock (RTC). The Hibernation module can be independently supplied from a battery or an auxiliary power supply.

The Hibernation module has the following features:

- 32-bit real-time counter (RTC)
 - Two 32-bit RTC match registers for timed wake-up and interrupt generation
 - RTC predivider trim for making fine adjustments to the clock rate
- Two mechanisms for power control
 - System power control using discrete external regulator
 - On-chip power control using internal switches under register control
- Dedicated pin for waking using an external signal
- RTC operational and hibernation memory valid as long as V_{BAT} is valid
- Low-battery detection, signaling, and interrupt generation
- Clock source from a 32.768-kHz external oscillator or a 4.194304-MHz crystal; 32.768-kHz external oscillator can be used for main controller clock
- 64 32-bit words of battery-backed memory to save state during hibernation
- Programmable interrupts for RTC match, external wake, and low battery events

6.1 Block Diagram

Figure 6-1. Hibernation Module Block Diagram



6.2 Signal Description

The following table lists the external signals of the Hibernation module and describes the function of each. These signals have dedicated functions and are not alternate functions for any GPIO signals.

Table 6-1. Hibernate Signals (100LQFP)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
HIB	51	fixed	0	OD	An output that indicates the processor is in Hibernate mode.
VBAT	55	fixed	-	Power	Power source for the Hibernation module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation module power-source supply.
WAKE	50	fixed	I	TTL	An external input that brings the processor out of Hibernate mode when asserted.
xosc0	52	fixed	I	Analog	Hibernation module oscillator crystal input or an external clock reference input. Note that this is either a 4.194304-MHz crystal or a 32.768-kHz oscillator for the Hibernation module RTC. See the CLKSEL bit in the HIBCTL register.
XOSC1	53	fixed	0	Analog	Hibernation module oscillator crystal output. Leave unconnected when using a single-ended clock source.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

	·				
Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
HIB	M12	fixed	0	OD	An output that indicates the processor is in Hibernate mode.
VBAT	L12	fixed	-	Power	Power source for the Hibernation module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation module power-source supply.
WAKE	M10	fixed	I	TTL	An external input that brings the processor out of Hibernate mode when asserted.
xosc0	K11	fixed	I	Analog	Hibernation module oscillator crystal input or an external clock reference input. Note that this is either a 4.194304-MHz crystal or a 32.768-kHz oscillator for the Hibernation module RTC. See the CLKSEL bit in the HIBCTL register.
XOSC1	K12	fixed	0	Analog	Hibernation module oscillator crystal output. Leave unconnected when using a single-ended clock source.

Table 6-2. Hibernate Signals (108BGA)

6.3 Functional Description

The Hibernation module provides two mechanisms for power control:

- The first mechanism controls the power to the microcontroller with a control signal (HIB) that signals an external voltage regulator to turn on or off.
- The second mechanism uses internal switches to control power to the Cortex-M3 as well as to most analog and digital functions while retaining I/O pin power (VDD3ON mode).

The Hibernation module power source is determined dynamically. The supply voltage of the Hibernation module is the larger of the main voltage source (V_{DD}) or the battery/auxilliary voltage source (V_{BAT}). The Hibernation module also has an independent clock source to maintain a real-time clock (RTC) when the system clock is powered down.

Once in hibernation, the module signals an external voltage regulator to turn the power back on when an external pin ($\overline{\text{WAKE}}$) is asserted or when the internal RTC reaches a certain value. The Hibernation module can also detect when the battery voltage is low and optionally prevent hibernation when this occurs.

When waking from hibernation, the $\overline{\mathtt{HIB}}$ signal is deasserted. The return of V_{DD} causes a POR to be executed. The time from when the $\overline{\mathtt{WAKE}}$ signal is asserted to when code begins execution is equal to the wake-up time (t_{WAKE} TO HIB) plus the power-on reset time (t_{IRPOR}).

6.3.1 Register Access Timing

Because the Hibernation module has an independent clocking domain, certain registers must be written only with a timing gap between accesses. The delay time is $t_{HIB_REG_ACCESS}$, therefore software must guarantee that this delay is inserted between back-to-back writes to certain Hibernation registers or between a write followed by a read to those same registers. Software may make use of the WRC bit in the **Hibernation Control (HIBCTL)** register to ensure that the required timing gap has elapsed. This bit is cleared on a write operation and set once the write completes, indicating to software that another write or read may be started safely. Software should poll **HIBCTL** for WRC=1 prior to accessing any affected register. The following registers are subject to this timing restriction:

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

- Hibernation RTC Counter (HIBRTCC)
- Hibernation RTC Match 0 (HIBRTCM0)
- Hibernation RTC Match 1 (HIBRTCM1)
- Hibernation RTC Load (HIBRTCLD)
- Hibernation RTC Trim (HIBRTCT)
- Hibernation Data (HIBDATA)

Back-to-back reads from Hibernation module registers have no timing restrictions. Reads are performed at the full peripheral clock rate.

6.3.2 Hibernation Clock Source

In systems where the Hibernation module is used to put the microcontroller into hibernation, the module must be clocked by an external source that is independent from the main system clock, even if the RTC feature is not used. An external oscillator or crystal is used for this purpose. To use a crystal, a 4.194304-MHz crystal is connected to the xosco and xosco pins. This clock signal is divided by 128 internally to produce a 32.768-kHz Hibernation clock reference. Alternatively, a 32.768-kHz oscillator can be connected to the xosco pin, leaving xosco unconnected. Care must be taken that the voltage amplitude of the 32.768-kHz oscillator is less than V_{BAT} , otherwise, the Hibernation module may draw power from the oscillator and not V_{BAT} during hibernation. See Figure 6-2 on page 271 and Figure 6-3 on page 271.

The Hibernation clock source is enabled by setting the CLK32EN bit of the **HIBCTL** register. The type of clock source is selected by clearing the CLKSEL bit for a 4.194304-MHz crystal and setting the CLKSEL bit for a 32.768-kHz oscillator. If a crystal is used for the clock source, the software must leave a delay of $t_{\text{HIBOSC_START}}$ after writing to the CLK32EN bit and before any other accesses to the Hibernation module registers. The delay allows the crystal to power up and stabilize. If an oscillator is used for the clock source, no delay is needed.

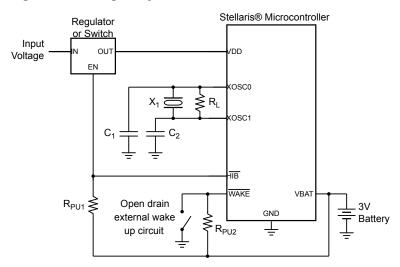


Figure 6-2. Using a Crystal as the Hibernation Clock Source

Note:

 X_1 = Crystal frequency is f_{XOSC_XTAL} .

 $C_{1,2}$ = Capacitor value derived from crystal vendor load capacitance specifications.

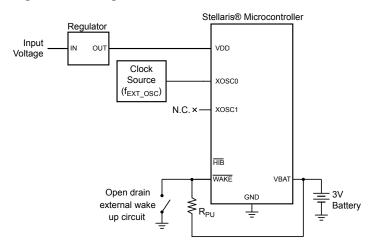
 R_L = Load resistor is R_{XOSC_LOAD} .

 R_{PU1} = Pull-up resistor 1 (value and voltage source (V_{BAT} or Input Voltage) determined by regulator or switch enable input characteristics).

 R_{PU2} = Pull-up resistor 2 is 200 k Ω

See "Hibernation Clock Source Specifications" on page 804 for specific parameter values.

Figure 6-3. Using a Dedicated Oscillator as the Hibernation Clock Source with VDD3ON Mode



Note: R_{PU} = Pull-up resistor is 1 M Ω

6.3.3 System Implementation

Several different system configurations are possible when using the Hibernation module:

Using a single battery source, where the battery provides both V_{DD} and V_{BAT}.

- Using the VDD3ON mode, where V_{DD} continues to be powered in hibernation, allowing the GPIO pins to retain their states, as shown in Figure 6-3 on page 271. In this mode, V_{DDC} is powered off internally.
- Using separate sources for V_{DD} and V_{BAT}, as shown in Figure 6-2 on page 271.
- Using a regulator to provide both V_{DD} and V_{BAT} with a switch enabled by HIB to remove V_{DD} during hibernation.

Adding external capacitance to the V_{BAT} supply reduces the accuracy of the low-battery measurement and should be avoided if possible. The diagrams referenced in this section only show the connection to the Hibernation pins and not to the full system.

If the application does not require the use of the Hibernation module, refer to "Connections for Unused Signals" on page 794. In this situation, the HIB bit in the **Run Mode Clock Gating Control Register 0 (RCGC0)** register must be cleared, disabling the system clock to the Hibernation module and Hibernation module registers are not accessible.

6.3.4 Battery Management

Important: System-level factors may affect the accuracy of the low battery detect circuit. The designer should consider battery type, discharge characteristics, and a test load during battery voltage measurements.

The Hibernation module can be independently powered by a battery or an auxiliary power source using the vBAT pin. The module can monitor the voltage level of the battery and detect when the voltage drops below V_{LOWBAT} . The module can also be configured so that it does not go into Hibernate mode if the battery voltage drops below this threshold. Battery voltage is not measured while in Hibernate mode.

The Hibernation module can be configured to detect a low battery condition by setting the LOWBATEN bit of the **HIBCTL** register. In this configuration, the LOWBAT bit of the **HIBCTL** register **Status (HIBRIS)** register is set when the battery level is low. If the VABORT bit in the **HIBCTL** register is also set, then the module is prevented from entering Hibernate mode when a low battery is detected. The module can also be configured to generate an interrupt for the low-battery condition (see "Interrupts and Status" on page 274).

Note that the Hibernation module draws power from whichever source (V_{BAT} or V_{DD}) has the higher voltage. Therefore, it is important to design the circuit to ensure that V_{DD} is higher that V_{BAT} under nominal conditions or else the Hibernation module draws power from the battery even when V_{DD} is available.

6.3.5 Real-Time Clock

The Hibernation module includes a 32-bit counter that increments once per second with the proper configuration (see "Hibernation Clock Source" on page 270). The 32.768-kHz clock signal, either directly from the 32.768-kHz oscillator or from the 4.194304-MHz crystal divided by 128, is fed into a predivider register that counts down the 32.768-kHz clock ticks to achieve a once per second clock rate for the RTC. The rate can be adjusted to compensate for inaccuracies in the clock source by using the predivider trim register, **HIBRTCT**. This register has a nominal value of 0x7FFF, and is used for one second out of every 64 seconds to divide the input clock. This configuration allows the software to make fine corrections to the clock rate by adjusting the predivider trim register up or down from 0x7FFF. The predivider trim should be adjusted up from 0x7FFF in order to slow down the RTC rate and down from 0x7FFF in order to speed up the RTC rate.

The Hibernation module includes two 32-bit match registers that are compared to the value of the RTC counter. The match registers can be used to wake the processor from Hibernate mode or to generate an interrupt to the processor if it is not in hibernation.

The RTC must be enabled with the RTCEN bit of the **HIBCTL** register. The value of the RTC can be set at any time by writing to the **HIBRTCLD** register. The predivider trim can be adjusted by reading and writing the **HIBRTCT** register. The predivider uses this register once every 64 seconds to adjust the clock rate. The two match registers can be set by writing to the **HIBRTCM0** and **HIBRTCM1** registers. The RTC can be configured to generate interrupts by using the interrupt registers (see "Interrupts and Status" on page 274). As long as the RTC is enabled and a valid V_{BAT} is present, the RTC continues counting, regardless of whether V_{DD} is present or if the part is in hibernation.

6.3.6 Battery-Backed Memory

The Hibernation module contains 64 32-bit words of memory that are powered from the battery or auxiliary power supply and therefore retained during hibernation. The processor software can save state information in this memory prior to hibernation and recover the state upon waking. The battery-backed memory can be accessed through the **HIBDATA** registers. If both V_{DD} and V_{BAT} are removed, the contents of the **HIBDATA** registers are not retained.

6.3.7 Power Control Using HIB

Important: The Hibernation Module requires special system implementation considerations when using $\overline{\mathtt{HIB}}$ to control power, as it is intended to power-down all other sections of the microcontroller. All system signals and power supplies that connect to the chip must be driven to 0 V_{DC} or powered down with the same regulator controlled by $\overline{\mathtt{HIB}}$.

The Hibernation module controls power to the microcontroller through the use of the $\overline{\text{HIB}}$ pin which is intended to be connected to the enable signal of the external regulator(s) providing 3.3 V to the microcontroller and other circuits. When the $\overline{\text{HIB}}$ signal is asserted by the Hibernation module, the external regulator is turned off and no longer powers the microcontroller and any parts of the system that are powered by the regulator. The Hibernation module remains powered from the V_{BAT} supply (which could be a battery or an auxiliary power source) until a Wake event. Power to the microcontroller is restored by deasserting the $\overline{\text{HIB}}$ signal, which causes the external regulator to turn power back on to the chip.

6.3.8 Power Control Using VDD3ON Mode

The Hibernation module may also be configured to cut power to all internal modules. While in this state, all pins are configured as inputs. In the VDD3ON mode, the regulator should maintain 3.3 V power to the microcontroller during Hibernate. This power control mode is enabled by setting the VDD3ON bit in **HIBCTL**.

6.3.9 Initiating Hibernate

Hibernate mode is initiated when the HIBREQ bit of the **HIBCTL** register is set. If a wake-up condition has not been configured using the PINWEN or RTCWEN bits in the **HIBCTL** register, the hibernation request is ignored. If a Flash memory write operation is in progress when the HIBREQ bit is set, an interlock feature holds off the transition into Hibernate mode until the write has completed.

6.3.10 Waking from Hibernate

The Hibernation module is configured to wake from the external $\overline{\text{WAKE}}$ pin by setting the PINWEN bit of the **HIBCTL** register. It is configured to wake from RTC match by setting the RTCWEN bit. Note that the $\overline{\text{WAKE}}$ pin uses the Hibernation module's internal power supply as the logic 1 reference.

Upon either external wake-up or RTC match, the Hibernation module delays coming out of hibernation until V_{DD} is above the minimum specified voltage, see Table 20-2 on page 797.

When the Hibernation module wakes, the microcontroller performs a normal power-on reset. Note that this reset does not reset the Hibernation module, but does reset the rest of the microcontroller. Software can detect that the power-on was due to a wake from hibernation by examining the raw interrupt status register (see "Interrupts and Status" on page 274) and by looking for state data in the battery-backed memory (see "Battery-Backed Memory" on page 273).

6.3.11 Interrupts and Status

The Hibernation module can generate interrupts when the following conditions occur:

- Assertion of WAKE pin
- RTC match
- Low battery detected

All of the interrupts are ORed together before being sent to the interrupt controller, so the Hibernate module can only generate a single interrupt request to the controller at any given time. The software interrupt handler can service multiple interrupt events by reading the **Hibernation Masked Interrupt Status (HIBMIS)** register. Software can also read the status of the Hibernation module at any time by reading the **HIBRIS** register which shows all of the pending events. This register can be used after waking from hibernation to see if the wake condition was caused by the $\overline{\text{WAKE}}$ signal or the RTC match.

The events that can trigger an interrupt are configured by setting the appropriate bits in the **Hibernation Interrupt Mask (HIBIM)** register. Pending interrupts can be cleared by writing the corresponding bit in the **Hibernation Interrupt Clear (HIBIC)** register.

6.4 Initialization and Configuration

The Hibernation module has several different configurations. The following sections show the recommended programming sequence for various scenarios. The examples below assume that a 32.768-kHz oscillator is used, and thus always set the CLKSEL bit of the **HIBCTL** register. If a 4.194304-MHz crystal is used instead, then the CLKSEL bit remains cleared. Because the Hibernation module runs at 32.768 kHz and is asynchronous to the rest of the microcontroller, which is run off the system clock, software must allow a delay of $t_{HIB_REG_ACCESS}$ after writes to certain registers (see "Register Access Timing" on page 269). The registers that require a delay are listed in a note in "Register Map" on page 276 as well as in each register description.

6.4.1 Initialization

The Hibernation module comes out of reset with the system clock enabled to the module, but if the system clock to the module has been disabled, then it must be re-enabled, even if the RTC feature is not used. See page 240.

If a 4.194304-MHz crystal is used as the Hibernation module clock source, perform the following step:

1. Write 0x40 to the **HIBCTL** register at offset 0x10 to enable the crystal and select the divide-by-128 input path.

If a 32.678-kHz single-ended oscillator is used as the Hibernation module clock source, then perform the following steps:

- 1. Write 0x44 to the **HIBCTL** register at offset 0x10 to enable the oscillator input and bypass the on-chip oscillator.
- 2. No delay is necessary.

The above steps are only necessary when the entire system is initialized for the first time. If the microcontroller has been in hibernation, then the Hibernation module has already been powered up and the above steps are not necessary. The software can detect that the Hibernation module and clock are already powered by examining the CLK32EN bit of the **HIBCTL** register.

Table 6-3 on page 275 illustrates how the clocks function with various bit setting both in normal operation and in hibernation.

Table 6-3. Hibern	ation Module	Clock	Operation
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CLK32EN	PINWEN	RTCWEN	CLKSEL	RTCEN	Result Normal Operation	Result Hibernation
0	Х	Х	Х	Х	Hibernation module disabled	Hibernation module disabled
1	0	0	0	1	RTC match capability enabled. Module clocked from 4.184304-MHz crystal.	No hibernation
1	0	0	1	1	RTC match capability enabled. Module clocked from 32.768-kHz oscillator.	No hibernation
1	0	1	Х	1	Module clocked from selected source	RTC match for wake-up event
1	1	0	X	0	Module clocked from selected source	Clock is powered down during hibernation and powered up again on external wake-up event.
1	1	0	Х	1	Module clocked from selected source	Clock is powered up during hibernation for RTC. Wake up on external event.
1	1	1	Х	1	Module clocked from selected source	RTC match or external wake-up event, whichever occurs first.

6.4.2 RTC Match Functionality (No Hibernation)

Use the following steps to implement the RTC match functionality of the Hibernation module:

- 1. Write the required RTC match value to one of the **HIBRTCMn** registers at offset 0x004 or 0x008.
- 2. Write the required RTC load value to the **HIBRTCLD** register at offset 0x00C.
- 3. Set the required RTC match interrupt mask in the RTCALT0 and RTCALT1 bits (bits 1:0) in the HIBIM register at offset 0x014.
- 4. Write 0x0000.0041 to the **HIBCTL** register at offset 0x010 to enable the RTC to begin counting.

6.4.3 RTC Match/Wake-Up from Hibernation

Use the following steps to implement the RTC match and wake-up functionality of the Hibernation module:

- 1. Write the required RTC match value to the **HIBRTCMn** registers at offset 0x004 or 0x008.
- 2. Write the required RTC load value to the **HIBRTCLD** register at offset 0x00C.

- 3. Write any data to be retained during power cut to the HIBDATA register at offsets 0x030-0x12C.
- **4.** Set the RTC Match Wake-Up and start the hibernation sequence by writing 0x0000.004F to the **HIBCTL** register at offset 0x010.

6.4.4 External Wake-Up from Hibernation

Use the following steps to implement the Hibernation module with the external $\overline{\mathtt{WAKE}}$ pin as the wake-up source for the microcontroller:

- 1. Write any data to be retained during power cut to the **HIBDATA** register at offsets 0x030-0x12C.
- 2. Enable the external wake and start the hibernation sequence by writing 0x0000.0056 to the **HIBCTL** register at offset 0x010.

Note that in this mode, if the RTC is disabled, then the Hibernation clock source is powered down during Hibernate mode and is powered up again on the external wake event to save power during hibernation. If the RTC is enabled before hibernation, it continues to operate during hibernation.

6.4.5 RTC or External Wake-Up from Hibernation

- 1. Write the required RTC match value to the **HIBRTCMn** registers at offset 0x004 or 0x008.
- 2. Write the required RTC load value to the **HIBRTCLD** register at offset 0x00C.
- 3. Write any data to be retained during power cut to the HIBDATA register at offsets 0x030-0x12C.
- **4.** Set the RTC Match/External Wake-Up and start the hibernation sequence by writing 0x0000.005F to the **HIBCTL** register at offset 0x010.

6.5 Register Map

Table 6-4 on page 277 lists the Hibernation registers. All addresses given are relative to the Hibernation Module base address at 0x400F.C000. Note that the system clock to the Hibernation module must be enabled before the registers can be programmed (see page 240). There must be a delay of 3 system clocks after the Hibernation module clock is enabled before any Hibernation module registers are accessed.

Note: HIBRTCC, HIBRTCM0, HIBRTCM1, HIBRTCLD, HIBRTCT, and HIBDATA are on the Hibernation module clock domain and have special timing requirements. Software should make use of the WRC bit in the HIBCTL register to ensure that the required timing gap has elapsed. If the WRC bit is clear, any attempted write access is ignored. See "Register Access Timing" on page 269.

Important: The Hibernation module registers are reset under two conditions:

- 1. A system reset when the RTCEN and the PINWEN bits in the **HIBCTL** register are both cleared.
- **2.** A cold POR, when both the V_{DD} and V_{BAT} supplies are removed.

Any other reset condition is ignored by the Hibernation module.

Table 6-4. Hibernation Module Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	HIBRTCC	RO	0x0000.0000	Hibernation RTC Counter	278
0x004	HIBRTCM0	R/W	0xFFFF.FFFF	Hibernation RTC Match 0	279
0x008	HIBRTCM1	R/W	0xFFFF.FFFF	Hibernation RTC Match 1	280
0x00C	HIBRTCLD	R/W	0xFFFF.FFFF	Hibernation RTC Load	281
0x010	HIBCTL	R/W	0x8000.0000	Hibernation Control	282
0x014	HIBIM	R/W	0x0000.0000	Hibernation Interrupt Mask	285
0x018	HIBRIS	RO	0x0000.0000	Hibernation Raw Interrupt Status	287
0x01C	HIBMIS	RO	0x0000.0000	Hibernation Masked Interrupt Status	289
0x020	HIBIC	R/W1C	0x0000.0000	Hibernation Interrupt Clear	291
0x024	HIBRTCT	R/W	0x0000.7FFF	Hibernation RTC Trim	292
0x030- 0x12C	HIBDATA	R/W	-	Hibernation Data	293

6.6 Register Descriptions

The remainder of this section lists and describes the Hibernation module registers, in numerical order by address offset.

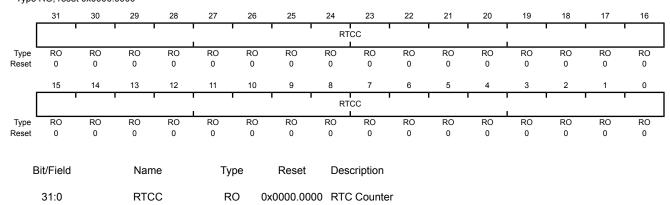
Register 1: Hibernation RTC Counter (HIBRTCC), offset 0x000

This register is the current 32-bit value of the RTC counter.

Note: HIBRTCC, HIBRTCM0, HIBRTCM1, HIBRTCLD, HIBRTCT, and HIBDATA are on the Hibernation module clock domain and have special timing requirements. Software should make use of the WRC bit in the HIBCTL register to ensure that the required timing gap has elapsed. If the WRC bit is clear, any attempted write access is ignored. See "Register Access Timing" on page 269.

Hibernation RTC Counter (HIBRTCC)

Base 0x400F.C000 Offset 0x000 Type RO, reset 0x0000.0000



A read returns the 32-bit counter value, which represents the seconds elapsed since the RTC was enabled. This register is read-only. To change the value, use the **HIBRTCLD** register.

Register 2: Hibernation RTC Match 0 (HIBRTCM0), offset 0x004

This register is the 32-bit match 0 register for the RTC counter.

Note: HIBRTCC, HIBRTCM0, HIBRTCM1, HIBRTCLD, HIBRTCT, and HIBDATA are on the Hibernation module clock domain and have special timing requirements. Software should make use of the WRC bit in the HIBCTL register to ensure that the required timing gap has elapsed. If the WRC bit is clear, any attempted write access is ignored. See "Register Access Timing" on page 269.

Hibernation RTC Match 0 (HIBRTCM0)

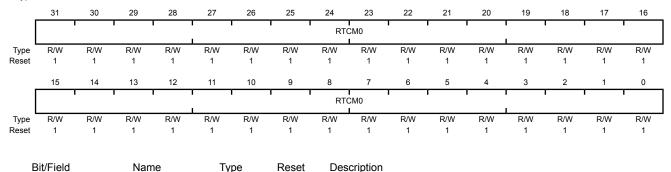
RTCM0

R/W

Base 0x400F.C000 Offset 0x004

31:0

Type R/W, reset 0xFFF.FFF



0xFFFF.FFFF RTC Match 0

A write loads the value into the RTC match register.

A read returns the current match value.

Register 3: Hibernation RTC Match 1 (HIBRTCM1), offset 0x008

This register is the 32-bit match 1 register for the RTC counter.

HIBRTCC, HIBRTCM0, HIBRTCM1, HIBRTCLD, HIBRTCT, and HIBDATA are on the Hibernation module clock domain and have special timing requirements. Software should make use of the WRC bit in the HIBCTL register to ensure that the required timing gap has elapsed. If the WRC bit is clear, any attempted write access is ignored. See "Register Access Timing" on page 269.

Hibernation RTC Match 1 (HIBRTCM1)

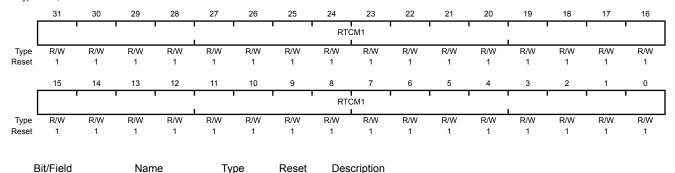
RTCM1

R/W

Base 0x400F.C000 Offset 0x008

31:0

Type R/W, reset 0xFFF.FFF



0xFFFF.FFFF RTC Match 1

A write loads the value into the RTC match register.

A read returns the current match value.

Register 4: Hibernation RTC Load (HIBRTCLD), offset 0x00C

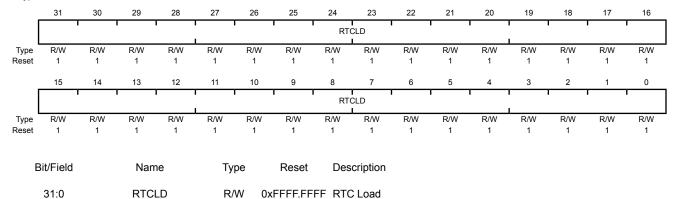
This register is used to load a 32-bit value loaded into the RTC counter. The load occurs immediately upon this register being written.

Note: HIBRTCC, HIBRTCM0, HIBRTCM1, HIBRTCLD, HIBRTCT, and HIBDATA are on the Hibernation module clock domain and have special timing requirements. Software should make use of the WRC bit in the HIBCTL register to ensure that the required timing gap has elapsed. If the WRC bit is clear, any attempted write access is ignored. See "Register Access Timing" on page 269.

Hibernation RTC Load (HIBRTCLD)

Base 0x400F.C000 Offset 0x00C

Offset 0x00C Type R/W, reset 0xFFFF.FFF



A write loads the current value into the RTC counter (RTCC).

A read returns the 32-bit load value.

Register 5: Hibernation Control (HIBCTL), offset 0x010

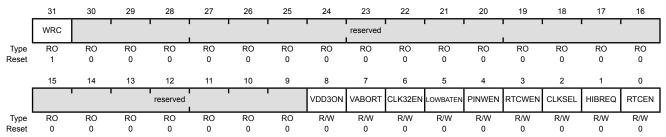
This register is the control register for the Hibernation module. This register must be written last before a hibernate event is issued. Writes to other registers after the HIBREQ bit is set are not guaranteed to complete before hibernation is entered.

Hibernation Control (HIBCTL)

Base 0x400F.C000 Offset 0x010

Rit/Field

Type R/W, reset 0x8000.0000



Bit/Field	Name	Type	Reset	Description
31	WRC	RO	1	Write Complete/Capable

Value Description

- The interface is processing a prior write and is busy. Any write operation that is attempted while WRC is 0 results in undetermined behavior.
- 1 The interface is ready to accept a write.

Software must poll this bit between write requests and defer writes until WRC=1 to ensure proper operation.

The bit name WRC means "Write Complete," which is the normal use of the bit (between write accesses). However, because the bit is set out-of-reset, the name can also mean "Write Capable" which simply indicates that the interface may be written to by software. This difference may be exploited by software at reset time to detect which method of programming is appropriate: 0 = software delay loops required; 1 = WRC paced available.

30:9	reserved	RO	0x000

R/W

VDD3ON

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Value Description

VDD Powered

- The internal switches control the power to the on-chip modules (VDD3ON mode).
- 0 The internal switches are not used. The $\overline{\mathtt{HIB}}$ signal should be used to control an external switch or regulator.

Note that regardless of the status of the VDD30N bit, the $\overline{\tt HIB}$ signal is asserted during Hibernate mode. Thus, when VDD30N is set, the $\overline{ t HIB}$ signal should not be connected to the 3.3V regulator, and the 3.3V power source should remain connected.

Bit/Field	Name	Туре	Reset	Description	on
7	VABORT	R/W	0	Power Co	ut Abort Enable
				Value	Description
				1	When this bit is set, the battery voltage level is checked before entering hibernation. If V_{BAT} is less than V_{LOWBAT} , the microcontroller does not go into hibernation.
				0	The microcontroller goes into hibernation regardless of the voltage level of the battery.
6	CLK32EN	R/W	0	Clocking	Enable
				This bit n	nust be enabled to use the Hibernation module.
				Value	Description
				1	The Hibernation module clock source is enabled.
				0	The Hibernation module clock source is disabled.
5	LOWBATEN	R/W	0	Low Batte	ery Monitoring Enable
				Value	Description
				1	Low battery voltage detection is enabled. When this bit is set, the battery voltage level is checked before entering hibernation. If V_{BAT} is less than V_{LOWBAT} , the LOWBAT bit in the HIBRIS register is set.
				0	Low battery monitoring is disabled.
4	PINWEN	R/W	0	External	WAKE Pin Enable
				Value	Description
				1	An assertion of the $\overline{\mathtt{WAKE}}$ pin takes the microcontroller out of hibernation.
				0	The status of the $\overline{\mathtt{WAKE}}$ pin has no effect on hibernation.
3	RTCWEN	R/W	0	RTC Wal	ke-up Enable
				Value	Description
				1	An RTC match event (the value the HIBRTCC register matches the value of the HIBRTCM0 or HIBRTCM1 register) takes the microcontroller out of hibernation.
				0	An RTC match event has no effect on hibernation.
2	CLKSEL	R/W	0	Hibernati	ion Module Clock Select
				Value	Description
				1	Use raw output. Use this value for a 32.768-kHz oscillator.
				0	Use Divide-by-128 output. Use this value for a 4.194304-MHz crystal.

Bit/Field	Name	Туре	Reset	Description	
1	HIBREQ	R/W	0	Hibernation	Request
				Value	Description
				1	Set this bit to initiate hibernation.
				0	No hibernation request.
				After a wak	e-up event, this bit is automatically cleared by hardware.
				A hibernation are clear.	on request is ignored if both the PINWEN and RTCWEN bits
0	RTCEN	R/W	0	RTC Timer	Enable
				Value	Description
				1	The Hibernation module RTC is enabled.
				0	The Hibernation module RTC is disabled.

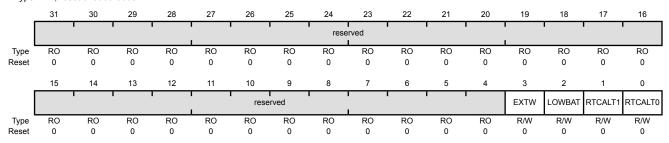
Register 6: Hibernation Interrupt Mask (HIBIM), offset 0x014

This register is the interrupt mask register for the Hibernation module interrupt sources. Each bit in this register masks the corresponding bit in the **Hibernation Raw Interrupt Status (HIBRIS)** register. If a bit is unmasked, the interrupt is sent to the interrupt controller. If the bit is masked, the interrupt is not sent to the interrupt controller.

Hibernation Interrupt Mask (HIBIM)

Base 0x400F.C000

Offset 0x014 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	EXTW	R/W	0	External Wake-Up Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the EXTW bit in the HIBRIS register is set.
				O The EXTW interrupt is suppressed and not sent to the interrupt controller.
2	LOWBAT	R/W	0	Low Battery Voltage Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the LOWBAT bit in the HIBRIS register is set.
				O The LOWBAT interrupt is suppressed and not sent to the interrupt controller.
1	RTCALT1	R/W	0	RTC Alert 1 Interrupt Mask
				Value Description

Value Description

- 1 An interrupt is sent to the interrupt controller when the RTCALT1 bit in the HIBRIS register is set.
- The RTCALT1 interrupt is suppressed and not sent to the interrupt controller.

Bit/Field	Name	Type	Reset	Description
0	RTCALT0	R/W	0	RTC Alert 0 Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the RTCALT0 bit in the HIBRIS register is set.
				O The RTCALTO interrupt is suppressed and not sent to the interrupt controller.

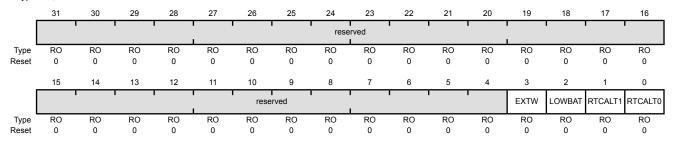
Register 7: Hibernation Raw Interrupt Status (HIBRIS), offset 0x018

This register is the raw interrupt status for the Hibernation module interrupt sources. Each bit can be masked by clearing the corresponding bit in the HIBIM register. When a bit is masked, the interrupt is not sent to the interrupt controller. Bits in this register are cleared by writing a 1 to the corresponding bit in the Hibernation Interrupt Clear (HIBIC) register or by entering hibernation.

Hibernation Raw Interrupt Status (HIBRIS)

Base 0x400F.C000

Offset 0x018
Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:4	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	EXTW	RO	0	External Wake-Up Raw Interrupt Status
				Value Description 1 The WAKE pin has been asserted. 0 The WAKE pin has not been asserted. This bit is cleared by writing a 1 to the EXTW bit in the HIBIC register.
2	LOWBAT	RO	0	Low Battery Voltage Raw Interrupt Status Value Description 1 The battery voltage dropped below V _{LOWBAT} . 0 The battery voltage has not dropped below V _{LOWBAT} .
1	RTCALT1	RO	0	This bit is cleared by writing a 1 to the LOWBAT bit in the HIBIC register. RTC Alert 1 Raw Interrupt Status Value Description

- The value of the **HIBRTCC** register matches the value in the 1 HIBRTCM1 register.
- 0 No match

This bit is cleared by writing a 1 to the RTCALT1 bit in the **HIBIC** register.

Bit/Field	Name	Type	Reset	Description
0	RTCALT0	RO	0	RTC Alert 0 Raw Interrupt Status
				Value Description
				The value of the HIBRTCC register matches the value in the HIBRTCM0 register.
				0 No match
				This bit is cleared by writing a 1 to the RTCALT0 bit in the HIBIC register.

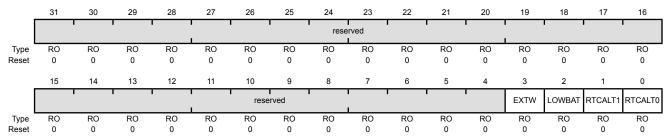
Register 8: Hibernation Masked Interrupt Status (HIBMIS), offset 0x01C

This register is the masked interrupt status for the Hibernation module interrupt sources. Bits in this register are the AND of the corresponding bits in the HIBRIS and HIBIM registers. When both corresponding bits are set, the bit in this register is set, and the interrupt is sent to the interrupt controller.

Hibernation Masked Interrupt Status (HIBMIS)

Base 0x400F.C000

Offset 0x01C Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:4	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	EXTW	RO	0	External Wake-Up Masked Interrupt Status
				Value Description
				1 An unmasked interrupt was signaled due to a WAKE pin assertion.
				O An external wake-up interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the EXTW bit in the HIBIC register.
2	LOWBAT	RO	0	Low Battery Voltage Masked Interrupt Status
				Value Description
				1 An unmasked interrupt was signaled due to a low battery voltage condition.
				O A low battery voltage interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the LOWBAT bit in the HIBIC register.
1	RTCALT1	RO	0	RTC Alert 1 Masked Interrupt Status
				Value Description

- An unmasked interrupt was signaled due to an RTC match. 1
- 0 An RTC match interrupt has not occurred or is masked.

This bit is cleared by writing a 1 to the RTCALT1 bit in the **HIBIC** register.

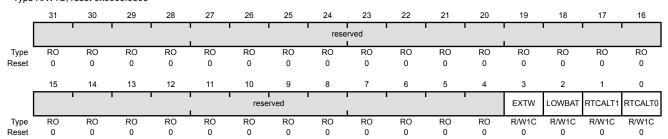
Bit/Field	Name	Type	Reset	Description
0	RTCALT0	RO	0	RTC Alert 0 Masked Interrupt Status
				Value Description An unmasked interrupt was signaled due to an RTC match. An RTC match interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the RTCALTO bit in the HIBIC register.

Register 9: Hibernation Interrupt Clear (HIBIC), offset 0x020

This register is the interrupt write-one-to-clear register for the Hibernation module interrupt sources. Writing a 1 to a bit clears the corresponding interrupt in the **HIBRIS** register.

Hibernation Interrupt Clear (HIBIC)

Base 0x400F.C000 Offset 0x020 Type R/W1C, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	EXTW	R/W1C	0	External Wake-Up Masked Interrupt Clear
				Writing a 1 to this bit clears the EXTW bit in the HIBRIS and HIBMIS registers.
				Reads return an indeterminate value.
2	LOWBAT	R/W1C	0	Low Battery Voltage Masked Interrupt Clear
				Writing a 1 to this bit clears the LOWBAT bit in the \textbf{HIBRIS} and \textbf{HIBMIS} registers.
				Reads return an indeterminate value.
1	RTCALT1	R/W1C	0	RTC Alert1 Masked Interrupt Clear
				Writing a 1 to this bit clears the RTCALT1 bit in the \textbf{HIBRIS} and \textbf{HIBMIS} registers.
				Reads return an indeterminate value.
0	RTCALT0	R/W1C	0	RTC Alert0 Masked Interrupt Clear
				Writing a 1 to this bit clears the ${\tt RTCALT0}$ bit in the \textbf{HIBRIS} and \textbf{HIBMIS} registers.
				Reads return an indeterminate value.

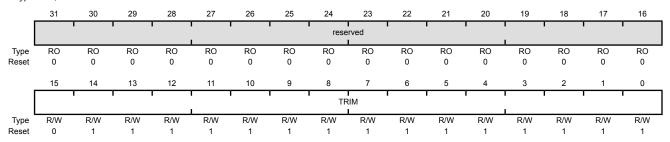
Register 10: Hibernation RTC Trim (HIBRTCT), offset 0x024

This register contains the value that is used to trim the RTC clock predivider. It represents the computed underflow value that is used during the trim cycle. It is represented as $0x7FFF \pm N$ clock cycles, where N is the number of clock cycles to add or subtract every 63 seconds.

Note: HIBRTCC, HIBRTCM0, HIBRTCM1, HIBRTCLD, HIBRTCT, and HIBDATA are on the Hibernation module clock domain and have special timing requirements. Software should make use of the WRC bit in the HIBCTL register to ensure that the required timing gap has elapsed. If the WRC bit is clear, any attempted write access is ignored. See "Register Access Timing" on page 269.

Hibernation RTC Trim (HIBRTCT)

Base 0x400F.C000 Offset 0x024 Type R/W, reset 0x0000.7FFF



Bit/Field	Name	Туре	Reset	Description
31:16	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:0	TRIM	R/W	0x7FFF	RTC Trim Value

This value is loaded into the RTC predivider every 64 seconds. It is used to adjust the RTC rate to account for drift and inaccuracy in the clock source. Compensation can be adjusted by software by moving the default value of 0x7FFF up or down. Moving the value up slows down the RTC and moving the value down speeds up the RTC.

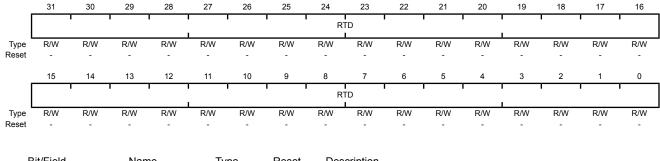
Register 11: Hibernation Data (HIBDATA), offset 0x030-0x12C

This address space is implemented as a 64x32-bit memory (256 bytes). It can be loaded by the system processor in order to store state information and does not lose power during a power cut operation as long as a battery is present.

Note: HIBRTCC, HIBRTCM0, HIBRTCM1, HIBRTCLD, HIBRTCT, and HIBDATA are on the Hibernation module clock domain and have special timing requirements. Software should make use of the WRC bit in the HIBCTL register to ensure that the required timing gap has elapsed. If the WRC bit is clear, any attempted write access is ignored. See "Register Access Timing" on page 269.

Hibernation Data (HIBDATA)

Base 0x400F.C000 Offset 0x030-0x12C Type R/W, reset -



Bit/Field	Name	Type	Reset	Description
31:0	RTD	R/W	-	Hibernation Module NV Data

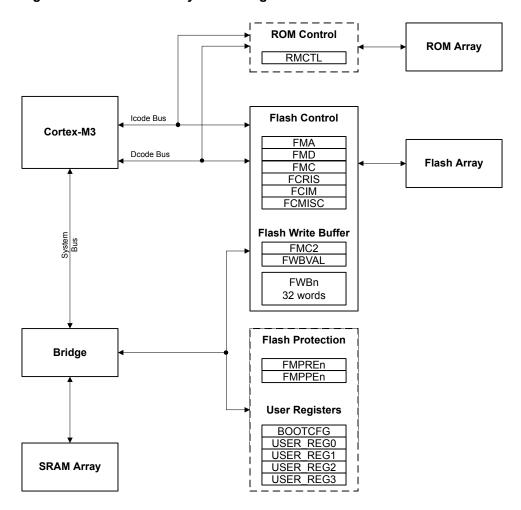
7 Internal Memory

The LM3S1J11 microcontroller comes with 20 KB of bit-banded SRAM, internal ROM, and 128 KB of Flash memory. The Flash memory controller provides a user-friendly interface, making Flash memory programming a simple task. Flash memory protection can be applied to the Flash memory on a 2-KB block basis.

7.1 Block Diagram

Figure 7-1 on page 294 illustrates the internal memory blocks and control logic. The dashed boxes in the figure indicate registers residing in the System Control module.

Figure 7-1. Internal Memory Block Diagram



7.2 Functional Description

This section describes the functionality of the SRAM, ROM, and Flash memories.

Note: The μDMA controller can transfer data to and from the on-chip SRAM. However, because the Flash memory and ROM are located on a separate internal bus, it is not possible to transfer data from the Flash memory or ROM with the μDMA controller.

7.2.1 SRAM

The internal SRAM of the Stellaris[®] devices is located at address 0x2000.0000 of the device memory map. To reduce the number of time consuming read-modify-write (RMW) operations, ARM provides bit-banding technology in the processor. With a bit-band-enabled processor, certain regions in the memory map (SRAM and peripheral space) can use address aliases to access individual bits in a single, atomic operation. The bit-band base is located at address 0x2200.0000.

The bit-band alias is calculated by using the formula:

```
bit-band alias = bit-band base + (byte offset * 32) + (bit number * 4)
```

For example, if bit 3 at address 0x2000.1000 is to be modified, the bit-band alias is calculated as:

```
0x2200.0000 + (0x1000 * 32) + (3 * 4) = 0x2202.000C
```

With the alias address calculated, an instruction performing a read/write to address 0x2202.000C allows direct access to only bit 3 of the byte at address 0x2000.1000.

For details about bit-banding, see "Bit-Banding" on page 77.

Note: The SRAM is implemented using two 32-bit wide SRAM banks (separate SRAM arrays). The banks are partitioned such that one bank contains all even words (the even bank) and the other contains all odd words (the odd bank). A write access that is followed immediately by a read access to the same bank incurs a stall of a single clock cycle. However, a write to one bank followed by a read of the other bank can occur in successive clock cycles without incurring any delay.

7.2.2 ROM

The internal ROM of the Stellaris device is located at address 0x0100.0000 of the device memory map. Detailed information on the ROM contents can be found in the *Stellaris® ROM User's Guide*.

The ROM contains the following components:

- Stellaris Boot Loader and vector table
- Stellaris Peripheral Driver Library (DriverLib) release for product-specific peripherals and interfaces
- Advanced Encryption Standard (AES) cryptography tables
- Cyclic Redundancy Check (CRC) error detection functionality

The boot loader is used as an initial program loader (when the Flash memory is empty) as well as an application-initiated firmware upgrade mechanism (by calling back to the boot loader). The Peripheral Driver Library APIs in ROM can be called by applications, reducing Flash memory requirements and freeing the Flash memory to be used for other purposes (such as additional features in the application). Advance Encryption Standard (AES) is a publicly defined encryption standard used by the U.S. Government and Cyclic Redundancy Check (CRC) is a technique to validate a span of data has the same contents as when previously checked.

7.2.2.1 Boot Loader Overview

The Stellaris Boot Loader is used to download code to the Flash memory of a device without the use of a debug interface. When the core is reset, the user has the opportunity to direct the core to execute the ROM Boot Loader or the application in Flash memory by using any GPIO signal in Ports A-H as configured in the **Boot Configuration (BOOTCFG)** register.

At reset, the ROM is mapped over the Flash memory so that the ROM boot sequence is always executed. The boot sequence executed from ROM is as follows:

- 1. The BA bit (below) is cleared such that ROM is mapped to 0x01xx.xxxx and Flash memory is mapped to address 0x0.
- 2. The **BOOTCFG** register is read. If the EN bit is clear, the status of the specified GPIO pin is compared with the specified polarity. If the status matches the specified polarity, the ROM is mapped to address 0x0000.0000 and execution continues out of the ROM Boot Loader.
- 3. If the status doesn't match the specified polarity, the data at address 0x0000.0004 is read, and if the data at this address is 0xFFFF.FFFF, the ROM is mapped to address 0x0000.0000 and execution continues out of the ROM Boot Loader.
- **4.** If there is data at address 0x0000.0004 that is not 0xFFF.FFF, the stack pointer (**SP**) is loaded from Flash memory at address 0x0000.0000 and the program counter (**PC**) is loaded from address 0x0000.0004. The user application begins executing.

The boot loader uses a simple packet interface to provide synchronous communication with the device. The speed of the boot loader is determined by the internal oscillator (PIOSC) frequency as it does not enable the PLL. The following serial interfaces can be used:

- UART0
- SSI0
- I²C0

For simplicity, both the data format and communication protocol are identical for all serial interfaces.

See the Stellaris® Boot Loader User's Guide for information on the boot loader software.

7.2.2.2 Stellaris Peripheral Driver Library

The Stellaris Peripheral Driver Library contains a file called driverlib/rom.h that assists with calling the peripheral driver library functions in the ROM. The detailed description of each function is available in the *Stellaris® ROM User's Guide*. See the "Using the ROM" chapter of the *Stellaris® Peripheral Driver Library User's Guide* for more details on calling the ROM functions and using driverlib/rom.h.

A table at the beginning of the ROM points to the entry points for the APIs that are provided in the ROM. Accessing the API through these tables provides scalability; while the API locations may change in future versions of the ROM, the API tables will not. The tables are split into two levels; the main table contains one pointer per peripheral which points to a secondary table that contains one pointer per API that is associated with that peripheral. The main table is located at 0x0100.0010, right after the Cortex-M3 vector table in the ROM.

DriverLib functions are described in detail in the Stellaris® Peripheral Driver Library User's Guide.

Additional APIs are available for graphics and USB functions, but are not preloaded into ROM. The Stellaris Graphics Library provides a set of graphics primitives and a widget set for creating graphical user interfaces on Stellaris microcontroller-based boards that have a graphical display (for more information, see the *Stellaris*® *Graphics Library User's Guide*).

7.2.2.3 Advanced Encryption Standard (AES) Cryptography Tables

AES is a strong encryption method with reasonable performance and size. AES is fast in both hardware and software, is fairly easy to implement, and requires little memory. AES is ideal for applications that can use pre-arranged keys, such as setup during manufacturing or configuration. Four data tables used by the XySSL AES implementation are provided in the ROM. The first is the forward S-box substitution table, the second is the reverse S-box substitution table, the third is the forward polynomial table, and the final is the reverse polynomial table. See the *Stellaris® ROM User's Guide* for more information on AES.

7.2.2.4 Cyclic Redundancy Check (CRC) Error Detection

The CRC technique can be used to validate correct receipt of messages (nothing lost or modified in transit), to validate data after decompression, to validate that Flash memory contents have not been changed, and for other cases where the data needs to be validated. A CRC is preferred over a simple checksum (e.g. XOR all bits) because it catches changes more readily. See the *Stellaris® ROM User's Guide* for more information on CRC.

7.2.3 Flash Memory

The Flash memory is organized as a set of 1-KB blocks that can be individually erased. An individual 32-bit word can be programmed to change bits from 1 to 0. In addition, a write buffer provides the ability to concurrently program 32 continuous words in Flash memory. Erasing a block causes the entire contents of the block to be reset to all 1s. The 1-KB blocks are paired into sets of 2-KB blocks that can be individually protected. The protection allows blocks to be marked as read-only or execute-only, providing different levels of code protection. Read-only blocks cannot be erased or programmed, protecting the contents of those blocks from being modified. Execute-only blocks cannot be erased or programmed and can only be read by the controller instruction fetch mechanism, protecting the contents of those blocks from being read by either the controller or by a debugger.

Caution - The Stellaris Flash memory array has ECC which uses a test port into the Flash memory to continually scan the array for ECC errors and to correct any that are detected. This operation is transparent to the microcontroller. The BIST must scan the entire memory array occasionally to ensure integrity, taking about five minutes to do so. In systems where the microcontroller is frequently powered for less than five minutes, power should be removed from the microcontroller in a controlled manner to ensure proper operation. This controlled manner can either be through entering Hibernate mode or software can request permission to power down the part using the USDREQ bit in the Flash Control (FCTL) register and wait to receive an acknowledge from the USDACK bit prior to removing power. If the microcontroller is powered down using this controlled method, the BIST engine keeps track of where it was in the memory array and it always scans the complete array after any aggregate of five minutes powered-on, regardless of the number of intervening power cycles. If the microcontroller is powered down before five minutes of being powered up, BIST starts again from wherever it left off before the last controlled power-down or from 0 if there never was a controlled power down. An occasional short power down is not a concern, but the microcontroller should not always be powered down frequently in an uncontrolled manner. The microcontroller can be power-cycled as frequently as necessary if it is powered-down in a controlled manner.

7.2.3.1 Flash Memory Protection

The user is provided two forms of Flash memory protection per 2-KB Flash memory block in two pairs of 32-bit wide registers. The policy for each protection form is controlled by individual bits (per policy per block) in the **FMPPEn** and **FMPREn** registers.

- Flash Memory Protection Program Enable (FMPPEn): If a bit is set, the corresponding block may be programmed (written) or erased. If a bit is cleared, the corresponding block may not be changed.
- Flash Memory Protection Read Enable (FMPREn): If a bit is set, the corresponding block may be executed or read by software or debuggers. If a bit is cleared, the corresponding block may only be executed, and contents of the memory block are prohibited from being read as data.

The policies may be combined as shown in Table 7-1 on page 298.

Table 7-1. Flash Memory Protection Policy Combinations

FMPPEn	FMPREn	Protection
0	0	Execute-only protection. The block may only be executed and may not be written or erased. This mode is used to protect code.
1	0	The block may be written, erased or executed, but not read. This combination is unlikely to be used.
0	1	Read-only protection. The block may be read or executed but may not be written or erased. This mode is used to lock the block from further modification while allowing any read or execute access.
1	1	No protection. The block may be written, erased, executed or read.

A Flash memory access that attempts to read a read-protected block (**FMPREn** bit is set) is prohibited and generates a bus fault. A Flash memory access that attempts to program or erase a program-protected block (**FMPPEn** bit is set) is prohibited and can optionally generate an interrupt (by setting the AMASK bit in the **Flash Controller Interrupt Mask (FCIM)** register) to alert software developers of poorly behaving software during the development and debug phases. Note that if a **FMPREn** bit is cleared, all read accesses to the Flash memory block are disallowed, including any data accesses. Care must be taken not to store required data in a Flash memory block that has the associated **FMPREn** bit cleared.

The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. These settings create a policy of open access and programmability. The register bits may be changed by clearing the specific register bit. The changes are effective immediately, but are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing any type of reset sequence. The changes are committed using the **Flash Memory Control (FMC)** register. Details on programming these bits are discussed in "Non-Volatile Register Programming" on page 300.

7.2.3.2 Interrupts

The Flash memory controller can generate interrupts when the following conditions are observed:

- Programming Interrupt signals when a program or erase action is complete.
- Access Interrupt signals when a program or erase action has been attempted on a 2-kB block of memory that is protected by its corresponding FMPPEn bit.

The interrupt events that can trigger a controller-level interrupt are defined in the **Flash Controller Masked Interrupt Status (FCMIS)** register (see page 310) by setting the corresponding MASK bits. If interrupts are not used, the raw interrupt status is always visible via the **Flash Controller Raw Interrupt Status (FCRIS)** register (see page 309).

Interrupts are always cleared (for both the FCMIS and FCRIS registers) by writing a 1 to the corresponding bit in the Flash Controller Masked Interrupt Status and Clear (FCMISC) register (see page 311).

7.2.3.3 Flash Memory Programming

The Stellaris devices provide a user-friendly interface for Flash memory programming. All erase/program operations are handled via three registers: **Flash Memory Address (FMA)**, **Flash Memory Data (FMD)**, and **Flash Memory Control (FMC)**. Note that if the debug capabilities of the microcontroller have been deactivated, resulting in a "locked" state, a recovery sequence must be performed in order to reactivate the debug module. See "Recovering a "Locked" Microcontroller" on page 168.

During a Flash memory operation (write, page erase, or mass erase) access to the Flash memory is inhibited. As a result, instruction and literal fetches are held off until the Flash memory operation is complete. If instruction execution is required during a Flash memory operation, the code that is executing must be placed in SRAM and executed from there while the flash operation is in progress.

Caution – The Flash memory is divided into sectors of electrically separated address ranges of 4 KB each, aligned on 4 KB boundaries. Erase/program operations on a 1-KB page have an electrical effect on the other three 1-KB pages within the sector. A specific 1-KB page must be erased after 6 total erase/program cycles occur to the other pages within its 4-KB sector. The following sequence of operations on a 4-KB sector of Flash memory (Page 0..3) provides an example:

- Page 3 is erase and programmed with values.
- Page 0, Page 1, and Page 2 are erased and then programmed with values. At this point Page 3 has been affected by 3 erase/program cycles.
- Page 0, Page 1, and Page 2 are again erased and then programmed with values. At this point Page 3 has been affected by 6 erase/program cycles.
- If the contents of Page 3 must continue to be valid, Page 3 must be erased and reprogrammed before any other page in this sector has another erase or program operation.

To program a 32-bit word

- Write source data to the FMD register.
- 2. Write the target address to the **FMA** register.
- 3. Write the Flash memory write key and the WRITE bit (a value of 0xA442.0001) to the **FMC** register.
- **4.** Poll the **FMC** register until the WRITE bit is cleared.

Important: To ensure proper operation, two writes to the same word must be separated by an ERASE. The following two sequences are allowed:

- ERASE -> PROGRAM value -> PROGRAM 0x0000.0000
- ERASE -> PROGRAM value -> ERASE

The following sequence is NOT allowed:

■ ERASE -> PROGRAM value -> PROGRAM value

To perform an erase of a 1-KB page

- Write the page address to the FMA register.
- 2. Write the Flash memory write key and the ERASE bit (a value of 0xA442.0002) to the FMC register.
- 3. Poll the FMC register until the ERASE bit is cleared or, alternatively, enable the programming interrupt using the PMASK bit in the FCIM register.

To perform a mass erase of the Flash memory

- 1. Write the Flash memory write key and the MERASE bit (a value of 0xA442.0004) to the **FMC** register.
- 2. Poll the FMC register until the MERASE bit is cleared or, alternatively, enable the programming interrupt using the PMASK bit in the FCIM register.

7.2.3.4 32-Word Flash Memory Write Buffer

A 32-word write buffer provides the capability to perform faster write accesses to the Flash memory by concurrently programing 32 words with a single buffered Flash memory write operation. The buffered Flash memory write operation takes the same amount of time as the single word write operation controlled by bit 0 in the **FMC** register. The data for the buffered write is written to the **Flash Write Buffer (FWBn)** registers.

The registers are 32-word aligned with Flash memory, and therefore the register **FWB0** corresponds with the address in **FMA** where bits [6:0] of **FMA** are all 0. **FWB1** corresponds with the address in **FMA** + 0x4 and so on. Only the **FWBn** registers that have been updated since the previous buffered Flash memory write operation are written. The **Flash Write Buffer Valid (FWBVAL)** register shows which registers have been written since the last buffered Flash memory write operation. This register contains a bit for each of the 32 **FWBn** registers, where bit[n] of **FWBVAL** corresponds to **FWBn**. The **FWBn** register has been updated if the corresponding bit in the **FWBVAL** register is set.

To program 32 words with a single buffered Flash memory write operation

- 1. Write the source data to the **FWBn** registers.
- 2. Write the target address to the **FMA** register. This must be a 32-word aligned address (that is, bits [6:0] in **FMA** must be 0s).
- 3. Write the Flash memory write key and the WRBUF bit (a value of 0xA442.0001) to the **FMC2** register.
- **4.** Poll the **FMC2** register until the WRBUF bit is cleared or wait for the PMIS interrupt to be signaled.

7.2.3.5 Non-Volatile Register Programming

This section discusses how to update the registers shown in Table 7-2 on page 302 that are resident within the Flash memory itself. These registers exist in a separate space from the main Flash memory array and are not affected by an ERASE or MASS ERASE operation. With the exception of the **Boot Configuration (BOOTCFG)** register, the settings in these registers can be written, their functions

verified, and their values read back before they are committed, at which point they become non-volatile. If a value in one of these registers has not been committed, any type of reset restores the last committed value or the default value if the register has never been committed. Once the register contents are committed, the only way to restore the factory default values is to perform the sequence described in "Recovering a "Locked" Microcontroller" on page 168.

To write to a non-volatile register:

- Bits can only be changed from 1 to 0.
- For all registers except the **BOOTCFG** register, write the data to the register address provided in the register description. For the **BOOTCFG** register, write the data to the **FMD** register.
- The registers can be read to verify their contents. To verify what is to be stored in the **BOOTCFG** register, read the **FMD** register. Reading the **BOOTCFG** register returns the previously committed value or the default value if the register has never been committed.
- The new values are effectively immediately for all registers except **BOOTCFG**, as the new value for the register is not stored in the register until it has been committed.
- Prior to committing the register value, any type of reset restores the last committed value or the default value if the register has never been committed.

To commit a new value to a non-volatile register:

- Write the data as described above.
- Write to the **FMA** register the value shown in Table 7-2 on page 302.
- Write the Flash memory write key and set the COMT bit in the **FMC** register. These values must be written to the **FMC** register at the same time.
- Committing a non-volatile register has the same timing as a write to regular Flash memory, defined by T_{PROG}, as shown in Table 20-19 on page 807. Software can poll the COMT bit in the **FMC** register to determine when the operation is complete, or an interrupt can be enabled by setting the PMASK bit in the **FCIM** register.
- When committing the **BOOTCFG** register, the INVDRIS bit in the **FCRIS** register is set if a bit that has already been committed as a 0 is attempted to be committed as a 1.
- Once the value has been committed, any type of reset has no effect on the register contents.
- Changes to the BOOTCFG register are effective after the next reset.
- The NW bit in the USER_REG0, USER_REG1, USER_REG2, USER_REG3, and BOOTCFG registers is cleared when the register is committed. Once this bit is cleared, additional changes to the register are not allowed.

Important: After being committed, these registers can only be restored to their factory default values by performing the sequence described in "Recovering a "Locked"
 Microcontroller" on page 168. The mass erase of the main Flash memory array caused by the sequence is performed prior to restoring these registers.

Table 7-2. User-Programmable Flash Memory Resident Registers

Register to be Committed	FMA Value	Data Source
FMPRE0	0x0000.0000	FMPRE0
FMPRE1	0x0000.0002	FMPRE1
FMPPE0	0x0000.0001	FMPPE0
FMPPE1	0x0000.0003	FMPPE1
USER_REG0	0x8000.0000	USER_REG0
USER_REG1	0x8000.0001	USER_REG1
USER_REG2	0x8000.0002	USER_REG2
USER_REG3	0x8000.0003	USER_REG3
BOOTCFG	0x7510.0000	FMD

7.3 Register Map

Table 7-3 on page 302 lists the ROM Controller register and the Flash memory and control registers. The offset listed is a hexadecimal increment to the register's address. The Flash memory register offsets are relative to the Flash memory control base address of 0x400F.D000. The ROM and Flash memory protection register offsets are relative to the System Control base address of 0x400F.E000.

Table 7-3. Flash Register Map

Offset	Name	Туре	Reset	Description	See page		
Flash Memory Registers (Flash Control Offset)							
0x000	FMA	R/W	0x0000.0000	Flash Memory Address	304		
0x004	FMD	R/W	0x0000.0000	Flash Memory Data	305		
0x008	FMC	R/W	0x0000.0000	Flash Memory Control	306		
0x00C	FCRIS	RO	0x0000.0000	Flash Controller Raw Interrupt Status	309		
0x010	FCIM	R/W	0x0000.0000	Flash Controller Interrupt Mask	310		
0x014	FCMISC	R/W1C	0x0000.0000	Flash Controller Masked Interrupt Status and Clear	311		
0x020	FMC2	R/W	0x0000.0000	Flash Memory Control 2	312		
0x030	FWBVAL	R/W	0x0000.0000	Flash Write Buffer Valid	313		
0x0F8	FCTL	R/W	0x0000.0000	Flash Control	314		
0x100 - 0x17C	FWBn	R/W	0x0000.0000	Flash Write Buffer n	315		
Memory F	Registers (System Contro	ol Offset)					
0x0F0	RMCTL	R/W1C	-	ROM Control	316		
0x130	FMPRE0	R/W	0xFFFF.FFFF	Flash Memory Protection Read Enable 0	317		
0x200	FMPRE0	R/W	0xFFFF.FFFF	Flash Memory Protection Read Enable 0	317		
0x134	FMPPE0	R/W	0xFFFF.FFFF	Flash Memory Protection Program Enable 0	318		
0x400	FMPPE0	R/W	0xFFFF.FFFF	Flash Memory Protection Program Enable 0	318		

Table 7-3. Flash Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0x1D0	BOOTCFG	R/W	0xFFFF.FFFE	Boot Configuration	319
0x1E0	USER_REG0	R/W	0xFFFF.FFFF	User Register 0	321
0x1E4	USER_REG1	R/W	0xFFFF.FFFF	User Register 1	322
0x1E8	USER_REG2	R/W	0xFFFF.FFFF	User Register 2	323
0x1EC	USER_REG3	R/W	0xFFFF.FFFF	User Register 3	324
0x204	FMPRE1	R/W	0xFFFF.FFFF	Flash Memory Protection Read Enable 1	325
0x208	FMPRE2	R/W	0x0000.0000	Flash Memory Protection Read Enable 2	326
0x20C	FMPRE3	R/W	0x0000.0000	Flash Memory Protection Read Enable 3	327
0x404	FMPPE1	R/W	0xFFFF.FFFF	Flash Memory Protection Program Enable 1	328
0x408	FMPPE2	R/W	0x0000.0000	Flash Memory Protection Program Enable 2	329
0x40C	FMPPE3	R/W	0x0000.0000	Flash Memory Protection Program Enable 3	330

7.4 Flash Memory Register Descriptions (Flash Control Offset)

This section lists and describes the Flash Memory registers, in numerical order by address offset. Registers in this section are relative to the Flash control base address of 0x400F.D000.

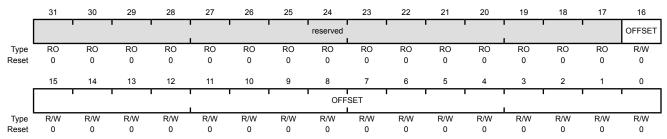
Register 1: Flash Memory Address (FMA), offset 0x000

During a write operation, this register contains a 4-byte-aligned address and specifies where the data is written. During erase operations, this register contains a 1 KB-aligned CPU byte address and specifies which block is erased. Note that the alignment requirements must be met by software or the results of the operation are unpredictable.

Flash Memory Address (FMA)

Base 0x400F.D000

Offset 0x000 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:17	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
16:0	OFFSET	R/W	0x0	Address Offset

Address offset in Flash memory where operation is performed, except for non-volatile registers (see "Non-Volatile Register Programming" on page 300 for details on values for this field).

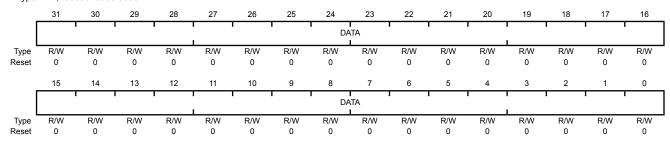
Register 2: Flash Memory Data (FMD), offset 0x004

This register contains the data to be written during the programming cycle or read during the read cycle. Note that the contents of this register are undefined for a read access of an execute-only block. This register is not used during erase cycles.

Flash Memory Data (FMD)

Base 0x400F.D000

Offset 0x004 Type R/W, reset 0x0000.0000



Bit/Field Name Type Reset Description
31:0 DATA R/W 0x0000.0000 Data Value

Data value for write operation.

Register 3: Flash Memory Control (FMC), offset 0x008

When this register is written, the Flash memory controller initiates the appropriate access cycle for the location specified by the **Flash Memory Address (FMA)** register (see page 304). If the access is a write access, the data contained in the **Flash Memory Data (FMD)** register (see page 305) is written to the specified address.

This register must be the final register written and initiates the memory operation. The four control bits in the lower byte of this register are used to initiate memory operations.

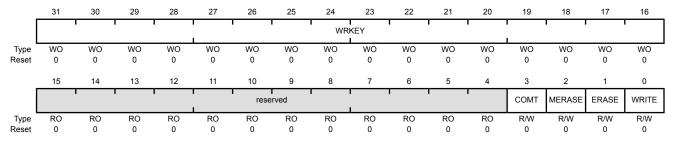
Care must be taken not to set multiple control bits as the results of such an operation are unpredictable.

Caution – If any of bits [15:4] are written to 1, the device may become inoperable. These bits should always be written to 0. In all registers, the value of a reserved bit should be preserved across a read-modify-write operation.

Flash Memory Control (FMC)

Base 0x400F.D000 Offset 0x008

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:16	WRKEY	WO	0x0000	Flash Memory Write Key
				This field contains a write key, which is used to minimize the incidence of accidental Flash memory writes. The value 0xA442 must be written into this field for a Flash memory write to occur. Writes to the FMC register without this WRKEY value are ignored. A read of this field returns the value 0.
15:4	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be

preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
3	COMT	R/W	0	Commit Register Value
				This bit is used to commit writes to Flash-memory-resident registers and to monitor the progress of that process.
				Value Description
				Set this bit to commit (write) the register value to a Flash-memory-resident register.
				When read, a 1 indicates that the previous commit access is not complete.
				0 A write of 0 has no effect on the state of this bit.
				When read, a 0 indicates that the previous commit access is complete.
				See "Non-Volatile Register Programming" on page 300 for more information on programming Flash-memory-resident registers.
2	MERASE	R/W	0	Mass Erase Flash Memory
				This bit is used to mass erase the Flash main memory and to monitor the progress of that process.
				Value Description
				1 Set this bit to erase the Flash main memory.
				When read, a 1 indicates that the previous mass erase access is not complete.
				0 A write of 0 has no effect on the state of this bit.
				When read, a 0 indicates that the previous mass erase access is complete.
				For information on erase time, see "Flash Memory" on page 807.
1	ERASE	R/W	0	Erase a Page of Flash Memory
				This bit is used to erase a page of Flash memory and to monitor the progress of that process.
				Value Description
				Set this bit to erase the Flash memory page specified by the contents of the FMA register.
				When read, a 1 indicates that the previous page erase access is not complete.
				0 A write of 0 has no effect on the state of this bit.
				When read, a 0 indicates that the previous page erase access is complete.
				For information on erase time, see "Flash Memory" on page 807.

Bit/Field	Name	Type	Reset	Description
0	WRITE	R/W	0	Write a Word into Flash Memory
				This bit is used to write a word into Flash memory and to monitor the progress of that process.
				Value Description
				Set this bit to write the data stored in the FMD register into the Flash memory location specified by the contents of the FMA register.
				When read, a 1 indicates that the write update access is not complete.
				0 A write of 0 has no effect on the state of this bit.
				When read, a 0 indicates that the previous write update access is complete.
				For information on programming time, see "Flash Memory" on page 807

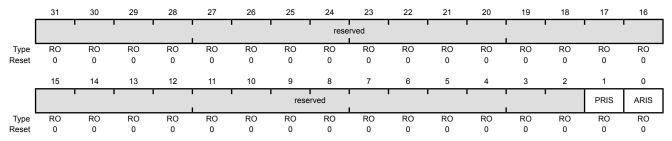
Register 4: Flash Controller Raw Interrupt Status (FCRIS), offset 0x00C

This register indicates that the Flash memory controller has an interrupt condition. An interrupt is sent to the interrupt controller only if the corresponding **FCIM** register bit is set.

Flash Controller Raw Interrupt Status (FCRIS)

Base 0x400F.D000

Offset 0x00C Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:2	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	PRIS	RO	0	Programming Raw Interrupt Status This bit provides status on programming cycles which are write or erase actions generated through the FMC or FMC2 register bits (see page 306 and page 312).

Value Description

- 1 The programming or erase cycle has completed.
- 0 The programming or erase cycle has not completed.

This status is sent to the interrupt controller when the PMASK bit in the FCIM register is set.

This bit is cleared by writing a 1 to the PMISC bit in the FCMISC register.

0 **ARIS** RO Access Raw Interrupt Status 0

Value Description

- A program or erase action was attempted on a block of Flash memory that contradicts the protection policy for that block as set in the FMPPEn registers.
- 0 No access has tried to improperly program or erase the Flash

This status is sent to the interrupt controller when the AMASK bit in the FCIM register is set.

This bit is cleared by writing a 1 to the AMISC bit in the FCMISC register.

Register 5: Flash Controller Interrupt Mask (FCIM), offset 0x010

This register controls whether the Flash memory controller generates interrupts to the controller.

Flash Controller Interrupt Mask (FCIM)

Base 0x400F.D000 Offset 0x010

D:4/E: -1-4

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:2	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	PMASK	R/W	0	Programming Interrupt Mask
				This bit controls the reporting of the programming raw interrupt status to the interrupt controller.
				Value Description
				An interrupt is sent to the interrupt controller when the PRIS bit is set.
				O The PRIS interrupt is suppressed and not sent to the interrupt controller.
0	AMASK	R/W	0	Access Interrupt Mask

Access Interrupt Mask

This bit controls the reporting of the access raw interrupt status to the interrupt controller.

Value Description

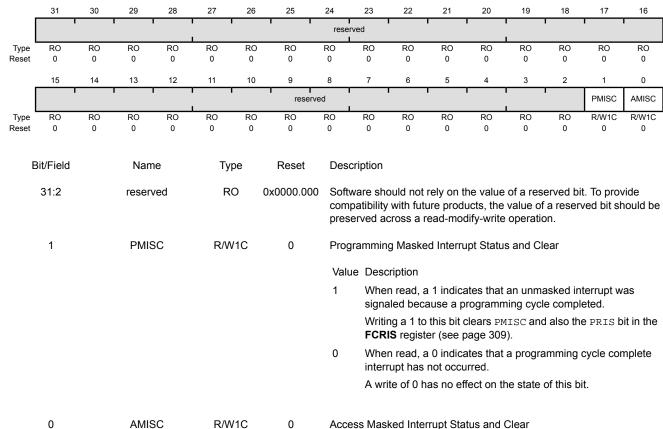
- An interrupt is sent to the interrupt controller when the ARIS bit
- 0 The ARIS interrupt is suppressed and not sent to the interrupt controller.

Register 6: Flash Controller Masked Interrupt Status and Clear (FCMISC), offset 0x014

This register provides two functions. First, it reports the cause of an interrupt by indicating which interrupt source or sources are signalling the interrupt. Second, it serves as the method to clear the interrupt reporting.

Flash Controller Masked Interrupt Status and Clear (FCMISC)

Base 0x400F.D000 Offset 0x014
Type R/W1C, reset 0x0000.0000



Value Description

When read, a 1 indicates that an unmasked interrupt was signaled because a program or erase action was attempted on a block of Flash memory that contradicts the protection policy for that block as set in the FMPPEn registers.

Writing a 1 to this bit clears AMISC and also the ARIS bit in the FCRIS register (see page 309).

0 When read, a 0 indicates that no improper accesses have occurred.

A write of 0 has no effect on the state of this bit.

Register 7: Flash Memory Control 2 (FMC2), offset 0x020

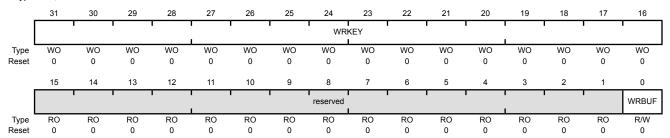
When this register is written, the Flash memory controller initiates the appropriate access cycle for the location specified by the **Flash Memory Address (FMA)** register (see page 304). If the access is a write access, the data contained in the **Flash Write Buffer (FWB)** registers is written.

This register must be the final register written as it initiates the memory operation.

Flash Memory Control 2 (FMC2)

Base 0x400F.D000 Offset 0x020

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:16	WRKEY	WO	0x0000	Flash Memory Write Key
				This field contains a write key, which is used to minimize the incidence of accidental Flash memory writes. The value 0xA442 must be written into this field for a write to occur. Writes to the FMC2 register without this WRKEY value are ignored. A read of this field returns the value 0.
15:1	reserved	RO	0x000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	WRBUF	R/W	0	Buffered Flash Memory Write

Value Description

Set this bit to write the data stored in the FWBn registers to the location specified by the contents of the FMA register.
 When read, a 1 indicates that the previous buffered Flash memory write access is not complete.

This bit is used to start a buffered write to Flash memory.

O A write of 0 has no effect on the state of this bit.
When read, a 0 indicates that the previous buffered Flash memory write access is complete.

For information on programming time, see "Flash Memory" on page 807.

Register 8: Flash Write Buffer Valid (FWBVAL), offset 0x030

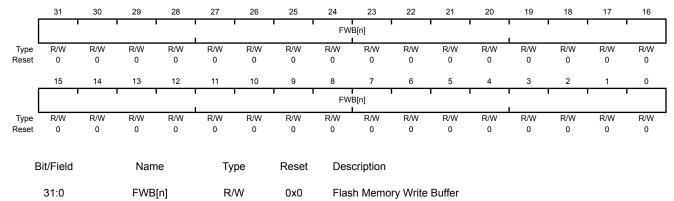
This register provides a bitwise status of which **FWBn** registers have been written by the processor since the last write of the Flash memory write buffer. The entries with a 1 are written on the next write of the Flash memory write buffer. This register is cleared after the write operation by hardware. A protection violation on the write operation also clears this status.

Software can program the same 32 words to various Flash memory locations by setting the FWB[n] bits after they are cleared by the write operation. The next write operation then uses the same data as the previous one. In addition, if a **FWBn** register change should not be written to Flash memory, software can clear the corresponding FWB[n] bit to preserve the existing data when the next write operation occurs.

Flash Write Buffer Valid (FWBVAL)

Base 0x400F.D000 Offset 0x030

Type R/W, reset 0x0000.0000



Value Description

- The corresponding FWBn register has been updated since the last buffer write operation and is ready to be written to Flash memory.
- The corresponding **FWBn** register has no new data to be written.

Bit 0 corresponds to **FWB0**, offset 0x100, and bit 31 corresponds to **FWB31**, offset 0x13C.

Register 9: Flash Control (FCTL), offset 0x0F8

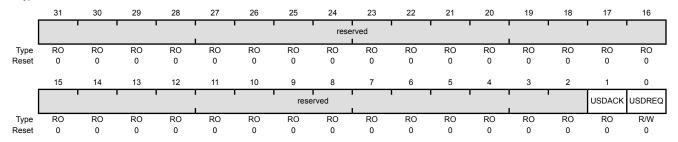
This register is used to ensure that the microcontroller is powered down in a controlled fashion in systems where power is cycled more frequently than once every five minutes. The USDREQ bit should be set to indicate that power is going to be turned off. Software should poll the USDACK bit to determine when it is acceptable to power down.

Note that this power-down process is not required if the microcontroller enters Hibernate mode prior to power being removed.

Flash Control (FCTL)

Base 0x400F.D000

Offset 0x0F8
Type R/W, reset 0x0000.0000



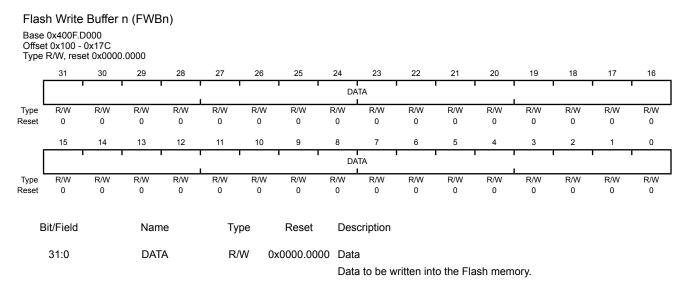
Bit/Field	Name	Type	Reset	Description
31:2	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	USDACK	RO	0	User Shut Down Acknowledge
				Value Description
				1 The microcontroller can be powered down.
				The microcontroller cannot yet be powered down.
				This bit should be set within 50 ms of setting the ${\tt USDREQ}$ bit.
0	USDREQ	R/W	0	User Shut Down Request
				Value Description

Value Description

- Requests permission to power down the microcontroller. 1
- 0 No effect.

Register 10: Flash Write Buffer n (FWBn), offset 0x100 - 0x17C

These 32 registers hold the contents of the data to be written into the Flash memory on a buffered Flash memory write operation. The offset selects one of the 32-bit registers. Only **FWBn** registers that have been updated since the preceding buffered Flash memory write operation are written into the Flash memory, so it is not necessary to write the entire bank of registers in order to write 1 or 2 words. The **FWBn** registers are written into the Flash memory with the **FWB0** register corresponding to the address contained in **FMA**. **FWB1** is written to the address **FMA**+0x4 etc. Note that only data bits that are 0 result in the Flash memory being modified. A data bit that is 1 leaves the content of the Flash memory bit at its previous value.



7.5 Memory Register Descriptions (System Control Offset)

The remainder of this section lists and describes the registers that reside in the System Control address space, in numerical order by address offset. Registers in this section are relative to the System Control base address of 0x400F.E000.

Register 11: ROM Control (RMCTL), offset 0x0F0

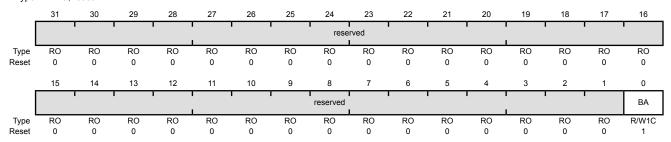
This register provides control of the ROM controller state. This register offset is relative to the System Control base address of 0x400F.E000.

At reset, the ROM is mapped over the Flash memory so that the ROM boot sequence is always executed. The boot sequence executed from ROM is as follows:

- 1. The BA bit (below) is cleared such that ROM is mapped to 0x01xx.xxxx and Flash memory is mapped to address 0x0.
- 2. The **BOOTCFG** register is read. If the EN bit is clear, the status of the specified GPIO pin is compared with the specified polarity. If the status matches the specified polarity, the ROM is mapped to address 0x0000.0000 and execution continues out of the ROM Boot Loader.
- 3. If the status doesn't match the specified polarity, the data at address 0x0000.0004 is read, and if the data at this address is 0xFFFF.FFFF, the ROM is mapped to address 0x0000.0000 and execution continues out of the ROM Boot Loader.
- **4.** If there is data at address 0x0000.0004 that is not 0xFFF.FFFF, the stack pointer (**SP**) is loaded from Flash memory at address 0x0000.0000 and the program counter (**PC**) is loaded from address 0x0000.0004. The user application begins executing.

ROM Control (RMCTL)

Base 0x400F.E000 Offset 0x0F0 Type R/W1C, reset -



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	ВА	R/W1C	1	Boot Alias

Value Description

- 1 The microcontroller's ROM appears at address 0x0.
- 0 The Flash memory is at address 0x0.

This bit is cleared by writing a 1 to this bit position.

Register 12: Flash Memory Protection Read Enable 0 (FMPRE0), offset 0x130 and 0x200

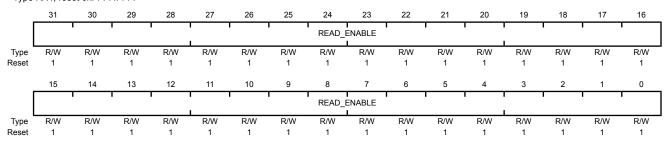
Note: This register is aliased for backwards compatability.

Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the read-only protection bits for each 2-KB flash block (**FMPPEn** stores the execute-only bits). Flash memory up to a total of 64 KB is controlled by this register. Other **FMPREn** registers (if any) provide protection for other 64K blocks. This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168. For additional information, see "Flash Memory Protection" on page 297.

Flash Memory Protection Read Enable 0 (FMPRE0)

Base 0x400F.E000 Offset 0x130 and 0x200 Type R/W, reset 0xFFFF.FFFF



Bit/Field	Name	Type	Reset	Description
31:0	READ ENABLE	R/W	0xFFFFFFF	Flash Read Enable

Configures 2-KB flash blocks to be read or executed only. The policies may be combined as shown in Table 7-1 on page 298.

Value Description

0xFFFFFFF Bits [31:0] each enable protection on a 2-KB block of Flash memory up to the total of 64 KB.

Register 13: Flash Memory Protection Program Enable 0 (FMPPE0), offset 0x134 and 0x400

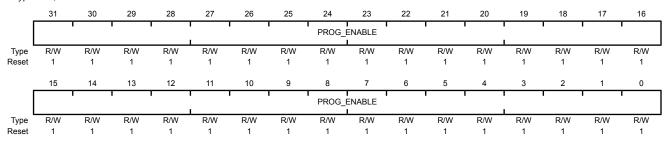
Note: This register is aliased for backwards compatability.

Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the execute-only protection bits for each 2-KB flash block (**FMPREn** stores the execute-only bits). Flash memory up to a total of 64 KB is controlled by this register. Other **FMPPEn** registers (if any) provide protection for other 64K blocks. This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168. For additional information, see "Flash Memory Protection" on page 297.

Flash Memory Protection Program Enable 0 (FMPPE0)

Base 0x400F.E000 Offset 0x134 and 0x400 Type R/W, reset 0xFFF.FFFF



Bit/Field Name Type Reset Description

31:0 PROG_ENABLE R/W 0xFFFFFFF Flash Programming Enable

Configures 2-KB flash blocks to be execute only. The policies may be combined as shown in Table 7-1 on page 298.

Value Description

0xFFFFFFF Bits [31:0] each enable protection on a 2-KB block of Flash memory up to the total of 64 KB.

Register 14: Boot Configuration (BOOTCFG), offset 0x1D0

Note: Offset is relative to System Control base address of 0x400FE000.

This register provides configuration of a GPIO pin to enable the ROM Boot Loader as well as a write-once mechanism to disable external debugger access to the device. Upon reset, the user has the opportunity to direct the core to execute the ROM Boot Loader or the application in Flash memory by using any GPIO signal from Ports A-H as configured by the bits in this register. If the EN bit is set or the specified pin does not have the required polarity, the system control module checks address 0x000.0004 to see if the Flash memory has a valid reset vector. If the data at address 0x0000.0004 is 0xFFFF.FFFF, then it is assumed that the Flash memory has not yet been programmed, and the core executes the ROM Boot Loader. The DBG0 bit (bit 0) is set to 0 from the factory and the DBG1 bit (bit 1) is set to 1, which enables external debuggers. Clearing the DBG1 bit disables any external debugger access to the device permanently, starting with the next power-up cycle of the device. The NW bit (bit 31) indicates that the register has not yet been committed and is controlled through hardware to ensure that the register is only committed once. Prior to being committed, bits can only be changed from 1 to 0. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168.

Boot Configuration (BOOTCFG)

Name

Type

Reset

Base 0x400F.E000 Offset 0x1D0 Type R/W, reset 0xFFFF.FFFE

Bit/Field

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	NW					1			reserved						1	'
Туре	R/W	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		PORT			I PIN I	I	POL	EN	'		rese	rved			DBG1	DBG0
Туре	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	RO	RO	RO	RO	RO	RO	R/W	R/W

31	NW	R/W	1	Not Written
				When set, this bit indicates that this 32-bit register has not been committed. When clear, this bit specifies that this register has been committed and may not be committed again.
30:16	reserved	RO	0x7FFF	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Description

Bit/Field	Name	Туре	Reset	Description
15:13	PORT	R/W	0x7	Boot GPIO Port This field selects the port of the GPIO port pin that enables the ROM boot loader at reset.
				Value Description
				0x0 Port A
				0x1 Port B
				0x2 Port C
				0x3 Port D
				0x4 Port E
				0x5 Port F
				0x6 Port G
				0x7 Port H
12:10	PIN	R/W	0x7	Boot GPIO Pin
				This field selects the pin number of the GPIO port pin that enables the ROM boot loader at reset.
				Value Description
				0x0 Pin 0
				0x1 Pin 1
				0x2 Pin 2
				0x3 Pin 3
				0x4 Pin 4
				0x5 Pin 5
				0x6 Pin 6
				0x7 Pin 7
9	POL	R/W	0x1	Boot GPIO Polarity
				When set, this bit selects a high level for the GPIO port pin to enable
				the ROM boot loader at reset. When clear, this bit selects a low level for the GPIO port pin.
8	EN	R/W	0x1	Boot GPIO Enable
				Clearing this bit enables the use of a GPIO pin to enable the ROM Boot Loader at reset. When this bit is set, the contents of address 0x0000.0004 are checked to see if the Flash memory has been programmed. If the contents are not 0xFFFF.FFFF, the core executes out of Flash memory. If the Flash has not been programmed, the core executes out of ROM.
7:2	reserved	RO	0x3F	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	DBG1	R/W	1	Debug Control 1 The DBG1 bit must be 1 and DBG0 must be 0 for debug to be available.
0	DBG0	R/W	0x0	Debug Control 0 The DBG1 bit must be 1 and DBG0 must be 0 for debug to be available.

Register 15: User Register 0 (USER REG0), offset 0x1E0

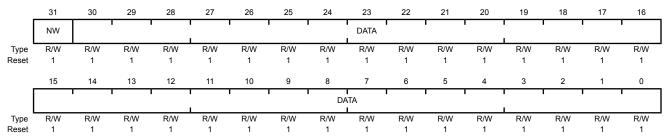
Note: Offset is relative to System Control base address of 0x400FE000.

This register provides 31 bits of user-defined data that is non-volatile and can only be committed once. Bit 31 indicates that the register is available to be committed and is controlled through hardware to ensure that the register is only committed once. Prior to being committed, bits can only be changed from 1 to 0. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. The write-once characteristics of this register are useful for keeping static information like communication addresses that need to be unique per part and would otherwise require an external EEPROM or other non-volatile device. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168.

User Register 0 (USER_ REG0)

Base 0x400F.E000 Offset 0x1E0

Type R/W, reset 0xFFFF.FFFF



Bit/Field	Name	Туре	Reset	Description
31	NW	R/W	1	Not Written
				When set, this bit indicates that this 32-bit register has not been committed. When clear, this bit specifies that this register has been committed and may not be committed again.
30:0	DATA	R/W 0x	7FFFFFF	User Data

Contains the user data value. This field is initialized to all 1s and can only be committed once.

Register 16: User Register 1 (USER_REG1), offset 0x1E4

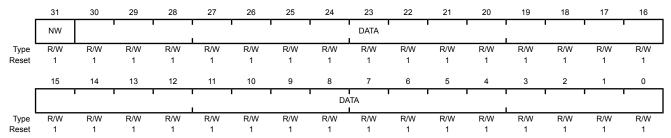
Note: Offset is relative to System Control base address of 0x400FE000.

This register provides 31 bits of user-defined data that is non-volatile and can only be written once. Bit 31 indicates that the register is available to be written and is controlled through hardware to ensure that the register is only written once. The write-once characteristics of this register are useful for keeping static information like communication addresses that need to be unique per part and would otherwise require an external EEPROM or other non-volatile device.

User Register 1 (USER_REG1)

Base 0x400F.E000 Offset 0x1E4

Type R/W, reset 0xFFFF.FFF



Bit/Field	Name	Туре	Reset	Description
31	NW	R/W	1	Not Written
				When set, this bit indicates that this 32-bit register has not been committed. When clear, this bit specifies that this register has been committed and may not be committed again.
30:0	DATA	R/W 0	k7FFFFFF	User Data

Contains the user data value. This field is initialized to all 1s and can only be committed once.

Register 17: User Register 2 (USER REG2), offset 0x1E8

Note: Offset is relative to System Control base address of 0x400FE000.

This register provides 31 bits of user-defined data that is non-volatile and can only be written once. Bit 31 indicates that the register is available to be written and is controlled through hardware to ensure that the register is only written once. The write-once characteristics of this register are useful for keeping static information like communication addresses that need to be unique per part and would otherwise require an external EEPROM or other non-volatile device.

User Register 2 (USER_REG2)

Base 0x400F.E000 Offset 0x1E8

D:4/E: -1-4

Type R/W, reset 0xFFFF.FFF



Bit/Field	Name	туре	Reset	Description
31	NW	R/W	1	Not Written
				When set, this bit indicates that this 32-bit register has not been committed. When clear, this bit specifies that this register has been committed and may not be committed again.
30:0	DATA	R/W 0	x7FFFFFF	User Data

Contains the user data value. This field is initialized to all 1s and can only be committed once.

Register 18: User Register 3 (USER_REG3), offset 0x1EC

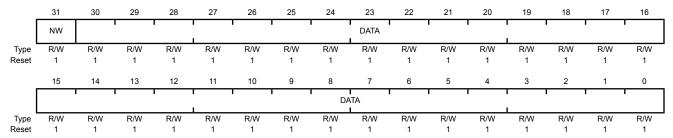
Note: Offset is relative to System Control base address of 0x400FE000.

This register provides 31 bits of user-defined data that is non-volatile and can only be written once. Bit 31 indicates that the register is available to be written and is controlled through hardware to ensure that the register is only written once. The write-once characteristics of this register are useful for keeping static information like communication addresses that need to be unique per part and would otherwise require an external EEPROM or other non-volatile device.

User Register 3 (USER_REG3)

Base 0x400F.E000 Offset 0x1EC

Type R/W, reset 0xFFFF.FFFF



Bit/Field	Name	Туре	Reset	Description
31	NW	R/W	1	Not Written
				When set, this bit indicates that this 32-bit register has not been committed. When clear, this bit specifies that this register has been committed and may not be committed again.
30:0	DATA	R/W 0:	x7FFFFFF	User Data

Contains the user data value. This field is initialized to all 1s and can only be committed once.

Register 19: Flash Memory Protection Read Enable 1 (FMPRE1), offset 0x204

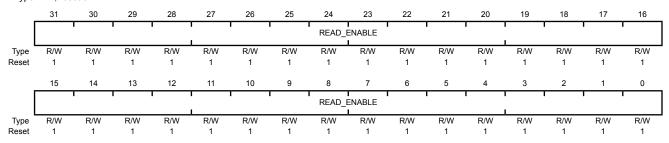
Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the read-only protection bits for each 2-KB flash block (**FMPPEn** stores the execute-only bits). Flash memory up to a total of 64 KB is controlled by this register. Other **FMPREn** registers (if any) provide protection for other 64K blocks. This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168. If the Flash memory size on the device is less than 64 KB, this register usually reads as zeroes, but software should not rely on these bits to be zero. For additional information, see "Flash Memory Protection" on page 297.

Flash Memory Protection Read Enable 1 (FMPRE1)

Base 0x400F.E000 Offset 0x204

Type R/W, reset 0xFFFF.FFFF



Bit/Field Name Type Reset Description

31:0 READ ENABLE R/W 0xFFFFFFF Flash Read Enable

Configures 2-KB flash blocks to be read or executed only. The policies may be combined as shown in Table 7-1 on page 298.

Value Description

0xFFFFFFF Bits [31:0] each enable protection on a 2-KB block of Flash memory in memory range from 65 to 128 KB.

Register 20: Flash Memory Protection Read Enable 2 (FMPRE2), offset 0x208

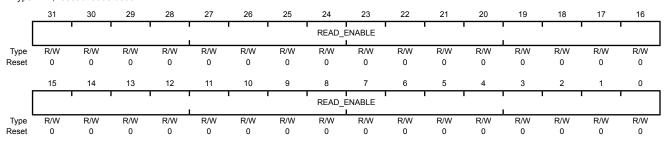
Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the read-only protection bits for each 2-KB flash block (**FMPPEn** stores the execute-only bits). Flash memory up to a total of 64 KB is controlled by this register. Other **FMPREn** registers (if any) provide protection for other 64K blocks. This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168. If the Flash memory size on the device is less than 128 KB, this register usually reads as zeroes, but software should not rely on these bits to be zero. For additional information, see "Flash Memory Protection" on page 297.

Flash Memory Protection Read Enable 2 (FMPRE2)

Base 0x400F.E000 Offset 0x208

Type R/W, reset 0x0000.0000



Bit/Field Name Type Reset Description

31:0 READ ENABLE R/W 0x00000000 Flash Read Enable

Configures 2-KB flash blocks to be read or executed only. The policies may be combined as shown in Table 7-1 on page 298.

Value Description

0x00000000 Bits [31:0] each enable protection on a 2-KB block of Flash memory in the range from 129 to 192 KB.

Register 21: Flash Memory Protection Read Enable 3 (FMPRE3), offset 0x20C

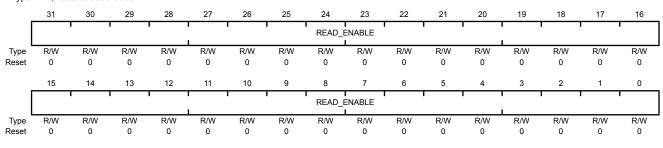
Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the read-only protection bits for each 2-KB flash block (**FMPPEn** stores the execute-only bits). Flash memory up to a total of 64 KB is controlled by this register. Other **FMPREn** registers (if any) provide protection for other 64K blocks. This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168. If the Flash memory size on the device is less than 192 KB, this register usually reads as zeroes, but software should not rely on these bits to be zero. For additional information, see "Flash Memory Protection" on page 297.

Flash Memory Protection Read Enable 3 (FMPRE3)

Base 0x400F.E000 Offset 0x20C

Type R/W, reset 0x0000.0000



Bit/Field Name Type Reset Description

31:0 READ ENABLE R/W 0x00000000 Flash Read Enable

Configures 2-KB flash blocks to be read or executed only. The policies may be combined as shown in Table 7-1 on page 298.

Value Description

0x00000000 Bits [31:0] each enable protection on a 2-KB block of Flash memory in the range from 193 to 256 KB.

Register 22: Flash Memory Protection Program Enable 1 (FMPPE1), offset 0x404

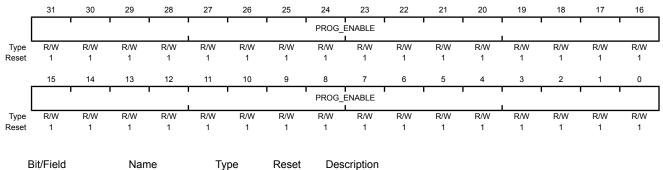
Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the execute-only protection bits for each 2-KB flash block (**FMPREn** stores the execute-only bits). Flash memory up to a total of 64 KB is controlled by this register. Other **FMPPEn** registers (if any) provide protection for other 64K blocks. This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168. If the Flash memory size on the device is less than 64 KB, this register usually reads as zeroes, but software should not rely on these bits to be zero. For additional information, see "Flash Memory Protection" on page 297.

Flash Memory Protection Program Enable 1 (FMPPE1)

Base 0x400F.E000 Offset 0x404

Type R/W, reset 0xFFFF.FFFF



Bit/Field Name Type Reset Description

31:0 PROG_ENABLE R/W 0xFFFFFFF Flash Programming Enable

Configures 2-KB flash blocks to be execute only. The policies may be combined as shown in Table 7-1 on page 298.

Value Description

0xFFFFFFF Bits [31:0] each enable protection on a 2-KB block of Flash memory in memory range from 65 to 128 KB.

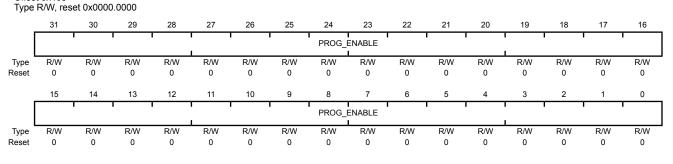
Register 23: Flash Memory Protection Program Enable 2 (FMPPE2), offset 0x408

Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the execute-only protection bits for each 2-KB flash block (**FMPREn** stores the execute-only bits). Flash memory up to a total of 64 KB is controlled by this register. Other **FMPPEn** registers (if any) provide protection for other 64K blocks. This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168. If the Flash memory size on the device is less than 128 KB, this register usually reads as zeroes, but software should not rely on these bits to be zero. For additional information, see "Flash Memory Protection" on page 297.

Flash Memory Protection Program Enable 2 (FMPPE2)

Base 0x400F.E000 Offset 0x408



Bit/Field Name Type Reset Description

31:0 PROG_ENABLE R/W 0x00000000 Flash Programming Enable

Configures 2-KB flash blocks to be execute only. The policies may be combined as shown in Table 7-1 on page 298.

Value Description

0x00000000 Bits [31:0] each enable protection on a 2-KB block of Flash memory in the range from 129 to 192 KB.

Register 24: Flash Memory Protection Program Enable 3 (FMPPE3), offset 0x40C

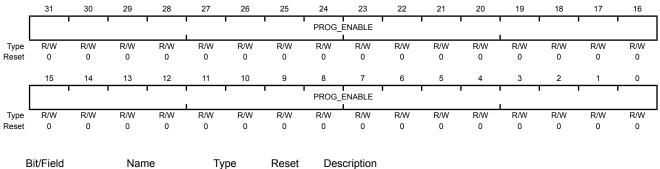
Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the execute-only protection bits for each 2-KB flash block (**FMPREn** stores the execute-only bits). Flash memory up to a total of 64 KB is controlled by this register. Other **FMPPEn** registers (if any) provide protection for other 64K blocks. This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. The reset value shown only applies to power-on reset; any other type of reset does not affect this register. Once committed, the only way to restore the factory default value of this register is to perform the sequence detailed in "Recovering a "Locked" Microcontroller" on page 168. If the Flash memory size on the device is less than 192 KB, this register usually reads as zeroes, but software should not rely on these bits to be zero. For additional information, see "Flash Memory Protection" on page 297.

Flash Memory Protection Program Enable 3 (FMPPE3)

Base 0x400F.E000 Offset 0x40C

Type R/W, reset 0x0000.0000



31:0 PROG_ENABLE R/W 0x00000000 Flash Programming Enable

Configures 2-KB flash blocks to be execute only. The policies may be combined as shown in Table 7-1 on page 298.

Value Description

0x00000000 Bits [31:0] each enable protection on a 2-KB block of Flash memory in the range from 193 to 256 KB.

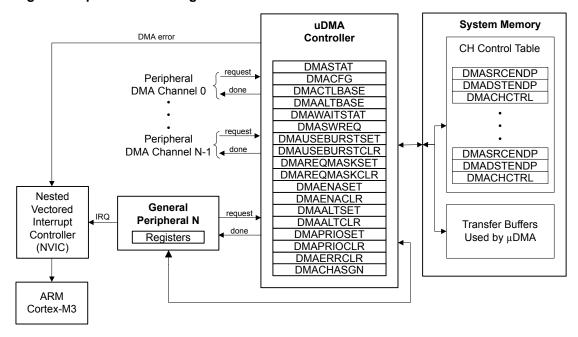
8 Micro Direct Memory Access (µDMA)

The LM3S1J11 microcontroller includes a Direct Memory Access (DMA) controller, known as micro-DMA (μ DMA). The μ DMA controller provides a way to offload data transfer tasks from the Cortex TM-M3 processor, allowing for more efficient use of the processor and the available bus bandwidth. The μ DMA controller can perform transfers between memory and peripherals. It has dedicated channels for each supported on-chip module and can be programmed to automatically perform transfers between peripherals and memory as the peripheral is ready to transfer more data. The μ DMA controller provides the following features:

- ARM® PrimeCell® 32-channel configurable µDMA controller
- Support for memory-to-memory, memory-to-peripheral, and peripheral-to-memory in multiple transfer modes
 - Basic for simple transfer scenarios
 - Ping-pong for continuous data flow
 - Scatter-gather for a programmable list of arbitrary transfers initiated from a single request
- Highly flexible and configurable channel operation
 - Independently configured and operated channels
 - Dedicated channels for supported on-chip modules
 - Primary and secondary channel assignments
 - One channel each for receive and transmit path for bidirectional modules
 - Dedicated channel for software-initiated transfers
 - Per-channel configurable priority scheme
 - Optional software-initiated requests for any channel
- Two levels of priority
- Design optimizations for improved bus access performance between µDMA controller and the processor core
 - µDMA controller access is subordinate to core access
 - RAM striping
 - Peripheral bus segmentation
- Data sizes of 8, 16, and 32 bits
- Transfer size is programmable in binary steps from 1 to 1024
- Source and destination address increment size of byte, half-word, word, or no increment
- Maskable peripheral requests

8.1 Block Diagram

Figure 8-1. µDMA Block Diagram



8.2 Functional Description

The μ DMA controller is a flexible and highly configurable DMA controller designed to work efficiently with the microcontroller's Cortex-M3 processor core. It supports multiple data sizes and address increment schemes, multiple levels of priority among DMA channels, and several transfer modes to allow for sophisticated programmed data transfers. The μ DMA controller's usage of the bus is always subordinate to the processor core, so it never holds up a bus transaction by the processor. Because the μ DMA controller is only using otherwise-idle bus cycles, the data transfer bandwidth it provides is essentially free, with no impact on the rest of the system. The bus architecture has been optimized to greatly enhance the ability of the processor core and the μ DMA controller to efficiently share the on-chip bus, thus improving performance. The optimizations include RAM striping and peripheral bus segmentation, which in many cases allow both the processor core and the μ DMA controller to access the bus and perform simultaneous data transfers.

The μ DMA controller can transfer data to and from the on-chip SRAM. However, because the Flash memory and ROM are located on a separate internal bus, it is not possible to transfer data from the Flash memory or ROM with the μ DMA controller.

Each peripheral function that is supported has a dedicated channel on the μ DMA controller that can be configured independently. The μ DMA controller implements a unique configuration method using channel control structures that are maintained in system memory by the processor. While simple transfer modes are supported, it is also possible to build up sophisticated "task" lists in memory that allow the μ DMA controller to perform arbitrary-sized transfers to and from arbitrary locations as part of a single transfer request. The μ DMA controller also supports the use of ping-pong buffering to accommodate constant streaming of data to or from a peripheral.

Each channel also has a configurable arbitration size. The arbitration size is the number of items that are transferred in a burst before the µDMA controller rearbitrates for channel priority. Using the

arbitration size, it is possible to control exactly how many items are transferred to or from a peripheral each time it makes a µDMA service request.

8.2.1 Channel Assignments

μDMA channels 0-31 are assigned to peripherals according to the following table. The **DMA Channel Assignment (DMACHASGN)** register (see page 379) can be used to specify the primary or secondary assignment. If the primary function is not available on this microcontroller, the secondary function becomes the primary function. If the secondary function is not available, the primary function is the only option.

Note: Channels noted in the table as "Available for software" may be assigned to peripherals in the future. However, they are currently available for software use. Channel 30 is dedicated for software use.

Because of the way the μ DMA controller interacts with peripherals, the μ DMA channel for the peripheral must be enabled in order for the μ DMA controller to be able to read and write the peripheral registers, even if a different μ DMA channel is used to perform the μ DMA transfer. To minimize confusion and chance of software errors, it is best practice to use a peripheral's μ DMA channel for performing all μ DMA transfers for that peripheral, even if it is processor-triggered and using AUTO mode, which could be considered a software transfer. Note that if the software channel is used, interrupts occur on the dedicated μ DMA interrupt vector. If the peripheral channel is used, then the interrupt occurs on the interrupt vector for the peripheral.

Table 8-1. µDMA Channel Assignments

μDMA Channel	Primary Assignment	Secondary Assignment
0	Available for software	UART2 Receive
1	Available for software	UART2 Transmit
2	Available for software	Available for software
3	Available for software	Available for software
4	Available for software	General-Purpose Timer 2A
5	Available for software	General-Purpose Timer 2B
6	Available for software	General-Purpose Timer 2A
7	Available for software	General-Purpose Timer 2B
8	UART0 Receive	UART1 Receive
9	UART0 Transmit	UART1 Transmit
10	SSI0 Receive	SSI1 Receive
11	SSI0 Transmit	SSI1 Transmit
12	Available for software	UART2 Receive
13	Available for software	UART2 Transmit
14	ADC0 Sample Sequencer 0	General-Purpose Timer 2A
15	ADC0 Sample Sequencer 1	General-Purpose Timer 2B
16	ADC0 Sample Sequencer 2	Available for software
17	ADC0 Sample Sequencer 3	Available for software
18	General-Purpose Timer 0A	General-Purpose Timer 1A
19	General-Purpose Timer 0B	General-Purpose Timer 1B
20	General-Purpose Timer 1A	Available for software
21	General-Purpose Timer 1B	Available for software

Table 8-1. µDMA Channel Assignments (continued)

μDMA Channel	Primary Assignment	Secondary Assignment
22	UART1 Receive	Available for software
23	UART1 Transmit	Available for software
24	SSI1 Receive	Available for software
25	SSI1 Transmit	Available for software
26	Available for software	Available for software
27	Available for software	Available for software
28	Available for software	Available for software
29	Available for software	Available for software
30	Dedicated for software use	
31	Reserved	

8.2.2 Priority

The µDMA controller assigns priority to each channel based on the channel number and the priority level bit for the channel. Channel number 0 has the highest priority and as the channel number increases, the priority of a channel decreases. Each channel has a priority level bit to provide two levels of priority: default priority and high priority. If the priority level bit is set, then that channel has higher priority than all other channels at default priority. If multiple channels are set for high priority, then the channel number is used to determine relative priority among all the high priority channels.

The priority bit for a channel can be set using the **DMA Channel Priority Set (DMAPRIOSET)** register and cleared with the **DMA Channel Priority Clear (DMAPRIOCLR)** register.

8.2.3 Arbitration Size

When a μ DMA channel requests a transfer, the μ DMA controller arbitrates among all the channels making a request and services the μ DMA channel with the highest priority. Once a transfer begins, it continues for a selectable number of transfers before rearbitrating among the requesting channels again. The arbitration size can be configured for each channel, ranging from 1 to 1024 item transfers. After the μ DMA controller transfers the number of items specified by the arbitration size, it then checks among all the channels making a request and services the channel with the highest priority.

If a lower priority μ DMA channel uses a large arbitration size, the latency for higher priority channels is increased because the μ DMA controller completes the lower priority burst before checking for higher priority requests. Therefore, lower priority channels should not use a large arbitration size for best response on high priority channels.

The arbitration size can also be thought of as a burst size. It is the maximum number of items that are transferred at any one time in a burst. Here, the term arbitration refers to determination of μDMA channel priority, not arbitration for the bus. When the μDMA controller arbitrates for the bus, the processor always takes priority. Furthermore, the μDMA controller is held off whenever the processor must perform a bus transaction on the same bus, even in the middle of a burst transfer.

8.2.4 Request Types

The μ DMA controller responds to two types of requests from a peripheral: single or burst. Each peripheral may support either or both types of requests. A single request means that the peripheral is ready to transfer one item, while a burst request means that the peripheral is ready to transfer multiple items.

The μ DMA controller responds differently depending on whether the peripheral is making a single request or a burst request. If both are asserted, and the μ DMA channel has been set up for a burst transfer, then the burst request takes precedence. See Table 8-2 on page 335, which shows how each peripheral supports the two request types.

Table 8-2. Request Type Support

Peripheral	Single Request Signal	Burst Request Signal
ADC	None	Sequencer IE bit
General-Purpose Timer	None	Trigger event
SSI TX	TX FIFO Not Full	TX FIFO Level (fixed at 4)
SSI RX	RX FIFO Not Empty	RX FIFO Level (fixed at 4)
UART TX	TX FIFO Not Full	TX FIFO Level (configurable)
UART RX	RX FIFO Not Empty	RX FIFO Level (configurable)

8.2.4.1 Single Request

When a single request is detected, and not a burst request, the µDMA controller transfers one item and then stops to wait for another request.

8.2.4.2 Burst Request

When a burst request is detected, the μ DMA controller transfers the number of items that is the lesser of the arbitration size or the number of items remaining in the transfer. Therefore, the arbitration size should be the same as the number of data items that the peripheral can accommodate when making a burst request. For example, the UART generates a burst request based on the FIFO trigger level. In this case, the arbitration size should be set to the amount of data that the FIFO can transfer when the trigger level is reached. A burst transfer runs to completion once it is started, and cannot be interrupted, even by a higher priority channel. Burst transfers complete in a shorter time than the same number of non-burst transfers.

It may be desirable to use only burst transfers and not allow single transfers. For example, perhaps the nature of the data is such that it only makes sense when transferred together as a single unit rather than one piece at a time. The single request can be disabled by using the **DMA Channel Useburst Set (DMAUSEBURSTSET)** register. By setting the bit for a channel in this register, the μDMA controller only responds to burst requests for that channel.

8.2.5 Channel Configuration

The μ DMA controller uses an area of system memory to store a set of channel control structures in a table. The control table may have one or two entries for each μ DMA channel. Each entry in the table structure contains source and destination pointers, transfer size, and transfer mode. The control table can be located anywhere in system memory, but it must be contiguous and aligned on a 1024-byte boundary.

Table 8-3 on page 336 shows the layout in memory of the channel control table. Each channel may have one or two control structures in the control table: a primary control structure and an optional alternate control structure. The table is organized so that all of the primary entries are in the first half of the table, and all the alternate structures are in the second half of the table. The primary entry is used for simple transfer modes where transfers can be reconfigured and restarted after each transfer is complete. In this case, the alternate control structures are not used and therefore only the first half of the table must be allocated in memory; the second half of the control table is not necessary, and that memory can be used for something else. If a more complex transfer mode is

used such as ping-pong or scatter-gather, then the alternate control structure is also used and memory space should be allocated for the entire table.

Any unused memory in the control table may be used by the application. This includes the control structures for any channels that are unused by the application as well as the unused control word for each channel.

Table 8-3. Control Structure Memory Map

Offset	Channel	
0x0	0, Primary	
0x10	1, Primary	
0x1F0	31, Primary	
0x200	0, Alternate	
0x210	1, Alternate	
0x3F0	31, Alternate	

Table 8-4 shows an individual control structure entry in the control table. Each entry is aligned on a 16-byte boundary. The entry contains four long words: the source end pointer, the destination end pointer, the control word, and an unused entry. The end pointers point to the ending address of the transfer and are inclusive. If the source or destination is non-incrementing (as for a peripheral register), then the pointer should point to the transfer address.

Table 8-4. Channel Control Structure

Offset	Description
0x000	Source End Pointer
0x004	Destination End Pointer
0x008	Control Word
0x00C	Unused

The control word contains the following fields:

- Source and destination data sizes
- Source and destination address increment size
- Number of transfers before bus arbitration
- Total number of items to transfer
- Useburst flag
- Transfer mode

The control word and each field are described in detail in " μ DMA Channel Control Structure" on page 353. The μ DMA controller updates the transfer size and transfer mode fields as the transfer is performed. At the end of a transfer, the transfer size indicates 0, and the transfer mode indicates "stopped." Because the control word is modified by the μ DMA controller, it must be reconfigured before each new transfer. The source and destination end pointers are not modified, so they can be left unchanged if the source or destination addresses remain the same.

Prior to starting a transfer, a μ DMA channel must be enabled by setting the appropriate bit in the **DMA Channel Enable Set (DMAENASET)** register. A channel can be disabled by setting the channel bit in the **DMA Channel Enable Clear (DMAENACLR)** register. At the end of a complete μ DMA transfer, the controller automatically disables the channel.

8.2.6 Transfer Modes

The µDMA controller supports several transfer modes. Two of the modes support simple one-time transfers. Several complex modes support a continuous flow of data.

8.2.6.1 Stop Mode

While Stop is not actually a transfer mode, it is a valid value for the mode field of the control word. When the mode field has this value, the μDMA controller does not perform any transfers and disables the channel if it is enabled. At the end of a transfer, the μDMA controller updates the control word to set the mode to Stop.

8.2.6.2 **Basic Mode**

In Basic mode, the μ DMA controller performs transfers as long as there are more items to transfer, and a transfer request is present. This mode is used with peripherals that assert a μ DMA request signal whenever the peripheral is ready for a data transfer. Basic mode should not be used in any situation where the request is momentary even though the entire transfer should be completed. For example, a software-initiated transfer creates a momentary request, and in Basic mode, only the number of transfers specified by the ARBSIZE field in the **DMA Channel Control Word (DMACHCTL)** register is transferred on a software request, even if there is more data to transfer.

When all of the items have been transferred using Basic mode, the μDMA controller sets the mode for that channel to Stop.

8.2.6.3 Auto Mode

Auto mode is similar to Basic mode, except that once a transfer request is received, the transfer runs to completion, even if the µDMA request is removed. This mode is suitable for software-triggered transfers. Generally, Auto mode is not used with a peripheral.

When all the items have been transferred using Auto mode, the µDMA controller sets the mode for that channel to Stop.

8.2.6.4 **Ping-Pong**

Ping-Pong mode is used to support a continuous data flow to or from a peripheral. To use Ping-Pong mode, both the primary and alternate data structures must be implemented. Both structures are set up by the processor for data transfer between memory and a peripheral. The transfer is started using the primary control structure. When the transfer using the primary control structure is complete, the µDMA controller reads the alternate control structure for that channel to continue the transfer. Each time this happens, an interrupt is generated, and the processor can reload the control structure for the just-completed transfer. Data flow can continue indefinitely this way, using the primary and alternate control structures to switch back and forth between buffers as the data flows to or from the peripheral.

Refer to Figure 8-2 on page 338 for an example showing operation in Ping-Pong mode.

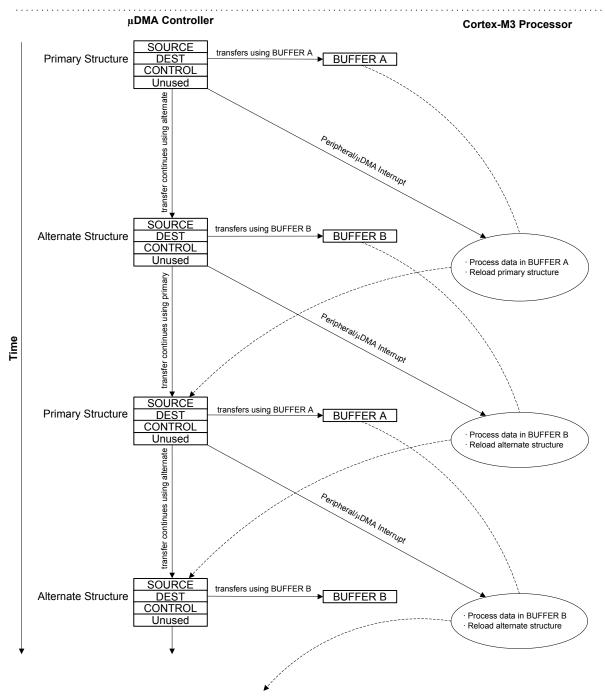


Figure 8-2. Example of Ping-Pong μDMA Transaction

8.2.6.5 Memory Scatter-Gather

Memory Scatter-Gather mode is a complex mode used when data must be transferred to or from varied locations in memory instead of a set of contiguous locations in a memory buffer. For example, a gather μDMA operation could be used to selectively read the payload of several stored packets of a communication protocol and store them together in sequence in a memory buffer.

In Memory Scatter-Gather mode, the primary control structure is used to program the alternate control structure from a table in memory. The table is set up by the processor software and contains a list of control structures, each containing the source and destination end pointers, and the control word for a specific transfer. The mode of each control word must be set to Scatter-Gather mode. Each entry in the table is copied in turn to the alternate structure where it is then executed. The μ DMA controller alternates between using the primary control structure to copy the next transfer instruction from the list and then executing the new transfer instruction. The end of the list is marked by programming the control word for the last entry to use Auto transfer mode. Once the last transfer is performed using Auto mode, the μ DMA controller stops. A completion interrupt is generated only after the last transfer. It is possible to loop the list by having the last entry copy the primary control structure to point back to the beginning of the list (or to a new list). It is also possible to trigger a set of other channels to perform a transfer, either directly, by programming a write to the software trigger for another channel, or indirectly, by causing a peripheral action that results in a μ DMA request.

By programming the μ DMA controller using this method, a set of arbitrary transfers can be performed based on a single μ DMA request.

Refer to Figure 8-3 on page 340 and Figure 8-4 on page 341, which show an example of operation in Memory Scatter-Gather mode. This example shows a *gather* operation, where data in three separate buffers in memory is copied together into one buffer. Figure 8-3 on page 340 shows how the application sets up a μ DMA task list in memory that is used by the controller to perform three sets of copy operations from different locations in memory. The primary control structure for the channel that is used for the operation is configured to copy from the task list to the alternate control structure.

Figure 8-4 on page 341 shows the sequence as the μDMA controller performs the three sets of copy operations. First, using the primary control structure, the μDMA controller loads the alternate control structure with task A. It then performs the copy operation specified by task A, copying the data from the source buffer A to the destination buffer. Next, the μDMA controller again uses the primary control structure to load task B into the alternate control structure, and then performs the B operation with the alternate control structure. The process is repeated for task C.

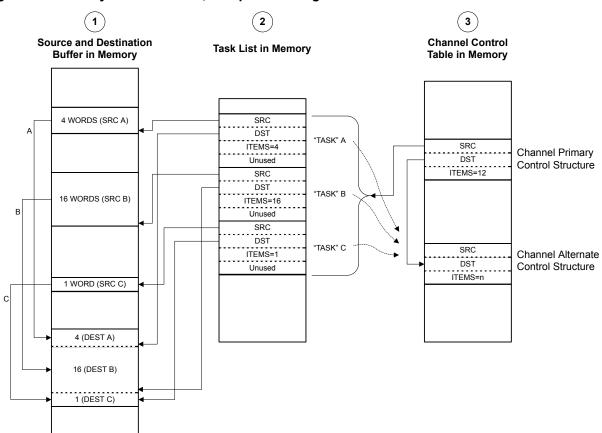
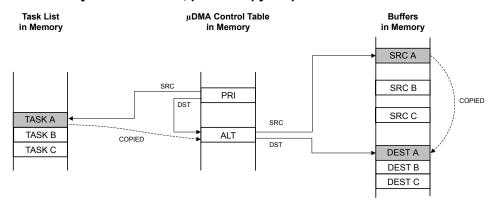


Figure 8-3. Memory Scatter-Gather, Setup and Configuration

NOTES:

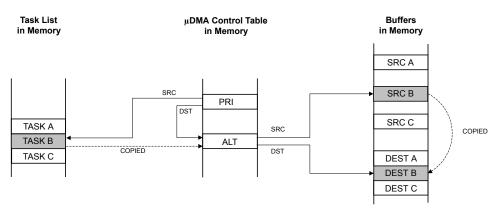
- 1. Application has a need to copy data items from three separate locations in memory into one combined buffer.
- 2. Application sets up μDMA "task list" in memory, which contains the pointers and control configuration for three μDMA copy "tasks."
- 3. Application sets up the channel primary control structure to copy each task configuration, one at a time, to the alternate control structure, where it is executed by the μDMA controller.
- 4. The SRC and DST pointers in the task list must point to the last location in the corresponding buffer.

Figure 8-4. Memory Scatter-Gather, µDMA Copy Sequence



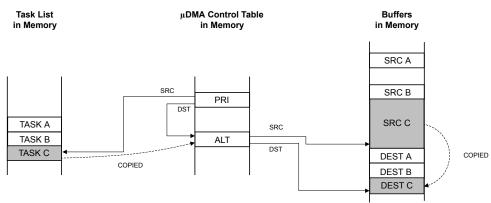
Using the channel's primary control structure, the μDMA controller copies task A configuration to the channel's alternate control structure.

Then, using the channel's alternate control structure, the μDMA controller copies data from the source buffer A to the destination buffer.



Using the channel's primary control structure, the μDMA controller copies task B configuration to the channel's alternate control structure.

Then, using the channel's alternate control structure, the μDMA controller copies data from the source buffer B to the destination buffer.



Using the channel's primary control structure, the μDMA controller copies task C configuration to the channel's alternate control structure.

Then, using the channel's alternate control structure, the μDMA controller copies data from the source buffer C to the destination buffer.

8.2.6.6 Peripheral Scatter-Gather

Peripheral Scatter-Gather mode is very similar to Memory Scatter-Gather, except that the transfers are controlled by a peripheral making a μ DMA request. Upon detecting a request from the peripheral, the μ DMA controller uses the primary control structure to copy one entry from the list to the alternate control structure and then performs the transfer. At the end of this transfer, the next transfer is started only if the peripheral again asserts a μ DMA request. The μ DMA controller continues to perform transfers from the list only when the peripheral is making a request, until the last transfer is complete. A completion interrupt is generated only after the last transfer.

By using this method, the μ DMA controller can transfer data to or from a peripheral from a set of arbitrary locations whenever the peripheral is ready to transfer data.

Refer to Figure 8-5 on page 343 and Figure 8-6 on page 344, which show an example of operation in Peripheral Scatter-Gather mode. This example shows a gather operation, where data from three separate buffers in memory is copied to a single peripheral data register. Figure 8-5 on page 343 shows how the application sets up a μ DMA task list in memory that is used by the controller to perform three sets of copy operations from different locations in memory. The primary control structure for the channel that is used for the operation is configured to copy from the task list to the alternate control structure.

Figure 8-6 on page 344 shows the sequence as the μ DMA controller performs the three sets of copy operations. First, using the primary control structure, the μ DMA controller loads the alternate control structure with task A. It then performs the copy operation specified by task A, copying the data from the source buffer A to the peripheral data register. Next, the μ DMA controller again uses the primary control structure to load task B into the alternate control structure, and then performs the B operation with the alternate control structure. The process is repeated for task C.

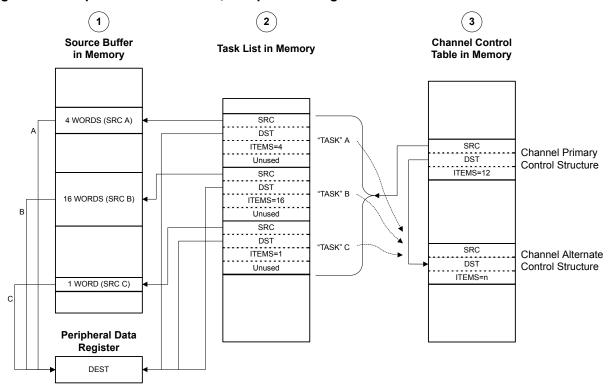
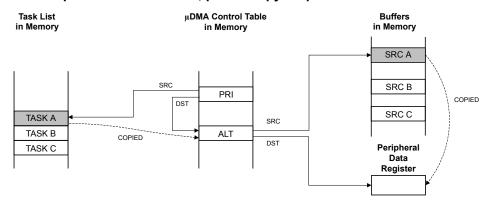


Figure 8-5. Peripheral Scatter-Gather, Setup and Configuration

NOTES:

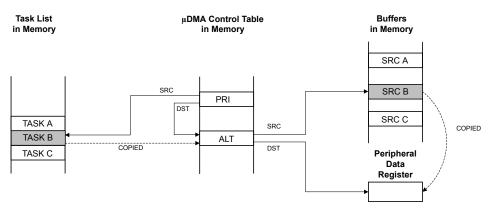
- 1. Application has a need to copy data items from three separate locations in memory into a peripheral data register.
- Application sets up μDMA "task list" in memory, which contains the pointers and control configuration for three μDMA copy "tasks."
- 3. Application sets up the channel primary control structure to copy each task configuration, one at a time, to the alternate control structure, where it is executed by the μDMA controller.

Figure 8-6. Peripheral Scatter-Gather, µDMA Copy Sequence



Using the channel's primary control structure, the μDMA controller copies task A configuration to the channel's alternate control structure.

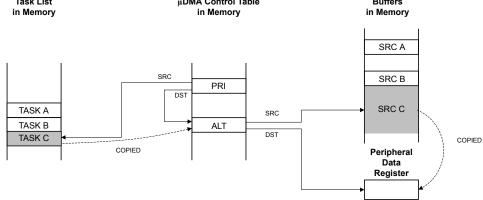
Then, using the channel's alternate control structure, the μDMA controller copies data from the source buffer A to the peripheral data register.



Using the channel's primary control structure, the μDMA controller copies task B configuration to the channel's alternate control structure.

Then, using the channel's alternate control structure, the μDMA controller copies data from the source buffer B to the peripheral data register.

Task List μDMA Control Table Buffers



Using the channel's primary control structure, the μDMA controller copies task C configuration to the channel's alternate control structure.

Then, using the channel's alternate control structure, the μDMA controller copies data from the source buffer C to the peripheral data register.

8.2.7 Transfer Size and Increment

The μDMA controller supports transfer data sizes of 8, 16, or 32 bits. The source and destination data size must be the same for any given transfer. The source and destination address can be auto-incremented by bytes, half-words, or words, or can be set to no increment. The source and destination address increment values can be set independently, and it is not necessary for the address increment to match the data size as long as the increment is the same or larger than the data size. For example, it is possible to perform a transfer using 8-bit data size, but using an address increment of full words (4 bytes). The data to be transferred must be aligned in memory according to the data size (8, 16, or 32 bits).

Table 8-5 shows the configuration to read from a peripheral that supplies 8-bit data.

Table 8-5. µDMA Read Example: 8-Bit Peripheral

Field	Configuration	
Source data size	8 bits	
Destination data size	8 bits	
Source address increment	No increment	
Destination address increment	Byte	
Source end pointer	Peripheral read FIFO register	
Destination end pointer	End of the data buffer in memory	

8.2.8 Peripheral Interface

Each peripheral that supports μ DMA has a single request and/or burst request signal that is asserted when the peripheral is ready to transfer data (see Table 8-2 on page 335). The request signal can be disabled or enabled using the **DMA Channel Request Mask Set (DMAREQMASKSET)** and **DMA Channel Request Mask Clear (DMAREQMASKCLR)** registers. The μ DMA request signal is disabled, or masked, when the channel request mask bit is set. When the request is not masked, the μ DMA channel is configured correctly and enabled, and the peripheral asserts the request signal, the μ DMA controller begins the transfer.

Note: When using μ DMA to transfer data to and from a peripheral, the peripheral must disable all interrupts to the NVIC.

When a μ DMA transfer is complete, the μ DMA controller generates an interrupt, see "Interrupts and Errors" on page 346 for more information.

For more information on how a specific peripheral interacts with the μ DMA controller, refer to the DMA Operation section in the chapter that discusses that peripheral.

8.2.9 Software Request

One μ DMA channel is dedicated to software-initiated transfers. This channel also has a dedicated interrupt to signal completion of a μ DMA transfer. A transfer is initiated by software by first configuring and enabling the transfer, and then issuing a software request using the **DMA Channel Software Request (DMASWREQ)** register. For software-based transfers, the Auto transfer mode should be used.

It is possible to initiate a transfer on any channel using the **DMASWREQ** register. If a request is initiated by software using a peripheral µDMA channel, then the completion interrupt occurs on the interrupt vector for the peripheral instead of the software interrupt vector. Any channel may be used for software requests as long as the corresponding peripheral is not using µDMA for data transfer.

8.2.10 Interrupts and Errors

When a μ DMA transfer is complete, the μ DMA controller generates a completion interrupt on the interrupt vector of the peripheral. Therefore, if μ DMA is used to transfer data for a peripheral and interrupts are used, then the interrupt handler for that peripheral must be designed to handle the μ DMA transfer completion interrupt. If the transfer uses the software μ DMA channel, then the completion interrupt occurs on the dedicated software μ DMA interrupt vector (see Table 8-6 on page 346).

When μDMA is enabled for a peripheral, the μDMA controller stops the normal transfer interrupts for a peripheral from reaching the interrupt controller (the interrupts are still reported in the peripheral's interrupt registers). Thus, when a large amount of data is transferred using μDMA , instead of receiving multiple interrupts from the peripheral as data flows, the interrupt controller receives only one interrupt when the transfer is complete. Unmasked peripheral error interrupts continue to be sent to the interrupt controller.

If the μ DMA controller encounters a bus or memory protection error as it attempts to perform a data transfer, it disables the μ DMA channel that caused the error and generates an interrupt on the μ DMA error interrupt vector. The processor can read the **DMA Bus Error Clear (DMAERRCLR)** register to determine if an error is pending. The ERRCLR bit is set if an error occurred. The error can be cleared by writing a 1 to the ERRCLR bit.

Table 8-6 shows the dedicated interrupt assignments for the µDMA controller.

Table 8-6. µDMA Interrupt Assignments

Interrupt	Assignment	
46	μDMA Software Channel Transfer	
47	μDMA Error	

8.3 Initialization and Configuration

8.3.1 Module Initialization

Before the μ DMA controller can be used, it must be enabled in the System Control block and in the peripheral. The location of the channel control structure must also be programmed.

The following steps should be performed one time during system initialization:

- 1. The μDMA peripheral must be enabled in the System Control block. To do this, set the UDMA bit of the System Control **RCGC2** register (see page 255).
- 2. Enable the μDMA controller by setting the MASTEREN bit of the **DMA Configuration (DMACFG)** register.
- Program the location of the channel control table by writing the base address of the table to the DMA Channel Control Base Pointer (DMACTLBASE) register. The base address must be aligned on a 1024-byte boundary.

8.3.2 Configuring a Memory-to-Memory Transfer

μDMA channel 30 is dedicated for software-initiated transfers. However, any channel can be used for software-initiated, memory-to-memory transfer if the associated peripheral is not being used.

8.3.2.1 Configure the Channel Attributes

First, configure the channel attributes:

- 1. Program bit 30 of the DMA Channel Priority Set (DMAPRIOSET) or DMA Channel Priority Clear (DMAPRIOCLR) registers to set the channel to High priority or Default priority.
- 2. Set bit 30 of the **DMA Channel Primary Alternate Clear (DMAALTCLR)** register to select the primary channel control structure for this transfer.
- 3. Set bit 30 of the **DMA Channel Useburst Clear (DMAUSEBURSTCLR)** register to allow the µDMA controller to respond to single and burst requests.
- **4.** Set bit 30 of the **DMA Channel Request Mask Clear (DMAREQMASKCLR)** register to allow the μDMA controller to recognize requests for this channel.

8.3.2.2 Configure the Channel Control Structure

Now the channel control structure must be configured.

This example transfers 256 words from one memory buffer to another. Channel 30 is used for a software transfer, and the control structure for channel 30 is at offset 0x1E0 of the channel control table. The channel control structure for channel 30 is located at the offsets shown in Table 8-7.

Table 8-7. Channel Control Structure Offsets for Channel 30

Offset	Description	
Control Table Base + 0x1E0	Channel 30 Source End Pointer	
Control Table Base + 0x1E4	Channel 30 Destination End Pointer	
Control Table Base + 0x1E8	Channel 30 Control Word	

Configure the Source and Destination

The source and destination end pointers must be set to the last address for the transfer (inclusive).

- 1. Program the source end pointer at offset 0x1E0 to the address of the source buffer + 0x3FC.
- 2. Program the destination end pointer at offset 0x1E4 to the address of the destination buffer + 0x3FC.

The control word at offset 0x1E8 must be programmed according to Table 8-8.

Table 8-8. Channel Control Word Configuration for Memory Transfer Example

Field in DMACHCTL	Bits	Value	Description
DSTINC	31:30	2	32-bit destination address increment
DSTSIZE	29:28	2	32-bit destination data size
SRCINC	27:26	2	32-bit source address increment
SRCSIZE	25:24	2	32-bit source data size
reserved	23:18	0	Reserved
ARBSIZE	17:14	3	Arbitrates after 8 transfers
XFERSIZE	13:4	255	Transfer 256 items
NXTUSEBURST	3	0	N/A for this transfer type
XFERMODE	2:0	2	Use Auto-request transfer mode

8.3.2.3 Start the Transfer

Now the channel is configured and is ready to start.

- Enable the channel by setting bit 30 of the DMA Channel Enable Set (DMAENASET) register.
- 2. Issue a transfer request by setting bit 30 of the **DMA Channel Software Request (DMASWREQ)** register.

The µDMA transfer begins. If the interrupt is enabled, then the processor is notified by interrupt when the transfer is complete. If needed, the status can be checked by reading bit 30 of the **DMAENASET** register. This bit is automatically cleared when the transfer is complete. The status can also be checked by reading the XFERMODE field of the channel control word at offset 0x1E8. This field is automatically cleared at the end of the transfer.

8.3.3 Configuring a Peripheral for Simple Transmit

This example configures the μ DMA controller to transmit a buffer of data to a peripheral. The peripheral has a transmit FIFO with a trigger level of 4. The example peripheral uses μ DMA channel 7.

8.3.3.1 Configure the Channel Attributes

First, configure the channel attributes:

- 1. Configure bit 7 of the **DMA Channel Priority Set (DMAPRIOSET)** or **DMA Channel Priority Clear (DMAPRIOCLR)** registers to set the channel to High priority or Default priority.
- 2. Set bit 7 of the **DMA Channel Primary Alternate Clear (DMAALTCLR)** register to select the primary channel control structure for this transfer.
- 3. Set bit 7 of the **DMA Channel Useburst Clear (DMAUSEBURSTCLR)** register to allow the µDMA controller to respond to single and burst requests.
- **4.** Set bit 7 of the **DMA Channel Request Mask Clear (DMAREQMASKCLR)** register to allow the μDMA controller to recognize requests for this channel.

8.3.3.2 Configure the Channel Control Structure

This example transfers 64 bytes from a memory buffer to the peripheral's transmit FIFO register using μ DMA channel 7. The control structure for channel 7 is at offset 0x070 of the channel control table. The channel control structure for channel 7 is located at the offsets shown in Table 8-9.

Table 8-9. Channel Control Structure Offsets for Channel 7

Offset	Description	
Control Table Base + 0x070	Channel 7 Source End Pointer	
Control Table Base + 0x074	Channel 7 Destination End Pointer	
Control Table Base + 0x078	Channel 7 Control Word	

Configure the Source and Destination

The source and destination end pointers must be set to the last address for the transfer (inclusive). Because the peripheral pointer does not change, it simply points to the peripheral's data register.

Program the source end pointer at offset 0x070 to the address of the source buffer + 0x3F.

2. Program the destination end pointer at offset 0x074 to the address of the peripheral's transmit FIFO register.

The control word at offset 0x078 must be programmed according to Table 8-10.

Table 8-10. Channel Control Word Configuration for Peripheral Transmit Example

Field in DMACHCTL	Bits	Value	Description
DSTINC	31:30	3	Destination address does not increment
DSTSIZE	29:28	0	8-bit destination data size
SRCINC	27:26	0	8-bit source address increment
SRCSIZE	25:24	0	8-bit source data size
reserved	23:18	0	Reserved
ARBSIZE	17:14	2	Arbitrates after 4 transfers
XFERSIZE	13:4	63	Transfer 64 items
NXTUSEBURST	3	0	N/A for this transfer type
XFERMODE	2:0	1	Use Basic transfer mode

Note: In this example, it is not important if the peripheral makes a single request or a burst request. Because the peripheral has a FIFO that triggers at a level of 4, the arbitration size is set to 4. If the peripheral does make a burst request, then 4 bytes are transferred, which is what the FIFO can accommodate. If the peripheral makes a single request (if there is any space in the FIFO), then one byte is transferred at a time. If it is important to the application that transfers only be made in bursts, then the Channel Useburst SET[7] bit should be set in the DMA Channel Useburst Set (DMAUSEBURSTSET) register.

8.3.3.3 Start the Transfer

Now the channel is configured and is ready to start.

1. Enable the channel by setting bit 7 of the DMA Channel Enable Set (DMAENASET) register.

The μ DMA controller is now configured for transfer on channel 7. The controller makes transfers to the peripheral whenever the peripheral asserts a μ DMA request. The transfers continue until the entire buffer of 64 bytes has been transferred. When that happens, the μ DMA controller disables the channel and sets the XFERMODE field of the channel control word to 0 (Stopped). The status of the transfer can be checked by reading bit 7 of the **DMA Channel Enable Set (DMAENASET)** register. This bit is automatically cleared when the transfer is complete. The status can also be checked by reading the XFERMODE field of the channel control word at offset 0x078. This field is automatically cleared at the end of the transfer.

If peripheral interrupts are enabled, then the peripheral interrupt handler receives an interrupt when the entire transfer is complete.

8.3.4 Configuring a Peripheral for Ping-Pong Receive

This example configures the μ DMA controller to continuously receive 8-bit data from a peripheral into a pair of 64-byte buffers. The peripheral has a receive FIFO with a trigger level of 8. The example peripheral uses μ DMA channel 8.

8.3.4.1 Configure the Channel Attributes

First, configure the channel attributes:

- 1. Configure bit 8 of the **DMA Channel Priority Set (DMAPRIOSET)** or **DMA Channel Priority Clear (DMAPRIOCLR)** registers to set the channel to High priority or Default priority.
- 2. Set bit 8 of the **DMA Channel Primary Alternate Clear (DMAALTCLR)** register to select the primary channel control structure for this transfer.
- 3. Set bit 8 of the **DMA Channel Useburst Clear (DMAUSEBURSTCLR)** register to allow the µDMA controller to respond to single and burst requests.
- **4.** Set bit 8 of the **DMA Channel Request Mask Clear (DMAREQMASKCLR)** register to allow the μDMA controller to recognize requests for this channel.

8.3.4.2 Configure the Channel Control Structure

This example transfers bytes from the peripheral's receive FIFO register into two memory buffers of 64 bytes each. As data is received, when one buffer is full, the μ DMA controller switches to use the other.

To use Ping-Pong buffering, both primary and alternate channel control structures must be used. The primary control structure for channel 8 is at offset 0x080 of the channel control table, and the alternate channel control structure is at offset 0x280. The channel control structures for channel 8 are located at the offsets shown in Table 8-11.

Table 8-11. Primary and Alternate Channel Control Structure Offsets for Channel 8

Offset	Description	
Control Table Base + 0x080	Channel 8 Primary Source End Pointer	
Control Table Base + 0x084	Channel 8 Primary Destination End Pointer	
Control Table Base + 0x088	Channel 8 Primary Control Word	
Control Table Base + 0x280	Channel 8 Alternate Source End Pointer	
Control Table Base + 0x284	Channel 8 Alternate Destination End Pointer	
Control Table Base + 0x288	Channel 8 Alternate Control Word	

Configure the Source and Destination

The source and destination end pointers must be set to the last address for the transfer (inclusive). Because the peripheral pointer does not change, it simply points to the peripheral's data register. Both the primary and alternate sets of pointers must be configured.

- **1.** Program the primary source end pointer at offset 0x080 to the address of the peripheral's receive buffer.
- 2. Program the primary destination end pointer at offset 0x084 to the address of ping-pong buffer A + 0x3F.
- **3.** Program the alternate source end pointer at offset 0x280 to the address of the peripheral's receive buffer.
- **4.** Program the alternate destination end pointer at offset 0x284 to the address of ping-pong buffer B + 0x3F.

The primary control word at offset 0x088 and the alternate control word at offset 0x288 are initially programmed the same way.

1. Program the primary channel control word at offset 0x088 according to Table 8-12.

2. Program the alternate channel control word at offset 0x288 according to Table 8-12.

Table 8-12. Channel Control Word Configuration for Peripheral Ping-Pong Receive Example

Field in DMACHCTL	Bits	Value	Description
DSTINC	31:30	0	8-bit destination address increment
DSTSIZE	29:28	0	8-bit destination data size
SRCINC	27:26	3	Source address does not increment
SRCSIZE	25:24	0	8-bit source data size
reserved	23:18	0	Reserved
ARBSIZE	17:14	3	Arbitrates after 8 transfers
XFERSIZE	13:4	63	Transfer 64 items
NXTUSEBURST	3	0	N/A for this transfer type
XFERMODE	2:0	3	Use Ping-Pong transfer mode

Note: In this example, it is not important if the peripheral makes a single request or a burst request. Because the peripheral has a FIFO that triggers at a level of 8, the arbitration size is set to 8. If the peripheral does make a burst request, then 8 bytes are transferred, which is what the FIFO can accommodate. If the peripheral makes a single request (if there is any data in the FIFO), then one byte is transferred at a time. If it is important to the application that transfers only be made in bursts, then the Channel Useburst SET[8] bit should be set in the DMA Channel Useburst Set (DMAUSEBURSTSET) register.

8.3.4.3 Configure the Peripheral Interrupt

An interrupt handler should be configured when using μ DMA Ping-Pong mode, it is best to use an interrupt handler. However, the Ping-Pong mode can be configured without interrupts by polling. The interrupt handler is triggered after each buffer is complete.

1. Configure and enable an interrupt handler for the peripheral.

8.3.4.4 Enable the µDMA Channel

Now the channel is configured and is ready to start.

1. Enable the channel by setting bit 8 of the **DMA Channel Enable Set (DMAENASET)** register.

8.3.4.5 Process Interrupts

The μ DMA controller is now configured and enabled for transfer on channel 8. When the peripheral asserts the μ DMA request signal, the μ DMA controller makes transfers into buffer A using the primary channel control structure. When the primary transfer to buffer A is complete, it switches to the alternate channel control structure and makes transfers into buffer B. At the same time, the primary channel control word mode field is configured to indicate Stopped, and an interrupt is

When an interrupt is triggered, the interrupt handler must determine which buffer is complete and process the data or set a flag that the data must be processed by non-interrupt buffer processing code. Then the next buffer transfer must be set up.

In the interrupt handler:

1. Read the primary channel control word at offset 0x088 and check the XFERMODE field. If the field is 0, this means buffer A is complete. If buffer A is complete, then:

- **a.** Process the newly received data in buffer A or signal the buffer processing code that buffer A has data available.
- **b.** Reprogram the primary channel control word at offset 0x88 according to Table 8-12 on page 351.
- 2. Read the alternate channel control word at offset 0x288 and check the XFERMODE field. If the field is 0, this means buffer B is complete. If buffer B is complete, then:
 - **a.** Process the newly received data in buffer B or signal the buffer processing code that buffer B has data available.
 - **b.** Reprogram the alternate channel control word at offset 0x288 according to Table 8-12 on page 351.

8.3.5 Configuring Channel Assignments

Channel assignments for each μ DMA channel can be changed using the **DMACHASGN** register. Each bit represents a μ DMA channel. If the bit is set, then the secondary function is used for the channel.

Refer to Table 8-1 on page 333 for channel assignments.

For example, to use SSI1 Receive on channel 8 instead of UART0, set bit 8 of the **DMACHASGN** register.

8.4 Register Map

Table 8-13 on page 352 lists the μ DMA channel control structures and registers. The channel control structure shows the layout of one entry in the channel control table. The channel control table is located in system memory, and the location is determined by the application, that is, the base address is n/a (not applicable). In the table below, the offset for the channel control structures is the offset from the entry in the channel control table. See "Channel Configuration" on page 335 and Table 8-3 on page 336 for a description of how the entries in the channel control table are located in memory. The μ DMA register addresses are given as a hexadecimal increment, relative to the μ DMA base address of 0x400F.F000. Note that the μ DMA module clock must be enabled before the registers can be programmed (see page 255). There must be a delay of 3 system clocks after the μ DMA module clock is enabled before any μ DMA module registers are accessed.

Table 8-13. µDMA Register Map

Offset	Name	Туре	Reset	Description	See page		
μDMA Channel Control Structure (Offset from Channel Control Table Base)							
0x000	DMASRCENDP	R/W	-	DMA Channel Source Address End Pointer	354		
0x004	DMADSTENDP	R/W	-	DMA Channel Destination Address End Pointer	355		
800x0	DMACHCTL	R/W	-	DMA Channel Control Word	356		
μDMA Registers (Offset from μDMA Base Address)							
0x000	DMASTAT	RO	0x001F.0000	DMA Status	361		
0x004	DMACFG	WO	-	DMA Configuration	363		
0x008	DMACTLBASE	R/W	0x0000.0000	DMA Channel Control Base Pointer	364		

Table 8-13. µDMA Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0x00C	DMAALTBASE	RO	0x0000.0200	DMA Alternate Channel Control Base Pointer	365
0x010	DMAWAITSTAT	RO	0xFFFF.FFC0	DMA Channel Wait-on-Request Status	366
0x014	DMASWREQ	WO	-	DMA Channel Software Request	367
0x018	DMAUSEBURSTSET	R/W	0x0000.0000	DMA Channel Useburst Set	368
0x01C	DMAUSEBURSTCLR	WO	-	DMA Channel Useburst Clear	369
0x020	DMAREQMASKSET	R/W	0x0000.0000	DMA Channel Request Mask Set	370
0x024	DMAREQMASKCLR	WO	-	DMA Channel Request Mask Clear	371
0x028	DMAENASET	R/W	0x0000.0000	DMA Channel Enable Set	372
0x02C	DMAENACLR	WO	-	DMA Channel Enable Clear	373
0x030	DMAALTSET	R/W	0x0000.0000	DMA Channel Primary Alternate Set	374
0x034	DMAALTCLR	WO	-	DMA Channel Primary Alternate Clear	375
0x038	DMAPRIOSET	R/W	0x0000.0000	DMA Channel Priority Set	376
0x03C	DMAPRIOCLR	WO	-	DMA Channel Priority Clear	377
0x04C	DMAERRCLR	R/W	0x0000.0000	DMA Bus Error Clear	378
0x500	DMACHASGN	R/W	0x0000.0000	DMA Channel Assignment	379
0xFD0	DMAPeriphID4	RO	0x0000.0004	DMA Peripheral Identification 4	384
0xFE0	DMAPeriphID0	RO	0x0000.0030	DMA Peripheral Identification 0	380
0xFE4	DMAPeriphID1	RO	0x0000.00B2	DMA Peripheral Identification 1	381
0xFE8	DMAPeriphID2	RO	0x0000.000B	DMA Peripheral Identification 2	382
0xFEC	DMAPeriphID3	RO	0x0000.0000	DMA Peripheral Identification 3	383
0xFF0	DMAPCellID0	RO	0x0000.000D	DMA PrimeCell Identification 0	385
0xFF4	DMAPCellID1	RO	0x0000.00F0	DMA PrimeCell Identification 1	386
0xFF8	DMAPCellID2	RO	0x0000.0005	DMA PrimeCell Identification 2	387
0xFFC	DMAPCelIID3	RO	0x0000.00B1	DMA PrimeCell Identification 3	388

8.5 µDMA Channel Control Structure

The μ DMA Channel Control Structure holds the transfer settings for a μ DMA channel. Each channel has two control structures, which are located in a table in system memory. Refer to "Channel Configuration" on page 335 for an explanation of the Channel Control Table and the Channel Control Structure.

The channel control structure is one entry in the channel control table. Each channel has a primary and alternate structure. The primary control structures are located at offsets 0x0, 0x10, 0x20 and so on. The alternate control structures are located at offsets 0x200, 0x210, 0x220, and so on.

Register 1: DMA Channel Source Address End Pointer (DMASRCENDP), offset 0x000

DMA Channel Source Address End Pointer (DMASRCENDP) is part of the Channel Control Structure and is used to specify the source address for a µDMA transfer.

The μ DMA controller can transfer data to and from the on-chip SRAM. However, because the Flash memory and ROM are located on a separate internal bus, it is not possible to transfer data from the Flash memory or ROM with the μ DMA controller.

Note: The offset specified is from the base address of the control structure in system memory, not the µDMA module base address.

DMA Channel Source Address End Pointer (DMASRCENDP)

Base n/a Offset 0x000 Type R/W, reset -



This field points to the last address of the μDMA transfer source (inclusive). If the source address is not incrementing (the SRCINC field in the **DMACHCTL** register is 0x3), then this field points at the source location itself (such as a peripheral data register).

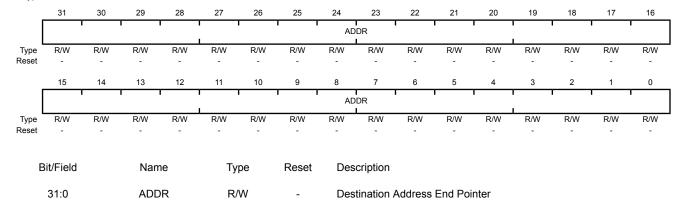
Register 2: DMA Channel Destination Address End Pointer (DMADSTENDP), offset 0x004

DMA Channel Destination Address End Pointer (DMADSTENDP) is part of the Channel Control Structure and is used to specify the destination address for a μ DMA transfer.

Note: The offset specified is from the base address of the control structure in system memory, not the μ DMA module base address.

DMA Channel Destination Address End Pointer (DMADSTENDP)

Base n/a Offset 0x004 Type R/W, reset -



This field points to the last address of the μDMA transfer destination (inclusive). If the destination address is not incrementing (the <code>DSTINC</code> field in the **DMACHCTL** register is 0x3), then this field points at the destination location itself (such as a peripheral data register).

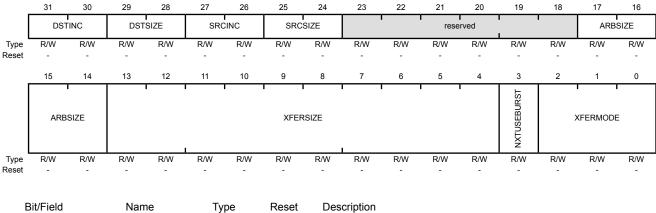
Register 3: DMA Channel Control Word (DMACHCTL), offset 0x008

DMA Channel Control Word (DMACHCTL) is part of the Channel Control Structure and is used to specify parameters of a μ DMA transfer.

Note: The offset specified is from the base address of the control structure in system memory, not the μ DMA module base address.

DMA Channel Control Word (DMACHCTL)

Base n/a Offset 0x008 Type R/W, reset -



31:30 DSTINC R/W - Destination Address Increment

This field configures the destination address increment.

The address increment value must be equal or greater than the value of the destination size (DSTSIZE).

Value Description

0x0 Byte

Increment by 8-bit locations

0x1 Half-word

Increment by 16-bit locations

0x2 Word

Increment by 32-bit locations

0x3 No increment

Address remains set to the value of the Destination Address End Pointer (DMADSTENDP) for the channel

Bit/Field	Name	Туре	Reset	Description
29:28	DSTSIZE	R/W	-	Destination Data Size This field configures the destination item data size.
				Note: DSTSIZE must be the same as SRCSIZE.
				Value Description
				0x0 Byte
				8-bit data size
				0x1 Half-word
				16-bit data size
				0x2 Word
				32-bit data size
				0x3 Reserved
27:26	SRCINC	R/W	-	Source Address Increment
				This field configures the source address increment.
				The address increment value must be equal or greater than the value of the source size (SRCSIZE).
				Value Description
				0x0 Byte
				Increment by 8-bit locations
				0x1 Half-word
				Increment by 16-bit locations
				0x2 Word
				Increment by 32-bit locations
				0x3 No increment
				Address remains set to the value of the Source Address End Pointer (DMASRCENDP) for the channel
25:24	SRCSIZE	R/W	_	Source Data Size
				This field configures the source item data size.
				Note: DSTSIZE must be the same as SRCSIZE.
				Value Description
				0x0 Byte
				8-bit data size.
				0x1 Half-word
				16-bit data size.
				0x2 Word
				32-bit data size.
				0x3 Reserved
23:18	reserved	R/W	-	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Type	Reset	Description
17:14	ARBSIZE	R/W	-	Arbitration Size This field configures the number of transfers that can occur before the μ DMA controller re-arbitrates. The possible arbitration rate configurations represent powers of 2 and are shown below.
				Value Description
				0x0 1 Transfer
				Arbitrates after each µDMA transfer
				0x1 2 Transfers
				0x2 4 Transfers
				0x3 8 Transfers
				0x4 16 Transfers
				0x5 32 Transfers
				0x6 64 Transfers
				0x7 128 Transfers
				0x8 256 Transfers
				0x9 512 Transfers
				0xA-0xF 1024 Transfers
				In this configuration, no arbitration occurs during the μDMA transfer because the maximum transfer size is 1024.
13:4	XFERSIZE	R/W	-	Transfer Size (minus 1)
				This field configures the total number of items to transfer. The value of this field is 1 less than the number to transfer (value 0 means transfer 1 item). The maximum value for this 10-bit field is 1023 which represents a transfer size of 1024 items.
				The transfer size is the number of items, not the number of bytes. If the data size is 32 bits, then this value is the number of 32-bit words to transfer.
				The μ DMA controller updates this field immediately prior to entering the arbitration process, so it contains the number of outstanding items that is necessary to complete the μ DMA cycle.
3	NXTUSEBURST	R/W	-	Next Useburst
				This field controls whether the Useburst SET[n] bit is automatically set for the last transfer of a peripheral scatter-gather operation. Normally, for the last transfer, if the number of remaining items to transfer is less than the arbitration size, the μ DMA controller uses single transfers to complete the transaction. If this bit is set, then the controller uses a burst transfer to complete the last transfer.

Bit/Field	Name	Туре	Reset	Description
2:0	XFERMODE	R/W	-	μDMA Transfer Mode
				This field configures the operating mode of the μ DMA cycle. Refer to "Transfer Modes" on page 337 for a detailed explanation of transfer modes.
				Because this register is in system RAM, it has no reset value. Therefore, this field should be initialized to 0 before the channel is enabled.
				Value Description
				0x0 Stop
				0x1 Basic
				0x2 Auto-Request
				0x3 Ping-Pong
				0x4 Memory Scatter-Gather
				0x5 Alternate Memory Scatter-Gather
				0x6 Peripheral Scatter-Gather
				0x7 Alternate Peripheral Scatter-Gather

XFERMODE Bit Field Values.

Stop

Channel is stopped or configuration data is invalid. No more transfers can occur.

Basic

For each trigger (whether from a peripheral or a software request), the μDMA controller performs the number of transfers specified by the ARBSIZE field.

Auto-Request

The initial request (software- or peripheral-initiated) is sufficient to complete the entire transfer of XFERSIZE items without any further requests.

Ping-Pong

This mode uses both the primary and alternate control structures for this channel. When the number of transfers specified by the XFERSIZE field have completed for the current control structure (primary or alternate), the μ DMA controller switches to the other one. These switches continue until one of the control structures is not set to ping-pong mode. At that point, the μ DMA controller stops. An interrupt is generated on completion of the transfers configured by each control structure. See "Ping-Pong" on page 337.

Memory Scatter-Gather

When using this mode, the primary control structure for the channel is configured to allow a list of operations (tasks) to be performed. The source address pointer specifies the start of a table of tasks to be copied to the alternate control structure for this channel. The XFERMODE field for the alternate control structure should be configured to 0x5 (Alternate memory scatter-gather) to perform the task. When the task completes, the µDMA switches back to the primary channel control structure, which then copies the next task to the alternate control structure. This process continues until the table of tasks is empty. The last task must have an XFERMODE value other than 0x5. Note that for continuous operation, the last task can update the primary channel control structure back to the start of the list or to another list. See "Memory Scatter-Gather" on page 338.

Alternate Memory Scatter-Gather

This value must be used in the alternate channel control data structure when the µDMA controller operates in Memory Scatter-Gather mode.

Peripheral Scatter-Gather

This value must be used in the primary channel control data structure when the μ DMA controller operates in Peripheral Scatter-Gather mode. In this mode, the μ DMA controller operates exactly the same as in Memory Scatter-Gather mode, except that instead of performing the number of transfers specified by the XFERSIZE field in the alternate control structure at one time, the μ DMA controller only performs the number of transfers specified by the ARBSIZE field per trigger; see Basic mode for details. See "Peripheral Scatter-Gather" on page 342.

Alternate Peripheral Scatter-Gather

This value must be used in the alternate channel control data structure when the µDMA controller operates in Peripheral Scatter-Gather mode.

8.6 µDMA Register Descriptions

The register addresses given are relative to the µDMA base address of 0x400F.F000.

Register 4: DMA Status (DMASTAT), offset 0x000

The DMA Status (DMASTAT) register returns the status of the μDMA controller. You cannot read this register when the µDMA controller is in the reset state.

DMA Status (DMASTAT)

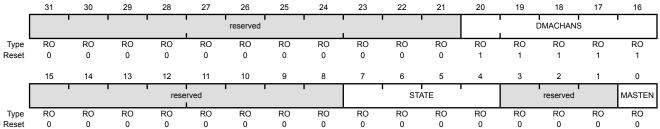
3:1

reserved

RO

0x0

Base 0x400F.F000 Offset 0x000 Type RO, reset 0x001F.0000



L																
et	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
В	sit/Field		Nan	ne	Ту	ре	Reset	Desc	ription							
	31:21		reser	ved	R	0	0x000	comp	atibility	ould not with futu cross a r	ure produ	ucts, the	value of	a reserv	•	
	20:16		DMACH	HANS	R	0	0x1F	Avail	able μD	MA Cha	nnels Mi	inus 1				
								μDM	A contro	ntains a soller is contains to 32 µ[onfigure	d to use,				
	15:8		reser	ved	R	0	0x00	comp	atibility	ould not with futu cross a re	ure produ	ucts, the	value of	a reserv	•	
	7:4		STA	TE	R	0	0x0	Cont	rol State	e Machin	ne Status	;				
										ows the of the follows		tatus of	the conti	ol state	machine	. Status
								Valu	e De	escription	า					
								0x0	ldl	е						
								0x1	Re	eading cl	nannel c	ontroller	data.			
								0x2	Re	eading so	ource en	d pointe	r.			
								0x3	Re	eading de	estinatio	n end po	inter.			
								0x4		eading so						
								0x5	Wı	riting des	stination	data.				

0x6 Waiting for μDMA request to clear. 0x7 Writing channel controller data.

0x8 Stalled 0x9 Done

0xA-0xF Undefined

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

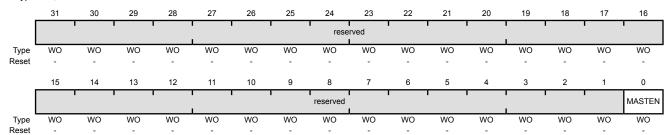
Bit/Field	Name	Type	Reset	Description
0	MASTEN	RO	0	Master Enable Status
				Value Description
				0 The μDMA controller is disabled.
				1 The μDMA controller is enabled.

Register 5: DMA Configuration (DMACFG), offset 0x004

The **DMACFG** register controls the configuration of the µDMA controller.

DMA Configuration (DMACFG)

Base 0x400F.F000 Offset 0x004 Type WO, reset -



Bit/Field	Name	Туре	Reset	Description
31:1	reserved	WO	-	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	MASTEN	WO	_	Controller Master Enable

Value Description

0 Disables the μDMA controller.

1 Enables μDMA controller.

Register 6: DMA Channel Control Base Pointer (DMACTLBASE), offset 0x008

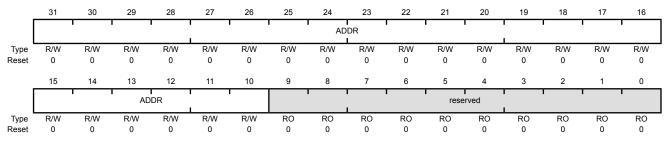
The **DMACTLBASE** register must be configured so that the base pointer points to a location in system memory.

The amount of system memory that must be assigned to the μDMA controller depends on the number of μDMA channels used and whether the alternate channel control data structure is used. See "Channel Configuration" on page 335 for details about the Channel Control Table. The base address must be aligned on a 1024-byte boundary. This register cannot be read when the μDMA controller is in the reset state.

DMA Channel Control Base Pointer (DMACTLBASE)

Base 0x400F.F000

Offset 0x008 Type R/W, reset 0x0000.0000



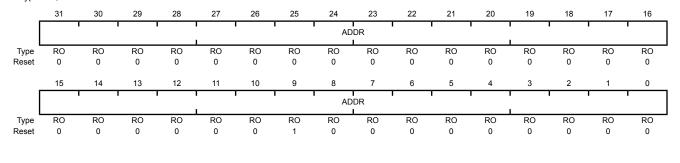
Bit/Field	Name	Туре	Reset	Description
31:10	ADDR	R/W	0x0000.00	Channel Control Base Address This field contains the pointer to the base address of the channel control table. The base address must be 1024-byte aligned.
9:0	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 7: DMA Alternate Channel Control Base Pointer (DMAALTBASE), offset 0x00C

The **DMAALTBASE** register returns the base address of the alternate channel control data. This register removes the necessity for application software to calculate the base address of the alternate channel control structures. This register cannot be read when the μDMA controller is in the reset state.

DMA Alternate Channel Control Base Pointer (DMAALTBASE)

Base 0x400F.F000 Offset 0x00C Type RO, reset 0x0000.0200



Bit/Field Name Type Reset Description

31:0 ADDR RO 0x0000.0200 Alternate Channel Address Pointer

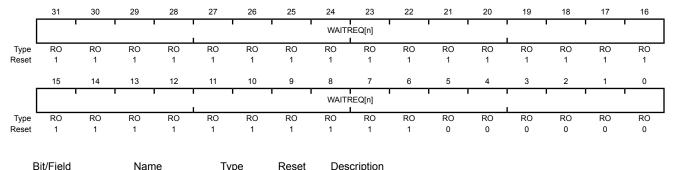
This field provides the base address of the alternate channel control structures.

Register 8: DMA Channel Wait-on-Request Status (DMAWAITSTAT), offset 0x010

This read-only register indicates that the µDMA channel is waiting on a request. A peripheral can hold off the µDMA from performing a single request until the peripheral is ready for a burst request to enhance the µDMA performance. The use of this feature is dependent on the design of the peripheral and is not controllable by software in any way. This register cannot be read when the µDMA controller is in the reset state.

DMA Channel Wait-on-Request Status (DMAWAITSTAT)

Base 0x400F.F000 Offset 0x010 Type RO, reset 0xFFFF.FFC0



Name Type Reset Description 31:0 WAITREQ[n] 0xFFFF.FFC0 Channel [n] Wait Status RO

> These bits provide the channel wait-on-request status. Bit 0 corresponds to channel 0.

Value Description

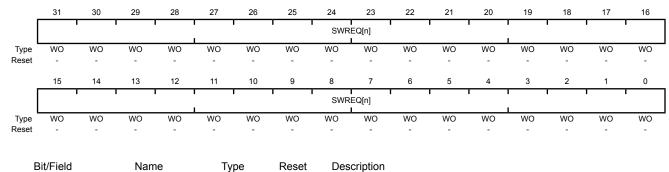
- 1 The corresponding channel is waiting on a request.
- 0 The corresponding channel is not waiting on a request.

Register 9: DMA Channel Software Request (DMASWREQ), offset 0x014

Each bit of the **DMASWREQ** register represents the corresponding μ DMA channel. Setting a bit generates a request for the specified μ DMA channel.

DMA Channel Software Request (DMASWREQ)

Base 0x400F.F000 Offset 0x014 Type WO, reset -



31:0 SWREQ[n] WO - Channel [n] Software Request

These bits generate software requests. Bit 0 corresponds to channel 0.

Value Description

- 1 Generate a software request for the corresponding channel.
- 0 No request generated.

These bits are automatically cleared when the software request has been completed.

Register 10: DMA Channel Useburst Set (DMAUSEBURSTSET), offset 0x018

Each bit of the **DMAUSEBURSTSET** register represents the corresponding µDMA channel. Setting a bit disables the channel's single request input from generating requests, configuring the channel to only accept burst requests. Reading the register returns the status of USEBURST.

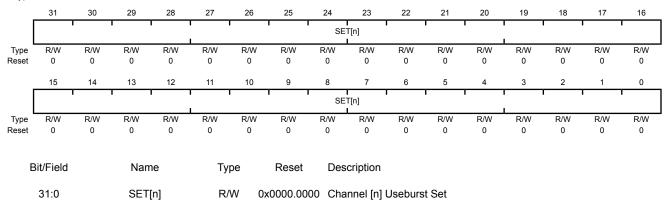
If the amount of data to transfer is a multiple of the arbitration (burst) size, the corresponding SET[n] bit is cleared after completing the final transfer. If there are fewer items remaining to transfer than the arbitration (burst) size, the μDMA controller automatically clears the corresponding SET[n] bit, allowing the remaining items to transfer using single requests. In order to resume transfers using burst requests, the corresponding bit must be set again. A bit should not be set if the corresponding peripheral does not support the burst request model.

Refer to "Request Types" on page 334 for more details about request types.

DMA Channel Useburst Set (DMAUSEBURSTSET)

Base 0x400F.F000

Offset 0x018 Type R/W, reset 0x0000.0000



Value Description

- 0 μDMA channel [n] responds to single or burst requests.
- 1 µDMA channel [n] responds only to burst requests.

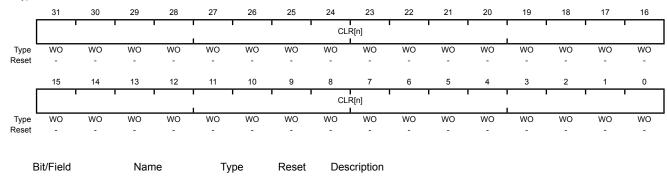
Bit 0 corresponds to channel 0. This bit is automatically cleared as described above. A bit can also be manually cleared by setting the corresponding ${\tt CLR[n]}$ bit in the **DMAUSEBURSTCLR** register.

Register 11: DMA Channel Useburst Clear (DMAUSEBURSTCLR), offset 0x01C

Each bit of the **DMAUSEBURSTCLR** register represents the corresponding μ DMA channel. Setting a bit clears the corresponding SET[n] bit in the **DMAUSEBURSTSET** register.

DMA Channel Useburst Clear (DMAUSEBURSTCLR)

Base 0x400F.F000 Offset 0x01C Type WO, reset -



31:0 CLR[n] WO - Channel [n] Useburst Clear

Value Description

- 0 No effect.
- 1 Setting a bit clears the corresponding SET[n] bit in the **DMAUSEBURSTSET** register meaning that μDMA channel [n] responds to single and burst requests.

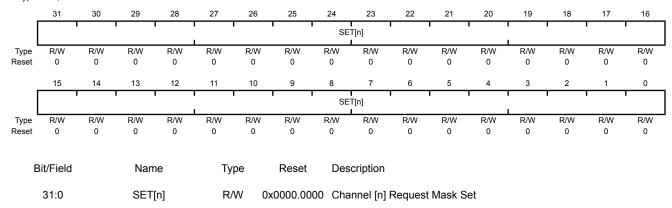
Register 12: DMA Channel Request Mask Set (DMAREQMASKSET), offset 0x020

Each bit of the **DMAREQMASKSET** register represents the corresponding μ DMA channel. Setting a bit disables μ DMA requests for the channel. Reading the register returns the request mask status. When a μ DMA channel's request is masked, that means the peripheral can no longer request μ DMA transfers. The channel can then be used for software-initiated transfers.

DMA Channel Request Mask Set (DMAREQMASKSET)

Base 0x400F.F000 Offset 0x020

Type R/W, reset 0x0000.0000



Value Description

- The peripheral associated with channel [n] is enabled to request μDMA transfers.
- The peripheral associated with channel [n] is not able to request μ DMA transfers. Channel [n] may be used for software-initiated transfers.

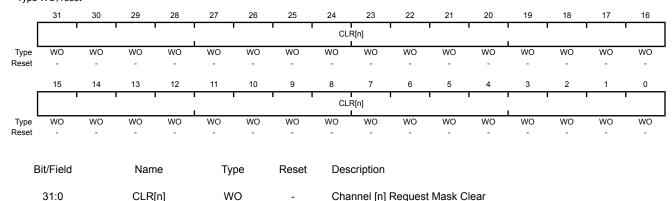
Bit 0 corresponds to channel 0. A bit can only be cleared by setting the corresponding CLR[n] bit in the **DMAREQMASKCLR** register.

Register 13: DMA Channel Request Mask Clear (DMAREQMASKCLR), offset 0x024

Each bit of the **DMAREQMASKCLR** register represents the corresponding μ DMA channel. Setting a bit clears the corresponding SET[n] bit in the **DMAREQMASKSET** register.

DMA Channel Request Mask Clear (DMAREQMASKCLR)

Base 0x400F.F000 Offset 0x024 Type WO, reset -



Value Description

0 No effect.

Setting a bit clears the corresponding SET[n] bit in the DMAREQMASKSET register meaning that the peripheral associated with channel [n] is enabled to request μDMA transfers.

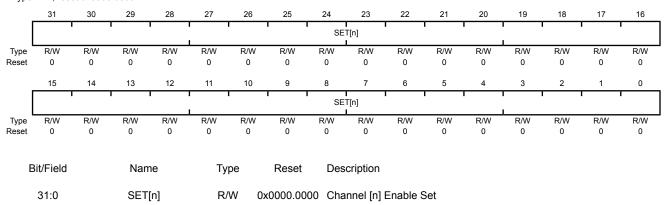
Register 14: DMA Channel Enable Set (DMAENASET), offset 0x028

Each bit of the **DMAENASET** register represents the corresponding μ DMA channel. Setting a bit enables the corresponding μ DMA channel. Reading the register returns the enable status of the channels. If a channel is enabled but the request mask is set (**DMAREQMASKSET**), then the channel can be used for software-initiated transfers.

DMA Channel Enable Set (DMAENASET)

Base 0x400F.F000

Offset 0x028 Type R/W, reset 0x0000.0000



Value Description

0 μDMA Channel [n] is disabled.

1 μDMA Channel [n] is enabled.

Bit 0 corresponds to channel 0. A bit can only be cleared by setting the corresponding $\mathtt{CLR}[n]$ bit in the **DMAENACLR** register.

Register 15: DMA Channel Enable Clear (DMAENACLR), offset 0x02C

Each bit of the **DMAENACLR** register represents the corresponding μ DMA channel. Setting a bit clears the corresponding SET[n] bit in the **DMAENASET** register.

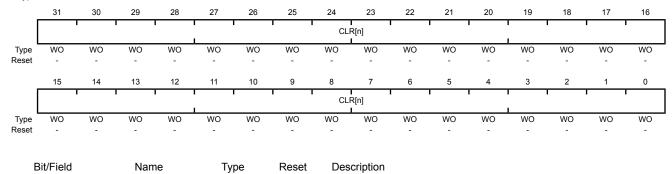
DMA Channel Enable Clear (DMAENACLR)

CLR[n]

WO

Base 0x400F.F000 Offset 0x02C Type WO, reset -

31:0



Value Description

Clear Channel [n] Enable Clear

0 No effect.

Setting a bit clears the corresponding SET[n] bit in the DMAENASET register meaning that channel [n] is disabled for μDMA transfers.

 $\begin{tabular}{ll} \textbf{Note:} & The controller disables a channel when it completes the μDMA cycle. \end{tabular}$

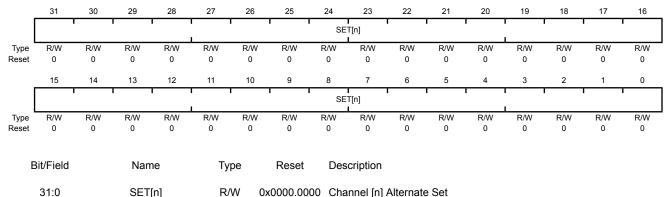
Register 16: DMA Channel Primary Alternate Set (DMAALTSET), offset 0x030

Each bit of the **DMAALTSET** register represents the corresponding μ DMA channel. Setting a bit configures the μ DMA channel to use the alternate control data structure. Reading the register returns the status of which control data structure is in use for the corresponding μ DMA channel.

DMA Channel Primary Alternate Set (DMAALTSET)

Base 0x400F.F000 Offset 0x030

Type R/W, reset 0x0000.0000



Value Description

- 0 μDMA channel [n] is using the primary control structure.
- 1 μDMA channel [n] is using the alternate control structure.

Bit 0 corresponds to channel 0. A bit can only be cleared by setting the corresponding CLR[n] bit in the **DMAALTCLR** register.

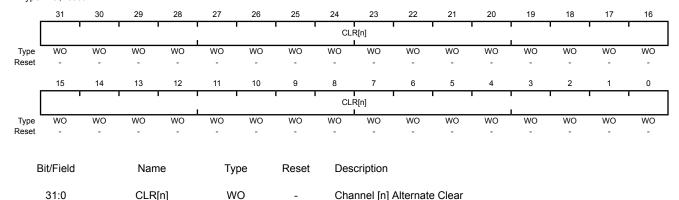
Note: For Ping-Pong and Scatter-Gather cycle types, the μDMA controller automatically sets these bits to select the alternate channel control data structure.

Register 17: DMA Channel Primary Alternate Clear (DMAALTCLR), offset 0x034

Each bit of the **DMAALTCLR** register represents the corresponding µDMA channel. Setting a bit clears the corresponding SET[n] bit in the **DMAALTSET** register.

DMA Channel Primary Alternate Clear (DMAALTCLR)

Base 0x400F.F000 Offset 0x034 Type WO, reset -



Value Description

0 No effect.

Setting a bit clears the corresponding SET[n] bit in the DMAALTSET register meaning that channel [n] is using the primary control structure.

Note: For Ping-Pong and Scatter-Gather cycle types, the µDMA controller automatically sets these bits to select the alternate

channel control data structure.

Register 18: DMA Channel Priority Set (DMAPRIOSET), offset 0x038

Each bit of the **DMAPRIOSET** register represents the corresponding μ DMA channel. Setting a bit configures the μ DMA channel to have a high priority level. Reading the register returns the status of the channel priority mask.

DMA Channel Priority Set (DMAPRIOSET)

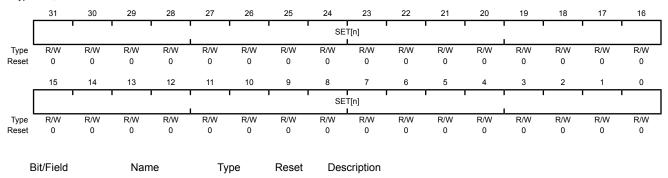
SET[n]

R/W

Base 0x400F.F000 Offset 0x038

31:0

Type R/W, reset 0x0000.0000



Value Description

0x0000.0000 Channel [n] Priority Set

- 0 μDMA channel [n] is using the default priority level.
- 1 μDMA channel [n] is using a high priority level.

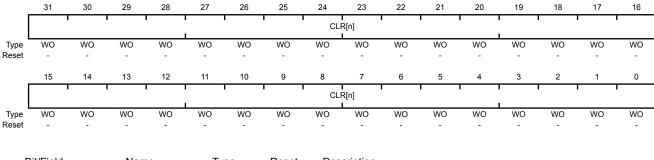
Bit 0 corresponds to channel 0. A bit can only be cleared by setting the corresponding ${\tt CLR[n]}$ bit in the **DMAPRIOCLR** register.

Register 19: DMA Channel Priority Clear (DMAPRIOCLR), offset 0x03C

Each bit of the **DMAPRIOCLR** register represents the corresponding μ DMA channel. Setting a bit clears the corresponding SET[n] bit in the **DMAPRIOSET** register.

DMA Channel Priority Clear (DMAPRIOCLR)

Base 0x400F.F000 Offset 0x03C Type WO, reset -



Bit/Field Name Type Reset Description

31:0 CLR[n] WO - Channel [n] Priority Clear

Value Description

0 No effect.

Setting a bit clears the corresponding SET[n] bit in the DMAPRIOSET register meaning that channel [n] is using the default priority level.

Register 20: DMA Bus Error Clear (DMAERRCLR), offset 0x04C

The **DMAERRCLR** register is used to read and clear the μ DMA bus error status. The error status is set if the μ DMA controller encountered a bus error while performing a transfer. If a bus error occurs on a channel, that channel is automatically disabled by the μ DMA controller. The other channels are unaffected.

DMA Bus Error Clear (DMAERRCLR)

Base 0x400F.F000

Offset 0x04C Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	ERRCLR	R/W1C	0	μDMA Bus Error Status

Value Description

0 No bus error is pending.

A bus error is pending.

This bit is cleared by writing a 1 to it.

Register 21: DMA Channel Assignment (DMACHASGN), offset 0x500

Each bit of the **DMACHASGN** register represents the corresponding µDMA channel. Setting a bit selects the secondary channel assignment as specified in Table 8-1 on page 333.

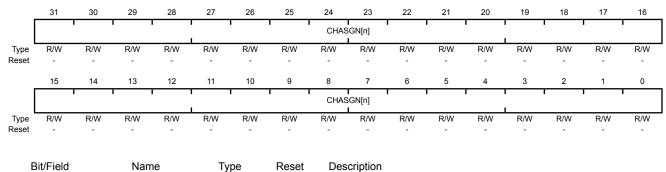
DMA Channel Assignment (DMACHASGN)

CHASGN[n]

R/W

Base 0x400F.F000 Offset 0x500 Type R/W, reset 0x0000.0000

31:0



Channel [n] Assignment Select

Value Description

0 Use the primary channel assignment.

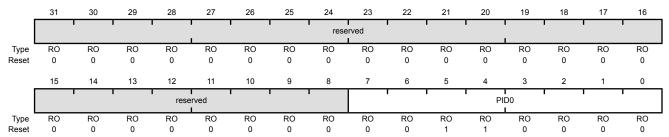
Use the secondary channel assignment.

Register 22: DMA Peripheral Identification 0 (DMAPeriphID0), offset 0xFE0

The **DMAPeriphIDn** registers are hard-coded, and the fields within the registers determine the reset values.

DMA Peripheral Identification 0 (DMAPeriphID0)

Base 0x400F.F000 Offset 0xFE0 Type RO, reset 0x0000.0030



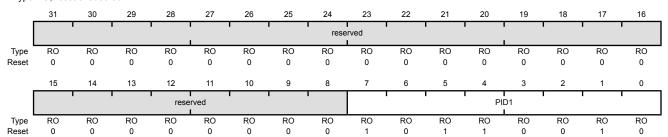
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID0	RO	0x30	μDMA Peripheral ID Register [7:0] Can be used by software to identify the presence of this peripheral.

Register 23: DMA Peripheral Identification 1 (DMAPeriphID1), offset 0xFE4

The **DMAPeriphIDn** registers are hard-coded, and the fields within the registers determine the reset values.

DMA Peripheral Identification 1 (DMAPeriphID1)

Base 0x400F.F000 Offset 0xFE4 Type RO, reset 0x0000.00B2



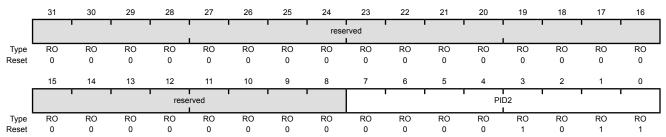
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID1	RO	0xB2	μDMA Peripheral ID Register [15:8]
				Can be used by software to identify the presence of this peripheral.

Register 24: DMA Peripheral Identification 2 (DMAPeriphID2), offset 0xFE8

The **DMAPeriphIDn** registers are hard-coded, and the fields within the registers determine the reset values.

DMA Peripheral Identification 2 (DMAPeriphID2)

Base 0x400F.F000 Offset 0xFE8 Type RO, reset 0x0000.000B



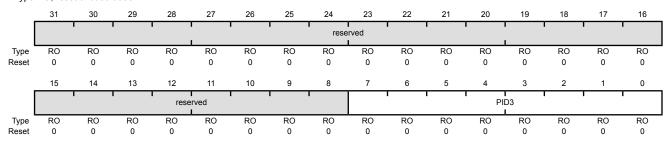
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID2	RO	0x0B	μDMA Peripheral ID Register [23:16]
				Can be used by software to identify the presence of this peripheral.

Register 25: DMA Peripheral Identification 3 (DMAPeriphID3), offset 0xFEC

The **DMAPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

DMA Peripheral Identification 3 (DMAPeriphID3)

Base 0x400F.F000 Offset 0xFEC Type RO, reset 0x0000.0000



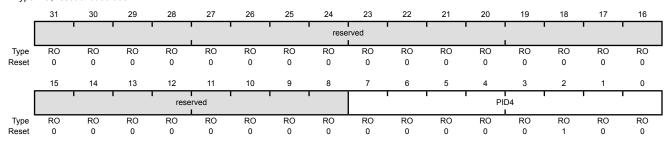
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID3	RO	0x00	μDMA Peripheral ID Register [31:24]
				Can be used by software to identify the presence of this peripheral.

Register 26: DMA Peripheral Identification 4 (DMAPeriphID4), offset 0xFD0

The **DMAPeriphIDn** registers are hard-coded, and the fields within the registers determine the reset values.

DMA Peripheral Identification 4 (DMAPeriphID4)

Base 0x400F.F000 Offset 0xFD0 Type RO, reset 0x0000.0004



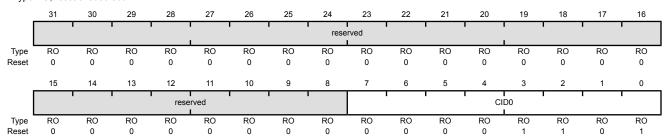
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID4	RO	0x04	μDMA Peripheral ID Register Can be used by software to identify the presence of this peripheral.

Register 27: DMA PrimeCell Identification 0 (DMAPCellID0), offset 0xFF0

The **DMAPCellIDn** registers are hard-coded, and the fields within the registers determine the reset values.

DMA PrimeCell Identification 0 (DMAPCellID0)

Base 0x400F.F000 Offset 0xFF0 Type RO, reset 0x0000.000D



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID0	RO	0x0D	μDMA PrimeCell ID Register [7:0]

Provides software a standard cross-peripheral identification system.

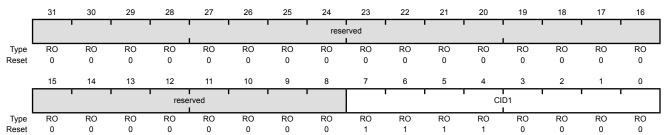
Register 28: DMA PrimeCell Identification 1 (DMAPCellID1), offset 0xFF4

The **DMAPCellIDn** registers are hard-coded, and the fields within the registers determine the reset values.

DMA PrimeCell Identification 1 (DMAPCellID1)

386

Base 0x400F.F000 Offset 0xFF4 Type RO, reset 0x0000.00F0



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID1	RO	0xF0	μDMA PrimeCell ID Register [15:8]
				Provides software a standard cross-peripheral identification system.

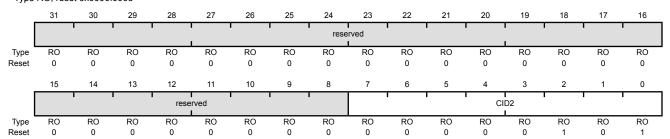
October 06, 2012

Register 29: DMA PrimeCell Identification 2 (DMAPCellID2), offset 0xFF8

The **DMAPCellIDn** registers are hard-coded, and the fields within the registers determine the reset values.

DMA PrimeCell Identification 2 (DMAPCelIID2)

Base 0x400F.F000 Offset 0xFF8 Type RO, reset 0x0000.0005



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID2	RO	0x05	μDMA PrimeCell ID Register [23:16]

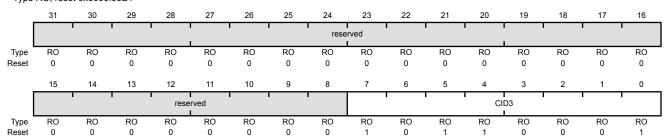
Provides software a standard cross-peripheral identification system.

Register 30: DMA PrimeCell Identification 3 (DMAPCellID3), offset 0xFFC

The **DMAPCellIDn** registers are hard-coded, and the fields within the registers determine the reset values.

DMA PrimeCell Identification 3 (DMAPCellID3)

Base 0x400F.F000 Offset 0xFFC Type RO, reset 0x0000.00B1



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID3	RO	0xB1	μDMA PrimeCell ID Register [31:24]

Provides software a standard cross-peripheral identification system.

9 General-Purpose Input/Outputs (GPIOs)

The GPIO module is composed of nine physical GPIO blocks, each corresponding to an individual GPIO port (Port A, Port B, Port C, Port D, Port E, Port F, Port G, Port H, Port J). The GPIO module supports up to 67 programmable input/output pins, depending on the peripherals being used.

The GPIO module has the following features:

- Up to 67 GPIOs, depending on configuration
- Highly flexible pin muxing allows use as GPIO or one of several peripheral functions
- 5-V-tolerant in input configuration
- Two means of port access: either Advanced High-Performance Bus (AHB) with better back-to-back access performance, or the legacy Advanced Peripheral Bus (APB) for backwards-compatibility with existing code
- Fast toggle capable of a change every clock cycle for ports on AHB, every two clock cycles for ports on APB
- Programmable control for GPIO interrupts
 - Interrupt generation masking
 - Edge-triggered on rising, falling, or both
 - Level-sensitive on High or Low values
- Bit masking in both read and write operations through address lines
- Can be used to initiate an ADC sample sequence
- Pins configured as digital inputs are Schmitt-triggered
- Programmable control for GPIO pad configuration
 - Weak pull-up or pull-down resistors
 - 2-mA, 4-mA, and 8-mA pad drive for digital communication; up to four pads can sink 18-mA for high-current applications
 - Slew rate control for the 8-mA drive
 - Open drain enables
 - Digital input enables

9.1 Signal Description

GPIO signals have alternate hardware functions. The following table lists the GPIO pins and their analog and digital alternate functions. The AINx and VREFA analog signals are not 5-V tolerant and go through an isolation circuit before reaching their circuitry. These signals are configured by clearing the corresponding DEN bit in the GPIO Digital Enable (GPIODEN) register and setting the corresponding AMSEL bit in the GPIO Analog Mode Select (GPIOAMSEL) register. Other analog

signals are 5-V tolerant and are connected directly to their circuitry (C0-, C0+, C1-, C1+). These signals are configured by clearing the DEN bit in the **GPIO Digital Enable (GPIODEN)** register. All GPIO signals are 5-V tolerant when configured as inputs except for PB0 and PB1, which are limited to 3.6 V. The digital alternate hardware functions are enabled by setting the appropriate bit in the **GPIO Alternate Function Select (GPIOAFSEL)** and **GPIODEN** registers and configuring the PMCx bit field in the **GPIO Port Control (GPIOPCTL)** register to the numeric encoding shown in the table below. Note that each pin must be programmed individually; no type of grouping is implied by the columns in the table. Table entries that are shaded gray are the default values for the corresponding GPIO pin.

Important: All GPIO pins are configured as GPIOs and tri-stated by default (GPIOAFSEL=0, GPIODEN=0, GPIOPDR=0, GPIOPUR=0, and GPIOPCTL=0, with the exception of the pins shown in the table below. A Power-On-Reset (POR) or asserting RST puts the pins back to their default state.

Table 9-1. GPIO Pins With Non-Zero Reset Values

GPIO Pins	Default State	GPIOAFSEL	GPIODEN	GPIOPDR	GPIOPUR	GPIOPCTL
PA[1:0]	UART0	0	0	0	0	0x1
PA[5:2]	SSI0	0	0	0	0	0x2
PB[3:2]	I ² C0	0	0	0	0	0x3
PC[3:0]	JTAG/SWD	1	1	0	1	0x1

Table 9-2. GPIO Pins and Alternate Functions (100LQFP)

10	Di-	Analog			Digi	tal Functi	ion (GPIO	PCTL PM	Cx Bit Fie	ld Encodii	າg) ^a		
Ю	Pin	Function	1	2	3	4	5	6	7	8	9	10	11
PA0	26	-	U0Rx	-	-	-	-	-	-	I2C1SCL	U1Rx	-	-
PA1	27	-	U0Tx	-	-	-	-	-	-	I2C1SDA	UlTx	-	-
PA2	28	-	SSI0Clk	-	-	-	-	-	-	-	-	-	-
PA3	29	-	SSI0Fss	-	-	-	-	-	-	-	-	-	-
PA4	30	-	SSI0Rx	-	-	-	-	-	-	-	-	-	-
PA5	31	-	SSIOTx	1	-	1	-	-	-	-	ı	1	1
PA6	34	-	I2C1SCL	CCP1	-	1	-	-	-	-	U1CTS	1	1
PA7	35	-	I2C1SDA	CCP4	-	-	-	-	CCP3	-	U1DCD	1	1
PB0	66	-	CCP0	1	-	1	U1Rx	-	-	-	1	1	1
PB1	67	-	CCP2	1	-	CCP1	U1Tx	-	-	-	1	1	-
PB2	72	-	I2C0SCL	-	-	CCP3	CCP0	-	-	-	-	-	-
PB3	65	-	I2C0SDA	-	-	-	-	-	-	-	1	-	-
PB4	92	C0-	-	1	-	U2Rx	-	-	UlRx	-	1	1	1
PB5	91	C1-	С00	CCP5	-	CCP0	-	CCP2	UlTx	-	ı	ı	ı
PB6	90	VREFA C0+	CCP1	-	C00	-	-	CCP5	-	-	-	-	-
PB7	89	-	-	-	-	NMI	-	-	-	-	-	-	-
PC0	80	-	-	-	TCK SWCLK	-	-	-	-	-	-	-	-
PC1	79	-	-	-	TMS SWDIO	-	-	-	-	-	-	-	-

Table 9-2. GPIO Pins and Alternate Functions (100LQFP) (continued)

10	Dia	Analog			Digi	tal Functi	ion (GPIO	PCTL PM	Cx Bit Fiel	ld Encodi	ng) ^a		
Ю	Pin	Function	1	2	3	4	5	6	7	8	9	10	11
PC2	78	-	-	-	TDI	-	-	-	-	-	-	-	-
PC3	77	-	-	-	TDO SWO	-	-	-	-	-	-	-	-
PC4	25	-	CCP5	-	-	-	CCP2	CCP4	-	-	CCP1	-	-
PC5	24	C1+	CCP1	Clo	C0o	-	CCP3	-	-	-	-	-	-
PC6	23	-	CCP3	-	-	-	U1Rx	CCP0	-	-	-	-	-
PC7	22	-	CCP4	-	-	CCP0	U1Tx	-	C1o	-	-	-	-
PD0	10	-	-	-	-	U2Rx	U1Rx	-	-	-	U1CTS	-	-
PD1	11	-	-	-	-	U2Tx	U1Tx	-	-	-	U1DCD	CCP2	-
PD2	12	-	U1Rx	-	-	CCP5	-	-	-	-	-	-	-
PD3	13	-	U1Tx	-	-	CCP0	-	-	-	-	-	-	-
PD4	97	AIN7	CCP0	CCP3	-	-	-	-	-	-	U1RI	-	-
PD5	98	AIN6	CCP2	CCP4	-	-	-	-	-	-	U2Rx	-	-
PD6	99	AIN5	-	-	-	-	-	-	-	-	U2Tx	-	-
PD7	100	AIN4	-	C0o	CCP1	-	-	-	-	-	U1DTR	-	-
PE0	74	-	-	SSI1Clk	CCP3	-	-	-	-	-	-	-	-
PE1	75	-	-	SSI1Fss	-	CCP2	-	-	-	-	-	-	-
PE2	95	-	CCP4	SSI1Rx	-	-	CCP2	-	-	-	-	-	-
PE3	96	-	CCP1	SSI1Tx	-	-	-	-	-	-	-	-	-
PE4	6	AIN3	CCP3	-	-	-	U2Tx	CCP2	-	-	-	-	-
PE5	5	AIN2	CCP5	-	-	-	-	-	-	-	-	-	-
PE6	2	AIN1	-	C1o	-	-	-	-	-	-	U1CTS	-	-
PE7	1	AIN0	-	-	-	-	-	-	-	-	U1DCD	-	-
PF0	47	-	-	-	-	-	-	-	-	-	U1DSR	-	-
PF1	61	-	-	-	-	-	-	-	-	-	U1RTS	CCP3	-
PF2	60	-	-	-	-	-	-	-	-	-	SSI1Clk	-	-
PF3	59	-	-	-	-	-	-	-	-	-	SSI1Fss	-	-
PF4	58	-	CCP0	C0o	-	-	-	-	-	-	SSI1Rx	-	-
PF5	46	-	CCP2	C1o	-	-	-	-	-	-	SSI1Tx	-	-
PF6	43	-	CCP1	-	-	-	-	-	-	-	-	U1RTS	-
PF7	42	-	CCP4	-	-	-	-	-	-	-	-	-	-
PG0	19	-	U2Rx	-	I2C1SCL	-	-	-	-	-	-	-	-
PG1	18	-	U2Tx	-	I2C1SDA	-	-	-	-	-	-	-	-
PG2	17	-	-	-	-	-	-	-	-	-	-	-	-
PG3	16	-	-	-	-	-	-	-	-	-	-	-	-
PG4	41	-	CCP3	-	-	-	-	-	-	-	-	U1RI	-
PG5	40	-	CCP5	-	-	-	-	-	-	-	-	U1DTR	-
PG6	37	-	-	-	-	-	-	-	-	-	-	U1RI	-
PG7	36	-	-	-	-	-	-	-	-	CCP5	-	-	-
PH0	86	-	-	-	-	-	-	-	-	-	-	-	-

Table 9-2. GPIO Pins and Alternate Functions (100LQFP) (continued)

10	Pin	Analog		Digital Function (GPIOPCTL PMCx Bit Field Encoding) ^a									
10	FIII	Function	1	2	3	4	5	6	7	8	9	10	11
PH1	85	-	-	-	-	-	-	-	-	-	-	-	-
PH2	84	-	-	C1o	-	-	-	-	-	-	-	-	-
PH3	83	-	-	-	-	-	-	-	-	-	-	-	-
PH4	76	-	-	-	-	-	-	-	-	-	-	-	SSI1Clk
PH5	63	-	-	-	-	-	-	-	-	-	-	-	SSI1Fss
РН6	62	-	-	-	-	-	-	-	-	-	-	-	SSI1Rx
PH7	15	-	-	-	-	-	-	-	-	-	-	-	SSI1Tx
рј0	14	-	-	-	-	-	-	-	-	-	-	-	I2C1SCL
PJ1	87	-	-	-	-	-	-	-	-	-	-	-	I2C1SDA
РЈ2	39	-	-	-	-	-	-	-	-	-	CCP0	-	-

a. The digital signals that are shaded gray are the power-on default values for the corresponding GPIO pin.

Table 9-3. GPIO Pins and Alternate Functions (108BGA)

Ю	Pin	Analog			Digi	ital Functi	on (GPIO	PCTL PM	Cx Bit Fie	ld Encodii	ng) ^a		
10	FIII	Function	1	2	3	4	5	6	7	8	9	10	11
PA0	L3	-	U0Rx	-	-	-	-	-	-	I2C1SCL	U1Rx	-	-
PA1	МЗ	-	U0Tx	-	-	-	-	-	-	I2C1SDA	U1Tx	-	-
PA2	M4	-	SSI0Clk	-	-	-	-	-	-	-	-	-	-
PA3	L4	-	SSI0Fss	-	-	-	-	-	-	-	-	-	-
PA4	L5	-	SSI0Rx	-	-	-	-	-	-	-	-	-	-
PA5	M5	-	SSI0Tx	-	-	-	-	-	-	-	-	-	-
PA6	L6	-	I2C1SCL	CCP1	-	-	-	-	-	-	U1CTS	-	-
PA7	M6	-	I2C1SDA	CCP4	-	-	-	-	CCP3	-	U1DCD	-	-
PB0	E12	-	CCP0	-	-	-	U1Rx	-	-	-	-	-	-
PB1	D12	-	CCP2	-	-	CCP1	U1Tx	-	-	-	-	-	-
PB2	A11	-	I2C0SCL	-	-	CCP3	CCP0	-	-	-	-	-	-
PB3	E11	-	I2C0SDA	-	-	-	-	-	-	-	-	-	-
PB4	A6	C0-	-	-	-	U2Rx	-	-	U1Rx	-	-	-	-
PB5	В7	C1-	C0o	CCP5	-	CCP0	-	CCP2	UlTx	-	-	-	-
PB6	A7	VREFA C0+	CCP1	-	C0o	-	-	CCP5	-	-	-	-	-
PB7	A8	-	-	-	-	NMI	-	-	-	-	-	-	-
PC0	A9	-	-	-	TCK SWCLK	-	-	-	-	-	-	-	-
PC1	В9	-	-	-	TMS SWDIO	-	-	-	-	-	-	-	-
PC2	B8	-	-	-	TDI	-	-	-	-	-	-	-	-
PC3	A10	-	-	-	TDO SWO	-	-	-	-	-	-	-	-
PC4	L1	-	CCP5	-	-	-	CCP2	CCP4	-	-	CCP1	-	-
PC5	M1	C1+	CCP1	C1o	C0o	-	CCP3	-	-	-	-	-	-

Table 9-3. GPIO Pins and Alternate Functions (108BGA) (continued)

		Analog			Digi	tal Funct	ion (GPIO	PCTL PM	Cx Bit Fie	ld Encodi	ng) ^a		
Ю	Pin	Function	1	2	3	4	5	6	7	8	9	10	11
PC6	M2	-	CCP3	-	-	-	U1Rx	CCP0	-	-	-	-	-
PC7	L2	-	CCP4	-	-	CCP0	U1Tx	-	C1o	-	-	-	-
PD0	G1	-	-	-	-	U2Rx	U1Rx	-	-	-	U1CTS	-	-
PD1	G2	-	-	-	-	U2Tx	U1Tx	-	-	-	U1DCD	CCP2	-
PD2	H2	-	U1Rx	-	-	CCP5	-	-	-	-	-	-	-
PD3	H1	-	U1Tx	-	-	CCP0	-	-	-	-	-	-	-
PD4	B5	AIN7	CCP0	CCP3	-	-	-	-	-	-	U1RI	-	-
PD5	C6	AIN6	CCP2	CCP4	-	-	-	-	-	-	U2Rx	-	-
PD6	A3	AIN5	-	-	-	-	-	-	-	-	U2Tx	-	-
PD7	A2	AIN4	-	C0o	CCP1	-	-	-	-	-	U1DTR	-	-
PE0	B11	-	-	SSI1Clk	CCP3	-	-	-	-	-	-	-	-
PE1	A12	-	-	SSI1Fss	-	CCP2	-	-	-	-	-	-	-
PE2	A4	-	CCP4	SSI1Rx	-	-	CCP2	-	-	-	-	-	-
PE3	B4	-	CCP1	SSI1Tx	-	-	-	-	-	-	-	-	-
PE4	B2	AIN3	CCP3	-	-	-	U2Tx	CCP2	-	-	-	-	-
PE5	В3	AIN2	CCP5	-	-	-	-	-	-	-	-	-	-
PE6	A1	AIN1	-	C1o	-	-	-	-	-	-	U1CTS	-	-
PE7	B1	AIN0	-	-	-	-	-	-	-	-	U1DCD	-	-
PF0	M9	-	-	-	-	-	-	-	-	-	U1DSR	-	-
PF1	H12	-	-	-	-	-	-	-	-	-	U1RTS	CCP3	-
PF2	J11	-	-	-	-	-	-	-	-	-	SSI1Clk	-	-
PF3	J12	-	-	-	-	-	-	-	-	-	SSI1Fss	ı	-
PF4	L9	-	CCP0	C0o	-	-	-	-	-	-	SSI1Rx	-	-
PF5	L8	-	CCP2	Clo	-	-	-	-	-	-	SSI1Tx	ı	-
PF6	M8	-	CCP1	-	-	-	-	-	-	-	-	U1RTS	-
PF7	K4	-	CCP4	-	-	-	-	-	-	-	-	-	-
PG0	K1	-	U2Rx	-	I2C1SCL	-	-	-	-	-	-	-	-
PG1	K2	-	U2Tx	-	I2C1SDA	-	-	-	-	-	-	-	-
PG2	J1	-	-	-	-	-	-	-	-	-	-	-	-
PG3	J2	-	-	-	-	-	-	-	-	-	-	-	-
PG4	K3	-	CCP3	-	-	-	-	-	-	-	-	U1RI	-
PG5	M7	-	CCP5	-	-	-	-	-	-	-	-	U1DTR	-
PG6	L7	-	-	-	-	-	-	-	-	-	-	U1RI	-
PG7	C10	-	-	-	-	-	-	-	-	CCP5	-	ı	-
PH0	C9	-	-	-	-	-	-	-	-	-	-	ı	-
PH1	C8	-	-	-	-	-	-	-	-	-	-	-	-
PH2	D11	-	-	C1o	-	-	-	-	-	-	-	-	-
рн3	D10	-	-	-	-	-	-	-	-	-	-	-	-
PH4	B10	-	-	-	-	-	-	-	-	-	-	-	SSI1Clk
PH5	F10	-	-	-	-	-	-	-	-	-	-	-	SSI1Fss

Table 9-3. GPIO Pins and Alternate Functions (108BGA) (continued)

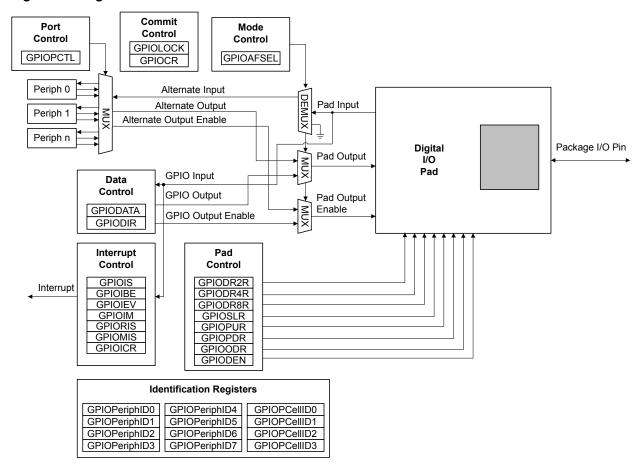
10	Pin	Analog		Digital Function (GPIOPCTL PMCx Bit Field Encoding) ^a										
10	FIII	Function	1	2	3	4	5	6	7	8	9	10	11	
РН6	G3	-	-	-	-	-	-	-	-	-	-	-	SSI1Rx	
PH7	НЗ	-	-	-	-	-	-	-	-	-	-	-	SSI1Tx	
рј0	F3	-	-	-	-	-	-	-	-	-	-	-	I2C1SCL	
PJ1	В6	-	-	-	-	-	-	-	-	-	-	-	I2C1SDA	
РЈ2	K6	-	-	-	-	-	i	-	-	-	CCP0	-	-	

a. The digital signals that are shaded gray are the power-on default values for the corresponding GPIO pin.

9.2 Functional Description

Each GPIO port is a separate hardware instantiation of the same physical block (see Figure 9-1 on page 394 and Figure 9-2 on page 395). The LM3S1J11 microcontroller contains nine ports and thus nine of these physical GPIO blocks. Note that not all pins may be implemented on every block. Some GPIO pins can function as I/O signals for the on-chip peripheral modules. For information on which GPIO pins are used for alternate hardware functions, refer to Table 18-5 on page 767.

Figure 9-1. Digital I/O Pads



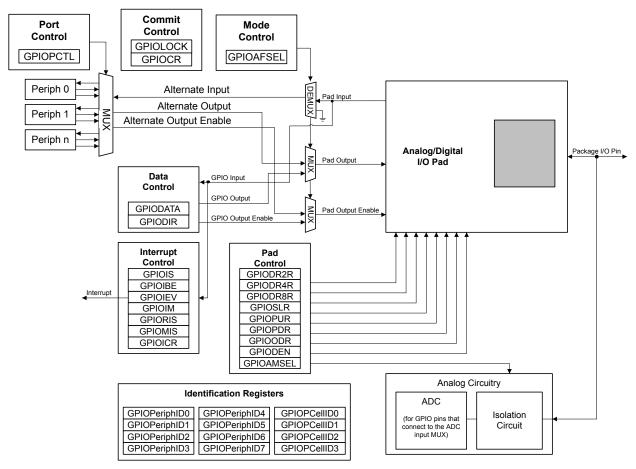


Figure 9-2. Analog/Digital I/O Pads

9.2.1 Data Control

The data control registers allow software to configure the operational modes of the GPIOs. The data direction register configures the GPIO as an input or an output while the data register either captures incoming data or drives it out to the pads.

Caution – It is possible to create a software sequence that prevents the debugger from connecting to the Stellaris® microcontroller. If the program code loaded into flash immediately changes the JTAG pins to their GPIO functionality, the debugger may not have enough time to connect and halt the controller before the JTAG pin functionality switches. As a result, the debugger may be locked out of the part. This issue can be avoided with a software routine that restores JTAG functionality based on an external or software trigger.

9.2.1.1 Data Direction Operation

The **GPIO Direction (GPIODIR)** register (see page 403) is used to configure each individual pin as an input or output. When the data direction bit is cleared, the GPIO is configured as an input, and the corresponding data register bit captures and stores the value on the GPIO port. When the data direction bit is set, the GPIO is configured as an output, and the corresponding data register bit is driven out on the GPIO port.

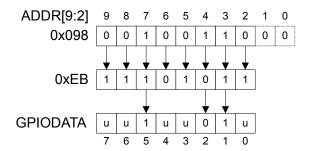
9.2.1.2 Data Register Operation

To aid in the efficiency of software, the GPIO ports allow for the modification of individual bits in the **GPIO Data (GPIODATA)** register (see page 402) by using bits [9:2] of the address bus as a mask. In this manner, software drivers can modify individual GPIO pins in a single instruction without affecting the state of the other pins. This method is more efficient than the conventional method of performing a read-modify-write operation to set or clear an individual GPIO pin. To implement this feature, the **GPIODATA** register covers 256 locations in the memory map.

During a write, if the address bit associated with that data bit is set, the value of the **GPIODATA** register is altered. If the address bit is cleared, the data bit is left unchanged.

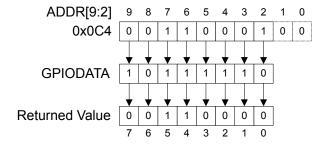
For example, writing a value of 0xEB to the address GPIODATA + 0x098 has the results shown in Figure 9-3, where u indicates that data is unchanged by the write.

Figure 9-3. GPIODATA Write Example



During a read, if the address bit associated with the data bit is set, the value is read. If the address bit associated with the data bit is cleared, the data bit is read as a zero, regardless of its actual value. For example, reading address GPIODATA + 0x0C4 yields as shown in Figure 9-4.

Figure 9-4. GPIODATA Read Example



9.2.2 Interrupt Control

The interrupt capabilities of each GPIO port are controlled by a set of seven registers. These registers are used to select the source of the interrupt, its polarity, and the edge properties. When one or more GPIO inputs cause an interrupt, a single interrupt output is sent to the interrupt controller for the entire GPIO port. For edge-triggered interrupts, software must clear the interrupt to enable any further interrupts. For a level-sensitive interrupt, the external source must hold the level constant for the interrupt to be recognized by the controller.

Three registers define the edge or sense that causes interrupts:

■ **GPIO Interrupt Sense (GPIOIS)** register (see page 404)

- GPIO Interrupt Both Edges (GPIOIBE) register (see page 405)
- GPIO Interrupt Event (GPIOIEV) register (see page 406)

Interrupts are enabled/disabled via the GPIO Interrupt Mask (GPIOIM) register (see page 407).

When an interrupt condition occurs, the state of the interrupt signal can be viewed in two locations: the **GPIO Raw Interrupt Status (GPIORIS)** and **GPIO Masked Interrupt Status (GPIOMIS)** registers (see page 408 and page 409). As the name implies, the **GPIOMIS** register only shows interrupt conditions that are allowed to be passed to the interrupt controller. The **GPIORIS** register indicates that a GPIO pin meets the conditions for an interrupt, but has not necessarily been sent to the interrupt controller.

Interrupts are cleared by writing a 1 to the appropriate bit of the **GPIO Interrupt Clear (GPIOICR)** register (see page 411).

When programming the interrupt control registers (**GPIOIS**, **GPIOIBE**, or **GPIOIEV**), the interrupts should be masked (**GPIOIM** cleared). Writing any value to an interrupt control register can generate a spurious interrupt if the corresponding bits are enabled.

9.2.2.1 ADC Trigger Source

In addition to providing GPIO functionality, PB4 can also be used as an external trigger for the ADC. If PB4 is configured as a non-masked interrupt pin (the appropriate bit of GPIOIM is set), an interrupt for Port B is generated, and an external trigger signal is sent to the ADC. If the **ADC Event Multiplexer Select (ADCEMUX)** register is configured to use the external trigger, an ADC conversion is initiated. See page 545.

If no other Port B pins are being used to generate interrupts, the **Interrupt 0-31 Set Enable (EN0)** register can disable the Port B interrupts, and the ADC interrupt can be used to read back the converted data. Otherwise, the Port B interrupt handler must ignore and clear interrupts on PB4 and wait for the ADC interrupt, or the ADC interrupt must be disabled in the **EN0** register and the Port B interrupt handler must poll the ADC registers until the conversion is completed. See page 111 for more information.

9.2.3 Mode Control

The GPIO pins can be controlled by either software or hardware. Software control is the default for most signals and corresponds to the GPIO mode, where the **GPIODATA** register is used to read or write the corresponding pins. When hardware control is enabled via the **GPIO Alternate Function Select (GPIOAFSEL)** register (see page 412), the pin state is controlled by its alternate function (that is, the peripheral).

Further pin muxing options are provided through the **GPIO Port Control (GPIOPCTL)** register which selects one of several peripheral functions for each GPIO. For information on the configuration options, refer to Table 18-5 on page 767.

Note: If any pin is to be used as an ADC input, the appropriate bit in the **GPIOAMSEL** register must be set to disable the analog isolation circuit.

9.2.4 Commit Control

The GPIO commit control registers provide a layer of protection against accidental programming of critical hardware peripherals. Protection is provided for the NMI pin (PB7) and the four JTAG/SWD pins (PC[3:0]). Writes to protected bits of the GPIO Alternate Function Select (GPIOAFSEL) register (see page 412), GPIO Pull Up Select (GPIOPUR) register (see page 418), GPIO Pull-Down Select (GPIOPDR) register (see page 420), and GPIO Digital Enable (GPIODEN) register (see

page 423) are not committed to storage unless the **GPIO Lock (GPIOLOCK)** register (see page 425) has been unlocked and the appropriate bits of the **GPIO Commit (GPIOCR)** register (see page 426) have been set.

9.2.5 Pad Control

The pad control registers allow software to configure the GPIO pads based on the application requirements. The pad control registers include the **GPIODR2R**, **GPIODR4R**, **GPIODR8R**, **GPIODDR**, **GPIOPUR**, **GPIOPDR**, **GPIOPDR**, and **GPIODEN** registers. These registers control drive strength, open-drain configuration, pull-up and pull-down resistors, slew-rate control and digital input enable for each GPIO.

9.2.6 Identification

The identification registers configured at reset allow software to detect and identify the module as a GPIO block. The identification registers include the **GPIOPeriphID0-GPIOPeriphID7** registers as well as the **GPIOPCeIIID0-GPIOPCeIIID3** registers.

9.3 Initialization and Configuration

The GPIO modules may be accessed via two different memory apertures. The legacy aperture, the Advanced Peripheral Bus (APB), is backwards-compatible with previous Stellaris parts. The other aperture, the Advanced High-Performance Bus (AHB), offers the same register map but provides better back-to-back access performance than the APB bus. These apertures are mutually exclusive. The aperture enabled for a given GPIO port is controlled by the appropriate bit in the **GPIOHBCTL** register (see page 209).

To use the pins in a particular GPIO port, the clock for the port must be enabled by setting the appropriate GPIO Port bit field (GPIOn) in the **RCGC2** register (see page 255).

When the internal POR signal is asserted and until otherwise configured, all GPIO pins are configured to be undriven (tristate): **GPIOAFSEL=**0, **GPIODEN=**0, **GPIOPDR=**0, and **GPIOPUR=**0, except for the pins shown in Table 9-1 on page 390. Table 9-4 on page 398 shows all possible configurations of the GPIO pads and the control register settings required to achieve them. Table 9-5 on page 399 shows how a rising edge interrupt is configured for pin 2 of a GPIO port.

Table 9-4. GPIO Pad Configuration Examples

Canfinumation	GPIO Reg	GPIO Register Bit Value ^a										
Configuration	AFSEL	DIR	ODR	DEN	PUR	PDR	DR2R	DR4R	DR8R	SLR		
Digital Input (GPIO)	0	0	0	1	?	?	Х	Х	Х	Х		
Digital Output (GPIO)	0	1	0	1	?	?	?	?	?	?		
Open Drain Output (GPIO)	0	1	1	1	Х	Х	?	?	?	?		
Open Drain Input/Output (I ² C)	1	Х	1	1	Х	Х	?	?	?	?		
Digital Input (Timer CCP)	1	Х	0	1	?	?	Х	Х	Х	Х		
Digital Output (Timer PWM)	1	Х	0	1	?	?	?	?	?	?		
Digital Input/Output (SSI)	1	Х	0	1	?	?	?	?	?	?		
Digital Input/Output (UART)	1	Х	0	1	?	?	?	?	?	?		

Table 9-4. GPIO Pad Configuration Examples (continued)

Configuration	GPIO Register Bit Value ^a									
Comiguration	AFSEL	DIR	ODR	DEN	PUR	PDR	DR2R	DR4R	DR8R	SLR
Analog Input (Comparator)	0	0	0	0	0	0	Х	Х	Х	Х
Digital Output (Comparator)	1	Х	0	1	?	?	?	?	?	?

a. X=Ignored (don't care bit)

Table 9-5. GPIO Interrupt Configuration Example

Register	Desired Interrupt	Pin 2 Bit Value ^a							
Register	Event Trigger	7	6	5	4	3	2	1	0
GPIOIS	0=edge 1=level	Х	Х	Х	Х	Х	0	Х	Х
GPIOIBE	0=single edge 1=both edges	Х	Х	Х	Х	Х	0	Х	Х
GPIOIEV	0=Low level, or falling edge 1=High level, or rising edge		Х	Х	Х	Х	1	Х	Х
GPIOIM	0=masked 1=not masked	0	0	0	0	0	1	0	0

a. X=Ignored (don't care bit)

9.4 Register Map

Table 9-7 on page 400 lists the GPIO registers. Each GPIO port can be accessed through one of two bus apertures. The legacy aperture, the Advanced Peripheral Bus (APB), is backwards-compatible with previous Stellaris parts. The other aperture, the Advanced High-Performance Bus (AHB), offers the same register map but provides better back-to-back access performance than the APB bus.

Important: The GPIO registers in this chapter are duplicated in each GPIO block; however, depending on the block, all eight bits may not be connected to a GPIO pad. In those cases, writing to unconnected bits has no effect, and reading unconnected bits returns no meaningful data.

The offset listed is a hexadecimal increment to the register's address, relative to that GPIO port's base address:

- GPIO Port A (APB): 0x4000.4000
- GPIO Port A (AHB): 0x4005.8000
- GPIO Port B (APB): 0x4000.5000
- GPIO Port B (AHB): 0x4005.9000
- GPIO Port C (APB): 0x4000.6000
- GPIO Port C (AHB): 0x4005.A000
- GPIO Port D (APB): 0x4000.7000
- GPIO Port D (AHB): 0x4005.B000
- GPIO Port E (APB): 0x4002.4000
- GPIO Port E (AHB): 0x4005.C000

^{?=}Can be either 0 or 1, depending on the configuration

- GPIO Port F (APB): 0x4002.5000
- GPIO Port F (AHB): 0x4005.D000
- GPIO Port G (APB): 0x4002.6000
- GPIO Port G (AHB): 0x4005.E000
- GPIO Port H (APB): 0x4002.7000
- GPIO Port H (AHB): 0x4005.F000
- GPIO Port J (APB): 0x4003.D000
- GPIO Port J (AHB): 0x4006.0000

Note that each GPIO module clock must be enabled before the registers can be programmed (see page 255). There must be a delay of 3 system clocks after the GPIO module clock is enabled before any GPIO module registers are accessed.

Important: All GPIO pins are configured as GPIOs and tri-stated by default (GPIOAFSEL=0, GPIODEN=0, GPIOPDR=0, GPIOPUR=0, and GPIOPCTL=0, with the exception of the pins shown in the table below. A Power-On-Reset (POR) or asserting RST puts the pins back to their default state.

Table 9-6. GPIO Pins With Non-Zero Reset Values

GPIO Pins	Default State	GPIOAFSEL	GPIODEN	GPIOPDR	GPIOPUR	GPIOPCTL
PA[1:0]	UART0	0	0	0	0	0x1
PA[5:2]	SSI0	0	0	0	0	0x2
PB[3:2]	I ² C0	0	0	0	0	0x3
PC[3:0]	JTAG/SWD	1	1	0	1	0x1

The default register type for the **GPIOCR** register is RO for all GPIO pins with the exception of the NMI pin and the four JTAG/SWD pins (PB7 and PC[3:0]). These five pins are the only GPIOs that are protected by the **GPIOCR** register. Because of this, the register type for GPIO Port B7 and GPIO Port C[3:0] is R/W.

The default reset value for the **GPIOCR** register is 0x0000.00FF for all GPIO pins, with the exception of the NMI pin and the four JTAG/SWD pins (PB7 and PC[3:0]). To ensure that the JTAG port is not accidentally programmed as GPIO pins, the PC[3:0] pins default to non-committable. Similarly, to ensure that the NMI pin is not accidentally programmed as a GPIO pin, the PB7 pin defaults to non-committable. Because of this, the default reset value of **GPIOCR** for GPIO Port B is 0x0000.007F while the default reset value of **GPIOCR** for Port C is 0x0000.00F0.

Table 9-7. GPIO Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	GPIODATA	R/W	0x0000.0000	GPIO Data	402
0x400	GPIODIR	R/W	0x0000.0000	GPIO Direction	403
0x404	GPIOIS	R/W	0x0000.0000	GPIO Interrupt Sense	404
0x408	GPIOIBE	R/W	0x0000.0000	GPIO Interrupt Both Edges	405
0x40C	GPIOIEV	R/W	0x0000.0000	GPIO Interrupt Event	406
0x410	GPIOIM	R/W	0x0000.0000	GPIO Interrupt Mask	407
0x414	GPIORIS	RO	0x0000.0000	GPIO Raw Interrupt Status	408

Table 9-7. GPIO Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0x418	GPIOMIS	RO	0x0000.0000	GPIO Masked Interrupt Status	409
0x41C	GPIOICR	W1C	0x0000.0000	GPIO Interrupt Clear	411
0x420	GPIOAFSEL	R/W	-	GPIO Alternate Function Select	412
0x500	GPIODR2R	R/W	0x0000.00FF	GPIO 2-mA Drive Select	414
0x504	GPIODR4R	R/W	0x0000.0000	GPIO 4-mA Drive Select	415
0x508	GPIODR8R	R/W	0x0000.0000	GPIO 8-mA Drive Select	416
0x50C	GPIOODR	R/W	0x0000.0000	GPIO Open Drain Select	417
0x510	GPIOPUR	R/W	-	GPIO Pull-Up Select	418
0x514	GPIOPDR	R/W	0x0000.0000	GPIO Pull-Down Select	420
0x518	GPIOSLR	R/W	0x0000.0000	GPIO Slew Rate Control Select	422
0x51C	GPIODEN	R/W	-	GPIO Digital Enable	423
0x520	GPIOLOCK	R/W	0x0000.0001	GPIO Lock	425
0x524	GPIOCR	-	-	GPIO Commit	426
0x528	GPIOAMSEL	R/W	0x0000.0000	GPIO Analog Mode Select	428
0x52C	GPIOPCTL	R/W	-	GPIO Port Control	430
0xFD0	GPIOPeriphID4	RO	0x0000.0000	GPIO Peripheral Identification 4	432
0xFD4	GPIOPeriphID5	RO	0x0000.0000	GPIO Peripheral Identification 5	433
0xFD8	GPIOPeriphID6	RO	0x0000.0000	GPIO Peripheral Identification 6	434
0xFDC	GPIOPeriphID7	RO	0x0000.0000	GPIO Peripheral Identification 7	435
0xFE0	GPIOPeriphID0	RO	0x0000.0061	GPIO Peripheral Identification 0	436
0xFE4	GPIOPeriphID1	RO	0x0000.0000	GPIO Peripheral Identification 1	437
0xFE8	GPIOPeriphID2	RO	0x0000.0018	GPIO Peripheral Identification 2	438
0xFEC	GPIOPeriphID3	RO	0x0000.0001	GPIO Peripheral Identification 3	439
0xFF0	GPIOPCellID0	RO	0x0000.000D	GPIO PrimeCell Identification 0	440
0xFF4	GPIOPCellID1	RO	0x0000.00F0	GPIO PrimeCell Identification 1	441
0xFF8	GPIOPCellID2	RO	0x0000.0005	GPIO PrimeCell Identification 2	442
0xFFC	GPIOPCellID3	RO	0x0000.00B1	GPIO PrimeCell Identification 3	443

9.5 Register Descriptions

The remainder of this section lists and describes the GPIO registers, in numerical order by address offset.

Register 1: GPIO Data (GPIODATA), offset 0x000

The **GPIODATA** register is the data register. In software control mode, values written in the **GPIODATA** register are transferred onto the GPIO port pins if the respective pins have been configured as outputs through the **GPIO Direction (GPIODIR)** register (see page 403).

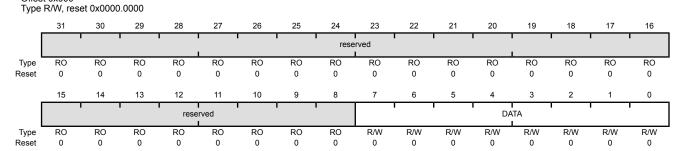
In order to write to **GPIODATA**, the corresponding bits in the mask, resulting from the address bus bits [9:2], must be set. Otherwise, the bit values remain unchanged by the write.

Similarly, the values read from this register are determined for each bit by the mask bit derived from the address used to access the data register, bits [9:2]. Bits that are set in the address mask cause the corresponding bits in **GPIODATA** to be read, and bits that are clear in the address mask cause the corresponding bits in **GPIODATA** to be read as 0, regardless of their value.

A read from **GPIODATA** returns the last bit value written if the respective pins are configured as outputs, or it returns the value on the corresponding input pin when these are configured as inputs. All bits are cleared by a reset.

GPIO Data (GPIODATA)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DATA	R/W	0x00	GPIO Data

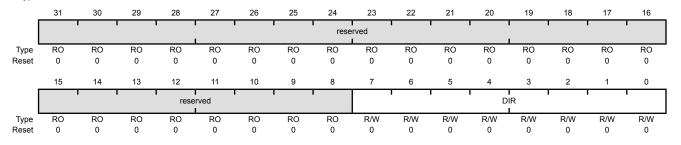
This register is virtually mapped to 256 locations in the address space. To facilitate the reading and writing of data to these registers by independent drivers, the data read from and written to the registers are masked by the eight address lines [9:2]. Reads from this register return its current state. Writes to this register only affect bits that are not masked by ADDR[9:2] and are configured as outputs. See "Data Register Operation" on page 396 for examples of reads and writes.

Register 2: GPIO Direction (GPIODIR), offset 0x400

The **GPIODIR** register is the data direction register. Setting a bit in the **GPIODIR** register configures the corresponding pin to be an output, while clearing a bit configures the corresponding pin to be an input. All bits are cleared by a reset, meaning all GPIO pins are inputs by default.

GPIO Direction (GPIODIR)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x400 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DIR	R/W	0x00	GPIO Data Direction

- 0 Corresponding pin is an input.
- 1 Corresponding pins is an output.

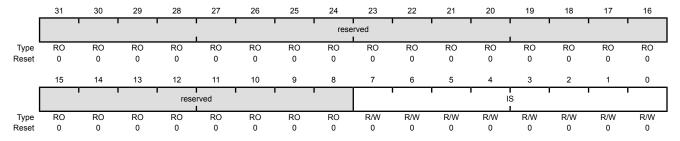
Register 3: GPIO Interrupt Sense (GPIOIS), offset 0x404

The **GPIOIS** register is the interrupt sense register. Setting a bit in the **GPIOIS** register configures the corresponding pin to detect levels, while clearing a bit configures the corresponding pin to detect edges. All bits are cleared by a reset.

GPIO Interrupt Sense (GPIOIS)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x404

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IS	R/W	0x00	GPIO Interrupt Sense

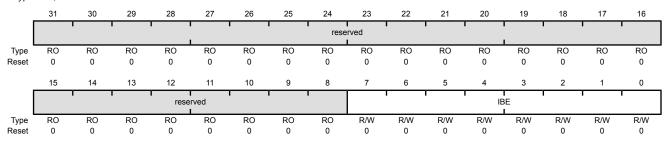
- The edge on the corresponding pin is detected (edge-sensitive).
- 1 The level on the corresponding pin is detected (level-sensitive).

Register 4: GPIO Interrupt Both Edges (GPIOIBE), offset 0x408

The **GPIOIBE** register allows both edges to cause interrupts. When the corresponding bit in the **GPIO Interrupt Sense (GPIOIS)** register (see page 404) is set to detect edges, setting a bit in the **GPIOIBE** register configures the corresponding pin to detect both rising and falling edges, regardless of the corresponding bit in the **GPIO Interrupt Event (GPIOIEV)** register (see page 406). Clearing a bit configures the pin to be controlled by the **GPIOIEV** register. All bits are cleared by a reset.

GPIO Interrupt Both Edges (GPIOIBE)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x408 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IBE	R/W	0x00	GPIO Interrupt Both Edges

- 0 Interrupt generation is controlled by the GPIO Interrupt Event (GPIOIEV) register (see page 406).
- 1 Both edges on the corresponding pin trigger an interrupt.

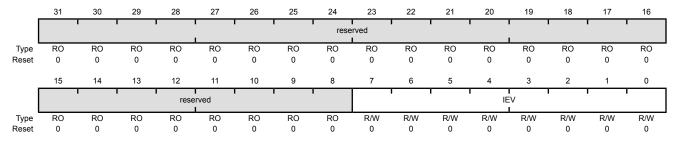
Register 5: GPIO Interrupt Event (GPIOIEV), offset 0x40C

The **GPIOIEV** register is the interrupt event register. Setting a bit in the **GPIOIEV** register configures the corresponding pin to detect rising edges or high levels, depending on the corresponding bit value in the **GPIO Interrupt Sense (GPIOIS)** register (see page 404). Clearing a bit configures the pin to detect falling edges or low levels, depending on the corresponding bit value in the **GPIOIS** register. All bits are cleared by a reset.

GPIO Interrupt Event (GPIOIEV)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x40C

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IEV	R/W	0x00	GPIO Interrupt Event

- 0 A falling edge or a Low level on the corresponding pin triggers an interrupt.
- A rising edge or a High level on the corresponding pin triggers an interrupt.

Register 6: GPIO Interrupt Mask (GPIOIM), offset 0x410

The **GPIOIM** register is the interrupt mask register. Setting a bit in the **GPIOIM** register allows interrupts that are generated by the corresponding pin to be sent to the interrupt controller on the combined interrupt signal. Clearing a bit prevents an interrupt on the corresponding pin from being sent to the interrupt controller. All bits are cleared by a reset.

GPIO Interrupt Mask (GPIOIM)

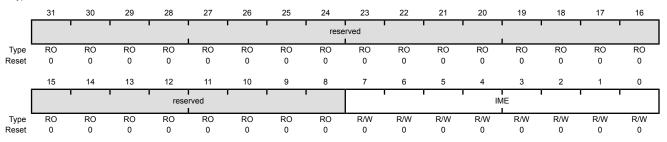
GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x410 Type R/W, reset 0x0000.0000

Bit/Field

Name

Type

Reset



Ditt icia	Hamo	Турс	110001	Beschiption
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IME	R/W	0x00	GPIO Interrupt Mask Enable

Description

- 0 The interrupt from the corresponding pin is masked.
- The interrupt from the corresponding pin is sent to the interrupt controller.

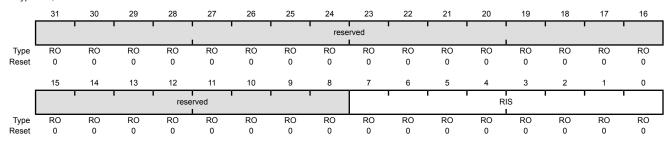
Register 7: GPIO Raw Interrupt Status (GPIORIS), offset 0x414

The **GPIORIS** register is the raw interrupt status register. A bit in this register is set when an interrupt condition occurs on the corresponding GPIO pin. If the corresponding bit in the **GPIO Interrupt Mask (GPIOIM)** register (see page 407) is set, the interrupt is sent to the interrupt controller. Bits read as zero indicate that corresponding input pins have not initiated an interrupt. A bit in this register can be cleared by writing a 1 to the corresponding bit in the **GPIO Interrupt Clear (GPIOICR)** register.

GPIO Raw Interrupt Status (GPIORIS)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x414

Type RO, reset 0x0000.0000



Bit/Field	Name	туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	RIS	RO	0x00	GPIO Interrupt Raw Status

Value Description

- 1 An interrupt condition has occurred on the corresponding pin.
- O An interrupt condition has not occurred on the corresponding pin.

A bit is cleared by writing a 1 to the corresponding bit in the **GPIOICR** register.

Register 8: GPIO Masked Interrupt Status (GPIOMIS), offset 0x418

The **GPIOMIS** register is the masked interrupt status register. If a bit is set in this register, the corresponding interrupt has triggered an interrupt to the interrupt controller. If a bit is clear, either no interrupt has been generated, or the interrupt is masked.

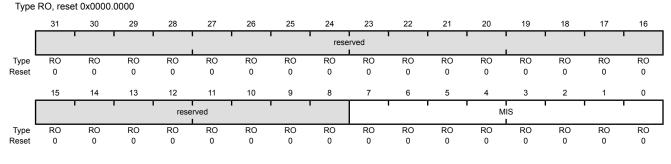
In addition to providing GPIO functionality, PB4 can also be used as an external trigger for the ADC. If PB4 is configured as a non-masked interrupt pin (the appropriate bit of GPIOIM is set), an interrupt for Port B is generated, and an external trigger signal is sent to the ADC. If the **ADC Event Multiplexer Select (ADCEMUX)** register is configured to use the external trigger, an ADC conversion is initiated. See page 545.

If no other Port B pins are being used to generate interrupts, the **Interrupt 0-31 Set Enable (EN0)** register can disable the Port B interrupts, and the ADC interrupt can be used to read back the converted data. Otherwise, the Port B interrupt handler must ignore and clear interrupts on PB4 and wait for the ADC interrupt, or the ADC interrupt must be disabled in the **EN0** register and the Port B interrupt handler must poll the ADC registers until the conversion is completed. See page 111 for more information.

GPIOMIS is the state of the interrupt after masking.

GPIO Masked Interrupt Status (GPIOMIS)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002,7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x418



Bit/Field Name Type Reset Description

31:8 reserved RO 0 Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

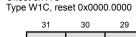
Bit/Field	Name	Туре	Reset	Description
7:0	MIS	RO	0x00	GPIO Masked Interrupt Status
				Value Description
				An interrupt condition on the corresponding pin has triggered an interrupt to the interrupt controller.
				O An interrupt condition on the corresponding pin is masked or has not occurred.
				A bit is cleared by writing a 1 to the corresponding bit in the GPIOICR register.

Register 9: GPIO Interrupt Clear (GPIOICR), offset 0x41C

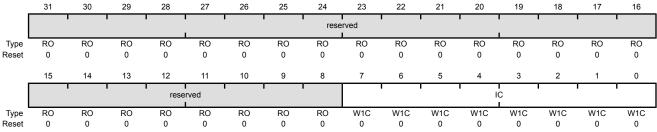
The GPIOICR register is the interrupt clear register. Writing a 1 to a bit in this register clears the corresponding interrupt bit in the GPIORIS and GPIOMIS registers. Writing a 0 has no effect.

GPIO Interrupt Clear (GPIOICR)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000



Offset 0x41C



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IC	W1C	0x00	GPIO Interrupt Clear

- The corresponding interrupt is cleared.
- 0 The corresponding interrupt is unaffected.

Register 10: GPIO Alternate Function Select (GPIOAFSEL), offset 0x420

The **GPIOAFSEL** register is the mode control select register. If a bit is clear, the pin is used as a GPIO and is controlled by the GPIO registers. Setting a bit in this register configures the corresponding GPIO line to be controlled by an associated peripheral. Several possible peripheral functions are multiplexed on each GPIO. The **GPIO Port Control (GPIOPCTL)** register is used to select one of the possible functions. Table 18-5 on page 767 details which functions are muxed on each GPIO pin. The reset value for this register is 0x0000.0000 for GPIO ports that are not listed in the table below.

Important: All GPIO pins are configured as GPIOs and tri-stated by default (GPIOAFSEL=0, GPIODEN=0, GPIOPDR=0, GPIOPUR=0, and GPIOPCTL=0, with the exception of the pins shown in the table below. A Power-On-Reset (POR) or asserting RST puts the pins back to their default state.

Table 9-8. GPIO Pins With Non-Zero Reset Values

GPIO Pins	Default State	GPIOAFSEL	GPIODEN	GPIOPDR	GPIOPUR	GPIOPCTL
PA[1:0]	UART0	0	0	0	0	0x1
PA[5:2]	SSI0	0	0	0	0	0x2
PB[3:2]	I ² C0	0	0	0	0	0x3
PC[3:0]	JTAG/SWD	1	1	0	1	0x1

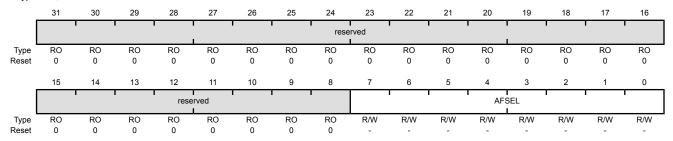
Caution – It is possible to create a software sequence that prevents the debugger from connecting to the Stellaris microcontroller. If the program code loaded into flash immediately changes the JTAG pins to their GPIO functionality, the debugger may not have enough time to connect and halt the controller before the JTAG pin functionality switches. As a result, the debugger may be locked out of the part. This issue can be avoided with a software routine that restores JTAG functionality based on an external or software trigger.

The GPIO commit control registers provide a layer of protection against accidental programming of critical hardware peripherals. Protection is provided for the NMI pin (PB7) and the four JTAG/SWD pins (PC[3:0]). Writes to protected bits of the GPIO Alternate Function Select (GPIOAFSEL) register (see page 412), GPIO Pull Up Select (GPIOPUR) register (see page 418), GPIO Pull-Down Select (GPIOPDR) register (see page 420), and GPIO Digital Enable (GPIODEN) register (see page 423) are not committed to storage unless the GPIO Lock (GPIOLOCK) register (see page 425) has been unlocked and the appropriate bits of the GPIO Commit (GPIOCR) register (see page 426) have been set.

When using the I²C module, in addition to setting the **GPIOAFSEL** register bits for the I²C clock and data pins, the data pins should be set to open drain using the **GPIO Open Drain Select** (**GPIOODR**) register (see examples in "Initialization and Configuration" on page 398).

GPIO Alternate Function Select (GPIOAFSEL)

GPIO Port A (APB) base: 0x4000.4000
GPIO Port A (AHB) base: 0x4005.8000
GPIO Port B (APB) base: 0x4005.8000
GPIO Port B (APB) base: 0x4005.9000
GPIO Port C (APB) base: 0x4000.6000
GPIO Port C (APB) base: 0x4000.6000
GPIO Port C (AHB) base: 0x4000.7000
GPIO Port D (AHB) base: 0x4005.8000
GPIO Port D (AHB) base: 0x4005.8000
GPIO Port E (APB) base: 0x4005.8000
GPIO Port E (AHB) base: 0x4005.000
GPIO Port E (AHB) base: 0x4002.5000
GPIO Port F (AHB) base: 0x4005.5000
GPIO Port F (AHB) base: 0x4005.5000
GPIO Port G (APB) base: 0x4005.5000
GPIO Port G (AHB) base: 0x4005.5000
GPIO Port G (AHB) base: 0x4005.5000
GPIO Port G (AHB) base: 0x4002.7000
GPIO Port H (AHB) base: 0x4002.7000
GPIO Port H (AHB) base: 0x4003.5000
GPIO Port J (AHB) base: 0x4003.0000
GPIO Port J (AHB) base: 0x4006.0000
GPIO Port J (AHB) base: 0x4006.0000
GFISET 0x420
Type R/W, reset -



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	AFSEL	R/W	-	GPIO Alternate Function Select

Value Description

- The associated pin functions as a GPIO and is controlled by the GPIO registers.
- The associated pin functions as a peripheral signal and is controlled by the alternate hardware function.

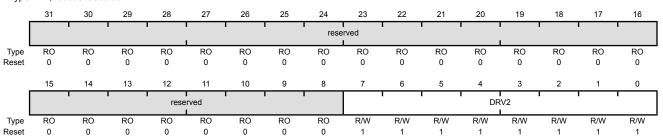
The reset value for this register is 0x0000.0000 for GPIO ports that are not listed in Table 9-1 on page 390.

Register 11: GPIO 2-mA Drive Select (GPIODR2R), offset 0x500

The **GPIODR2R** register is the 2-mA drive control register. Each GPIO signal in the port can be individually configured without affecting the other pads. When setting the DRV2 bit for a GPIO signal, the corresponding DRV4 bit in the **GPIODR4R** register and DRV8 bit in the **GPIODR8R** register are automatically cleared by hardware. By default, all GPIO pins have 2-mA drive.

GPIO 2-mA Drive Select (GPIODR2R)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x500 Type R/W, reset 0x0000.00FF



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DRV2	R/W	0xFF	Output Pad 2-mA Drive Enable

Value Description

- 1 The corresponding GPIO pin has 2-mA drive.
- The drive for the corresponding GPIO pin is controlled by the GPIODR4R or GPIODR8R register.

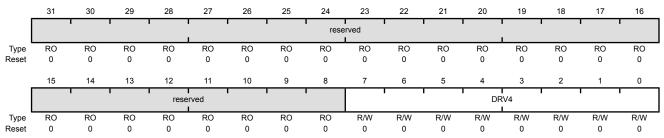
Setting a bit in either the **GPIODR4** register or the **GPIODR8** register clears the corresponding 2-mA enable bit. The change is effective on the second clock cycle after the write if accessing GPIO via the APB memory aperture. If using AHB access, the change is effective on the next clock cycle.

Register 12: GPIO 4-mA Drive Select (GPIODR4R), offset 0x504

The GPIODR4R register is the 4-mA drive control register. Each GPIO signal in the port can be individually configured without affecting the other pads. When setting the DRV4 bit for a GPIO signal, the corresponding DRV2 bit in the GPIODR2R register and DRV8 bit in the GPIODR8R register are automatically cleared by hardware.

GPIO 4-mA Drive Select (GPIODR4R)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x504 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DRV4	R/W	0x00	Output Pad 4-mA Drive Enable

Value Description

- The corresponding GPIO pin has 4-mA drive.
- 0 The drive for the corresponding GPIO pin is controlled by the GPIODR2R or GPIODR8R register.

Setting a bit in either the GPIODR2 register or the GPIODR8 register clears the corresponding 4-mA enable bit. The change is effective on the second clock cycle after the write if accessing GPIO via the APB memory aperture. If using AHB access, the change is effective on the next clock cycle.

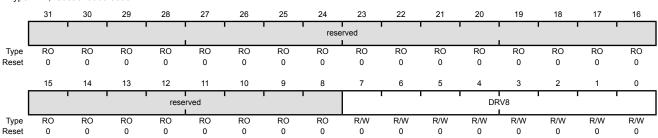
Register 13: GPIO 8-mA Drive Select (GPIODR8R), offset 0x508

The **GPIODR8R** register is the 8-mA drive control register. Each GPIO signal in the port can be individually configured without affecting the other pads. When setting the DRV8 bit for a GPIO signal, the corresponding DRV2 bit in the **GPIODR2R** register and DRV4 bit in the **GPIODR4R** register are automatically cleared by hardware. The 8-mA setting is also used for high-current operation.

Note: There is no configuration difference between 8-mA and high-current operation. The additional current capacity results from a shift in the V_{OH}/V_{OL} levels. See "Recommended Operating Conditions" on page 797 for further information.

GPIO 8-mA Drive Select (GPIODR8R)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port F (APR) base: 0x4002 4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x508 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DRV8	R/W	0x00	Output Pad 8-mA Drive Enable

Value Description

- 1 The corresponding GPIO pin has 8-mA drive.
- The drive for the corresponding GPIO pin is controlled by the GPIODR2R or GPIODR4R register.

Setting a bit in either the **GPIODR2** register or the **GPIODR4** register clears the corresponding 8-mA enable bit. The change is effective on the second clock cycle after the write if accessing GPIO via the APB memory aperture. If using AHB access, the change is effective on the next clock cycle.

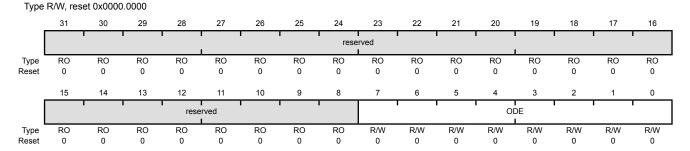
Register 14: GPIO Open Drain Select (GPIOODR), offset 0x50C

The **GPIOODR** register is the open drain control register. Setting a bit in this register enables the open-drain configuration of the corresponding GPIO pad. When open-drain mode is enabled, the corresponding bit should also be set in the **GPIO Digital Enable (GPIODEN)** register (see page 423). Corresponding bits in the drive strength and slew rate control registers (**GPIODR2R**, **GPIODR4R**, **GPIODR8R**, and **GPIOSLR**) can be set to achieve the desired rise and fall times. The GPIO acts as an input if the corresponding bit in the **GPIODIR** register is cleared. If open drain is selected while the GPIO is configured as an input, the GPIO will remain an input and the open-drain selection has no effect until the GPIO is changed to an output.

When using the I²C module, in addition to configuring the pin to open drain, the **GPIO Alternate Function Select (GPIOAFSEL)** register bits for the I²C clock and data pins should be set (see examples in "Initialization and Configuration" on page 398).

GPIO Open Drain Select (GPIOODR)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x50C



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	ODE	R/W	0x00	Output Pad Open Drain Enable

- 1 The corresponding pin is configured as open drain.
- 0 The corresponding pin is not configured as open drain.

Register 15: GPIO Pull-Up Select (GPIOPUR), offset 0x510

The **GPIOPUR** register is the pull-up control register. When a bit is set, a weak pull-up resistor on the corresponding GPIO signal is enabled. Setting a bit in **GPIOPUR** automatically clears the corresponding bit in the **GPIO Pull-Down Select (GPIOPDR)** register (see page 420). Write access to this register is protected with the **GPIOCR** register. Bits in **GPIOCR** that are cleared prevent writes to the equivalent bit in this register.

Important: All GPIO pins are configured as GPIOs and tri-stated by default (GPIOAFSEL=0, GPIODEN=0, GPIOPDR=0, GPIOPUR=0, and GPIOPCTL=0, with the exception of the pins shown in the table below. A Power-On-Reset (POR) or asserting RST puts the pins back to their default state.

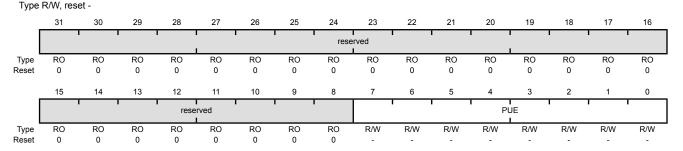
Table 9-9. GPIO Pins With Non-Zero Reset Values

GPIO Pins	Default State	GPIOAFSEL	GPIODEN	GPIOPDR	GPIOPUR	GPIOPCTL
PA[1:0]	UART0	0	0	0	0	0x1
PA[5:2]	SSI0	0	0	0	0	0x2
PB[3:2]	I ² C0	0	0	0	0	0x3
PC[3:0]	JTAG/SWD	1	1	0	1	0x1

Note: The GPIO commit control registers provide a layer of protection against accidental programming of critical hardware peripherals. Protection is provided for the NMI pin (PB7) and the four JTAG/SWD pins (PC[3:0]). Writes to protected bits of the GPIO Alternate Function Select (GPIOAFSEL) register (see page 412), GPIO Pull Up Select (GPIOPUR) register (see page 418), GPIO Pull-Down Select (GPIOPDR) register (see page 420), and GPIO Digital Enable (GPIODEN) register (see page 423) are not committed to storage unless the GPIO Lock (GPIOLOCK) register (see page 425) has been unlocked and the appropriate bits of the GPIO Commit (GPIOCR) register (see page 426) have been set.

GPIO Pull-Up Select (GPIOPUR)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x510



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PUE	R/W	-	Pad Weak Pull-Up Enable
				Value Description The corresponding pin's weak pull-up resistor is disabled.
				1 The corresponding pin's weak pull-up resistor is enabled

1 The corresponding pin's weak pull-up resistor is enabled.

Setting a bit in the **GPIOPDR** register clears the corresponding bit in the **GPIOPUR** register. The change is effective on the second clock cycle after the write if accessing GPIO via the APB memory aperture. If using AHB access, the change is effective on the next clock cycle.

The reset value for this register is 0x0000.0000 for GPIO ports that are not listed in Table 9-1 on page 390.

Register 16: GPIO Pull-Down Select (GPIOPDR), offset 0x514

The **GPIOPDR** register is the pull-down control register. When a bit is set, a weak pull-down resistor on the corresponding GPIO signal is enabled. Setting a bit in **GPIOPDR** automatically clears the corresponding bit in the **GPIO Pull-Up Select (GPIOPUR)** register (see page 418).

Important: All GPIO pins are configured as GPIOs and tri-stated by default (GPIOAFSEL=0, GPIODEN=0, GPIOPDR=0, GPIOPUR=0, and GPIOPCTL=0, with the exception of the pins shown in the table below. A Power-On-Reset (POR) or asserting RST puts the pins back to their default state.

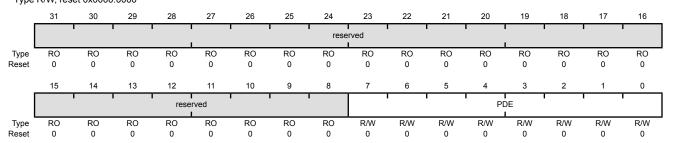
Table 9-10. GPIO Pins With Non-Zero Reset Values

GPIO Pins	Default State	GPIOAFSEL	GPIODEN	GPIOPDR	GPIOPUR	GPIOPCTL
PA[1:0]	UART0	0	0	0	0	0x1
PA[5:2]	SSI0	0	0	0	0	0x2
PB[3:2]	I ² C0	0	0	0	0	0x3
PC[3:0]	JTAG/SWD	1	1	0	1	0x1

Note: The GPIO commit control registers provide a layer of protection against accidental programming of critical hardware peripherals. Protection is provided for the NMI pin (PB7) and the four JTAG/SWD pins (PC[3:0]). Writes to protected bits of the GPIO Alternate Function Select (GPIOAFSEL) register (see page 412), GPIO Pull Up Select (GPIOPUR) register (see page 418), GPIO Pull-Down Select (GPIOPDR) register (see page 420), and GPIO Digital Enable (GPIODEN) register (see page 423) are not committed to storage unless the GPIO Lock (GPIOLOCK) register (see page 425) has been unlocked and the appropriate bits of the GPIO Commit (GPIOCR) register (see page 426) have been set.

GPIO Pull-Down Select (GPIOPDR)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x514 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PDE	R/W	0x00	Pad Weak Pull-Down Enable

Value Description

- The corresponding pin's weak pull-down resistor is disabled.
- 1 The corresponding pin's weak pull-down resistor is enabled.

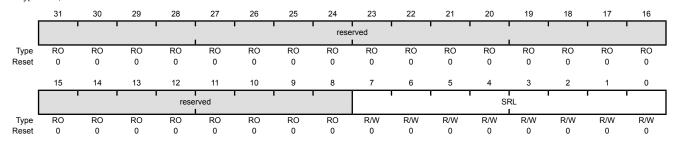
Setting a bit in the **GPIOPUR** register clears the corresponding bit in the **GPIOPDR** register. The change is effective on the second clock cycle after the write if accessing GPIO via the APB memory aperture. If using AHB access, the change is effective on the next clock cycle.

Register 17: GPIO Slew Rate Control Select (GPIOSLR), offset 0x518

The **GPIOSLR** register is the slew rate control register. Slew rate control is only available when using the 8-mA drive strength option via the **GPIO 8-mA Drive Select (GPIODR8R)** register (see page 416).

GPIO Slew Rate Control Select (GPIOSLR)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x518 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	SRL	R/W	0x00	Slew Rate Limit Enable (8-mA drive only)

- 1 Slew rate control is enabled for the corresponding pin.
- O Slew rate control is disabled for the corresponding pin.

Register 18: GPIO Digital Enable (GPIODEN), offset 0x51C

Note: Pins configured as digital inputs are Schmitt-triggered.

The **GPIODEN** register is the digital enable register. By default, all GPIO signals except those listed below are configured out of reset to be undriven (tristate). Their digital function is disabled; they do not drive a logic value on the pin and they do not allow the pin voltage into the GPIO receiver. To use the pin as a digital input or output (either GPIO or alternate function), the corresponding GPIODEN bit must be set.

Important: All GPIO pins are configured as GPIOs and tri-stated by default (GPIOAFSEL=0, GPIODEN=0, GPIOPDR=0, GPIOPUR=0, and GPIOPCTL=0, with the exception of the pins shown in the table below. A Power-On-Reset (POR) or asserting RST puts the pins back to their default state.

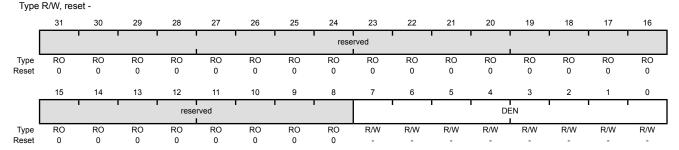
Table 9-11. GPIO Pins With Non-Zero Reset Values

GPIO Pins	Default State	GPIOAFSEL	GPIODEN	GPIOPDR	GPIOPUR	GPIOPCTL
PA[1:0]	UART0	0	0	0	0	0x1
PA[5:2]	SSI0	0	0	0	0	0x2
PB[3:2]	I ² C0	0	0	0	0	0x3
PC[3:0]	JTAG/SWD	1	1	0	1	0x1

Note: The GPIO commit control registers provide a layer of protection against accidental programming of critical hardware peripherals. Protection is provided for the NMI pin (PB7) and the four JTAG/SWD pins (PC[3:0]). Writes to protected bits of the GPIO Alternate Function Select (GPIOAFSEL) register (see page 412), GPIO Pull Up Select (GPIOPUR) register (see page 418), GPIO Pull-Down Select (GPIOPDR) register (see page 420), and GPIO Digital Enable (GPIODEN) register (see page 423) are not committed to storage unless the GPIO Lock (GPIOLOCK) register (see page 425) has been unlocked and the appropriate bits of the GPIO Commit (GPIOCR) register (see page 426) have been set.

GPIO Digital Enable (GPIODEN)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4005.B000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (APB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4005.F000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (APB) base: 0x4006.0000 Offset 0x51C



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DEN	R/W	-	Digital Enable

- 0 The digital functions for the corresponding pin are disabled.
- The digital functions for the corresponding pin are enabled.

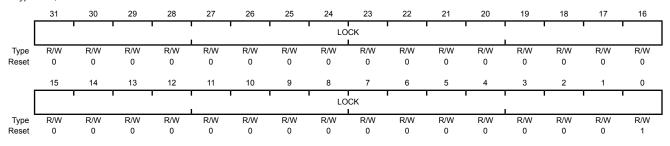
 The reset value for this register is 0x0000.0000 for GPIO ports that are not listed in Table 9-1 on page 390.

Register 19: GPIO Lock (GPIOLOCK), offset 0x520

The **GPIOLOCK** register enables write access to the **GPIOCR** register (see page 426). Writing 0x4C4F.434B to the **GPIOLOCK** register unlocks the **GPIOCR** register. Writing any other value to the **GPIOLOCK** register re-enables the locked state. Reading the **GPIOLOCK** register returns the lock status rather than the 32-bit value that was previously written. Therefore, when write accesses are disabled, or locked, reading the **GPIOLOCK** register returns 0x0000.0001. When write accesses are enabled, or unlocked, reading the **GPIOLOCK** register returns 0x0000.0000.

GPIO Lock (GPIOLOCK)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x520 Type R/W, reset 0x0000.0001



Bit/Field	Name	Type	Reset	Description
31:0	LOCK	R/W	0x0000 0001	GPIO Lock

A write of the value 0x4C4F.434B unlocks the **GPIO Commit (GPIOCR)** register for write access.A write of any other value or a write to the **GPIOCR** register reapplies the lock, preventing any register updates.

A read of this register returns the following values:

Value Description

0x1 The **GPIOCR** register is locked and may not be modified.

0x0 The **GPIOCR** register is unlocked and may be modified.

Register 20: GPIO Commit (GPIOCR), offset 0x524

The GPIOCR register is the commit register. The value of the GPIOCR register determines which bits of the GPIOAFSEL, GPIOPUR, GPIOPDR, and GPIODEN registers are committed when a write to these registers is performed. If a bit in the **GPIOCR** register is cleared, the data being written to the corresponding bit in the GPIOAFSEL, GPIOPUR, GPIOPDR, or GPIODEN registers cannot be committed and retains its previous value. If a bit in the **GPIOCR** register is set, the data being written to the corresponding bit of the GPIOAFSEL, GPIOPUR, GPIOPDR, or GPIODEN registers is committed to the register and reflects the new value.

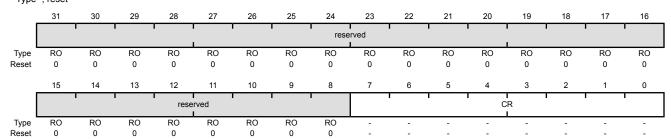
The contents of the GPIOCR register can only be modified if the status in the GPIOLOCK register is unlocked. Writes to the GPIOCR register are ignored if the status in the GPIOLOCK register is locked.

Important: This register is designed to prevent accidental programming of the registers that control connectivity to the NMI and JTAG/SWD debug hardware. By initializing the bits of the GPIOCR register to 0 for PB7 and PC[3:0], the NMI and JTAG/SWD debug port can only be converted to GPIOs through a deliberate set of writes to the **GPIOLOCK**, **GPIOCR**, and the corresponding registers.

> Because this protection is currently only implemented on the NMI and JTAG/SWD pins on PB7 and PC[3:0], all of the other bits in the GPIOCR registers cannot be written with 0x0. These bits are hardwired to 0x1, ensuring that it is always possible to commit new values to the GPIOAFSEL, GPIOPUR, GPIOPDR, or GPIODEN register bits of these other pins.

GPIO Commit (GPIOCR)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x524 Type -, reset



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CR	-	_	GPIO Commit

Value Description

- The corresponding GPIOAFSEL, GPIOPUR, GPIOPDR, or GPIODEN bits can be written.
- The corresponding GPIOAFSEL, GPIOPUR, GPIOPDR, or GPIODEN bits cannot be written.

Note:

The default register type for the **GPIOCR** register is RO for all GPIO pins with the exception of the NMI pin and the four JTAG/SWD pins (PB7 and PC[3:0]). These five pins are the only GPIOs that are protected by the **GPIOCR** register. Because of this, the register type for GPIO Port B7 and GPIO Port C[3:0] is R/W.

The default reset value for the **GPIOCR** register is 0x0000.00FF for all GPIO pins, with the exception of the NMI pin and the four JTAG/SWD pins (PB7 and PC[3:0]). To ensure that the JTAG port is not accidentally programmed as GPIO pins, the PC[3:0] pins default to non-committable. Similarly, to ensure that the NMI pin is not accidentally programmed as a GPIO pin, the PB7 pin defaults to non-committable. Because of this, the default reset value of **GPIOCR** for GPIO Port B is 0x0000.007F while the default reset value of **GPIOCR** for Port C is 0x0000.00FO.

Register 21: GPIO Analog Mode Select (GPIOAMSEL), offset 0x528

Important: This register is only valid for ports D and E; the corresponding base addresses for the remaining ports are not valid.

If any pin is to be used as an ADC input, the appropriate bit in **GPIOAMSEL** must be set to disable the analog isolation circuit.

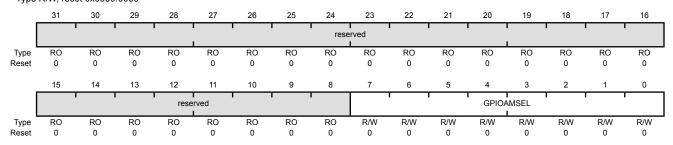
The **GPIOAMSEL** register controls isolation circuits to the analog side of a unified I/O pad. Because the GPIOs may be driven by a 5-V source and affect analog operation, analog circuitry requires isolation from the pins when they are not used in their analog function.

Each bit of this register controls the isolation circuitry for the corresponding GPIO signal. For information on which GPIO pins can be used for ADC functions, refer to Table 18-5 on page 767.

GPIO Analog Mode Select (GPIOAMSEL)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0x528

Type R/W, reset 0x0000.0000



Bit/Field Name Type Reset Description

31:8 reserved RO 0x0000.00 Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Type	Reset	Description
7:0	GPIOAMSEL	R/W	0x00	GPIO Analog Mode Select

Value Description

- 1 The analog function of the pin is enabled, the isolation is disabled, and the pin is capable of analog functions.
- The analog function of the pin is disabled, the isolation is enabled, and the pin is capable of digital functions as specified by the other GPIO configuration registers.

Note: This register and bits are only valid for GPIO signals that share analog function through a unified I/O pad.

The reset state of this register is 0 for all signals.

Register 22: GPIO Port Control (GPIOPCTL), offset 0x52C

The **GPIOPCTL** register is used in conjunction with the **GPIOAFSEL** register and selects the specific peripheral signal for each GPIO pin when using the alternate function mode. Most bits in the **GPIOAFSEL** register are cleared on reset, therefore most GPIO pins are configured as GPIOs by default. When a bit is set in the **GPIOAFSEL** register, the corresponding GPIO signal is controlled by an associated peripheral. The **GPIOPCTL** register selects one out of a set of peripheral functions for each GPIO, providing additional flexibility in signal definition. For information on the defined encodings for the bit fields in this register, refer to Table 18-5 on page 767. The reset value for this register is 0x0000.0000 for GPIO ports that are not listed in the table below.

Note: If the same signal is assigned to two different GPIO port pins, the signal is assigned to the port with the lowest letter and the assignment to the higher letter port is ignored.

Important: All GPIO pins are configured as GPIOs and tri-stated by default (GPIOAFSEL=0, GPIODEN=0, GPIOPDR=0, GPIOPUR=0, and GPIOPCTL=0, with the exception of the pins shown in the table below. A Power-On-Reset (POR) or asserting RST puts the pins back to their default state.

Table 9-12. GPIO Pins With Non-Zero Reset Values

GPIO Pins	Default State	GPIOAFSEL	GPIODEN	GPIOPDR	GPIOPUR	GPIOPCTL
PA[1:0]	UART0	0	0	0	0	0x1
PA[5:2]	SSI0	0	0	0	0	0x2
PB[3:2]	I ² C0	0	0	0	0	0x3
PC[3:0]	JTAG/SWD	1	1	0	1	0x1

GPIO Port Control (GPIOPCTL) GPIO Port A (APB) base: 0x4000.4000

GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000

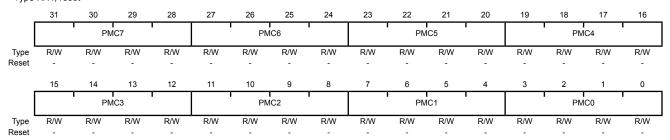
GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000

GPIO Port D (AHB) base: 0x4005.8000 GPIO Port E (AHB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000

GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000

GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.000

Offset 0x52C Type R/W, reset -



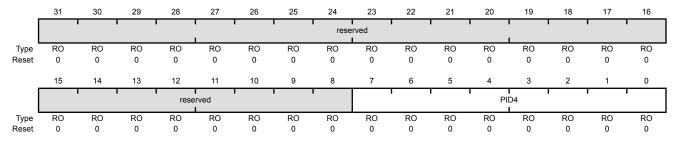
Bit/Field	Name	Туре	Reset	Description
31:28	PMC7	R/W	-	Port Mux Control 7 This field controls the configuration for GPIO pin 7.
27:24	PMC6	R/W	-	Port Mux Control 6 This field controls the configuration for GPIO pin 6.
23:20	PMC5	R/W	-	Port Mux Control 5 This field controls the configuration for GPIO pin 5.
19:16	PMC4	R/W	-	Port Mux Control 4 This field controls the configuration for GPIO pin 4.
15:12	PMC3	R/W	-	Port Mux Control 3 This field controls the configuration for GPIO pin 3.
11:8	PMC2	R/W	-	Port Mux Control 2 This field controls the configuration for GPIO pin 2.
7:4	PMC1	R/W	-	Port Mux Control 1 This field controls the configuration for GPIO pin 1.
3:0	PMC0	R/W	-	Port Mux Control 0 This field controls the configuration for GPIO pin 0.

Register 23: GPIO Peripheral Identification 4 (GPIOPeriphID4), offset 0xFD0

The **GPIOPeriphID4**, **GPIOPeriphID5**, **GPIOPeriphID6**, and **GPIOPeriphID7** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 4 (GPIOPeriphID4)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFD0 Type RO, reset 0x0000.0000



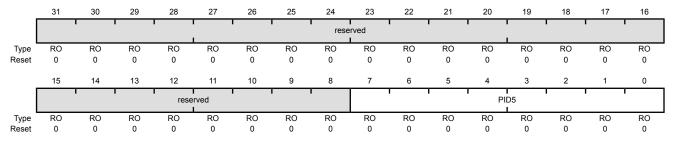
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID4	RO	0x00	GPIO Peripheral ID Register [7:0]

Register 24: GPIO Peripheral Identification 5 (GPIOPeriphID5), offset 0xFD4

The **GPIOPeriphID4**, **GPIOPeriphID5**, **GPIOPeriphID6**, and **GPIOPeriphID7** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 5 (GPIOPeriphID5)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFD4 Type RO, reset 0x0000.0000



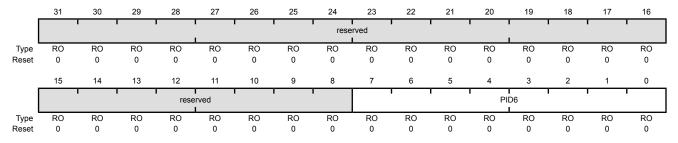
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID5	RO	0x00	GPIO Peripheral ID Register [15:8]

Register 25: GPIO Peripheral Identification 6 (GPIOPeriphID6), offset 0xFD8

The **GPIOPeriphID4**, **GPIOPeriphID5**, **GPIOPeriphID6**, and **GPIOPeriphID7** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 6 (GPIOPeriphID6)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFD8 Type RO, reset 0x0000.0000



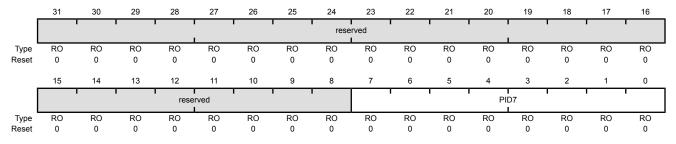
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID6	RO	0x00	GPIO Peripheral ID Register [23:16]

Register 26: GPIO Peripheral Identification 7 (GPIOPeriphID7), offset 0xFDC

The GPIOPeriphID4, GPIOPeriphID5, GPIOPeriphID6, and GPIOPeriphID7 registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 7 (GPIOPeriphID7)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFDC Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID7	RO	0x00	GPIO Peripheral ID Register [31:24]

Register 27: GPIO Peripheral Identification 0 (GPIOPeriphID0), offset 0xFE0

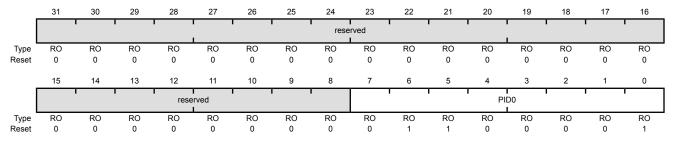
The **GPIOPeriphID0**, **GPIOPeriphID1**, **GPIOPeriphID2**, and **GPIOPeriphID3** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 0 (GPIOPeriphID0)

Name

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFE0 Type RO, reset 0x0000.0061

Bit/Field



31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID0	RO	0x61	GPIO Peripheral ID Register [7:0]
				Can be used by software to identify the presence of this peripheral.

Description

Reset

Register 28: GPIO Peripheral Identification 1 (GPIOPeriphID1), offset 0xFE4

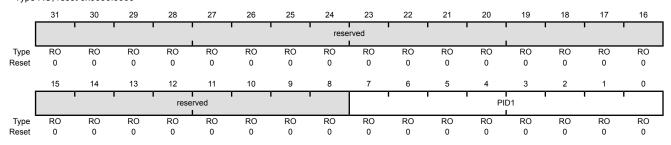
The **GPIOPeriphID0**, **GPIOPeriphID1**, **GPIOPeriphID2**, and **GPIOPeriphID3** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 1 (GPIOPeriphID1)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFE4 Type RO, reset 0x0000.0000

Name

Bit/Field



31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID1	RO	0x00	GPIO Peripheral ID Register [15:8]
				Can be used by software to identify the presence of this peripheral.

Description

Reset

Register 29: GPIO Peripheral Identification 2 (GPIOPeriphID2), offset 0xFE8

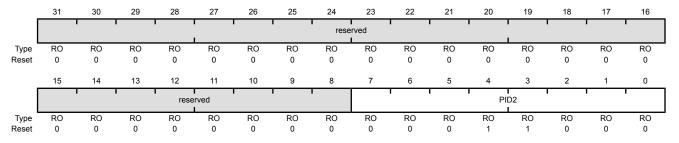
The **GPIOPeriphID0**, **GPIOPeriphID1**, **GPIOPeriphID2**, and **GPIOPeriphID3** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 2 (GPIOPeriphID2)

Name

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFE8 Type RO, reset 0x0000.0018

Bit/Field



31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID2	RO	0x18	GPIO Peripheral ID Register [23:16]
				Can be used by software to identify the presence of this peripheral.

Description

Reset

Register 30: GPIO Peripheral Identification 3 (GPIOPeriphID3), offset 0xFEC

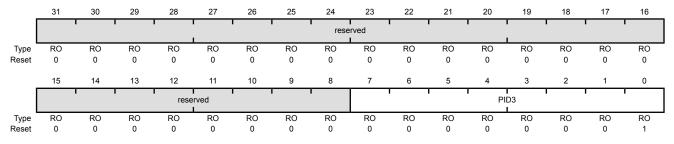
The **GPIOPeriphID0**, **GPIOPeriphID1**, **GPIOPeriphID2**, and **GPIOPeriphID3** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 3 (GPIOPeriphID3)

Name

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFEC Type RO, reset 0x0000.0001

Bit/Field



31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID3	RO	0x01	GPIO Peripheral ID Register [31:24]
				Can be used by software to identify the presence of this peripheral.

Description

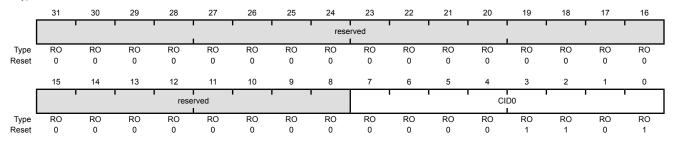
Reset

Register 31: GPIO PrimeCell Identification 0 (GPIOPCellID0), offset 0xFF0

The **GPIOPCeIIID1**, **GPIOPCeIIID1**, and **GPIOPCeIIID3** registers are four 8-bit wide registers, that can conceptually be treated as one 32-bit register. The register is used as a standard cross-peripheral identification system.

GPIO PrimeCell Identification 0 (GPIOPCellID0)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFF0 Type RO, reset 0x0000.000D



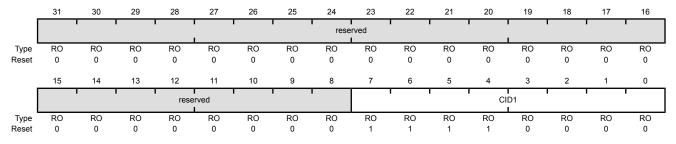
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID0	RO	0x0D	GPIO PrimeCell ID Register [7:0]
				Provides software a standard cross-peripheral identification system.

Register 32: GPIO PrimeCell Identification 1 (GPIOPCellID1), offset 0xFF4

The **GPIOPCeIIID1**, **GPIOPCeIIID1**, and **GPIOPCeIIID3** registers are four 8-bit wide registers, that can conceptually be treated as one 32-bit register. The register is used as a standard cross-peripheral identification system.

GPIO PrimeCell Identification 1 (GPIOPCellID1)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFF4 Type RO, reset 0x0000.00F0



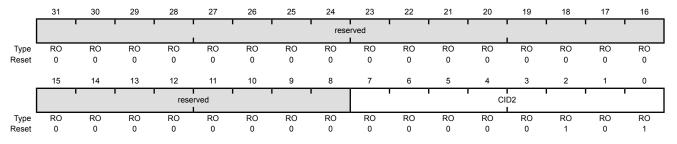
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID1	RO	0xF0	GPIO PrimeCell ID Register [15:8] Provides software a standard cross-peripheral identification system.

Register 33: GPIO PrimeCell Identification 2 (GPIOPCellID2), offset 0xFF8

The **GPIOPCeIIID1**, **GPIOPCeIIID1**, and **GPIOPCeIIID3** registers are four 8-bit wide registers, that can conceptually be treated as one 32-bit register. The register is used as a standard cross-peripheral identification system.

GPIO PrimeCell Identification 2 (GPIOPCellID2)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFF8 Type RO, reset 0x0000.0005



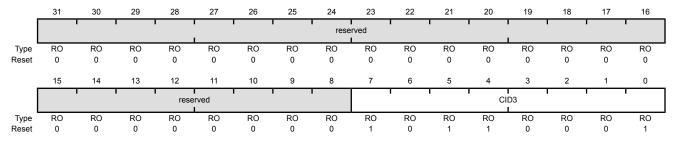
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID2	RO	0x05	GPIO PrimeCell ID Register [23:16] Provides software a standard cross-peripheral identification system.

Register 34: GPIO PrimeCell Identification 3 (GPIOPCelIID3), offset 0xFFC

The **GPIOPCeIIID1**, **GPIOPCeIIID1**, and **GPIOPCeIIID3** registers are four 8-bit wide registers, that can conceptually be treated as one 32-bit register. The register is used as a standard cross-peripheral identification system.

GPIO PrimeCell Identification 3 (GPIOPCellID3)

GPIO Port A (APB) base: 0x4000.4000 GPIO Port A (AHB) base: 0x4005.8000 GPIO Port B (APB) base: 0x4000.5000 GPIO Port B (AHB) base: 0x4005.9000 GPIO Port C (APB) base: 0x4000.6000 GPIO Port C (AHB) base: 0x4005.A000 GPIO Port D (APB) base: 0x4000.7000 GPIO Port D (AHB) base: 0x4005.B000 GPIO Port E (APB) base: 0x4002.4000 GPIO Port E (AHB) base: 0x4005.C000 GPIO Port F (APB) base: 0x4002.5000 GPIO Port F (AHB) base: 0x4005.D000 GPIO Port G (APB) base: 0x4002.6000 GPIO Port G (AHB) base: 0x4005.E000 GPIO Port H (APB) base: 0x4002.7000 GPIO Port H (AHB) base: 0x4005.F000 GPIO Port J (APB) base: 0x4003.D000 GPIO Port J (AHB) base: 0x4006.0000 Offset 0xFFC Type RO, reset 0x0000.00B1



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID3	RO	0xB1	GPIO PrimeCell ID Register [31:24] Provides software a standard cross-peripheral identification system.

10 General-Purpose Timers

Programmable timers can be used to count or time external events that drive the Timer input pins. The Stellaris[®] General-Purpose Timer Module (GPTM) contains three GPTM blocks. Each GPTM block provides two 16-bit timers/counters (referred to as Timer A and Timer B) that can be configured to operate independently as timers or event counters, or concatenated to operate as one 32-bit timer or one 32-bit Real-Time Clock (RTC). Timers can also be used to trigger µDMA transfers.

In addition, timers can be used to trigger analog-to-digital conversions (ADC). The ADC trigger signals from all of the general-purpose timers are ORed together before reaching the ADC module, so only one timer should be used to trigger ADC events.

The GPT Module is one timing resource available on the Stellaris microcontrollers. Other timer resources include the System Timer (SysTick) (see 96).

The General-Purpose Timer Module (GPTM) contains three GPTM blocks with the following functional options:

- Operating modes:
 - 16- or 32-bit programmable one-shot timer
 - 16- or 32-bit programmable periodic timer
 - 16-bit general-purpose timer with an 8-bit prescaler
 - 32-bit Real-Time Clock (RTC) when using an external 32.768-KHz clock as the input
 - 16-bit input-edge count- or time-capture modes
 - 16-bit PWM mode with software-programmable output inversion of the PWM signal
- Count up or down
- Six Capture Compare PWM pins (CCP)
- Daisy chaining of timer modules to allow a single timer to initiate multiple timing events
- ADC event trigger
- User-enabled stalling when the microcontroller asserts CPU Halt flag during debug (excluding RTC mode)
- Ability to determine the elapsed time between the assertion of the timer interrupt and entry into the interrupt service routine.
- Efficient transfers using Micro Direct Memory Access Controller (µDMA)
 - Dedicated channel for each timer
 - Burst request generated on timer interrupt

10.1 Block Diagram

In the block diagram, the specific Capture Compare PWM (CCP) pins available depend on the Stellaris device. See Table 10-1 on page 445 for the available CCP pins and their timer assignments.

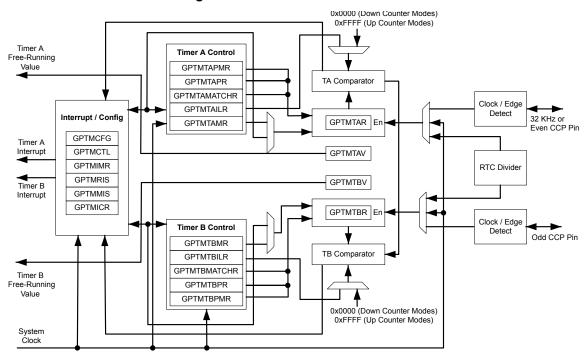


Figure 10-1. GPTM Module Block Diagram

Table 10-1. Available CCP Pins

Timer	16-Bit Up/Down Counter	Even CCP Pin	Odd CCP Pin
Timer 0	TimerA	CCP0	-
	TimerB	-	CCP1
Timer 1	TimerA	CCP2	-
	TimerB	-	CCP3
Timer 2	TimerA	CCP4	-
	TimerB	-	CCP5

10.2 Signal Description

The following table lists the external signals of the GP Timer module and describes the function of each. The GP Timer signals are alternate functions for some GPIO signals and default to be GPIO signals at reset. The column in the table below titled "Pin Mux/Pin Assignment" lists the possible GPIO pin placements for these GP Timer signals. The AFSEL bit in the **GPIO Alternate Function Select (GPIOAFSEL)** register (page 412) should be set to choose the GP Timer function. The number in parentheses is the encoding that must be programmed into the PMCn field in the **GPIO Port Control (GPIOPCTL)** register (page 430) to assign the GP Timer signal to the specified GPIO port pin. For more information on configuring GPIOs, see "General-Purpose Input/Outputs (GPIOs)" on page 389.

Table 10-2. General-Purpose Timers Signals (100LQFP)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
CCP0	13 22 23 39 58 66 72 91	PD3 (4) PC7 (4) PC6 (6) PJ2 (9) PF4 (1) PB0 (1) PB2 (5) PB5 (4) PD4 (1)	I/O	TTL	Capture/Compare/PWM 0.
CCP1	24 25 34 43 67 90 96 100	PC5 (1) PC4 (9) PA6 (2) PF6 (1) PB1 (4) PB6 (1) PE3 (1) PD7 (3)	I/O	TTL	Capture/Compare/PWM 1.
CCP2	6 11 25 46 67 75 91 95 98	PE4 (6) PD1 (10) PC4 (5) PF5 (1) PB1 (1) PE1 (4) PB5 (6) PE2 (5) PD5 (1)	I/O	TTL	Capture/Compare/PWM 2.
CCP3	6 23 24 35 41 61 72 74	PE4 (1) PC6 (1) PC5 (5) PA7 (7) PG4 (1) PF1 (10) PB2 (4) PE0 (3) PD4 (2)	I/O	TTL	Capture/Compare/PWM 3.
CCP4	22 25 35 42 95 98	PC7 (1) PC4 (6) PA7 (2) PF7 (1) PE2 (1) PD5 (2)	I/O	TTL	Capture/Compare/PWM 4.
CCP5	5 12 25 36 40 90 91	PE5 (1) PD2 (4) PC4 (1) PG7 (8) PG5 (1) PB6 (6) PB5 (2)	I/O	TTL	Capture/Compare/PWM 5.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

Table 10-3. General-Purpose Timers Signals (108BGA)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
CCP0	H1 L2 M2 K6 L9 E12 A11 B7 B5	PD3 (4) PC7 (4) PC6 (6) PJ2 (9) PF4 (1) PB0 (1) PB2 (5) PB5 (4) PD4 (1)	I/O	TTL	Capture/Compare/PWM 0.
CCP1	M1 L1 L6 M8 D12 A7 B4 A2	PC5 (1) PC4 (9) PA6 (2) PF6 (1) PB1 (4) PB6 (1) PE3 (1) PD7 (3)	I/O	TTL	Capture/Compare/PWM 1.
CCP2	B2 G2 L1 L8 D12 A12 B7 A4 C6	PE4 (6) PD1 (10) PC4 (5) PF5 (1) PB1 (1) PE1 (4) PB5 (6) PE2 (5) PD5 (1)	1/0	TTL	Capture/Compare/PWM 2.
CCP3	B2 M2 M1 M6 K3 H12 A11 B11	PE4 (1) PC6 (1) PC5 (5) PA7 (7) PG4 (1) PF1 (10) PB2 (4) PE0 (3) PD4 (2)	I/O	TTL	Capture/Compare/PWM 3.
CCP4	L2 L1 M6 K4 A4 C6	PC7 (1) PC4 (6) PA7 (2) PF7 (1) PE2 (1) PD5 (2)	I/O	TTL	Capture/Compare/PWM 4.
CCP5	B3 H2 L1 C10 M7 A7 B7	PE5 (1) PD2 (4) PC4 (1) PG7 (8) PG5 (1) PB6 (6) PB5 (2)	I/O	TTL	Capture/Compare/PWM 5.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

10.3 Functional Description

The main components of each GPTM block are two free-running up/down counters (referred to as Timer A and Timer B), two match registers, two prescaler match registers, two shadow registers, and two load/initialization registers and their associated control functions. The exact functionality of

each GPTM is controlled by software and configured through the register interface. Timer A and Timer B can be used individually, in which case they have a 16-bit counting range. In addition, Timer A and Timer B can be concatenated to provide a 32-bit counting range. Note that the prescaler can only be used when the timers are used individually.

The available modes for each GPTM block are shown in Table 10-4 on page 448. Note that when counting down in one-shot or periodic modes, the prescaler acts as a true prescaler and contains the least-significant bits of the count. When counting up in one-shot or periodic modes, the prescaler acts as a timer extension and holds the most-significant bits of the count. In input edge count mode, the prescaler always acts as a timer extension, regardless of the count direction.

Table 10-4. General-Purpose Timer Capabilities

Mode	Timer Use	Count Direction	Counter Size	Prescaler Size ^a
One-shot	Individual	Up or Down	16-bit	8-bit
One-shot	Concatenated	Up or Down	32-bit	-
Periodic	Individual	Up or Down	16-bit	8-bit
Periodic	Concatenated	Up or Down	32-bit	-
RTC	Concatenated	Up	32-bit	-
Edge Count	Individual	Down	16-bit	8-bit
Edge Time	Individual	Down	16-bit	-
PWM	Individual	Down	16-bit	-

a. The prescaler is only available when the timers are used individually

Software configures the GPTM using the **GPTM Configuration (GPTMCFG)** register (see page 461), the **GPTM Timer A Mode (GPTMTAMR)** register (see page 462), and the **GPTM Timer B Mode (GPTMTBMR)** register (see page 464). When in one of the concatentated modes, Timer A and Timer B can only operate in one mode. However, when configured in an individual mode, Timer A and Timer B can be independently configured in any combination of the individual modes.

10.3.1 GPTM Reset Conditions

After reset has been applied to the GPTM module, the module is in an inactive state, and all control registers are cleared and in their default states. Counters Timer A and Timer B are initialized to all 1s, along with their corresponding load registers: the **GPTM Timer A Interval Load (GPTMTAILR)** register (see page 479) and the **GPTM Timer B Interval Load (GPTMTBILR)** register (see page 480) and shadow registers: the **GPTM Timer A Value (GPTMTAV)** register (see page 489) and the **GPTM Timer B Value (GPTMTBV)** register (see page 490). The prescale counters are initialized to 0x00: the **GPTM Timer A Prescale (GPTMTAPR)** register (see page 483) and the **GPTM Timer B Prescale (GPTMTBPR)** register (see page 484).

10.3.2 Timer Modes

This section describes the operation of the various timer modes. When using Timer A and Timer B in concatenated mode, only the Timer A control and status bits must be used; there is no need to use Timer B control and status bits. The GPTM is placed into individual/split mode by writing a value of 0x4 to the **GPTM Configuration (GPTMCFG)** register (see page 461). In the following sections, the variable "n" is used in bit field and register names to imply either a Timer A function or a Timer B function. Throughout this section, the timeout event in down-count mode is 0x0 and in up-count mode is the value in the **GPTM Timer n Interval Load (GPTMTnILR)** and the optional **GPTM Timer n Prescale (GPTMTnPR)** registers.

10.3.2.1 One-Shot/Periodic Timer Mode

The selection of one-shot or periodic mode is determined by the value written to the TnMR field of the **GPTM Timer n Mode (GPTMTnMR)** register (see page 462). The timer is configured to count up or down using the TnCDIR bit in the **GPTMTnMR** register.

When software sets the \mathtt{TnEN} bit in the **GPTM Control (GPTMCTL)** register (see page 466), the timer begins counting up from 0x0 or down from its preloaded value. Alternatively, if the \mathtt{TnWOT} bit is set in the **GPTMTnMR** register, once the \mathtt{TnEN} bit is set, the timer waits for a trigger to begin counting (see the section called "Wait-for-Trigger Mode" on page 450). Table 10-5 on page 449 shows the values that are loaded into the timer registers when the timer is enabled.

Table 10-5. Counter Values When the Timer is Enabled in Periodic or One-Shot Modes

Register	Count Down Mode	Count Up Mode
TnR	GPTMTnlLR	0x0
TnV	GPTMTnlLR	0x0

When the timer is counting down and it reaches the timeout event (0x0), the timer reloads its start value from the **GPTMTnILR** and the **GPTMTnPR** registers on the next cycle. When the timer is counting up and it reaches the timeout event (the value in the **GPTMTnILR** and the optional **GPTMTnPR** registers), the timer reloads with 0x0. If configured to be a one-shot timer, the timer stops counting and clears the TnEN bit in the **GPTMCTL** register. If configured as a periodic timer, the timer starts counting again on the next cycle.

In periodic, snap-shot mode (TnMR field is 0x2 and the TnSNAPS bit is set in the **GPTMTnMR** register), the value of the timer at the time-out event is loaded into the **GPTMTnR** register. The free-running counter value is shown in the **GPTMTnV** register. In this manner, software can determine the time elapsed from the interrupt assertion to the ISR entry by examining the snapshot values and the current value of the free-running timer. Snapshot mode is not available when the timer is configured in one-shot mode.

In addition to reloading the count value, the GPTM generates interrupts and triggers when it reaches the time-out event. The GPTM sets the Thtoris bit in the GPTM Raw Interrupt Status (GPTMRIS) register (see page 471), and holds it until it is cleared by writing the GPTM Interrupt Clear (GPTMICR) register (see page 477). If the time-out interrupt is enabled in the GPTM Interrupt Mask (GPTMIMR) register (see page 469), the GPTM also sets the Thtomis bit in the GPTM Masked Interrupt Status (GPTMMIS) register (see page 474). By setting the Thmie bit in the GPTMThmR register, an interrupt condition can also be generated when the Timer value equals the value loaded into the GPTM Timer n Match (GPTMThMATCHR) and GPTM Timer n Prescale Match (GPTMThPMR) registers. This interrupt has the same status, masking, and clearing functions as the time-out interrupt, but uses the match interrupt bits instead (for example, the raw interrupt status is monitored via Thmris bit in the GPTM Raw Interrupt Status (GPTMRIS) register). Note that the interrupt status bits are not updated by the hardware unless the Thmie bit in the GPTMThMR register is set, which is different than the behavior for the time-out interrupt. The ADC trigger is enabled by setting the Thote bit in GPTMCTL. The μDMA trigger is enabled by configuring and enabling the appropriate μDMA channel. See "Channel Configuration" on page 335.

If software updates the **GPTMTnILR** register while the counter is counting down, the counter loads the new value on the next clock cycle and continues counting from the new value. If software updates the **GPTMTnILR** register while the counter is counting up, the timeout event is changed on the next cycle to the new value. If software updates the **GPTM Timer n Value (GPTMTnV)** register while the counter is counting up or down, the counter loads the new value on the next clock cycle and continues counting from the new value.

If the TnSTALL bit in the **GPTMCTL** register is set, the timer freezes counting while the processor is halted by the debugger. The timer resumes counting when the processor resumes execution.

The following table shows a variety of configurations for a 16-bit free-running timer while using the prescaler. All values assume a 50-MHz clock with Tc=20 ns (clock period). The prescaler can only be used when a 16/32-bit timer is configured in 16-bit mode.

Table 10-6.	. 16-Bit Timer	With Prescaler	Configurations
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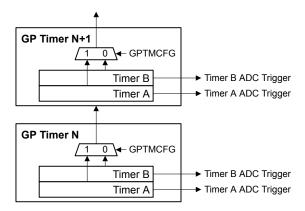
Prescale (8-bit value)	# of Timer Clocks (Tc) ^a	Max Time	Units
00000000	1	1.3107	ms
0000001	2	2.6214	ms
0000010	3	3.9322	ms
11111101	254	332.9229	ms
11111110	255	334.2336	ms
11111111	256	335.5443	ms

a. Tc is the clock period.

Wait-for-Trigger Mode

The Wait-for-Trigger mode allows daisy chaining of the timer modules such that once configured, a single timer can initiate mulitple timing events using the Timer triggers. Wait-for-Trigger mode is enabled by setting the Timeoff bit in the **GPTMTnMR** register. When the Timeoff bit is set, Timer N+1 does not begin counting until the timer in the previous position in the daisy chain (Timer N) reaches its time-out event. The daisy chain is configured such that GPTM1 always follows GPTM0 and GPTM2 follows GPTM1. If Timer A is in 32-bit mode (controlled by the GPTMCFG bit in the **GPTMCFG** register), it triggers Timer A in the next module. If Timer A is in 16-bit mode, it triggers Timer B in the same module, and Timer B triggers Timer A in the next module. Care must be taken that the TAWOT bit is never set in GPTM0. Figure 10-2 on page 450 shows how the GPTMCFG bit affects the daisy chain. This function is valid for both one-shot and periodic modes.

Figure 10-2. Timer Daisy Chain



10.3.2.2 Real-Time Clock Timer Mode

In Real-Time Clock (RTC) mode, the concatenated versions of the Timer A and Timer B registers are configured as an up-counter. When RTC mode is selected for the first time after reset, the counter is loaded with a value of 0x1. All subsequent load values must be written to the **GPTM**

Timer A Interval Load (GPTMTAILR) register (see page 479). Table 10-7 on page 451 shows the values that are loaded into the timer registers when the timer is enabled.

Table 10-7. Counter Values When the Timer is Enabled in RTC Mode

Register	Count Down Mode	Count Up Mode
TnR	Not available	0x1
TnV	Not available	0x1

The input clock on an even CCP input is required to be 32.768 KHz in RTC mode. The clock signal is then divided down to a 1-Hz rate and is passed along to the input of the counter.

When software writes the TAEN bit in the **GPTMCTL** register, the counter starts counting up from its preloaded value of 0x1. When the current count value matches the preloaded value in the GPTMTAMATCHR register, the GPTM asserts the RTCRIS bit in GPTMRIS and continues counting until either a hardware reset, or it is disabled by software (clearing the TAEN bit). When the timer value reaches the terminal count, the timer rolls over and continues counting up from 0x0. If the RTC interrupt is enabled in GPTMIMR, the GPTM also sets the RTCMIS bit in GPTMMIS and generates a controller interrupt. The status flags are cleared by writing the RTCCINT bit in GPTMICR.

In this mode, the **GPTMTnR** and **GPTMTnV** registers always have the same value.

In addition to generating interrupts, a µDMA trigger can be generated. The µDMA trigger is enabled by configuring and enabling the appropriate µDMA channel. See "Channel Configuration" on page 335.

If the TASTALL bit in the GPTMCTL register is set, the timer does not freeze when the processor is halted by the debugger if the RTCEN bit is set in **GPTMCTL**.

10.3.2.3 **Input Edge-Count Mode**

For rising-edge detection, the input signal must be High for at least two system clock periods following the rising edge. Similarly, for falling-edge detection, the input signal must be Low for at least two system clock periods following the falling edge. Based on this criteria, the maximum input frequency for edge detection is 1/4 of the system frequency.

In Edge-Count mode, the timer is configured as a 24-bit down-counter including the optional prescaler with the upper count value stored in the GPTM Timer n Prescale (GPTMTnPR) register and the lower bits in the GPTMTnR register. In this mode, the timer is capable of capturing three types of events: rising edge, falling edge, or both. To place the timer in Edge-Count mode, the TnCMR bit of the **GPTMTnMR** register must be cleared. The type of edge that the timer counts is determined by the Thevent fields of the GPTMCTL register. During initialization, the GPTMTnMATCHR and GPTMTnPMR registers are configured so that the difference between the value in the GPTMTnILR and GPTMTnPR registers and the GPTMTnMATCHR and GPTMTnPMR registers equals the number of edge events that must be counted. Table 10-8 on page 451 shows the values that are loaded into the timer registers when the timer is enabled.

Table 10-8. Counter Values When the Timer is Enabled in Input Edge-Count Mode

Register	Count Down Mode	Count Up Mode
TnR	GPTMTnlLR	Not available
TnV	GPTMTnlLR	Not available

When software writes the TnEN bit in the GPTM Control (GPTMCTL) register, the timer is enabled for event capture. Each input event on the CCP pin decrements the counter by 1 until the event count matches GPTMTnMATCHR and GPTMTnPMR. When the counts match, the GPTM asserts the CnMRIS bit in the GPTM Raw Interrupt Status (GPTMRIS) register, and holds it until it is cleared by writing the **GPTM Interrupt Clear (GPTMICR)** register. If the capture mode match interrupt is enabled in the **GPTM Interrupt Mask (GPTMIMR)** register, the GPTM also sets the CnMMIS bit in the **GPTM Masked Interrupt Status (GPTMMIS)** register. In this mode, the **GPTMTnR** register holds the count of the input events while the **GPTMTnV** register holds the free-running timer value.

In addition to generating interrupts, an ADC and/or a μ DMA trigger can be generated. The ADC trigger is enabled by setting the ThOTE bit in **GPTMCTL**. The μ DMA trigger is enabled by configuring and enabling the appropriate μ DMA channel. See "Channel Configuration" on page 335.

After the match value is reached, the counter is then reloaded using the value in **GPTMTnlLR** and **GPTMTnPR** registers, and stopped because the GPTM automatically clears the \mathtt{TnEN} bit in the **GPTMCTL** register. Once the event count has been reached, all further events are ignored until \mathtt{TnEN} is re-enabled by software.

Figure 10-3 on page 452 shows how Input Edge-Count mode works. In this case, the timer start value is set to **GPTMTnILR** =0x000A and the match value is set to **GPTMTnMATCHR** =0x0006 so that four edge events are counted. The counter is configured to detect both edges of the input signal.

Note that the last two edges are not counted because the timer automatically clears the TnEN bit after the current count matches the value in the **GPTMTnMATCHR** register.

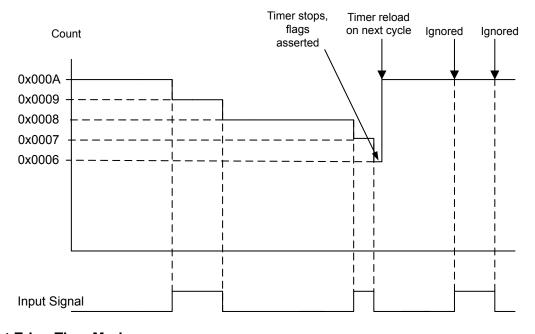


Figure 10-3. Input Edge-Count Mode Example

10.3.2.4 Input Edge-Time Mode

Note: For rising-edge detection, the input signal must be High for at least two system clock periods following the rising edge. Similarly, for falling edge detection, the input signal must be Low for at least two system clock periods following the falling edge. Based on this criteria, the maximum input frequency for edge detection is 1/4 of the system frequency.

The prescaler is not available in 16-Bit Input Edge-Time mode.

In Edge-Time mode, the timer is configured as a 16-bit down-counter. In this mode, the timer is initialized to the value loaded in the **GPTMTnILR**register. The timer is capable of capturing three types of events: rising edge, falling edge, or both. The timer is placed into Edge-Time mode by setting the TnCMR bit in the **GPTMTnMR** register, and the type of event that the timer captures is

determined by the TnEVENT fields of the **GPTMCTL** register. Table 10-9 on page 453 shows the values that are loaded into the timer registers when the timer is enabled.

Table 10-9. Counter Values When the Timer is Enabled in Input Event-Count Mode

Register	Count Down Mode	Count Up Mode
TnR	GPTMTnlLR	Not available
TnV	GPTMTnILR	Not available

When software writes the Tnen bit in the GPTMCTL register, the timer is enabled for event capture. When the selected input event is detected, the current timer counter value is captured in the GPTMTnR register and is available to be read by the microcontroller. The GPTM then asserts the Cners bit in the GPTM Raw Interrupt Status (GPTMRIS) register, and holds it until it is cleared by writing the GPTM Interrupt Clear (GPTMICR) register. If the capture mode event interrupt is enabled in the GPTM Interrupt Mask (GPTMIMR) register, the GPTM also sets the Cnems bit in the GPTM Masked Interrupt Status (GPTMMIS) register. In this mode, the GPTMTnR register holds the time at which the selected input event occurred while the GPTMTnV register holds the free-running timer value. These registers can be read to determine the time that elapsed between the interrupt assertion and the entry into the ISR.

In addition to generating interrupts, an ADC and/or a μ DMA trigger can be generated. The ADC trigger is enabled by setting the ThOTE bit in **GPTMCTL**. The μ DMA trigger is enabled by configuring and enabling the appropriate μ DMA channel. See "Channel Configuration" on page 335.

After an event has been captured, the timer does not stop counting. It continues to count until the \mathtt{TnEN} bit is cleared. When the timer reaches the timeout value, it is reloaded with the value from the **GPTMTnILR** register.

Figure 10-4 on page 454 shows how input edge timing mode works. In the diagram, it is assumed that the start value of the timer is the default value of 0xFFFF, and the timer is configured to capture rising edge events.

Each time a rising edge event is detected, the current count value is loaded into the **GPTMTnR** register, and is held there until another rising edge is detected (at which point the new count value is loaded into the **GPTMTnR** register).

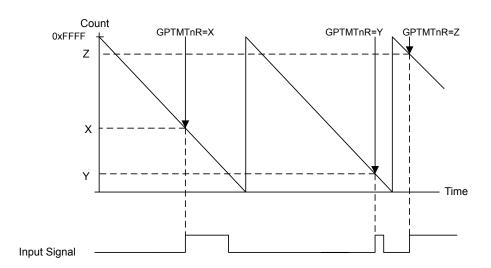


Figure 10-4. 16-Bit Input Edge-Time Mode Example

10.3.2.5 PWM Mode

Note: The prescaler is not available in 16-Bit PWM mode.

The GPTM supports a simple PWM generation mode. In PWM mode, the timer is configured as a 16-bit down-counter with a start value (and thus period) defined by the **GPTMTnILR** register. In this mode, the PWM frequency and period are synchronous events and therefore guaranteed to be glitch free. PWM mode is enabled with the **GPTMTnMR** register by setting the TnAMS bit to 0x1, the TnCMR bit to 0x0, and the TnMR field to 0x1 or 0x2. Table 10-10 on page 454 shows the values that are loaded into the timer registers when the timer is enabled.

Table 10-10. Counter Values When the Timer is Enabled in PWM Mode

Register	Count Down Mode	Count Up Mode
GPTMTnR	GPTMTnILR	Not available
GPTMTnV	GPTMTnILR	Not available

When software writes the TnEN bit in the **GPTMCTL** register, the counter begins counting down until it reaches the 0x0 state. On the next counter cycle in periodic mode, the counter reloads its start value from the **GPTMTnILR** register and continues counting until disabled by software clearing the TnEN bit in the **GPTMCTL** register. No interrupts or status bits are asserted in PWM mode.

In this mode, the **GPTMTnR** and **GPTMTnV** registers always have the same value.

The output PWM signal asserts when the counter is at the value of the **GPTMTnILR** register (its start state), and is deasserted when the counter value equals the value in the **GPTMTnMATCHR** register. Software has the capability of inverting the output PWM signal by setting the TnPWML bit in the **GPTMCTL** register.

Figure 10-5 on page 455 shows how to generate an output PWM with a 1-ms period and a 66% duty cycle assuming a 50-MHz input clock and **TnPWML** =0 (duty cycle would be 33% for the **TnPWML** =1 configuration). For this example, the start value is **GPTMTnILR**=0xC350 and the match value is **GPTMTnMATCHR**=0x411A.

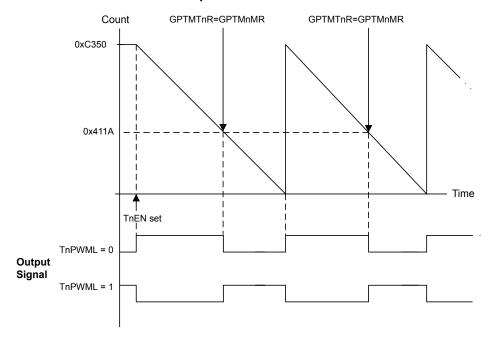


Figure 10-5. 16-Bit PWM Mode Example

10.3.3 DMA Operation

The timers each have a dedicated μDMA channel and can provide a request signal to the μDMA controller. The request is a burst type and occurs whenever a timer raw interrupt condition occurs. The arbitration size of the μDMA transfer should be set to the amount of data that should be transferred whenever a timer event occurs.

For example, to transfer 256 items, 8 items at a time every 10 ms, configure a timer to generate a periodic timeout at 10 ms. Configure the μDMA transfer for a total of 256 items, with a burst size of 8 items. Each time the timer times out, the μDMA controller transfers 8 items, until all 256 items have been transferred.

No other special steps are needed to enable Timers for μ DMA operation. Refer to "Micro Direct Memory Access (μ DMA)" on page 331 for more details about programming the μ DMA controller.

10.3.4 Accessing Concatenated Register Values

The GPTM is placed into concatenated mode by writing a 0x0 or a 0x1 to the GPTMCFG bit field in the **GPTM Configuration (GPTMCFG)** register. In both configurations, certain registers are concatenated to form pseudo 32-bit registers. These registers include:

- GPTM Timer A Interval Load (GPTMTAILR) register [15:0], see page 479
- GPTM Timer B Interval Load (GPTMTBILR) register [15:0], see page 480
- GPTM Timer A (GPTMTAR) register [15:0], see page 487
- **GPTM Timer B (GPTMTBR)** register [15:0], see page 488
- GPTM Timer A Value (GPTMTAV) register [15:0], see page 489

- GPTM Timer B Value (GPTMTBV) register [15:0], see page 490
- GPTM Timer A Match (GPTMTAMATCHR) register [15:0], see page 481
- GPTM Timer B Match (GPTMTBMATCHR) register [15:0], see page 482

In the 32-bit modes, the GPTM translates a 32-bit write access to **GPTMTAILR** into a write access to both **GPTMTAILR** and **GPTMTBILR**. The resulting word ordering for such a write operation is:

```
GPTMTBILR[15:0]:GPTMTAILR[15:0]
```

Likewise, a 32-bit read access to **GPTMTAR** returns the value:

```
GPTMTBR[15:0]:GPTMTAR[15:0]
```

A 32-bit read access to **GPTMTAV** returns the value:

```
GPTMTBV[15:0]:GPTMTAV[15:0]
```

10.4 Initialization and Configuration

To use a GPTM, the appropriate TIMERn bit must be set in the **RCGC1** register (see page 246). If using any CCP pins, the clock to the appropriate GPIO module must be enabled via the **RCGC1** register (see page 246). To find out which GPIO port to enable, refer to Table 18-4 on page 762. Configure the PMCn fields in the **GPIOPCTL** register to assign the CCP signals to the appropriate pins (see page 430 and Table 18-5 on page 767).

This section shows module initialization and configuration examples for each of the supported timer modes.

10.4.1 One-Shot/Periodic Timer Mode

The GPTM is configured for One-Shot and Periodic modes by the following sequence:

- 1. Ensure the timer is disabled (the TnEN bit in the **GPTMCTL** register is cleared) before making any changes.
- 2. Write the GPTM Configuration Register (GPTMCFG) with a value of 0x0000.0000.
- 3. Configure the TnMR field in the GPTM Timer n Mode Register (GPTMTnMR):
 - a. Write a value of 0x1 for One-Shot mode.
 - **b.** Write a value of 0x2 for Periodic mode.
- **4.** Optionally configure the TnSNAPS, TnWOT, TnMTE, and TnCDIR bits in the **GPTMTnMR** register to select whether to capture the value of the free-running timer at time-out, use an external trigger to start counting, configure an additional trigger or interrupt, and count up or down.
- 5. Load the start value into the GPTM Timer n Interval Load Register (GPTMTnILR).
- If interrupts are required, set the appropriate bits in the GPTM Interrupt Mask Register (GPTMIMR).
- 7. Set the Then bit in the **GPTMCTL** register to enable the timer and start counting.

8. Poll the **GPTMRIS** register or wait for the interrupt to be generated (if enabled). In both cases, the status flags are cleared by writing a 1 to the appropriate bit of the **GPTM Interrupt Clear Register (GPTMICR)**.

If the TnMIE bit in the **GPTMTnMR** register is set, the RTCRIS bit in the **GPTMRIS** register is set, and the timer continues counting. In One-Shot mode, the timer stops counting after the time-out event. To re-enable the timer, repeat the sequence. A timer configured in Periodic mode reloads the timer and continues counting after the time-out event.

10.4.2 Real-Time Clock (RTC) Mode

To use the RTC mode, the timer must have a 32.768-KHz input signal on an even CCP input. To enable the RTC feature, follow these steps:

- 1. Ensure the timer is disabled (the TAEN bit is cleared) before making any changes.
- 2. Write the GPTM Configuration Register (GPTMCFG) with a value of 0x0000.0001.
- 3. Write the match value to the GPTM Timer n Match Register (GPTMTnMATCHR).
- 4. Set/clear the RTCEN bit in the GPTM Control Register (GPTMCTL) as needed.
- 5. If interrupts are required, set the RTCIM bit in the GPTM Interrupt Mask Register (GPTMIMR).
- **6.** Set the TAEN bit in the **GPTMCTL** register to enable the timer and start counting.

When the timer count equals the value in the **GPTMTnMATCHR** register, the GPTM asserts the RTCRIS bit in the **GPTMRIS** register and continues counting until Timer A is disabled or a hardware reset. The interrupt is cleared by writing the RTCCINT bit in the **GPTMICR** register.

10.4.3 Input Edge-Count Mode

A timer is configured to Input Edge-Count mode by the following sequence:

- 1. Ensure the timer is disabled (the TnEN bit is cleared) before making any changes.
- 2. Write the **GPTM Configuration (GPTMCFG)** register with a value of 0x0000.0004.
- 3. In the GPTM Timer Mode (GPTMTnMR) register, write the TnCMR field to 0x0 and the TnMR field to 0x3.
- **4.** Configure the type of event(s) that the timer captures by writing the Tnevent field of the **GPTM** Control (GPTMCTL) register.
- 5. If a prescaler is to be used, write the prescale value to the GPTM Timer n Prescale Register (GPTMTnPR).
- 6. Load the timer start value into the GPTM Timer n Interval Load (GPTMTnILR) register.
- 7. Load the event count into the GPTM Timer n Match (GPTMTnMATCHR) register.
- 8. If interrupts are required, set the CnMIM bit in the GPTM Interrupt Mask (GPTMIMR) register.
- **9.** Set the TnEN bit in the **GPTMCTL** register to enable the timer and begin waiting for edge events.

10. Poll the CnMRIS bit in the **GPTMRIS** register or wait for the interrupt to be generated (if enabled). In both cases, the status flags are cleared by writing a 1 to the CnMCINT bit of the **GPTM** Interrupt Clear (GPTMICR) register.

When counting down in Input Edge-Count Mode, the timer stops after the programmed number of edge events has been detected. To re-enable the timer, ensure that the TnEN bit is cleared and repeat #4 on page 457 through #9 on page 458.

10.4.4 Input Edge Timing Mode

A timer is configured to Input Edge Timing mode by the following sequence:

- 1. Ensure the timer is disabled (the TnEN bit is cleared) before making any changes.
- 2. Write the **GPTM Configuration (GPTMCFG)** register with a value of 0x0000.0004.
- 3. In the GPTM Timer Mode (GPTMTnMR) register, write the TnCMR field to 0x1 and the TnMR field to 0x3.
- **4.** Configure the type of event that the timer captures by writing the Tnevent field of the **GPTM Control (GPTMCTL)** register.
- 5. Load the timer start value into the GPTM Timer n Interval Load (GPTMTnILR) register.
- 6. If interrupts are required, set the CnEIM bit in the GPTM Interrupt Mask (GPTMIMR) register.
- 7. Set the Then bit in the GPTM Control (GPTMCTL) register to enable the timer and start counting.
- 8. Poll the Cners bit in the GPTMRIS register or wait for the interrupt to be generated (if enabled). In both cases, the status flags are cleared by writing a 1 to the Cnecint bit of the GPTM Interrupt Clear (GPTMICR) register. The time at which the event happened can be obtained by reading the GPTM Timer n (GPTMTnR) register.

In Input Edge Timing mode, the timer continues running after an edge event has been detected, but the timer interval can be changed at any time by writing the **GPTMTnILR** register. The change takes effect at the next cycle after the write.

10.4.5 **PWM Mode**

A timer is configured to PWM mode using the following sequence:

- 1. Ensure the timer is disabled (the TnEN bit is cleared) before making any changes.
- 2. Write the **GPTM Configuration (GPTMCFG)** register with a value of 0x0000.0004.
- 3. In the **GPTM Timer Mode (GPTMTnMR)** register, set the TnAMS bit to 0x1, the TnCMR bit to 0x0, and the TnMR field to 0x2.
- **4.** Configure the output state of the PWM signal (whether or not it is inverted) in the TnPWML field of the **GPTM Control (GPTMCTL)** register.
- 5. Load the timer start value into the GPTM Timer n Interval Load (GPTMTnILR) register.
- 6. Load the GPTM Timer n Match (GPTMTnMATCHR) register with the match value.

7. Set the TnEN bit in the **GPTM Control (GPTMCTL)** register to enable the timer and begin generation of the output PWM signal.

In PWM Timing mode, the timer continues running after the PWM signal has been generated. The PWM period can be adjusted at any time by writing the **GPTMTnILR** register, and the change takes effect at the next cycle after the write.

10.5 Register Map

Table 10-11 on page 459 lists the GPTM registers. The offset listed is a hexadecimal increment to the register's address, relative to that timer's base address:

Timer 0: 0x4003.0000Timer 1: 0x4003.1000Timer 2: 0x4003.2000

Note that the GP Timer module clock must be enabled before the registers can be programmed (see page 246). There must be a delay of 3 system clocks after the Timer module clock is enabled before any Timer module registers are accessed.

Table 10-11. Timers Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	GPTMCFG	R/W	0x0000.0000	GPTM Configuration	461
0x004	GPTMTAMR	R/W	0x0000.0000	GPTM Timer A Mode	462
0x008	GPTMTBMR	R/W	0x0000.0000	GPTM Timer B Mode	464
0x00C	GPTMCTL	R/W	0x0000.0000	GPTM Control	466
0x018	GPTMIMR	R/W	0x0000.0000	GPTM Interrupt Mask	469
0x01C	GPTMRIS	RO	0x0000.0000	GPTM Raw Interrupt Status	471
0x020	GPTMMIS	RO	0x0000.0000	GPTM Masked Interrupt Status	474
0x024	GPTMICR	W1C	0x0000.0000	GPTM Interrupt Clear	477
0x028	GPTMTAILR	R/W	0xFFFF.FFFF	GPTM Timer A Interval Load	479
0x02C	GPTMTBILR	R/W	0x0000.FFFF	GPTM Timer B Interval Load	480
0x030	GPTMTAMATCHR	R/W	0xFFFF.FFFF	GPTM Timer A Match	481
0x034	GPTMTBMATCHR	R/W	0x0000.FFFF	GPTM Timer B Match	482
0x038	GPTMTAPR	R/W	0x0000.0000	GPTM Timer A Prescale	483
0x03C	GPTMTBPR	R/W	0x0000.0000	GPTM Timer B Prescale	484
0x040	GPTMTAPMR	R/W	0x0000.0000	GPTM TimerA Prescale Match	485
0x044	GPTMTBPMR	R/W	0x0000.0000	GPTM TimerB Prescale Match	486
0x048	GPTMTAR	RO	0xFFFF.FFFF	GPTM Timer A	487
0x04C	GPTMTBR	RO	0x0000.FFFF	GPTM Timer B	488
0x050	GPTMTAV	RW	0xFFFF.FFFF	GPTM Timer A Value	489

Table 10-11. Timers Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0x054	GPTMTBV	RW	0x0000.FFFF	GPTM Timer B Value	490

10.6 Register Descriptions

The remainder of this section lists and describes the GPTM registers, in numerical order by address offset.

Register 1: GPTM Configuration (GPTMCFG), offset 0x000

This register configures the global operation of the GPTM module. The value written to this register determines whether the GPTM is in 32- or 16-bit mode.

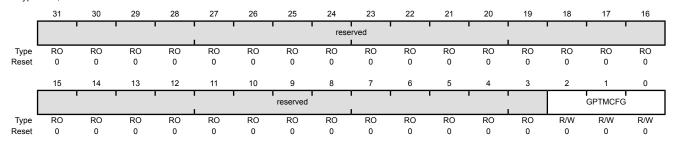
Important: Bits in this register should only be changed when the TAEN and TBEN bits in the **GPTMCTL** register are cleared.

GPTM Configuration (GPTMCFG)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x000

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:3	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2:0	GPTMCFG	R/W	0x0	GPTM Configuration

The ${\tt GPTMCFG}$ values are defined as follows:

Value Description
0x0 32-bit timer configuration.

0x1 32-bit real-time clock (RTC) counter configuration.

0x2-0x3 Reserved

0x4 16-bit timer configuration.

The function is controlled by bits 1:0 of $\ensuremath{\mathbf{GPTMTAMR}}$ and

GPTMTBMR.

0x5-0x7 Reserved

Register 2: GPTM Timer A Mode (GPTMTAMR), offset 0x004

This register configures the GPTM based on the configuration selected in the **GPTMCFG** register. When in PWM mode, set the TAAMS bit, clear the TACMR bit, and configure the TAMR field to 0x1 or 0x2.

This register controls the modes for Timer A when it is used individually. When Timer A and Timer B are concatenated, this register controls the modes for both Timer A and Timer B, and the contents of **GPTMTBMR** are ignored.

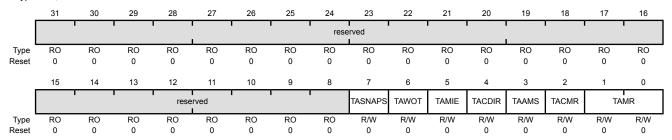
Important: Bits in this register should only be changed when the TAEN bit in the GPTMCTL register is cleared.

GPTM Timer A Mode (GPTMTAMR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x004

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	TASNAPS	R/W	0	GPTM Timer A Snap-Shot Mode

Value Description

- 0 Snap-shot mode is disabled.
- If Timer A is configured in the periodic mode, the actual free-running value of Timer A is loaded at the time-out event into the GPTM Timer A (GPTMTAR) register. If the timer prescaler is used, the prescaler snapshot is loaded into the GPTM Timer A (GPTMTAPR).

6 TAWOT R/W 0 GPTM Timer A Wait-on-Trigger

Value Description

- 0 Timer A begins counting as soon as it is enabled.
- If Timer A is enabled (TAEN is set in the GPTMCTL register), Timer A does not begin counting until it receives a trigger from the timer in the previous position in the daisy chain, see Figure 10-2 on page 450. This function is valid for both one-shot and periodic modes.

This bit must be clear for GP Timer Module 0, Timer A.

Bit/Field	Name	Туре	Reset	Description
5	TAMIE	R/W	0	GPTM Timer A Match Interrupt Enable
				Value Description
				0 The match interrupt is disabled.
				An interrupt is generated when the match value in the GPTMTAMATCHR register is reached in the one-shot and periodic modes.
4	TACDIR	R/W	0	GPTM Timer A Count Direction
				Value Description
				0 The timer counts down.
				1 When in one-shot or periodic mode, the timer counts up. When counting up, the timer starts from a value of 0x0.
				When in PWM or RTC mode, the status of this bit is ignored. PWM mode always counts down and RTC mode always counts up.
3	TAAMS	R/W	0	GPTM Timer A Alternate Mode Select
				The TAAMS values are defined as follows:
				Value Description
				0 Capture mode is enabled.
				1 PWM mode is enabled.
				Note: To enable PWM mode, you must also clear the TACMR bit and configure the TAMR field to 0x1 or 0x2.
2	TACMR	R/W	0	GPTM Timer A Capture Mode
				The TACMR values are defined as follows:
				Value Description
				0 Edge-Count mode
				1 Edge-Time mode
1:0	TAMR	R/W	0x0	GPTM Timer A Mode
				The TAMR values are defined as follows:
				Value Description
				0x0 Reserved
				0x1 One-Shot Timer mode
				0x2 Periodic Timer mode
				0x3 Capture mode
				The Timer mode is based on the timer configuration defined by bits 2:0 in the GPTMCFG register.

Register 3: GPTM Timer B Mode (GPTMTBMR), offset 0x008

This register configures the GPTM based on the configuration selected in the **GPTMCFG** register. When in PWM mode, set the TBAMS bit, clear the TBCMR bit, and configure the TBMR field to 0x1 or 0x2.

This register controls the modes for Timer B when it is used individually. When Timer A and Timer B are concatenated, this register is ignored and **GPTMTBMR** controls the modes for both Timer A and Timer B.

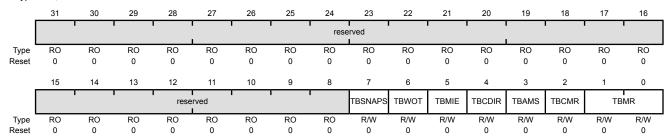
Important: Bits in this register should only be changed when the TBEN bit in the **GPTMCTL** register is cleared.

GPTM Timer B Mode (GPTMTBMR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x008

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	TBSNAPS	R/W	0	GPTM Timer B Snap-Shot Mode

Value Description

- 0 Snap-shot mode is disabled.
- If Timer B is configured in the periodic mode, the actual free-running value of Timer B is loaded at the time-out event into the GPTM Timer B (GPTMTBR) register. If the timer prescaler is used, the prescaler snapshot is loaded into the GPTM Timer B (GPTMTBPR).

6 TBWOT R/W 0 GPTM Timer B Wait-on-Trigger

Value Description

- 0 Timer B begins counting as soon as it is enabled.
- 1 If Timer B is enabled (TBEN is set in the **GPTMCTL** register), Timer B does not begin counting until it receives an it receives a trigger from the timer in the previous position in the daisy chain, see Figure 10-2 on page 450. This function is valid for both one-shot and periodic modes.

Bit/Field	Name	Туре	Reset	Description
5	TBMIE	R/W	0	GPTM Timer B Match Interrupt Enable
				Value Description
				0 The match interrupt is disabled.
				An interrupt is generated when the match value in the GPTMTBMATCHR register is reached in the one-shot and periodic modes.
4	TBCDIR	R/W	0	GPTM Timer B Count Direction
				Value Description
				0 The timer counts down.
				When in one-shot or periodic mode, the timer counts up. When counting up, the timer starts from a value of 0x0.
				When in PWM or RTC mode, the status of this bit is ignored. PWM mode always counts down and RTC mode always counts up.
3	TBAMS	R/W	0	GPTM Timer B Alternate Mode Select
				The TBAMS values are defined as follows:
				Value Description
				Value Description 0 Capture mode is enabled.
				PWM mode is enabled.
				Note: To enable PWM mode, you must also clear the TBCMR bit and configure the TBMR field to 0x1 or 0x2.
2	TBCMR	R/W	0	GPTM Timer B Capture Mode
				The TBCMR values are defined as follows:
				Value Description
				0 Edge-Count mode
				1 Edge-Time mode
1:0	TBMR	R/W	0x0	GPTM Timer B Mode
				The TBMR values are defined as follows:
				Value Description
				0x0 Reserved
				0x1 One-Shot Timer mode
				0x2 Periodic Timer mode
				0x3 Capture mode
				The timer mode is based on the timer configuration defined by bits 2:0 in the GPTMCFG register.

Register 4: GPTM Control (GPTMCTL), offset 0x00C

This register is used alongside the **GPTMCFG** and **GMTMTnMR** registers to fine-tune the timer configuration, and to enable other features such as timer stall and the output trigger. The output trigger can be used to initiate transfers on the ADC module.

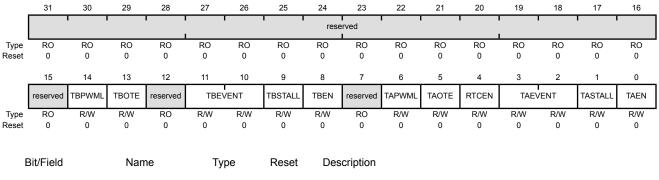
Important: Bits in this register should only be changed when the TnEN bit for the respective timer is cleared.

GPTM Control (GPTMCTL)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x00C

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:15	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
14	TBPWML	R/W	0	GPTM Timer B PWM Output Level
				The TBPWML values are defined as follows:
				Value Description
				0 Output is unaffected.
				1 Output is inverted.
13	ТВОТЕ	R/W	0	GPTM Timer B Output Trigger Enable
				The TBOTE values are defined as follows:
				Value Description
				0 The output Timer B ADC trigger is disabled.
				1 The output Timer B ADC trigger is enabled.
				In addition, the ADC must be enabled and the timer selected as a trigger source with the ${\tt EMn}$ bit in the ADCEMUX register (see page 545).
12	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
11:10	TBEVENT	R/W	0x0	GPTM Timer B Event Mode
				The TBEVENT values are defined as follows:
				Value Description
				0x0 Positive edge
				0x1 Negative edge
				0x2 Reserved
				0x3 Both edges
9	TBSTALL	R/W	0	GPTM Timer B Stall Enable
				The TBSTALL values are defined as follows:
				Value Description
				Timer B continues counting while the processor is halted by the debugger.
				1 Timer B freezes counting while the processor is halted by the debugger.
				If the processor is executing normally, the ${\tt TBSTALL}$ bit is ignored.
8	TBEN	R/W	0	GPTM Timer B Enable
				The TBEN values are defined as follows:
				Value Description
				0 Timer B is disabled.
				1 Timer B is enabled and begins counting or the capture logic is enabled based on the GPTMCFG register.
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	TAPWML	R/W	0	GPTM Timer A PWM Output Level
· ·			·	The TAPWML values are defined as follows:
				Value Description
				0 Output is unaffected.
				1 Output is inverted.
5	TAOTE	R/W	0	GPTM Timer A Output Trigger Enable
				The TAOTE values are defined as follows:
				Value Description
				O The output Timer A ADC trigger is disabled.
				The output Timer A ADC trigger is disabled. The output Timer A ADC trigger is enabled.
				In addition, the ADC must be enabled and the timer selected as a trigger source with the EMn bit in the ADCEMUX register (see page 545).

Bit/Field	Name	Туре	Reset	Description
4	RTCEN	R/W	0	GPTM RTC Stall Enable
				The RTCEN values are defined as follows:
				Value Description
				0 RTC counting freezes while the processor is halted by the debugger.
				1 RTC counting continues while the processor is halted by the debugger.
				If the RTCEN bit is set, it prevents the timer from stalling in all operating modes, even if ${\tt ThSTALL}$ is set.
3:2	TAEVENT	R/W	0x0	GPTM Timer A Event Mode
				The TAEVENT values are defined as follows:
				Value Description
				0x0 Positive edge
				0x1 Negative edge
				0x2 Reserved
				0x3 Both edges
1	TASTALL	R/W	0	GPTM Timer A Stall Enable
				The TASTALL values are defined as follows:
				Value Description
				Timer A continues counting while the processor is halted by the debugger.
				Timer A freezes counting while the processor is halted by the debugger.
				If the processor is executing normally, the TASTALL bit is ignored.
0	TAEN	R/W	0	GPTM Timer A Enable
				The TAEN values are defined as follows:
				Value Description
				0 Timer A is disabled.
				1 Timer A is enabled and begins counting or the capture logic is enabled based on the GPTMCFG register.

Register 5: GPTM Interrupt Mask (GPTMIMR), offset 0x018

This register allows software to enable/disable GPTM controller-level interrupts. Setting a bit enables the corresponding interrupt, while clearing a bit disables it.

GPTM Interrupt Mask (GPTMIMR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x018

Type R/W, reset 0x0000.0000

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	'		'				'	rese	rved			•				
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
Reset																
Г	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
L			erved		TBMIM	CBEIM	СВМІМ	TBTOIM		reserved		TAMIM	RTCIM	CAEIM	CAMIM	TATOIM
Type Reset	RO 0	RO 0	RO 0	RO 0	R/W 0	R/W 0	R/W 0	R/W 0	RO 0	RO 0	RO 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0
В	it/Field		Nam	ne	Ту	ре	Reset	Des	cription							
	31:12		reserv	/ed	R	0	0x0000.0) Soft	ware sh	ould not r	elv on tl	he value	of a res	erved bit	To prov	ride
	O 1		100011			•		com	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be							
								pres	erved a	cross a re	ead-mod	dify-write	operation	n.		
	11		TBM	IM	R/	W	0	GPT	M Time	r B Match	Interru	pt Mask				
										values ar			ows:			
									_							
									ie Des	•						
								0		rupt is dis						
								1	Inter	rupt is en	abled.					
	10		CBE	IM	R/	W	0	GPTM Timer B Capture Mode Event Interrupt Mask								
								The	CBEIM	values ar	e define	d as follo	ows:			
								Valu	ie Des	cription						
								0	Inter	rupt is dis	abled.					
								1		rupt is en						
										•						
	9		СВМ	IM	R/	W	0	GPT	M Time	r B Captu	re Mode	e Match	Interrunt	Mask		
			02				ū			values ar						
									_							
									ie Des	•						
								0	Inter	rupt is dis	abled.					

Interrupt is enabled.

Bit/Field	Name	Туре	Reset	Description
8	ТВТОІМ	R/W	0	GPTM Timer B Time-Out Interrupt Mask
				The TBTOIM values are defined as follows:
				Value Description
				0 Interrupt is disabled.
				1 Interrupt is enabled.
7:5	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	TAMIM	R/W	0	GPTM Timer A Match Interrupt Mask
				The TAMIM values are defined as follows:
				Value Description
				0 Interrupt is disabled.
				1 Interrupt is enabled.
3	RTCIM	R/W	0	GPTM RTC Interrupt Mask
				The RTCIM values are defined as follows:
				Value Description
				0 Interrupt is disabled.
				1 Interrupt is enabled.
2	CAEIM	R/W	0	GPTM Timer A Capture Mode Event Interrupt Mask
				The CAEIM values are defined as follows:
				Value Description
				0 Interrupt is disabled.
				1 Interrupt is enabled.
1	CAMIM	R/W	0	GPTM Timer A Capture Mode Match Interrupt Mask
				The CAMIM values are defined as follows:
				Value Description
				0 Interrupt is disabled.
				1 Interrupt is enabled.
0	TATOIM	R/W	0	GPTM Timer A Time-Out Interrupt Mask
				The TATOIM values are defined as follows:
				Value Description
				0 Interrupt is disabled.
				1 Interrupt is enabled.

Register 6: GPTM Raw Interrupt Status (GPTMRIS), offset 0x01C

This register shows the state of the GPTM's internal interrupt signal. These bits are set whether or not the interrupt is masked in the **GPTMIMR** register. Each bit can be cleared by writing a 1 to its corresponding bit in **GPTMICR**.

GPTM Raw Interrupt Status (GPTMRIS)

Name

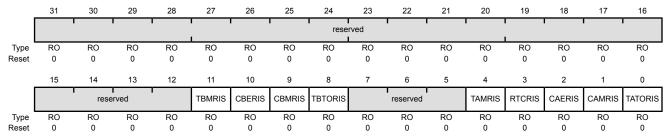
Type

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x01C

Bit/Field

Type RO, reset 0x0000.0000



31:12	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
11	TBMRIS	RO	0	GPTM Timer B Match Raw Interrupt

Reset

Description

Value Description

- 1 The TBMIE bit is set in the **GPTMTBMR** register, and the match values in the **GPTMTBMATCHR** and (optionally) **GPTMTBPMR** registers have been reached when configured in one-shot or periodic mode.
- 0 The match value has not been reached.

This bit is cleared by writing a 1 to the ${\tt TBMCINT}$ bit in the ${\bf GPTMICR}$ register.

10 CBERIS RO 0 GPTM Timer B Capture Mode Event Raw Interrupt

Value Description

- 1 A capture mode event has occurred for Timer B. This interrupt asserts when the subtimer is configured in Input Edge-Time mode.
- 0 The capture mode event for Timer B has not occurred.

This bit is cleared by writing a 1 to the ${\tt CBECINT}$ bit in the $\mbox{{\tt GPTMICR}}$ register.

Bit/Field	Name	Туре	Reset	Description
9	CBMRIS	RO	0	GPTM Timer B Capture Mode Match Raw Interrupt
				Value Description
				The capture mode match has occurred for Timer B. This interrupt asserts when the values in the GPTMTBR and GPTMTBPR match the values in the GPTMTBMATCHR and GPTMTBPMR when configured in Input Edge-Time mode.
				0 The capture mode match for Timer B has not occurred.
				This bit is cleared by writing a 1 to the CBMCINT bit in the GPTMICR register.
8	TBTORIS	RO	0	GPTM Timer B Time-Out Raw Interrupt
				Value Description
				Timer B has timed out. This interrupt is asserted when a one-shot or periodic mode timer reaches it's count limit (0 or the value loaded into GPTMTBILR, depending on the count direction).
				0 Timer B has not timed out.
				This bit is cleared by writing a 1 to the ${\tt TBTOCINT}$ bit in the ${\tt GPTMICR}$ register.
7:5	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	TAMRIS	RO	0	GPTM Timer A Match Raw Interrupt
				Value Description
				The TAMIE bit is set in the GPTMTAMR register, and the match value in the GPTMTAMATCHR and (optionally) GPTMTAPMR registers have been reached when configured in one-shot or periodic mode.
				0 The match value has not been reached.
				This bit is cleared by writing a 1 to the TAMCINT bit in the GPTMICR register.
3	RTCRIS	RO	0	GPTM RTC Raw Interrupt
				Value Description
				1 The RTC event has occurred.
				0 The RTC event has not occurred.
				This bit is cleared by writing a 1 to the RTCCINT bit in the GPTMICR register.

Bit/Field	Name	Туре	Reset	Description
2	CAERIS	RO	0	GPTM Timer A Capture Mode Event Raw Interrupt
				Value Description
				A capture mode event has occurred for Timer A. This interrupt asserts when the subtimer is configured in Input Edge-Time mode.
				0 The capture mode event for Timer A has not occurred.
				This bit is cleared by writing a 1 to the CAECINT bit in the GPTMICR register.
1	CAMRIS	RO	0	GPTM Timer A Capture Mode Match Raw Interrupt
				Value Description
				A capture mode match has occurred for Timer A. This interrupt asserts when the values in the GPTMTAR and GPTMTAPR match the values in the GPTMTAMATCHR and GPTMTAPMR when configured in Input Edge-Time mode.
				The capture mode match for Timer A has not occurred.
				This bit is cleared by writing a 1 to the CAMCINT bit in the GPTMICR register.
0	TATORIS	RO	0	GPTM Timer A Time-Out Raw Interrupt
				Value Description
				Timer A has timed out. This interrupt is asserted when a one-shot or periodic mode timer reaches it's count limit (0 or the value loaded into GPTMTAILR, depending on the count direction).
				0 Timer A has not timed out.
				This bit is cleared by writing a 1 to the TATOCINT bit in the GPTMICR register.

Register 7: GPTM Masked Interrupt Status (GPTMMIS), offset 0x020

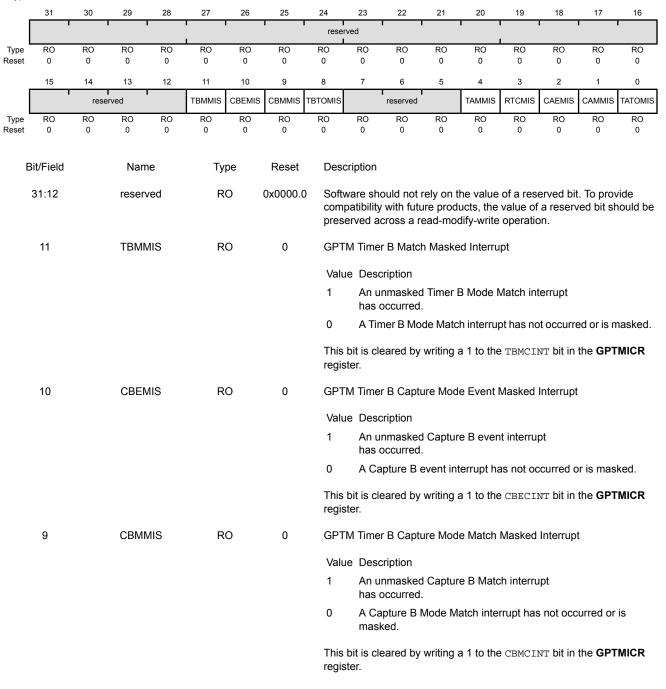
This register show the state of the GPTM's controller-level interrupt. If an interrupt is unmasked in **GPTMIMR**, and there is an event that causes the interrupt to be asserted, the corresponding bit is set in this register. All bits are cleared by writing a 1 to the corresponding bit in **GPTMICR**.

GPTM Masked Interrupt Status (GPTMMIS)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x020

Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
8	TBTOMIS	RO	0	GPTM Timer B Time-Out Masked Interrupt
				Value Description
				An unmasked Timer B Time-Out interrupt has occurred.
				0 A Timer B Time-Out interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the ${\tt TBTOCINT}$ bit in the ${\tt GPTMICR}$ register.
7:5	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	TAMMIS	RO	0	GPTM Timer A Match Masked Interrupt
				Value Description
				 An unmasked Timer A Mode Match interrupt has occurred.
				0 A Timer A Mode Match interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the TAMCINT bit in the GPTMICR register.
3	RTCMIS	RO	0	GPTM RTC Masked Interrupt
				Value Description
				1 An unmasked RTC event interrupt has occurred.
				O An RTC event interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the RTCCINT bit in the GPTMICR register.
2	CAEMIS	RO	0	GPTM Timer A Capture Mode Event Masked Interrupt
				Value Description
				 An unmasked Capture A event interrupt has occurred.
				0 A Capture A event interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the CAECINT bit in the GPTMICR register.
1	CAMMIS	RO	0	GPTM Timer A Capture Mode Match Masked Interrupt
				Value Description
				 An unmasked Capture A Match interrupt has occurred.
				O A Capture A Mode Match interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the CAMCINT bit in the GPTMICR register.

Bit/Field	Name	Туре	Reset	Description
0	TATOMIS	RO	0	GPTM Timer A Time-Out Masked Interrupt
				Value Description
				 An unmasked Timer A Time-Out interrupt has occurred.
				0 A Timer A Time-Out interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the ${\tt TATOCINT}$ bit in the ${\tt GPTMICR}$ register.

Register 8: GPTM Interrupt Clear (GPTMICR), offset 0x024

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This register is used to clear the status bits in the **GPTMRIS** and **GPTMMIS** registers. Writing a 1 to a bit clears the corresponding bit in the **GPTMRIS** and **GPTMMIS** registers.

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and the TAMMIS bit in the GPTMMIS register.

and the RTCMIS bit in the GPTMMIS register.

and the CAEMIS bit in the GPTMMIS register.

GPTM Timer A Capture Mode Event Interrupt Clear

Writing a 1 to this bit clears the RTCRIS bit in the GPTMRIS register

Writing a 1 to this bit clears the CAERIS bit in the GPTMRIS register

GPTM RTC Interrupt Clear

20

19

18

16

GPTM Interrupt Clear (GPTMICR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x024

31

3

2

RTCCINT

CAECINT

W1C

W1C

0

0

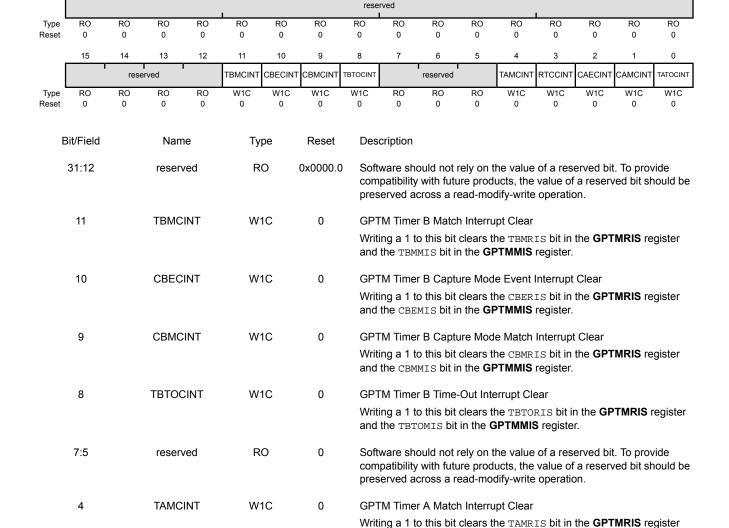
Type W1C, reset 0x0000.0000

30

29

28

27



Bit/Field	Name	Туре	Reset	Description
1	CAMCINT	W1C	0	GPTM Timer A Capture Mode Match Interrupt Clear Writing a 1 to this bit clears the CAMRIS bit in the GPTMRIS register and the CAMMIS bit in the GPTMMIS register.
0	TATOCINT	W1C	0	GPTM Timer A Time-Out Raw Interrupt Writing a 1 to this bit clears the TATORIS bit in the GPTMRIS register and the TATOMIS bit in the GPTMMIS register.

Register 9: GPTM Timer A Interval Load (GPTMTAILR), offset 0x028

When the timer is counting down, this register is used to load the starting count value into the timer. When the timer is counting up, this register sets the upper bound for the timeout event.

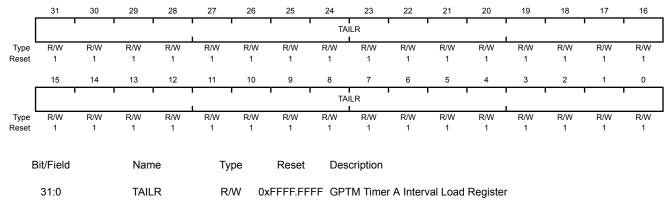
When a GPTM is configured to one of the 32-bit modes, **GPTMTAILR** appears as a 32-bit register (the upper 16-bits correspond to the contents of the **GPTM Timer B Interval Load (GPTMTBILR)** register). In a 16-bit mode, the upper 16 bits of this register read as 0s and have no effect on the state of **GPTMTBILR**.

GPTM Timer A Interval Load (GPTMTAILR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x028

Type R/W, reset 0xFFFF.FFF



Writing this field loads the counter for Timer A. A read returns the current value of **GPTMTAILR**.

Register 10: GPTM Timer B Interval Load (GPTMTBILR), offset 0x02C

When the timer is counting down, this register is used to load the starting count value into the timer. When the timer is counting up, this register sets the upper bound for the timeout event.

When a GPTM is configured to one of the 32-bit modes, the contents of bits 15:0 in this register are loaded into the upper 16 bits of the **GPTMTAILR** register. Reads from this register return the current value of Timer B and writes are ignored. In a 16-bit mode, bits 15:0 are used for the load value. Bits 31:16 are reserved in both cases.

GPTM Timer B Interval Load (GPTMTBILR)

TBILR

R/W

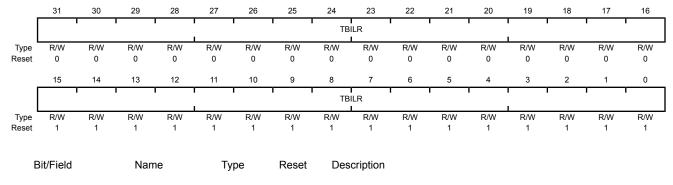
0x0000.FFFF

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x02C

31:0

Type R/W, reset 0x0000.FFFF



Writing this field loads the counter for Timer B. A read returns the current value of **GPTMTBILR**.

GPTM Timer B Interval Load Register

When a GPTM is in 32-bit mode, writes are ignored, and reads return the current value of **GPTMTBILR**.

Register 11: GPTM Timer A Match (GPTMTAMATCHR), offset 0x030

This register is loaded with a match value. Interrupts can be generated when the timer value is equal to the value in this register in one-shot or periodic mode.

In Edge-Count mode, this register along with **GPTMTAILR**, determines how many edge events are counted. The total number of edge events counted is equal to the value in **GPTMTAILR** minus this value.

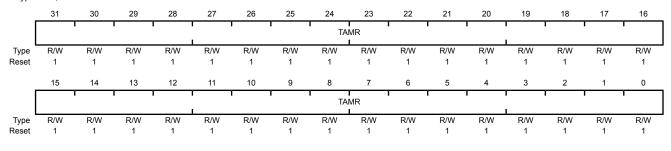
In PWM mode, this value along with **GPTMTAILR**, determines the duty cycle of the output PWM signal.

When a GPTM is configured to one of the 32-bit modes, **GPTMTAMATCHR** appears as a 32-bit register (the upper 16-bits correspond to the contents of the **GPTM Timer B Match** (**GPTMTBMATCHR**) register). In a 16-bit mode, the upper 16 bits of this register read as 0s and have no effect on the state of **GPTMTBMATCHR**.

GPTM Timer A Match (GPTMTAMATCHR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x030

Type R/W, reset 0xFFFF.FFFF



Bit/Field	Name	Туре	Reset	Description
31:0	TAMR	R/W (xFFFF.FFF	GPTM Timer A Match Register

This value is compared to the **GPTMTAR** register to determine match events.

Register 12: GPTM Timer B Match (GPTMTBMATCHR), offset 0x034

This register is loaded with a match value. Interrupts can be generated when the timer value is equal to the value in this register in one-shot or periodic mode.

In Edge-Count mode, this register along with **GPTMTBILR**, determines how many edge events are counted. The total number of edge events counted is equal to the value in **GPTMTBILR** minus this value.

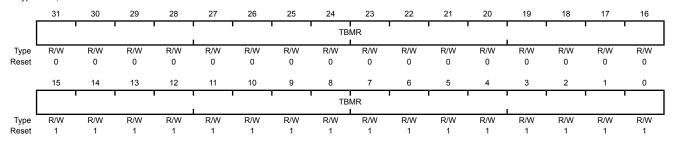
In PWM mode, this value along with **GPTMTBILR**, determines the duty cycle of the output PWM signal.

When a GPTM is configured to one of the 32-bit modes, the contents of bits 15:0 in this register are loaded into the upper 16 bits of the **GPTMTAMATCHR** register. Reads from this register return the current match value of Timer B and writes are ignored. In a 16-bit mode, bits 15:0 are used for the match value. Bits 31:16 are reserved in both cases.

GPTM Timer B Match (GPTMTBMATCHR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x034

Type R/W, reset 0x0000.FFFF



Bit/Field	Name	Type	Reset	Description
31:0	TBMR	R/W	0x0000.FFFF	GPTM Timer B Match Register

This value is compared to the $\ensuremath{\mathbf{GPTMTBR}}$ register to determine match events.

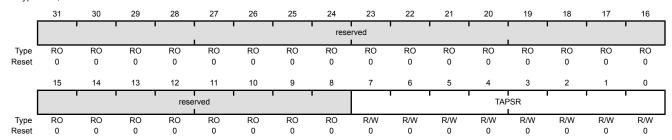
Register 13: GPTM Timer A Prescale (GPTMTAPR), offset 0x038

This register allows software to extend the range of the 16-bit timers in periodic and one-shot modes. In Edge-Count mode, this register is the MSB of the 24-bit count value.

GPTM Timer A Prescale (GPTMTAPR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x038

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	TAPSR	R/W	0x00	GPTM Timer A Prescale

The register loads this value on a write. A read returns the current value of the register.

Refer to Table 10-6 on page 450 for more details and an example.

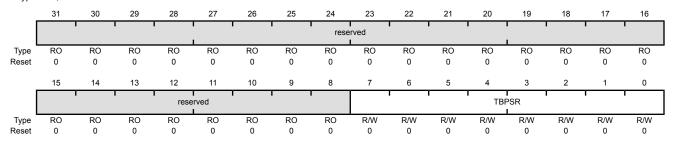
Register 14: GPTM Timer B Prescale (GPTMTBPR), offset 0x03C

This register allows software to extend the range of the 16-bit timers in periodic and one-shot modes. In Edge-Count mode, this register is the MSB of the 24-bit count value.

GPTM Timer B Prescale (GPTMTBPR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x03C

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	TBPSR	R/W	0x00	GPTM Timer B Prescale

The register loads this value on a write. A read returns the current value of this register.

Refer to Table 10-6 on page 450 for more details and an example.

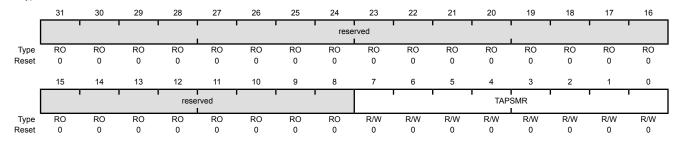
Register 15: GPTM TimerA Prescale Match (GPTMTAPMR), offset 0x040

This register effectively extends the range of **GPTMTAMATCHR** to 24 bits when operating in 16-bit one-shot or periodic mode.

GPTM TimerA Prescale Match (GPTMTAPMR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x040

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	TAPSMR	R/W	0x00	GPTM TimerA Prescale Match

This value is used alongside **GPTMTAMATCHR** to detect timer match events while using a prescaler.

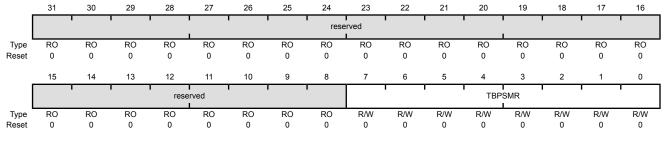
Register 16: GPTM TimerB Prescale Match (GPTMTBPMR), offset 0x044

This register effectively extends the range of GPTMTBMATCHR to 24 bits when operating in 16-bit one-shot or periodic mode.

GPTM TimerB Prescale Match (GPTMTBPMR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x044

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	TBPSMR	R/W	0x00	GPTM TimerB Prescale Match

This value is used alongside **GPTMTBMATCHR** to detect timer match events while using a prescaler.

Register 17: GPTM Timer A (GPTMTAR), offset 0x048

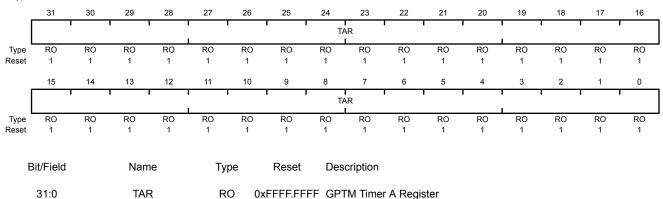
This register shows the current value of the Timer A counter in all cases except for Input Edge Count and Time modes. In the Input Edge Count mode, this register contains the number of edges that have occurred. In the Input Edge Time mode, this register contains the time at which the last edge event took place. Also in Input Edge-Count mode, bits 23:16 contain the upper 8 bits of the count.

When a GPTM is configured to one of the 32-bit modes, **GPTMTAR** appears as a 32-bit register (the upper 16-bits correspond to the contents of the GPTM Timer B (GPTMTBR) register). In the16-bit Input Edge Count, Input Edge Time, and PWM modes, bits 15:0 contain the value of the counter and bits 23:16 contain the value of the prescaler, which is the upper 8 bits of the count. Bits 31:24 always read as 0. To read the value of the prescaler in 16-bit One-Shot and Periodic modes, read bits [23:16] in the GPTMTAV register.

GPTM Timer A (GPTMTAR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x048

Type RO, reset 0xFFFF.FFFF



A read returns the current value of the **GPTM Timer A Count Register**, in all cases except for Input Edge Count and Time modes. In the Input Edge Count mode, this register contains the number of edges that have occurred. In the Input Edge Time mode, this register contains the time at which the last edge event took place.

Register 18: GPTM Timer B (GPTMTBR), offset 0x04C

This register shows the current value of the Timer B counter in all cases except for Input Edge Count and Time modes. In the Input Edge Count mode, this register contains the number of edges that have occurred. In the Input Edge Time mode, this register contains the time at which the last edge event took place. Also in Input Edge-Count mode, bits 23:16 contain the upper 8 bits of the count.

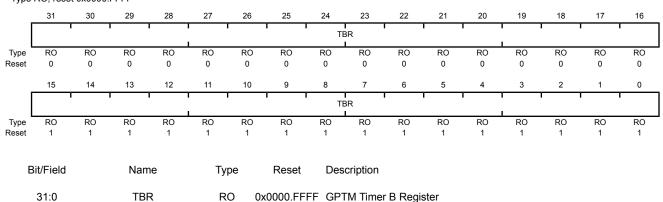
When a GPTM is configured to one of the 32-bit modes, the contents of bits 15:0 in this register are loaded into the upper 16 bits of the **GPTMTAR** register. Reads from this register return the current value of Timer B. In a 16-bit mode, bits 15:0 contain the value of the counter and bits 23:16 contain the value of the prescaler in Input Edge Count, Input Edge Time, and PWM modes, which is the upper 8 bits of the count. Bits 31:24 always read as 0. To read the value of the prescaler in 16-bit One-Shot and Periodic modes, read bits [23:16] in the **GPTMTBV** register.

GPTM Timer B (GPTMTBR)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000

Offset 0x04C

Type RO, reset 0x0000.FFFF



A read returns the current value of the **GPTM Timer B Count Register**, in all cases except for Input Edge Count and Time modes. In the Input Edge Count mode, this register contains the number of edges that have occurred. In the Input Edge Time mode, this register contains the time at which the last edge event took place.

Register 19: GPTM Timer A Value (GPTMTAV), offset 0x050

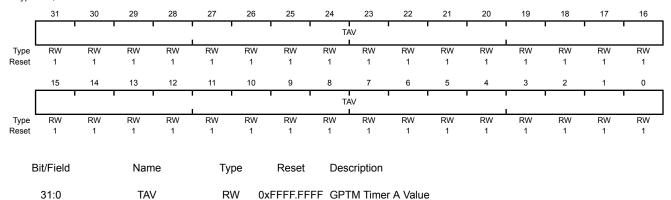
When read, this register shows the current, free-running value of Timer A in all modes. Software can use this value to determine the time elapsed between an interrupt and the ISR entry when using the snapshot feature with the periodic operating mode. When written, the value written into this register is loaded into the **GPTMTAR** register on the next clock cycle. In Input Edge-Count mode, bits 23:16 contain the upper 8 bits of the count.

When a GPTM is configured to one of the 32-bit modes, **GPTMTAV** appears as a 32-bit register (the upper 16-bits correspond to the contents of the **GPTM Timer B Value (GPTMTBV)** register). In a 16-bit mode, bits 15:0 contain the value of the counter and bits 23:16 contain the current, free-running value of the prescaler, which is the upper 8 bits of the count in Input Edge Count, Input Edge Time, PWM and one-shot or periodic up count modes. In one-shot or periodic down count modes, the prescaler stored in 23:16 is a true prescaler, meaning bits 23:16 count down before decrementing the value in bits 15:0. The prescaler in bits 31:24 always reads as 0.

GPTM Timer A Value (GPTMTAV)

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x050

Type RW, reset 0xFFFF.FFF



A read returns the current, free-running value of Timer A in all modes. When written, the value written into this register is loaded into the **GPTMTAR** register on the next clock cycle.

Note: In 16-bit mode, only the lower 16-bits of the GPTMTAV register can be written with a new value. Writes to the

prescaler bits have no effect.

Register 20: GPTM Timer B Value (GPTMTBV), offset 0x054

When read, this register shows the current, free-running value of Timer B in all modes. Software can use this value to determine the time elapsed between an interrupt and the ISR entry. When written, the value written into this register is loaded into the **GPTMTBR** register on the next clock cycle. In Input Edge-Count mode, bits 23:16 contain the upper 8 bits of the count.

When a GPTM is configured to one of the 32-bit modes, the contents of bits 15:0 in this register are loaded into the upper 16 bits of the **GPTMTAV** register. Reads from this register return the current free-running value of Timer B. In a 16-bit mode, bits 15:0 contain the value of the counter and bits 23:16 contain the current, free-running value of the prescaler, which is the upper 8 bits of the count in Input Edge Count, Input Edge Time, PWM and one-shot or periodic up count modes. In one-shot or periodic down count modes, the prescaler stored in 23:16 is a true prescaler, meaning bits 23:16 count down before decrementing the value in bits 15:0. The prescaler in bits 31:24 always reads as 0.

GPTM Timer B Value (GPTMTBV)

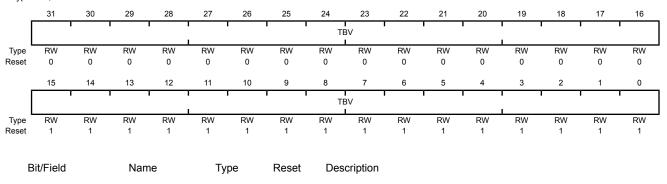
TBV

RW

Timer 0 base: 0x4003.0000 Timer 1 base: 0x4003.1000 Timer 2 base: 0x4003.2000 Offset 0x054

Type RW, reset 0x0000.FFFF

31:0



0x0000.FFFF GPTM Timer B Value

A read returns the current, free-running value of Timer A in all modes.

When written, the value written into this register is loaded into the

GPTMTAR register on the next clock cycle.

Note:

In 16-bit mode, only the lower 16-bits of the **GPTMTBV** register can be written with a new value. Writes to the prescaler bits have no effect.

11 Watchdog Timers

A watchdog timer can generate an interrupt or a reset when a time-out value is reached. The watchdog timer is used to regain control when a system has failed due to a software error or due to the failure of an external device to respond in the expected way. The LM3S1J11 microcontroller has two Watchdog Timer Modules, one module is clocked by the system clock (Watchdog Timer 0) and the other is clocked by the PIOSC (Watchdog Timer 1). The two modules are identical except that WDT1 is in a different clock domain, and therefore requires synchronizers. As a result, WDT1 has a bit defined in the **Watchdog Timer Control (WDTCTL)** register to indicate when a write to a WDT1 register is complete. Software can use this bit to ensure that the previous access has completed before starting the next access.

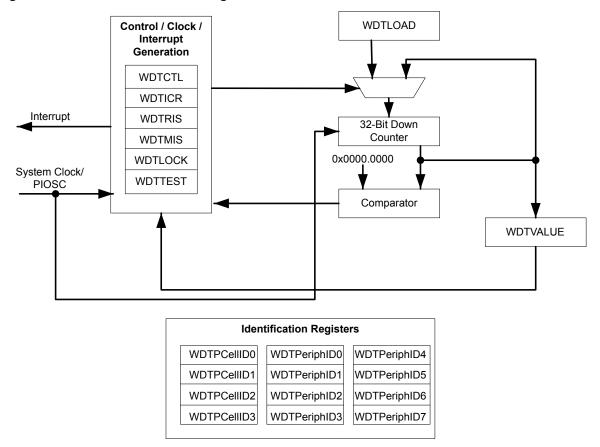
The Stellaris[®] LM3S1J11 controller has two Watchdog Timer modules with the following features:

- 32-bit down counter with a programmable load register
- Separate watchdog clock with an enable
- Programmable interrupt generation logic with interrupt masking
- Lock register protection from runaway software
- Reset generation logic with an enable/disable
- User-enabled stalling when the microcontroller asserts the CPU Halt flag during debug

The Watchdog Timer can be configured to generate an interrupt to the controller on its first time-out, and to generate a reset signal on its second time-out. Once the Watchdog Timer has been configured, the lock register can be written to prevent the timer configuration from being inadvertently altered.

11.1 Block Diagram

Figure 11-1. WDT Module Block Diagram



11.2 Functional Description

The Watchdog Timer module generates the first time-out signal when the 32-bit counter reaches the zero state after being enabled; enabling the counter also enables the watchdog timer interrupt. After the first time-out event, the 32-bit counter is re-loaded with the value of the **Watchdog Timer Load (WDTLOAD)** register, and the timer resumes counting down from that value. Once the Watchdog Timer has been configured, the **Watchdog Timer Lock (WDTLOCK)** register is written, which prevents the timer configuration from being inadvertently altered by software.

If the timer counts down to its zero state again before the first time-out interrupt is cleared, and the reset signal has been enabled by setting the RESEN bit in the **WDTCTL** register, the Watchdog timer asserts its reset signal to the system. If the interrupt is cleared before the 32-bit counter reaches its second time-out, the 32-bit counter is loaded with the value in the **WDTLOAD** register, and counting resumes from that value.

If **WDTLOAD** is written with a new value while the Watchdog Timer counter is counting, then the counter is loaded with the new value and continues counting.

Writing to **WDTLOAD** does not clear an active interrupt. An interrupt must be specifically cleared by writing to the **Watchdog Interrupt Clear (WDTICR)** register.

The Watchdog module interrupt and reset generation can be enabled or disabled as required. When the interrupt is re-enabled, the 32-bit counter is preloaded with the load register value and not its last state.

11.2.1 Register Access Timing

Because the Watchdog Timer 1 module has an independent clocking domain, its registers must be written with a timing gap between accesses. Software must guarantee that this delay is inserted between back-to-back writes to WDT1 registers or between a write followed by a read to the registers. The timing for back-to-back reads from the WDT1 module has no restrictions. The WRC bit in the **Watchdog Control (WDTCTL)** register for WDT1 indicates that the required timing gap has elapsed. This bit is cleared on a write operation and set once the write completes, indicating to software that another write or read may be started safely. Software should poll **WDTCTL** for WRC=1 prior to accessing another register. Note that WDT0 does not have this restriction as it runs off the system clock.

11.3 Initialization and Configuration

To use the WDT, its peripheral clock must be enabled by setting the WDT bit in the **RCGC0n** register, see page 240.

The Watchdog Timer is configured using the following sequence:

- 1. Load the WDTLOAD register with the desired timer load value.
- 2. If WDT1, wait for the WRC bit in the WDTCTL register to be set.
- If the Watchdog is configured to trigger system resets, set the RESEN bit in the WDTCTL register.
- 4. If WDT1, wait for the WRC bit in the WDTCTL register to be set.
- 5. Set the INTEN bit in the WDTCTL register to enable the Watchdog and lock the control register.

If software requires that all of the watchdog registers are locked, the Watchdog Timer module can be fully locked by writing any value to the **WDTLOCK** register. To unlock the Watchdog Timer, write a value of 0x1ACC.E551.

To service the watchdog, periodically reload the count value into the **WDTLOAD** register to restart the count. The interrupt can be enabled using the INTEN bit in the **WDTCTL** register to allow the processor to attempt corrective action if the watchdog is not serviced often enough. The RESEN bit in the **WDTCTL** can be set so that the system resets if the failure is not recoverable using the ISR.

11.4 Register Map

Table 11-1 on page 494 lists the Watchdog registers. The offset listed is a hexadecimal increment to the register's address, relative to the Watchdog Timer base address:

■ WDT0: 0x4000.0000 ■ WDT1: 0x4000.1000

Note that the Watchdog Timer module clock must be enabled before the registers can be programmed (see page 240).

Table 11-1. Watchdog Timers Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	WDTLOAD	R/W	0xFFFF.FFFF	Watchdog Load	495
0x004	WDTVALUE	RO	0xFFFF.FFFF	Watchdog Value	496
0x008	WDTCTL	R/W	0x0000.0000 (WDT0) 0x8000.0000 (WDT1)	Watchdog Control	497
0x00C	WDTICR	WO	-	Watchdog Interrupt Clear	499
0x010	WDTRIS	RO	0x0000.0000	Watchdog Raw Interrupt Status	500
0x014	WDTMIS	RO	0x0000.0000	Watchdog Masked Interrupt Status	501
0x418	WDTTEST	R/W	0x0000.0000	Watchdog Test	502
0xC00	WDTLOCK	R/W	0x0000.0000	Watchdog Lock	503
0xFD0	WDTPeriphID4	RO	0x0000.0000	Watchdog Peripheral Identification 4	504
0xFD4	WDTPeriphID5	RO	0x0000.0000	Watchdog Peripheral Identification 5	505
0xFD8	WDTPeriphID6	RO	0x0000.0000	Watchdog Peripheral Identification 6	506
0xFDC	WDTPeriphID7	RO	0x0000.0000	Watchdog Peripheral Identification 7	507
0xFE0	WDTPeriphID0	RO	0x0000.0005	Watchdog Peripheral Identification 0	508
0xFE4	WDTPeriphID1	RO	0x0000.0018	Watchdog Peripheral Identification 1	509
0xFE8	WDTPeriphID2	RO	0x0000.0018	Watchdog Peripheral Identification 2	510
0xFEC	WDTPeriphID3	RO	0x0000.0001	Watchdog Peripheral Identification 3	511
0xFF0	WDTPCellID0	RO	0x0000.000D	Watchdog PrimeCell Identification 0	512
0xFF4	WDTPCellID1	RO	0x0000.00F0	Watchdog PrimeCell Identification 1	513
0xFF8	WDTPCellID2	RO	0x0000.0006	Watchdog PrimeCell Identification 2	514
0xFFC	WDTPCellID3	RO	0x0000.00B1	Watchdog PrimeCell Identification 3	515

11.5 Register Descriptions

The remainder of this section lists and describes the WDT registers, in numerical order by address offset.

Register 1: Watchdog Load (WDTLOAD), offset 0x000

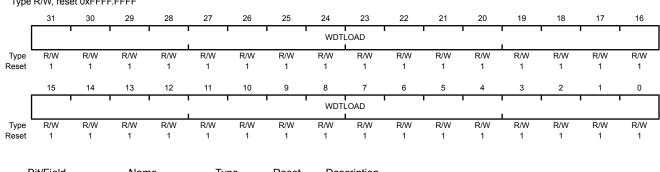
This register is the 32-bit interval value used by the 32-bit counter. When this register is written, the value is immediately loaded and the counter restarts counting down from the new value. If the WDTLOAD register is loaded with 0x0000.0000, an interrupt is immediately generated.

Watchdog Load (WDTLOAD)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000

Offset 0x000

Type R/W, reset 0xFFFF.FFFF



Bit/Field Description Name Type Reset 31:0 **WDTLOAD** R/W 0xFFFF.FFFF Watchdog Load Value

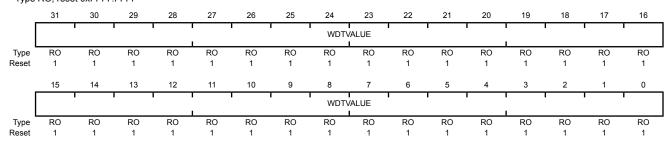
Register 2: Watchdog Value (WDTVALUE), offset 0x004

This register contains the current count value of the timer.

Watchdog Value (WDTVALUE)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0x004

Type RO, reset 0xFFFF.FFFF



Bit/Field Name Type Reset Description

31:0 WDTVALUE RO 0xFFF.FFFF Watchdog Value

Current value of the 32-bit down counter.

Register 3: Watchdog Control (WDTCTL), offset 0x008

This register is the watchdog control register. The watchdog timer can be configured to generate a reset signal (on second time-out) or an interrupt on time-out.

When the watchdog interrupt has been enabled by setting the INTEN bit, all subsequent writes to the INTEN bit are ignored. The only mechanism that can re-enable writes to this bit is a hardware reset.

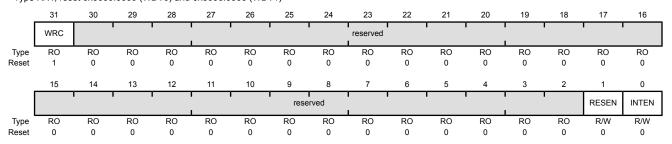
Important: Because the Watchdog Timer 1 module has an independent clocking domain, its registers must be written with a timing gap between accesses. Software must guarantee that this delay is inserted between back-to-back writes to WDT1 registers or between a write followed by a read to the registers. The timing for back-to-back reads from the WDT1 module has no restrictions. The WRC bit in the Watchdog Control (WDTCTL) register for WDT1 indicates that the required timing gap has elapsed. This bit is cleared on a write operation and set once the write completes, indicating to software that another write or read may be started safely. Software should poll WDTCTL for WRC=1 prior to accessing another register. Note that WDT0 does not have this restriction as it runs off the system clock and therefore does not have a WRC bit.

Watchdog Control (WDTCTL)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000

Offset 0x008

Type R/W, reset 0x0000.0000 (WDT0) and 0x8000.0000 (WDT1)



Bit/Field	ivame	туре	Reset	Description
31	WRC	RO	1	Write Complete

The WRC values are defined as follows:

Value Description

- A write access to one of the WDT1 registers is in progress. 0
- A write access is not in progress, and WDT1 registers can be 1 read or written.

This bit is reserved for WDT0 and has a reset value of 0. Note:

30:2 reserved RO 0x000 000 Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be

preserved across a read-modify-write operation.

Bit/Field	Name	Type	Reset	Description
1	RESEN	R/W	0	Watchdog Reset Enable
				The RESEN values are defined as follows:
				Value Description
				0 Disabled.
				1 Enable the Watchdog module reset output.
0	INTEN	R/W	0	Watchdog Interrupt Enable
				The INTEN values are defined as follows:
				Value Description
				0 Interrupt event disabled (once this bit is set, it can only be cleared by a hardware reset).
				1 Interrupt event enabled. Once enabled, all writes are ignored.

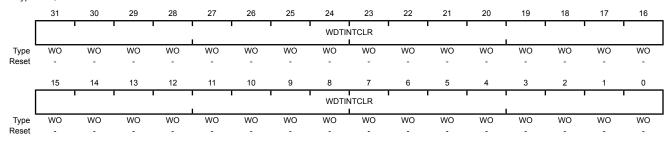
Register 4: Watchdog Interrupt Clear (WDTICR), offset 0x00C

This register is the interrupt clear register. A write of any value to this register clears the Watchdog interrupt and reloads the 32-bit counter from the **WDTLOAD** register. Value for a read or reset is indeterminate.

Watchdog Interrupt Clear (WDTICR)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0x00C

Type WO, reset -



Bit/Field Name Type Reset Description

31:0 WDTINTCLR WO - Watchdog Interrupt Clear

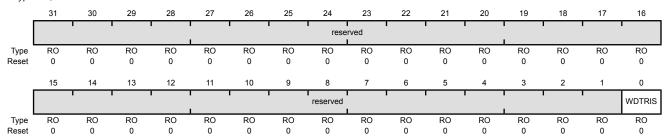
Register 5: Watchdog Raw Interrupt Status (WDTRIS), offset 0x010

This register is the raw interrupt status register. Watchdog interrupt events can be monitored via this register if the controller interrupt is masked.

Watchdog Raw Interrupt Status (WDTRIS)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0x010

Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	WDTRIS	RO	0	Watchdog Raw Interrupt Status

Value Description

- 1 A watchdog time-out event has occurred.
- 0 The watchdog has not timed out.

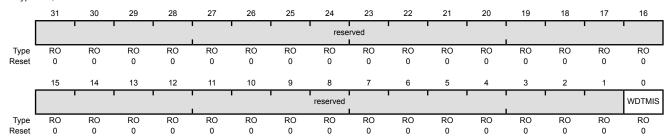
Register 6: Watchdog Masked Interrupt Status (WDTMIS), offset 0x014

This register is the masked interrupt status register. The value of this register is the logical AND of the raw interrupt bit and the Watchdog interrupt enable bit.

Watchdog Masked Interrupt Status (WDTMIS)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0x014

Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	WDTMIS	RO	0	Watchdog Masked Interrupt Status

Value Description

- A watchdog time-out event has been signalled to the interrupt controller.
- 0 The watchdog has not timed out or the watchdog timer interrupt is masked.

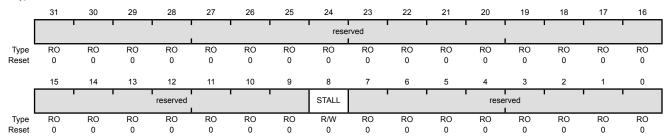
Register 7: Watchdog Test (WDTTEST), offset 0x418

This register provides user-enabled stalling when the microcontroller asserts the CPU halt flag during debug.

Watchdog Test (WDTTEST)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0x418

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:9	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	STALL	R/W	0	Watchdog Stall Enable
				Value Description
				1 If the microcontroller is stopped with a debugger, the watchdog timer stops counting. Once the microcontroller is restarted, the

- watchdog timer resumes counting.
- 0 The watchdog timer continues counting if the microcontroller is stopped with a debugger.

7:0 reserved RO 0x00 Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

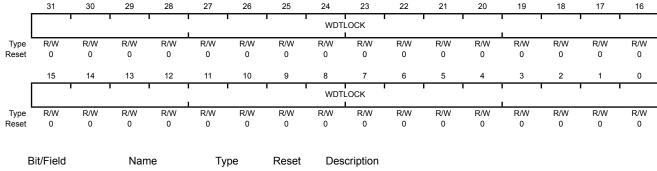
Register 8: Watchdog Lock (WDTLOCK), offset 0xC00

Writing 0x1ACC.E551 to the **WDTLOCK** register enables write access to all other registers. Writing any other value to the **WDTLOCK** register re-enables the locked state for register writes to all the other registers. Reading the **WDTLOCK** register returns the lock status rather than the 32-bit value written. Therefore, when write accesses are disabled, reading the **WDTLOCK** register returns 0x0000.0001 (when locked; otherwise, the returned value is 0x0000.0000 (unlocked)).

Watchdog Lock (WDTLOCK)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000

Offset 0xC00 Type R/W, reset 0x0000.0000



31:0 WDTLOCK R/W 0x0000.0000 Watchdog Lock

A write of the value 0x1ACC.E551 unlocks the watchdog registers for write access. A write of any other value reapplies the lock, preventing any register updates.

A read of this register returns the following values:

Value Description
0x0000.0001 Locked
0x0000.0000 Unlocked

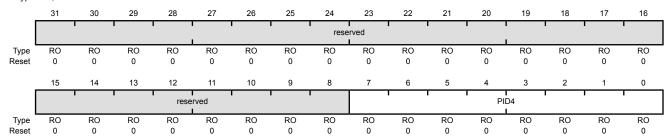
Register 9: Watchdog Peripheral Identification 4 (WDTPeriphID4), offset 0xFD0

The WDTPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 4 (WDTPeriphID4)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFD0

Type RO, reset 0x0000.0000



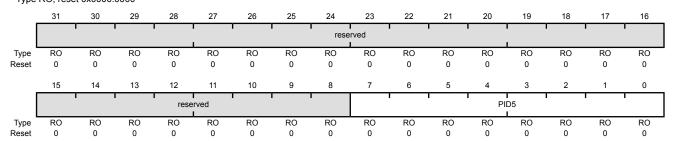
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID4	RO	0x00	WDT Peripheral ID Register [7:0]

Register 10: Watchdog Peripheral Identification 5 (WDTPeriphID5), offset 0xFD4

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 5 (WDTPeriphID5)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFD4 Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID5	RO	0x00	WDT Peripheral ID Register [15:8]

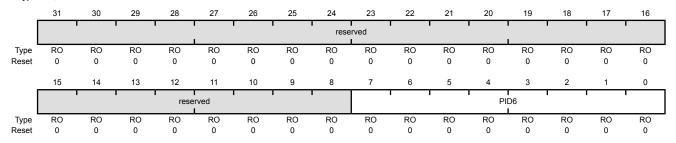
Register 11: Watchdog Peripheral Identification 6 (WDTPeriphID6), offset 0xFD8

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 6 (WDTPeriphID6)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFD8

Type RO, reset 0x0000.0000



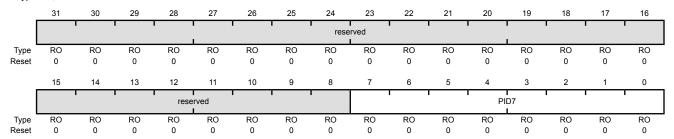
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID6	RO	0x00	WDT Peripheral ID Register [23:16]

Register 12: Watchdog Peripheral Identification 7 (WDTPeriphID7), offset 0xFDC

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 7 (WDTPeriphID7)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFDC Type RO, reset 0x0000.0000



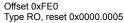
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID7	RO	0x00	WDT Peripheral ID Register [31:24]

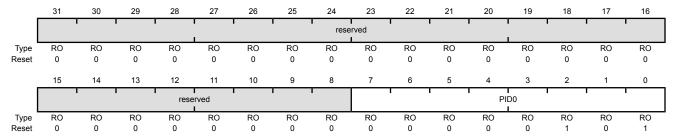
Register 13: Watchdog Peripheral Identification 0 (WDTPeriphID0), offset 0xFE0

The WDTPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 0 (WDTPeriphID0)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFE0





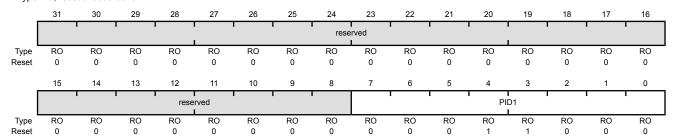
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID0	RO	0x05	Watchdog Peripheral ID Register [7:0]

Register 14: Watchdog Peripheral Identification 1 (WDTPeriphID1), offset 0xFE4

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 1 (WDTPeriphID1)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFE4 Type RO, reset 0x0000.0018



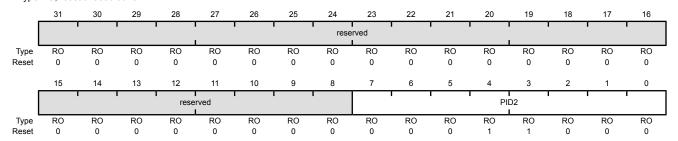
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID1	RO	0x18	Watchdog Peripheral ID Register [15:8]

Register 15: Watchdog Peripheral Identification 2 (WDTPeriphID2), offset 0xFE8

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 2 (WDTPeriphID2)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFE8 Type RO, reset 0x0000.0018



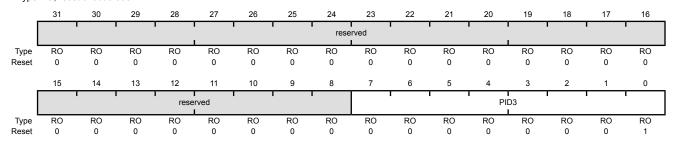
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID2	RO	0x18	Watchdog Peripheral ID Register [23:16]

Register 16: Watchdog Peripheral Identification 3 (WDTPeriphID3), offset 0xFEC

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 3 (WDTPeriphID3)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFEC Type RO, reset 0x0000.0001



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID3	RO	0x01	Watchdog Peripheral ID Register [31:24]

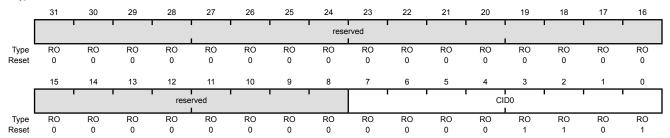
Register 17: Watchdog PrimeCell Identification 0 (WDTPCellID0), offset 0xFF0

The WDTPCellIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog PrimeCell Identification 0 (WDTPCellID0)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFF0

Type RO, reset 0x0000.000D



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID0	RO	0x0D	Watchdog PrimeCell ID Register [7:0]

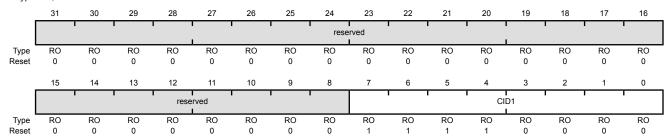
Register 18: Watchdog PrimeCell Identification 1 (WDTPCellID1), offset 0xFF4

The WDTPCellIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog PrimeCell Identification 1 (WDTPCellID1)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFF4

Type RO, reset 0x0000.00F0



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID1	RO	0xF0	Watchdog PrimeCell ID Register [15:8]

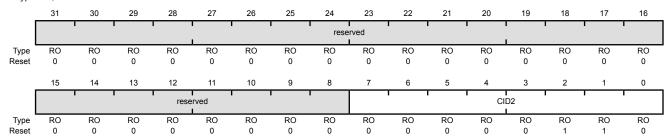
Register 19: Watchdog PrimeCell Identification 2 (WDTPCellID2), offset 0xFF8

The WDTPCellIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog PrimeCell Identification 2 (WDTPCellID2)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFF8

Type RO, reset 0x0000.0006



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID2	RO	0x06	Watchdog PrimeCell ID Register [23:16]

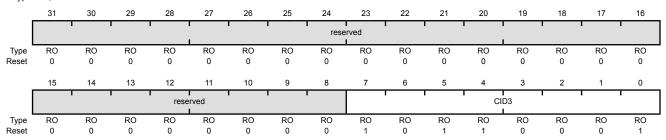
Register 20: Watchdog PrimeCell Identification 3 (WDTPCellID3), offset 0xFFC

The WDTPCellIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog PrimeCell Identification 3 (WDTPCellID3)

WDT0 base: 0x4000.0000 WDT1 base: 0x4000.1000 Offset 0xFFC

Type RO, reset 0x0000.00B1



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID3	RO	0xB1	Watchdog PrimeCell ID Register [31:24]

12 Analog-to-Digital Converter (ADC)

An analog-to-digital converter (ADC) is a peripheral that converts a continuous analog voltage to a discrete digital number.

The Stellaris[®] ADC module features 10-bit conversion resolution and supports eight input channels, plus an internal temperature sensor. The ADC module contains four programmable sequencers allowing the sampling of multiple analog input sources without controller intervention. Each sample sequencer provides flexible programming with fully configurable input source, trigger events, interrupt generation, and sequencer priority. A digital comparator function is included which allows the conversion value to be diverted to a digital comparator module. The ADC module provides eight digital comparators. Each digital comparator evaluates the ADC conversion value against its two user-defined values to determine the operational range of the signal.

The Stellaris LM3S1J11 microcontroller provides one ADC module with the following features:

- Eight analog input channels
- Single-ended and differential-input configurations
- On-chip internal temperature sensor
- Maximum sample rate of one million samples/second
- Optional phase shift in sample time programmable from 22.5° to 337.5°
- Four programmable sample conversion sequencers from one to eight entries long, with corresponding conversion result FIFOs
- Flexible trigger control
 - Controller (software)
 - Timers
 - Analog Comparators
 - GPIO
- Hardware averaging of up to 64 samples
- Digital comparison unit providing eight digital comparators
- Converter uses an internal 3-V reference or an external reference
- Power and ground for the analog circuitry is separate from the digital power and ground
- Efficient transfers using Micro Direct Memory Access Controller (μDMA)
 - Dedicated channel for each sample sequencer
 - ADC module uses burst requests for DMA

12.1 Block Diagram

Figure 12-1 on page 517 provides details on the internal configuration of the ADC controls and data registers.

External Internal Voltage Ref Voltage Ref (VREFA) Trigger Events Sample Comparator Sequencer 0 GPIO (PB4) Control/Status ADCSSMUX0 PWM ADCACTSS Analog-to-Digital ADCSSCTL0 Converter ADCOSTAT ADCSSFSTAT0 Analog Inputs Comparator ADCUSTAT GPIO (PB4) (AINX) Time ADCSSPRI Sample ADCCTL Sequencer 1 ADCSPC ADCSSMUX1 Comparator GPIO (PB4) Timer ADCSSCTL1 Hardware Averager ADCSSFSTAT1 ADCSAC Sample Comparator Sequencer 2 GPIO (PB4) Digital ADCSSMUX2 PWM Comparator FIFO Block ADCSSCTL2 ADCSSOPn ADCSSFSTAT2 ADCSSFIF00 ADCSSDCn ADCEMUX

Sample

Sequencer 3

ADCSSMUX3

ADCSSCTL3

ADCSSFSTAT3

Figure 12-1. ADC Module Block Diagram

12.2 Signal Description

ADCPSSI

SS0 Interrupt -

SS1 Interrupt ◀

SS3 Interrupt <

PWM Trigger ◀

SS2 Interrupt

Interrupt Control

ADCIM

ADCRIS

ADCISC

ADCDCISC

The following table lists the external signals of the ADC module and describes the function of each. The ADC signals are analog functions for some GPIO signals. The column in the table below titled "Pin Mux/Pin Assignment" lists the GPIO pin placement for the ADC signals. The AINx and VREFA analog signals are not 5-V tolerant and go through an isolation circuit before reaching their circuitry. These signals are configured by clearing the corresponding DEN bit in the GPIO Digital Enable (GPIODEN) register and setting the corresponding AMSEL bit in the GPIO Analog Mode Select (GPIOAMSEL) register. For more information on configuring GPIOs, see "General-Purpose Input/Outputs (GPIOs)" on page 389.

ADCSSFIFO1

ADCSSFIFO2

ADCSSFIFO3

DC Interrupts

ADCDCCTLn

ADCDCCMPn

ADCDCRIC

Table 12-1. ADC Signals (100LQFP)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
AIN0	1	PE7	1	Analog	Analog-to-digital converter input 0.
AIN1	2	PE6	1	Analog	Analog-to-digital converter input 1.
AIN2	5	PE5	I	Analog	Analog-to-digital converter input 2.
AIN3	6	PE4	1	Analog	Analog-to-digital converter input 3.
AIN4	100	PD7	1	Analog	Analog-to-digital converter input 4.
AIN5	99	PD6	1	Analog	Analog-to-digital converter input 5.

Table 12-1. ADC Signals (100LQFP) (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
AIN6	98	PD5	1	Analog	Analog-to-digital converter input 6.
AIN7	97	PD4	1	Analog	Analog-to-digital converter input 7.
VREFA	90	PB6	I	Analog	This input provides a reference voltage used to specify the input voltage at which the ADC converts to a maximum value. In other words, the voltage that is applied to VREFA is the voltage with which an AINn signal is converted to 1023. The VREFA input is limited to the range specified in Table 20-22 on page 809.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

Table 12-2. ADC Signals (108BGA)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
AIN0	B1	PE7	1	Analog	Analog-to-digital converter input 0.
AIN1	A1	PE6	I	Analog	Analog-to-digital converter input 1.
AIN2	В3	PE5	I	Analog	Analog-to-digital converter input 2.
AIN3	B2	PE4	I	Analog	Analog-to-digital converter input 3.
AIN4	A2	PD7	I	Analog	Analog-to-digital converter input 4.
AIN5	A3	PD6	Ţ	Analog	Analog-to-digital converter input 5.
AIN6	C6	PD5	1	Analog	Analog-to-digital converter input 6.
AIN7	B5	PD4	I	Analog	Analog-to-digital converter input 7.
VREFA	A7	PB6	I	Analog	This input provides a reference voltage used to specify the input voltage at which the ADC converts to a maximum value. In other words, the voltage that is applied to VREFA is the voltage with which an AINn signal is converted to 1023. The VREFA input is limited to the range specified in Table 20-22 on page 809.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

12.3 Functional Description

The Stellaris ADC collects sample data by using a programmable sequence-based approach instead of the traditional single or double-sampling approaches found on many ADC modules. Each *sample sequence* is a fully programmed series of consecutive (back-to-back) samples, allowing the ADC to collect data from multiple input sources without having to be re-configured or serviced by the processor. The programming of each sample in the sample sequence includes parameters such as the input source and mode (differential versus single-ended input), interrupt generation on sample completion, and the indicator for the last sample in the sequence. In addition, the μ DMA can be used to more efficiently move data from the sample sequencers without CPU intervention.

12.3.1 Sample Sequencers

The sampling control and data capture is handled by the sample sequencers. All of the sequencers are identical in implementation except for the number of samples that can be captured and the depth of the FIFO. Table 12-3 on page 519 shows the maximum number of samples that each sequencer can capture and its corresponding FIFO depth. Each sample that is captured is stored in the FIFO.

In this implementation, each FIFO entry is a 32-bit word, with the lower 10 bits containing the conversion result.

Table 12-3. Samples and FIFO Depth of Sequencers

Sequencer	Number of Samples	Depth of FIFO
SS3	1	1
SS2	4	4
SS1	4	4
SS0	8	8

For a given sample sequence, each sample is defined by bit fields in the ADC Sample Sequence Input Multiplexer Select (ADCSSMUXn) and ADC Sample Sequence Control (ADCSSCTLn) registers, where "n" corresponds to the sequence number. The ADCSSMUXn fields select the input pin, while the ADCSSCTLn fields contain the sample control bits corresponding to parameters such as temperature sensor selection, interrupt enable, end of sequence, and differential input mode. Sample sequencers are enabled by setting the respective ASENn bit in the ADC Active Sample Sequencer (ADCACTSS) register and should be configured before being enabled. Sampling is then initiated by setting the SSn bit in the ADC Processor Sample Sequence Initiate (ADCPSSI) register.

When configuring a sample sequence, multiple uses of the same input pin within the same sequence are allowed. In the **ADCSSCTLn** register, the IEn bits can be set for any combination of samples, allowing interrupts to be generated after every sample in the sequence if necessary. Also, the END bit can be set at any point within a sample sequence. For example, if Sequencer 0 is used, the END bit can be set in the nibble associated with the fifth sample, allowing Sequencer 0 to complete execution of the sample sequence after the fifth sample.

After a sample sequence completes execution, the result data can be retrieved from the **ADC Sample Sequence Result FIFO** (**ADCSSFIFOn**) registers. The FIFOs are simple circular buffers that read a single address to "pop" result data. For software debug purposes, the positions of the FIFO head and tail pointers are visible in the **ADC Sample Sequence FIFO Status (ADCSSFSTATn)** registers along with FULL and EMPTY status flags. If a write is attempted when the FIFO is full, the write does not occur and an overflow condition is indicated. Overflow and underflow conditions are monitored using the **ADCOSTAT** and **ADCUSTAT** registers.

12.3.2 Module Control

Outside of the sample sequencers, the remainder of the control logic is responsible for tasks such as:

- Interrupt generation
- DMA operation
- Sequence prioritization
- Trigger configuration
- Comparator configuration
- External voltage reference
- Sample phase control

Most of the ADC control logic runs at the ADC clock rate of 16 MHz. The internal ADC divider is configured for 16-MHz operation automatically by hardware when the system XTAL is selected with the PLL.

12.3.2.1 Interrupts

The register configurations of the sample sequencers and digital comparators dictate which events generate raw interrupts, but do not have control over whether the interrupt is actually sent to the interrupt controller. The ADC module's interrupt signals are controlled by the state of the MASK bits in the ADC Interrupt Mask (ADCIM) register. Interrupt status can be viewed at two locations: the ADC Raw Interrupt Status (ADCRIS) register, which shows the raw status of the various interrupt signals; and the ADC Interrupt Status and Clear (ADCISC) register, which shows active interrupts that are enabled by the ADCIM register. Sequencer interrupts are cleared by writing a 1 to the corresponding IN bit in ADCISC. Digital comparator interrupts are cleared by writing a 1 to the ADC Digital Comparator Interrupt Status and Clear (ADCDCISC) register.

12.3.2.2 DMA Operation

DMA may be used to increase efficiency by allowing each sample sequencer to operate independently and transfer data without processor intervention or reconfiguration. The ADC module provides a request signal from each sample sequencer to the associated dedicated channel of the μ DMA controller. The ADC does not support single transfer requests. A burst transfer request is asserted when the interrupt bit for the sample sequence is set (IE bit in the **ADCSSCTLn** register is set).

The arbitration size of the μ DMA transfer must be a power of 2, and the associated IE bits in the **ADDSSCTLn** register must be set. For example, if the μ DMA channel of SS0 has an arbitration size of four, the IE3 bit (4th sample) and the IE7 bit (8th sample) must be set. Thus the μ DMA request occurs every time 4 samples have been acquired. No other special steps are needed to enable the ADC module for μ DMA operation.

Refer to the "Micro Direct Memory Access (µDMA)" on page 331 for more details about programming the µDMA controller.

12.3.2.3 Prioritization

When sampling events (triggers) happen concurrently, they are prioritized for processing by the values in the ADC Sample Sequencer Priority (ADCSSPRI) register. Valid priority values are in the range of 0-3, with 0 being the highest priority and 3 being the lowest. Multiple active sample sequencer units with the same priority do not provide consistent results, so software must ensure that all active sample sequencer units have a unique priority value.

12.3.2.4 Sampling Events

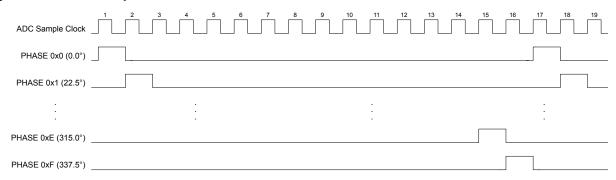
Sample triggering for each sample sequencer is defined in the **ADC Event Multiplexer Select** (**ADCEMUX**) register. Trigger sources include processor (default), analog comparators, an external signal on GPIO PB4, a GP Timer, and continuous sampling. The processor triggers sampling by setting the SSx bits in the **ADC Processor Sample Sequence Initiate (ADCPSSI)** register.

Care must be taken when using the continuous sampling trigger. If a sequencer's priority is too high, it is possible to starve other lower priority sequencers. Generally, a sample sequencer using continuous sampling should be set to the lowest priority. Continuous sampling can be used with a digital comparator to cause an interrupt when a particular voltage is seen on an input.

12.3.2.5 Sample Phase Control

The sample time can be delayed from the standard sampling time in 22.5° increments up to 337.5° using the **ADC Sample Phase Control (ADCSPC)** register. Figure 12-2 on page 521 shows an example of various phase relationships at a 1 Msps rate.

Figure 12-2. ADC Sample Phases



12.3.3 Hardware Sample Averaging Circuit

Higher precision results can be generated using the hardware averaging circuit, however, the improved results are at the cost of throughput. Up to 64 samples can be accumulated and averaged to form a single data entry in the sequencer FIFO. Throughput is decreased proportionally to the number of samples in the averaging calculation. For example, if the averaging circuit is configured to average 16 samples, the throughput is decreased by a factor of 16.

By default the averaging circuit is off, and all data from the converter passes through to the sequencer FIFO. The averaging hardware is controlled by the **ADC Sample Averaging Control (ADCSAC)** register (see page 555). A single averaging circuit has been implemented, thus all input channels receive the same amount of averaging whether they are single-ended or differential.

Figure 12-3 shows an example in which the **ADCSAC** register is set to 0x2 for 4x hardware oversampling and the IE1 bit is set for the sample sequence, resulting in an interrupt after the second averaged value is stored in the FIFO.

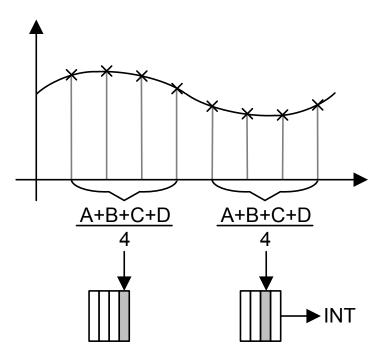
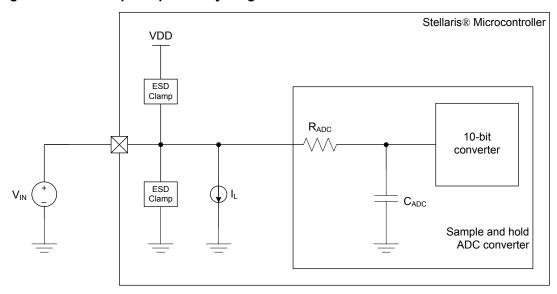


Figure 12-3. Sample Averaging Example

12.3.4 Analog-to-Digital Converter

The Analog-to-Digital Converter (ADC) module uses a Successive Approximation Register (SAR) architecture to deliver a 10-bit, low-power, high-precision conversion value. The successive-approximation algorithm uses a current mode D/A converter to achieve lower settling time, resulting in higher conversion speeds for the A/D converter. In addition, built-in sample-and-hold circuitry with offset-calibration circuitry improves conversion accuracy. The ADC must be run from the PLL or a 16-MHz clock source. Figure 12-4 shows the ADC input equivalency diagram; for parameter values, see "Analog-to-Digital Converter (ADC)" on page 808.

Figure 12-4. ADC Input Equivalency Diagram

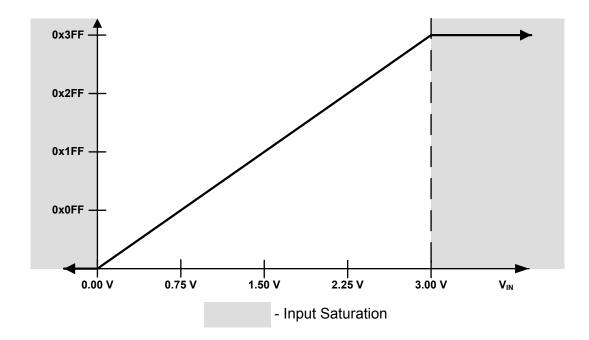


The ADC operates from both the 3.3-V analog and 1.2-V digital power supplies. The ADC clock can be configured to reduce power consumption when ADC conversions are not required (see "System Control" on page 188). The analog inputs are connected to the ADC through specially balanced input paths to minimize the distortion and cross-talk on the inputs. Detailed information on the ADC power supplies and analog inputs can be found in "Analog-to-Digital Converter (ADC)" on page 808.

12.3.4.1 Internal Voltage Reference

The band-gap circuitry generates an internal 3.0 V reference that can be used by the ADC to produce a conversion value from the selected analog input. The range of this conversion value is from 0x000 to 0x3FF. This configuration results in a resolution of approximately 2.9 mV per ADC code. While the analog input pads can handle voltages beyond this range, the ADC conversions saturate in under-voltage and over-voltage cases. Figure 12-5 on page 523 shows the ADC conversion function of the analog inputs.

Figure 12-5. Internal Voltage Conversion Result



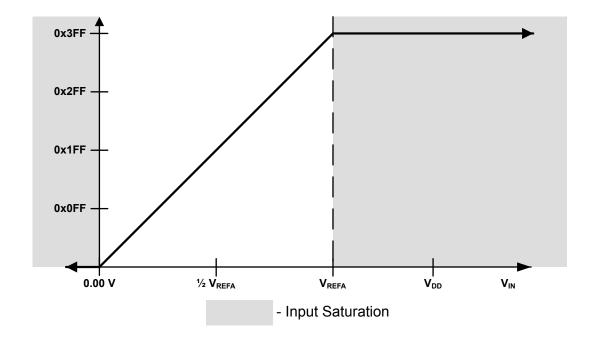
12.3.4.2 External Voltage Reference

The ADC can use an external voltage reference to produce the conversion value from the selected analog input by setting the VREF bit in the **ADC Control (ADCCTL)** register. The VREF bit specifies whether to use the internal or external reference. While the range of the conversion value remains the same (0x000 to 0x3FF), the analog voltage associated with the 0x3FF value corresponds to the value of the voltage when using the 3.0-V setting and three times the voltage when using the 1.0-V setting, resulting in a smaller voltage resolution per ADC code. Ground is always used as the reference level for the minimum conversion value. Analog input voltages above the external voltage reference saturate to 0x3FF while those below 0.0 V continue to saturate at 0x000. The V_{REFA} specification defines the useful range for the external voltage reference, see Table 20-22 on page 809. Care must be taken to supply a reference voltage of acceptable quality.

Figure 12-6 on page 524 shows the ADC conversion function of the analog inputs when using an external voltage reference.

The external voltage reference can be more accurate than the internal reference by using a high-precision source or trimming the source.

Figure 12-6. External Voltage Conversion Result



12.3.5 Differential Sampling

In addition to traditional single-ended sampling, the ADC module supports differential sampling of two analog input channels. To enable differential sampling, software must set the \mathtt{Dn} bit in the **ADCSSCTL0n** register in a step's configuration nibble.

When a sequence step is configured for differential sampling, the input pair to sample must be configured in the **ADCSSMUXn** register. Differential pair 0 samples analog inputs 0 and 1; differential pair 1 samples analog inputs 2 and 3; and so on (see Table 12-4 on page 524). The ADC does not support other differential pairings such as analog input 0 with analog input 3.

Table 12-4. Differential Sampling Pairs

Differential Pair	Analog Inputs
0	0 and 1
1	2 and 3
2	4 and 5
3	6 and 7

The voltage sampled in differential mode is the difference between the odd and even channels:

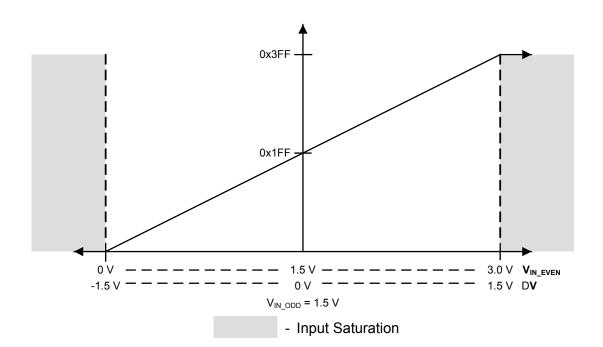
 ΔV (differential voltage) = $V_{IN EVEN}$ (even channel) – $V_{IN ODD}$ (odd channel), therefore:

- If $\Delta V = 0$, then the conversion result = 0x1FF
- If $\Delta V > 0$, then the conversion result > 0x1FF (range is 0x1FF–0x3FF)
- If $\Delta V < 0$, then the conversion result < 0x1FF (range is 0–0x1FF)

The differential pairs assign polarities to the analog inputs: the even-numbered input is always positive, and the odd-numbered input is always negative. In order for a valid conversion result to appear, the negative input must be in the range of \pm 1.5 V of the positive input. If an analog input is greater than 3 V or less than 0 V (the valid range for analog inputs), the input voltage is clipped, meaning it appears as either 3 V or 0 V , respectively, to the ADC.

Figure 12-7 on page 525 shows an example of the negative input centered at 1.5 V. In this configuration, the differential range spans from -1.5 V to 1.5 V. Figure 12-8 on page 526 shows an example where the negative input is centered at 0.75 V, meaning inputs on the positive input saturate past a differential voltage of -0.75 V because the input voltage is less than 0 V. Figure 12-9 on page 526 shows an example of the negative input centered at 2.25 V, where inputs on the positive channel saturate past a differential voltage of 0.75 V since the input voltage would be greater than 3 V.

Figure 12-7. Differential Sampling Range, $V_{IN\ ODD}$ = 1.5 V





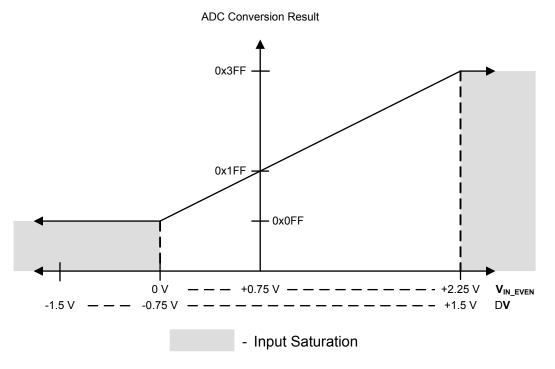
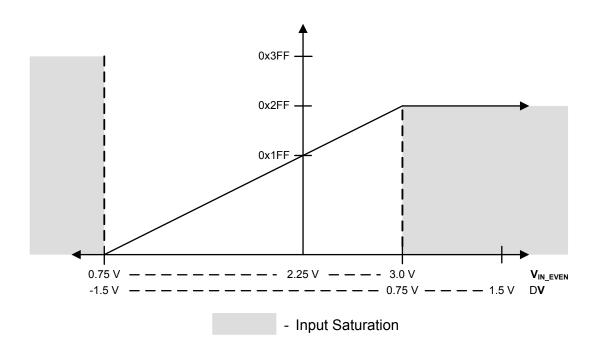


Figure 12-9. Differential Sampling Range, V_{IN_ODD} = 2.25 V



12.3.6 Internal Temperature Sensor

The temperature sensor serves two primary purposes: 1) to notify the system that internal temperature is too high or low for reliable operation and 2) to provide temperature measurements for calibration of the Hibernate module RTC trim value.

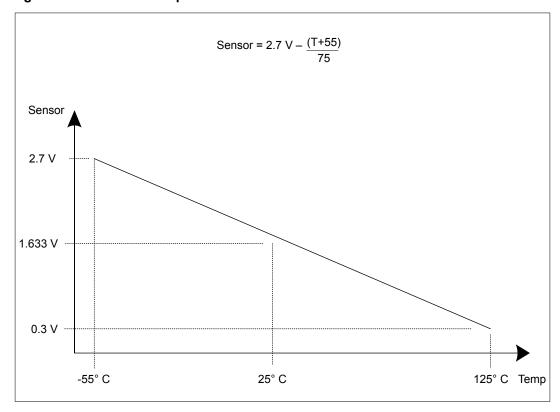
The temperature sensor does not have a separate enable, because it also contains the bandgap reference and must always be enabled. The reference is supplied to other analog modules; not just the ADC. In addition, the temperature sensor has a second power-down input in the 3.3 V domain which provides control by the Hibernation module.

The internal temperature sensor provides an analog temperature reading as well as a reference voltage. This reference voltage, *SENSO*, is given by the following equation:

$$SENSO = 2.7 - ((T + 55) / 75)$$

This relation is shown in Figure 12-10 on page 527.

Figure 12-10. Internal Temperature Sensor Characteristic



The temperature sensor reading can be sampled in a sample sequence by setting the ${\tt TSn}$ bit in the **ADCSSCTLn** register. The temperature reading from the temperature sensor can also be given as a function of the ADC value. The following formula calculates temperature (in ${}^{\circ}$ C) based on the ADC reading:

Temperature =
$$147.5 - ((225 \times ADC) / 1023)$$

12.3.7 Digital Comparator Unit

An ADC is commonly used to sample an external signal and to monitor its value to ensure that it remains in a given range. To automate this monitoring procedure and reduce the amount of processor

overhead that is required, eight digital comparators are provided. Conversions from the ADC that are sent to the digital comparators are compared against the user programmable limits in the **ADC Digital Comparator Range (ADCDCCMPn)** registers. If the observed signal moves out of the acceptable range, a processor interrupt can be generated. The digital comparators four operational modes (Once, Always, Hysteresis Once, Hysteresis Always) can be applied to three separate regions (low band, mid band, high band) as defined by the user.

12.3.7.1 Output Functions

ADC conversions can either be stored in the ADC Sample Sequence FIFOs or compared using the digital comparator resources as defined by the SnDCOP bits in the **ADC Sample Sequence n Operation (ADCSSOPn)** register. These selected ADC conversions are used by their respective digital comparator to monitor the external signal. Each comparator has two possible output functions: processor interrupts and triggers.

Each function has its own state machine to track the monitored signal. Even though the interrupt and trigger functions can be enabled individually or both at the same time, the same conversion data is used by each function to determine if the right conditions have been met to assert the associated output.

Interrupts

The digital comparator interrupt function is enabled by setting the CIE bit in the **ADC Digital Comparator Control (ADCDCCTLn)** register. This bit enables the interrupt function state machine to start monitoring the incoming ADC conversions. When the appropriate set of conditions is met, and the DCONSSX bit is set in the **ADCIM** register, an interrupt is sent to the interrupt controller.

12.3.7.2 Operational Modes

Four operational modes are provided to support a broad range of applications and multiple possible signaling requirements: Always, Once, Hysteresis Always, and Hysteresis Once. The operational mode is selected using the CIM field in the **ADCDCCTLn** register.

Always Mode

In the Always operational mode, the associated interrupt or trigger is asserted whenever the ADC conversion value meets its comparison criteria. The result is a string of assertions on the interrupt or trigger while the conversions are within the appropriate range.

Once Mode

In the Once operational mode, the associated interrupt or trigger is asserted whenever the ADC conversion value meets its comparison criteria, and the previous ADC conversion value did not. The result is a single assertion of the interrupt or trigger when the conversions are within the appropriate range.

Hysteresis-Always Mode

The Hysteresis-Always operational mode can only be used in conjunction with the low-band or high-band regions because the mid-band region must be crossed and the opposite region entered to clear the hysteresis condition. In the Hysteresis-Always mode, the associated interrupt or trigger is asserted in the following cases: 1) the ADC conversion value meets its comparison criteria or 2) a previous ADC conversion value has met the comparison criteria, and the hysteresis condition has not been cleared by entering the opposite region. The result is a string of assertions on the interrupt or trigger that continue until the opposite region is entered.

Hysteresis-Once Mode

The Hysteresis-Once operational mode can only be used in conjunction with the low-band or high-band regions because the mid-band region must be crossed and the opposite region entered to clear the hysteresis condition. In the Hysteresis-Once mode, the associated interrupt or trigger is asserted only when the ADC conversion value meets its comparison criteria, the hysteresis condition is clear, and the previous ADC conversion did not meet the comparison criteria. The result is a single assertion on the interrupt or trigger.

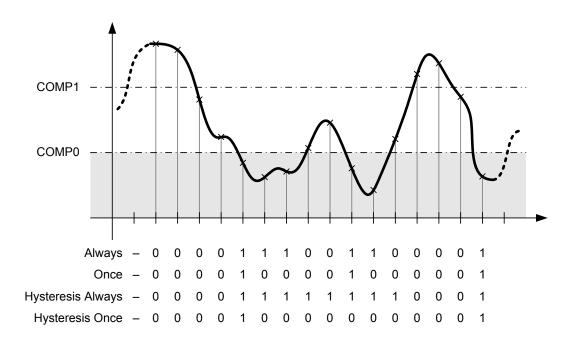
12.3.7.3 Function Ranges

The two comparison values, COMPO and COMP1, in the ADC Digital Comparator Range (ADCDCCMPn) register effectively break the conversion area into three distinct regions. These regions are referred to as the low-band (less than or equal to COMPO), mid-band (greater than COMPO but less than or equal to COMP1), and high-band (greater than COMP1) regions. COMPO and COMP1 may be programmed to the same value, effectively creating two regions, but COMP1 must always be greater than or equal to the value of COMPO. A COMP1 value that is less than COMPO generates unpredictable results.

Low-Band Operation

To operate in the low-band region, either the CIC field field in the **ADCDCCTLn** register must be programmed to 0x0. This setting causes interrupts or triggers to be generated in the low-band region as defined by the programmed operational mode. An example of the state of the interrupt/trigger signal in the low-band region for each of the operational modes is shown in Figure 12-11 on page 529. Note that a "0" in a column following the operational mode name (Always, Once, Hysteresis Always, and Hysteresis Once) indicates that the interrupt or trigger signal is de-asserted and a "1" indicates that the signal is asserted.

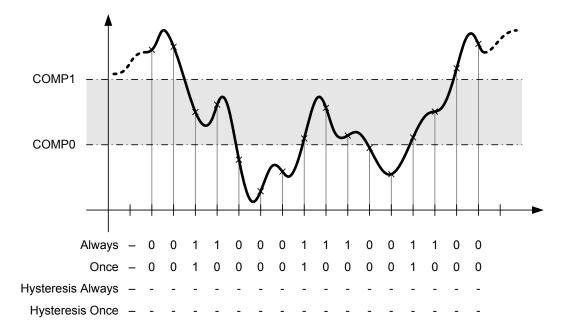
Figure 12-11. Low-Band Operation (CIC=0x0)



Mid-Band Operation

To operate in the mid-band region, either the CIC field field in the **ADCDCCTLn** register must be programmed to 0x1. This setting causes interrupts or triggers to be generated in the mid-band region according the operation mode. Only the Always and Once operational modes are available in the mid-band region. An example of the state of the interrupt/trigger signal in the mid-band region for each of the allowed operational modes is shown in Figure 12-12 on page 530. Note that a "0" in a column following the operational mode name (Always or Once) indicates that the interrupt or trigger signal is de-asserted and a "1" indicates that the signal is asserted.





High-Band Operation

To operate in the high-band region, either the CIC field field in the **ADCDCCTLn** register must be programmed to 0x3. This setting causes interrupts or triggers to be generated in the high-band region according the operation mode. An example of the state of the interrupt/trigger signal in the high-band region for each of the allowed operational modes is shown in Figure 12-13 on page 531. Note that a "0" in a column following the operational mode name (Always, Once, Hysteresis Always, and Hysteresis Once) indicates that the interrupt or trigger signal is de-asserted and a "1" indicates that the signal is asserted.

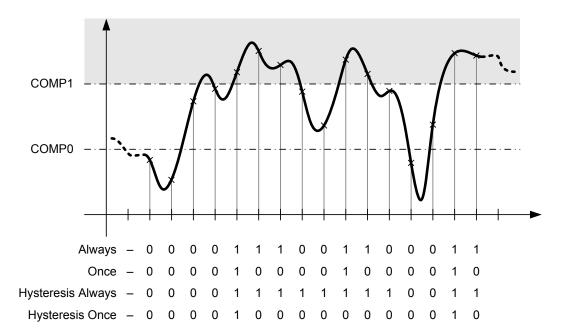


Figure 12-13. High-Band Operation (CIC=0x3)

12.4 Initialization and Configuration

In order for the ADC module to be used, the PLL must be enabled and programmed to a supported crystal frequency in the **RCC** register (see page 204). Using unsupported frequencies can cause faulty operation in the ADC module.

12.4.1 Module Initialization

Initialization of the ADC module is a simple process with very few steps: enabling the clock to the ADC, disabling the analog isolation circuit associated with all inputs that are to be used, and reconfiguring the sample sequencer priorities (if needed).

The initialization sequence for the ADC is as follows:

- 1. Enable the ADC clock by using the **RCGC0** register (see page 240).
- **2.** Enable the clock to the appropriate GPIO modules via the **RCGC2** register (see page 255). To find out which GPIO ports to enable, refer to "Signal Description" on page 517.
- 3. Set the GPIO AFSEL bits for the ADC input pins (see page 412). To determine which GPIOs to configure, see Table 18-4 on page 762.
- **4.** Configure the AINx and VREFA signals to be analog inputs by clearing the corresponding DEN bit in the **GPIO Digital Enable (GPIODEN)** register (see page 423).
- **5.** Disable the analog isolation circuit for all ADC input pins that are to be used by writing a 1 to the appropriate bits of the **GPIOAMSEL** register (see page 428) in the associated GPIO block.

6. If required by the application, reconfigure the sample sequencer priorities in the **ADCSSPRI** register. The default configuration has Sample Sequencer 0 with the highest priority and Sample Sequencer 3 as the lowest priority.

12.4.2 Sample Sequencer Configuration

Configuration of the sample sequencers is slightly more complex than the module initialization because each sample sequencer is completely programmable.

The configuration for each sample sequencer should be as follows:

- 1. Ensure that the sample sequencer is disabled by clearing the corresponding ASENn bit in the ADCACTSS register. Programming of the sample sequencers is allowed without having them enabled. Disabling the sequencer during programming prevents erroneous execution if a trigger event were to occur during the configuration process.
- 2. Configure the trigger event for the sample sequencer in the ADCEMUX register.
- **3.** For each sample in the sample sequence, configure the corresponding input source in the **ADCSSMUXn** register.
- **4.** For each sample in the sample sequence, configure the sample control bits in the corresponding nibble in the **ADCSSCTLn** register. When programming the last nibble, ensure that the END bit is set. Failure to set the END bit causes unpredictable behavior.
- 5. If interrupts are to be used, set the corresponding MASK bit in the ADCIM register.
- **6.** Enable the sample sequencer logic by setting the corresponding ASENn bit in the **ADCACTSS** register.

12.5 Register Map

Table 12-5 on page 532 lists the ADC registers. The offset listed is a hexadecimal increment to the register's address, relative to that ADC module's base address of:

■ ADC0: 0x4003.8000

Note that the ADC module clock must be enabled before the registers can be programmed (see page 240). There must be a delay of 3 system clocks after the ADC module clock is enabled before any ADC module registers are accessed.

Table 12-5. ADC Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	ADCACTSS	R/W	0x0000.0000	ADC Active Sample Sequencer	535
0x004	ADCRIS	RO	0x0000.0000	ADC Raw Interrupt Status	536
0x008	ADCIM	R/W	0x0000.0000	ADC Interrupt Mask	538
0x00C	ADCISC	R/W1C	0x0000.0000	ADC Interrupt Status and Clear	540
0x010	ADCOSTAT	R/W1C	0x0000.0000	ADC Overflow Status	543
0x014	ADCEMUX	R/W	0x0000.0000	ADC Event Multiplexer Select	545

Table 12-5. ADC Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0x018	ADCUSTAT	R/W1C	0x0000.0000	ADC Underflow Status	549
0x020	ADCSSPRI	R/W	0x0000.3210	ADC Sample Sequencer Priority	550
0x024	ADCSPC	R/W	0x0000.0000	ADC Sample Phase Control	552
0x028	ADCPSSI	R/W	-	ADC Processor Sample Sequence Initiate	553
0x030	ADCSAC	R/W	0x0000.0000	ADC Sample Averaging Control	555
0x034	ADCDCISC	R/W1C	0x0000.0000	ADC Digital Comparator Interrupt Status and Clear	556
0x038	ADCCTL	R/W	0x0000.0000	ADC Control	558
0x040	ADCSSMUX0	R/W	0x0000.0000	ADC Sample Sequence Input Multiplexer Select 0	559
0x044	ADCSSCTL0	R/W	0x0000.0000	ADC Sample Sequence Control 0	561
0x048	ADCSSFIFO0	RO	-	ADC Sample Sequence Result FIFO 0	564
0x04C	ADCSSFSTAT0	RO	0x0000.0100	ADC Sample Sequence FIFO 0 Status	565
0x050	ADCSSOP0	R/W	0x0000.0000	ADC Sample Sequence 0 Operation	567
0x054	ADCSSDC0	R/W	0x0000.0000	ADC Sample Sequence 0 Digital Comparator Select	569
0x060	ADCSSMUX1	R/W	0x0000.0000	ADC Sample Sequence Input Multiplexer Select 1	571
0x064	ADCSSCTL1	R/W	0x0000.0000	ADC Sample Sequence Control 1	572
0x068	ADCSSFIFO1	RO	-	ADC Sample Sequence Result FIFO 1	564
0x06C	ADCSSFSTAT1	RO	0x0000.0100	ADC Sample Sequence FIFO 1 Status	565
0x070	ADCSSOP1	R/W	0x0000.0000	ADC Sample Sequence 1 Operation	574
0x074	ADCSSDC1	R/W	0x0000.0000	ADC Sample Sequence 1 Digital Comparator Select	575
0x080	ADCSSMUX2	R/W	0x0000.0000	ADC Sample Sequence Input Multiplexer Select 2	571
0x084	ADCSSCTL2	R/W	0x0000.0000	ADC Sample Sequence Control 2	572
0x088	ADCSSFIFO2	RO	-	ADC Sample Sequence Result FIFO 2	564
0x08C	ADCSSFSTAT2	RO	0x0000.0100	ADC Sample Sequence FIFO 2 Status	565
0x090	ADCSSOP2	R/W	0x0000.0000	ADC Sample Sequence 2 Operation	574
0x094	ADCSSDC2	R/W	0x0000.0000	ADC Sample Sequence 2 Digital Comparator Select	575
0x0A0	ADCSSMUX3	R/W	0x0000.0000	ADC Sample Sequence Input Multiplexer Select 3	577
0x0A4	ADCSSCTL3	R/W	0x0000.0002	ADC Sample Sequence Control 3	578
0x0A8	ADCSSFIFO3	RO	-	ADC Sample Sequence Result FIFO 3	564
0x0AC	ADCSSFSTAT3	RO	0x0000.0100	ADC Sample Sequence FIFO 3 Status	565
0x0B0	ADCSSOP3	R/W	0x0000.0000	ADC Sample Sequence 3 Operation	579
0x0B4	ADCSSDC3	R/W	0x0000.0000	ADC Sample Sequence 3 Digital Comparator Select	580
0xD00	ADCDCRIC	R/W	0x0000.0000	ADC Digital Comparator Reset Initial Conditions	581

Table 12-5. ADC Register Map (continued)

Offset	Name	Type	Reset	Description	See page
0xE00	ADCDCCTL0	R/W	0x0000.0000	ADC Digital Comparator Control 0	586
0xE04	ADCDCCTL1	R/W	0x0000.0000	ADC Digital Comparator Control 1	586
0xE08	ADCDCCTL2	R/W	0x0000.0000	ADC Digital Comparator Control 2	586
0xE0C	ADCDCCTL3	R/W	0x0000.0000	ADC Digital Comparator Control 3	586
0xE10	ADCDCCTL4	R/W	0x0000.0000	ADC Digital Comparator Control 4	586
0xE14	ADCDCCTL5	R/W	0x0000.0000	ADC Digital Comparator Control 5	586
0xE18	ADCDCCTL6	R/W	0x0000.0000	ADC Digital Comparator Control 6	586
0xE1C	ADCDCCTL7	R/W	0x0000.0000	ADC Digital Comparator Control 7	586
0xE40	ADCDCCMP0	R/W	0x0000.0000	ADC Digital Comparator Range 0	588
0xE44	ADCDCCMP1	R/W	0x0000.0000	ADC Digital Comparator Range 1	588
0xE48	ADCDCCMP2	R/W	0x0000.0000	ADC Digital Comparator Range 2	588
0xE4C	ADCDCCMP3	R/W	0x0000.0000	ADC Digital Comparator Range 3	588
0xE50	ADCDCCMP4	R/W	0x0000.0000	ADC Digital Comparator Range 4	588
0xE54	ADCDCCMP5	R/W	0x0000.0000	ADC Digital Comparator Range 5	588
0xE58	ADCDCCMP6	R/W	0x0000.0000	ADC Digital Comparator Range 6	588
0xE5C	ADCDCCMP7	R/W	0x0000.0000	ADC Digital Comparator Range 7	588

12.6 Register Descriptions

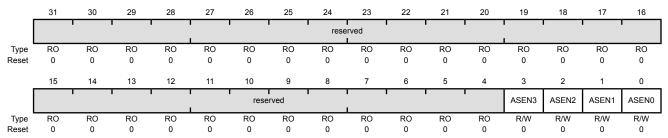
The remainder of this section lists and describes the ADC registers, in numerical order by address offset.

Register 1: ADC Active Sample Sequencer (ADCACTSS), offset 0x000

This register controls the activation of the sample sequencers. Each sample sequencer can be enabled or disabled independently.

ADC Active Sample Sequencer (ADCACTSS)

ADC0 base: 0x4003.8000 Offset 0x000 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:4	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	ASEN3	R/W	0	ADC SS3 Enable Value Description
				Sample Sequencer 3 is enabled.Sample Sequencer 3 is disabled.
2	ASEN2	R/W	0	ADC SS2 Enable
				Value Description Sample Sequencer 2 is enabled. Sample Sequencer 2 is disabled.
1	ASEN1	R/W	0	ADC SS1 Enable
				Value Description Sample Sequencer 1 is enabled. Sample Sequencer 1 is disabled.
0	ASEN0	R/W	0	ADC SS0 Enable
				Value Description Sample Sequencer 0 is enabled. Sample Sequencer 0 is disabled.

Register 2: ADC Raw Interrupt Status (ADCRIS), offset 0x004

This register shows the status of the raw interrupt signal of each sample sequencer. These bits may be polled by software to look for interrupt conditions without sending the interrupts to the interrupt controller.

ADC Raw Interrupt Status (ADCRIS)

ADC0 base: 0x4003.8000

Offset 0x004

Type RO, reset 0x0000.0000

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
			•		! !		' '	reserved	·		•	•	' '			INRDC		
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0		
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
					'	res	erved		·		•		INR3	INR2	INR1	INR0		
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0		
В	it/Field		Nam	ne	Тур	ре	Reset	Des	Description									
	31:17		reserv	ved	R	0x000		com	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.									
	16	INRDC RO 0			Digit	tal Comp	arator F	Raw Inter	rupt Sta	tus								
								Valu	ue Desc	ription								
								1					ISC regi has occu		et, mean	ing that		
								0	All bi	ts in the	ADCDC	ISC regi	ster are	clear.				
	15:4		reserv	ved	R)	0	com	Software should not rely on the value of a reserved bit. To provious compatibility with future products, the value of a reserved bit sho preserved across a read-modify-write operation.									
	3		INR	3	R)	0	SS3	Raw Int	errupt S	tatus							
								Valu	ie Desc	ription								
								1		•			ersion a		•	е		
								0	An in	terrupt h	nas not o	ccurred.						
								This	bit is cle	eared by	writing a	a 1 to the	e IN3 bit	in the A	DCISC	register.		
	2		INR	2	R)	0	SS2	Raw Int	errupt S	tatus							
								Valu	ue Desc	ription								
								1					ersion a			е		
								0	An in	terrupt h	nas not o	ccurred.						

This bit is cleared by writing a 1 to the ${\tt IN2}$ bit in the **ADCISC** register.

Bit/Field	Name	Туре	Reset	Description
1	INR1	RO	0	SS1 Raw Interrupt Status
				Value Description
				A sample has completed conversion and the respective ADCSSCTL1 IEn bit is set, enabling a raw interrupt.
				0 An interrupt has not occurred.
				This bit is cleared by writing a 1 to the IN1 bit in the ADCISC register.
0	INR0	RO	0	SS0 Raw Interrupt Status
				Value Description
				A sample has completed conversion and the respective ADCSSCTL0 IEn bit is set, enabling a raw interrupt.
				0 An interrupt has not occurred.
				This bit is cleared by writing a 1 to the IN0 bit in the ADCISC register.

Register 3: ADC Interrupt Mask (ADCIM), offset 0x008

This register controls whether the sample sequencer and digital comparator raw interrupt signals are sent to the interrupt controller. Each raw interrupt signal can be masked independently. Only a single DCONSSn bit should be set at any given time. Setting more than one of these bits results in the INRDC bit from the ADCRIS register being masked, and no interrupt is generated on any of the sample sequencer interrupt lines.

ADC Interrupt Mask (ADCIM)

ADC0 base: 0x4003.8000 Offset 0x008 Type R/W, reset 0x0000.0000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	1		1			res	erved	DCONSS3 DCONSS2 DCONS					DCONSS1	DCONSS0		
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		•		-	· ·	res	erved					•	MASK3	MASK2	MASK1	MASK0
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	R/W 0	R/W 0	R/W 0	R/W 0
Reset	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
Е	Bit/Field	d Name Type Reset		Reset	Description											
	31:20		reserv	/ed	R	0	0x000	Soft	ware sho	ould not	relv on tl	he value	of a res	erved bit	. To prov	⁄ide
								compatibi		are should not rely on the value of a reserved bit. To provide atibility with future products, the value of a reserved bit should be ved across a read-modify-write operation.						
	19		DCON	SS3	R/	W	0	0 Digital Compar		arator Ir	nterrupt o	on SS3				
								Val	ue Desc	ription						
							1	bit in	the ADC		ister) is	the digita sent to th				
								0		status of upt statu		al comp	arators d	loes not	affect the	e SS3
	18		DCON	SS2	R/	W	0	Digi	tal Comp	parator Ir	nterrupt o	on SS2				
								Val	ue Desc	ription						
								1	The raw interrupt signal from the digital comparators (INRDC bit in the ADCRIS register) is sent to the interrupt controller on the SS2 interrupt line.							
								0		status of rupt statu		al comp	arators d	loes not	affect the	e SS2
	17		DCONSS1		R/	R/W 0		Digital Comparator Interrupt on SS1								
								Val	ue Desc	ription						

- The raw interrupt signal from the digital comparators (INRDC $\,$ bit in the ADCRIS register) is sent to the interrupt controller on the SS1 interrupt line.
- 0 The status of the digital comparators does not affect the SS1 interrupt status.

Bit/Field	Name	Туре	Reset	Description
16	DCONSS0	R/W	0	Digital Comparator Interrupt on SS0
				Value Description
				The raw interrupt signal from the digital comparators (INRDC bit in the ADCRIS register) is sent to the interrupt controller on the SS0 interrupt line.
				The status of the digital comparators does not affect the SS0 interrupt status.
15:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	MASK3	R/W	0	SS3 Interrupt Mask
				Value Description
				1 The raw interrupt signal from Sample Sequencer 3 (ADCRIS register INR3 bit) is sent to the interrupt controller.
				The status of Sample Sequencer 3 does not affect the SS3 interrupt status.
2	MASK2	R/W	0	SS2 Interrupt Mask
				Value Description
				1 The raw interrupt signal from Sample Sequencer 2 (ADCRIS register INR2 bit) is sent to the interrupt controller.
				0 The status of Sample Sequencer 2 does not affect the SS2 interrupt status.
1	MASK1	R/W	0	SS1 Interrupt Mask
				Value Description
				1 The raw interrupt signal from Sample Sequencer 1 (ADCRIS register INR1 bit) is sent to the interrupt controller.
				O The status of Sample Sequencer 1 does not affect the SS1 interrupt status.
0	MASK0	R/W	0	SS0 Interrupt Mask
				Value Description
				1 The raw interrupt signal from Sample Sequencer 0 (ADCRIS register INR0 bit) is sent to the interrupt controller.
				The status of Sample Sequencer 0 does not affect the SS0 interrupt status.

Register 4: ADC Interrupt Status and Clear (ADCISC), offset 0x00C

This register provides the mechanism for clearing sample sequencer interrupt conditions and shows the status of interrupts generated by the sample sequencers and the digital comparators which have been sent to the interrupt controller. When read, each bit field is the logical AND of the respective INR and MASK bits. Sample sequencer interrupts are cleared by writing a 1 to the corresponding bit position. Digital comparator interrupts are cleared by writing a 1 to the appropriate bits in the **ADCDCISC** register. If software is polling the **ADCRIS** instead of generating interrupts, the sample sequence INRn bits are still cleared via the **ADCISC** register, even if the INn bit is not set.

ADC Interrupt Status and Clear (ADCISC)

Name

Type

Reset

ADC0 base: 0x4003.8000

Offset 0x00C

Bit/Field

Type R/W1C, reset 0x0000.0000



Description

31:20	reserved	RO	0x000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
19	DCINSS3	RO	0	Digital Comparator Interrupt Status on SS3
				Value Description
				Both the INRDC bit in the ADCRIS register and the DCONSS3 bit in the ADCIM register are set, providing a level-based interrupt to the interrupt controller.
				0 No interrupt has occurred or the interrupt is masked.
				This bit is cleared by writing a 1 to it. Clearing this bit also clears the INRDC bit in the ADCRIS register.
18	DCINSS2	RO	0	Digital Comparator Interrupt Status on SS2

Value Description

- 1 Both the INRDC bit in the **ADCRIS** register and the DCONSS2 bit in the **ADCIM** register are set, providing a level-based interrupt to the interrupt controller.
- 0 No interrupt has occurred or the interrupt is masked.

This bit is cleared by writing a 1 to it. Clearing this bit also clears the INRDC bit in the **ADCRIS** register.

Bit/Field	Name	Туре	Reset	Description
17	DCINSS1	RO	0	Digital Comparator Interrupt Status on SS1
				Value Description
				Both the INRDC bit in the ADCRIS register and the DCONSS1 bit in the ADCIM register are set, providing a level-based interrupt to the interrupt controller.
				0 No interrupt has occurred or the interrupt is masked.
				This bit is cleared by writing a 1 to it. Clearing this bit also clears the INRDC bit in the ADCRIS register.
16	DCINSS0	RO	0	Digital Comparator Interrupt Status on SS0
				Value Description
				Both the INRDC bit in the ADCRIS register and the DCONSS0 bit in the ADCIM register are set, providing a level-based interrupt to the interrupt controller.
				0 No interrupt has occurred or the interrupt is masked.
				This bit is cleared by writing a 1 to it. Clearing this bit also clears the INRDC bit in the ADCRIS register.
15:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	IN3	R/W1C	0	SS3 Interrupt Status and Clear
				Value Description
				Both the INR3 bit in the ADCRIS register and the MASK3 bit in the ADCIM register are set, providing a level-based interrupt to the interrupt controller.
				0 No interrupt has occurred or the interrupt is masked.
				This bit is cleared by writing a 1. Clearing this bit also clears the INR3 bit in the ADCRIS register.
2	IN2	R/W1C	0	SS2 Interrupt Status and Clear
				Value Description
				1 Both the INR2 bit in the ADCRIS register and the MASK2 bit in the ADCIM register are set, providing a level-based interrupt to the interrupt controller.
				0 No interrupt has occurred or the interrupt is masked.
				This bit is cleared by writing a 1. Clearing this bit also clears the ${\tt INR2}$ bit in the ${\bf ADCRIS}$ register.

Bit/Field	Name	Туре	Reset	Description
1	IN1	R/W1C	0	SS1 Interrupt Status and Clear
				Value Description
				1 Both the INR1 bit in the ADCRIS register and the MASK1 bit in the ADCIM register are set, providing a level-based interrupt to the interrupt controller.
				0 No interrupt has occurred or the interrupt is masked.
				This bit is cleared by writing a 1. Clearing this bit also clears the INR1 bit in the ADCRIS register.
0	IN0	R/W1C	0	SS0 Interrupt Status and Clear
				Value Description
				Both the INRO bit in the ADCRIS register and the MASKO bit in the ADCIM register are set, providing a level-based interrupt to the interrupt controller.
				0 No interrupt has occurred or the interrupt is masked.
				This bit is cleared by writing a 1. Clearing this bit also clears the INR0 bit in the ADCRIS register.

Register 5: ADC Overflow Status (ADCOSTAT), offset 0x010

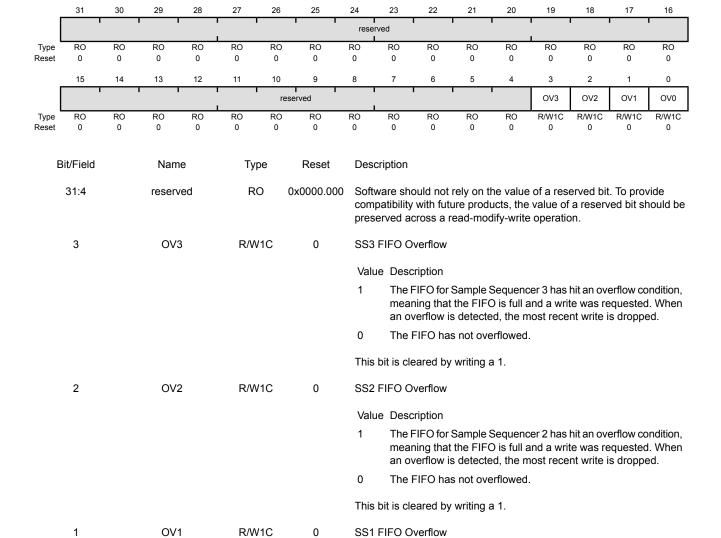
This register indicates overflow conditions in the sample sequencer FIFOs. Once the overflow condition has been handled by software, the condition can be cleared by writing a 1 to the corresponding bit position.

ADC Overflow Status (ADCOSTAT)

ADC0 base: 0x4003.8000

Offset 0x010

Type R/W1C, reset 0x0000.0000



Value Description

- 1 The FIFO for Sample Sequencer 1 has hit an overflow condition, meaning that the FIFO is full and a write was requested. When an overflow is detected, the most recent write is dropped.
- 0 The FIFO has not overflowed.

This bit is cleared by writing a 1.

Bit/Field	Name	Туре	Reset	Description
0	OV0	R/W1C	0	SS0 FIFO Overflow
				Value Description
				The FIFO for Sample Sequencer 0 has hit an overflow condition, meaning that the FIFO is full and a write was requested. When an overflow is detected, the most recent write is dropped.
				0 The FIFO has not overflowed.
				This bit is cleared by writing a 1.

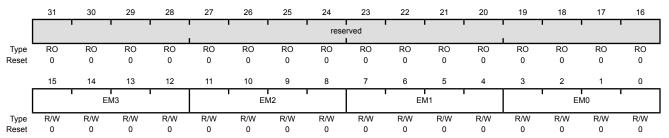
Register 6: ADC Event Multiplexer Select (ADCEMUX), offset 0x014

The ADCEMUX selects the event (trigger) that initiates sampling for each sample sequencer. Each sample sequencer can be configured with a unique trigger source.

ADC Event Multiplexer Select (ADCEMUX)

ADC0 base: 0x4003.8000

Offset 0x014 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:16	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:12	EM3	R/W	0x0	SS3 Trigger Select

This field selects the trigger source for Sample Sequencer 3.

The valid configurations for this field are:

Value Event 0x0 Processor (default) The trigger is initiated by setting the SSn bit in the ADCPSSI register. 0x1 Analog Comparator 0 This trigger is configured by the Analog Comparator Control 0 (ACCTL0) register (page 744).

0x2 **Analog Comparator 1**

> This trigger is configured by the **Analog Comparator Control** 1 (ACCTL1) register (page 744).

reserved 0x3

0x4 External (GPIO PB4)

This trigger is connected to the GPIO interrupt for PB4 (see

"ADC Trigger Source" on page 397).

0x5 Timer

> In addition, the trigger must be enabled with the Thote bit in the GPTMCTL register (page 466).

0x6 reserved 0x7 reserved 0x8 reserved 0x9 reserved 0xA-0xE reserved

0xF Always (continuously sample)

Bit/Field	Name	Туре	Reset	Description	on
11:8	EM2	R/W	0x0		ger Select selects the trigger source for Sample Sequencer 2.
				The valid	configurations for this field are:
				Value	Event
				0x0	Processor (default)
					The trigger is initiated by setting the \mathtt{SSn} bit in the ADCPSSI register.
				0x1	Analog Comparator 0
					This trigger is configured by the Analog Comparator Control 0 (ACCTL0) register (page 744).
				0x2	Analog Comparator 1
					This trigger is configured by the Analog Comparator Control 1 (ACCTL1) register (page 744).
				0x3	reserved
				0x4	External (GPIO PB4)
					This trigger is connected to the GPIO interrupt for PB4 (see "ADC Trigger Source" on page 397).
				0x5	Timer
					In addition, the trigger must be enabled with the ${\tt TnOTE}$ bit in the GPTMCTL register (page 466).
				0x6	reserved
				0x7	reserved
				0x8	reserved
				0x9	reserved
				0xA-0xE	reserved
				0xF	Always (continuously sample)

Bit/Field	Name	Туре	Reset	Description	on
7:4	EM1	R/W	0x0	This field	per Select selects the trigger source for Sample Sequencer 1. configurations for this field are:
				Value	Event
				0x0	Processor (default)
					The trigger is initiated by setting the ssn bit in the ADCPSSI register.
				0x1	Analog Comparator 0
					This trigger is configured by the Analog Comparator Control 0 (ACCTL0) register (page 744).
				0x2	Analog Comparator 1
					This trigger is configured by the Analog Comparator Control 1 (ACCTL1) register (page 744).
				0x3	reserved
				0x4	External (GPIO PB4)
					This trigger is connected to the GPIO interrupt for $PB4$ (see "ADC Trigger Source" on page 397).
				0x5	Timer
					In addition, the trigger must be enabled with the ${\tt TnOTE}$ bit in the GPTMCTL register (page 466).
				0x6	reserved
				0x7	reserved
				0x8	reserved
				0x9	reserved
				0xA-0xE	reserved
				0xF	Always (continuously sample)

Bit/Field	Name	Type	Reset	Description	on
3:0	EM0	R/W	0x0	This field	ger Select selects the trigger source for Sample Sequencer 0 configurations for this field are:
				Value	Event
				0x0	Processor (default)
					The trigger is initiated by setting the ${\tt SSn}$ bit in the ${\tt ADCPSSI}$ register.
				0x1	Analog Comparator 0
					This trigger is configured by the Analog Comparator Control 0 (ACCTL0) register (page 744).
				0x2	Analog Comparator 1
					This trigger is configured by the Analog Comparator Control 1 (ACCTL1) register (page 744).
				0x3	reserved
				0x4	External (GPIO PB4)
					This trigger is connected to the GPIO interrupt for $\mathtt{PB4}$ (see "ADC Trigger Source" on page 397).
				0x5	Timer
					In addition, the trigger must be enabled with the ${\tt TnOTE}$ bit in the GPTMCTL register (page 466).
				0x6	reserved
				0x7	reserved
				0x8	reserved
				0x9	reserved
				0xA-0xE	reserved
				0xF	Always (continuously sample)

Register 7: ADC Underflow Status (ADCUSTAT), offset 0x018

This register indicates underflow conditions in the sample sequencer FIFOs. The corresponding underflow condition is cleared by writing a 1 to the relevant bit position.

ADC Underflow Status (ADCUSTAT)

ADC0 base: 0x4003.8000

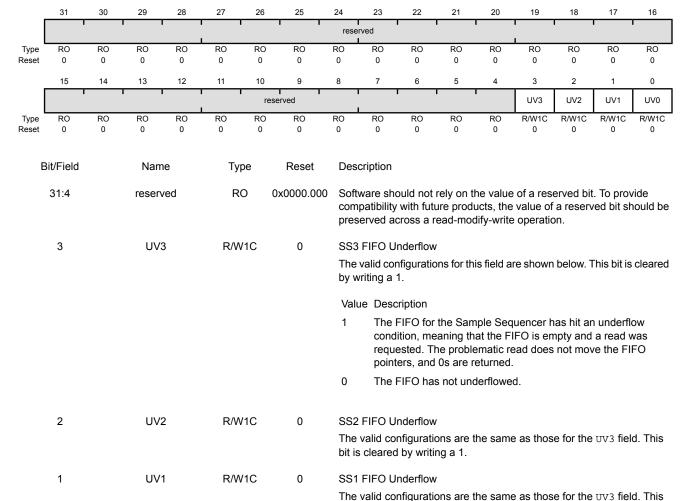
0

UV0

R/W1C

0

Offset 0x018
Type R/W1C, reset 0x0000.0000



bit is cleared by writing a 1.

bit is cleared by writing a 1.

The valid configurations are the same as those for the UV3 field. This

SS0 FIFO Underflow

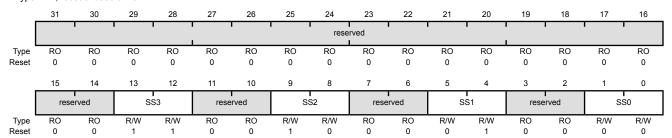
Register 8: ADC Sample Sequencer Priority (ADCSSPRI), offset 0x020

This register sets the priority for each of the sample sequencers. Out of reset, Sequencer 0 has the highest priority, and Sequencer 3 has the lowest priority. When reconfiguring sequence priorities, each sequence must have a unique priority for the ADC to operate properly.

ADC Sample Sequencer Priority (ADCSSPRI)

ADC0 base: 0x4003.8000

Offset 0x020 Type R/W, reset 0x0000.3210



		_		
Bit/Field	Name	Type	Reset	Description
31:14	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
13:12	SS3	R/W	0x3	SS3 Priority This field contains a binary-encoded value that specifies the priority encoding of Sample Sequencer 3. A priority encoding of 0x0 is highest and 0x3 is lowest. The priorities assigned to the sequencers must be uniquely mapped. The ADC may not operate properly if two or more fields are equal.
11:10	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
9:8	SS2	R/W	0x2	SS2 Priority This field contains a binary-encoded value that specifies the priority encoding of Sample Sequencer 2. A priority encoding of 0x0 is highest and 0x3 is lowest. The priorities assigned to the sequencers must be uniquely mapped. The ADC may not operate properly if two or more fields are equal.
7:6	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5:4	SS1	R/W	0x1	SS1 Priority This field contains a binary-encoded value that specifies the priority encoding of Sample Sequencer 1. A priority encoding of 0x0 is highest and 0x3 is lowest. The priorities assigned to the sequencers must be uniquely mapped. The ADC may not operate properly if two or more fields are equal.
3:2	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
1:0	SS0	R/W	0x0	SS0 Priority This field contains a binary-encoded value that specifies the priority encoding of Sample Sequencer 0. A priority encoding of 0x0 is highest and 0x3 is lowest. The priorities assigned to the sequencers must be uniquely mapped. The ADC may not operate properly if two or more fields are equal.

Register 9: ADC Sample Phase Control (ADCSPC), offset 0x024

This register allows the ADC module to sample at one of 16 different discrete phases from 0.0° through 337.5°.

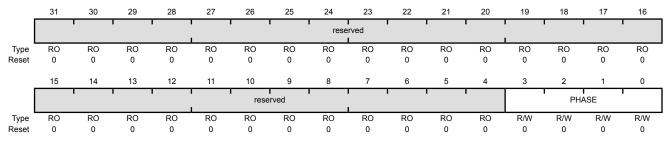
Note: Care should be taken when the PHASE field is non-zero, as the resulting delay in sampling the AINx input may result in undesirable system consequences. The time from ADC trigger to sample is increased and could make the response time longer than anticipated. The added latency could have ramifications in the system design. Designers should carefully consider the impact of this delay.

ADC Sample Phase Control (ADCSPC)

ADC0 base: 0x4003.8000

Offset 0x024

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:4	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3:0	PHASE	R/W	0x0	Phase Difference

This field selects the sample phase difference from the standard sample time.

Value Description 0x0 ADC sample lags by 0.0° 0x1 ADC sample lags by 22.5° 0x2 ADC sample lags by 45.0° ADC sample lags by 67.5° 0x3 0x4 ADC sample lags by 90.0° 0x5 ADC sample lags by 112.5° 0x6 ADC sample lags by 135.0° 0x7 ADC sample lags by 157.5° ADC sample lags by 180.0° 0x8 0x9ADC sample lags by 202.5° ADC sample lags by 225.0° 0xA 0xB ADC sample lags by 247.5°

0xC ADC sample lags by 270.0° 0xD ADC sample lags by 292.5° 0xE ADC sample lags by 315.0°

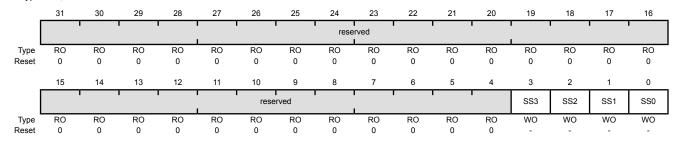
0xF ADC sample lags by 337.5°

Register 10: ADC Processor Sample Sequence Initiate (ADCPSSI), offset 0x028

This register provides a mechanism for application software to initiate sampling in the sample sequencers. Sample sequences can be initiated individually or in any combination. When multiple sequences are triggered simultaneously, the priority encodings in **ADCSSPRI** dictate execution order.

ADC Processor Sample Sequence Initiate (ADCPSSI)

ADC0 base: 0x4003.8000 Offset 0x028 Type R/W, reset -



Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	SS3	WO	-	SS3 Initiate
				Value Description
				Begin sampling on Sample Sequencer 3, if the sequencer is enabled in the ADCACTSS register.
				0 No effect.
				Only a write by software is valid; a read of this register returns no meaningful data.
2	SS2	WO	-	SS2 Initiate
				Value Description
				Begin sampling on Sample Sequencer 2, if the sequencer is enabled in the ADCACTSS register.
				0 No effect.
				Only a write by software is valid; a read of this register returns no meaningful data.
1	SS1	WO	-	SS1 Initiate
				Value Description
				Begin sampling on Sample Sequencer 1, if the sequencer is enabled in the ADCACTSS register.
				0 No effect.

meaningful data.

Only a write by software is valid; a read of this register returns no

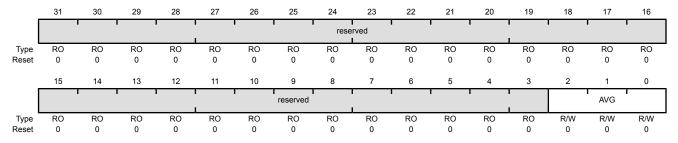
Bit/Field	Name	Туре	Reset	Description
0	SS0	WO	-	SS0 Initiate
				Value Description
				1 Begin sampling on Sample Sequencer 0, if the sequencer is enabled in the ADCACTSS register.
				0 No effect.
				Only a write by software is valid; a read of this register returns no meaningful data.

Register 11: ADC Sample Averaging Control (ADCSAC), offset 0x030

This register controls the amount of hardware averaging applied to conversion results. The final conversion result stored in the FIFO is averaged from 2 AVG consecutive ADC samples at the specified ADC speed. If AVG is 0, the sample is passed directly through without any averaging. If AVG=6, then 64 consecutive ADC samples are averaged to generate one result in the sequencer FIFO. An AVG=7 provides unpredictable results.

ADC Sample Averaging Control (ADCSAC)

ADC0 base: 0x4003.8000 Offset 0x030 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:3	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2:0	AVG	R/W	0x0	Hardware Averaging Control

Specifies the amount of hardware averaging that will be applied to ADC samples. The AVG field can be any value between 0 and 6. Entering a value of 7 creates unpredictable results.

Value Description 0x0 No hardware oversampling 2x hardware oversampling 0x1 0x2 4x hardware oversampling 0x3 8x hardware oversampling 16x hardware oversampling 0x4 32x hardware oversampling 0x5 64x hardware oversampling 0x6 reserved 0x7

Register 12: ADC Digital Comparator Interrupt Status and Clear (ADCDCISC), offset 0x034

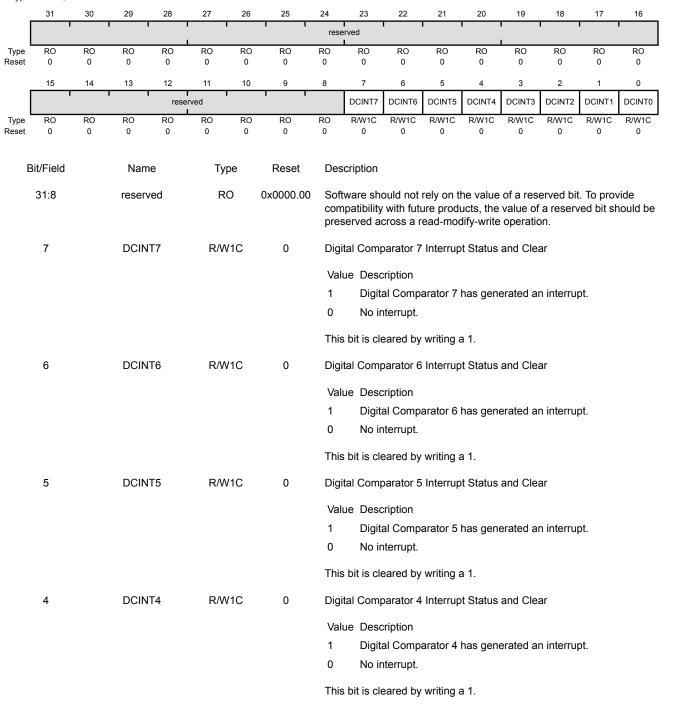
This register provides status and acknowledgement of digital comparator interrupts. One bit is provided for each comparator.

ADC Digital Comparator Interrupt Status and Clear (ADCDCISC)

ADC0 base: 0x4003.8000

Offset 0x034

Type R/W1C, reset 0x0000.0000



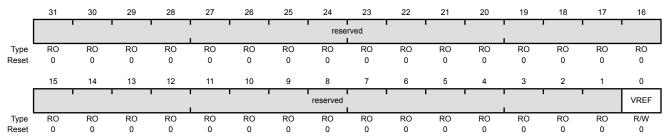
Bit/Field	Name	Туре	Reset	Description
3	DCINT3	R/W1C	0	Digital Comparator 3 Interrupt Status and Clear
				Value Description 1 Digital Comparator 3 has generated an interrupt. 0 No interrupt.
				This bit is cleared by writing a 1.
2	DCINT2	R/W1C	0	Digital Comparator 2 Interrupt Status and Clear
				Value Description 1 Digital Comparator 2 has generated an interrupt. 0 No interrupt.
				This bit is cleared by writing a 1.
1	DCINT1	R/W1C	0	Digital Comparator 1 Interrupt Status and Clear
				Value Description 1 Digital Comparator 1 has generated an interrupt. 0 No interrupt. This bit is cleared by writing a 1.
0	DCINT0	R/W1C	0	Digital Comparator 0 Interrupt Status and Clear Value Description 1 Digital Comparator 0 has generated an interrupt. 0 No interrupt.
				This bit is cleared by writing a 1.

Register 13: ADC Control (ADCCTL), offset 0x038

This register configures the voltage reference. The voltage reference for the conversion can be the internal 3.0-V reference or an external voltage reference in the range of 2.4 V to 3.06 V.

ADC Control (ADCCTL)

ADC0 base: 0x4003.8000 Offset 0x038 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	VREF	R/W	0	Voltage Reference Select

Value Description

- The external VREFA input is the voltage reference. 1
- 0 The internal reference as the voltage reference.

Register 14: ADC Sample Sequence Input Multiplexer Select 0 (ADCSSMUX0), offset 0x040

This register defines the analog input configuration for each sample in a sequence executed with Sample Sequencer 0. This register is 32 bits wide and contains information for eight possible samples.

ADC Sample Sequence Input Multiplexer Select 0 (ADCSSMUX0)

ADC0 base: 0x4003.8000 Offset 0x040 Type R/W, reset 0x0000.0000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
	reserved		MUX7		reserved		MUX6		reserved		MUX5	ı	reserved		MUX4				
Type Reset	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0			
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
	reserved		MUX3		reserved		MUX2		reserved		MUX1	1	reserved		MUX0				
Type Reset	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0			
	D:4/E: - I - I		Name	_	т		Decet	D											
t	Bit/Field		Nam	ie	Ty	pe	Reset	Description											
	31		reserv	/ed	R	0	0	compatibilit		ware should not rely on the value of a reserved bit. To provide a patibility with future products, the value of a reserved bit should be served across a read-modify-write operation.									
	30:28		MUX	(7	R/	W	0x0	8th	Sample I	nput Se	lect								
								The MUX7 field is used during the eighth sample of a swith the sample sequencer. It specifies which of the sampled for the analog-to-digital conversion. The valuathe corresponding pin, for example, a value of 0x1 in is AIN1.				of the are values	nalog inpo set here in	uts is idicates					
	27		reserv	/ed	R	0	0	con		with fut	ure produ	ucts, the	value of	a reser	t. To prov /ed bit sh				
	26:24		MUX	(6	R/	W	0x0	7th	Sample I	nput Se	lect								
								exe	cuted wit	h the sa	s used during the seventh sample of a sequence e sample sequencer. It specifies which of the analog d for the analog-to-digital conversion.								
	23		reserv	/ed	R	0	0	Software should not rely on the value of a reserved across a read-modify-write operation.				a reser\							
	22:20		MUX	(5	R/	W	0x0	6th	Sample I	nput Se	lect								
								The with	мих5 fie	Id is use ple sequ	ed during uencer. It	specifie	es which		quence ex nalog inpi				
	19		reserv	/ed	R	0	0								t. To prov ed bit sh				

preserved across a read-modify-write operation.

Bit/Field	Name	Type	Reset	Description
18:16	MUX4	R/W	0x0	5th Sample Input Select The $\texttt{MUX4}$ field is used during the fifth sample of a sequence executed with the sample sequencer. It specifies which of the analog inputs is sampled for the analog-to-digital conversion.
15	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
14:12	MUX3	R/W	0x0	4th Sample Input Select The MUX3 field is used during the fourth sample of a sequence executed with the sample sequencer. It specifies which of the analog inputs is sampled for the analog-to-digital conversion.
11	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
10:8	MUX2	R/W	0x0	3rd Sample Input Select The MUX2 field is used during the third sample of a sequence executed with the sample sequencer. It specifies which of the analog inputs is sampled for the analog-to-digital conversion.
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6:4	MUX1	R/W	0x0	2nd Sample Input Select The MUX1 field is used during the second sample of a sequence executed with the sample sequencer. It specifies which of the analog inputs is sampled for the analog-to-digital conversion.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2:0	MUX0	R/W	0x0	1st Sample Input Select The MUX0 field is used during the first sample of a sequence executed with the sample sequencer. It specifies which of the analog inputs is sampled for the analog-to-digital conversion.

Register 15: ADC Sample Sequence Control 0 (ADCSSCTL0), offset 0x044

This register contains the configuration information for each sample for a sequence executed with a sample sequencer. When configuring a sample sequence, the END bit must be set for the final sample, whether it be after the first sample, eighth sample, or any sample in between. This register is 32 bits wide and contains information for eight possible samples.

ADC Sample Sequence Control 0 (ADCSSCTL0)

ADC0 base: 0x4003.8000

Offset 0x044 Type R/W, reset 0x0000.0000

Dit/Eiold

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	TS7	IE7	END7	D7	TS6	IE6	END6	D6	TS5	IE5	END5	D5	TS4	IE4	END4	D4
Туре	R/W	R/W	R/W	R/W												
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0
Туре	R/W	R/W	R/W	R/W												
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Description

DII/FIEIU	ivame	туре	Reset	Description
31	TS7	R/W	0	8th Sample Temp Sensor Select
				Value Description

- The temperature sensor is read during the eighth sample of the sample sequence.
- The input pin specified by the ADCSSMUXn register is read during the eighth sample of the sample sequence.
- 30 IE7 R/W 0 8th Sample Interrupt Enable

Value Description

- The raw interrupt signal (INR0 bit) is asserted at the end of the eighth sample's conversion. If the MASK0 bit in the ADCIM register is set, the interrupt is promoted to the interrupt controller.
- 0 The raw interrupt is not asserted to the interrupt controller.

It is legal to have multiple samples within a sequence generate interrupts.

29 END7 R/W 0 8th Sample is End of Sequence

Value Description

- 1 The eighth sample is the last sample of the sequence.
- 0 Another sample in the sequence is the final sample.

It is possible to end the sequence on any sample position. Software must set an \mathtt{ENDn} bit somewhere within the sequence. Samples defined after the sample containing a set \mathtt{ENDn} bit are not requested for conversion even though the fields may be non-zero.

Bit/Field	Name	Туре	Reset	Description
28	D7	R/W	0	8th Sample Diff Input Select
				Value Description
				The analog input is differentially sampled. The corresponding ADCSSMUXn nibble must be set to the pair number "i", where the paired inputs are "2i and 2i+1".
				0 The analog inputs are not differentially sampled.
				Because the temperature sensor does not have a differential option, this bit must not be set when the ${\tt TS7}$ bit is set.
27	TS6	R/W	0	7th Sample Temp Sensor Select Same definition as TS7 but used during the seventh sample.
26	IE6	R/W	0	7th Sample Interrupt Enable Same definition as IE7 but used during the seventh sample.
25	END6	R/W	0	7th Sample is End of Sequence Same definition as END7 but used during the seventh sample.
24	D6	R/W	0	7th Sample Diff Input Select Same definition as D7 but used during the seventh sample.
23	TS5	R/W	0	6th Sample Temp Sensor Select Same definition as TS7 but used during the sixth sample.
22	IE5	R/W	0	6th Sample Interrupt Enable Same definition as IE7 but used during the sixth sample.
21	END5	R/W	0	6th Sample is End of Sequence Same definition as END7 but used during the sixth sample.
20	D5	R/W	0	6th Sample Diff Input Select Same definition as D7 but used during the sixth sample.
19	TS4	R/W	0	5th Sample Temp Sensor Select Same definition as TS7 but used during the fifth sample.
18	IE4	R/W	0	5th Sample Interrupt Enable Same definition as IE7 but used during the fifth sample.
17	END4	R/W	0	5th Sample is End of Sequence Same definition as END7 but used during the fifth sample.
16	D4	R/W	0	5th Sample Diff Input Select Same definition as D7 but used during the fifth sample.
15	TS3	R/W	0	4th Sample Temp Sensor Select Same definition as TS7 but used during the fourth sample.
14	IE3	R/W	0	4th Sample Interrupt Enable Same definition as IE7 but used during the fourth sample.

Bit/Field	Name	Туре	Reset	Description
13	END3	R/W	0	4th Sample is End of Sequence Same definition as END7 but used during the fourth sample.
12	D3	R/W	0	4th Sample Diff Input Select Same definition as D7 but used during the fourth sample.
11	TS2	R/W	0	3rd Sample Temp Sensor Select Same definition as TS7 but used during the third sample.
10	IE2	R/W	0	3rd Sample Interrupt Enable Same definition as IE7 but used during the third sample.
9	END2	R/W	0	3rd Sample is End of Sequence Same definition as END7 but used during the third sample.
8	D2	R/W	0	3rd Sample Diff Input Select Same definition as D7 but used during the third sample.
7	TS1	R/W	0	2nd Sample Temp Sensor Select Same definition as TS7 but used during the second sample.
6	IE1	R/W	0	2nd Sample Interrupt Enable Same definition as IE7 but used during the second sample.
5	END1	R/W	0	2nd Sample is End of Sequence Same definition as END7 but used during the second sample.
4	D1	R/W	0	2nd Sample Diff Input Select Same definition as D7 but used during the second sample.
3	TS0	R/W	0	1st Sample Temp Sensor Select Same definition as TS7 but used during the first sample.
2	IE0	R/W	0	1st Sample Interrupt Enable Same definition as IE7 but used during the first sample.
1	END0	R/W	0	1st Sample is End of Sequence Same definition as END7 but used during the first sample.
0	D0	R/W	0	1st Sample Diff Input Select Same definition as D7 but used during the first sample.

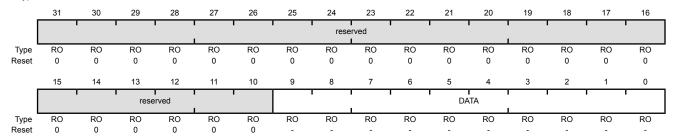
Register 16: ADC Sample Sequence Result FIFO 0 (ADCSSFIFO0), offset 0x048 Register 17: ADC Sample Sequence Result FIFO 1 (ADCSSFIFO1), offset 0x068 Register 18: ADC Sample Sequence Result FIFO 2 (ADCSSFIFO2), offset 0x088 Register 19: ADC Sample Sequence Result FIFO 3 (ADCSSFIFO3), offset 0x0A8

Important: This register is read-sensitive. See the register description for details.

This register contains the conversion results for samples collected with the sample sequencer (the ADCSSFIFO0 register is used for Sample Sequencer 0, ADCSSFIFO1 for Sequencer 1, ADCSSFIFO2 for Sequencer 2, and ADCSSFIFO3 for Sequencer 3). Reads of this register return conversion result data in the order sample 0, sample 1, and so on, until the FIFO is empty. If the FIFO is not properly handled by software, overflow and underflow conditions are registered in the ADCOSTAT and ADCUSTAT registers.

ADC Sample Sequence Result FIFO n (ADCSSFIFOn)

ADC0 base: 0x4003.8000 Offset 0x048 Type RO, reset -



Bit/Field	Name	Туре	Reset	Description
31:10	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
9:0	DATA	RO	-	Conversion Result Data

Register 20: ADC Sample Sequence FIFO 0 Status (ADCSSFSTAT0), offset 0x04C

Register 21: ADC Sample Sequence FIFO 1 Status (ADCSSFSTAT1), offset 0x06C

Register 22: ADC Sample Sequence FIFO 2 Status (ADCSSFSTAT2), offset 0x08C

Register 23: ADC Sample Sequence FIFO 3 Status (ADCSSFSTAT3), offset 0x0AC

This register provides a window into the sample sequencer, providing full/empty status information as well as the positions of the head and tail pointers. The reset value of 0x100 indicates an empty FIFO with the head and tail pointers both pointing to index 0. The **ADCSSFSTAT0** register provides status on FIFO0, which has 8 entries; **ADCSSFSTAT1** on FIFO1, which has 4 entries;

ADCSSFSTAT2 on FIFO2, which has 4 entries; and **ADCSSFSTAT3** on FIFO3 which has a single entry.

ADC Sample Sequence FIFO 0 Status (ADCSSFSTAT0)

ADC0 base: 0x4003.8000 Offset 0x04C

Offset 0x04C Type RO, reset 0x0000.0100

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								rese	rved							1
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		reserved		FULL		reserved		EMPTY		HP	TR			TP	TR	'
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:13	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	FULL	RO	0	FIFO Full
				Value Description 1 The FIFO is currently full. 0 The FIFO is not currently full.
11:9	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	EMPTY	RO	1	FIFO Empty
				Value Decementary

Value Description

- 1 The FIFO is currently empty.
- 0 The FIFO is not currently empty.

Bit/Field	Name	Type	Reset	Description
7:4	HPTR	RO	0x0	FIFO Head Pointer
				This field contains the current "head" pointer index for the FIFO, that is, the next entry to be written.
				Valid values are 0x0-0x7 for FIFO0; 0x0-0x3 for FIFO1 and FIFO2; and 0x0 for FIFO3.
3:0	TPTR	RO	0x0	FIFO Tail Pointer
				This field contains the current "tail" pointer index for the FIFO, that is, the next entry to be read.
				Valid values are $0x0-0x7$ for FIFO0; $0x0-0x3$ for FIFO1 and FIFO2; and $0x0$ for FIFO3.

Register 24: ADC Sample Sequence 0 Operation (ADCSSOP0), offset 0x050

This register determines whether the sample from the given conversion on Sample Sequence 0 is saved in the Sample Sequence FIFO0 or sent to the digital comparator unit.

ADC Sample Sequence 0 Operation (ADCSSOP0)

ADC0 base: 0x4003.8000 Offset 0x050 Type R/W, reset 0x0000.0000

		reserved		S7DCOP		reserved		S6DCOP		reserved		S5DCOP		reserved		S4DCOP
Type	RO	RO	RO 0	R/W	RO	RO	RO	R/W	RO 0	RO	RO 0	R/W	RO	RO 0	RO	R/W
Reset	0	0		0	0	0	0	0		0		0	0		0	0
ſ	15	14	13	12	11	10	9	8	7	6	5	4 CADCOD	3	2	1	0
Type	RO	reserved	RO	S3DCOP R/W	RO	reserved	RO	S2DCOP R/W	RO	reserved	RO	S1DCOP R/W	RO	reserved	RO	S0DCOP R/W
Type Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
В	it/Field		Nan	ne	Ту	ре	Reset	Des	cription							
	31:29		reser	ved	R	0	0x0	Soft	ware sh	nould not re	ely on t	he value	of a res	served bit.	To pro	vide
								com	patibilit	y with futur	re prod	ucts, the	value o	f a reserve		
								pres	served a	across a re	ad-mo	dify-write	operati	on.		
	28		S7DC	OP	R	W	0	Sam	nple 7 D	igital Com	parato	r Operatio	n			
								Valu	ue Des	cription						
								1		eighth san	nple is s	sent to the	digital	comparato	or unit s	pecified
									,	he S7DCSE			SSDC	o register,	and th	e value
								0		ot written to eighth sar			Sample	Soguene	o EIEC	00
								U	1116	eigiitii sai	libie is	saveu III	Sample	Sequenc	e i ii c	
	27:25		reser	hav	R	.0	0x0	Soft	ware sh	nould not re	elv on t	he value	of a res	erved hit	To pro	vide
	27.20		10001	vou		.0	OXO	com	patibilit	y with futur	re prod	ucts, the	value o	f a reserve		
								pres	served a	cross a re	ad-mo	dify-write	operati	on.		
	24		S6DC	COP	R	W	0	Sam	nple 6 D	igital Com	parato	r Operatio	n			
								Sam	ne defin	ition as S7	DCOP k	out used o	during t	he seventl	h samp	le.
	23:21		reser	ved	R	.0	0x0	Soft	ware sh	nould not re	ely on t	he value	of a res	served bit.	To pro	vide
								com	patibilit	y with futur	re prod	ucts, the	value o	f a reserve		
								pres	served a	across a re	ad-mo	airy-write	operati	on.		
	20		S5DC	OP	R	W	0		•	igital Com	•	•				
								San	ne defin	ition as S7	DCOP k	out used o	during t	he sixth sa	ample.	
	19:17		reser	ved	R	.0	0x0	Soft	ware sh	nould not re	ely on t	he value	of a res	served bit.	To pro	vide
										y with futur across a re					ed bit s	nould be
												-		OII.		
	16		S4DC	COP	R/	W	0			igital Com	•					
								Sam	ne defin	ition as S7	DCOP k	out used o	during t	he fifth sai	mple.	
	15:13		reser	ved	R	.0	0x0			nould not re						
										y with futur across a re					ed bit s	nould be
								p. 00				,				

Bit/Field	Name	Туре	Reset	Description
12	S3DCOP	R/W	0	Sample 3 Digital Comparator Operation Same definition as S7DCOP but used during the fourth sample.
11:9	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	S2DCOP	R/W	0	Sample 2 Digital Comparator Operation Same definition as STDCOP but used during the third sample.
				, , , , , , , , , , , , , , , , , , ,
7:5	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	S1DCOP	R/W	0	Sample 1 Digital Comparator Operation
				Same definition as ${\tt S7DCOP}$ but used during the second sample.
3:1	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	S0DCOP	R/W	0	Sample 0 Digital Comparator Operation
				Same definition as S7DCOP but used during the first sample.

Register 25: ADC Sample Sequence 0 Digital Comparator Select (ADCSSDC0), offset 0x054

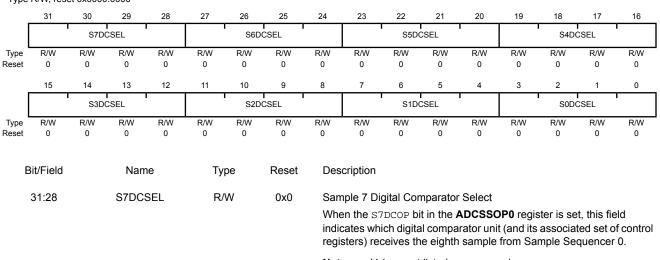
This register determines which digital comparator receives the sample from the given conversion on Sample Sequence 0, if the corresponding SnDCOP bit in the **ADCSSOP0** register is set.

ADC Sample Sequence 0 Digital Comparator Select (ADCSSDC0)

ADC0 base: 0x4003.8000

Offset 0x054

Type R/W, reset 0x0000.0000



Note: Values not listed are reserved.

				Value Description
				0x0 Digital Comparator Unit 0 (ADCDCCMP0 and ADCDCCTL0)
				0x1 Digital Comparator Unit 1 (ADCDCCMP1 and ADCDCCTL1)
				0x2 Digital Comparator Unit 2 (ADCDCCMP2 and ADCDCCTL2)
				0x3 Digital Comparator Unit 3 (ADCDCCMP3 and ADCDCCTL3)
				0x4 Digital Comparator Unit 4 (ADCDCCMP4 and ADCDCCTL4)
				0x5 Digital Comparator Unit 5 (ADCDCCMP5 and ADCDCCTL5)
				0x6 Digital Comparator Unit 6 (ADCDCCMP6 and ADCDCCTL6)
				0x7 Digital Comparator Unit 7 (ADCDCCMP7 and ADCDCCTL7)
27:24	S6DCSEL	R/W	0x0	Sample 6 Digital Comparator Select
				This field has the same encodings as ${\tt S7DCSEL}$ but is used during the seventh sample.
23:20	S5DCSEL	R/W	0x0	Sample 5 Digital Comparator Select
				This field has the same encodings as ${\tt S7DCSEL}$ but is used during the sixth sample.
19:16	S4DCSEL	R/W	0x0	Sample 4 Digital Comparator Select
				This field has the same encodings as ${\tt S7DCSEL}$ but is used during the fifth sample.
15:12	S3DCSEL	R/W	0x0	Sample 3 Digital Comparator Select
				This field has the same encodings as ${\tt S7DCSEL}$ but is used during the fourth sample.

Bit/Field	Name	Type	Reset	Description
11:8	S2DCSEL	R/W	0x0	Sample 2 Digital Comparator Select This field has the same encodings as S7DCSEL but is used during the third sample.
7:4	S1DCSEL	R/W	0x0	Sample 1 Digital Comparator Select This field has the same encodings as S7DCSEL but is used during the second sample.
3:0	SODCSEL	R/W	0x0	Sample 0 Digital Comparator Select This field has the same encodings as S7DCSEL but is used during the first sample.

Register 26: ADC Sample Sequence Input Multiplexer Select 1 (ADCSSMUX1), offset 0x060

Register 27: ADC Sample Sequence Input Multiplexer Select 2 (ADCSSMUX2), offset 0x080

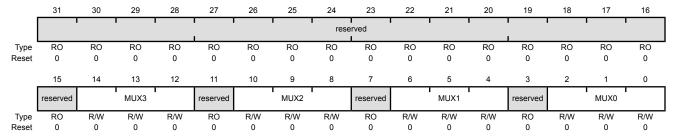
This register defines the analog input configuration for each sample in a sequence executed with Sample Sequencer 1 or 2. These registers are 16 bits wide and contain information for four possible samples. See the **ADCSSMUX0** register on page 559 for detailed bit descriptions. The **ADCSSMUX1** register affects Sample Sequencer 1 and the **ADCSSMUX2** register affects Sample Sequencer 2.

ADC Sample Sequence Input Multiplexer Select 1 (ADCSSMUX1)

ADC0 base: 0x4003.8000

Offset 0x060

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:15	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
14:12	MUX3	R/W	0x0	4th Sample Input Select
11	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
10:8	MUX2	R/W	0x0	3rd Sample Input Select
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6:4	MUX1	R/W	0x0	2nd Sample Input Select
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2:0	MUX0	R/W	0x0	1st Sample Input Select

Register 28: ADC Sample Sequence Control 1 (ADCSSCTL1), offset 0x064 Register 29: ADC Sample Sequence Control 2 (ADCSSCTL2), offset 0x084

These registers contain the configuration information for each sample for a sequence executed with Sample Sequencer 1 or 2. When configuring a sample sequence, the END bit must be set for the final sample, whether it be after the first sample, fourth sample, or any sample in between. These registers are 16-bits wide and contain information for four possible samples. See the **ADCSSCTL0** register on page 561 for detailed bit descriptions. The **ADCSSCTL1** register configures Sample Sequencer 1 and the **ADCSSCTL2** register configures Sample Sequencer 2.

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ADC Sample Sequence Control 1 (ADCSSCTL1)

TS1

7

R/W

0

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ADC0 base: 0x4003.8000 Offset 0x064 Type R/W, reset 0x0000.0000

	1		1				1	rese	rved	ı					1	
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0
Type Reset	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0
Е	Bit/Field		Nam	ie	Ту	ре	Reset	Des	cription							
	31:16		reserv	/ed	R	0	0x0000	com	patibility	with futu	ıre produ	ne value ucts, the lify-write	value of	a reserv		
	15		TS	3	R/	W	0		Sample ⁻ ne definit	•		ect sed durir	ng the fo	urth sam	ıple.	
	14		IE3	i	R/	W	0		Sample I ne definit	•		sed durir	ng the fo	urth sam	ıple.	
	13		END	3	R/	W	0		Sample i ne definit		•	ce used dur	ring the f	fourth sa	mple.	
	12		D3		R/	W	0			e Diff Input Select nition as D7 but used during the fourth sample.						
	11		TS2	2	R/	W	0		Sample ⁻ ne definit			lect sed durir	ng the th	ird samp	ole.	
	10		IE2	!	R/	W	0		Sample I ne definit	•		sed durir	ng the th	ird samp	ole.	
	9		END	2	R/	W	0		Sample i ne definit		•	ice used dui	ring the t	third sam	ıple.	
	8		D2		R/	W	0		Sample I ne definit	•		ed durinç	g the thir	d sample	Э.	

2nd Sample Temp Sensor Select

Same definition as TS7 but used during the second sample.

Bit/Field	Name	Туре	Reset	Description
6	IE1	R/W	0	2nd Sample Interrupt Enable Same definition as IE7 but used during the second sample.
5	END1	R/W	0	2nd Sample is End of Sequence Same definition as END7 but used during the second sample.
4	D1	R/W	0	2nd Sample Diff Input Select Same definition as D7 but used during the second sample.
3	TS0	R/W	0	1st Sample Temp Sensor Select Same definition as TS7 but used during the first sample.
2	IE0	R/W	0	1st Sample Interrupt Enable Same definition as IE7 but used during the first sample.
1	END0	R/W	0	1st Sample is End of Sequence Same definition as END7 but used during the first sample.
0	D0	R/W	0	1st Sample Diff Input Select Same definition as D7 but used during the first sample.

Register 30: ADC Sample Sequence 1 Operation (ADCSSOP1), offset 0x070 Register 31: ADC Sample Sequence 2 Operation (ADCSSOP2), offset 0x090

This register determines whether the sample from the given conversion on Sample Sequence n is saved in the Sample Sequence n FIFO or sent to the digital comparator unit. The **ADCSSOP1** register controls Sample Sequencer 1 and the **ADCSSOP2** register controls Sample Sequencer 2.

ADC Sample Sequence 1 Operation (ADCSSOP1)

ADC0 base: 0x4003.8000 Offset 0x070

Offset 0x070 Type R/W, reset 0x0000.0000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1 1						resei	ved			, ,				'
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		reserved		S3DCOP		reserved		S2DCOP		reserved		S1DCOP		reserved		SODCOP
Туре	RO	RO	RO	R/W	RO	RO	RO	R/W	RO	RO	RO	R/W	RO	RO	RO	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:13	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	S3DCOP	R/W	0	Sample 3 Digital Comparator Operation
				Value Description
				The fourth sample is sent to the digital comparator unit specified by the S3DCSEL bit in the ADCSSDC0n register, and the value is not written to the FIFO.
				0 The fourth sample is saved in Sample Sequence FIFOn.
11:9	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	S2DCOP	R/W	0	Sample 2 Digital Comparator Operation
				Same definition as S3DCOP but used during the third sample.
7:5	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	S1DCOP	R/W	0	Sample 1 Digital Comparator Operation
				Same definition as S3DCOP but used during the second sample.
3:1	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	SODCOP	R/W	0	Sample 0 Digital Comparator Operation
				Same definition as S3DCOP but used during the first sample.

Register 32: ADC Sample Sequence 1 Digital Comparator Select (ADCSSDC1), offset 0x074

Register 33: ADC Sample Sequence 2 Digital Comparator Select (ADCSSDC2), offset 0x094

These registers determine which digital comparator receives the sample from the given conversion on Sample Sequence n if the corresponding SnDCOP bit in the **ADCSSOPn** register is set. The **ADCSSDC1** register controls the selection for Sample Sequencer 1 and the **ADCSSDC2** register controls the selection for Sample Sequencer 2.

ADC Sample Sequence 1 Digital Comparator Select (ADCSSDC1)

ADC0 base: 0x4003.8000

Offset 0x074

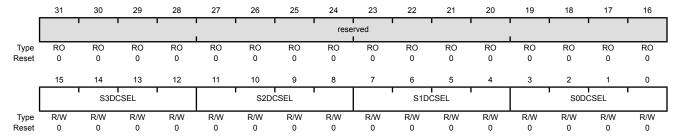
11:8

S2DCSEL

R/W

0x0

Type R/W, reset 0x0000.0000



Bit/Field	name	туре	Reset	Description
31:16	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:12	S3DCSEL	R/W	0x0	Sample 3 Digital Comparator Select

When the S3DCOP bit in the **ADCSSOPn** register is set, this field indicates which digital comparator unit (and its associated set of control registers) receives the eighth sample from Sample Sequencer n.

Note: Values not listed are reserved.

Value	Description
value	Description
0x0	Digital Comparator Unit 0 (ADCDCCMP0 and ADCCCTL0)
0x1	Digital Comparator Unit 1 (ADCDCCMP1 and ADCCCTL1)
0x2	Digital Comparator Unit 2 (ADCDCCMP2 and ADCCCTL2)
0x3	Digital Comparator Unit 3 (ADCDCCMP3 and ADCCCTL3)
0x4	Digital Comparator Unit 4 (ADCDCCMP4 and ADCCCTL4)
0x5	Digital Comparator Unit 5 (ADCDCCMP5 and ADCCCTL5)
0x6	Digital Comparator Unit 6 (ADCDCCMP6 and ADCCCTL6)
0x7	Digital Comparator Unit 7 (ADCDCCMP7 and ADCCCTL7)
Sampl	e 2 Digital Comparator Select

This field has the same encodings as ${\tt S3DCSEL}$ but is used during the third sample.

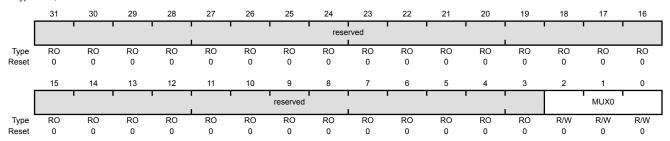
Bit/Field	Name	Type	Reset	Description
7:4	S1DCSEL	R/W	0x0	Sample 1 Digital Comparator Select This field has the same encodings as S3DCSEL but is used during the second sample.
3:0	SODCSEL	R/W	0x0	Sample 0 Digital Comparator Select This field has the same encodings as S3DCSEL but is used during the first sample.

Register 34: ADC Sample Sequence Input Multiplexer Select 3 (ADCSSMUX3), offset 0x0A0

This register defines the analog input configuration for the sample executed with Sample Sequencer 3. This register is 4 bits wide and contains information for one possible sample. See the **ADCSSMUX0** register on page 559 for detailed bit descriptions.

ADC Sample Sequence Input Multiplexer Select 3 (ADCSSMUX3)

ADC0 base: 0x4003.8000 Offset 0x0A0 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:3	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2:0	MUX0	R/W	0	1st Sample Input Select

Register 35: ADC Sample Sequence Control 3 (ADCSSCTL3), offset 0x0A4

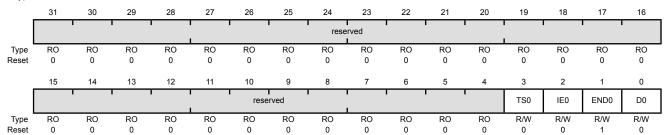
This register contains the configuration information for a sample executed with Sample Sequencer 3. The ENDO bit is always set as this sequencer can execute only one sample. This register is 4 bits wide and contains information for one possible sample. See the **ADCSSCTLO** register on page 561 for detailed bit descriptions.

ADC Sample Sequence Control 3 (ADCSSCTL3)

ADC0 base: 0x4003.8000

Offset 0x0A4

Type R/W, reset 0x0000.0002



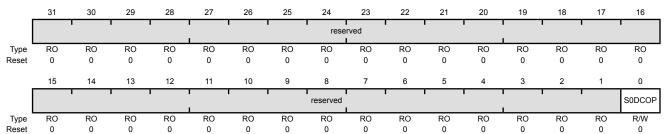
Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	TS0	R/W	0	1st Sample Temp Sensor Select Same definition as TS7 but used during the first sample.
2	IE0	R/W	0	1st Sample Interrupt Enable Same definition as IE7 but used during the first sample.
1	END0	R/W	1	1st Sample is End of Sequence Same definition as END7 but used during the first sample. Because this sequencer has only one entry, this bit must be set.
0	D0	R/W	0	1st Sample Diff Input Select Same definition as D7 but used during the first sample.

Register 36: ADC Sample Sequence 3 Operation (ADCSSOP3), offset 0x0B0

This register determines whether the sample from the given conversion on Sample Sequence 3 is saved in the Sample Sequence 3 FIFO or sent to the digital comparator unit.

ADC Sample Sequence 3 Operation (ADCSSOP3)

ADC0 base: 0x4003.8000 Offset 0x0B0 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	SODCOP	R/W	0	Sample 0 Digital Comparator Operation

Value Description

- The sample is sent to the digital comparator unit specified by the SODCSEL bit in the ADCSSDC03 register, and the value is not written to the FIFO.
- The sample is saved in Sample Sequence FIFO3. 0

Register 37: ADC Sample Sequence 3 Digital Comparator Select (ADCSSDC3), offset 0x0B4

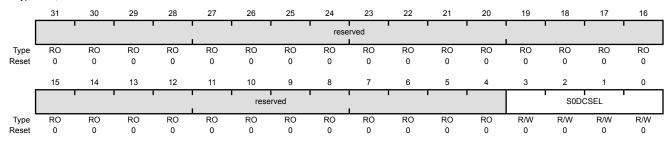
This register determines which digital comparator receives the sample from the given conversion on Sample Sequence 3 if the corresponding SnDCOP bit in the **ADCSSOP3** register is set.

ADC Sample Sequence 3 Digital Comparator Select (ADCSSDC3)

ADC0 base: 0x4003.8000

Offset 0x0B4

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:4	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3:0	S0DCSEL	R/W	0x0	Sample 0 Digital Comparator Select

When the SODCOP bit in the **ADCSSOP3** register is set, this field indicates which digital comparator unit (and its associated set of control registers) receives the sample from Sample Sequencer 3.

Note: Values not listed are reserved.

Value Description 0x0 Digital Comparator Unit 0 (ADCDCCMP0 and ADCCCTL0) Digital Comparator Unit 1 (ADCDCCMP1 and ADCCCTL1) 0x1 Digital Comparator Unit 2 (ADCDCCMP2 and ADCCCTL2) 0x2 0x3 Digital Comparator Unit 3 (ADCDCCMP3 and ADCCCTL3) 0x4 Digital Comparator Unit 4 (ADCDCCMP4 and ADCCCTL4) 0x5 Digital Comparator Unit 5 (ADCDCCMP5 and ADCCCTL5) Digital Comparator Unit 6 (ADCDCCMP6 and ADCCCTL6) 0x6 0x7 Digital Comparator Unit 7 (ADCDCCMP7 and ADCCCTL7)

Register 38: ADC Digital Comparator Reset Initial Conditions (ADCDCRIC), offset 0xD00

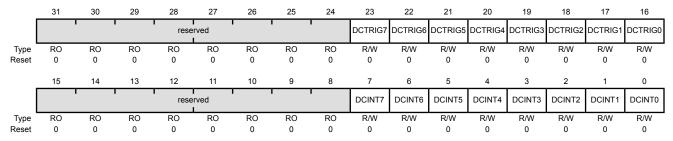
This register provides the ability to reset any of the digital comparator interrupt or trigger functions back to their initial conditions. Resetting these functions ensures that the data that is being used by the interrupt and trigger functions in the digital comparator unit is not stale.

ADC Digital Comparator Reset Initial Conditions (ADCDCRIC)

DCTRIG7

ADC0 base: 0x4003.8000 Offset 0xD00 Type R/W, reset 0x0000.0000

23



Bit/Field	Name	Type	Reset	Description
31:24	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

0

Digital Comparator Trigger 7

Value Description

- 1 Resets the Digital Comparator 7 trigger unit to its initial conditions.
- No effect. 0

When the trigger has been cleared, this bit is automatically cleared.

Because the digital comparators use the current and previous ADC conversion values to determine when to assert the trigger, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used. After setting this bit, software should wait until the bit clears before continuing.

22 DCTRIG6 R/W 0 Digital Comparator Trigger 6

R/W

Value Description

- Resets the Digital Comparator 6 trigger unit to its initial conditions
- 0 No effect.

When the trigger has been cleared, this bit is automatically cleared.

Because the digital comparators use the current and previous ADC conversion values to determine when to assert the trigger, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.

Description

Name

Type

Reset

Bit/Field

21	DCTRIG5	R/W	0	Digital Comparator Trigger 5
				Value Description
				Resets the Digital Comparator 5 trigger unit to its initial conditions.
				0 No effect.
				When the trigger has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the trigger, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
20	DCTRIG4	R/W	0	Digital Comparator Trigger 4
				Value Description
				1 Resets the Digital Comparator 4 trigger unit to its initial conditions.
				0 No effect.
				When the trigger has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the trigger, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
19	DCTRIG3	R/W	0	Digital Comparator Trigger 3
				Value Description
				 Resets the Digital Comparator 3 trigger unit to its initial conditions.
				0 No effect.
				When the trigger has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the trigger, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
18	DCTRIG2	R/W	0	Digital Comparator Trigger 2
				Value Description
				 Resets the Digital Comparator 2 trigger unit to its initial conditions.
				0 No effect.
				When the trigger has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the trigger, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.

Bit/Field	Name	Туре	Reset	Description
17	DCTRIG1	R/W	0	Digital Comparator Trigger 1
				Value Description
				1 Resets the Digital Comparator 1 trigger unit to its initial conditions.
				0 No effect.
				When the trigger has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the trigger, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
16	DCTRIG0	R/W	0	Digital Comparator Trigger 0
				Value Description
				 Resets the Digital Comparator 0 trigger unit to its initial conditions.
				0 No effect.
				When the trigger has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the trigger, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
15:8	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	DCINT7	R/W	0	Digital Comparator Interrupt 7
				Value Description
				1 Resets the Digital Comparator 7 interrupt unit to its initial conditions.
				0 No effect.
				When the interrupt has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the interrupt, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
6	DCINT6	R/W	0	Digital Comparator Interrupt 6
				Value Description
				 Resets the Digital Comparator 6 interrupt unit to its initial conditions.
				0 No effect.
				When the interrupt has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the interrupt, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.

Bit/Field	Name	Type	Reset	Description
5	DCINT5	R/W	0	Digital Comparator Interrupt 5
				Value Description
				1 Resets the Digital Comparator 5 interrupt unit to its initial conditions.
				0 No effect.
				When the interrupt has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the interrupt, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
4	DCINT4	R/W	0	Digital Comparator Interrupt 4
				Value Description
				 Resets the Digital Comparator 4 interrupt unit to its initial conditions.
				0 No effect.
				When the interrupt has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the interrupt, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
3	DCINT3	R/W	0	Digital Comparator Interrupt 3
				Value Description
				1 Resets the Digital Comparator 3 interrupt unit to its initial conditions.
				0 No effect.
				When the interrupt has been cleared, this bit is automatically cleared.
				Because the digital comparators use the current and previous ADC conversion values to determine when to assert the interrupt, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
2	DCINT2	R/W	0	Digital Comparator Interrupt 2
				Value Description
				 Resets the Digital Comparator 2 interrupt unit to its initial conditions.
				0 No effect.
				When the interrupt has been cleared, this bit is automatically cleared. Because the digital comparators use the current and previous ADC conversion values to determine when to assert the interrupt, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.

Bit/Field	Name	Туре	Reset	Description
1	DCINT1	R/W	0	Digital Comparator Interrupt 1
				Value Description
				 Resets the Digital Comparator 1 interrupt unit to its initial conditions.
				0 No effect.
				When the interrupt has been cleared, this bit is automatically cleared. Because the digital comparators use the current and previous ADC conversion values to determine when to assert the interrupt, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.
0	DCINT0	R/W	0	Digital Comparator Interrupt 0
				Value Description
				 Resets the Digital Comparator 0 interrupt unit to its initial conditions.
				0 No effect.
				When the interrupt has been cleared, this bit is automatically cleared.

When the interrupt has been cleared, this bit is automatically cleared. Because the digital comparators use the current and previous ADC conversion values to determine when to assert the interrupt, it is important to reset the digital comparator to initial conditions when starting a new sequence so that stale data is not used.

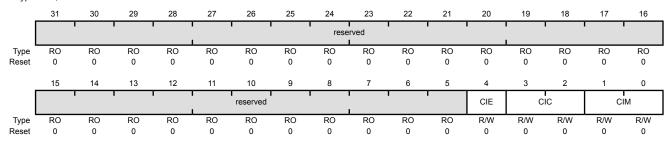
Register 39: ADC Digital Comparator Control 0 (ADCDCCTL0), offset 0xE00 Register 40: ADC Digital Comparator Control 1 (ADCDCCTL1), offset 0xE04 Register 41: ADC Digital Comparator Control 2 (ADCDCCTL2), offset 0xE08 Register 42: ADC Digital Comparator Control 3 (ADCDCCTL3), offset 0xE0C Register 43: ADC Digital Comparator Control 4 (ADCDCCTL4), offset 0xE10 Register 44: ADC Digital Comparator Control 5 (ADCDCCTL5), offset 0xE14 Register 45: ADC Digital Comparator Control 6 (ADCDCCTL6), offset 0xE18 Register 46: ADC Digital Comparator Control 7 (ADCDCCTL7), offset 0xE1C

This register provides the comparison encodings that generate an interrupt.

ADC Digital Comparator Control 0 (ADCDCCTL0)

ADC0 base: 0x4003.8000 Offset 0xE00

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:5	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	CIE	R/W	0	Comparison Interrupt Enable

Value Description

- 1 Enables the comparison interrupt. The ADC conversion data is used to determine if an interrupt should be generated according to the programming of the CIC and CIM fields.
- 0 Disables the comparison interrupt. ADC conversion data has no effect on interrupt generation.

CIC	R/W	0x0	Comparison Interrupt Condition This field specifies the operational region in which an interrupt is generated when the ADC conversion data is compared against the values of COMPO and COMP1. The COMPO and COMP1 fields are defined in the ADCDCCMPx registers. Value Description 0x0 Low Band ADC Data < COMPO ≤ COMP1 0x1 Mid Band COMPO ≤ ADC Data < COMP1
			0x0 Low Band ADC Data < COMP0 ≤ COMP1 0x1 Mid Band
			0x2 reserved 0x3 High Band COMP0 < COMP1 ≤ ADC Data
CIM	R/W	0x0	Comparison Interrupt Mode This field specifies the mode by which the interrupt comparison is made. Value Description 0x0 Always This mode generates an interrupt every time the ADC conversion data falls within the selected operational region. 0x1 Once This mode generates an interrupt the first time that the ADC conversion data enters the selected operational region. 0x2 Hysteresis Always This mode generates an interrupt when the ADC conversion data falls within the selected operational region and continues to generate the interrupt until the hysteresis condition is cleared by entering the opposite operational region. 0x3 Hysteresis Once This mode generates an interrupt the first time that the ADC conversion data falls within the selected operational region. No

Register 47: ADC Digital Comparator Range 0 (ADCDCCMP0), offset 0xE40 Register 48: ADC Digital Comparator Range 1 (ADCDCCMP1), offset 0xE44 Register 49: ADC Digital Comparator Range 2 (ADCDCCMP2), offset 0xE48 Register 50: ADC Digital Comparator Range 3 (ADCDCCMP3), offset 0xE4C Register 51: ADC Digital Comparator Range 4 (ADCDCCMP4), offset 0xE50 Register 52: ADC Digital Comparator Range 5 (ADCDCCMP5), offset 0xE54 Register 53: ADC Digital Comparator Range 6 (ADCDCCMP6), offset 0xE58 Register 54: ADC Digital Comparator Range 7 (ADCDCCMP7), offset 0xE5C

This register defines the comparison values that are used to determine if the ADC conversion data falls in the appropriate operating region.

Note: The value in the COMP1 field must be greater than or equal to the value in the COMP0 field or unexpected results can occur.

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ADC Digital Comparator Range 0 (ADCDCCMP0)

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ADC0 base: 0x4003.8000

Offset 0xE40

Type R/W, reset 0x0000.0000

30

	reserved					1	'		' '		COI	MP1			1	<u>' </u>
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0
110001	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
[1		rese		···	1	ٔ ا		· 1			MP0			· ·	٦
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0
В	Bit/Field Name		Ту	ре	Reset	Des	cription									
	31:26		reserv	/ed	R	0	0x0	Software should not rely on the value of a reserved bit. To compatibility with future products, the value of a reserved b preserved across a read-modify-write operation.								
	25:16	The result the high-ba Note that tl				Compare 1 The value in this field is compared against the ADC conversion data. The result of the comparison is used to determine if the data lies within the high-band region. Note that the value of COMP1 must be greater than or equal to the value of COMP0.										
	15:10		reser	/ed	R	0	0x0	com	Software should not rely on the value of a reserved bit. To prov compatibility with future products, the value of a reserved bit sh preserved across a read-modify-write operation.							
	9:0		СОМ	P0	R/	W	0x000	The The	Compare 0 The value in this field is compared against the ADC conve The result of the comparison is used to determine if the da the low-band region.							

13 Universal Asynchronous Receivers/Transmitters (UARTs)

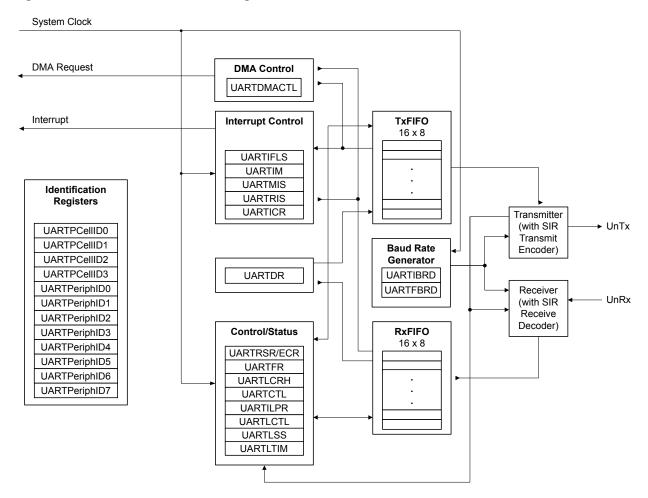
The Stellaris[®] LM3S1J11 controller includes three Universal Asynchronous Receiver/Transmitter (UART) with the following features:

- Programmable baud-rate generator allowing speeds up to 3.125 Mbps for regular speed (divide by 16) and 6.25 Mbps for high speed (divide by 8)
- Separate 16x8 transmit (TX) and receive (RX) FIFOs to reduce CPU interrupt service loading
- Programmable FIFO length, including 1-byte deep operation providing conventional double-buffered interface
- FIFO trigger levels of 1/8, 1/4, 1/2, 3/4, and 7/8
- Standard asynchronous communication bits for start, stop, and parity
- Line-break generation and detection
- Fully programmable serial interface characteristics
 - 5, 6, 7, or 8 data bits
 - Even, odd, stick, or no-parity bit generation/detection
 - 1 or 2 stop bit generation
- IrDA serial-IR (SIR) encoder/decoder providing
 - Programmable use of IrDA Serial Infrared (SIR) or UART input/output
 - Support of IrDA SIR encoder/decoder functions for data rates up to 115.2 Kbps half-duplex
 - Support of normal 3/16 and low-power (1.41-2.23 μs) bit durations
 - Programmable internal clock generator enabling division of reference clock by 1 to 256 for low-power mode bit duration
- Support for communication with ISO 7816 smart cards
- Full modem handshake support (on UART1)
- LIN protocol support
- Standard FIFO-level and End-of-Transmission interrupts
- Efficient transfers using Micro Direct Memory Access Controller (μDMA)
 - Separate channels for transmit and receive
 - Receive single request asserted when data is in the FIFO; burst request asserted at programmed FIFO level

 Transmit single request asserted when there is space in the FIFO; burst request asserted at programmed FIFO level

13.1 Block Diagram

Figure 13-1. UART Module Block Diagram



13.2 Signal Description

The following table lists the external signals of the UART module and describes the function of each. The UART signals are alternate functions for some GPIO signals and default to be GPIO signals at reset, with the exception of the UORX and UOTX pins which default to the UART function. The column in the table below titled "Pin Mux/Pin Assignment" lists the possible GPIO pin placements for these UART signals. The AFSEL bit in the **GPIO Alternate Function Select (GPIOAFSEL)** register (page 412) should be set to choose the UART function. The number in parentheses is the encoding that must be programmed into the PMCn field in the **GPIO Port Control (GPIOPCTL)** register (page 430) to assign the UART signal to the specified GPIO port pin. For more information on configuring GPIOs, see "General-Purpose Input/Outputs (GPIOS)" on page 389.

Table 13-1. UART Signals (100LQFP)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
UORx	26	PA0 (1)	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
UOTx	27	PA1 (1)	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
U1CTS	2 10 34	PE6 (9) PD0 (9) PA6 (9)	I	TTL	UART module 1 Clear To Send modem flow control input signal.
U1DCD	1 11 35	PE7 (9) PD1 (9) PA7 (9)	I	TTL	UART module 1 Data Carrier Detect modem status input signal.
U1DSR	47	PF0 (9)	I	TTL	UART module 1 Data Set Ready modem output control line.
U1DTR	40 100	PG5 (10) PD7 (9)	0	TTL	UART module 1 Data Terminal Ready modem status input signal.
UlRI	37 41 97	PG6 (10) PG4 (10) PD4 (9)	I	TTL	UART module 1 Ring Indicator modem status input signal.
Ulrts	43 61	PF6 (10) PF1 (9)	0	TTL	UART module 1 Request to Send modem flow control output line.
Ulrx	10 12 23 26 66 92	PD0 (5) PD2 (1) PC6 (5) PA0 (9) PB0 (5) PB4 (7)	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
UlTx	11 13 22 27 67 91	PD1 (5) PD3 (1) PC7 (5) PA1 (9) PB1 (5) PB5 (7)	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
U2Rx	10 19 92 98	PD0 (4) PG0 (1) PB4 (4) PD5 (9)	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
U2Tx	6 11 18 99	PE4 (5) PD1 (4) PG1 (1) PD6 (9)	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

Table 13-2. UART Signals (108BGA)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
UORx	L3	PA0 (1)	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
UOTx	M3	PA1 (1)	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
U1CTS	A1 G1 L6	PE6 (9) PD0 (9) PA6 (9)	I	TTL	UART module 1 Clear To Send modem flow control input signal.

Table 13-2. UART Signals (108BGA) (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
U1DCD	B1 G2 M6	PE7 (9) PD1 (9) PA7 (9)	1	TTL	UART module 1 Data Carrier Detect modem status input signal.
U1DSR	M9	PF0 (9)	I	TTL	UART module 1 Data Set Ready modem output control line.
U1DTR	M7 A2	PG5 (10) PD7 (9)	0	TTL	UART module 1 Data Terminal Ready modem status input signal.
UlRI	L7 K3 B5	PG6 (10) PG4 (10) PD4 (9)	I	TTL	UART module 1 Ring Indicator modem status input signal.
U1RTS	M8 H12	PF6 (10) PF1 (9)	0	TTL	UART module 1 Request to Send modem flow control output line.
UlRx	G1 H2 M2 L3 E12 A6	PD0 (5) PD2 (1) PC6 (5) PA0 (9) PB0 (5) PB4 (7)	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
UlTx	G2 H1 L2 M3 D12 B7	PD1 (5) PD3 (1) PC7 (5) PA1 (9) PB1 (5) PB5 (7)	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
U2Rx	G1 K1 A6 C6	PD0 (4) PG0 (1) PB4 (4) PD5 (9)	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
U2Tx	B2 G2 K2 A3	PE4 (5) PD1 (4) PG1 (1) PD6 (9)	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

13.3 Functional Description

Each Stellaris UART performs the functions of parallel-to-serial and serial-to-parallel conversions. It is similar in functionality to a 16C550 UART, but is not register compatible.

The UART is configured for transmit and/or receive via the TXE and RXE bits of the **UART Control** (**UARTCTL**) register (see page 617). Transmit and receive are both enabled out of reset. Before any control registers are programmed, the UART must be disabled by clearing the UARTEN bit in **UARTCTL**. If the UART is disabled during a TX or RX operation, the current transaction is completed prior to the UART stopping.

The UART module also includes a serial IR (SIR) encoder/decoder block that can be connected to an infrared transceiver to implement an IrDA SIR physical layer. The SIR function is programmed using the **UARTCTL** register.

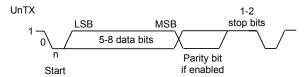
13.3.1 Transmit/Receive Logic

The transmit logic performs parallel-to-serial conversion on the data read from the transmit FIFO. The control logic outputs the serial bit stream beginning with a start bit and followed by the data bits

(LSB first), parity bit, and the stop bits according to the programmed configuration in the control registers. See Figure 13-2 on page 593 for details.

The receive logic performs serial-to-parallel conversion on the received bit stream after a valid start pulse has been detected. Overrun, parity, frame error checking, and line-break detection are also performed, and their status accompanies the data that is written to the receive FIFO.

Figure 13-2. UART Character Frame



13.3.2 Baud-Rate Generation

The baud-rate divisor is a 22-bit number consisting of a 16-bit integer and a 6-bit fractional part. The number formed by these two values is used by the baud-rate generator to determine the bit period. Having a fractional baud-rate divisor allows the UART to generate all the standard baud rates.

The 16-bit integer is loaded through the **UART Integer Baud-Rate Divisor (UARTIBRD)** register (see page 613) and the 6-bit fractional part is loaded with the **UART Fractional Baud-Rate Divisor (UARTFBRD)** register (see page 614). The baud-rate divisor (BRD) has the following relationship to the system clock (where *BRDI* is the integer part of the *BRD* and *BRDF* is the fractional part, separated by a decimal place.)

```
BRD = BRDI + BRDF = UARTSysClk / (ClkDiv * Baud Rate)
```

where <code>UARTSysClk</code> is the system clock connected to the <code>UART</code>, and <code>ClkDiv</code> is either 16 (if <code>HSE</code> in <code>UARTCTL</code> is clear) or 8 (if <code>HSE</code> is set).

The 6-bit fractional number (that is to be loaded into the DIVFRAC bit field in the **UARTFBRD** register) can be calculated by taking the fractional part of the baud-rate divisor, multiplying it by 64, and adding 0.5 to account for rounding errors:

```
UARTFBRD[DIVFRAC] = integer(BRDF * 64 + 0.5)
```

The UART generates an internal baud-rate reference clock at 8x or 16x the baud-rate (referred to as Baud8 and Baud16, depending on the setting of the HSE bit (bit 5) in **UARTCTL**). This reference clock is divided by 8 or 16 to generate the transmit clock, and is used for error detection during receive operations. Note that the state of the HSE bit has no effect on clock generation in ISO 7816 smart card mode (when the SMART bit in the **UARTCTL** register is set).

Along with the **UART Line Control**, **High Byte (UARTLCRH)** register (see page 615), the **UARTIBRD** and **UARTFBRD** registers form an internal 30-bit register. This internal register is only updated when a write operation to **UARTLCRH** is performed, so any changes to the baud-rate divisor must be followed by a write to the **UARTLCRH** register for the changes to take effect.

To update the baud-rate registers, there are four possible sequences:

- UARTIBRD write, UARTFBRD write, and UARTLCRH write
- UARTFBRD write, UARTIBRD write, and UARTLCRH write
- UARTIBRD write and UARTLCRH write

■ UARTFBRD write and UARTLCRH write

13.3.3 Data Transmission

Data received or transmitted is stored in two 16-byte FIFOs, though the receive FIFO has an extra four bits per character for status information. For transmission, data is written into the transmit FIFO. If the UART is enabled, it causes a data frame to start transmitting with the parameters indicated in the **UARTLCRH** register. Data continues to be transmitted until there is no data left in the transmit FIFO. The BUSY bit in the **UART Flag (UARTFR)** register (see page 609) is asserted as soon as data is written to the transmit FIFO (that is, if the FIFO is non-empty) and remains asserted while data is being transmitted. The BUSY bit is negated only when the transmit FIFO is empty, and the last character has been transmitted from the shift register, including the stop bits. The UART can indicate that it is busy even though the UART may no longer be enabled.

When the receiver is idle (the UnRx signal is continuously 1), and the data input goes Low (a start bit has been received), the receive counter begins running and data is sampled on the eighth cycle of Baud16 or fourth cycle of Baud8 depending on the setting of the HSE bit (bit 5) in **UARTCTL** (described in "Transmit/Receive Logic" on page 592).

The start bit is valid and recognized if the <code>UnRx</code> signal is still low on the eighth cycle of <code>Baud16</code> (HSE clear) or the fourth cycle of <code>Baud8</code> (HSE set), otherwise it is ignored. After a valid start bit is detected, successive data bits are sampled on every 16th cycle of <code>Baud16</code> or 8th cycle of <code>Baud8</code> (that is, one bit period later) according to the programmed length of the data characters and value of the <code>HSE</code> bit in <code>UARTCTL</code>. The parity bit is then checked if parity mode is enabled. Data length and parity are defined in the <code>UARTLCRH</code> register.

Lastly, a valid stop bit is confirmed if the UnRx signal is High, otherwise a framing error has occurred. When a full word is received, the data is stored in the receive FIFO along with any error bits associated with that word.

13.3.4 Serial IR (SIR)

The UART peripheral includes an IrDA serial-IR (SIR) encoder/decoder block. The IrDA SIR block provides functionality that converts between an asynchronous UART data stream and a half-duplex serial SIR interface. No analog processing is performed on-chip. The role of the SIR block is to provide a digital encoded output and decoded input to the UART. When enabled, the SIR block uses the UnTx and UnRx pins for the SIR protocol. These signals should be connected to an infrared transceiver to implement an IrDA SIR physical layer link. The SIR block can receive and transmit, but it is only half-duplex so it cannot do both at the same time. Transmission must be stopped before data can be received. The IrDA SIR physical layer specifies a minimum 10-ms delay between transmission and reception. The SIR block has two modes of operation:

- In normal IrDA mode, a zero logic level is transmitted as a high pulse of 3/16th duration of the selected baud rate bit period on the output pin, while logic one levels are transmitted as a static LOW signal. These levels control the driver of an infrared transmitter, sending a pulse of light for each zero. On the reception side, the incoming light pulses energize the photo transistor base of the receiver, pulling its output LOW and driving the UART input pin LOW.
- In low-power IrDA mode, the width of the transmitted infrared pulse is set to three times the period of the internally generated IrLPBaud16 signal (1.63 μs, assuming a nominal 1.8432 MHz frequency) by changing the appropriate bit in the UARTCR register. See page 612 for more information on IrDA low-power pulse-duration configuration.

Figure 13-3 on page 595 shows the UART transmit and receive signals, with and without IrDA modulation.

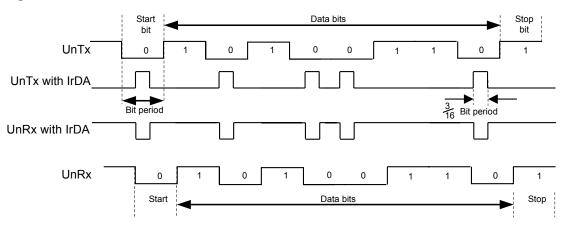


Figure 13-3. IrDA Data Modulation

In both normal and low-power IrDA modes:

- During transmission, the UART data bit is used as the base for encoding
- During reception, the decoded bits are transferred to the UART receive logic

The IrDA SIR physical layer specifies a half-duplex communication link, with a minimum 10-ms delay between transmission and reception. This delay must be generated by software because it is not automatically supported by the UART. The delay is required because the infrared receiver electronics might become biased or even saturated from the optical power coupled from the adjacent transmitter LED. This delay is known as latency or receiver setup time.

13.3.5 ISO 7816 Support

The UART offers basic support to allow communication with an ISO 7816 smartcard. When bit 3 (SMART) of the **UARTCTL** register is set, the UnTx signal is used as a bit clock, and the UnRx signal is used as the half-duplex communication line connected to the smartcard. A GPIO signal can be used to generate the reset signal to the smartcard. The remaining smartcard signals should be provided by the system design. The maximum clock rate in this mode is system clock / 16.

When using ISO 7816 mode, the **UARTLCRH** register must be set to transmit 8-bit words (WLEN bits 6:5 configured to 0x3) with EVEN parity (PEN set and EPS set). In this mode, the UART automatically uses 2 stop bits, and the STP2 bit of the **UARTLCRH** register is ignored.

If a parity error is detected during transmission, UnRx is pulled Low during the second stop bit. In this case, the UART aborts the transmission, flushes the transmit FIFO and discards any data it contains, and raises a parity error interrupt, allowing software to detect the problem and initiate retransmission of the affected data. Note that the UART does not support automatic retransmission in this case.

13.3.6 Modem Handshake Support

This section describes how to configure and use the modem flow control and status signals for UART1 when connected as a DTE (data terminal equipment) or as a DCE (data communications equipment). In general, a modem is a DCE and a computing device that connects to a modem is the DTE.

13.3.6.1 **Signaling**

The status signals provided by UART1 differ based on whether the UART is used as a DTE or DCE. When used as a DTE, the modem flow control and status signals are defined as:

- U1CTS is Clear To Send
- UIDSR is Data Set Ready
- Ū1DCD is Data Carrier Detect
- ŪIRI is Ring Indicator
- UIRTS is Request To Send
- UIDTR is Data Terminal Ready

When used as a DCE, the the modem flow control and status signals are defined as:

- Ū1CTS is Request To Send
- U1DSR is Data Terminal Ready
- UIRTS is Clear To Send
- ŪIDTR is Data Set Ready

Note that the support for DCE functions Data Carrier Detect and Ring Indicator are not provided. If these signals are required, their function can be emulated by using a general-purpose I/O signal and providing software support.

13.3.6.2 Flow Control

Flow control can be accomplished by either hardware or software. The following sections describe the different methods.

Hardware Flow Control (RTS/CTS)

Hardware flow control between two devices is accomplished by connecting the $\overline{\mathtt{U1RTS}}$ output to the Clear-To-Send input on the receiving device, and connecting the Request-To-Send output on the receiving device to the $\overline{\mathtt{U1CTS}}$ input.

The $\overline{\mathtt{U1CTS}}$ input controls the transmitter. The transmitter may only transmit data when the $\overline{\mathtt{U1CTS}}$ input is asserted. The $\overline{\mathtt{U1RTS}}$ output signal indicates the state of the receive FIFO. $\overline{\mathtt{U1CTS}}$ remains asserted until the preprogrammed watermark level is reached, indicating that the Receive FIFO has no space to store additional characters.

The **UARTCTL** register bits 15 (CTSEN) and 14 (RTSEN) specify the flow control mode as shown in Table 13-3 on page 596.

Table 13-3. Flow Control Mode

CTSEN	RTSEN	Description
1	1	RTS and CTS flow control enabled
1	0	Only CTS flow control enabled
0	1	Only RTS flow control enabled

Table 13-3. Flow Control Mode (continued)

CTSEN	RTSEN	Description
0	0	Both RTS and CTS flow control disabled

Note that when RTSEN is 1, software cannot modify the $\overline{\mathtt{UIRTS}}$ output value through the **UARTCTL** register Request to Send (RTS) bit, and the status of the RTS bit should be ignored.

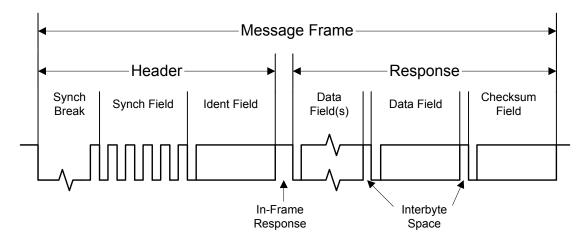
Software Flow Control (Modem Status Interrupts)

Software flow control between two devices is accomplished by using interrupts to indicate the status of the UART. Interrupts may be generated for the $\overline{\mathtt{UIDSR}}$, $\overline{\mathtt{UIDCD}}$, $\overline{\mathtt{UICTS}}$, and $\overline{\mathtt{UIRI}}$ signals using bits 3:0 of the **UARTIM** register, respectively. The raw and masked interrupt status may be checked using the **UARTRIS** and **UARTMIS** register. These interrupts may be cleared using the **UARTICR** register.

13.3.7 LIN Support

The UART module offers hardware support for the LIN protocol as either a master or a slave. The LIN mode is enabled by setting the LIN bit in the **UARTCTL** register. A LIN message is identified by the use of a Sync Break at the beginning of the message. The Sync Break is a transmission of a series of 0s. The Sync Break is followed by the Sync data field (0x55). Figure 13-4 on page 597 illustrates the structure of a LIN message.

Figure 13-4. LIN Message



The UART should be configured as followed to operate in LIN mode:

- 1. Configure the UART for 1 start bit, 8 data bits, no parity, and 1 stop bit. Enable the Transmit FIFO.
- 2. Set the LIN bit in the **UARTCTL** register.

When preparing to send a LIN message, the TXFIFO should contain the Sync data (0x55) at FIFO location 0 and the Identifier data at location 1, followed by the data to be transmitted, and with the checksum in the final FIFO entry.

13.3.7.1 LIN Master

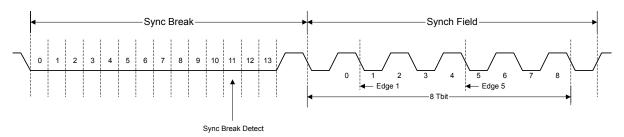
The UART is enabled to be the LIN master by setting the MASTER bit in the **UARTLCTL** register. The length of the Sync Break is programmable using the BLEN field in the **UARTLCTL** register and can be 13-16 bits (baud clock cycles).

13.3.7.2 LIN Slave

The LIN UART slave is required to adjust its baud rate to that of the LIN master. In slave mode, the LIN UART recognizes the Sync Break, which must be at least 13 bits in duration. A timer is provided to capture timing data on the 1st and 5th falling edges of the Sync field so that the baud rate can be adjusted to match the master.

After detecting a Sync Break, the UART waits for the synchronization field. The first falling edge generates an interrupt using the LME1RIS bit in the **UARTRIS** register, and the timer value is captured and stored in the **UARTLSS** register (T1). On the fifth falling edge, a second interrupt is generated using the LME5RIS bit in the **UARTRIS** register, and the timer value is captured again (T2). The actual baud rate can be calculated using (T2-T1)/8, and the local baud rate should be adjusted as needed. Figure 13-5 on page 598 illustrates the synchronization field.

Figure 13-5. LIN Synchronization Field



13.3.8 FIFO Operation

The UART has two 16x8 FIFOs; one for transmit and one for receive. Both FIFOs are accessed via the **UART Data (UARTDR)** register (see page 604). Read operations of the **UARTDR** register return a 12-bit value consisting of 8 data bits and 4 error flags while write operations place 8-bit data in the transmit FIFO.

Out of reset, both FIFOs are disabled and act as 1-byte-deep holding registers. The FIFOs are enabled by setting the FEN bit in **UARTLCRH** (page 615).

FIFO status can be monitored via the **UART Flag (UARTFR)** register (see page 609) and the **UART Receive Status (UARTRSR)** register. Hardware monitors empty, full and overrun conditions. The **UARTFR** register contains empty and full flags (TXFE, TXFF, RXFE, and RXFF bits), and the **UARTRSR** register shows overrun status via the OE bit. If the FIFOs are disabled, the empty and full flags are set according to the status of the 1-byte-deep holding registers.

The trigger points at which the FIFOs generate interrupts is controlled via the **UART Interrupt FIFO Level Select (UARTIFLS)** register (see page 621). Both FIFOs can be individually configured to trigger interrupts at different levels. Available configurations include ½, ¼, ½, ¾, and ⅙. For example, if the ¼ option is selected for the receive FIFO, the UART generates a receive interrupt after 4 data bytes are received. Out of reset, both FIFOs are configured to trigger an interrupt at the ½ mark.

13.3.9 Interrupts

The UART can generate interrupts when the following conditions are observed:

- Overrun Error
- Break Error
- Parity Error
- Framing Error
- Receive Timeout
- Transmit (when condition defined in the TXIFLSEL bit in the **UARTIFLS** register is met, or if the EOT bit in **UARTCTL** is set, when the last bit of all transmitted data leaves the serializer)
- Receive (when condition defined in the RXIFLSEL bit in the **UARTIFLS** register is met)

All of the interrupt events are ORed together before being sent to the interrupt controller, so the UART can only generate a single interrupt request to the controller at any given time. Software can service multiple interrupt events in a single interrupt service routine by reading the **UART Masked Interrupt Status (UARTMIS)** register (see page 631).

The interrupt events that can trigger a controller-level interrupt are defined in the **UART Interrupt Mask (UARTIM)** register (see page 623) by setting the corresponding IM bits. If interrupts are not used, the raw interrupt status is always visible via the **UART Raw Interrupt Status (UARTRIS)** register (see page 627).

Interrupts are always cleared (for both the **UARTMIS** and **UARTRIS** registers) by writing a 1 to the corresponding bit in the **UART Interrupt Clear (UARTICR)** register (see page 635).

The receive timeout interrupt is asserted when the receive FIFO is not empty, and no further data is received over a 32-bit period. The receive timeout interrupt is cleared either when the FIFO becomes empty through reading all the data (or by reading the holding register), or when a 1 is written to the corresponding bit in the **UARTICR** register.

The receive interrupt changes state when one of the following events occurs:

- If the FIFOs are enabled and the receive FIFO reaches the programmed trigger level, the RXRIS bit is set. The receive interrupt is cleared by reading data from the receive FIFO until it becomes less than the trigger level, or by clearing the interrupt by writing a 1 to the RXIC bit.
- If the FIFOs are disabled (have a depth of one location) and data is received thereby filling the location, the RXRIS bit is set. The receive interrupt is cleared by performing a single read of the receive FIFO, or by clearing the interrupt by writing a 1 to the RXIC bit.

The transmit interrupt changes state when one of the following events occurs:

- If the FIFOs are enabled and the transmit FIFO reaches the programmed trigger level, the TXRIS bit is set. The transmit interrupt is cleared by writing data to the transmit FIFO until it becomes greater than the trigger level, or by clearing the interrupt by writing a 1 to the TXIC bit.
- If the FIFOs are disabled (have a depth of one location) and there is no data present in the transmitters single location, the TXRIS bit is set. It is cleared by performing a single write to the transmit FIFO, or by clearing the interrupt by writing a 1 to the TXIC bit.

13.3.10 Loopback Operation

The UART can be placed into an internal loopback mode for diagnostic or debug work by setting the LBE bit in the **UARTCTL** register (see page 617). In loopback mode, data transmitted on the \mathtt{UnTx} output is received on the \mathtt{UnRx} input. Note that the LBE bit should be set before the UART is enabled.

13.3.11 DMA Operation

The UART provides an interface to the μ DMA controller with separate channels for transmit and receive. The DMA operation of the UART is enabled through the **UART DMA Control** (**UARTDMACTL**) register. When DMA operation is enabled, the UART asserts a DMA request on the receive or transmit channel when the associated FIFO can transfer data. For the receive channel, a single transfer request is asserted whenever any data is in the receive FIFO. A burst transfer request is asserted whenever the amount of data in the receive FIFO is at or above the FIFO trigger level configured in the **UARTIFLS** register. For the transmit channel, a single transfer request is asserted whenever there is at least one empty location in the transmit FIFO. The burst request is asserted whenever the transmit FIFO contains fewer characters than the FIFO trigger level. The single and burst DMA transfer requests are handled automatically by the μ DMA controller depending on how the DMA channel is configured.

To enable DMA operation for the receive channel, set the RXDMAE bit of the **DMA Control** (**UARTDMACTL**) register. To enable DMA operation for the transmit channel, set the TXDMAE bit of the **UARTDMACTL** register. The UART can also be configured to stop using DMA for the receive channel if a receive error occurs. If the DMAERR bit of the **UARTDMACR** register is set and a receive error occurs, the DMA receive requests are automatically disabled. This error condition can be cleared by clearing the appropriate UART error interrupt.

If DMA is enabled, then the μ DMA controller triggers an interrupt when a transfer is complete. The interrupt occurs on the UART interrupt vector. Therefore, if interrupts are used for UART operation and DMA is enabled, the UART interrupt handler must be designed to handle the μ DMA completion interrupt.

See "Micro Direct Memory Access (μ DMA)" on page 331 for more details about programming the μ DMA controller.

13.4 Initialization and Configuration

To enable and initialize the UART, the following steps are necessary:

- The peripheral clock must be enabled by setting the UARTO, UART1, or UART2 bits in the RCGC1 register (see page 246).
- 2. The clock to the appropriate GPIO module must be enabled via the RCGC2 register in the System Control module (see page 255).
- 3. Set the GPIO AFSEL bits for the appropriate pins (see page 412). To determine which GPIOs to configure, see Table 18-4 on page 762.
- **4.** Configure the GPIO current level and/or slew rate as specified for the mode selected (see page 414 and page 422).
- **5.** Configure the PMCn fields in the **GPIOPCTL** register to assign the UART signals to the appropriate pins (see page 430 and Table 18-5 on page 767).

To use the UART, the peripheral clock must be enabled by setting the appropriate bit in the **RCGC1** register (page 246). In addition, the clock to the appropriate GPIO module must be enabled via the **RCGC2** register (page 255) in the System Control module. To find out which GPIO port to enable, refer to Table 18-5 on page 767.

This section discusses the steps that are required to use a UART module. For this example, the UART clock is assumed to be 20 MHz, and the desired UART configuration is:

- 115200 baud rate
- Data length of 8 bits
- One stop bit
- No parity
- FIFOs disabled
- No interrupts

The first thing to consider when programming the UART is the baud-rate divisor (BRD), because the **UARTIBRD** and **UARTFBRD** registers must be written before the **UARTLCRH** register. Using the equation described in "Baud-Rate Generation" on page 593, the BRD can be calculated:

```
BRD = 20,000,000 / (16 * 115,200) = 10.8507
```

which means that the DIVINT field of the **UARTIBRD** register (see page 613) should be set to 10 decimal or 0xA. The value to be loaded into the **UARTFBRD** register (see page 614) is calculated by the equation:

```
UARTFBRD[DIVFRAC] = integer(0.8507 * 64 + 0.5) = 54
```

With the BRD values in hand, the UART configuration is written to the module in the following order:

- 1. Disable the UART by clearing the UARTEN bit in the **UARTCTL** register.
- 2. Write the integer portion of the BRD to the **UARTIBRD** register.
- **3.** Write the fractional portion of the BRD to the **UARTFBRD** register.
- **4.** Write the desired serial parameters to the **UARTLCRH** register (in this case, a value of 0x0000.0060).
- **5.** Optionally, configure the μDMA channel (see "Micro Direct Memory Access (μDMA)" on page 331) and enable the DMA option(s) in the **UARTDMACTL** register.
- **6.** Enable the UART by setting the UARTEN bit in the **UARTCTL** register.

13.5 Register Map

Table 13-4 on page 602 lists the UART registers. The offset listed is a hexadecimal increment to the register's address, relative to that UART's base address:

UART0: 0x4000.C000UART1: 0x4000.D000UART2: 0x4000.E000

Note that the UART module clock must be enabled before the registers can be programmed (see page 246). There must be a delay of 3 system clocks after the UART module clock is enabled before any UART module registers are accessed.

Note: The UART must be disabled (see the UARTEN bit in the **UARTCTL** register on page 617) before any of the control registers are reprogrammed. When the UART is disabled during a TX or RX operation, the current transaction is completed prior to the UART stopping.

Table 13-4. UART Register Map

0x000 0x004	UARTDR UARTRSR/UARTECR	R/W	0x0000.0000		
0x004	UARTRSR/UARTECR		0,0000.0000	UART Data	604
		R/W	0x0000.0000	UART Receive Status/Error Clear	606
0x018	UARTFR	RO	0x0000.0090	UART Flag	609
0x020	UARTILPR	R/W	0x0000.0000	UART IrDA Low-Power Register	612
0x024	UARTIBRD	R/W	0x0000.0000	UART Integer Baud-Rate Divisor	613
0x028	UARTFBRD	R/W	0x0000.0000	UART Fractional Baud-Rate Divisor	614
0x02C	UARTLCRH	R/W	0x0000.0000	UART Line Control	615
0x030	UARTCTL	R/W	0x0000.0300	UART Control	617
0x034	UARTIFLS	R/W	0x0000.0012	UART Interrupt FIFO Level Select	621
0x038	UARTIM	R/W	0x0000.0000	UART Interrupt Mask	623
0x03C	UARTRIS	RO	0x0000.0000	UART Raw Interrupt Status	627
0x040	UARTMIS	RO	0x0000.0000	UART Masked Interrupt Status	631
0x044	UARTICR	W1C	0x0000.0000	UART Interrupt Clear	635
0x048	UARTDMACTL	R/W	0x0000.0000	UART DMA Control	637
0x090	UARTLCTL	R/W	0x0000.0000	UART LIN Control	638
0x094	UARTLSS	RO	0x0000.0000	UART LIN Snap Shot	639
0x098	UARTLTIM	RO	0x0000.0000	UART LIN Timer	640
0xFD0	UARTPeriphID4	RO	0x0000.0000	UART Peripheral Identification 4	641
0xFD4	UARTPeriphID5	RO	0x0000.0000	UART Peripheral Identification 5	642
0xFD8	UARTPeriphID6	RO	0x0000.0000	UART Peripheral Identification 6	643
0xFDC	UARTPeriphID7	RO	0x0000.0000	UART Peripheral Identification 7	644
0xFE0	UARTPeriphID0	RO	0x0000.0060	UART Peripheral Identification 0	645
0xFE4	UARTPeriphID1	RO	0x0000.0000	UART Peripheral Identification 1	646
0xFE8	UARTPeriphID2	RO	0x0000.0018	UART Peripheral Identification 2	647
0xFEC	UARTPeriphID3	RO	0x0000.0001	UART Peripheral Identification 3	648
0xFF0	UARTPCellID0	RO	0x0000.000D	UART PrimeCell Identification 0	649
0xFF4	UARTPCellID1	RO	0x0000.00F0	UART PrimeCell Identification 1	650

Table 13-4. UART Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0xFF8	UARTPCellID2	RO	0x0000.0005	UART PrimeCell Identification 2	651
0xFFC	UARTPCellID3	RO	0x0000.00B1	UART PrimeCell Identification 3	652

13.6 Register Descriptions

The remainder of this section lists and describes the UART registers, in numerical order by address offset.

Register 1: UART Data (UARTDR), offset 0x000

Important: This register is read-sensitive. See the register description for details.

This register is the data register (the interface to the FIFOs).

For transmitted data, if the FIFO is enabled, data written to this location is pushed onto the transmit FIFO. If the FIFO is disabled, data is stored in the transmitter holding register (the bottom word of the transmit FIFO). A write to this register initiates a transmission from the UART.

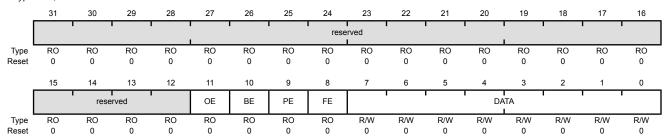
For received data, if the FIFO is enabled, the data byte and the 4-bit status (break, frame, parity, and overrun) is pushed onto the 12-bit wide receive FIFO. If the FIFO is disabled, the data byte and status are stored in the receiving holding register (the bottom word of the receive FIFO). The received data can be retrieved by reading this register.

UART Data (UARTDR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x000

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:12	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
11	OE	RO	0	UART Overrun Error
				Value Description
				New data was received when the FIFO was full, resulting in data loss.
				0 No data has been lost due to a FIFO overrun.
10	BE	RO	0	UART Break Error

Value Description

- A break condition has been detected, indicating that the receive data input was held Low for longer than a full-word transmission time (defined as start, data, parity, and stop bits).
- 0 No break condition has occurred

In FIFO mode, this error is associated with the character at the top of the FIFO. When a break occurs, only one 0 character is loaded into the FIFO. The next character is only enabled after the received data input goes to a 1 (marking state), and the next valid start bit is received.

D://E: 11		_	Б	
Bit/Field	Name	Type	Reset	Description
9	PE	RO	0	UART Parity Error
				Value Description
				The parity of the received data character does not match the parity defined by bits 2 and 7 of the UARTLCRH register.
				0 No parity error has occurred
				In FIFO mode, this error is associated with the character at the top of the FIFO.
8	FE	RO	0	UART Framing Error
				Value Description
				1 The received character does not have a valid stop bit (a valid stop bit is 1).
				0 No framing error has occurred
7:0	DATA	R/W	0x00	Data Transmitted or Received Data that is to be transmitted via the UART is written to this field. When read, this field contains the data that was received by the UART.

Register 2: UART Receive Status/Error Clear (UARTRSR/UARTECR), offset 0x004

The **UARTRSR/UARTECR** register is the receive status register/error clear register.

In addition to the **UARTDR** register, receive status can also be read from the **UARTRSR** register. If the status is read from this register, then the status information corresponds to the entry read from **UARTDR** prior to reading **UARTRSR**. The status information for overrun is set immediately when an overrun condition occurs.

The **UARTRSR** register cannot be written.

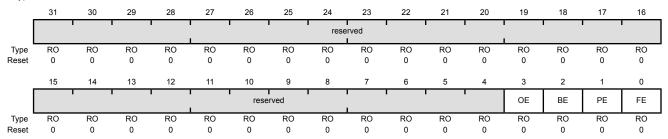
A write of any value to the **UARTECR** register clears the framing, parity, break, and overrun errors. All the bits are cleared on reset.

Read-Only Status Register

UART Receive Status/Error Clear (UARTRSR/UARTECR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x004





Bit/Field	Name	Type	Reset	Description
31:4	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	OE	RO	0	UART Overrun Error

Value Description

- New data was received when the FIFO was full, resulting in data loss.
- 0 No data has been lost due to a FIFO overrun.

This bit is cleared by a write to **UARTECR**.

The FIFO contents remain valid because no further data is written when the FIFO is full, only the contents of the shift register are overwritten. The CPU must read the data in order to empty the FIFO.

Bit/Field	Name	Туре	Reset	Description
2	BE	RO	0	UART Break Error
				Value Description
				A break condition has been detected, indicating that the receive data input was held Low for longer than a full-word transmission time (defined as start, data, parity, and stop bits).
				0 No break condition has occurred
				This bit is cleared to 0 by a write to UARTECR .
				In FIFO mode, this error is associated with the character at the top of the FIFO. When a break occurs, only one 0 character is loaded into the FIFO. The next character is only enabled after the receive data input goes to a 1 (marking state) and the next valid start bit is received.
1	PE	RO	0	UART Parity Error
				Value Description
				The parity of the received data character does not match the parity defined by bits 2 and 7 of the UARTLCRH register.
				0 No parity error has occurred
				This bit is cleared to 0 by a write to UARTECR .
0	FE	RO	0	UART Framing Error
				Value Description
				1 The received character does not have a valid stop bit (a valid stop bit is 1).
				0 No framing error has occurred

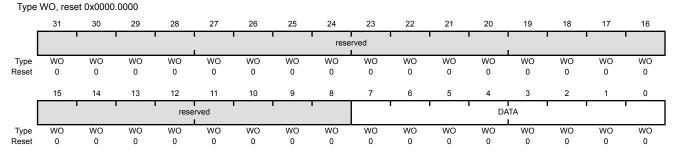
This bit is cleared to 0 by a write to **UARTECR**.

In FIFO mode, this error is associated with the character at the top of the FIFO.

Write-Only Error Clear Register

UART Receive Status/Error Clear (UARTRSR/UARTECR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x004



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	WO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DATA	WO	0x00	Error Clear A write to this register of any data clears the framing, parity, break, and overrun flags.

Register 3: UART Flag (UARTFR), offset 0x018

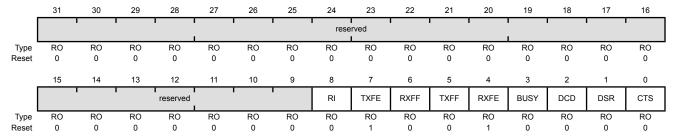
The **UARTFR** register is the flag register. After reset, the TXFF, RXFF, and BUSY bits are 0, and TXFE and RXFE bits are 1. The RI, DCD, DSR and CTS bits indicate the modem flow control and status. Note that the modem bits are only implemented on UART1 and are reserved on UART0 and UART2.

UART Flag (UARTFR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x018

Type RO, reset 0x0000.0090



Bit/Field	Name	Type	Reset	Description
31:9	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	RI	RO	0	Ring Indicator
				Value Description
				1 The U1RI signal is asserted.
				0 The ulri signal is not asserted.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
7	TXFE	RO	1	UART Transmit FIFO Empty
				The meaning of this bit depends on the state of the ${\tt FEN}$ bit in the

Value Description

UARTLCRH register.

- 1 If the FIFO is disabled (FEN is 0), the transmit holding register is empty.
 - If the FIFO is enabled (FEN is 1), the transmit FIFO is empty.
- 0 The transmitter has data to transmit.

Bit/Field	Name	Туре	Reset	Description
6	RXFF	RO	0	UART Receive FIFO Full The meaning of this bit depends on the state of the FEN bit in the UARTLCRH register.
				Value Description
				1 If the FIFO is disabled (FEN is 0), the receive holding register is full.
				If the FIFO is enabled (FEN is 1), the receive FIFO is full.
				0 The receiver can receive data.
5	TXFF	RO	0	UART Transmit FIFO Full
				The meaning of this bit depends on the state of the FEN bit in the UARTLCRH register.
				Value Description
				1 If the FIFO is disabled (FEN is 0), the transmit holding register is full.
				If the FIFO is enabled (FEN is 1), the transmit FIFO is full.
				0 The transmitter is not full.
4	RXFE	RO	1	UART Receive FIFO Empty
				The meaning of this bit depends on the state of the ${\tt FEN}$ bit in the ${\tt UARTLCRH}$ register.
				Value Description
				1 If the FIFO is disabled (FEN is 0), the receive holding register is empty.
				If the FIFO is enabled ($\ensuremath{\mathtt{FEN}}$ is 1), the receive FIFO is empty.
				0 The receiver is not empty.
3	BUSY	RO	0	UART Busy
				Value Description
				The UART is busy transmitting data. This bit remains set until the complete byte, including all stop bits, has been sent from the shift register.
				0 The UART is not busy.
				This bit is set as soon as the transmit FIFO becomes non-empty (regardless of whether UART is enabled).
2	DCD	RO	0	Data Carrier Detect
				Value Description
				1 The U1DCD signal is asserted.
				0 The U1DCD signal is not asserted.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.

Bit/Field	Name	Туре	Reset	Description
1	DSR	RO	0	Data Set Ready
				Value Description
				1 The U1DSR signal is asserted.
				0 The uldsr signal is not asserted.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
0	CTS	RO	0	Clear To Send
				Value Description
				1 The ulcts signal is asserted.
				0 The ulcts signal is not asserted.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.

Register 4: UART IrDA Low-Power Register (UARTILPR), offset 0x020

The **UARTILPR** register stores the 8-bit low-power counter divisor value used to derive the low-power SIR pulse width clock by dividing down the system clock (SysClk). All the bits are cleared when reset.

The internal IrlPBaud16 clock is generated by dividing down SysClk according to the low-power divisor value written to **UARTILPR**. The duration of SIR pulses generated when low-power mode is enabled is three times the period of the IrlPBaud16 clock. The low-power divisor value is calculated as follows:

 $ILPDVSR = SysClk / F_{IrLPBaud16}$

where F_{IrlPBaud16} is nominally 1.8432 MHz.

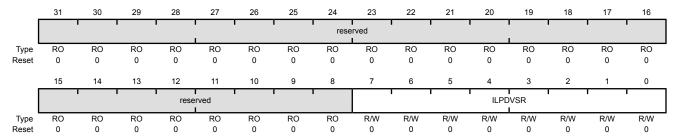
The divisor must be programmed such that 1.42 MHz < $F_{\tt IrlPBaud16}$ < 2.12 MHz, resulting in a low-power pulse duration of 1.41–2.11 μs (three times the period of $\tt IrlPBaud16$). The minimum frequency of $\tt IrlPBaud16$ ensures that pulses less than one period of $\tt IrlPBaud16$ are rejected, but pulses greater than 1.4 μs are accepted as valid pulses.

Note: Zero is an illegal value. Programming a zero value results in no IrlPBaud16 pulses being generated.

UART IrDA Low-Power Register (UARTILPR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x020

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	ILPDVSR	R/W	0x00	IrDA Low-Power Divisor
				This field contains the 8-bit low-power divisor value.

Register 5: UART Integer Baud-Rate Divisor (UARTIBRD), offset 0x024

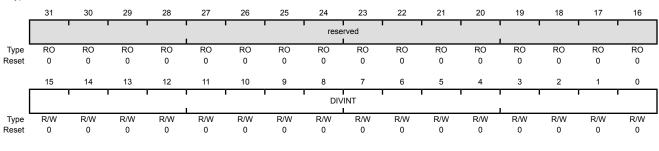
The **UARTIBRD** register is the integer part of the baud-rate divisor value. All the bits are cleared on reset. The minimum possible divide ratio is 1 (when **UARTIBRD**=0), in which case the **UARTFBRD** register is ignored. When changing the **UARTIBRD** register, the new value does not take effect until transmission/reception of the current character is complete. Any changes to the baud-rate divisor must be followed by a write to the **UARTLCRH** register. See "Baud-Rate Generation" on page 593 for configuration details.

UART Integer Baud-Rate Divisor (UARTIBRD)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x024

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:16	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:0	DIVINT	R/W	0x0000	Integer Baud-Rate Divisor

Register 6: UART Fractional Baud-Rate Divisor (UARTFBRD), offset 0x028

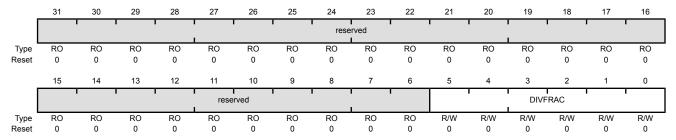
The **UARTFBRD** register is the fractional part of the baud-rate divisor value. All the bits are cleared on reset. When changing the **UARTFBRD** register, the new value does not take effect until transmission/reception of the current character is complete. Any changes to the baud-rate divisor must be followed by a write to the **UARTLCRH** register. See "Baud-Rate Generation" on page 593 for configuration details.

UART Fractional Baud-Rate Divisor (UARTFBRD)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x028

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:6	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5:0	DIVFRAC	R/W	0x0	Fractional Baud-Rate Divisor

Register 7: UART Line Control (UARTLCRH), offset 0x02C

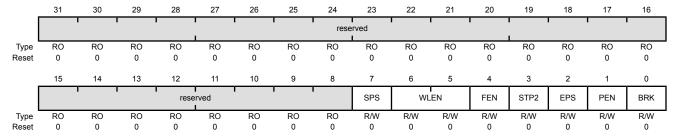
The **UARTLCRH** register is the line control register. Serial parameters such as data length, parity, and stop bit selection are implemented in this register.

When updating the baud-rate divisor (**UARTIBRD** and/or **UARTIFRD**), the **UARTLCRH** register must also be written. The write strobe for the baud-rate divisor registers is tied to the **UARTLCRH** register.

UART Line Control (UARTLCRH)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x02C

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	SPS	R/W	0	UART Stick Parity Select
				When bits 1, 2, and 7 of UARTLCRH are set, the parity bit is transmitted and checked as a 0. When bits 1 and 7 are set and 2 is cleared, the parity bit is transmitted and checked as a 1.
				When this bit is cleared, stick parity is disabled.
6:5	WLEN	R/W	0x0	UART Word Length
				The bits indicate the number of data bits transmitted or received in a frame as follows:
				Value Description
				0x0 5 bits (default)
				0x1 6 bits
				0x2 7 bits
				0x3 8 bits
4	FEN	R/W	0	UART Enable FIFOs
				Value Description

Value Description

- 1 The transmit and receive FIFO buffers are enabled (FIFO mode).
- The FIFOs are disabled (Character mode). The FIFOs become
 1-byte-deep holding registers.

Bit/Field	Name	Туре	Reset	Description
3	STP2	R/W	0	UART Two Stop Bits Select
				Value Description
				Two stop bits are transmitted at the end of a frame. The receive logic does not check for two stop bits being received.
				When in 7816 smartcard mode (the SMART bit is set in the UARTCTL register), the number of stop bits is forced to 2.
				One stop bit is transmitted at the end of a frame.
2	EPS	R/W	0	UART Even Parity Select
				Value Description
				Even parity generation and checking is performed during transmission and reception, which checks for an even number of 1s in data and parity bits.
				Odd parity is performed, which checks for an odd number of 1s.
				This bit has no effect when parity is disabled by the \mathtt{PEN} bit.
1	PEN	R/W	0	UART Parity Enable
				Value Description
				1 Parity checking and generation is enabled.
				O Parity is disabled and no parity bit is added to the data frame.
0	BRK	R/W	0	UART Send Break
				Value Description
				A Low level is continually output on the UnTx signal, after completing transmission of the current character. For the proper execution of the break command, software must set this bit for at least two frames (character periods).
				0 Normal use.

Register 8: UART Control (UARTCTL), offset 0x030

The **UARTCTL** register is the control register. All the bits are cleared on reset except for the Transmit Enable (TXE) and Receive Enable (RXE) bits, which are set.

To enable the UART module, the UARTEN bit must be set. If software requires a configuration change in the module, the UARTEN bit must be cleared before the configuration changes are written. If the UART is disabled during a transmit or receive operation, the current transaction is completed prior to the UART stopping.

Note that bits [15:14,11:10] are only implemented on UART1. These bits are reserved on UART0 and UART2.

Note: The **UARTCTL** register should not be changed while the UART is enabled or else the results are unpredictable. The following sequence is recommended for making changes to the **UARTCTL** register.

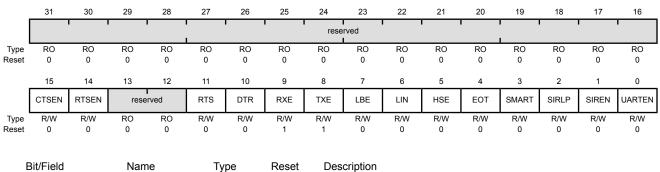
- 1. Disable the UART.
- 2. Wait for the end of transmission or reception of the current character.
- 3. Flush the transmit FIFO by clearing bit 4 (FEN) in the line control register (**UARTLCRH**).
- 4. Reprogram the control register.
- Enable the UART.

UART Control (UARTCTL)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x030

Type R/W, reset 0x0000.0300



31:16 reserved RO 0x0000

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
15	CTSEN	R/W	0	Enable Clear To Send
				Value Description
				1 CTS hardware flow control is enabled. Data is only transmitted when the U1CTS signal is asserted.
				0 CTS hardware flow control is disabled.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
14	RTSEN	R/W	0	Enable Request to Send
				Value Description
				1 RTS hardware flow control is enabled. Data is only requested (by asserting Ulrts) when the receive FIFO has available entries.
				0 RTS hardware flow control is disabled.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
13:12	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
11	RTS	R/W	0	Request to Send
				When RTSEN is clear, the status of this bit is reflected on the U1RTS signal. If RTSEN is set, this bit is ignored on a write and should be ignored on read.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
10	DTR	R/W	0	Data Terminal Ready
				This bit sets the state of the Uldtr output.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
9	RXE	R/W	1	UART Receive Enable
				Value Description
				1 The receive section of the UART is enabled.
				The receive section of the UART is disabled.
				If the UART is disabled in the middle of a receive, it completes the current character before stopping.
				Note: To enable reception, the UARTEN bit must also be set.

Bit/Field	Name	Туре	Reset	Description
8	TXE	R/W	1	UART Transmit Enable
				Value Description
				1 The transmit section of the UART is enabled.
				0 The transmit section of the UART is disabled.
				If the UART is disabled in the middle of a transmission, it completes the current character before stopping.
				Note: To enable transmission, the <code>UARTEN</code> bit must also be set.
7	LBE	R/W	0	UART Loop Back Enable
				Value Description
				1 The UnTx path is fed through the UnRx path.
				0 Normal operation.
6	LIN	R/W	0	LIN Mode Enable
				Value Description
				1 The UART operates in LIN mode.
				0 Normal operation.
5	HSE	R/W	0	High-Speed Enable
				Value Description
				0 The UART is clocked using the system clock divided by 16.
				1 The UART is clocked using the system clock divided by 8.
				Note: System clock used is also dependent on the baud-rate divisor configuration (see page 613) and page 614).
				The state of this bit has no effect on clock generation in ISO 7816 smart card mode (the SMART bit is set).
4	EOT	R/W	0	End of Transmission
				This bit determines the behavior of the ${\tt TXRIS}$ bit in the $\textbf{UARTRIS}$ register.
				Value Description
				1 The TXRIS bit is set only after all transmitted data, including stop bits, have cleared the serializer.
				The TXRIS bit is set when the transmit FIFO condition specified

in **UARTIFLS** is met.

Bit/Field	Name	Туре	Reset	Description
3	SMART	R/W	0	ISO 7816 Smart Card Support
				Value Description 1 The UART operates in Smart Card mode. 0 Normal operation. The application must ensure that it sets 8-bit word length (WLEN set to 0x3) and even parity (PEN set to 1, EPS set to 1, SPS set to 0) in UARTLCRH when using ISO 7816 mode. In this mode, the value of the STP2 bit in UARTLCRH is ignored and the number of stop bits is forced to 2. Note that the UART does not support automatic retransmission on parity errors. If a parity error is detected on transmission, all further transmit operations are aborted and software must handle retransmission of the affected byte or
2	SIRLP	R/W	0	 WART SIR Low-Power Mode This bit selects the IrDA encoding mode. Value Description The UART operates in SIR Low-Power mode. Low-level bits are transmitted with a pulse width which is 3 times the period of the IrLPBaud16 input signal, regardless of the selected bit rate. Low-level bits are transmitted as an active High pulse with a width of 3/16th of the bit period.
				Setting this bit uses less power, but might reduce transmission distances. See page 612 for more information.
1	SIREN	R/W	0	UART SIR Enable
				 Value Description The IrDA SIR block is enabled, and the UART will transmit and receive data using SIR protocol. Normal operation.
0	UARTEN	R/W	0	UART Enable Value Description 1 The UART is enabled. 0 The UART is disabled.

If the UART is disabled in the middle of transmission or reception, it completes the current character before stopping.

Register 9: UART Interrupt FIFO Level Select (UARTIFLS), offset 0x034

The **UARTIFLS** register is the interrupt FIFO level select register. You can use this register to define the FIFO level at which the TXRIS and RXRIS bits in the **UARTRIS** register are triggered.

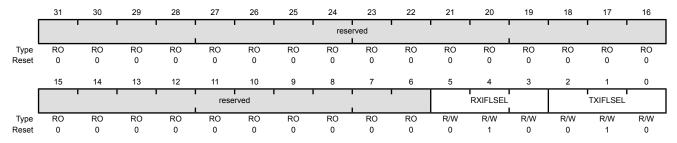
The interrupts are generated based on a transition through a level rather than being based on the level. That is, the interrupts are generated when the fill level progresses through the trigger level. For example, if the receive trigger level is set to the half-way mark, the interrupt is triggered as the module is receiving the 9th character.

Out of reset, the TXIFLSEL and RXIFLSEL bits are configured so that the FIFOs trigger an interrupt at the half-way mark.

UART Interrupt FIFO Level Select (UARTIFLS)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x034

Type R/W, reset 0x0000.0012



Bit/Field	Name	Туре	Reset	Description
31:6	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5:3	RXIFLSEL	R/W	0x2	UART Receive Interrupt FIFO Level Select

The trigger points for the receive interrupt are as follows:

Value	Description
0x0	RX FIFO ≥ 1/8 full
0x1	RX FIFO ≥ ¼ full
0x2	RX FIFO ≥ ½ full (default)
0x3	RX FIFO ≥ ¾ full
0x4	RX FIFO ≥ 7/8 full
0x5-0x7	Reserved

Bit/Field	Name	Type	Reset	Description
2:0	TXIFLSEL	R/W	0x2	UART Transmit Interrupt FIFO Level Select The trigger points for the transmit interrupt are as follows:
				Value Description
				0x0 TX FIFO ≤ ½ empty
				0x1 TX FIFO ≤ ¾ empty
				0x2 TX FIFO ≤ ½ empty (default)
				0x3 TX FIFO ≤ 1/4 empty
				0x4 TX FIFO ≤ 1/2 empty
				0x5-0x7 Reserved

interrupt is generated once the FIFO is completely empty and all data including stop bits have left the transmit serializer. In this case, the setting of ${\tt TXIFLSEL}$ is ignored.

Register 10: UART Interrupt Mask (UARTIM), offset 0x038

The **UARTIM** register is the interrupt mask set/clear register.

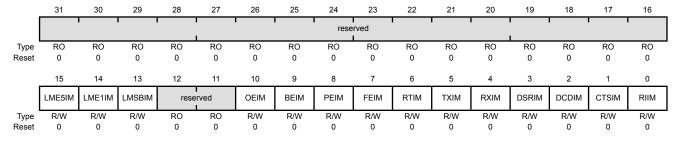
On a read, this register gives the current value of the mask on the relevant interrupt. Setting a bit allows the corresponding raw interrupt signal to be routed to the interrupt controller. Clearing a bit prevents the raw interrupt signal from being sent to the interrupt controller.

Note that bits [3:0] are only implemented on UART1. These bits are reserved on UART0 and UART2.

UART Interrupt Mask (UARTIM)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x038 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:16	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15	LME5IM	R/W	0	LIN Mode Edge 5 Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the LME5RIS bit in the UARTRIS register is set.
				O The LME5RIS interrupt is suppressed and not sent to the interrupt controller.
14	LME1IM	R/W	0	LIN Mode Edge 1 Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the LME1RIS bit in the UARTRIS register is set.
				O The LMEIRIS interrupt is suppressed and not sent to the interrupt controller.
13	LMSBIM	R/W	0	LIN Mode Sync Break Interrupt Mask
				Value Description

1

0

An interrupt is sent to the interrupt controller when the LMSBRIS

The LMSBRIS interrupt is suppressed and not sent to the

bit in the **UARTRIS** register is set.

interrupt controller.

Bit/Field	Name	Туре	Reset	Description
12:11	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
10	OEIM	R/W	0	UART Overrun Error Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the OERIS bit in the UARTRIS register is set.
				O The OERIS interrupt is suppressed and not sent to the interrupt controller.
9	BEIM	R/W	0	UART Break Error Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the BERIS bit in the UARTRIS register is set.
				O The BERIS interrupt is suppressed and not sent to the interrupt controller.
8	PEIM	R/W	0	UART Parity Error Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the PERIS bit in the UARTRIS register is set.
				O The PERIS interrupt is suppressed and not sent to the interrupt controller.
7	FEIM	R/W	0	UART Framing Error Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the FERIS bit in the UARTRIS register is set.
				O The FERIS interrupt is suppressed and not sent to the interrupt controller.
6	RTIM	R/W	0	UART Receive Time-Out Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the RTRIS bit in the UARTRIS register is set.
				O The RTRIS interrupt is suppressed and not sent to the interrupt controller.

Bit/Field	Name	Туре	Reset	Description
5	TXIM	R/W	0	UART Transmit Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the TXRIS bit in the UARTRIS register is set.
				O The TXRIS interrupt is suppressed and not sent to the interrupt controller.
4	RXIM	R/W	0	UART Receive Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the RXRIS bit in the UARTRIS register is set.
				O The RXRIS interrupt is suppressed and not sent to the interrupt controller.
3	DSRIM	R/W	0	UART Data Set Ready Modem Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the DSRRIS bit in the UARTRIS register is set.
				O The DSRRIS interrupt is suppressed and not sent to the interrupt controller.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
2	DCDIM	R/W	0	UART Data Carrier Detect Modem Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the DCDRIS bit in the UARTRIS register is set.
				O The DCDRIS interrupt is suppressed and not sent to the interrupt controller.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
1	CTSIM	R/W	0	UART Clear to Send Modem Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the CTSRIS bit in the UARTRIS register is set.
				O The CTSRIS interrupt is suppressed and not sent to the interrupt controller.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.

Bit/Field	Name	Туре	Reset	Description
0	RIIM	R/W	0	UART Ring Indicator Modem Interrupt Mask
				Value Description
				An interrupt is sent to the interrupt controller when the RIRIS bit in the UARTRIS register is set.
				O The RIRIS interrupt is suppressed and not sent to the interrupt controller.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.

Register 11: UART Raw Interrupt Status (UARTRIS), offset 0x03C

The **UARTRIS** register is the raw interrupt status register. On a read, this register gives the current raw status value of the corresponding interrupt. A write has no effect.

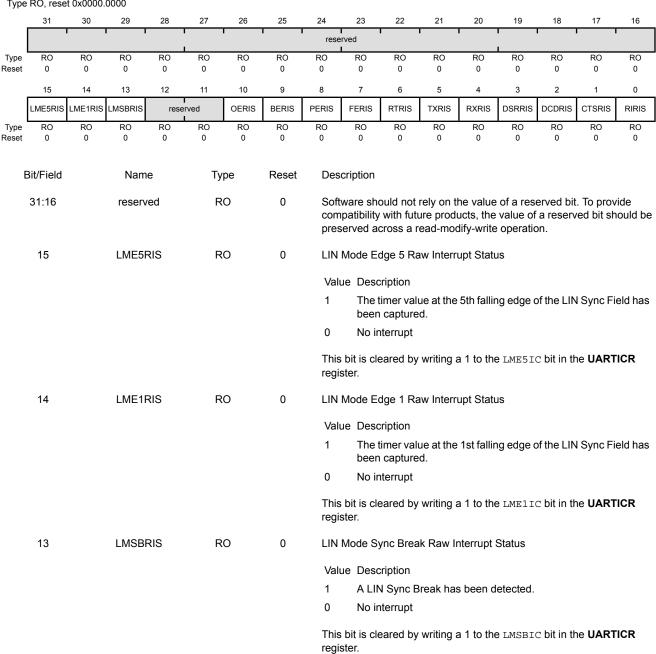
Note that bits [3:0] are only implemented on UART1. These bits are reserved on UART0 and UART2.

UART Raw Interrupt Status (UARTRIS)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x03C

Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
12:11	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
10	OERIS	RO	0	UART Overrun Error Raw Interrupt Status
				Value Description 1 An overrun error has occurred. 0 No interrupt
				This bit is cleared by writing a 1 to the OEIC bit in the UARTICR register.
9	BERIS	RO	0	UART Break Error Raw Interrupt Status
				Value Description 1 A break error has occurred. 0 No interrupt
				This bit is cleared by writing a 1 to the ${\tt BEIC}$ bit in the $\textbf{UARTICR}$ register.
8	PERIS	RO	0	UART Parity Error Raw Interrupt Status
				Value Description 1 A parity error has occurred. 0 No interrupt
				This bit is cleared by writing a 1 to the PEIC bit in the UARTICR register.
7	FERIS	RO	0	UART Framing Error Raw Interrupt Status
				Value Description 1 A framing error has occurred. 0 No interrupt
				This bit is cleared by writing a 1 to the ${\tt FEIC}$ bit in the $\textbf{UARTICR}$ register.
6	RTRIS	RO	0	UART Receive Time-Out Raw Interrupt Status
				Value Description 1 A receive time out has occurred. 0 No interrupt

This bit is cleared by writing a 1 to the ${\tt RTIC}$ bit in the UARTICR register.

Bit/Field	Name	Туре	Reset	Description
5	TXRIS	RO	0	UART Transmit Raw Interrupt Status
				Value Description
				1 If the EOT bit in the UARTCTL register is clear, the transmit FIFO level has passed through the condition defined in the UARTIFLS register.
				If the ${\tt EOT}$ bit is set, the last bit of all transmitted data and flags has left the serializer.
				0 No interrupt
				This bit is cleared by writing a 1 to the TXIC bit in the UARTICR register or by writing data to the transmit FIFO until it becomes greater than the trigger level, if the FIFO is enabled, or by writing a single byte if the FIFO is disabled.
4	RXRIS	RO	0	UART Receive Raw Interrupt Status
				Value Description
				1 The receive FIFO level has passed through the condition defined in the UARTIFLS register.
				0 No interrupt
				This bit is cleared by writing a 1 to the RXIC bit in the UARTICR register or by reading data from the receive FIFO until it becomes less than the trigger level, if the FIFO is enabled, or by reading a single byte if the FIFO is disabled.
3	DSRRIS	RO	0	UART Data Set Ready Modem Raw Interrupt Status
				Value Description
				1 Data Set Ready used for software flow control.
				0 No interrupt
				This bit is cleared by writing a 1 to the DSRIC bit in the UARTICR register.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
2	DCDRIS	RO	0	UART Data Carrier Detect Modem Raw Interrupt Status
				Value Description
				1 Data Carrier Detect used for software flow control.
				0 No interrupt
				This bit is cleared by writing a 1 to the DCDIC bit in the UARTICR register. This bit is implemented only on LIART1 and is recoved for LIART0 and
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.

Bit/Field	Name	Туре	Reset	Description
1	CTSRIS	RO	0	UART Clear to Send Modem Raw Interrupt Status
				Value Description 1 Clear to Send used for software flow control. 0 No interrupt This bit is cleared by writing a 1 to the CTSIC bit in the UARTICR register.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
0	RIRIS	RO	0	UART Ring Indicator Modem Raw Interrupt Status
				Value Description
				1 Ring Indicator used for software flow control.
				0 No interrupt
				This bit is cleared by writing a 1 to the RIIC bit in the UARTICR register. This bit is implemented only on UART1 and is reserved for UART0 and UART2.

Register 12: UART Masked Interrupt Status (UARTMIS), offset 0x040

The **UARTMIS** register is the masked interrupt status register. On a read, this register gives the current masked status value of the corresponding interrupt. A write has no effect.

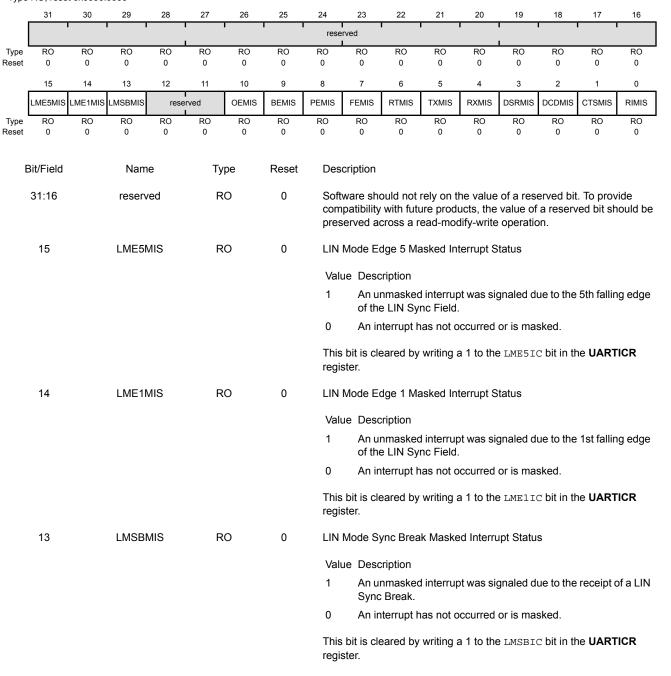
Note that bits [3:0] are only implemented on UART1. These bits are reserved on UART0 and UART2.

UART Masked Interrupt Status (UARTMIS)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x040

Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
12:11	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
10	OEMIS	RO	0	UART Overrun Error Masked Interrupt Status
				Value Description 1 An unmasked interrupt was signaled due to an overrun error. 0 An interrupt has not occurred or is masked. This bit is cleared by writing a 1 to the OEIC bit in the UARTICR register.
9	BEMIS	RO	0	UART Break Error Masked Interrupt Status
v	DEMIC		Ü	Value Description An unmasked interrupt was signaled due to a break error. An interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the BEIC bit in the UARTICR register.
8	PEMIS	RO	0	UART Parity Error Masked Interrupt Status
				Value Description 1 An unmasked interrupt was signaled due to a parity error. 0 An interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the PEIC bit in the UARTICR register.
7	FEMIS	RO	0	Value Description An unmasked interrupt was signaled due to a framing error. An interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the ${\tt FEIC}$ bit in the $\textbf{UARTICR}$ register.
6	RTMIS	RO	0	UART Receive Time-Out Masked Interrupt Status
				Value Description 1 An unmasked interrupt was signaled due to a receive time out. 0 An interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the ${\tt RTIC}$ bit in the $\textbf{UARTICR}$ register.

Bit/Field	Name	Туре	Reset	Description
5	TXMIS	RO	0	UART Transmit Masked Interrupt Status
				Value Description
				An unmasked interrupt was signaled due to passing through the specified transmit FIFO level (if the EOT bit is clear) or due to the transmission of the last data bit (if the EOT bit is set).
				O An interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the TXIC bit in the UARTICR register or by writing data to the transmit FIFO until it becomes greater than the trigger level, if the FIFO is enabled, or by writing a single byte if the FIFO is disabled.
4	RXMIS	RO	0	UART Receive Masked Interrupt Status
				Value Description
				An unmasked interrupt was signaled due to passing through the specified receive FIFO level.
				O An interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the RXIC bit in the UARTICR register or by reading data from the receive FIFO until it becomes less than the trigger level, if the FIFO is enabled, or by reading a single byte if the FIFO is disabled.
3	DSRMIS	RO	0	UART Data Set Ready Modem Masked Interrupt Status
				Value Description
				1 An unmasked interrupt was signaled due to Data Set Ready.
				O An interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the DSRIC bit in the UARTICR register.
				This bit is implemented only on UART1 and is reserved for UART0 and UART2.
2	DCDMIS	RO	0	UART Data Carrier Detect Modem Masked Interrupt Status
				Value Description
				1 An unmasked interrupt was signaled due to Data Carrier Detect.
				O An interrupt has not occurred or is masked.
				This bit is cleared by writing a 1 to the DCDIC bit in the UARTICR register. This bit is implemented only on UART1 and is reserved for UART0 and UART2.

Bit/Field	Name	Туре	Reset	Description
1	CTSMIS	RO	0	UART Clear to Send Modem Masked Interrupt Status
				Value Description 1 An unmasked interrupt was signaled due to Clear to Send. 0 An interrupt has not occurred or is masked. This bit is cleared by writing a 1 to the CTSIC bit in the UARTICR register. This bit is implemented only on UART1 and is reserved for UART0 and UART2.
0	RIMIS	RO	0	UART Ring Indicator Modem Masked Interrupt Status Value Description 1 An unmasked interrupt was signaled due to Ring Indicator. 0 An interrupt has not occurred or is masked. This bit is cleared by writing a 1 to the RIIC bit in the UARTICR register. This bit is implemented only on UART1 and is reserved for UART0 and UART2.

Register 13: UART Interrupt Clear (UARTICR), offset 0x044

The **UARTICR** register is the interrupt clear register. On a write of 1, the corresponding interrupt (both raw interrupt and masked interrupt, if enabled) is cleared. A write of 0 has no effect.

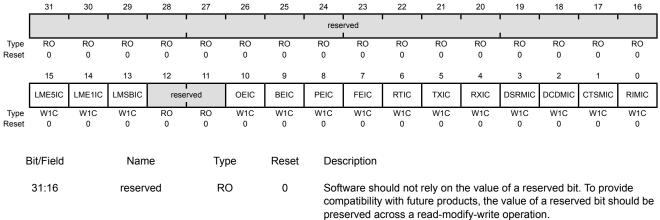
Note that bits [3:0] are only implemented on UART1. These bits are reserved on UART0 and UART2.

UART Interrupt Clear (UARTICR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x044

Type W1C, reset 0x0000.0000



DII/FIEIU	Ivallie	Type	Reset	Description
31:16	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15	LME5IC	W1C	0	LIN Mode Edge 5 Interrupt Clear Writing a 1 to this bit clears the LME5RIS bit in the UARTRIS register and the LME5MIS bit in the UARTMIS register.
14	LME1IC	W1C	0	LIN Mode Edge 1 Interrupt Clear Writing a 1 to this bit clears the LME1RIS bit in the UARTRIS register and the LME1MIS bit in the UARTMIS register.
13	LMSBIC	W1C	0	LIN Mode Sync Break Interrupt Clear Writing a 1 to this bit clears the LMSBRIS bit in the UARTRIS register and the LMSBMIS bit in the UARTMIS register.
12:11	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
10	OEIC	W1C	0	Overrun Error Interrupt Clear
				Writing a 1 to this bit clears the OERIS bit in the UARTRIS register and the OEMIS bit in the UARTMIS register.
9	BEIC	W1C	0	Break Error Interrupt Clear
				Writing a 1 to this bit clears the BERIS bit in the UARTRIS register and the BEMIS bit in the UARTMIS register.
8	PEIC	W1C	0	Parity Error Interrupt Clear
				Writing a 1 to this bit clears the PERIS bit in the UARTRIS register and the PEMIS bit in the UARTMIS register.

Bit/Field	Name	Туре	Reset	Description
7	FEIC	W1C	0	Framing Error Interrupt Clear Writing a 1 to this bit clears the FERIS bit in the UARTRIS register and the FEMIS bit in the UARTMIS register.
6	RTIC	W1C	0	Receive Time-Out Interrupt Clear Writing a 1 to this bit clears the RTRIS bit in the UARTRIS register and the RTMIS bit in the UARTMIS register.
5	TXIC	W1C	0	Transmit Interrupt Clear Writing a 1 to this bit clears the TXRIS bit in the UARTRIS register and the TXMIS bit in the UARTMIS register.
4	RXIC	W1C	0	Receive Interrupt Clear Writing a 1 to this bit clears the RXRIS bit in the UARTRIS register and the RXMIS bit in the UARTMIS register.
3	DSRMIC	W1C	0	UART Data Set Ready Modem Interrupt Clear Writing a 1 to this bit clears the DSRRIS bit in the UARTRIS register and the DSRMIS bit in the UARTMIS register. This bit is implemented only on UART1 and is reserved for UART0 and UART2.
2	DCDMIC	W1C	0	UART Data Carrier Detect Modem Interrupt Clear Writing a 1 to this bit clears the DCDRIS bit in the UARTRIS register and the DCDMIS bit in the UARTMIS register. This bit is implemented only on UART1 and is reserved for UART0 and UART2.
1	CTSMIC	W1C	0	UART Clear to Send Modem Interrupt Clear Writing a 1 to this bit clears the CTSRIS bit in the UARTRIS register and the CTSMIS bit in the UARTMIS register. This bit is implemented only on UART1 and is reserved for UART0 and UART2.
0	RIMIC	W1C	0	UART Ring Indicator Modem Interrupt Clear Writing a 1 to this bit clears the RIRIS bit in the UARTRIS register and the RIMIS bit in the UARTMIS register. This bit is implemented only on UART1 and is reserved for UART0 and UART2.

Register 14: UART DMA Control (UARTDMACTL), offset 0x048

The **UARTDMACTL** register is the DMA control register.

UART DMA Control (UARTDMACTL)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x048

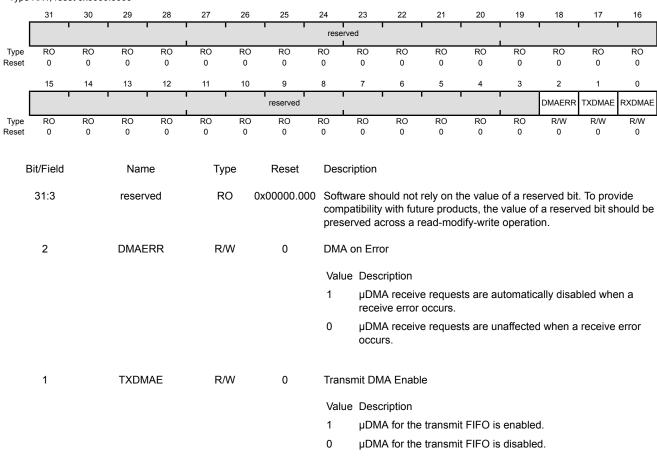
0

RXDMAE

R/W

0

Type R/W, reset 0x0000.0000



Receive DMA Enable
Value Description

1 μDMA for the receive FIFO is enabled.

0 μDMA for the receive FIFO is disabled.

Register 15: UART LIN Control (UARTLCTL), offset 0x090

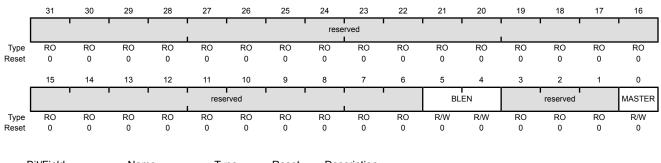
The **UARTLCTL** register is the configures the operation of the UART when in LIN mode.

UART LIN Control (UARTLCTL)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x090

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:6	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5:4	BLEN	R/W	0x0	Sync Break Length
				Value Description
				0x3 Sync break length is 16T bits
				0x2 Sync break length is 15T bits
				0x1 Sync break length is 14T bits
				0x0 Sync break length is 13T bits (default)
3:1	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	MASTER	R/W	0	LIN Master Enable

Value Description

- 1 The UART operates as a LIN master.
- 0 The UART operates as a LIN slave.

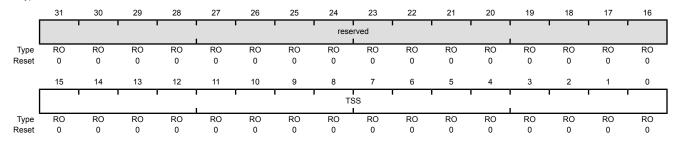
Register 16: UART LIN Snap Shot (UARTLSS), offset 0x094

The **UARTLSS** register captures the free-running timer value when either the Sync Edge 1 or the Sync Edge 5 is detected in LIN mode.

UART LIN Snap Shot (UARTLSS)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x004

Offset 0x094 Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:16	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:0	TSS	RO	0x0000	Timer Snap Shot

This field contains the value of the free-running timer when either the Sync Edge 5 or the Sync Edge 1 was detected.

Register 17: UART LIN Timer (UARTLTIM), offset 0x098

The **UARTLTIM** register contains the current timer value for the free-running timer that is used to calculate the baud rate when in LIN slave mode. The value in this register is used along with the value in the **UART LIN Snap Shot (UARTLSS)** register to adjust the baud rate to match that of the master.

UART LIN Timer (UARTLTIM)

TIMER

RO

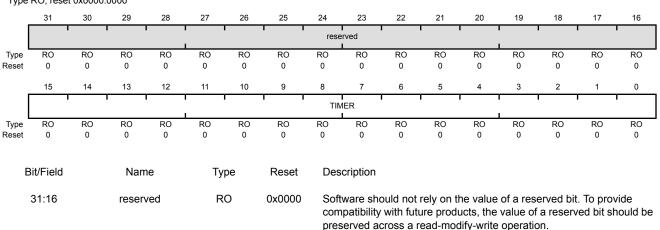
0x0000

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x098

15:0

Type RO, reset 0x0000.0000



Timer Value

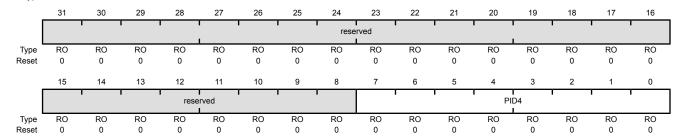
This field contains the value of the free-running timer.

Register 18: UART Peripheral Identification 4 (UARTPeriphID4), offset 0xFD0

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 4 (UARTPeriphID4)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFD0 Type RO, reset 0x0000.0000



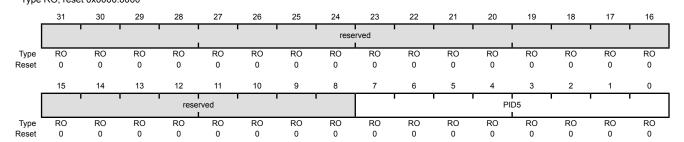
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID4	RO	0x00	UART Peripheral ID Register [7:0]
				Can be used by software to identify the presence of this peripheral.

Register 19: UART Peripheral Identification 5 (UARTPeriphID5), offset 0xFD4

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 5 (UARTPeriphID5)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0xFD4
Type RO, reset 0x0000.0000



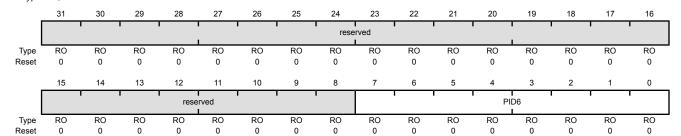
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID5	RO	0x00	UART Peripheral ID Register [15:8]
				Can be used by software to identify the presence of this peripheral.

Register 20: UART Peripheral Identification 6 (UARTPeriphID6), offset 0xFD8

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 6 (UARTPeriphID6)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFD8 Type RO, reset 0x0000.0000



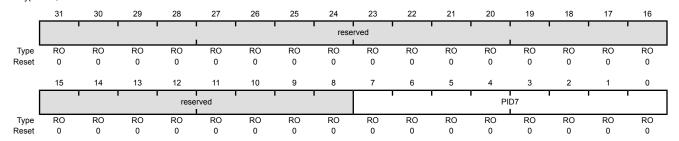
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID6	RO	0x00	UART Peripheral ID Register [23:16]
				Can be used by software to identify the presence of this peripheral.

Register 21: UART Peripheral Identification 7 (UARTPeriphID7), offset 0xFDC

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 7 (UARTPeriphID7)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0xFDC
Type RO, reset 0x0000.0000



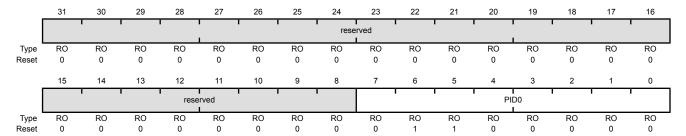
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID7	RO	0x00	UART Peripheral ID Register [31:24] Can be used by software to identify the presence of this peripheral

Register 22: UART Peripheral Identification 0 (UARTPeriphID0), offset 0xFE0

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 0 (UARTPeriphID0)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFE0 Type RO, reset 0x0000.0060



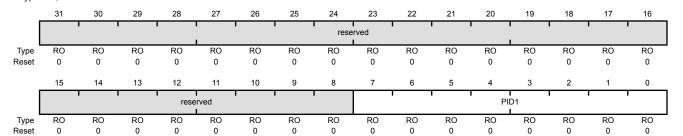
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID0	RO	0x60	UART Peripheral ID Register [7:0]
				Can be used by software to identify the presence of this peripheral.

Register 23: UART Peripheral Identification 1 (UARTPeriphID1), offset 0xFE4

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 1 (UARTPeriphID1)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFE4 Type RO, reset 0x0000.0000



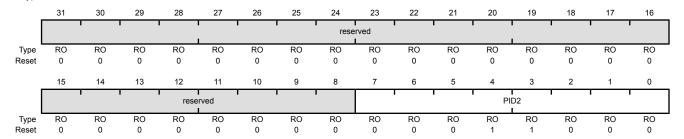
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID1	RO	0x00	UART Peripheral ID Register [15:8]
				Can be used by software to identify the presence of this peripheral.

Register 24: UART Peripheral Identification 2 (UARTPeriphID2), offset 0xFE8

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 2 (UARTPeriphID2)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFE8 Type RO, reset 0x0000.0018



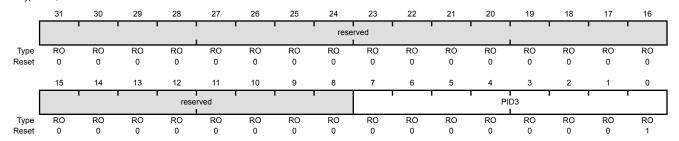
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID2	RO	0x18	UART Peripheral ID Register [23:16] Can be used by software to identify the presence of this peripheral

Register 25: UART Peripheral Identification 3 (UARTPeriphID3), offset 0xFEC

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 3 (UARTPeriphID3)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFEC Type RO, reset 0x0000.0001



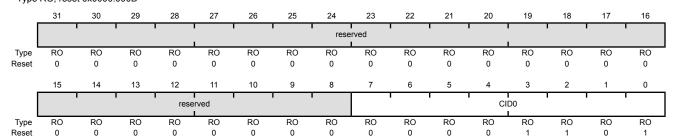
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID3	RO	0x01	UART Peripheral ID Register [31:24] Can be used by software to identify the presence of this peripheral

Register 26: UART PrimeCell Identification 0 (UARTPCellID0), offset 0xFF0

The **UARTPCellIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART PrimeCell Identification 0 (UARTPCellID0)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFF0 Type RO, reset 0x0000.000D



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID0	RO	0x0D	UART PrimeCell ID Register [7:0] Provides software a standard cross-peripheral identification system.

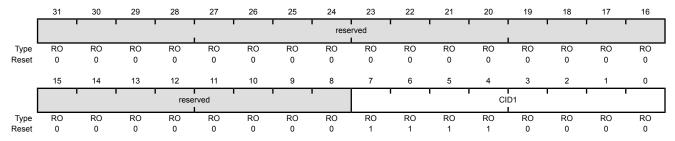
Register 27: UART PrimeCell Identification 1 (UARTPCellID1), offset 0xFF4

The **UARTPCellIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART PrimeCell Identification 1 (UARTPCellID1)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFF4

Type RO, reset 0x0000.00F0



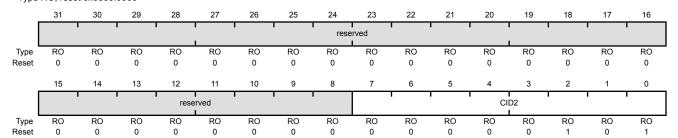
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID1	RO	0xF0	UART PrimeCell ID Register [15:8]
				Provides software a standard cross-peripheral identification system.

Register 28: UART PrimeCell Identification 2 (UARTPCellID2), offset 0xFF8

The **UARTPCellIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART PrimeCell Identification 2 (UARTPCellID2)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFF8 Type RO, reset 0x0000.0005



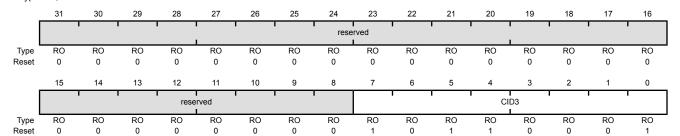
Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID2	RO	0x05	UART PrimeCell ID Register [23:16] Provides software a standard cross-peripheral identification system.

Register 29: UART PrimeCell Identification 3 (UARTPCellID3), offset 0xFFC

The **UARTPCellIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART PrimeCell Identification 3 (UARTPCellID3)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFFC Type RO, reset 0x0000.00B1



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID3	RO	0xB1	UART PrimeCell ID Register [31:24]
				Provides software a standard cross-peripheral identification system.

14 Synchronous Serial Interface (SSI)

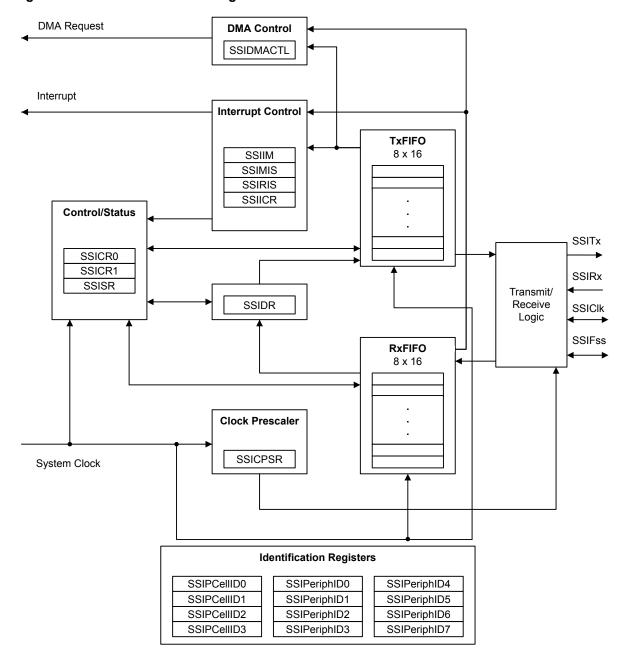
The Stellaris[®] microcontroller includes two Synchronous Serial Interface (SSI) modules. Each SSI is a master or slave interface for synchronous serial communication with peripheral devices that have either Freescale SPI, MICROWIRE, or Texas Instruments synchronous serial interfaces.

The Stellaris LM3S1J11 controller includes two SSI modules with the following features:

- Programmable interface operation for Freescale SPI, MICROWIRE, or Texas Instruments synchronous serial interfaces
- Master or slave operation
- Programmable clock bit rate and prescaler
- Separate transmit and receive FIFOs, each 16 bits wide and 8 locations deep
- Programmable data frame size from 4 to 16 bits
- Internal loopback test mode for diagnostic/debug testing
- Standard FIFO-based interrupts and End-of-Transmission interrupt
- Efficient transfers using Micro Direct Memory Access Controller (µDMA)
 - Separate channels for transmit and receive
 - Receive single request asserted when data is in the FIFO; burst request asserted when FIFO contains 4 entries
 - Transmit single request asserted when there is space in the FIFO; burst request asserted when FIFO contains 4 entries

14.1 Block Diagram

Figure 14-1. SSI Module Block Diagram



14.2 Signal Description

The following table lists the external signals of the SSI module and describes the function of each. The SSI signals are alternate functions for some GPIO signals and default to be GPIO signals at reset., with the exception of the SSIOClk, SSIOFss, SSIORx, and SSIOTx pins which default to the SSI function. The column in the table below titled "Pin Mux/Pin Assignment" lists the possible GPIO pin placements for the SSI signals. The AFSEL bit in the **GPIO Alternate Function Select (GPIOAFSEL)** register (page 412) should be set to choose the SSI function. The number in

parentheses is the encoding that must be programmed into the PMCn field in the **GPIO Port Control** (**GPIOPCTL**) register (page 430) to assign the SSI signal to the specified GPIO port pin. For more information on configuring GPIOs, see "General-Purpose Input/Outputs (GPIOs)" on page 389.

Table 14-1. SSI Signals (100LQFP)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
SSI0Clk	28	PA2 (1)	I/O	TTL	SSI module 0 clock
SSI0Fss	29	PA3 (1)	I/O	TTL	SSI module 0 frame signal
SSIORx	30	PA4 (1)	1	TTL	SSI module 0 receive
SSIOTx	31	PA5 (1)	0	TTL	SSI module 0 transmit
SSI1Clk	60 74 76	PF2 (9) PE0 (2) PH4 (11)	I/O	TTL	SSI module 1 clock.
SSI1Fss	59 63 75	PF3 (9) PH5 (11) PE1 (2)	I/O	TTL	SSI module 1 frame signal.
SSI1Rx	58 62 95	PF4 (9) PH6 (11) PE2 (2)	I	TTL	SSI module 1 receive.
SSI1Tx	15 46 96	PH7 (11) PF5 (9) PE3 (2)	0	TTL	SSI module 1 transmit.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

Table 14-2. SSI Signals (108BGA)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
SSI0Clk	M4	PA2 (1)	I/O	TTL	SSI module 0 clock
SSI0Fss	L4	PA3 (1)	I/O	TTL	SSI module 0 frame signal
SSIORx	L5	PA4 (1)	1	TTL	SSI module 0 receive
SSIOTX	M5	PA5 (1)	0	TTL	SSI module 0 transmit
SSI1Clk	J11 B11 B10	PF2 (9) PE0 (2) PH4 (11)	I/O	TTL	SSI module 1 clock.
SSI1Fss	J12 F10 A12	PF3 (9) PH5 (11) PE1 (2)	I/O	TTL	SSI module 1 frame signal.
SSI1Rx	L9 G3 A4	PF4 (9) PH6 (11) PE2 (2)	I	TTL	SSI module 1 receive.
SSI1Tx	H3 L8 B4	PH7 (11) PF5 (9) PE3 (2)	0	TTL	SSI module 1 transmit.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

14.3 Functional Description

The SSI performs serial-to-parallel conversion on data received from a peripheral device. The CPU accesses data, control, and status information. The transmit and receive paths are buffered with internal FIFO memories allowing up to eight 16-bit values to be stored independently in both transmit

and receive modes. The SSI also supports the μ DMA interface. The transmit and receive FIFOs can be programmed as destination/source addresses in the μ DMA module. μ DMA operation is enabled by setting the appropriate bit(s) in the **SSIDMACTL** register (see page 682).

14.3.1 Bit Rate Generation

The SSI includes a programmable bit rate clock divider and prescaler to generate the serial output clock. Bit rates are supported to 2 MHz and higher, although maximum bit rate is determined by peripheral devices.

The serial bit rate is derived by dividing down the input clock (SysClk). The clock is first divided by an even prescale value CPSDVSR from 2 to 254, which is programmed in the **SSI Clock Prescale** (**SSICPSR**) register (see page 675). The clock is further divided by a value from 1 to 256, which is 1 + SCR, where SCR is the value programmed in the **SSI Control 0** (**SSICR0**) register (see page 668).

The frequency of the output clock SSIClk is defined by:

```
SSIClk = SysClk / (CPSDVSR * (1 + SCR))
```

Note: For master mode, the system clock must be at least two times faster than the SSIClk. For slave mode, the system clock must be at least 12 times faster than the SSIClk.

See "Synchronous Serial Interface (SSI)" on page 809 to view SSI timing parameters.

14.3.2 FIFO Operation

14.3.2.1 Transmit FIFO

The common transmit FIFO is a 16-bit wide, 8-locations deep, first-in, first-out memory buffer. The CPU writes data to the FIFO by writing the **SSI Data (SSIDR)** register (see page 672), and data is stored in the FIFO until it is read out by the transmission logic.

When configured as a master or a slave, parallel data is written into the transmit FIFO prior to serial conversion and transmission to the attached slave or master, respectively, through the SSITX pin.

In slave mode, the SSI transmits data each time the master initiates a transaction. If the transmit FIFO is empty and the master initiates, the slave transmits the 8th most recent value in the transmit FIFO. If less than 8 values have been written to the transmit FIFO since the SSI module clock was enabled using the SSI bit in the **RGCG1** register, then 0 is transmitted. Care should be taken to ensure that valid data is in the FIFO as needed. The SSI can be configured to generate an interrupt or a μ DMA request when the FIFO is empty.

14.3.2.2 Receive FIFO

The common receive FIFO is a 16-bit wide, 8-locations deep, first-in, first-out memory buffer. Received data from the serial interface is stored in the buffer until read out by the CPU, which accesses the read FIFO by reading the **SSIDR** register.

When configured as a master or slave, serial data received through the SSIRx pin is registered prior to parallel loading into the attached slave or master receive FIFO, respectively.

14.3.3 Interrupts

The SSI can generate interrupts when the following conditions are observed:

- Transmit FIFO service (when the transmit FIFO is half full or less)
- Receive FIFO service (when the receive FIFO is half full or more)

- Receive FIFO time-out
- Receive FIFO overrun
- End of transmission

All of the interrupt events are ORed together before being sent to the interrupt controller, so the SSI generates a single interrupt request to the controller regardless of the number of active interrupts. Each of the four individual maskable interrupts can be masked by clearing the appropriate bit in the **SSI Interrupt Mask (SSIIM)** register (see page 676). Setting the appropriate mask bit enables the interrupt.

The individual outputs, along with a combined interrupt output, allow use of either a global interrupt service routine or modular device drivers to handle interrupts. The transmit and receive dynamic dataflow interrupts have been separated from the status interrupts so that data can be read or written in response to the FIFO trigger levels. The status of the individual interrupt sources can be read from the SSI Raw Interrupt Status (SSIRIS) and SSI Masked Interrupt Status (SSIMIS) registers (see page 677 and page 679, respectively).

The receive FIFO has a time-out period that is 32 periods at the rate of SSIClk (whether or not SSIClk is currently active) and is started when the RX FIFO goes from EMPTY to not-EMPTY. If the RX FIFO is emptied before 32 clocks have passed, the time-out period is reset. As a result, the ISR should clear the Receive FIFO Time-out Interrupt just after reading out the RX FIFO by writing a 1 to the RTIC bit in the SSI Interrupt Clear (SSIICR) register. The interrupt should not be cleared so late that the ISR returns before the interrupt is actually cleared, or the ISR may be re-activated unnecessarily.

The End-of-Transmission (EOT) interrupt indicates that the data has been transmitted completely. This interrupt can be used to indicate when it is safe to turn off the SSI module clock or enter sleep mode. In addition, because transmitted data and received data complete at exactly the same time, the interrupt can also indicate that read data is ready immediately, without waiting for the receive FIFO time-out period to complete.

14.3.4 Frame Formats

Each data frame is between 4 and 16 bits long, depending on the size of data programmed, and is transmitted starting with the MSB. There are three basic frame types that can be selected:

- Texas Instruments synchronous serial
- Freescale SPI
- MICROWIRE

For all three formats, the serial clock (SSIClk) is held inactive while the SSI is idle, and SSIClk transitions at the programmed frequency only during active transmission or reception of data. The idle state of SSIClk is utilized to provide a receive timeout indication that occurs when the receive FIFO still contains data after a timeout period.

For Freescale SPI and MICROWIRE frame formats, the serial frame (SSIFss) pin is active Low, and is asserted (pulled down) during the entire transmission of the frame.

For Texas Instruments synchronous serial frame format, the SSIFss pin is pulsed for one serial clock period starting at its rising edge, prior to the transmission of each frame. For this frame format, both the SSI and the off-chip slave device drive their output data on the rising edge of SSIClk and latch data from the other device on the falling edge.

Unlike the full-duplex transmission of the other two frame formats, the MICROWIRE format uses a special master-slave messaging technique which operates at half-duplex. In this mode, when a frame begins, an 8-bit control message is transmitted to the off-chip slave. During this transmit, no incoming data is received by the SSI. After the message has been sent, the off-chip slave decodes it and, after waiting one serial clock after the last bit of the 8-bit control message has been sent, responds with the requested data. The returned data can be 4 to 16 bits in length, making the total frame length anywhere from 13 to 25 bits.

14.3.4.1 Texas Instruments Synchronous Serial Frame Format

Figure 14-2 on page 658 shows the Texas Instruments synchronous serial frame format for a single transmitted frame.

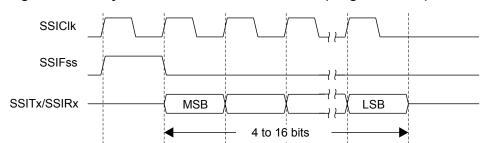


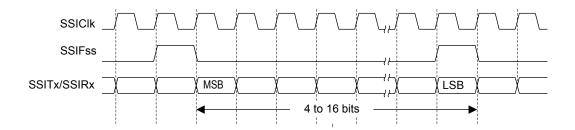
Figure 14-2. TI Synchronous Serial Frame Format (Single Transfer)

In this mode, SSIClk and SSIFss are forced Low, and the transmit data line SSITx is tristated whenever the SSI is idle. Once the bottom entry of the transmit FIFO contains data, SSIFss is pulsed High for one SSIClk period. The value to be transmitted is also transferred from the transmit FIFO to the serial shift register of the transmit logic. On the next rising edge of SSIClk, the MSB of the 4 to 16-bit data frame is shifted out on the SSITx pin. Likewise, the MSB of the received data is shifted onto the SSIRx pin by the off-chip serial slave device.

Both the SSI and the off-chip serial slave device then clock each data bit into their serial shifter on each falling edge of SSIClk. The received data is transferred from the serial shifter to the receive FIFO on the first rising edge of SSIClk after the LSB has been latched.

Figure 14-3 on page 658 shows the Texas Instruments synchronous serial frame format when back-to-back frames are transmitted.





14.3.4.2 Freescale SPI Frame Format

The Freescale SPI interface is a four-wire interface where the SSIFss signal behaves as a slave select. The main feature of the Freescale SPI format is that the inactive state and phase of the SSIClk signal are programmable through the SPO and SPH bits in the **SSISCRO** control register.

SPO Clock Polarity Bit

When the SPO clock polarity control bit is clear, it produces a steady state Low value on the SSIClk pin. If the SPO bit is set, a steady state High value is placed on the SSIClk pin when data is not being transferred.

SPH Phase Control Bit

The SPH phase control bit selects the clock edge that captures data and allows it to change state. The state of this bit has the most impact on the first bit transmitted by either allowing or not allowing a clock transition before the first data capture edge. When the SPH phase control bit is clear, data is captured on the first clock edge transition. If the SPH bit is set, data is captured on the second clock edge transition.

14.3.4.3 Freescale SPI Frame Format with SPO=0 and SPH=0

Q is undefined.

Single and continuous transmission signal sequences for Freescale SPI format with SPO=0 and SPH=0 are shown in Figure 14-4 on page 659 and Figure 14-5 on page 659.

SSICIK

SSIFss

SSIRx

MSB

4 to 16 bits

SSITx

MSB

LSB

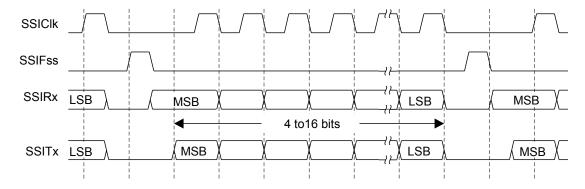
Q

LSB

LSB

Figure 14-4. Freescale SPI Format (Single Transfer) with SPO=0 and SPH=0

Figure 14-5. Freescale SPI Format (Continuous Transfer) with SPO=0 and SPH=0



In this configuration, during idle periods:

■ SSIC1k is forced Low

Note:

- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low
- When the SSI is configured as a master, it enables the SSIClk pad
- When the SSI is configured as a slave, it disables the SSIClk pad

If the SSI is enabled and valid data is in the transmit FIFO, the start of transmission is signified by the SSIFss master signal being driven Low, causing slave data to be enabled onto the SSIRx input line of the master. The master SSITx output pad is enabled.

One half SSIC1k period later, valid master data is transferred to the SSITx pin. Once both the master and slave data have been set, the SSIC1k master clock pin goes High after one additional half SSIC1k period.

The data is now captured on the rising and propagated on the falling edges of the SSIClk signal.

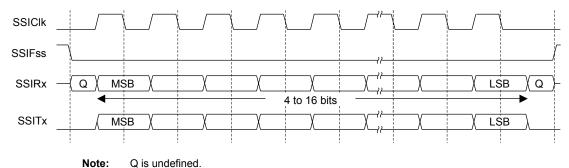
In the case of a single word transmission, after all bits of the data word have been transferred, the SSIFss line is returned to its idle High state one SSIC1k period after the last bit has been captured.

However, in the case of continuous back-to-back transmissions, the SSIFss signal must be pulsed High between each data word transfer because the slave select pin freezes the data in its serial peripheral register and does not allow it to be altered if the SPH bit is clear. Therefore, the master device must raise the SSIFss pin of the slave device between each data transfer to enable the serial peripheral data write. On completion of the continuous transfer, the SSIFss pin is returned to its idle state one SSIClk period after the last bit has been captured.

14.3.4.4 Freescale SPI Frame Format with SPO=0 and SPH=1

The transfer signal sequence for Freescale SPI format with SPO=0 and SPH=1 is shown in Figure 14-6 on page 660, which covers both single and continuous transfers.

Figure 14-6. Freescale SPI Frame Format with SPO=0 and SPH=1



In this configuration, during idle periods:

- SSIC1k is forced Low
- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low
- When the SSI is configured as a master, it enables the SSIClk pad

■ When the SSI is configured as a slave, it disables the SSIClk pad

If the SSI is enabled and valid data is in the transmit FIFO, the start of transmission is signified by the SSIFss master signal being driven Low. The master SSITx output is enabled. After an additional one-half SSIC1k period, both master and slave valid data are enabled onto their respective transmission lines. At the same time, the SSIC1k is enabled with a rising edge transition.

Data is then captured on the falling edges and propagated on the rising edges of the SSIC1k signal.

In the case of a single word transfer, after all bits have been transferred, the SSIFss line is returned to its idle High state one SSIClk period after the last bit has been captured.

For continuous back-to-back transfers, the SSIFss pin is held Low between successive data words, and termination is the same as that of the single word transfer.

14.3.4.5 Freescale SPI Frame Format with SPO=1 and SPH=0

Single and continuous transmission signal sequences for Freescale SPI format with SPO=1 and SPH=0 are shown in Figure 14-7 on page 661 and Figure 14-8 on page 661.

Figure 14-7. Freescale SPI Frame Format (Single Transfer) with SPO=1 and SPH=0

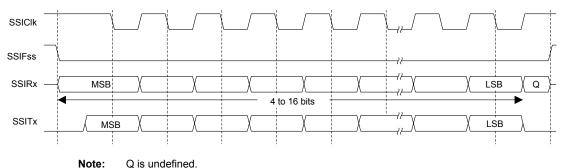
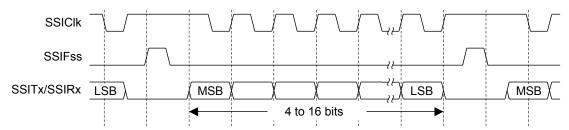


Figure 14-8. Freescale SPI Frame Format (Continuous Transfer) with SPO=1 and SPH=0



In this configuration, during idle periods:

- SSIClk is forced High
- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low
- When the SSI is configured as a master, it enables the SSIClk pad
- When the SSI is configured as a slave, it disables the SSIClk pad

If the SSI is enabled and valid data is in the transmit FIFO, the start of transmission is signified by the SSIFss master signal being driven Low, causing slave data to be immediately transferred onto the SSIRx line of the master. The master SSITx output pad is enabled.

One-half period later, valid master data is transferred to the SSITx line. Once both the master and slave data have been set, the SSIClk master clock pin becomes Low after one additional half SSIClk period, meaning that data is captured on the falling edges and propagated on the rising edges of the SSIClk signal.

In the case of a single word transmission, after all bits of the data word are transferred, the SSIFss line is returned to its idle High state one SSIClk period after the last bit has been captured.

However, in the case of continuous back-to-back transmissions, the SSIFss signal must be pulsed High between each data word transfer because the slave select pin freezes the data in its serial peripheral register and does not allow it to be altered if the SPH bit is clear. Therefore, the master device must raise the SSIFss pin of the slave device between each data transfer to enable the serial peripheral data write. On completion of the continuous transfer, the SSIFss pin is returned to its idle state one SSIClk period after the last bit has been captured.

14.3.4.6 Freescale SPI Frame Format with SPO=1 and SPH=1

The transfer signal sequence for Freescale SPI format with SPO=1 and SPH=1 is shown in Figure 14-9 on page 662, which covers both single and continuous transfers.

Figure 14-9. Freescale SPI Frame Format with SPO=1 and SPH=1

In this configuration, during idle periods:

■ SSIC1k is forced High

Note:

- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low

Q is undefined.

- When the SSI is configured as a master, it enables the SSIClk pad
- When the SSI is configured as a slave, it disables the SSIClk pad

If the SSI is enabled and valid data is in the transmit FIFO, the start of transmission is signified by the SSIFss master signal being driven Low. The master SSITx output pad is enabled. After an additional one-half SSIClk period, both master and slave data are enabled onto their respective transmission lines. At the same time, SSIClk is enabled with a falling edge transition. Data is then captured on the rising edges and propagated on the falling edges of the SSIClk signal.

After all bits have been transferred, in the case of a single word transmission, the SSIFss line is returned to its idle high state one SSIClk period after the last bit has been captured.

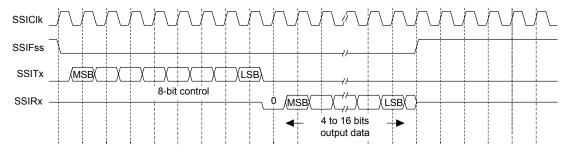
For continuous back-to-back transmissions, the SSIFss pin remains in its active Low state until the final bit of the last word has been captured and then returns to its idle state as described above.

For continuous back-to-back transfers, the SSIFss pin is held Low between successive data words and termination is the same as that of the single word transfer.

14.3.4.7 MICROWIRE Frame Format

Figure 14-10 on page 663 shows the MICROWIRE frame format for a single frame. Figure 14-11 on page 664 shows the same format when back-to-back frames are transmitted.





MICROWIRE format is very similar to SPI format, except that transmission is half-duplex instead of full-duplex and uses a master-slave message passing technique. Each serial transmission begins with an 8-bit control word that is transmitted from the SSI to the off-chip slave device. During this transmission, no incoming data is received by the SSI. After the message has been sent, the off-chip slave decodes it and, after waiting one serial clock after the last bit of the 8-bit control message has been sent, responds with the required data. The returned data is 4 to 16 bits in length, making the total frame length anywhere from 13 to 25 bits.

In this configuration, during idle periods:

- SSIC1k is forced Low
- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low

A transmission is triggered by writing a control byte to the transmit FIFO. The falling edge of SSIFss causes the value contained in the bottom entry of the transmit FIFO to be transferred to the serial shift register of the transmit logic and the MSB of the 8-bit control frame to be shifted out onto the SSITxpin. SSIFss remains Low for the duration of the frame transmission. The SSIRxpin remains tristated during this transmission.

The off-chip serial slave device latches each control bit into its serial shifter on each rising edge of SSIClk. After the last bit is latched by the slave device, the control byte is decoded during a one clock wait-state, and the slave responds by transmitting data back to the SSI. Each bit is driven onto the SSIRx line on the falling edge of SSIClk. The SSI in turn latches each bit on the rising edge of SSIClk. At the end of the frame, for single transfers, the SSIFss signal is pulled High one clock period after the last bit has been latched in the receive serial shifter, causing the data to be transferred to the receive FIFO.

Note: The off-chip slave device can tristate the receive line either on the falling edge of SSIC1k after the LSB has been latched by the receive shifter or when the SSIFss pin goes High.

For continuous transfers, data transmission begins and ends in the same manner as a single transfer. However, the SSIFss line is continuously asserted (held Low) and transmission of data occurs back-to-back. The control byte of the next frame follows directly after the LSB of the received data from the current frame. Each of the received values is transferred from the receive shifter on the falling edge of SSIClk, after the LSB of the frame has been latched into the SSI.

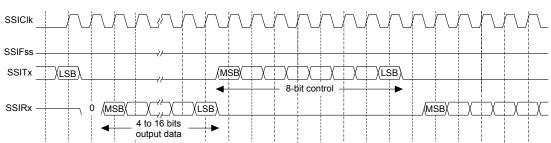


Figure 14-11. MICROWIRE Frame Format (Continuous Transfer)

In the MICROWIRE mode, the SSI slave samples the first bit of receive data on the rising edge of SSIClk after SSIFss has gone Low. Masters that drive a free-running SSIClk must ensure that the SSIFss signal has sufficient setup and hold margins with respect to the rising edge of SSIClk.

Figure 14-12 on page 664 illustrates these setup and hold time requirements. With respect to the SSIClk rising edge on which the first bit of receive data is to be sampled by the SSI slave, SSIFSS must have a setup of at least two times the period of SSIClk on which the SSI operates. With respect to the SSIClk rising edge previous to this edge, SSIFSS must have a hold of at least one SSIClk period.

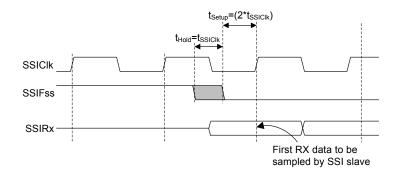


Figure 14-12. MICROWIRE Frame Format, SSIFss Input Setup and Hold Requirements

14.3.5 DMA Operation

The SSI peripheral provides an interface to the μ DMA controller with separate channels for transmit and receive. The μ DMA operation of the SSI is enabled through the **SSI DMA Control (SSIDMACTL)** register. When μ DMA operation is enabled, the SSI asserts a μ DMA request on the receive or transmit channel when the associated FIFO can transfer data. For the receive channel, a single transfer request is asserted whenever any data is in the receive FIFO. A burst transfer request is asserted whenever the amount of data in the receive FIFO is 4 or more items. For the transmit channel, a single transfer request is asserted whenever at least one empty location is in the transmit

FIFO. The burst request is asserted whenever the transmit FIFO has 4 or more empty slots. The single and burst μDMA transfer requests are handled automatically by the μDMA controller depending how the μDMA channel is configured. To enable μDMA operation for the receive channel, the RXDMAE bit of the **DMA Control (SSIDMACTL)** register should be set. To enable μDMA operation for the transmit channel, the TXDMAE bit of **SSIDMACTL** should be set. If μDMA is enabled, then the μDMA controller triggers an interrupt when a transfer is complete. The interrupt occurs on the SSI interrupt vector. Therefore, if interrupts are used for SSI operation and μDMA is enabled, the SSI interrupt handler must be designed to handle the μDMA completion interrupt.

See "Micro Direct Memory Access (µDMA)" on page 331 for more details about programming the µDMA controller.

14.4 Initialization and Configuration

To enable and initialize the SSI, the following steps are necessary:

- 1. Enable the SSI module by setting the SSI bit in the RCGC1 register (see page 246).
- **2.** Enable the clock to the appropriate GPIO module via the **RCGC2** register (see page 255). To find out which GPIO port to enable, refer to Table 18-5 on page 767.
- 3. Set the GPIO AFSEL bits for the appropriate pins (see page 412). To determine which GPIOs to configure, see Table 18-4 on page 762.
- **4.** Configure the PMCn fields in the **GPIOPCTL** register to assign the SSI signals to the appropriate pins. See page 430 and Table 18-5 on page 767.

For each of the frame formats, the SSI is configured using the following steps:

- 1. Ensure that the SSE bit in the **SSICR1** register is clear before making any configuration changes.
- 2. Select whether the SSI is a master or slave:
 - **a.** For master operations, set the **SSICR1** register to 0x0000.0000.
 - **b.** For slave mode (output enabled), set the **SSICR1** register to 0x0000.0004.
 - c. For slave mode (output disabled), set the **SSICR1** register to 0x0000.000C.
- 3. Configure the clock prescale divisor by writing the **SSICPSR** register.
- **4.** Write the **SSICR0** register with the following configuration:
 - Serial clock rate (SCR)
 - Desired clock phase/polarity, if using Freescale SPI mode (SPH and SPO)
 - The protocol mode: Freescale SPI, TI SSF, MICROWIRE (FRF)
 - The data size (DSS)
- **5.** Optionally, configure the μDMA channel (see "Micro Direct Memory Access (μDMA)" on page 331) and enable the DMA option(s) in the **SSIDMACTL** register.
- **6.** Enable the SSI by setting the SSE bit in the **SSICR1** register.

As an example, assume the SSI must be configured to operate with the following parameters:

- Master operation
- Freescale SPI mode (SPO=1, SPH=1)
- 1 Mbps bit rate
- 8 data bits

Assuming the system clock is 20 MHz, the bit rate calculation would be:

```
SSIClk = SysClk / (CPSDVSR * (1 + SCR))
1x106 = 20x106 / (CPSDVSR * (1 + SCR))
```

In this case, if CPSDVSR=0x2, SCR must be 0x9.

The configuration sequence would be as follows:

- 1. Ensure that the SSE bit in the SSICR1 register is clear.
- 2. Write the **SSICR1** register with a value of 0x0000.0000.
- 3. Write the **SSICPSR** register with a value of 0x0000.0002.
- **4.** Write the **SSICR0** register with a value of 0x0000.09C7.
- 5. The SSI is then enabled by setting the SSE bit in the SSICR1 register.

14.5 Register Map

Table 14-3 on page 666 lists the SSI registers. The offset listed is a hexadecimal increment to the register's address, relative to that SSI module's base address:

SSI0: 0x4000.8000SSI1: 0x4000.9000

Note that the SSI module clock must be enabled before the registers can be programmed (see page 246). There must be a delay of 3 system clocks after the SSI module clock is enabled before any SSI module registers are accessed.

Note: The SSI must be disabled (see the SSE bit in the **SSICR1** register) before any of the control registers are reprogrammed.

Table 14-3. SSI Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	SSICR0	R/W	0x0000.0000	SSI Control 0	668
0x004	SSICR1	R/W	0x0000.0000	SSI Control 1	670
0x008	SSIDR	R/W	0x0000.0000	SSI Data	672
0x00C	SSISR	RO	0x0000.0003	SSI Status	673
0x010	SSICPSR	R/W	0x0000.0000	SSI Clock Prescale	675

Table 14-3. SSI Register Map (continued)

Offset	Name	Type	Reset	Description	See page
0x014	SSIIM	R/W	0x0000.0000	SSI Interrupt Mask	676
0x018	SSIRIS	RO	0x0000.0008	SSI Raw Interrupt Status	677
0x01C	SSIMIS	RO	0x0000.0000	SSI Masked Interrupt Status	679
0x020	SSIICR	W1C	0x0000.0000	SSI Interrupt Clear	681
0x024	SSIDMACTL	R/W	0x0000.0000	SSI DMA Control	682
0xFD0	SSIPeriphID4	RO	0x0000.0000	SSI Peripheral Identification 4	683
0xFD4	SSIPeriphID5	RO	0x0000.0000	SSI Peripheral Identification 5	684
0xFD8	SSIPeriphID6	RO	0x0000.0000	SSI Peripheral Identification 6	685
0xFDC	SSIPeriphID7	RO	0x0000.0000	SSI Peripheral Identification 7	686
0xFE0	SSIPeriphID0	RO	0x0000.0022	SSI Peripheral Identification 0	687
0xFE4	SSIPeriphID1	RO	0x0000.0000	SSI Peripheral Identification 1	688
0xFE8	SSIPeriphID2	RO	0x0000.0018	SSI Peripheral Identification 2	689
0xFEC	SSIPeriphID3	RO	0x0000.0001	SSI Peripheral Identification 3	690
0xFF0	SSIPCelIID0	RO	0x0000.000D	SSI PrimeCell Identification 0	691
0xFF4	SSIPCellID1	RO	0x0000.00F0	SSI PrimeCell Identification 1	692
0xFF8	SSIPCellID2	RO	0x0000.0005	SSI PrimeCell Identification 2	693
0xFFC	SSIPCelIID3	RO	0x0000.00B1	SSI PrimeCell Identification 3	694

14.6 Register Descriptions

The remainder of this section lists and describes the SSI registers, in numerical order by address offset.

Register 1: SSI Control 0 (SSICR0), offset 0x000

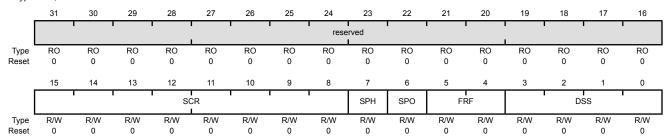
The **SSICR0** register contains bit fields that control various functions within the SSI module. Functionality such as protocol mode, clock rate, and data size are configured in this register.

SSI Control 0 (SSICR0)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x000

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:16	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:8	SCR	R/W	0x00	SSI Serial Clock Rate
				This bit field is used to generate the transmit and receive bit rate of the SSI. The bit rate is: BR=SysClk/(CPSDVSR * (1 + SCR))
				where CPSDVSR is an even value from 2-254 programmed in the SSICPSR register, and SCR is a value from 0-255.
7	SPH	R/W	0	SSI Serial Clock Phase
				This bit is only applicable to the Freescale SPI Format.
				The SPH control bit selects the clock edge that captures data and allows it to change state. This bit has the most impact on the first bit transmitted by either allowing or not allowing a clock transition before the first data capture edge.
				Value Description
				0 Data is captured on the first clock edge transition.
				1 Data is captured on the second clock edge transition.
6	SPO	R/W	0	SSI Serial Clock Polarity

Value Description

- 0 A steady state Low value is placed on the SSIClk pin.
- A steady state High value is placed on the SSIClk pin when data is not being transferred.

Bit/Field	Name	Туре	Reset	Description
5:4	FRF	R/W	0x0	SSI Frame Format Select
				Value Frame Format 0x0 Freescale SPI Frame Format 0x1 Texas Instruments Synchronous Serial Frame Format 0x2 MICROWIRE Frame Format 0x3 Reserved
3:0	DSS	R/W	0x0	SSI Data Size Select
				Value Data Size
				0x0-0x2 Reserved
				0x3 4-bit data
				0x4 5-bit data
				0x5 6-bit data
				0x6 7-bit data
				0x7 8-bit data
				0x8 9-bit data
				0x9 10-bit data
				0xA 11-bit data
				0xB 12-bit data
				0xC 13-bit data
				0xD 14-bit data
				0xE 15-bit data
				0xF 16-bit data

Register 2: SSI Control 1 (SSICR1), offset 0x004

The **SSICR1** register contains bit fields that control various functions within the SSI module. Master and slave mode functionality is controlled by this register.

SSI Control 1 (SSICR1)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x004

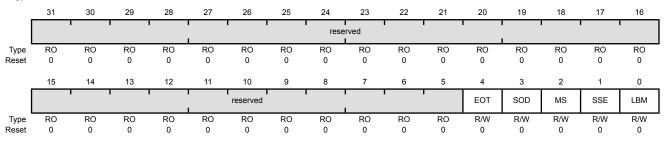
Bit/Field

3

Name

SOD

Type R/W, reset 0x0000.0000



31:5	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	EOT	R/W	0	End of Transmission

Description

Reset

0

Type

R/W

Value Description

- The TXRIS interrupt indicates that the transmit FIFO is half full or less.
- 1 The End of Transmit interrupt mode for the TXRIS interrupt is enabled.
- This bit is relevant only in the Slave mode (MS=1). In multiple-slave systems, it is possible for the SSI master to broadcast a message to all slaves in the system while ensuring that only one slave drives data onto

slaves in the system while ensuring that only one slave drives data onto the serial output line. In such systems, the TXD lines from multiple slaves could be tied together. To operate in such a system, the SOD bit can be configured so that the SSI slave does not drive the SSITX pin.

Value Description

SSI Slave Mode Output Disable

- 0 SSI can drive the SSITx output in Slave mode.
- 1 SSI must not drive the SSITx output in Slave mode.

2 MS R/W 0 SSI Master/Slave Select This bit selects Master or Slave mode and can be modified only when

the SSI is disabled (SSE=0).

Value Description

- 0 The SSI is configured as a master.
- 1 The SSI is configured as a slave.

Bit/Field	Name	Туре	Reset	Description
1	SSE	R/W	0	SSI Synchronous Serial Port Enable
				Value Description
				0 SSI operation is disabled.
				1 SSI operation is enabled.
				Note: This bit must be cleared before any control registers are reprogrammed.
0	LBM	R/W	0	SSI Loopback Mode
				Value Description
				0 Normal serial port operation enabled.
				Output of the transmit serial shift register is connected internally to the input of the receive serial shift register.

Register 3: SSI Data (SSIDR), offset 0x008

Important: This register is read-sensitive. See the register description for details.

The **SSIDR** register is 16-bits wide. When the **SSIDR** register is read, the entry in the receive FIFO that is pointed to by the current FIFO read pointer is accessed. When a data value is removed by the SSI receive logic from the incoming data frame, it is placed into the entry in the receive FIFO pointed to by the current FIFO write pointer.

When the **SSIDR** register is written to, the entry in the transmit FIFO that is pointed to by the write pointer is written to. Data values are removed from the transmit FIFO one value at a time by the transmit logic. Each data value is loaded into the transmit serial shifter, then serially shifted out onto the SSITX pin at the programmed bit rate.

When a data size of less than 16 bits is selected, the user must right-justify data written to the transmit FIFO. The transmit logic ignores the unused bits. Received data less than 16 bits is automatically right-justified in the receive buffer.

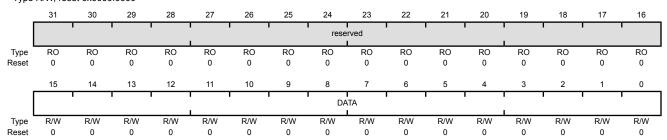
When the SSI is programmed for MICROWIRE frame format, the default size for transmit data is eight bits (the most significant byte is ignored). The receive data size is controlled by the programmer. The transmit FIFO and the receive FIFO are not cleared even when the SSE bit in the **SSICR1** register is cleared, allowing the software to fill the transmit FIFO before enabling the SSI.

SSI Data (SSIDR)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x008

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:16	reserved	RO	0x0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:0	DATA	R/W	0x0000	SSI Receive/Transmit Data

A read operation reads the receive FIFO. A write operation writes the transmit FIFO.

Software must right-justify data when the SSI is programmed for a data size that is less than 16 bits. Unused bits at the top are ignored by the transmit logic. The receive logic automatically right-justifies the data.

Register 4: SSI Status (SSISR), offset 0x00C

The **SSISR** register contains bits that indicate the FIFO fill status and the SSI busy status.

SSI Status (SSISR) SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offse	t 0x00C RO, reset															
	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	1		1	•		1	1 1	rese	rved	1	1	1		1		1
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	'		•	•		reserve	ed		!	'	'	BSY	RFF	RNE	TNF	TFE
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 1	RO 1
В	sit/Field		Nam	ne	Ту	pe	Reset	Des	cription							
	31:5		reserv	ved	R	0	0x0000.00	com	patibility	with fut	ure prod		value of	erved bit a reserv on.		
	4		BS	Y	R	O	0	SSI	Busy Bit	t						
								Val	ue Desc	ription						
								0	The	SSI is idl	le.					
								1				ransmitti not empt		or receivi	ng a frar	ne, or
	3		RFI	F	R	.0	0	SSI	Receive	FIFO F	ull					
								Val	ue Desc	cription						
								0	The	receive F	FIFO is r	not full.				
								1	The	receive F	FIFO is f	ull.				
	2		RNI	E	R	.0	0	SSI	Receive	FIFO N	ot Empt	y				
								Val	ue Desc	cription						
								0	The	receive F	FIFO is 6	empty.				
								1	The	receive F	FIFO is r	not empt	y.			
	1		TNI	F	R	.O	1	SSI	Transmi	t FIFO N	lot Full					
								Val	ue Desc	cription						
								0		transmit	FIFO is	full.				

The transmit FIFO is not full.

Bit/Field	Name	Туре	Reset	Description
0	TFE	RO	1	SSI Transmit FIFO Empty
				Value Description
				0 The transmit FIFO is not empty.
				1 The transmit FIFO is empty.

Register 5: SSI Clock Prescale (SSICPSR), offset 0x010

The **SSICPSR** register specifies the division factor which is used to derive the SSIC1k from the system clock. The clock is further divided by a value from 1 to 256, which is 1 + SCR. SCR is programmed in the **SSICR0** register. The frequency of the SSIC1k is defined by:

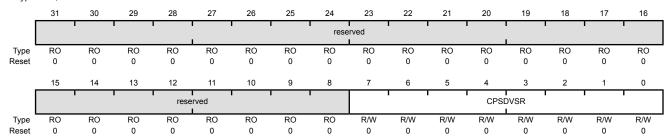
$$SSIClk = SysClk / (CPSDVSR * (1 + SCR))$$

The value programmed into this register must be an even number between 2 and 254. The least-significant bit of the programmed number is hard-coded to zero. If an odd number is written to this register, data read back from this register has the least-significant bit as zero.

SSI Clock Prescale (SSICPSR)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x010 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CPSDVSR	R/W	0x00	SSI Clock Prescale Divisor

This value must be an even number from 2 to 254, depending on the frequency of ${\tt SSIClk}.$ The LSB always returns 0 on reads.

Register 6: SSI Interrupt Mask (SSIIM), offset 0x014

The **SSIIM** register is the interrupt mask set or clear register. It is a read/write register and all bits are cleared on reset.

On a read, this register gives the current value of the mask on the corresponding interrupt. Setting a bit sets the mask, preventing the interrupt from being signaled to the interrupt controller. Clearing a bit clears the corresponding mask, enabling the interrupt to be sent to the interrupt controller.

21

20

19

18

17

16

SSI Interrupt Mask (SSIIM)

28

RTIM

27

26

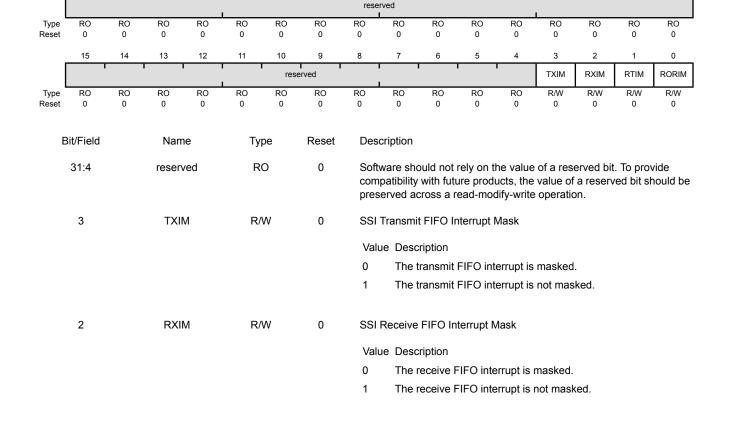
25

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x014

31

Type R/W, reset 0x0000.0000



Value Description

0 The receive FIFO time-out interrupt is masked.

SSI Receive Time-Out Interrupt Mask

- 1 The receive FIFO time-out interrupt is not masked.
- 0 RORIM R/W 0 SSI Receive Overrun Interrupt Mask

0

R/W

Value Description

- 0 The receive FIFO overrun interrupt is masked.
- 1 The receive FIFO overrun interrupt is not masked.

Register 7: SSI Raw Interrupt Status (SSIRIS), offset 0x018

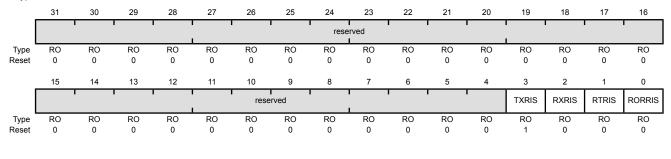
The **SSIRIS** register is the raw interrupt status register. On a read, this register gives the current raw status value of the corresponding interrupt prior to masking. A write has no effect.

SSI Raw Interrupt Status (SSIRIS)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x018

Type RO, reset 0x0000.0008



Bit/Field	Name	Type	Reset	Description
31:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	TXRIS	RO	1	SSI Transmit FIFO Raw Interrupt Status
				Value Description

- 0 No interrupt.
- 1 If the EOT bit in the SSICR1 register is clear, the transmit FIFO is half empty or less.

If the EOT bit is set, the transmit FIFO is empty, and the last bit has been transmitted out of the serializer.

This bit is cleared when the transmit FIFO is more than half full (if the EOT bit is clear) or when it has any data in it (if the EOT bit is set).

2 **RXRIS** RO 0 SSI Receive FIFO Raw Interrupt Status Value Description

> No interrupt. 1 The receive FIFO is half full or more.

This bit is cleared when the receive FIFO is less than half full.

RTRIS RO 0 SSI Receive Time-Out Raw Interrupt Status

0

Value Description

- 0 No interrupt.
- The receive time-out has occurred.

This bit is cleared when a 1 is written to the RTIC bit in the SSI Interrupt Clear (SSIICR) register.

Bit/Field	Name	Туре	Reset	Description
0	RORRIS	RO	0	SSI Receive Overrun Raw Interrupt Status
				Value Description
				0 No interrupt.
				1 The receive FIFO has overflowed
				This bit is cleared when a 1 is written to the RORIC bit in the SSI Interrupt Clear (SSIICR) register.

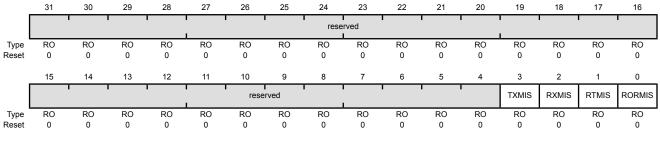
Register 8: SSI Masked Interrupt Status (SSIMIS), offset 0x01C

The **SSIMIS** register is the masked interrupt status register. On a read, this register gives the current masked status value of the corresponding interrupt. A write has no effect.

SSI Masked Interrupt Status (SSIMIS)

SSI0 base: 0x4000.8000 SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0x01C

Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	TXMIS	RO	0	SSI Transmit FIFO Masked Interrupt Status
				Value Description
				0 An interrupt has not occurred or is masked.
				An unmasked interrupt was signaled due to the transmit FIFO being half empty or less (if the EOT bit is clear) or due to the transmission of the last data bit (if the EOT bit is set).
				This bit is cleared when the transmit FIFO is more than half empty (if the ${\tt EOT}$ bit is clear) or when it has any data in it (if the ${\tt EOT}$ bit is set).
2	RXMIS	RO	0	SSI Receive FIFO Masked Interrupt Status
				Value Description
				O An interrupt has not occurred or is masked.
				An unmasked interrupt was signaled due to the receive FIFO being half full or more.
				This bit is cleared when the receive FIFO is less than half full.
1	RTMIS	RO	0	SSI Receive Time-Out Masked Interrupt Status
				Value Description

Value Description

- 0 An interrupt has not occurred or is masked.
- 1 An unmasked interrupt was signaled due to the receive time

This bit is cleared when a 1 is written to the RTIC bit in the SSI Interrupt Clear (SSIICR) register.

Bit/Field	Name	Type	Reset	Description
0	RORMIS	RO	0	SSI Receive Overrun Masked Interrupt Status
				Value Description
				0 An interrupt has not occurred or is masked.
				An unmasked interrupt was signaled due to the receive FIFO overflowing.
				This bit is cleared when a 1 is written to the RORIC bit in the SSI Interrupt Clear (SSIICR) register.

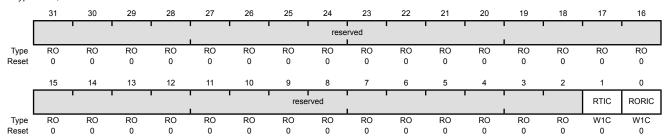
Register 9: SSI Interrupt Clear (SSIICR), offset 0x020

The **SSIICR** register is the interrupt clear register. On a write of 1, the corresponding interrupt is cleared. A write of 0 has no effect.

SSI Interrupt Clear (SSIICR)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0x020

Type W1C, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	RTIC	W1C	0	SSI Receive Time-Out Interrupt Clear
				Writing a 1 to this bit clears the RTRIS bit in the SSIRIS register and the RTMIS bit in the SSIMIS register.
0	RORIC	W1C	0	SSI Receive Overrun Interrupt Clear
				Writing a 1 to this bit clears the RORRIS bit in the SSIRIS register and the RORMIS bit in the SSIMIS register.

Register 10: SSI DMA Control (SSIDMACTL), offset 0x024

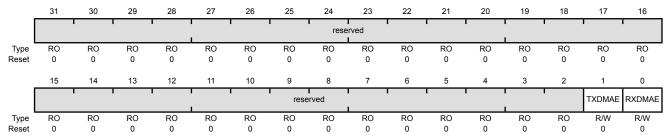
The **SSIDMACTL** register is the μ DMA control register.

SSI DMA Control (SSIDMACTL)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x024

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:2	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	TXDMAE	R/W	0	Transmit DMA Enable
				Value Description 0 μDMA for the transmit FIFO is disabled.
				1 μ DMA for the transmit FIFO is enabled.
0	RXDMAE	R/W	0	Receive DMA Enable

Value Description

0 μDMA for the receive FIFO is disabled.

1 μDMA for the receive FIFO is enabled.

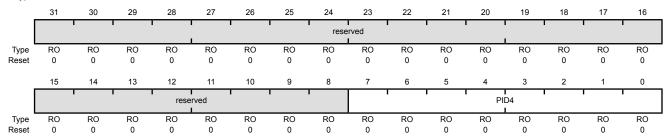
Register 11: SSI Peripheral Identification 4 (SSIPeriphID4), offset 0xFD0

The SSIPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 4 (SSIPeriphID4)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFD0

Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID4	RO	0x00	SSI Peripheral ID Register [7:0] Can be used by software to identify the presence of this peripheral.

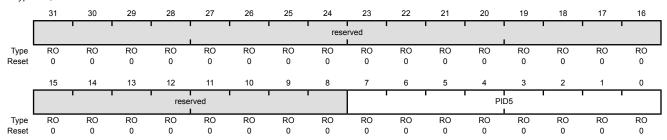
Register 12: SSI Peripheral Identification 5 (SSIPeriphID5), offset 0xFD4

The SSIPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 5 (SSIPeriphID5)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFD4

Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID5	RO	0x00	SSI Peripheral ID Register [15:8]

Can be used by software to identify the presence of this peripheral.

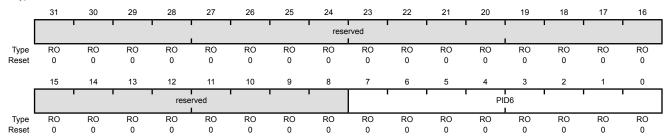
Register 13: SSI Peripheral Identification 6 (SSIPeriphID6), offset 0xFD8

The SSIPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 6 (SSIPeriphID6)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFD8

Type RO, reset 0x0000.0000



RO		
RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
RO	0x00	SSI Peripheral ID Register [23:16]

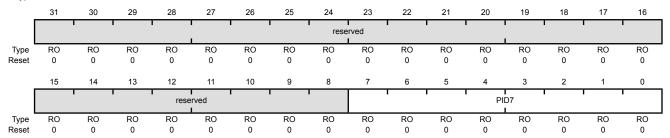
Register 14: SSI Peripheral Identification 7 (SSIPeriphID7), offset 0xFDC

The SSIPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 7 (SSIPeriphID7)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFDC

Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID7	RO	0x00	SSI Peripheral ID Register [31:24]

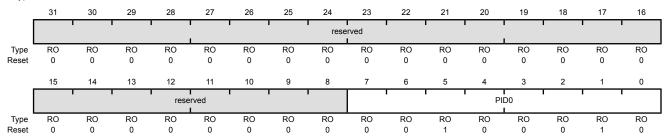
Register 15: SSI Peripheral Identification 0 (SSIPeriphID0), offset 0xFE0

The SSIPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 0 (SSIPeriphID0)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFE0

Type RO, reset 0x0000.0022



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID0	RO	0x22	SSI Peripheral ID Register [7:0]

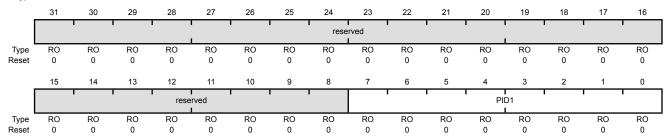
Register 16: SSI Peripheral Identification 1 (SSIPeriphID1), offset 0xFE4

The SSIPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 1 (SSIPeriphID1)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFE4

Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID1	RO	0x00	SSI Peripheral ID Register [15:8]

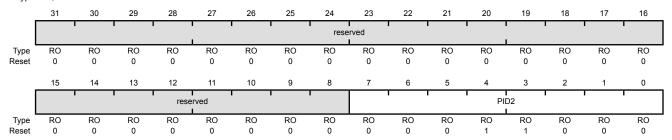
Register 17: SSI Peripheral Identification 2 (SSIPeriphID2), offset 0xFE8

The SSIPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 2 (SSIPeriphID2)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFE8

Type RO, reset 0x0000.0018



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID2	RO	0x18	SSI Peripheral ID Register [23:16]

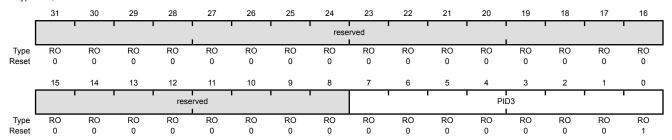
Register 18: SSI Peripheral Identification 3 (SSIPeriphID3), offset 0xFEC

The SSIPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 3 (SSIPeriphID3)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFEC

Type RO, reset 0x0000.0001



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID3	RO	0x01	SSI Peripheral ID Register [31:24]

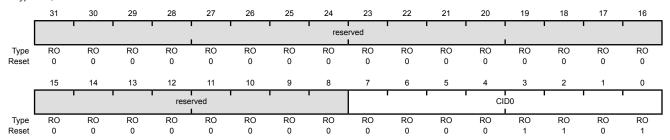
Register 19: SSI PrimeCell Identification 0 (SSIPCellID0), offset 0xFF0

The SSIPCeIIIDn registers are hard-coded, and the fields within the register determine the reset value.

SSI PrimeCell Identification 0 (SSIPCellID0)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFF0

Type RO, reset 0x0000.000D



Bit/Field	Name	туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID0	RO	0x0D	SSI PrimeCell ID Register [7:0]

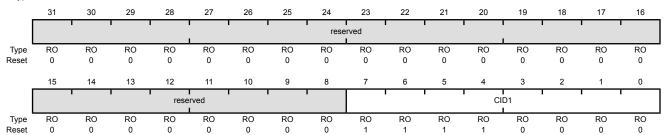
Register 20: SSI PrimeCell Identification 1 (SSIPCellID1), offset 0xFF4

The SSIPCeIIIDn registers are hard-coded, and the fields within the register determine the reset value.

SSI PrimeCell Identification 1 (SSIPCelIID1)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFF4

Type RO, reset 0x0000.00F0



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID1	RO	0xF0	SSI PrimeCell ID Register [15:8]

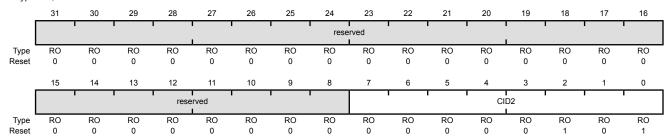
Register 21: SSI PrimeCell Identification 2 (SSIPCellID2), offset 0xFF8

The SSIPCeIIIDn registers are hard-coded, and the fields within the register determine the reset value.

SSI PrimeCell Identification 2 (SSIPCelIID2)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFF8

Type RO, reset 0x0000.0005



Bit/Field	Name	туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID2	RO	0x05	SSI PrimeCell ID Register [23:16]

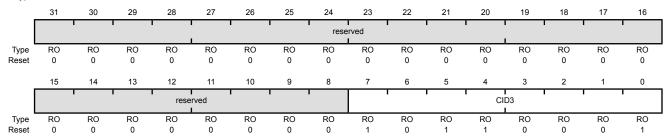
Register 22: SSI PrimeCell Identification 3 (SSIPCelIID3), offset 0xFFC

The SSIPCeIIIDn registers are hard-coded, and the fields within the register determine the reset value.

SSI PrimeCell Identification 3 (SSIPCelIID3)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFFC

Type RO, reset 0x0000.00B1



Bit/Field	Name	туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID3	RO	0xB1	SSI PrimeCell ID Register [31:24]

15 Inter-Integrated Circuit (I²C) Interface

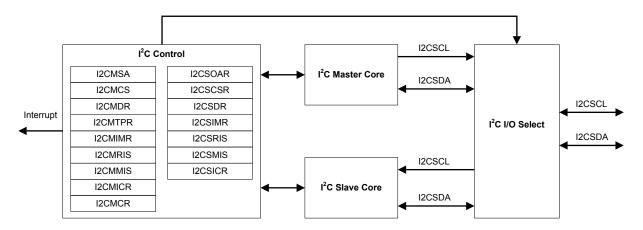
The Inter-Integrated Circuit (I²C) bus provides bi-directional data transfer through a two-wire design (a serial data line SDA and a serial clock line SCL), and interfaces to external I²C devices such as serial memory (RAMs and ROMs), networking devices, LCDs, tone generators, and so on. The I²C bus may also be used for system testing and diagnostic purposes in product development and manufacture. The LM3S1J11 microcontroller includes two I²C modules, providing the ability to interact (both transmit and receive) with other I²C devices on the bus.

The Stellaris[®] LM3S1J11 controller includes two I²C modules with the following features:

- Devices on the I²C bus can be designated as either a master or a slave
 - Supports both transmitting and receiving data as either a master or a slave
 - Supports simultaneous master and slave operation
- Four I²C modes
 - Master transmit
 - Master receive
 - Slave transmit
 - Slave receive
- Two transmission speeds: Standard (100 Kbps) and Fast (400 Kbps)
- Master and slave interrupt generation
 - Master generates interrupts when a transmit or receive operation completes (or aborts due to an error)
 - Slave generates interrupts when data has been transferred or requested by a master or when a START or STOP condition is detected
- Master with arbitration and clock synchronization, multimaster support, and 7-bit addressing mode

15.1 Block Diagram

Figure 15-1. I²C Block Diagram



15.2 Signal Description

The following table lists the external signals of the I^2C interface and describes the function of each. The I^2C interface signals are alternate functions for some GPIO signals and default to be GPIO signals at reset., with the exception of the I2COSCL and I2CSDA pins which default to the I^2C function. The column in the table below titled "Pin Mux/Pin Assignment" lists the possible GPIO pin placements for the I^2C signals. The AFSEL bit in the **GPIO Alternate Function Select (GPIOAFSEL)** register (page 412) should be set to choose the I^2C function. The number in parentheses is the encoding that must be programmed into the PMCn field in the **GPIO Port Control (GPIOPCTL)** register (page 430) to assign the I^2C signal to the specified GPIO port pin. Note that the I^2C pins should be set to open drain using the **GPIO Open Drain Select (GPIOODR)** register. For more information on configuring GPIOs, see "General-Purpose Input/Outputs (GPIOs)" on page 389.

Table 15-1. I2C Signals (100LQFP)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
I2C0SCL	72	PB2 (1)	I/O	OD	I ² C module 0 clock.
I2C0SDA	65	PB3 (1)	I/O	OD	I ² C module 0 data.
I2C1SCL	14 19 26 34	PJ0 (11) PG0 (3) PA0 (8) PA6 (1)	I/O	OD	I ² C module 1 clock.
I2C1SDA	18 27 35 87	PG1 (3) PA1 (8) PA7 (1) PJ1 (11)	I/O	OD	I ² C module 1 data.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

Table 15-2. I2C Signals (108BGA)

Pin Name	Pin Number	Pin Mux / Pin Assignment		Buffer Type ^a	Description
I2C0SCL	A11	PB2 (1)	I/O	OD	I ² C module 0 clock.

Pin Name Pin Number | Pin Mux / Pin Buffer Type^a Description Pin Type **Assignment** I2C0SDA E11 PB3 (1) I/O OD I²C module 0 data. I2C1SCL F3 PJ0 (11) I/O OD I²C module 1 clock. K1 PG0 (3) PA0 (8) L3 L6 PA6 (1) I²C module 1 data K2 PG1 (3) I/O OD T2C1SDA М3 PA1 (8) PA7 (1) M6 PJ1 (11)

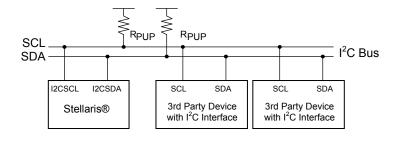
Table 15-2. I2C Signals (108BGA) (continued)

15.3 Functional Description

Each I²C module is comprised of both master and slave functions. For proper operation, the SDA and SCL pins must be configured as open-drain signals. A typical I²C bus configuration is shown in Figure 15-2.

See "Inter-Integrated Circuit (I²C) Interface" on page 811 for I²C timing diagrams.

Figure 15-2. I²C Bus Configuration



15.3.1 I²C Bus Functional Overview

The I^2C bus uses only two signals: SDA and SCL, named <code>I2CSDA</code> and <code>I2CSCL</code> on Stellaris microcontrollers. SDA is the bi-directional serial data line and SCL is the bi-directional serial clock line. The bus is considered idle when both lines are High.

Every transaction on the I²C bus is nine bits long, consisting of eight data bits and a single acknowledge bit. The number of bytes per transfer (defined as the time between a valid START and STOP condition, described in "START and STOP Conditions" on page 697) is unrestricted, but each byte has to be followed by an acknowledge bit, and data must be transferred MSB first. When a receiver cannot receive another complete byte, it can hold the clock line SCL Low and force the transmitter into a wait state. The data transfer continues when the receiver releases the clock SCL.

15.3.1.1 START and STOP Conditions

The protocol of the I²C bus defines two states to begin and end a transaction: START and STOP. A High-to-Low transition on the SDA line while the SCL is High is defined as a START condition, and a Low-to-High transition on the SDA line while SCL is High is defined as a STOP condition. The bus is considered busy after a START condition and free after a STOP condition. See Figure 15-3.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

Figure 15-3. START and STOP Conditions



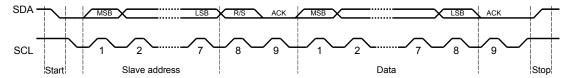
The STOP bit determines if the cycle stops at the end of the data cycle or continues on to a repeated START condition. To generate a single transmit cycle, the I^2C Master Slave Address (I2CMSA) register is written with the desired address, the R/S bit is cleared, and the Control register is written with ACK=X (0 or 1), STOP=1, START=1, and RUN=1 to perform the operation and stop. When the operation is completed (or aborted due an error), the interrupt pin becomes active and the data may be read from the I^2C Master Data (I2CMDR) register. When the I^2C module operates in Master receiver mode, the ACK bit is normally set causing the I^2C bus controller to transmit an acknowledge automatically after each byte. This bit must be cleared when the I^2C bus controller requires no further data to be transmitted from the slave transmitter.

When operating in slave mode, two bits in the I²C Slave Raw Interrupt Status (I2CSRIS) register indicate detection of start and stop conditions on the bus; while two bits in the I²C Slave Masked Interrupt Status (I2CSMIS) register allow start and stop conditions to be promoted to controller interrupts (when interrupts are enabled).

15.3.1.2 Data Format with 7-Bit Address

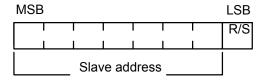
Data transfers follow the format shown in Figure 15-4. After the START condition, a slave address is transmitted. This address is 7-bits long followed by an eighth bit, which is a data direction bit (\mathbb{R}/\mathbb{S} bit in the **I2CMSA** register). If the \mathbb{R}/\mathbb{S} bit is clear, it indicates a transmit operation (send), and if it is set, it indicates a request for data (receive). A data transfer is always terminated by a STOP condition generated by the master, however, a master can initiate communications with another device on the bus by generating a repeated START condition and addressing another slave without first generating a STOP condition. Various combinations of receive/transmit formats are then possible within a single transfer.

Figure 15-4. Complete Data Transfer with a 7-Bit Address



The first seven bits of the first byte make up the slave address (see Figure 15-5). The eighth bit determines the direction of the message. A zero in the R/S position of the first byte means that the master transmits (sends) data to the selected slave, and a one in this position means that the master receives data from the slave.

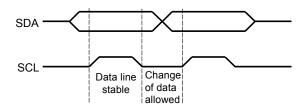
Figure 15-5. R/S Bit in First Byte



15.3.1.3 Data Validity

The data on the SDA line must be stable during the high period of the clock, and the data line can only change when SCL is Low (see Figure 15-6).

Figure 15-6. Data Validity During Bit Transfer on the I²C Bus



15.3.1.4 Acknowledge

All bus transactions have a required acknowledge clock cycle that is generated by the master. During the acknowledge cycle, the transmitter (which can be the master or slave) releases the SDA line. To acknowledge the transaction, the receiver must pull down SDA during the acknowledge clock cycle. The data transmitted out by the receiver during the acknowledge cycle must comply with the data validity requirements described in "Data Validity" on page 699.

When a slave receiver does not acknowledge the slave address, SDA must be left High by the slave so that the master can generate a STOP condition and abort the current transfer. If the master device is acting as a receiver during a transfer, it is responsible for acknowledging each transfer made by the slave. Because the master controls the number of bytes in the transfer, it signals the end of data to the slave transmitter by not generating an acknowledge on the last data byte. The slave transmitter must then release SDA to allow the master to generate the STOP or a repeated START condition.

15.3.1.5 Arbitration

A master may start a transfer only if the bus is idle. It's possible for two or more masters to generate a START condition within minimum hold time of the START condition. In these situations, an arbitration scheme takes place on the SDA line, while SCL is High. During arbitration, the first of the competing master devices to place a '1' (High) on SDA while another master transmits a '0' (Low) switches off its data output stage and retires until the bus is idle again.

Arbitration can take place over several bits. Its first stage is a comparison of address bits, and if both masters are trying to address the same device, arbitration continues on to the comparison of data bits.

15.3.2 Available Speed Modes

The I^2C bus can run in either Standard mode (100 kbps) or Fast mode (400 kbps). The selected mode should match the speed of the other I^2C devices on the bus.

15.3.2.1 Standard and Fast Modes

Standard and Fast modes are selected using a value in the I²C Master Timer Period (I2CMTPR) register that results in an SCL frequency of 100 kbps for Standard mode.

The I²C clock rate is determined by the parameters *CLK_PRD*, *TIMER_PRD*, *SCL_LP*, and *SCL_HP* where:

CLK_PRD is the system clock period

SCL_LP is the low phase of SCL (fixed at 6)

SCL_HP is the high phase of SCL (fixed at 4)

TIMER_PRD is the programmed value in the **I2CMTPR** register (see page 719).

The I²C clock period is calculated as follows:

For example:

 $CLK_PRD = 50 \text{ ns}$

TIMER PRD = 2

SCL_LP=6

SCL HP=4

yields a SCL frequency of:

1/SCL PERIOD = 333 Khz

Table 15-3 gives examples of the timer periods that should be used to generate SCL frequencies based on various system clock frequencies.

Table 15-3. Examples of I²C Master Timer Period versus Speed Mode

System Clock	Timer Period	Standard Mode	Timer Period	Fast Mode
4 MHz	0x01	100 Kbps	-	-
6 MHz	0x02	100 Kbps	-	-
12.5 MHz	0x06	89 Kbps	0x01	312 Kbps
16.7 MHz	0x08	93 Kbps	0x02	278 Kbps
20 MHz	0x09	100 Kbps	0x02	333 Kbps
25 MHz	0x0C	96.2 Kbps	0x03	312 Kbps
33 MHz	0x10	97.1 Kbps	0x04	330 Kbps
40 MHz	0x13	100 Kbps	0x04	400 Kbps
50 MHz	0x18	100 Kbps	0x06	357 Kbps

15.3.3 Interrupts

The I²C can generate interrupts when the following conditions are observed:

- Master transaction completed
- Master arbitration lost
- Master transaction error

- Slave transaction received
- Slave transaction requested
- Stop condition on bus detected
- Start condition on bus detected

The I²C master and I²C slave modules have separate interrupt signals. While both modules can generate interrupts for multiple conditions, only a single interrupt signal is sent to the interrupt controller.

15.3.3.1 I²C Master Interrupts

The I^2C master module generates an interrupt when a transaction completes (either transmit or receive), when arbitration is lost, or when an error occurs during a transaction. To enable the I^2C master interrupt, software must set the IM bit in the I^2C Master Interrupt Mask (I2CMIMR) register. When an interrupt condition is met, software must check the ERROR and ARBLST bits in the I^2C Master Control/Status (I2CMCS) register to verify that an error didn't occur during the last transaction and to ensure that arbitration has not been lost. An error condition is asserted if the last transaction wasn't acknowledged by the slave. If an error is not detected and the master has not lost arbitration, the application can proceed with the transfer. The interrupt is cleared by writing a 1 to the IC bit in the I^2C Master Interrupt Clear (I2CMICR) register.

If the application doesn't require the use of interrupts, the raw interrupt status is always visible via the **I**²**C Master Raw Interrupt Status (I2CMRIS)** register.

15.3.3.2 I²C Slave Interrupts

The slave module can generate an interrupt when data has been received or requested. This interrupt is enabled by setting the DATAIM bit in the I^2C Slave Interrupt Mask (I2CSIMR) register. Software determines whether the module should write (transmit) or read (receive) data from the I^2C Slave Data (I2CSDR) register, by checking the RREQ and TREQ bits of the I^2C Slave Control/Status (I2CSCSR) register. If the slave module is in receive mode and the first byte of a transfer is received, the FBR bit is set along with the RREQ bit. The interrupt is cleared by setting the DATAIC bit in the I^2C Slave Interrupt Clear (I2CSICR) register.

In addition, the slave module can generate an interrupt when a start and stop condition is detected. These interrupts are enabled by setting the STARTIM and STOPIM bits of the I²C Slave Interrupt Mask (I2CSIMR) register and cleared by writing a 1 to the STOPIC and STARTIC bits of the I²C Slave Interrupt Clear (I2CSICR) register.

If the application doesn't require the use of interrupts, the raw interrupt status is always visible via the I²C Slave Raw Interrupt Status (I2CSRIS) register.

15.3.4 Loopback Operation

The I^2C modules can be placed into an internal loopback mode for diagnostic or debug work by setting the LPBK bit in the I^2C Master Configuration (I2CMCR) register. In loopback mode, the SDA and SCL signals from the master and slave modules are tied together.

15.3.5 Command Sequence Flow Charts

This section details the steps required to perform the various I²C transfer types in both master and slave mode.

15.3.5.1 I²C Master Command Sequences

The figures that follow show the command sequences available for the I^2C master.

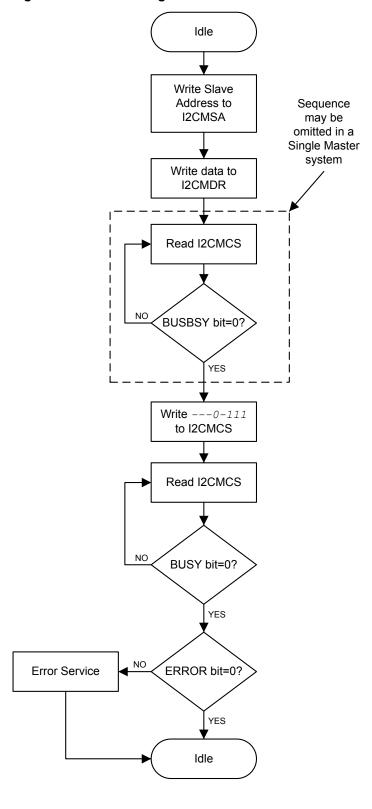


Figure 15-7. Master Single TRANSMIT

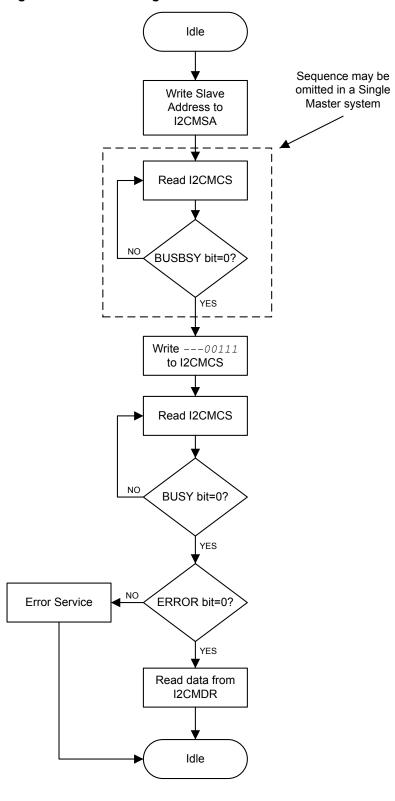


Figure 15-8. Master Single RECEIVE

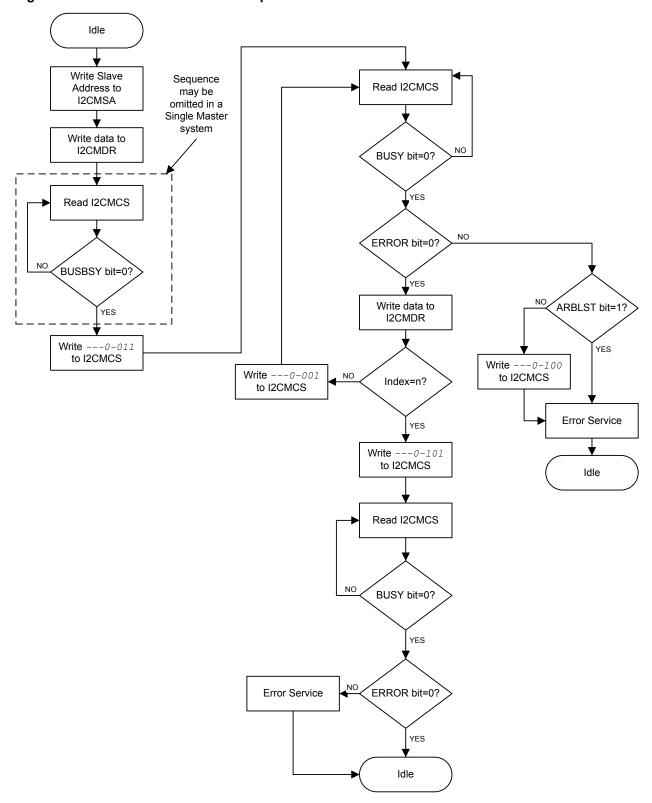


Figure 15-9. Master TRANSMIT with Repeated START

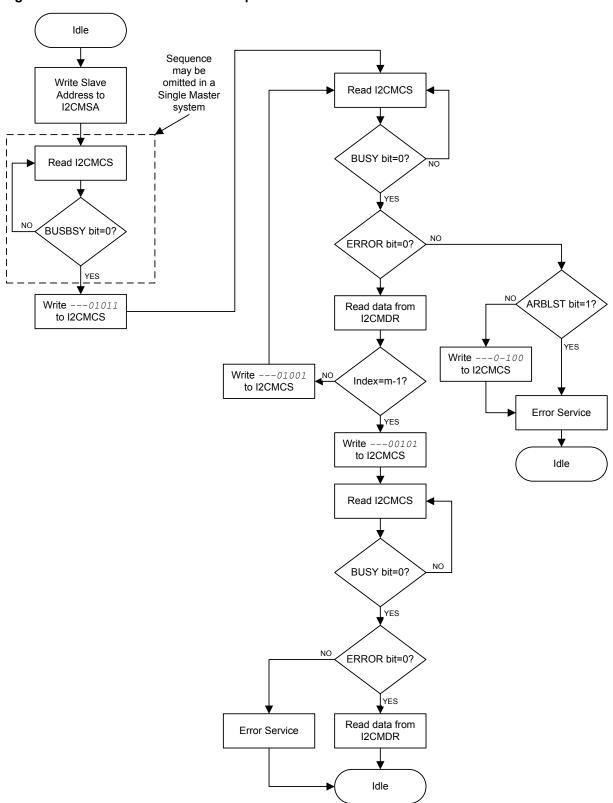


Figure 15-10. Master RECEIVE with Repeated START

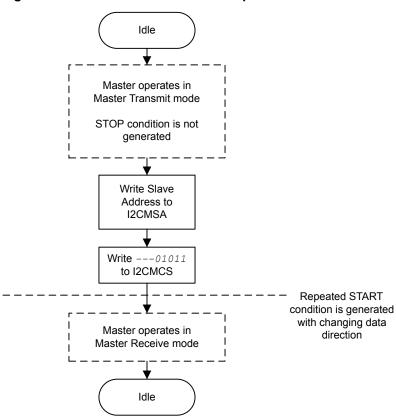


Figure 15-11. Master RECEIVE with Repeated START after TRANSMIT with Repeated START

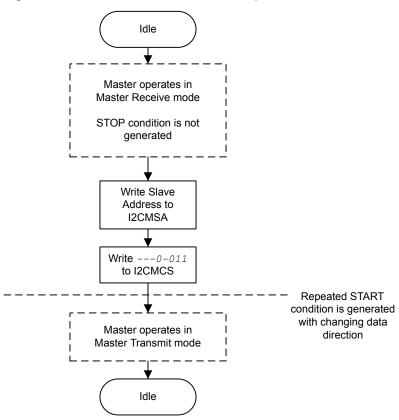


Figure 15-12. Master TRANSMIT with Repeated START after RECEIVE with Repeated START

15.3.5.2 I²C Slave Command Sequences

Figure 15-13 on page 709 presents the command sequence available for the I²C slave.

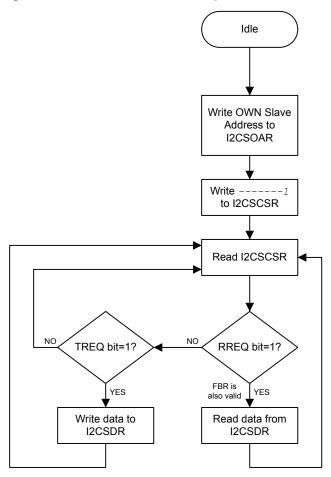


Figure 15-13. Slave Command Sequence

15.4 Initialization and Configuration

The following example shows how to configure the I^2C module to transmit a single byte as a master. This assumes the system clock is 20 MHz.

- **1.** Enable the I²C clock by writing a value of 0x0000.1000 to the **RCGC1** register in the System Control module (see page 246).
- 2. Enable the clock to the appropriate GPIO module via the RCGC2 register in the System Control module (see page 255). To find out which GPIO port to enable, refer to Table 18-5 on page 767.
- 3. In the GPIO module, enable the appropriate pins for their alternate function using the **GPIOAFSEL** register (see page 412). To determine which GPIOs to configure, see Table 18-4 on page 762.
- **4.** Enable the I²C pins for open-drain operation. See page 417.
- **5.** Configure the PMCn fields in the **GPIOPCTL** register to assign the I²C signals to the appropriate pins. See page 430 and Table 18-5 on page 767.
- **6.** Initialize the I²C Master by writing the **I2CMCR** register with a value of 0x0000.0010.

7. Set the desired SCL clock speed of 100 Kbps by writing the **I2CMTPR** register with the correct value. The value written to the **I2CMTPR** register represents the number of system clock periods in one SCL clock period. The TPR value is determined by the following equation:

```
TPR = (System Clock/(2*(SCL_LP + SCL_HP)*SCL_CLK))-1;
TPR = (20MHz/(2*(6+4)*100000))-1;
TPR = 9
```

Write the **I2CMTPR** register with the value of 0x0000.0009.

- **8.** Specify the slave address of the master and that the next operation is a Transmit by writing the **I2CMSA** register with a value of 0x0000.0076. This sets the slave address to 0x3B.
- **9.** Place data (byte) to be transmitted in the data register by writing the **I2CMDR** register with the desired data.
- **10.** Initiate a single byte transmit of the data from Master to Slave by writing the **I2CMCS** register with a value of 0x0000.0007 (STOP, START, RUN).
- **11.** Wait until the transmission completes by polling the **I2CMCS** register's BUSBSY bit until it has been cleared.
- 12. Check the ERROR bit in the I2CMCS register to confirm the transmit was acknowledged.

15.5 Register Map

Table 15-4 on page 710 lists the I²C registers. All addresses given are relative to the I²C base address:

I²C 0: 0x4002.0000
 I²C 1: 0x4002.1000

Note that the I²C module clock must be enabled before the registers can be programmed (see page 246). There must be a delay of 3 system clocks after the I²C module clock is enabled before any I²C module registers are accessed.

The hw_i2c.h file in the StellarisWare[®] Driver Library uses a base address of 0x800 for the I²C slave registers. Be aware when using registers with offsets between 0x800 and 0x818 that StellarisWare uses an offset between 0x000 and 0x018 with the slave base address.

Table 15-4. Inter-Integrated Circuit (I²C) Interface Register Map

Offset	Name	Туре	Reset	Description	See page
I ² C Maste	r				'
0x000	I2CMSA	R/W	0x0000.0000	I2C Master Slave Address	712
0x004	I2CMCS	R/W	0x0000.0020	I2C Master Control/Status	713
0x008	I2CMDR	R/W	0x0000.0000	I2C Master Data	718
0x00C	I2CMTPR	R/W	0x0000.0001	I2C Master Timer Period	719
0x010	I2CMIMR	R/W	0x0000.0000	I2C Master Interrupt Mask	720
0x014	I2CMRIS	RO	0x0000.0000	I2C Master Raw Interrupt Status	721

Table 15-4. Inter-Integrated Circuit (I²C) Interface Register Map (continued)

Offset	Name	Туре	Reset	Description	See page
0x018	I2CMMIS	RO	0x0000.0000	I2C Master Masked Interrupt Status	722
0x01C	I2CMICR	WO	0x0000.0000	I2C Master Interrupt Clear	723
0x020	I2CMCR	R/W	0x0000.0000	I2C Master Configuration	724
I ² C Slave					<u>'</u>
0x800	I2CSOAR	R/W	0x0000.0000	I2C Slave Own Address	725
0x804	I2CSCSR	RO	0x0000.0000	I2C Slave Control/Status	726
0x808	I2CSDR	R/W	0x0000.0000	I2C Slave Data	728
0x80C	I2CSIMR	R/W	0x0000.0000	I2C Slave Interrupt Mask	729
0x810	I2CSRIS	RO	0x0000.0000	I2C Slave Raw Interrupt Status	730
0x814	I2CSMIS	RO	0x0000.0000	I2C Slave Masked Interrupt Status	731
0x818	I2CSICR	WO	0x0000.0000	I2C Slave Interrupt Clear	732

15.6 Register Descriptions (I²C Master)

The remainder of this section lists and describes the I²C master registers, in numerical order by address offset.

Register 1: I²C Master Slave Address (I2CMSA), offset 0x000

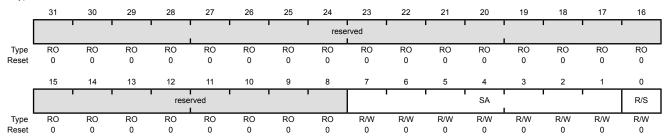
This register consists of eight bits: seven address bits (A6-A0), and a Receive/Send bit, which determines if the next operation is a Receive (High), or Transmit (Low).

I2C Master Slave Address (I2CMSA)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000

Offset 0x000

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:1	SA	R/W	0x00	I ² C Slave Address This field specifies bits A6 through A0 of the slave address.
0	R/S	R/W	0	Receive/Send The P/S hit specifies if the payt operation is a Paceive (High) or Transmit

The \mathbb{R}/\mathbb{S} bit specifies if the next operation is a Receive (High) or Transmit (Low).

Value Description

0 Transmit

1 Receive

Register 2: I²C Master Control/Status (I2CMCS), offset 0x004

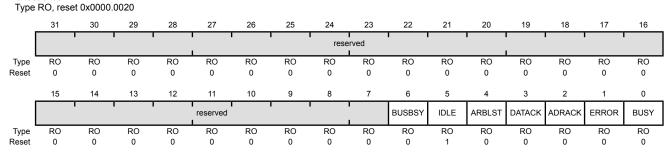
This register accesses status bits when read and control bits when written. When read, the status register indicates the state of the I^2C bus controller. When written, the control register configures the I^2C controller operation.

The START bit generates the START or REPEATED START condition. The STOP bit determines if the cycle stops at the end of the data cycle or continues on to a repeated START condition. To generate a single transmit cycle, the I^2C Master Slave Address (I2CMSA) register is written with the desired address, the R/S bit is cleared, and this register is written with ACK=X (0 or 1), STOP=1, START=1, and RUN=1 to perform the operation and stop. When the operation is completed (or aborted due an error), an interrupt becomes active and the data may be read from the I2CMDR register. When the I2CMDR module operates in Master receiver mode, the ACK bit is normally set, causing the I2C bus controller to transmit an acknowledge automatically after each byte. This bit must be cleared when the I2CMDR requires no further data to be transmitted from the slave transmitter.

Read-Only Status Register

I2C Master Control/Status (I2CMCS)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x004



Bit/Field	Name	Туре	Reset	Description
31:7	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	BUSBSY	RO	0	Bus Busy
				Value Description The I ² C bus is idle. The I ² C bus is busy.
				The bit changes based on the START and STOP conditions.
5	IDLE	RO	1	I ² C Idle
				Value Description
				The I ² C controller is not idle.
				1 The I ² C controller is idle.

Bit/Field	Name	Туре	Reset	Description
4	ARBLST	RO	0	Arbitration Lost
				Value Description
				The I ² C controller won arbitration.
				1 The I ² C controller lost arbitration.
3	DATACK	RO	0	Acknowledge Data
				Value Description
				0 The transmitted data was acknowledged
				1 The transmitted data was not acknowledged.
2	ADRACK	RO	0	Acknowledge Address
				Value Description
				0 The transmitted address was acknowledged
				1 The transmitted address was not acknowledged.
1	ERROR	RO	0	Error
				Value Description
				0 No error was detected on the last operation.
				1 An error occurred on the last operation.
				The error can be from the slave address not being acknowledged or the transmit data not being acknowledged.
0	BUSY	RO	0	I ² C Busy
				Value Description
				0 The controller is idle.
				1 The controller is busy.

Write-Only Control Register

I2C Master Control/Status (I2CMCS)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x004 Type WO, reset 0x0000.0020

Туре

Reset

RO

0

0

0

0

31 30 29 28 27 25 24 23 22 21 20 19 18 16 26 17 reserved Type RO 15 14 13 12 11 10 8 3 0 ACK STOP START RUN reserved reserved reserved WO WO WO WO RO RO RO RO RO RO RO RO RO

0

0

RO

0

0

0

When the BUSY bit is set, the other status bits are not valid.

0

0

0

0

0

RO

0

Bit/Field	Name	Type	Reset	Description
31:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	reserved	RO	1	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	ACK	WO	0	Data Acknowledge Enable
				Value Description
				The received data byte is not acknowledged automatically by the master.
				The received data byte is acknowledged automatically by the master. See field decoding in Table 15-5 on page 716.
2	STOP	WO	0	Generate STOP
				Value Description
				0 The controller does not generate the STOP condition.
				1 The controller generates the STOP condition. See field decoding in Table 15-5 on page 716.
1	START	WO	0	Generate START
				Value Description
				0 The controller does not generate the START condition.
				1 The controller generates the START or repeated START condition. See field decoding in Table 15-5 on page 716.
0	RUN	WO	0	I ² C Master Enable
				Value Description
				0 The master is disabled.
				1 The master is enabled to transmit or receive data. See field

decoding in Table 15-5 on page 716.

Table 15-5. Write Field Decoding for I2CMCS[3:0] Field

Current	I2CMSA[0]		I2CMC	S[3:0]		Description
State	R/S	ACK	STOP	START	RUN	Description
	0	X ^a	0	1	1	START condition followed by TRANSMIT (master goes to the Master Transmit state).
	0	Х	1	1	1	START condition followed by a TRANSMIT and STOP condition (master remains in Idle state).
1.41	1	0	0	1	1	START condition followed by RECEIVE operation with negative ACK (master goes to the Master Receive state).
Idle	1	0	1	1	1	START condition followed by RECEIVE and STOP condition (master remains in Idle state).
	1	1	0	1	1	START condition followed by RECEIVE (master goes to the Master Receive state).
	1	1	1	1	1	Illegal
	All other co	mbinations	s not listed	are non-op	erations.	NOP
	Х	Х	0	0	1	TRANSMIT operation (master remains in Master Transmit state).
	Х	Х	1	0	0	STOP condition (master goes to Idle state).
	Х	Х	1	0	1	TRANSMIT followed by STOP condition (master goes to Idle state).
	0	Х	0	1	1	Repeated START condition followed by a TRANSMIT (master remains in Master Transmit state).
Master	0	Х	1	1	1	Repeated START condition followed by TRANSMIT and STOP condition (master goes to Idle state).
Transmit	1	0	0	1	1	Repeated START condition followed by a RECEIVE operation with a negative ACK (master goes to Master Receive state).
	1	0	1	1	1	Repeated START condition followed by a TRANSMIT and STOP condition (master goes to Idle state).
	1	1	0	1	1	Repeated START condition followed by RECEIVE (master goes to Master Receive state).
	1	1	1	1	1	Illegal.
	All other co	mbinations	s not listed	are non-op	erations.	NOP.

Table 15-5. Write Field Decoding for I2CMCS[3:0] Field (continued)

Current	rent I2CMSA[0] I2CMCS[3:0]		Description			
State	R/S	ACK	STOP	START	RUN	Description
	Х	0	0	0	1	RECEIVE operation with negative ACK (master remains in Master Receive state).
	Х	Х	1	0	0	STOP condition (master goes to Idle state).b
	Х	0	1	0	1	RECEIVE followed by STOP condition (master goes to Idle state).
	Х	1	0	0	1	RECEIVE operation (master remains in Master Receive state).
	Х	1	1	0	1	Illegal.
Master Receive	1	0	0	1	1	Repeated START condition followed by RECEIVE operation with a negative ACK (master remains in Master Receive state).
	1	0	1	1	1	Repeated START condition followed by RECEIVE and STOP condition (master goes to Idle state).
	1	1	0	1	1	Repeated START condition followed by RECEIVE (master remains in Master Receive state).
	0	Х	0	1	1	Repeated START condition followed by TRANSMIT (master goes to Master Transmit state).
	0	Х	1	1	1	Repeated START condition followed by TRANSMIT and STOP condition (master goes to Idle state).
	All other co	mbinations	s not listed	are non-op	erations.	NOP.

a. An X in a table cell indicates the bit can be 0 or 1.

b. In Master Receive mode, a STOP condition should be generated only after a Data Negative Acknowledge executed by the master or an Address Negative Acknowledge executed by the slave.

Register 3: I²C Master Data (I2CMDR), offset 0x008

Important: This register is read-sensitive. See the register description for details.

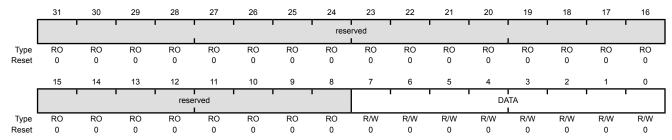
This register contains the data to be transmitted when in the Master Transmit state and the data received when in the Master Receive state.

I2C Master Data (I2CMDR)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000

Offset 0x008

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DATA	R/W	0x00	Data Transferred
				Data transferred during transaction.

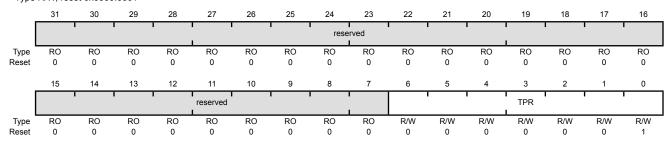
Register 4: I²C Master Timer Period (I2CMTPR), offset 0x00C

This register specifies the period of the SCL clock.

I2C Master Timer Period (I2CMTPR)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x00C

Type R/W, reset 0x0000.0001



Bit/Field	Name	Туре	Reset	Description
31:7	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6:0	TPR	R/W	0x1	SCL Clock Period

This field specifies the period of the SCL clock.

 $SCL_PRD = 2 \times (1 + TPR) \times (SCL_LP + SCL_HP) \times CLK_PRD$

where:

SCL_PRD is the SCL line period (I²C clock).

 \mathtt{TPR} is the Timer Period register value (range of 1 to 127).

SCL_LP is the SCL Low period (fixed at 6).

 ${\it SCL_HP}$ is the SCL High period (fixed at 4).

 $\textit{CLK_PRD}$ is the system clock period in ns.

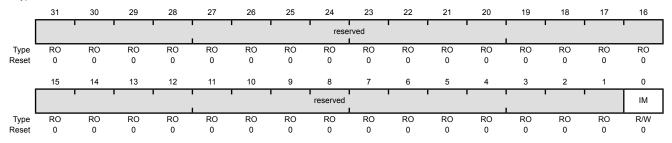
Register 5: I²C Master Interrupt Mask (I2CMIMR), offset 0x010

This register controls whether a raw interrupt is promoted to a controller interrupt.

I2C Master Interrupt Mask (I2CMIMR)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x010

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	IM	R/W	0	Interrupt Mask

Value Description

- 1 The master interrupt is sent to the interrupt controller when the RIS bit in the **I2CMRIS** register is set.
- The RIS interrupt is suppressed and not sent to the interrupt controller.

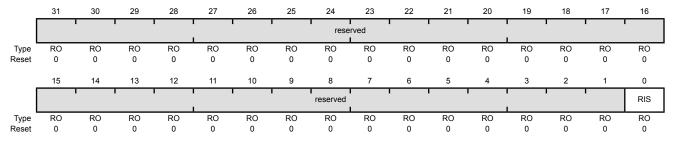
Register 6: I²C Master Raw Interrupt Status (I2CMRIS), offset 0x014

This register specifies whether an interrupt is pending.

I2C Master Raw Interrupt Status (I2CMRIS)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x014

Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	RIS	RO	0	Raw Interrupt Status

Value Description

1 A master interrupt is pending.

0 No interrupt.

This bit is cleared by writing a 1 to the ${\tt IC}$ bit in the <code>I2CMICR</code> register.

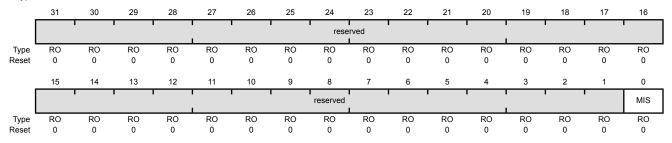
Register 7: I²C Master Masked Interrupt Status (I2CMMIS), offset 0x018

This register specifies whether an interrupt was signaled.

I2C Master Masked Interrupt Status (I2CMMIS)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x018

Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	MIS	RO	0	Masked Interrupt Status

Value Description

- 1 An unmasked master interrupt was signaled and is pending.
- O An interrupt has not occurred or is masked.

This bit is cleared by writing a 1 to the IC bit in the I2CMICR register.

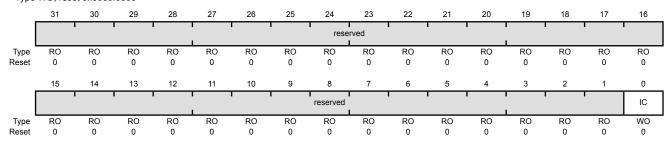
Register 8: I²C Master Interrupt Clear (I2CMICR), offset 0x01C

This register clears the raw and masked interrupts.

I2C Master Interrupt Clear (I2CMICR)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x01C

Type WO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	IC	WO	0	Interrupt Clear

Writing a 1 to this bit clears the ${\tt RIS}$ bit in the <code>I2CMRIS</code> register and the ${\tt MIS}$ bit in the <code>I2CMMIS</code> register.

A read of this register returns no meaningful data.

Register 9: I²C Master Configuration (I2CMCR), offset 0x020

This register configures the mode (Master or Slave) and sets the interface for test mode loopback.

I2C Master Configuration (I2CMCR)

Name

Type

Reset

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x020

Type R/W, reset 0x0000.0000

Bit/Field

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1	1		ı			rese	rved							
Type Reset	RO 0	RO 0	RO 0													
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		1	1		rese	rved		1			SFE	MFE		reserved		LPBK
Туре	RO	R/W	R/W	RO	RO	RO	R/W									
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Description

31:6	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SFE	R/W	0	I ² C Slave Function Enable
				Value Description 1 Slave mode is enabled. 0 Slave mode is disabled.
4	MFE	R/W	0	I ² C Master Function Enable
				Value Description
				1 Master mode is enabled.
				0 Master mode is disabled.
3:1	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	LPBK	R/W	0	I ² C Loopback

15.7 Register Descriptions (I²C Slave)

The remainder of this section lists and describes the I²C slave registers, in numerical order by address offset.

Value Description

Normal operation.

The controller in a test mode loopback configuration.

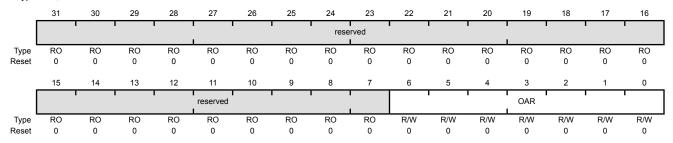
0

Register 10: I²C Slave Own Address (I2CSOAR), offset 0x800

This register consists of seven address bits that identify the Stellaris I²C device on the I²C bus.

I2C Slave Own Address (I2CSOAR)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x800 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:7	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6:0	OAR	R/W	0x00	I ² C Slave Own Address

This field specifies bits A6 through A0 of the slave address.

Register 11: I²C Slave Control/Status (I2CSCSR), offset 0x804

This register functions as a control register when written, and a status register when read.

Read-Only Status Register

I2C Slave Control/Status (I2CSCSR)

Name

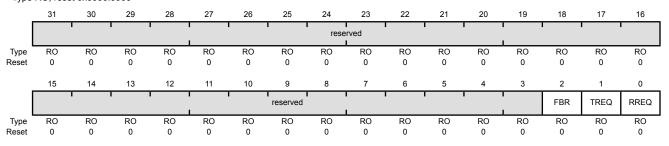
Type

Reset

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x804

Type RO, reset 0x0000.0000

Bit/Field



Description

31:3	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	FBR	RO	0	First Byte Received
				Value Description
				The first byte following the slave's own address has been received.
				0 The first byte has not been received.
				This bit is only valid when the RREQ bit is set and is automatically cleared when data has been read from the I2CSDR register.
				Note: This bit is not used for slave transmit operations.
1	TREQ	RO	0	Transmit Request
				Value Description
				The I ² C controller has been addressed as a slave transmitter and is using clock stretching to delay the master until data has been written to the I2CSDR register.
				0 No outstanding transmit request.
0	RREQ	RO	0	Receive Request
				Value Description
				1 The I ² C controller has outstanding receive data from the I ² C

0

master and is using clock stretching to delay the master until

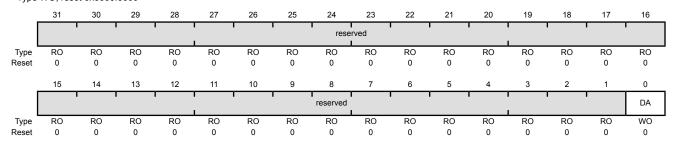
the data has been read from the I2CSDR register.

No outstanding receive data.

Write-Only Control Register

I2C Slave Control/Status (I2CSCSR)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x804 Type WO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	DA	WO	0	Device Active

Value Description

Disables the I²C slave operation. 0

Enables the I²C slave operation. 1

Once this bit has been set, it should not be set again unless it has been cleared by writing a 0 or by a reset, otherwise transfer failures may occur.

Register 12: I²C Slave Data (I2CSDR), offset 0x808

Important: This register is read-sensitive. See the register description for details.

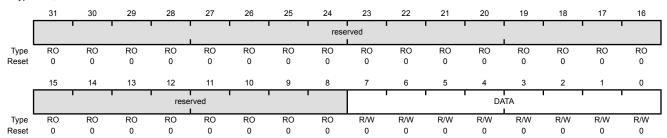
This register contains the data to be transmitted when in the Slave Transmit state, and the data received when in the Slave Receive state.

I2C Slave Data (I2CSDR)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000

Offset 0x808

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0x0000.00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DATA	R/W	0x00	Data for Transfer

This field contains the data for transfer during a slave receive or transmit operation.

Register 13: I²C Slave Interrupt Mask (I2CSIMR), offset 0x80C

This register controls whether a raw interrupt is promoted to a controller interrupt.

I2C Slave Interrupt Mask (I2CSIMR)

DATAIM

R/W

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x80C

Type R/W, reset 0x0000.0000

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		'	1	1	 			rese	rved					1		
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		•	'	1			reserved							STOPIM	STARTIM	DATAIM
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	STOPIM	R/W	0	Stop Condition Interrupt Mask
				Value Description
				1 The STOP condition interrupt is sent to the interrupt controller when the STOPRIS bit in the I2CSRIS register is set.
				O The STOPRIS interrupt is suppressed and not sent to the interrupt controller.
1	STARTIM	R/W	0	Start Condition Interrupt Mask
				Value Description
				1 The START condition interrupt is sent to the interrupt controller when the STARTRIS bit in the I2CSRIS register is set.
				O The STARTRIS interrupt is suppressed and not sent to the interrupt controller.

Data Interrupt Mask Value Description

- The data received or data requested interrupt is sent to the interrupt controller when the DATARIS bit in the I2CSRIS register is set.
- O The DATARIS interrupt is suppressed and not sent to the interrupt controller.

Register 14: I²C Slave Raw Interrupt Status (I2CSRIS), offset 0x810

This register specifies whether an interrupt is pending.

I2C Slave Raw Interrupt Status (I2CSRIS)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x810 Type RO, reset 0x0000.0000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1	1	1	ı			rese	rved I				1			
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO						
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		l	!	l	! !		reserved						! [STOPRIS	STARTRIS	DATARIS
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0						

Bit/Field	Name	Туре	Reset	Description
31:3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	STOPRIS	RO	0	Stop Condition Raw Interrupt Status Value Description 1 A STOP condition interrupt is pending. 0 No interrupt. This bit is cleared by writing a 1 to the STOPIC bit in the I2CSICR register.
1	STARTRIS	RO	0	Start Condition Raw Interrupt Status Value Description 1 A START condition interrupt is pending. 0 No interrupt. This bit is cleared by writing a 1 to the STARTIC bit in the I2CSICR
0	DATARIS	RO	0	register. Data Raw Interrupt Status Value Description

A data received or data requested interrupt is pending. 1

No interrupt.

This bit is cleared by writing a 1 to the DATAIC bit in the I2CSICR register.

Register 15: I²C Slave Masked Interrupt Status (I2CSMIS), offset 0x814

This register specifies whether an interrupt was signaled.

I2C Slave Masked Interrupt Status (I2CSMIS)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x814

Type RO, reset 0x0000.0000

								rese	ervea •							
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	•		1				reserved		1 1			1	ı	STOPMIS	STARTMIS	DATAMIS
- 1																
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
_):4/E: _1.4		Name	_	т		Danat	D								
	Bit/Field		Nam	ie	Tyl	pe	Reset	Des	scription							
					_	_	_								_	
	31:3		reserv	/ed	R	O	0		tware sho		•				•	
								com	npatibility	with futu	ure prod	ucts, the	e value o	f a reserv	ed bit sh	nould be
								pres	served ac	ross a r	ead-mo	dify-write	e operati	on.		
	2		STOPI	MIS	R	0	0	Sto	p Condition	on Mask	ed Inter	rupt Sta	tus			
								Val	ue Desc	ription						
								4	A no	maakad	CTOD	andition	intornun	tuunn ninn	م ما امام	andina
								1	Anun	imaskeo	13101	Condition	interrup	t was sign	iaieu is p	ending.
								0	An in	terrupt h	as not o	occurred	or is ma	asked.		
								This	s bit is cle	ared by	writina	a 1 to th	e stopi	c bit in th	ne I2CSI	CR
									ister.	,	. 3					
								.cg								
	1		START	MIC	R	\circ	0	Star	rt Conditio	on Mack	ad Into	runt Sta	tue			
	1		SIARI	IVIIO	K	O	U	Sidi	i Conditi	oii iviask	eu iiitei	rupi Ola	เนอ			

Value Description

- An unmasked START condition interrupt was signaled is pending.
- 0 An interrupt has not occurred or is masked.

This bit is cleared by writing a 1 to the ${\tt STARTIC}$ bit in the <code>l2CSICR</code> register.

0 DATAMIS RO 0 Data Masked Interrupt Status

Value Description

- An unmasked data received or data requested interrupt was signaled is pending.
- O An interrupt has not occurred or is masked.

This bit is cleared by writing a 1 to the ${\tt DATAIC}$ bit in the ${\tt I2CSICR}$ register.

Register 16: I²C Slave Interrupt Clear (I2CSICR), offset 0x818

This register clears the raw interrupt. A read of this register returns no meaningful data.

I2C Slave Interrupt Clear (I2CSICR)

I2C 0 base: 0x4002.0000 I2C 1 base: 0x4002.1000 Offset 0x818 Type WO, reset 0x0000.0000

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1	1	1				rese	rved					1		
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO						
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		l	!	l			reserved							STOPIC	STARTIC	DATAIC
Туре	RO	RO	RO	RO	RO	RO	RO	WO	WO	WO						
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit/Field	Name	Type	Reset	Description
31:3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	STOPIC	WO	0	Stop Condition Interrupt Clear
				Writing a 1 to this bit clears the STOPRIS bit in the I2CSRIS register and the STOPMIS bit in the I2CSMIS register.
				A read of this register returns no meaningful data.
1	STARTIC	WO	0	Start Condition Interrupt Clear
				Writing a 1 to this bit clears the STOPRIS bit in the I2CSRIS register and the STOPMIS bit in the I2CSMIS register.
				A read of this register returns no meaningful data.
0	DATAIC	WO	0	Data Interrupt Clear
				Writing a 1 to this bit clears the STOPRIS bit in the I2CSRIS register

and the STOPMIS bit in the I2CSMIS register. A read of this register returns no meaningful data.

16 Analog Comparators

An analog comparator is a peripheral that compares two analog voltages and provides a logical output that signals the comparison result.

Note: Not all comparators have the option to drive an output pin. See "Signal Description" on page 734 for more information.

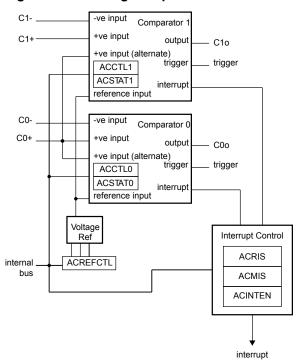
The comparator can provide its output to a device pin, acting as a replacement for an analog comparator on the board. In addition, the comparator can signal the application via interrupts or trigger the start of a sample sequence in the ADC. The interrupt generation and ADC triggering logic is separate and independent. This flexibility means, for example, that an interrupt can be generated on a rising edge and the ADC triggered on a falling edge.

The Stellaris[®] LM3S1J11 microcontroller provides two independent integrated analog comparators with the following functions:

- Compare external pin input to external pin input or to internal programmable voltage reference
- Compare a test voltage against any one of the following voltages:
 - An individual external reference voltage
 - A shared single external reference voltage
 - A shared internal reference voltage

16.1 Block Diagram

Figure 16-1. Analog Comparator Module Block Diagram



16.2 Signal Description

The following table lists the external signals of the Analog Comparators and describes the function of each. The Analog Comparator output signals are alternate functions for some GPIO signals and default to be GPIO signals at reset. The column in the table below titled "Pin Mux/Pin Assignment" lists the possible GPIO pin placements for the Analog Comparator signals. The AFSEL bit in the **GPIO Alternate Function Select (GPIOAFSEL)** register (page 412) should be set to choose the Analog Comparator function. The number in parentheses is the encoding that must be programmed into the PMCn field in the **GPIO Port Control (GPIOPCTL)** register (page 430) to assign the Analog Comparator signal to the specified GPIO port pin. The positive and negative input signals are configured by clearing the DEN bit in the **GPIO Digital Enable (GPIODEN)** register. For more information on configuring GPIOs, see "General-Purpose Input/Outputs (GPIOs)" on page 389.

Table 16-1. Analog Comparators Signals (100LQFP)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
C0+	90	PB6	I	Analog	Analog comparator 0 positive input.
C0-	92	PB4	I	Analog	Analog comparator 0 negative input.
C0o	24 58 90 91 100	PC5 (3) PF4 (2) PB6 (3) PB5 (1) PD7 (2)	0	TTL	Analog comparator 0 output.
C1+	24	PC5	I	Analog	Analog comparator 1 positive input.
C1-	91	PB5	I	Analog	Analog comparator 1 negative input.
Clo	2 22 24 46 84	PE6 (2) PC7 (7) PC5 (2) PF5 (2) PH2 (2)	0	TTL	Analog comparator 1 output.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

Table 16-2. Analog Comparators Signals (108BGA)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
C0+	A7	PB6	I	Analog	Analog comparator 0 positive input.
C0-	A6	PB4	I	Analog	Analog comparator 0 negative input.
C0o	M1 L9 A7 B7 A2	PC5 (3) PF4 (2) PB6 (3) PB5 (1) PD7 (2)	0	TTL	Analog comparator 0 output.
C1+	M1	PC5	I	Analog	Analog comparator 1 positive input.
C1-	B7	PB5	I	Analog	Analog comparator 1 negative input.
Clo	A1 L2 M1 L8 D11	PE6 (2) PC7 (7) PC5 (2) PF5 (2) PH2 (2)	0	TTL	Analog comparator 1 output.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

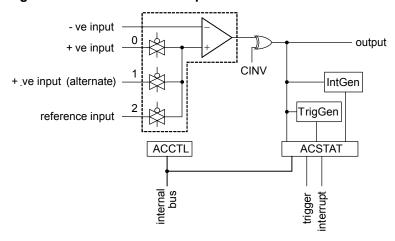
16.3 Functional Description

The comparator compares the VIN- and VIN+ inputs to produce an output, VOUT.

```
VIN- < VIN+, VOUT = 1
VIN- > VIN+, VOUT = 0
```

As shown in Figure 16-2 on page 735, the input source for VIN- is an external input, Cn-. In addition to an external input, Cn+, input sources for VIN+ can be the C0+ or an internal reference, V_{IRFF} .

Figure 16-2. Structure of Comparator Unit



A comparator is configured through two status/control registers, Analog Comparator Control (ACCTL) and Analog Comparator Status (ACSTAT). The internal reference is configured through one control register, Analog Comparator Reference Voltage Control (ACREFCTL). Interrupt status and control are configured through three registers, Analog Comparator Masked Interrupt Status (ACMIS), Analog Comparator Raw Interrupt Status (ACRIS), and Analog Comparator Interrupt Enable (ACINTEN).

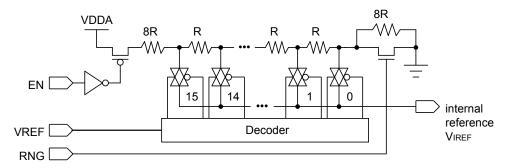
Typically, the comparator output is used internally to generate an interrupt as controlled by the ISEN bit in the **ACCTL** register. The output may also be used to drive an external pin, Co or generate an analog-to-digital converter (ADC) trigger.

Important: The ASRCP bits in the **ACCTL** register must be set before using the analog comparators.

16.3.1 Internal Reference Programming

The structure of the internal reference is shown in Figure 16-3 on page 736. The internal reference is controlled by a single configuration register (**ACREFCTL**).

Figure 16-3. Comparator Internal Reference Structure



The internal reference can be programmed in one of two modes (low range or high range) depending on the RNG bit in the **ACREFCTL** register. When RNG is clear, the internal reference is in high-range mode, and when RNG is set the internal reference is in low-range mode.

In each range, the internal reference, V_{IREF} , has 16 pre-programmed thresholds or step values. The threshold to be used to compare the external input voltage against is selected using the VREF field in the **ACREFCTL** register.

In the high-range mode, the V_{IREF} threshold voltages start at the ideal high-range starting voltage of $V_{DDA}/3.875$ and increase in ideal constant voltage steps of $V_{DDA}/31$.

In the low-range mode, the V_{IREF} threshold voltages start at:0V and increase in ideal constant voltage steps of $V_{DDA}/23$. The ideal V_{IREF} step voltages for each mode and their dependence on the RNG and VREF fields are summarized in Table 16-3 on page 736.

Table 16-3. Internal Reference Voltage and ACREFCTL Field Values

ACREFCTL Register		
EN Bit Value	RNG Bit Value	Output Reference Voltage Based on VREF Field Value
EN=0		0 V (GND) for any value of ${\tt VREF}.$ It is recommended that ${\tt RNG=1}$ and ${\tt VREF=0}$ to minimize noise on the reference ground.

Table 16-3. Internal Reference Voltage and ACREFCTL Field Values (continued)

ACREFCTL	Register							
EN Bit Value	RNG Bit Value	Output Reference Voltage Based on VREF Field Value						
	RNG=0	Total resistance in ladder is 31 R. $V_{IREF} = V_{DDA} \times \frac{R_{VREF}}{R_T}$ $V_{IREF} = V_{DDA} \times \frac{(VREF + 8)}{31}$						
		$V_{IREF} = 0.85 + 0.106 \times VREF$ The range of internal reference in this mode is 0.85-2.448 V.						
EN=1	RNG=1	Total resistance in ladder is 23 R. $V_{IREF} = V_{DDA} \times \frac{R_{VREF}}{R_T}$						
		$V_{IREF} = V_{DDA} imes rac{VREF}{23}$ $V_{IREF} = 0.143 imes VREF$						
		The range of internal reference for this mode is 0-2.152 V.						

16.4 Initialization and Configuration

The following example shows how to configure an analog comparator to read back its output value from an internal register.

- **1.** Enable the analog comparator clock by writing a value of 0x0010.0000 to the **RCGC1** register in the System Control module (see page 246).
- **2.** Enable the clock to the appropriate GPIO modules via the **RCGC2** register (see page 255). To find out which GPIO ports to enable, refer to Table 18-5 on page 767.
- **3.** In the GPIO module, enable the GPIO port/pin associated with the input signals as GPIO inputs. To determine which GPIO to configure, see Table 18-4 on page 762.
- **4.** Configure the PMCn fields in the **GPIOPCTL** register to assign the analog comparator output signals to the appropriate pins (see page 430 and Table 18-5 on page 767).

- **5.** Configure the internal voltage reference to 1.65 V by writing the **ACREFCTL** register with the value 0x0000.030C.
- **6.** Configure the comparator to use the internal voltage reference and to *not* invert the output by writing the **ACCTLn** register with the value of 0x0000.040C.
- 7. Delay for 10 µs.
- 8. Read the comparator output value by reading the ACSTATn register's OVAL value.

Change the level of the comparator negative input signal C- to see the OVAL value change.

16.5 Register Map

Table 16-4 on page 738 lists the comparator registers. The offset listed is a hexadecimal increment to the register's address, relative to the Analog Comparator base address of 0x4003.C000. Note that the analog comparator clock must be enabled before the registers can be programmed (see page 246). There must be a delay of 3 system clocks after the analog comparator module clock is enabled before any analog comparator module registers are accessed.

Table 16-4. Analog Comparators Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	ACMIS	R/W1C	0x0000.0000	Analog Comparator Masked Interrupt Status	739
0x004	ACRIS	RO	0x0000.0000	Analog Comparator Raw Interrupt Status	740
0x008	ACINTEN	R/W	0x0000.0000	Analog Comparator Interrupt Enable	741
0x010	ACREFCTL	R/W	0x0000.0000	Analog Comparator Reference Voltage Control	742
0x020	ACSTAT0	RO	0x0000.0000	Analog Comparator Status 0	743
0x024	ACCTL0	R/W	0x0000.0000	Analog Comparator Control 0	744
0x040	ACSTAT1	RO	0x0000.0000	Analog Comparator Status 1	743
0x044	ACCTL1	R/W	0x0000.0000	Analog Comparator Control 1	744

16.6 Register Descriptions

The remainder of this section lists and describes the Analog Comparator registers, in numerical order by address offset.

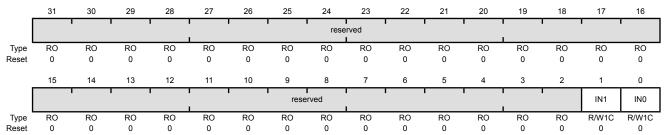
Register 1: Analog Comparator Masked Interrupt Status (ACMIS), offset 0x000

This register provides a summary of the interrupt status (masked) of the comparators.

Analog Comparator Masked Interrupt Status (ACMIS)

Base 0x4003.C000 Offset 0x000

Type R/W1C, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:2	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	IN1	R/W1C	0	Comparator 1 Masked Interrupt Status
				Value Description
				1 The IN1 bits in the ACRIS register and the ACINTEN registers are set, providing an interrupt to the interrupt controller.
				0 No interrupt has occurred or the interrupt is masked.
				This bit is cleared by writing a 1. Clearing this bit also clears the ${\tt INl}$ bit in the ${\textbf{ACRIS}}$ register.
0	IN0	R/W1C	0	Comparator 0 Masked Interrupt Status

Value Description

- 1 The INO bits in the **ACRIS** register and the **ACINTEN** registers are set, providing an interrupt to the interrupt controller.
- 0 No interrupt has occurred or the interrupt is masked.

This bit is cleared by writing a 1. Clearing this bit also clears the ${\tt IN0}$ bit in the **ACRIS** register.

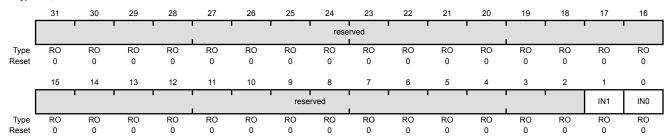
Register 2: Analog Comparator Raw Interrupt Status (ACRIS), offset 0x004

This register provides a summary of the interrupt status (raw) of the comparators. The bits in this register must be enabled to generate interrupts using the **ACINTEN** register.

Analog Comparator Raw Interrupt Status (ACRIS)

Base 0x4003.C000

Offset 0x004 Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:2	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	IN1	RO	0	Comparator 1 Interrupt Status
				Value Description
				1 Comparator 1 has generated an interruptfor an event as configured by the ISEN bit in the ACCTL1 register.
				0 An interrupt has not occurred.
				This bit is cleared by writing a 1 to the IN1 bit in the ACMIS register.
0	IN0	RO	0	Comparator 0 Interrupt Status

Value Description

- 1 Comparator 0 has generated an interrupt for an event as configured by the ISEN bit in the ACCTL0 register.
- 0 An interrupt has not occurred.

This bit is cleared by writing a 1 to the ${\tt IN0}$ bit in the ACMIS register.

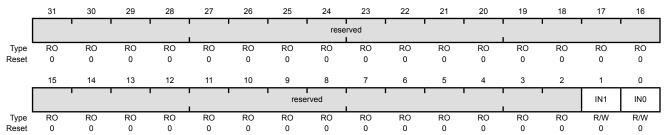
Register 3: Analog Comparator Interrupt Enable (ACINTEN), offset 0x008

This register provides the interrupt enable for the comparators.

Analog Comparator Interrupt Enable (ACINTEN)

Base 0x4003.C000 Offset 0x008

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:2	reserved	RO	0x00	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	IN1	R/W	0	Comparator 1 Interrupt Enable
				Value Description
				1 The raw interrupt signal comparator 1 is sent to the interrupt controller.
				0 A comparator 1 interrupt does not affect the interrupt status.
0	IN0	R/W	0	Comparator 0 Interrupt Enable

Value Description

- 1 The raw interrupt signal comparator 0 is sent to the interrupt controller.
- 0 A comparator 0 interrupt does not affect the interrupt status.

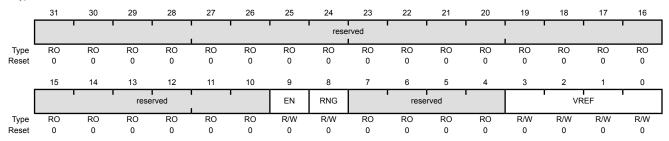
Register 4: Analog Comparator Reference Voltage Control (ACREFCTL), offset 0x010

This register specifies whether the resistor ladder is powered on as well as the range and tap.

Analog Comparator Reference Voltage Control (ACREFCTL)

Base 0x4003.C000

Offset 0x010 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:10	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
9	EN	R/W	0	Resistor Ladder Enable
				Value Description
				0 The resistor ladder is unpowered.
				Powers on the resistor ladder. The resistor ladder is connected to $\rm V_{\rm DDA}.$
				This bit is cleared at reset so that the internal reference consumes the least amount of power if it is not used.
8	RNG	R/W	0	Resistor Ladder Range
				Value Description
				0 The resistor ladder has a total resistance of 31 R.
				1 The resistor ladder has a total resistance of 23 R.
7:4	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3:0	VREF	R/W	0x0	Resistor Ladder Voltage Ref
				The \mathtt{VREF} bit field specifies the resistor ladder tap that is passed through

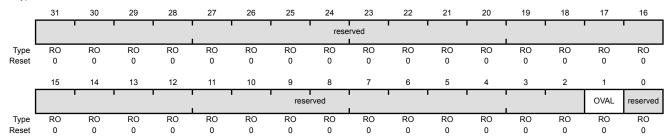
an analog multiplexer. The voltage corresponding to the tap position is the internal reference voltage available for comparison. See Table 16-3 on page 736 for some output reference voltage examples.

Register 5: Analog Comparator Status 0 (ACSTAT0), offset 0x020 Register 6: Analog Comparator Status 1 (ACSTAT1), offset 0x040

These registers specify the current output value of the comparator.

Analog Comparator Status 0 (ACSTAT0)

Base 0x4003.C000 Offset 0x020 Type RO, reset 0x0000.0000



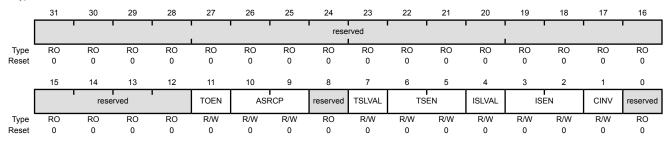
Bit/Field	Name	Туре	Reset	Description
31:2	reserved	RO	0x0000.000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	OVAL	RO	0	Comparator Output Value
				Value Description 0 VIN-> VIN+
				1 VIN- < VIN+
				I VIIV- VIIVT
				VIN - is the voltage on the ${\tt Cn-}$ pin. VIN+ is the voltage on the ${\tt Cn+}$ pin, the C0+ pin, or the internal voltage reference (V _{IREF}) as defined by the ASRCP bit in the ACCTL register.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 7: Analog Comparator Control 0 (ACCTL0), offset 0x024 Register 8: Analog Comparator Control 1 (ACCTL1), offset 0x044

These registers configure the comparator's input and output.

Analog Comparator Control 0 (ACCTL0)

Base 0x4003.C000 Offset 0x024 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:12	reserved	RO	0x0000.0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
11	TOEN	R/W	0	Trigger Output Enable
				Value Description
				ADC events are suppressed and not sent to the ADC.
				1 ADC events are sent to the ADC.
10:9	ASRCP	R/W	0x0	Analog Source Positive
				The ASRCP field specifies the source of input voltage to the VIN+ terminal of the comparator. The encodings for this field are as follows:
				Value Description
				0x0 Pin value of Cn+
				0x1 Pin value of C0+
				0x2 Internal voltage reference (V _{IREF})
				0x3 Reserved
8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	TSLVAL	R/W	0	Trigger Sense Level Value
				Value Description
				0 An ADC event is generated if the comparator output is Low

- 0 An ADC event is generated if the comparator output is Low.
- An ADC event is generated if the comparator output is High.

Bit/Field	Name	Туре	Reset	Description
6:5	TSEN	R/W	0x0	Trigger Sense The TSEN field specifies the sense of the comparator output that generates an ADC event. The sense conditioning is as follows:
				Value Description
				0x0 Level sense, see TSLVAL
				0x1 Falling edge
				0x2 Rising edge
				0x3 Either edge
4	ISLVAL	R/W	0	Interrupt Sense Level Value
				Value Description
				O An interrupt is generated if the comparator output is Low.
				1 An interrupt is generated if the comparator output is High.
3:2	ISEN	R/W	0x0	Interrupt Sense
				The ISEN field specifies the sense of the comparator output that generates an interrupt. The sense conditioning is as follows:
				Value Description
				0x0 Level sense, see ISLVAL
				0x1 Falling edge
				0x2 Rising edge
				0x3 Either edge
1	CINV	R/W	0	Comparator Output Invert
				Value Description
				0 The output of the comparator is unchanged.
				1 The output of the comparator is inverted prior to being processed by hardware.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

17 Pin Diagram

The LM3S1J11 microcontroller pin diagram is shown below.

Each GPIO signal is identified by its GPIO port unless it defaults to an alternate function on reset. In this case, the GPIO port name is followed by the default alternate function. To see a complete list of possible functions for each pin, see Table 18-5 on page 767.

Figure 17-1. 100-Pin LQFP Package Pin Diagram

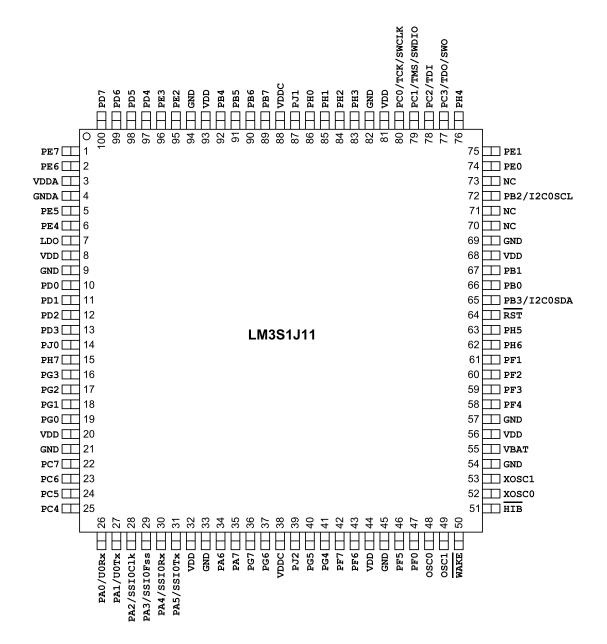


Figure 17-2. 108-Ball BGA Package Pin Diagram (Top View)

	1	2	3	4	5	6	7	8	9	10	11	12	
Α	PE6	PD7	PD6	PE2	GNDA	PB4	РВ6	РВ7	PC0 TCK SWCLK	PC3 TDO SWO	PB2 I2C0SCL	PE1	Α
В	PE7	PE4	PE5	PE3	PD4	PJ1	PB5	PC2 TDI	PC1 TMS SWDIO	PH4	PEO	NC	В
С	NC (NC	VDDC	GND	GND	PD5	VDDA	PH1	РНО	PG7	NC	NC	С
D	NC (NC	VDDC							РНЗ	PH2	PB1	D
E	NC (NC NC	TDO							VDD	PB3 I2C0SDA	PB0	Е
F	NC (NC	РЈ0							PH5	GND	GND	F
G	PDO	PD1	PH6			LM3	S1J11			VDD	VDD	VDD	G
Н	PD3	PD2	PH7							VDD	RST	PF1	Н
J	PG2	PG3	GND		_					GND	PF2	PF3	J
K	PG0	PG1	PG4	PF7	GND	РЈ2	VDD	VDD	VDD	GND	(xosco)	(xosc1)	K
L	PC4	PC7	PA0 UORx	PA3 SSI0Fss	PA4 SSIORX	PA6	PG6	PF5	PF4	GND	OSC0	VBAT	L
М	PC5	PC6	PA1 UOTx	PA2 SSIOC1k	PA5 SSIOTx	PA7	PG5	PF6	PF0	WAKE	OSC1	HIB	M
	1	2	3	4	5	6	7	8	9	10	11	12	

18 Signal Tables

The following tables list the signals available for each pin. Signals are configured as GPIOs on reset, except for those noted below. Use the **GPIOAMSEL** register (see page 428) to select analog mode. For a GPIO pin to be used for an alternate digital function, the corresponding bit in the **GPIOAFSEL** register (see page 412) must be set. Further pin muxing options are provided through the PMCx bit field in the **GPIOPCTL** register (see page 430), which selects one of several available peripheral functions for that GPIO.

Important: All GPIO pins are configured as GPIOs by default with the exception of the pins shown in the table below. A Power-On-Reset (POR) or asserting RST puts the pins back to their default state.

GPIO Pin	Default State	GPIOAFSEL Bit	GPIOPCTL PMCx Bit Field
PA[1:0]	UART0	0	0x1
PA[5:2]	SSI0	0	0x1
PB[3:2]	I ² C0	0	0x1
PC[3:0]	JTAG/SWD	1	0x3

Table 18-1. GPIO Pins With Default Alternate Functions

Table 18-2 on page 749 shows the pin-to-signal-name mapping, including functional characteristics of the signals. Each possible alternate analog and digital function is listed for each pin.

Table 18-3 on page 756 lists the signals in alphabetical order by signal name. If it is possible for a signal to be on multiple pins, each possible pin assignment is listed. The "Pin Mux" column indicates the GPIO and the encoding needed in the PMCx bit field in the **GPIOPCTL** register.

Table 18-4 on page 762 groups the signals by functionality, except for GPIOs. If it is possible for a signal to be on multiple pins, each possible pin assignment is listed.

Table 18-5 on page 767 lists the GPIO pins and their analog and digital alternate functions. The AINx and VREFA analog signals are not 5-V tolerant and go through an isolation circuit before reaching their circuitry. These signals are configured by clearing the corresponding DEN bit in the **GPIO Digital Enable (GPIODEN)** register and setting the corresponding AMSEL bit in the **GPIO Analog Mode Select (GPIOAMSEL)** register. Other analog signals are 5-V tolerant and are connected directly to their circuitry (C0-, C0+, C1-, C1+). These signals are configured by clearing the DEN bit in the **GPIO Digital Enable (GPIODEN)** register. The digital signals are enabled by setting the appropriate bit in the **GPIO Alternate Function Select (GPIOAFSEL)** and **GPIODEN** registers and configuring the PMCx bit field in the **GPIO Port Control (GPIOPCTL)** register to the numeric enoding shown in the table below. Table entries that are shaded gray are the default values for the corresponding GPIO pin.

Table 18-6 on page 770 lists the signals based on number of possible pin assignments. This table can be used to plan how to configure the pins for a particular functionality. Application Note AN01274 Configuring Stellaris[®] Microcontrollers with Pin Multiplexing provides an overview of the pin muxing implementation, an explanation of how a system designer defines a pin configuration, and examples of the pin configuration process.

Note: All digital inputs are Schmitt triggered.

18.1 100-Pin LQFP Package Pin Tables

18.1.1 Signals by Pin Number

Table 18-2. Signals by Pin Number

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PE7	I/O	TTL	GPIO port E bit 7.
1 1	AIN0	I	Analog	Analog-to-digital converter input 0.
	U1DCD	I	TTL	UART module 1 Data Carrier Detect modem status input signal.
	PE6	I/O	TTL	GPIO port E bit 6.
	AIN1	ı	Analog	Analog-to-digital converter input 1.
2	Clo	0	TTL	Analog comparator 1 output.
	U1CTS	I	TTL	UART module 1 Clear To Send modem flow control input signal.
3	VDDA	-	Power	The positive supply for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions. VDDA pins must be supplied with a voltage that meets the specification in Table 20-2 on page 797, regardless of system implementation.
4	GNDA	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.
	PE5	I/O	TTL	GPIO port E bit 5.
5	AIN2	I	Analog	Analog-to-digital converter input 2.
	CCP5	I/O	TTL	Capture/Compare/PWM 5.
	PE4	I/O	TTL	GPIO port E bit 4.
	AIN3	I	Analog	Analog-to-digital converter input 3.
6	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	U2Tx	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.
7	LDO	-	Power	Low drop-out regulator output voltage. This pin requires an external capacitor between the pin and GND of 1 μ F or greater. The LDO pin must also be connected to the VDDC pins at the board level in addition to the decoupling capacitor(s).
8	VDD	-	Power	Positive supply for I/O and some logic.
9	GND	-	Power	Ground reference for logic and I/O pins.
	PD0	I/O	TTL	GPIO port D bit 0.
	U1CTS	I	TTL	UART module 1 Clear To Send modem flow control input signal.
10	UlRx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
	U2Rx	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.

Table 18-2. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PD1	I/O	TTL	GPIO port D bit 1.
	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	U1DCD	I	TTL	UART module 1 Data Carrier Detect modem status input signal.
11	UlTx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
	U2Tx	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.
	PD2	I/O	TTL	GPIO port D bit 2.
12	CCP5	I/O	TTL	Capture/Compare/PWM 5.
	U1Rx	1	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
	PD3	I/O	TTL	GPIO port D bit 3.
13	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	UlTx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
14	PJ0	I/O	TTL	GPIO port J bit 0.
"	I2C1SCL	I/O	OD	I ² C module 1 clock.
15	PH7	I/O	TTL	GPIO port H bit 7.
13	SSI1Tx	0	TTL	SSI module 1 transmit.
16	PG3	I/O	TTL	GPIO port G bit 3.
17	PG2	I/O	TTL	GPIO port G bit 2.
	PG1	I/O	TTL	GPIO port G bit 1.
18	I2C1SDA	I/O	OD	I ² C module 1 data.
	U2Tx	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.
	PG0	I/O	TTL	GPIO port G bit 0.
19	I2C1SCL	I/O	OD	I ² C module 1 clock.
	U2Rx	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
20	VDD	-	Power	Positive supply for I/O and some logic.
21	GND	-	Power	Ground reference for logic and I/O pins.
	PC7	I/O	TTL	GPIO port C bit 7.
	Clo	0	TTL	Analog comparator 1 output.
22	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	CCP4	I/O	TTL	Capture/Compare/PWM 4.
	UlTx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
	PC6	I/O	TTL	GPIO port C bit 6.
	CCP0	I/O	TTL	Capture/Compare/PWM 0.
23	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	U1Rx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.

Table 18-2. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PC5	I/O	TTL	GPIO port C bit 5.
	C0o	0	TTL	Analog comparator 0 output.
24	C1+	I	Analog	Analog comparator 1 positive input.
24	Clo	0	TTL	Analog comparator 1 output.
	CCP1	I/O	TTL	Capture/Compare/PWM 1.
	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	PC4	I/O	TTL	GPIO port C bit 4.
	CCP1	I/O	TTL	Capture/Compare/PWM 1.
25	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	CCP4	I/O	TTL	Capture/Compare/PWM 4.
	CCP5	I/O	TTL	Capture/Compare/PWM 5.
	PA0	I/O	TTL	GPIO port A bit 0.
	I2C1SCL	I/O	OD	I ² C module 1 clock.
26	U0Rx	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
	U1Rx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
	PA1	I/O	TTL	GPIO port A bit 1.
	I2C1SDA	I/O	OD	I ² C module 1 data.
27	UOTx	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
	UlTx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
28	PA2	I/O	TTL	GPIO port A bit 2.
28	SSI0Clk	I/O	TTL	SSI module 0 clock
20	PA3	I/O	TTL	GPIO port A bit 3.
29	SSIOFss	I/O	TTL	SSI module 0 frame signal
20	PA4	I/O	TTL	GPIO port A bit 4.
30	SSI0Rx	I	TTL	SSI module 0 receive
31	PA5	I/O	TTL	GPIO port A bit 5.
31	SSI0Tx	0	TTL	SSI module 0 transmit
32	VDD	-	Power	Positive supply for I/O and some logic.
33	GND	-	Power	Ground reference for logic and I/O pins.
	PA6	I/O	TTL	GPIO port A bit 6.
34	CCP1	I/O	TTL	Capture/Compare/PWM 1.
34 —	I2C1SCL	I/O	OD	I ² C module 1 clock.
	U1CTS	I	TTL	UART module 1 Clear To Send modem flow control input signal.
	PA7	I/O	TTL	GPIO port A bit 7.
	CCP3	I/O	TTL	Capture/Compare/PWM 3.
35	CCP4	I/O	TTL	Capture/Compare/PWM 4.
	I2C1SDA	I/O	OD	I ² C module 1 data.
	U1DCD	1	TTL	UART module 1 Data Carrier Detect modem status input signal.

Table 18-2. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PG7	I/O	TTL	GPIO port G bit 7.
36	CCP5	I/O	TTL	Capture/Compare/PWM 5.
07	PG6	I/O	TTL	GPIO port G bit 6.
37	U1RI	1	TTL	UART module 1 Ring Indicator modem status input signal.
38	VDDC	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals. The voltage on this pin is 1.3 V and is supplied by the on-chip LDO. The VDDC pins should only be connected to the LDO pin and an external capacitor as specified in .
39	PJ2	I/O	TTL	GPIO port J bit 2.
39	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	PG5	I/O	TTL	GPIO port G bit 5.
40	CCP5	I/O	TTL	Capture/Compare/PWM 5.
	U1DTR	0	TTL	UART module 1 Data Terminal Ready modem status input signal.
	PG4	I/O	TTL	GPIO port G bit 4.
41	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	U1RI	I	TTL	UART module 1 Ring Indicator modem status input signal.
40	PF7	I/O	TTL	GPIO port F bit 7.
42	CCP4	I/O	TTL	Capture/Compare/PWM 4.
	PF6	I/O	TTL	GPIO port F bit 6.
43	CCP1	I/O	TTL	Capture/Compare/PWM 1.
	U1RTS	0	TTL	UART module 1 Request to Send modem flow control output line.
44	VDD	-	Power	Positive supply for I/O and some logic.
45	GND	-	Power	Ground reference for logic and I/O pins.
	PF5	I/O	TTL	GPIO port F bit 5.
46	Clo	0	TTL	Analog comparator 1 output.
40	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	SSI1Tx	0	TTL	SSI module 1 transmit.
47	PF0	I/O	TTL	GPIO port F bit 0.
47	U1DSR	I	TTL	UART module 1 Data Set Ready modem output control line.
48	osc0	I	Analog	Main oscillator crystal input or an external clock reference input.
49	OSC1	0	Analog	Main oscillator crystal output. Leave unconnected when using a single-ended clock source.
50	WAKE	I	TTL	An external input that brings the processor out of Hibernate mode when asserted.
51	HIB	0	OD	An output that indicates the processor is in Hibernate mode.
52	xosc0	I	Analog	Hibernation module oscillator crystal input or an external clock reference input. Note that this is either a 4.194304-MHz crystal or a 32.768-kHz oscillator for the Hibernation module RTC. See the CLKSEL bit in the HIBCTL register.
53	XOSC1	0	Analog	Hibernation module oscillator crystal output. Leave unconnected when using a single-ended clock source.
54	GND	-	Power	Ground reference for logic and I/O pins.

Table 18-2. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
55	VBAT	-	Power	Power source for the Hibernation module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation module power-source supply.
56	VDD	-	Power	Positive supply for I/O and some logic.
57	GND	-	Power	Ground reference for logic and I/O pins.
	PF4	I/O	TTL	GPIO port F bit 4.
EO	C0o	0	TTL	Analog comparator 0 output.
58	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	SSI1Rx	I	TTL	SSI module 1 receive.
59	PF3	I/O	TTL	GPIO port F bit 3.
59	SSI1Fss	I/O	TTL	SSI module 1 frame signal.
60	PF2	I/O	TTL	GPIO port F bit 2.
60	SSI1Clk	I/O	TTL	SSI module 1 clock.
	PF1	I/O	TTL	GPIO port F bit 1.
61	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	U1RTS	0	TTL	UART module 1 Request to Send modem flow control output line.
00	РН6	I/O	TTL	GPIO port H bit 6.
62	SSI1Rx	I	TTL	SSI module 1 receive.
00	РН5	I/O	TTL	GPIO port H bit 5.
63	SSI1Fss	I/O	TTL	SSI module 1 frame signal.
64	RST	I	TTL	System reset input.
G.F.	PB3	I/O	TTL	GPIO port B bit 3.
65	I2C0SDA	I/O	OD	I ² C module 0 data.
	PB0	I/O	TTL	GPIO port B bit 0. This pin is not 5-V tolerant.
66	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	UlRx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
	PB1	I/O	TTL	GPIO port B bit 1. This pin is not 5-V tolerant.
	CCP1	I/O	TTL	Capture/Compare/PWM 1.
67	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	UlTx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
68	VDD	-	Power	Positive supply for I/O and some logic.
69	GND	-	Power	Ground reference for logic and I/O pins.
70	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
71	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
	PB2	I/O	TTL	GPIO port B bit 2.
70	CCP0	I/O	TTL	Capture/Compare/PWM 0.
72	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	I2C0SCL	I/O	OD	I ² C module 0 clock.
73	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.

Table 18-2. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PE0	I/O	TTL	GPIO port E bit 0.
74	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	SSI1Clk	I/O	TTL	SSI module 1 clock.
	PE1	I/O	TTL	GPIO port E bit 1.
75	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	SSI1Fss	I/O	TTL	SSI module 1 frame signal.
76	PH4	I/O	TTL	GPIO port H bit 4.
'6	SSI1Clk	I/O	TTL	SSI module 1 clock.
	PC3	I/O	TTL	GPIO port C bit 3.
77	SWO	0	TTL	JTAG TDO and SWO.
	TDO	0	TTL	JTAG TDO and SWO.
78	PC2	I/O	TTL	GPIO port C bit 2.
	TDI	I	TTL	JTAG TDI.
	PC1	I/O	TTL	GPIO port C bit 1.
79	SWDIO	I/O	TTL	JTAG TMS and SWDIO.
	TMS	I	TTL	JTAG TMS and SWDIO.
	PC0	I/O	TTL	GPIO port C bit 0.
80	SWCLK	I	TTL	JTAG/SWD CLK.
Γ	TCK	I	TTL	JTAG/SWD CLK.
81	VDD	-	Power	Positive supply for I/O and some logic.
82	GND	-	Power	Ground reference for logic and I/O pins.
83	РН3	I/O	TTL	GPIO port H bit 3.
84	PH2	I/O	TTL	GPIO port H bit 2.
04	Clo	0	TTL	Analog comparator 1 output.
85	PH1	I/O	TTL	GPIO port H bit 1.
86	РН0	I/O	TTL	GPIO port H bit 0.
87	PJ1	I/O	TTL	GPIO port J bit 1.
01	I2C1SDA	I/O	OD	I ² C module 1 data.
88	VDDC	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals. The voltage on this pin is 1.3 V and is supplied by the on-chip LDO. The VDDC pins should only be connected to the LDO pin and an external capacitor as specified in .
89	PB7	I/O	TTL	GPIO port B bit 7.
09	NMI	I	TTL	Non-maskable interrupt.

Table 18-2. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description	
	PB6	I/O	TTL	GPIO port B bit 6.	
	C0+	I	Analog	Analog comparator 0 positive input.	
	C0o	0	TTL	Analog comparator 0 output.	
	CCP1	I/O	TTL	Capture/Compare/PWM 1.	
90	CCP5	I/O	TTL	Capture/Compare/PWM 5.	
	VREFA	I	Analog	This input provides a reference voltage used to specify the input voltage at which the ADC converts to a maximum value. In other words, the voltage that is applied to VREFA is the voltage with which an AINn signal is converted to 1023. The VREFA input is limited to the range specified in Table 20-22 on page 809.	
	PB5	I/O	TTL	GPIO port B bit 5.	
	C0o	0	TTL	Analog comparator 0 output.	
	C1-	1	Analog	Analog comparator 1 negative input.	
91	CCP0	I/O	TTL	Capture/Compare/PWM 0.	
0.	CCP2	I/O	TTL	Capture/Compare/PWM 2.	
	CCP5	I/O	TTL	Capture/Compare/PWM 5.	
	U1Tx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.	
	PB4	I/O	TTL	GPIO port B bit 4.	
	C0-	I	Analog	Analog comparator 0 negative input.	
92	UlRx	1	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.	
	U2Rx	1	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.	
93	VDD	-	Power	Positive supply for I/O and some logic.	
94	GND	-	Power	Ground reference for logic and I/O pins.	
	PE2	I/O	TTL	GPIO port E bit 2.	
0.5	CCP2	I/O	TTL	Capture/Compare/PWM 2.	
95	CCP4	I/O	TTL	Capture/Compare/PWM 4.	
	SSI1Rx	I	TTL	SSI module 1 receive.	
	PE3	I/O	TTL	GPIO port E bit 3.	
96	CCP1	I/O	TTL	Capture/Compare/PWM 1.	
-	SSI1Tx	0	TTL	SSI module 1 transmit.	
	PD4	I/O	TTL	GPIO port D bit 4.	
	AIN7	I	Analog	Analog-to-digital converter input 7.	
97	CCP0	I/O	TTL	Capture/Compare/PWM 0.	
	CCP3	I/O	TTL	Capture/Compare/PWM 3.	
	UlRI	ı	TTL	UART module 1 Ring Indicator modem status input signal.	
	PD5	I/O	TTL	GPIO port D bit 5.	
	AIN6	I	Analog	Analog-to-digital converter input 6.	
98	CCP2	I/O	TTL	Capture/Compare/PWM 2.	
	CCP4	I/O	TTL	Capture/Compare/PWM 4.	
	U2Rx	1	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.	

Table 18-2. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description	
99	PD6	I/O	TTL	GPIO port D bit 6.	
	AIN5	I	Analog	Analog-to-digital converter input 5.	
	U2Tx	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.	
100	PD7	I/O	TTL	GPIO port D bit 7.	
	AIN4	I	Analog	Analog-to-digital converter input 4.	
	C0o	0	TTL	Analog comparator 0 output.	
	CCP1	I/O	TTL	Capture/Compare/PWM 1.	
	U1DTR	0	TTL	UART module 1 Data Terminal Ready modem status input signal.	

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

18.1.2 Signals by Signal Name

Table 18-3. Signals by Signal Name

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
AIN0	1	PE7	I	Analog	Analog-to-digital converter input 0.
AIN1	2	PE6	I	Analog	Analog-to-digital converter input 1.
AIN2	5	PE5	I	Analog	Analog-to-digital converter input 2.
AIN3	6	PE4	I	Analog	Analog-to-digital converter input 3.
AIN4	100	PD7	I	Analog	Analog-to-digital converter input 4.
AIN5	99	PD6	I	Analog	Analog-to-digital converter input 5.
AIN6	98	PD5	I	Analog	Analog-to-digital converter input 6.
AIN7	97	PD4	I	Analog	Analog-to-digital converter input 7.
C0+	90	PB6	I	Analog	Analog comparator 0 positive input.
C0-	92	PB4	Į	Analog	Analog comparator 0 negative input.
C0o	24 58 90 91 100	PC5 (3) PF4 (2) PB6 (3) PB5 (1) PD7 (2)	0	TTL	Analog comparator 0 output.
C1+	24	PC5	I	Analog	Analog comparator 1 positive input.
C1-	91	PB5	I	Analog	Analog comparator 1 negative input.
Clo	2 22 24 46 84	PE6 (2) PC7 (7) PC5 (2) PF5 (2) PH2 (2)	0	TTL	Analog comparator 1 output.
CCP0	13 22 23 39 58 66 72 91 97	PD3 (4) PC7 (4) PC6 (6) PJ2 (9) PF4 (1) PB0 (1) PB2 (5) PB5 (4) PD4 (1)	I/O	TTL	Capture/Compare/PWM 0.

Table 18-3. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
CCP1	24 25 34 43 67 90 96 100	PC5 (1) PC4 (9) PA6 (2) PF6 (1) PB1 (4) PB6 (1) PE3 (1) PD7 (3)	I/O	TTL	Capture/Compare/PWM 1.
CCP2	6 11 25 46 67 75 91 95	PE4 (6) PD1 (10) PC4 (5) PF5 (1) PB1 (1) PE1 (4) PB5 (6) PE2 (5) PD5 (1)	I/O	TTL	Capture/Compare/PWM 2.
CCP3	6 23 24 35 41 61 72 74	PE4 (1) PC6 (1) PC5 (5) PA7 (7) PG4 (1) PF1 (10) PB2 (4) PE0 (3) PD4 (2)	I/O	TTL	Capture/Compare/PWM 3.
CCP4	22 25 35 42 95 98	PC7 (1) PC4 (6) PA7 (2) PF7 (1) PE2 (1) PD5 (2)	I/O	TTL	Capture/Compare/PWM 4.
CCP5	5 12 25 36 40 90 91	PE5 (1) PD2 (4) PC4 (1) PG7 (8) PG5 (1) PB6 (6) PB5 (2)	I/O	TTL	Capture/Compare/PWM 5.
GND	9 21 33 45 54 57 69 82 94	fixed	-	Power	Ground reference for logic and I/O pins.
GNDA	4	fixed	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.
HIB	51	fixed	0	OD	An output that indicates the processor is in Hibernate mode.
I2C0SCL	72	PB2 (1)	I/O	OD	I ² C module 0 clock.

Table 18-3. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
I2C0SDA	65	PB3 (1)	I/O	OD	I ² C module 0 data.
I2C1SCL	14 19 26 34	PJ0 (11) PG0 (3) PA0 (8) PA6 (1)	I/O	OD	I ² C module 1 clock.
I2C1SDA	18 27 35 87	PG1 (3) PA1 (8) PA7 (1) PJ1 (11)	I/O	OD	I ² C module 1 data.
LDO	7	fixed	-	Power	Low drop-out regulator output voltage. This pin requires an external capacitor between the pin and GND of 1 μ F or greater. The LDO pin must also be connected to the VDDC pins at the board level in addition to the decoupling capacitor(s).
NC	70 71 73	fixed	-	-	No connect. Leave the pin electrically unconnected/isolated.
NMI	89	PB7 (4)	I	TTL	Non-maskable interrupt.
osc0	48	fixed	I	Analog	Main oscillator crystal input or an external clock reference input.
osc1	49	fixed	0	Analog	Main oscillator crystal output. Leave unconnected when using a single-ended clock source.
PA0	26	-	I/O	TTL	GPIO port A bit 0.
PA1	27	-	I/O	TTL	GPIO port A bit 1.
PA2	28	-	I/O	TTL	GPIO port A bit 2.
PA3	29	-	I/O	TTL	GPIO port A bit 3.
PA4	30	-	I/O	TTL	GPIO port A bit 4.
PA5	31	-	I/O	TTL	GPIO port A bit 5.
PA6	34	-	I/O	TTL	GPIO port A bit 6.
PA7	35	-	I/O	TTL	GPIO port A bit 7.
PB0	66	-	I/O	TTL	GPIO port B bit 0. This pin is not 5-V tolerant.
PB1	67	-	I/O	TTL	GPIO port B bit 1. This pin is not 5-V tolerant.
PB2	72	-	I/O	TTL	GPIO port B bit 2.
PB3	65	-	I/O	TTL	GPIO port B bit 3.
PB4	92	-	I/O	TTL	GPIO port B bit 4.
PB5	91	-	I/O	TTL	GPIO port B bit 5.
PB6	90	-	I/O	TTL	GPIO port B bit 6.
PB7	89	-	I/O	TTL	GPIO port B bit 7.
PC0	80	-	I/O	TTL	GPIO port C bit 0.
PC1	79	-	I/O	TTL	GPIO port C bit 1.
PC2	78	-	I/O	TTL	GPIO port C bit 2.
PC3	77	-	I/O	TTL	GPIO port C bit 3.
PC4	25	-	I/O	TTL	GPIO port C bit 4.
PC5	24	-	I/O	TTL	GPIO port C bit 5.
PC6	23	-	I/O	TTL	GPIO port C bit 6.

Table 18-3. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
PC7	22	-	I/O	TTL	GPIO port C bit 7.
PD0	10	-	I/O	TTL	GPIO port D bit 0.
PD1	11	-	I/O	TTL	GPIO port D bit 1.
PD2	12	-	I/O	TTL	GPIO port D bit 2.
PD3	13	-	I/O	TTL	GPIO port D bit 3.
PD4	97	-	I/O	TTL	GPIO port D bit 4.
PD5	98	-	I/O	TTL	GPIO port D bit 5.
PD6	99	-	I/O	TTL	GPIO port D bit 6.
PD7	100	-	I/O	TTL	GPIO port D bit 7.
PE0	74	-	I/O	TTL	GPIO port E bit 0.
PE1	75	-	I/O	TTL	GPIO port E bit 1.
PE2	95	-	I/O	TTL	GPIO port E bit 2.
PE3	96	-	I/O	TTL	GPIO port E bit 3.
PE4	6	-	I/O	TTL	GPIO port E bit 4.
PE5	5	-	I/O	TTL	GPIO port E bit 5.
PE6	2	-	I/O	TTL	GPIO port E bit 6.
PE7	1	-	I/O	TTL	GPIO port E bit 7.
PF0	47	-	I/O	TTL	GPIO port F bit 0.
PF1	61	-	I/O	TTL	GPIO port F bit 1.
PF2	60	-	I/O	TTL	GPIO port F bit 2.
PF3	59	-	I/O	TTL	GPIO port F bit 3.
PF4	58	-	I/O	TTL	GPIO port F bit 4.
PF5	46	-	I/O	TTL	GPIO port F bit 5.
PF6	43	-	I/O	TTL	GPIO port F bit 6.
PF7	42	-	I/O	TTL	GPIO port F bit 7.
PG0	19	-	I/O	TTL	GPIO port G bit 0.
PG1	18	-	I/O	TTL	GPIO port G bit 1.
PG2	17	-	I/O	TTL	GPIO port G bit 2.
PG3	16	-	I/O	TTL	GPIO port G bit 3.
PG4	41	-	I/O	TTL	GPIO port G bit 4.
PG5	40	-	I/O	TTL	GPIO port G bit 5.
PG6	37	-	I/O	TTL	GPIO port G bit 6.
PG7	36	-	I/O	TTL	GPIO port G bit 7.
PH0	86	-	I/O	TTL	GPIO port H bit 0.
PH1	85	-	I/O	TTL	GPIO port H bit 1.
PH2	84	-	I/O	TTL	GPIO port H bit 2.
РН3	83	-	I/O	TTL	GPIO port H bit 3.
PH4	76	-	I/O	TTL	GPIO port H bit 4.
PH5	63	-	I/O	TTL	GPIO port H bit 5.
РН6	62	-	I/O	TTL	GPIO port H bit 6.
PH7	15	-	I/O	TTL	GPIO port H bit 7.

Table 18-3. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
РЈ0	14	-	I/O	TTL	GPIO port J bit 0.
PJ1	87	-	I/O	TTL	GPIO port J bit 1.
PJ2	39	-	I/O	TTL	GPIO port J bit 2.
RST	64	fixed	I	TTL	System reset input.
SSI0Clk	28	PA2 (1)	I/O	TTL	SSI module 0 clock
SSI0Fss	29	PA3 (1)	I/O	TTL	SSI module 0 frame signal
SSI0Rx	30	PA4 (1)	I	TTL	SSI module 0 receive
SSIOTx	31	PA5 (1)	0	TTL	SSI module 0 transmit
SSI1Clk	60 74 76	PF2 (9) PE0 (2) PH4 (11)	I/O	TTL	SSI module 1 clock.
SSI1Fss	59 63 75	PF3 (9) PH5 (11) PE1 (2)	I/O	TTL	SSI module 1 frame signal.
SSI1Rx	58 62 95	PF4 (9) PH6 (11) PE2 (2)	I	TTL	SSI module 1 receive.
SSI1Tx	15 46 96	PH7 (11) PF5 (9) PE3 (2)	0	TTL	SSI module 1 transmit.
SWCLK	80	PC0 (3)	I	TTL	JTAG/SWD CLK.
SWDIO	79	PC1 (3)	I/O	TTL	JTAG TMS and SWDIO.
SWO	77	PC3 (3)	0	TTL	JTAG TDO and SWO.
TCK	80	PC0 (3)	1	TTL	JTAG/SWD CLK.
TDI	78	PC2 (3)	I	TTL	JTAG TDI.
TDO	77	PC3 (3)	0	TTL	JTAG TDO and SWO.
TMS	79	PC1 (3)	I	TTL	JTAG TMS and SWDIO.
U0Rx	26	PA0 (1)	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
UOTx	27	PA1 (1)	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
U1CTS	2 10 34	PE6 (9) PD0 (9) PA6 (9)	I	TTL	UART module 1 Clear To Send modem flow control input signal.
U1DCD	1 11 35	PE7 (9) PD1 (9) PA7 (9)	I	TTL	UART module 1 Data Carrier Detect modem status input signal.
U1DSR	47	PF0 (9)	I	TTL	UART module 1 Data Set Ready modem output control line.
U1DTR	40 100	PG5 (10) PD7 (9)	0	TTL	UART module 1 Data Terminal Ready modem status input signal.
UlRI	37 41 97	PG6 (10) PG4 (10) PD4 (9)	I	TTL	UART module 1 Ring Indicator modem status input signal.
U1RTS	43 61	PF6 (10) PF1 (9)	0	TTL	UART module 1 Request to Send modem flow control output line.

Table 18-3. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
U1Rx	10 12 23 26 66 92	PD0 (5) PD2 (1) PC6 (5) PA0 (9) PB0 (5) PB4 (7)	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
UlTx	11 13 22 27 67 91	PD1 (5) PD3 (1) PC7 (5) PA1 (9) PB1 (5) PB5 (7)	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
U2Rx	10 19 92 98	PD0 (4) PG0 (1) PB4 (4) PD5 (9)	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
U2Tx	6 11 18 99	PE4 (5) PD1 (4) PG1 (1) PD6 (9)	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.
VBAT	55	fixed	-	Power	Power source for the Hibernation module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation module power-source supply.
VDD	8 20 32 44 56 68 81 93	fixed	-	Power	Positive supply for I/O and some logic.
VDDA	3	fixed	-	Power	The positive supply for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions. VDDA pins must be supplied with a voltage that meets the specification in Table 20-2 on page 797, regardless of system implementation.
VDDC	38 88	fixed	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals. The voltage on this pin is 1.3 V and is supplied by the on-chip LDO. The VDDC pins should only be connected to the LDO pin and an external capacitor as specified in .
VREFA	90	PB6	I	Analog	This input provides a reference voltage used to specify the input voltage at which the ADC converts to a maximum value. In other words, the voltage that is applied to VREFA is the voltage with which an AINn signal is converted to 1023. The VREFA input is limited to the range specified in Table 20-22 on page 809.
WAKE	50	fixed	I	TTL	An external input that brings the processor out of Hibernate mode when asserted.

Table 18-3. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
xosc0	52	fixed	I	Analog	Hibernation module oscillator crystal input or an external clock reference input. Note that this is either a 4.194304-MHz crystal or a 32.768-kHz oscillator for the Hibernation module RTC. See the CLKSEL bit in the HIBCTL register.
XOSC1	53	fixed	0	Analog	Hibernation module oscillator crystal output. Leave unconnected when using a single-ended clock source.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

18.1.3 Signals by Function, Except for GPIO

Table 18-4. Signals by Function, Except for GPIO

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	AIN0	1	I	Analog	Analog-to-digital converter input 0.
	AIN1	2	I	Analog	Analog-to-digital converter input 1.
	AIN2	5	I	Analog	Analog-to-digital converter input 2.
	AIN3	6	I	Analog	Analog-to-digital converter input 3.
	AIN4	100	I	Analog	Analog-to-digital converter input 4.
	AIN5	99	I	Analog	Analog-to-digital converter input 5.
ADC	AIN6	98	I	Analog	Analog-to-digital converter input 6.
	AIN7	97	I	Analog	Analog-to-digital converter input 7.
	VREFA	90 1	I	Analog	This input provides a reference voltage used to specify the input voltage at which the ADC converts to a maximum value. In other words, the voltage that is applied to VREFA is the voltage with which an AINn signal is converted to 1023. The VREFA input is limited to the range specified in Table 20-22 on page 809.
	C0+	90	I	Analog	Analog comparator 0 positive input.
	C0-	92	I	Analog	Analog comparator 0 negative input.
Analog Comparators	C0o	24 58 90 91 100	0	TTL	Analog comparator 0 output.
Analog Comparators	C1+	24	I	Analog	Analog comparator 1 positive input.
	C1-	91	I	Analog	Analog comparator 1 negative input.
	C10	2 22 24 46 84	0	TTL	Analog comparator 1 output.

Table 18-4. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	CCP0	13 22 23 39 58 66 72 91	I/O	TTL	Capture/Compare/PWM 0.
	CCP1	24 25 34 43 67 90 96 100	I/O	TTL	Capture/Compare/PWM 1.
General-Purpose Timers	CCP2	6 11 25 46 67 75 91 95	I/O	TTL	Capture/Compare/PWM 2.
Ilmers	CCP3	6 23 24 35 41 61 72 74	I/O	TTL	Capture/Compare/PWM 3.
	CCP4	22 25 35 42 95 98	I/O	TTL	Capture/Compare/PWM 4.
	CCP5	5 12 25 36 40 90 91	I/O	TTL	Capture/Compare/PWM 5.

Table 18-4. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	HIB	51	0	OD	An output that indicates the processor is in Hibernate mode.
	VBAT	55	-	Power	Power source for the Hibernation module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation module power-source supply.
Hibernate	WAKE	50	I	TTL	An external input that brings the processor out of Hibernate mode when asserted.
Tiberrate	xosc0	52	I	Analog	Hibernation module oscillator crystal input or an external clock reference input. Note that this is either a 4.194304-MHz crystal or a 32.768-kHz oscillator for the Hibernation module RTC. See the CLKSEL bit in the HIBCTL register.
	xosc1	53	0	Analog	Hibernation module oscillator crystal output. Leave unconnected when using a single-ended clock source.
	I2C0SCL	72	I/O	OD	I ² C module 0 clock.
	I2C0SDA	65	I/O	OD	I ² C module 0 data.
12C	I2C1SCL	14 19 26 34	I/O	OD	I ² C module 1 clock.
	I2C1SDA	18 27 35 87	I/O	OD	I ² C module 1 data.
	SWCLK	80	I	TTL	JTAG/SWD CLK.
	SWDIO	79	I/O	TTL	JTAG TMS and SWDIO.
	SWO	77	0	TTL	JTAG TDO and SWO.
JTAG/SWD/SWO	TCK	80	I	TTL	JTAG/SWD CLK.
	TDI	78	I	TTL	JTAG TDI.
	TDO	77	0	TTL	JTAG TDO and SWO.
	TMS	79	I	TTL	JTAG TMS and SWDIO.

Table 18-4. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	GND	9 21 33 45 54 57 69 82 94	-	Power	Ground reference for logic and I/O pins.
	GNDA	4	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.
	LDO	7	-	Power	Low drop-out regulator output voltage. This pin requires an external capacitor between the pin and GND of 1 μ F or greater. The LDO pin must also be connected to the VDDC pins at the board level in addition to the decoupling capacitor(s).
Power	VDD	8 20 32 44 56 68 81 93	-	Power	Positive supply for I/O and some logic.
	VDDA	3	-	Power	The positive supply for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions. VDDA pins must be supplied with a voltage that meets the specification in Table 20-2 on page 797, regardless of system implementation.
	VDDC	38 88	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals. The voltage on this pin is 1.3 V and is supplied by the on-chip LDO. The VDDC pins should only be connected to the LDO pin and an external capacitor as specified in .

Table 18-4. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	SSI0Clk	28	I/O	TTL	SSI module 0 clock
	SSI0Fss	29	I/O	TTL	SSI module 0 frame signal
	SSI0Rx	30	I	TTL	SSI module 0 receive
	SSIOTx	31	0	TTL	SSI module 0 transmit
	SSI1Clk	60 74 76	I/O	TTL	SSI module 1 clock.
SSI	SSI1Fss	59 63 75	I/O	TTL	SSI module 1 frame signal.
	SSI1Rx	58 62 95	I	TTL	SSI module 1 receive.
	SSI1Tx	15 46 96	0	TTL	SSI module 1 transmit.
	NMI	89	1	TTL	Non-maskable interrupt.
System Control &	osc0	48	I	Analog	Main oscillator crystal input or an external clock reference input.
Clocks	osc1	49	0	Analog	Main oscillator crystal output. Leave unconnected when using a single-ended clock source.
	RST	64	I	TTL	System reset input.

Table 18-4. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	U0Rx	26	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
	U0Tx	27	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
	U1CTS	2 10 34	I	TTL	UART module 1 Clear To Send modem flow control input signal.
	U1DCD	1 11 35	I	TTL	UART module 1 Data Carrier Detect modem status input signal.
	U1DSR	47	I	TTL	UART module 1 Data Set Ready modem output control line.
	U1DTR	40 100	0	TTL	UART module 1 Data Terminal Ready modem status input signal.
	U1RI	37 41 97	I	TTL	UART module 1 Ring Indicator modem status input signal.
UART	U1RTS	43 61	0	TTL	UART module 1 Request to Send modem flow control output line.
	UlRx	10 12 23 26 66 92	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
U1Tx U2Rx	UlTx	11 13 22 27 67 91	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
	U2Rx	10 19 92 98	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
	U2Tx	6 11 18 99	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

18.1.4 GPIO Pins and Alternate Functions

Table 18-5. GPIO Pins and Alternate Functions

Ю	Pin	Analog Function	Digital Function (GPIOPCTL PMCx Bit Field Encoding) ^a										
10			1	2	3	4	5	6	7	8	9	10	11
PA0	26	-	U0Rx	-	-	-	-	-	-	I2C1SCL	U1Rx	-	-
PA1	27	-	UOTx	-	-	-	-	-	-	I2C1SDA	UlTx	-	-
PA2	28	-	SSI0Clk	-	-	-	-	-	-	-	-	-	-
PA3	29	-	SSI0Fss	-	-	-	i	-	-	-	-	-	-

Table 18-5. GPIO Pins and Alternate Functions (continued)

10	Pin	Analog			Digi	ital Funct	ion (GPIO	PCTL PM	Cx Bit Fiel	ld Encodi	ing) ^a		
10	PIII	Function	1	2	3	4	5	6	7	8	9	10	11
PA4	30	-	SSI0Rx	-	-	-	-	-	-	-	-	-	-
PA5	31	-	SSIOTx	-	-	-	-	-	-	-	-	-	-
PA6	34	-	I2C1SCL	CCP1	-	-	-	-	-	-	U1CTS	-	-
PA7	35	-	I2C1SDA	CCP4	-	-	-	-	CCP3	-	U1DCD	-	-
PB0	66	-	CCP0	-	-	-	U1Rx	-	-	-	-	-	-
PB1	67	-	CCP2	-	-	CCP1	U1Tx	-	-	-	-	-	-
PB2	72	-	I2C0SCL	-	-	CCP3	CCP0	-	-	-	-	-	-
PB3	65	-	I2C0SDA	-	-	-	-	-	-	-	-	-	-
PB4	92	C0-	-	-	-	U2Rx	-	-	U1Rx	-	-	-	-
PB5	91	C1-	C0o	CCP5	-	CCP0	-	CCP2	U1Tx	-	-	-	-
PB6	90	VREFA C0+	CCP1	-	C00	-	-	CCP5	-	-	-	-	-
PB7	89	-	-	-	-	NMI	-	-	-	-	-	-	-
PC0	80	-	-	-	TCK SWCLK	-	-	-	-	-	-	-	-
PC1	79	-	-	-	TMS SWDIO	-	-	-	-	-	-	-	-
PC2	78	-	-	-	TDI	-	-	-	-	-	-	-	-
PC3	77	-	-	-	TDO SWO	-	-	-	-	-	-	-	-
PC4	25	-	CCP5	-	-	-	CCP2	CCP4	-	-	CCP1	-	-
PC5	24	C1+	CCP1	C1o	C0o	-	CCP3	-	-	-	-	-	-
PC6	23	-	CCP3	-	-	-	U1Rx	CCP0	-	-	-	-	-
PC7	22	-	CCP4	-	-	CCP0	U1Tx	-	C1o	-	-	-	-
PD0	10	-	-	-	-	U2Rx	U1Rx	-	-	-	U1CTS	-	-
PD1	11	-	-	-	-	U2Tx	U1Tx	-	-	-	U1DCD	CCP2	-
PD2	12	-	U1Rx	-	-	CCP5	-	-	-	-	-	-	-
PD3	13	-	U1Tx	-	-	CCP0	-	-	-	-	-	-	-
PD4	97	AIN7	CCP0	CCP3	-	-	-	-	-	-	U1RI	-	-
PD5	98	AIN6	CCP2	CCP4	-	-	-	-	-	-	U2Rx	-	-
PD6	99	AIN5	-	-	-	-	-	-	-	-	U2Tx	-	-
PD7	100	AIN4	-	C0o	CCP1	-	-	-	-	-	U1DTR	-	-
PE0	74	-	-	SSI1Clk	CCP3	-	-	-	-	-	-	-	-
PE1	75	-	-	SSI1Fss	-	CCP2	-	-	-	-	-	-	-
PE2	95	-	CCP4	SSI1Rx	-	-	CCP2	-	-	-	-	-	-
PE3	96	-	CCP1	SSI1Tx	-	-	-	-	-	-	-	-	-
PE4	6	AIN3	CCP3	-	-	-	U2Tx	CCP2	-	-	-	-	-
PE5	5	AIN2	CCP5	-	-	-	-	-	-	-	-	-	-
PE6	2	AIN1	-	C1o	-	-	-	-	-	-	U1CTS	-	-
PE7	1	AIN0	-	-	-	-	-	-	-	-	U1DCD	-	-
PF0	47	-	-	-	-	-	-	-	-	-	U1DSR	-	-

Table 18-5. GPIO Pins and Alternate Functions (continued)

10	Din	Analog			Digi	tal Funct	ion (GPIO	PCTL PM	Cx Bit Fie	ld Encodi	ng) ^a		
Ю	Pin	Function	1	2	3	4	5	6	7	8	9	10	11
PF1	61	-	-	-	-	-	-	-	-	-	U1RTS	CCP3	-
PF2	60	-	-	-	-	-	-	-	-	-	SSI1Clk	-	-
PF3	59	-	-	-	-	-	-	-	-	-	SSI1Fss	-	-
PF4	58	-	CCP0	C0o	-	-	-	-	-	-	SSI1Rx	-	-
PF5	46	-	CCP2	C1o	-	-	-	-	-	-	SSI1Tx	-	-
PF6	43	-	CCP1	-	-	-	-	-	-	-	-	Ulrts	-
PF7	42	-	CCP4	-	-	-	-	-	-	-	-	-	-
PG0	19	-	U2Rx	-	I2C1SCL	-	-	-	-	-	-	-	-
PG1	18	-	U2Tx	-	I2C1SDA	-	-	-	-	-	-	-	-
PG2	17	-	-	-	-	-	-	-	-	-	-	-	-
PG3	16	-	-	-	-	-	-	-	-	-	-	-	-
PG4	41	-	CCP3	-	-	-	-	-	-	-	-	U1RI	-
PG5	40	-	CCP5	-	-	-	-	-	-	-	-	U1DTR	-
PG6	37	-	-	-	-	-	-	-	-	-	-	U1RI	-
PG7	36	-	-	-	-	-	-	-	-	CCP5	-	-	-
PH0	86	-	-	-	-	-	-	-	-	-	-	-	-
PH1	85	-	-	-	-	-	-	-	-	-	-	-	-
PH2	84	-	-	C1o	-	-	-	-	-	-	-	-	-
PH3	83	-	-	-	-	-	-	-	-	-	-	-	-
PH4	76	-	-	-	-	-	-	-	-	-	-	-	SSI1Clk
PH5	63	-	-	-	-	-	-	-	-	-	-	-	SSI1Fss
РНб	62	-	-	-	-	-	-	-	-	-	-	-	SSI1Rx
PH7	15	-	-	-	-	-	-	-	-	-	-	-	SSI1Tx
рј0	14	-	-	-	-	-	-	-	-	-	-	-	I2C1SCL
PJ1	87	-	-	-	-	-	-	-	-	-	-	-	I2C1SDA
РЈ2	39	-	-	-	-	-	-	-	-	-	CCP0	-	-

a. The digital signals that are shaded gray are the power-on default values for the corresponding GPIO pin.

18.1.5 Possible Pin Assignments for Alternate Functions

Table 18-6. Possible Pin Assignments for Alternate Functions

# of Possible Assignments	Alternate Function	GPIO Function
	AIN0	PE7
	AIN1	PE6
	AIN2	PE5
	AIN3	PE4
	AIN4	PD7
	AIN5	PD6
	AIN6	PD5
	AIN7	PD4
	C0+	PB6
	C0-	PB4
	C1+	PC5
	C1-	PB5
	I2C0SCL	PB2
	I2C0SDA	PB3
	NMI	PB7
one	SSIOClk	PA2
	SSI0Fss	PA3
	SSIORx	PA4
	SSIOTx	PA5
	SWCLK	PC0
	SWDIO	PC1
	SWO	PC3
	TCK	PC0
	TDI	PC2
	TDO	PC3
	TMS	PC1
	UORx	PA0
	UOTx	PA1
	U1DSR	PF0
	VREFA	PB6
huo	U1DTR	PD7 PG5
two	U1RTS	PF1 PF6
	SSI1Clk	PE0 PF2 PH4
	SSI1Fss	PE1 PF3 PH5
	SSI1Rx	PE2 PF4 PH6
three	SSI1Tx	PE3 PF5 PH7
	Ulcts	PA6 PD0 PE6
	U1DCD	PA7 PD1 PE7
	U1RI	PD4 PG4 PG6

Table 18-6. Possible Pin Assignments for Alternate Functions (continued)

# of Possible Assignments	Alternate Function	GPIO Function		
	I2C1SCL	PA0 PA6 PG0 PJ0		
four	I2C1SDA	PA1 PA7 PG1 PJ1		
loui	U2Rx	PB4 PD0 PD5 PG0		
	U2Tx	PD1 PD6 PE4 PG1		
five	C0o	PB5 PB6 PC5 PD7 PF4		
live	Clo	PC5 PC7 PE6 PF5 PH2		
	CCP4	PA7 PC4 PC7 PD5 PE2 PF7		
six	UlRx	PA0 PB0 PB4 PC6 PD0 PD2		
	UlTx	PA1 PB1 PB5 PC7 PD1 PD3		
seven	CCP5	PB5 PB6 PC4 PD2 PE5 PG5 PG7		
eight	CCP1	PA6 PB1 PB6 PC4 PC5 PD7 PE3 PF6		
	CCP0	PB0 PB2 PB5 PC6 PC7 PD3 PD4 PF4 PJ2		
nine	CCP2	PB1 PB5 PC4 PD1 PD5 PE1 PE2 PE4 PF5		
	CCP3	PA7 PB2 PC5 PC6 PD4 PE0 PE4 PF1 PG4		

18.2 108-Ball BGA Package Pin Tables

18.2.1 Signals by Pin Number

Table 18-7. Signals by Pin Number

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PE6	I/O	TTL	GPIO port E bit 6.
A1	AIN1	I	Analog	Analog-to-digital converter input 1.
	C1o	0	TTL	Analog comparator 1 output.
	U1CTS	I	TTL	UART module 1 Clear To Send modem flow control input signal.
	PD7	I/O	TTL	GPIO port D bit 7.
	AIN4	1	Analog	Analog-to-digital converter input 4.
A2	C0o	0	TTL	Analog comparator 0 output.
	CCP1	I/O	TTL	Capture/Compare/PWM 1.
	U1DTR	0	TTL	UART module 1 Data Terminal Ready modem status input signal.
	PD6	I/O	TTL	GPIO port D bit 6.
A3	AIN5	I	Analog	Analog-to-digital converter input 5.
	U2Tx	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.
	PE2	I/O	TTL	GPIO port E bit 2.
A4	CCP2	I/O	TTL	Capture/Compare/PWM 2.
A4	CCP4	I/O	TTL	Capture/Compare/PWM 4.
	SSI1Rx	I	TTL	SSI module 1 receive.
A5	GNDA	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.

Table 18-7. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PB4	I/O	TTL	GPIO port B bit 4.
	C0-	I	Analog	Analog comparator 0 negative input.
A6	U1Rx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
	U2Rx	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
	PB6	I/O	TTL	GPIO port B bit 6.
	C0+	I	Analog	Analog comparator 0 positive input.
	C0o	0	TTL	Analog comparator 0 output.
	CCP1	I/O	TTL	Capture/Compare/PWM 1.
A7	CCP5	I/O	TTL	Capture/Compare/PWM 5.
	VREFA	I	Analog	This input provides a reference voltage used to specify the input voltage at which the ADC converts to a maximum value. In other words, the voltage that is applied to VREFA is the voltage with which an AINn signal is converted to 1023. The VREFA input is limited to the range specified in Table 20-22 on page 809.
A8 -	PB7	I/O	TTL	GPIO port B bit 7.
Α0	NMI	I	TTL	Non-maskable interrupt.
	PC0	I/O	TTL	GPIO port C bit 0.
A9	SWCLK	I	TTL	JTAG/SWD CLK.
	TCK	I	TTL	JTAG/SWD CLK.
	PC3	I/O	TTL	GPIO port C bit 3.
A10	SWO	0	TTL	JTAG TDO and SWO.
	TDO	0	TTL	JTAG TDO and SWO.
	PB2	I/O	TTL	GPIO port B bit 2.
A11	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	I2C0SCL	I/O	OD	I ² C module 0 clock.
	PE1	I/O	TTL	GPIO port E bit 1.
A12	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	SSI1Fss	I/O	TTL	SSI module 1 frame signal.
	PE7	I/O	TTL	GPIO port E bit 7.
B1	AIN0	I	Analog	Analog-to-digital converter input 0.
	U1DCD	I	TTL	UART module 1 Data Carrier Detect modem status input signal.
	PE4	I/O	TTL	GPIO port E bit 4.
	AIN3	I	Analog	Analog-to-digital converter input 3.
B2	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	U2Tx	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.
	PE5	I/O	TTL	GPIO port E bit 5.
В3	AIN2	1	Analog	Analog-to-digital converter input 2.
	CCP5	I/O	TTL	Capture/Compare/PWM 5.
			1	I .

Table 18-7. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PE3	I/O	TTL	GPIO port E bit 3.
B4	CCP1	I/O	TTL	Capture/Compare/PWM 1.
	SSI1Tx	0	TTL	SSI module 1 transmit.
	PD4	I/O	TTL	GPIO port D bit 4.
	AIN7	I	Analog	Analog-to-digital converter input 7.
B5	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	U1RI	I	TTL	UART module 1 Ring Indicator modem status input signal.
B6 -	PJ1	I/O	TTL	GPIO port J bit 1.
	I2C1SDA	I/O	OD	I ² C module 1 data.
	PB5	I/O	TTL	GPIO port B bit 5.
	C0o	0	TTL	Analog comparator 0 output.
	C1-	I	Analog	Analog comparator 1 negative input.
В7	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	CCP5	I/O	TTL	Capture/Compare/PWM 5.
	U1Tx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
B8 -	PC2	I/O	TTL	GPIO port C bit 2.
	TDI	I	TTL	JTAG TDI.
	PC1	I/O	TTL	GPIO port C bit 1.
В9	SWDIO	I/O	TTL	JTAG TMS and SWDIO.
	TMS	I	TTL	JTAG TMS and SWDIO.
B10 -	PH4	I/O	TTL	GPIO port H bit 4.
	SSI1Clk	I/O	TTL	SSI module 1 clock.
	PE0	I/O	TTL	GPIO port E bit 0.
B11	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	SSI1Clk	I/O	TTL	SSI module 1 clock.
B12	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
C1	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
C2	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
С3	VDDC	_	Power	Positive supply for most of the logic function, including the processor core and most peripherals. The voltage on this pin is 1.3 V and is supplied by the on-chip LDO. The \mathtt{VDDC} pins should only be connected to the \mathtt{LDO} pin and an external capacitor as specified in .
C4	GND	-	Power	Ground reference for logic and I/O pins.
C5	GND	-	Power	Ground reference for logic and I/O pins.

Table 18-7. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PD5	I/O	TTL	GPIO port D bit 5.
	AIN6	ı	Analog	Analog-to-digital converter input 6.
C6	CCP2	I/O	TTL	Capture/Compare/PWM 2.
C0 _	CCP4	I/O	TTL	Capture/Compare/PWM 4.
	U2Rx	1	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
C7	VDDA	-	Power	The positive supply for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions. VDDA pins must be supplied with a voltage that meets the specification in Table 20-2 on page 797, regardless of system implementation.
C8	PH1	I/O	TTL	GPIO port H bit 1.
C9	PH0	I/O	TTL	GPIO port H bit 0.
040	PG7	I/O	TTL	GPIO port G bit 7.
C10 –	CCP5	I/O	TTL	Capture/Compare/PWM 5.
C11	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
C12	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
D1	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
D2	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
D3	VDDC	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals. The voltage on this pin is 1.3 V and is supplied by the on-chip LDO. The VDDC pins should only be connected to the LDO pin and an external capacitor as specified in .
D10	PH3	I/O	TTL	GPIO port H bit 3.
5	PH2	I/O	TTL	GPIO port H bit 2.
D11 -	C1o	0	TTL	Analog comparator 1 output.
	PB1	I/O	TTL	GPIO port B bit 1. This pin is not 5-V tolerant.
	CCP1	I/O	TTL	Capture/Compare/PWM 1.
D12	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	UlTx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
E1	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
E2	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
E3	LDO	-	Power	Low drop-out regulator output voltage. This pin requires an external capacitor between the pin and GND of 1 μ F or greater. The LDO pin must also be connected to the VDDC pins at the board level in addition to the decoupling capacitor(s).
E10	VDD	-	Power	Positive supply for I/O and some logic.
F44	PB3	I/O	TTL	GPIO port B bit 3.
E11 -	I2C0SDA	I/O	OD	I ² C module 0 data.
	PB0	I/O	TTL	GPIO port B bit 0. This pin is not 5-V tolerant.
E12	CCP0	I/O	TTL	Capture/Compare/PWM 0.
L12 _	UlRx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.

Table 18-7. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
F1	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
F2	NC	-	-	No connect. Leave the pin electrically unconnected/isolated.
F0	PJ0	I/O	TTL	GPIO port J bit 0.
F3 –	I2C1SCL	I/O	OD	I ² C module 1 clock.
F40	PH5	I/O	TTL	GPIO port H bit 5.
F10 –	SSI1Fss	I/O	TTL	SSI module 1 frame signal.
F11	GND	-	Power	Ground reference for logic and I/O pins.
F12	GND	-	Power	Ground reference for logic and I/O pins.
	PD0	I/O	TTL	GPIO port D bit 0.
	Ulcts	I	TTL	UART module 1 Clear To Send modem flow control input signal.
G1	U1Rx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
	U2Rx	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
	PD1	I/O	TTL	GPIO port D bit 1.
	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	U1DCD	I	TTL	UART module 1 Data Carrier Detect modem status input signal.
G2	UlTx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
	U2Tx	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.
C2	РН6	I/O	TTL	GPIO port H bit 6.
G3	SSI1Rx	I	TTL	SSI module 1 receive.
G10	VDD	-	Power	Positive supply for I/O and some logic.
G11	VDD	-	Power	Positive supply for I/O and some logic.
G12	VDD	-	Power	Positive supply for I/O and some logic.
	PD3	I/O	TTL	GPIO port D bit 3.
H1	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	UlTx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
	PD2	I/O	TTL	GPIO port D bit 2.
H2	CCP5	I/O	TTL	Capture/Compare/PWM 5.
	U1Rx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
H3 -	PH7	I/O	TTL	GPIO port H bit 7.
ПЗ	SSI1Tx	0	TTL	SSI module 1 transmit.
H10	VDD	-	Power	Positive supply for I/O and some logic.
H11	RST	I	TTL	System reset input.
	PF1	I/O	TTL	GPIO port F bit 1.
H12	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	U1RTS	0	TTL	UART module 1 Request to Send modem flow control output line.
J1	PG2	I/O	TTL	GPIO port G bit 2.
J2	PG3	I/O	TTL	GPIO port G bit 3.

Table 18-7. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
J3	GND	-	Power	Ground reference for logic and I/O pins.
J10	GND	-	Power	Ground reference for logic and I/O pins.
144	PF2	I/O	TTL	GPIO port F bit 2.
J11 —	SSI1Clk	I/O	TTL	SSI module 1 clock.
J12	PF3	I/O	TTL	GPIO port F bit 3.
J12	SSI1Fss	I/O	TTL	SSI module 1 frame signal.
	PG0	I/O	TTL	GPIO port G bit 0.
K1	I2C1SCL	I/O	OD	I ² C module 1 clock.
	U2Rx	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
	PG1	I/O	TTL	GPIO port G bit 1.
K2	I2C1SDA	I/O	OD	I ² C module 1 data.
	U2Tx	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.
	PG4	I/O	TTL	GPIO port G bit 4.
К3	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	U1RI	I	TTL	UART module 1 Ring Indicator modem status input signal.
K4	PF7	I/O	TTL	GPIO port F bit 7.
	CCP4	I/O	TTL	Capture/Compare/PWM 4.
K5	GND	-	Power	Ground reference for logic and I/O pins.
K6	PJ2	I/O	TTL	GPIO port J bit 2.
Ko _	CCP0	I/O	TTL	Capture/Compare/PWM 0.
K7	VDD	-	Power	Positive supply for I/O and some logic.
K8	VDD	-	Power	Positive supply for I/O and some logic.
К9	VDD	-	Power	Positive supply for I/O and some logic.
K10	GND	-	Power	Ground reference for logic and I/O pins.
K11	XOSC0	I	Analog	Hibernation module oscillator crystal input or an external clock reference input. Note that this is either a 4.194304-MHz crystal or a 32.768-kHz oscillator for the Hibernation module RTC. See the CLKSEL bit in the HIBCTL register.
K12	XOSC1	0	Analog	Hibernation module oscillator crystal output. Leave unconnected when using a single-ended clock source.
	PC4	I/O	TTL	GPIO port C bit 4.
	CCP1	I/O	TTL	Capture/Compare/PWM 1.
L1	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	CCP4	I/O	TTL	Capture/Compare/PWM 4.
	CCP5	I/O	TTL	Capture/Compare/PWM 5.
	PC7	I/O	TTL	GPIO port C bit 7.
	Clo	0	TTL	Analog comparator 1 output.
L2	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	CCP4	I/O	TTL	Capture/Compare/PWM 4.
	UlTx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.

Table 18-7. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description
	PA0	I/O	TTL	GPIO port A bit 0.
	I2C1SCL	I/O	OD	I ² C module 1 clock.
L3	U0Rx	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
	U1Rx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
L4	PA3	I/O	TTL	GPIO port A bit 3.
L 4	SSI0Fss	I/O	TTL	SSI module 0 frame signal
L5	PA4	I/O	TTL	GPIO port A bit 4.
LO	SSI0Rx	I	TTL	SSI module 0 receive
	PA6	I/O	TTL	GPIO port A bit 6.
1.0	CCP1	I/O	TTL	Capture/Compare/PWM 1.
L6	I2C1SCL	I/O	OD	I ² C module 1 clock.
	Ulcts	I	TTL	UART module 1 Clear To Send modem flow control input signal.
	PG6	I/O	TTL	GPIO port G bit 6.
L7	UlRI	ı	TTL	UART module 1 Ring Indicator modem status input signal.
	PF5	I/O	TTL	GPIO port F bit 5.
	Clo	0	TTL	Analog comparator 1 output.
L8	CCP2	I/O	TTL	Capture/Compare/PWM 2.
	SSI1Tx	0	TTL	SSI module 1 transmit.
	PF4	I/O	TTL	GPIO port F bit 4.
	C0o	0	TTL	Analog comparator 0 output.
L9	CCP0	I/O	TTL	Capture/Compare/PWM 0.
	SSI1Rx	ı	TTL	SSI module 1 receive.
L10	GND	-	Power	Ground reference for logic and I/O pins.
L11	OSC0	I	Analog	Main oscillator crystal input or an external clock reference input.
L12	VBAT	-	Power	Power source for the Hibernation module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation module power-source supply.
	PC5	I/O	TTL	GPIO port C bit 5.
	C0o	0	TTL	Analog comparator 0 output.
	C1+	ı	Analog	Analog comparator 1 positive input.
M1	Clo	0	TTL	Analog comparator 1 output.
	CCP1	I/O	TTL	Capture/Compare/PWM 1.
	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	PC6	I/O	TTL	GPIO port C bit 6.
	CCP0	I/O	TTL	Capture/Compare/PWM 0.
M2	CCP3	I/O	TTL	Capture/Compare/PWM 3.
	UlRx	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.

Table 18-7. Signals by Pin Number (continued)

Pin Number	Pin Name	Pin Type	Buffer Type ^a	Description	
	PA1	I/O	TTL	GPIO port A bit 1.	
	I2C1SDA	I/O	OD	I ² C module 1 data.	
М3	UOTx	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.	
	U1Tx	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.	
M4	PA2	I/O	TTL	GPIO port A bit 2.	
1014	SSIOClk	I/O	TTL	SSI module 0 clock	
M5 -	PA5	I/O	TTL	GPIO port A bit 5.	
IVIS	SSIOTx	0	TTL	SSI module 0 transmit	
	PA7	I/O	TTL	GPIO port A bit 7.	
	CCP3	I/O	TTL	Capture/Compare/PWM 3.	
M6	CCP4	I/O	TTL	Capture/Compare/PWM 4.	
	I2C1SDA	I/O	OD	I ² C module 1 data.	
	U1DCD	I	TTL	UART module 1 Data Carrier Detect modem status input signal.	
	PG5	I/O	TTL	GPIO port G bit 5.	
M7	CCP5	I/O	TTL	Capture/Compare/PWM 5.	
	U1DTR	0	TTL	UART module 1 Data Terminal Ready modem status input signal.	
	PF6	I/O	TTL	GPIO port F bit 6.	
M8	CCP1	I/O	TTL	Capture/Compare/PWM 1.	
	U1RTS	0	TTL	UART module 1 Request to Send modem flow control output line.	
M9	PF0	I/O	TTL	GPIO port F bit 0.	
IVIÐ	U1DSR	1	TTL	UART module 1 Data Set Ready modem output control line.	
M10	WAKE	I	TTL	An external input that brings the processor out of Hibernate mode when asserted.	
M11	OSC1	0	Analog	Main oscillator crystal output. Leave unconnected when using a single-ended clock source.	
M12	HIB	0	OD	An output that indicates the processor is in Hibernate mode.	

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

18.2.2 Signals by Signal Name

Table 18-8. Signals by Signal Name

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
AIN0	B1	PE7	1	Analog	Analog-to-digital converter input 0.
AIN1	A1	PE6	1	Analog	Analog-to-digital converter input 1.
AIN2	В3	PE5	1	Analog	Analog-to-digital converter input 2.
AIN3	B2	PE4	1	Analog	Analog-to-digital converter input 3.
AIN4	A2	PD7	1	Analog	Analog-to-digital converter input 4.
AIN5	A3	PD6	1	Analog	Analog-to-digital converter input 5.
AIN6	C6	PD5	1	Analog	Analog-to-digital converter input 6.
AIN7	B5	PD4	1	Analog	Analog-to-digital converter input 7.

Table 18-8. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
C0+	A7	PB6	ı	Analog	Analog comparator 0 positive input.
C0-	A6	PB4	I	Analog	Analog comparator 0 negative input.
C0o	M1 L9 A7 B7 A2	PC5 (3) PF4 (2) PB6 (3) PB5 (1) PD7 (2)	0	TTL	Analog comparator 0 output.
C1+	M1	PC5	Ĺ	Analog	Analog comparator 1 positive input.
C1-	B7	PB5	I	Analog	Analog comparator 1 negative input.
Clo	A1 L2 M1 L8 D11	PE6 (2) PC7 (7) PC5 (2) PF5 (2) PH2 (2)	0	TTL	Analog comparator 1 output.
CCP0	H1 L2 M2 K6 L9 E12 A11 B7 B5	PD3 (4) PC7 (4) PC6 (6) PJ2 (9) PF4 (1) PB0 (1) PB2 (5) PB5 (4) PD4 (1)	I/O	TTL	Capture/Compare/PWM 0.
CCP1	M1 L1 L6 M8 D12 A7 B4 A2	PC5 (1) PC4 (9) PA6 (2) PF6 (1) PB1 (4) PB6 (1) PE3 (1) PD7 (3)	I/O	TTL	Capture/Compare/PWM 1.
CCP2	B2 G2 L1 L8 D12 A12 B7 A4	PE4 (6) PD1 (10) PC4 (5) PF5 (1) PB1 (1) PE1 (4) PB5 (6) PE2 (5) PD5 (1)	I/O	TTL	Capture/Compare/PWM 2.
CCP3	B2 M2 M1 M6 K3 H12 A11 B11	PE4 (1) PC6 (1) PC5 (5) PA7 (7) PG4 (1) PF1 (10) PB2 (4) PE0 (3) PD4 (2)	I/O	TTL	Capture/Compare/PWM 3.

Table 18-8. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
CCP4	L2 L1 M6 K4 A4 C6	PC7 (1) PC4 (6) PA7 (2) PF7 (1) PE2 (1) PD5 (2)	I/O	TTL	Capture/Compare/PWM 4.
CCP5	B3 H2 L1 C10 M7 A7 B7	PE5 (1) PD2 (4) PC4 (1) PG7 (8) PG5 (1) PB6 (6) PB5 (2)	I/O	TTL	Capture/Compare/PWM 5.
GND	C4 C5 J3 K5 L10 K10 J10 F11	fixed	-	Power	Ground reference for logic and I/O pins.
GNDA	A5	fixed	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.
HIB	M12	fixed	0	OD	An output that indicates the processor is in Hibernate mode.
I2C0SCL	A11	PB2 (1)	I/O	OD	I ² C module 0 clock.
I2C0SDA	E11	PB3 (1)	I/O	OD	I ² C module 0 data.
I2C1SCL	F3 K1 L3 L6	PJ0 (11) PG0 (3) PA0 (8) PA6 (1)	I/O	OD	I ² C module 1 clock.
I2C1SDA	K2 M3 M6 B6	PG1 (3) PA1 (8) PA7 (1) PJ1 (11)	I/O	OD	I ² C module 1 data.
LDO	E3	fixed	-	Power	Low drop-out regulator output voltage. This pin requires an external capacitor between the pin and GND of 1 μ F or greater. The LDO pin must also be connected to the VDDC pins at the board level in addition to the decoupling capacitor(s).
NC	C11 C12 B12 C1 C2 D2 D1 E1 E2 F1	fixed	-	-	No connect. Leave the pin electrically unconnected/isolated.

Table 18-8. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
NMI	A8	PB7 (4)	I	TTL	Non-maskable interrupt.
OSC0	L11	fixed	I	Analog	Main oscillator crystal input or an external clock reference input.
OSC1	M11	fixed	0	Analog	Main oscillator crystal output. Leave unconnected when using a single-ended clock source.
PA0	L3	-	I/O	TTL	GPIO port A bit 0.
PA1	M3	-	I/O	TTL	GPIO port A bit 1.
PA2	M4	-	I/O	TTL	GPIO port A bit 2.
PA3	L4	-	I/O	TTL	GPIO port A bit 3.
PA4	L5	-	I/O	TTL	GPIO port A bit 4.
PA5	M5	-	I/O	TTL	GPIO port A bit 5.
РАб	L6	-	I/O	TTL	GPIO port A bit 6.
PA7	M6	-	I/O	TTL	GPIO port A bit 7.
PB0	E12	-	I/O	TTL	GPIO port B bit 0. This pin is not 5-V tolerant.
PB1	D12	-	I/O	TTL	GPIO port B bit 1. This pin is not 5-V tolerant.
PB2	A11	-	I/O	TTL	GPIO port B bit 2.
PB3	E11	-	I/O	TTL	GPIO port B bit 3.
PB4	A6	-	I/O	TTL	GPIO port B bit 4.
PB5	B7	-	I/O	TTL	GPIO port B bit 5.
РВ6	A7	-	I/O	TTL	GPIO port B bit 6.
PB7	A8	-	I/O	TTL	GPIO port B bit 7.
PC0	A9	-	I/O	TTL	GPIO port C bit 0.
PC1	В9	-	I/O	TTL	GPIO port C bit 1.
PC2	B8	-	I/O	TTL	GPIO port C bit 2.
PC3	A10	-	I/O	TTL	GPIO port C bit 3.
PC4	L1	-	I/O	TTL	GPIO port C bit 4.
PC5	M1	-	I/O	TTL	GPIO port C bit 5.
PC6	M2	-	I/O	TTL	GPIO port C bit 6.
PC7	L2	-	I/O	TTL	GPIO port C bit 7.
PD0	G1	-	I/O	TTL	GPIO port D bit 0.
PD1	G2	-	I/O	TTL	GPIO port D bit 1.
PD2	H2	-	I/O	TTL	GPIO port D bit 2.
PD3	H1	-	I/O	TTL	GPIO port D bit 3.
PD4	B5	-	I/O	TTL	GPIO port D bit 4.
PD5	C6	-	I/O	TTL	GPIO port D bit 5.
PD6	A3	-	I/O	TTL	GPIO port D bit 6.
PD7	A2	-	I/O	TTL	GPIO port D bit 7.
PE0	B11	-	I/O	TTL	GPIO port E bit 0.
PE1	A12	-	I/O	TTL	GPIO port E bit 1.
PE2	A4	-	I/O	TTL	GPIO port E bit 2.
PE3	B4	-	I/O	TTL	GPIO port E bit 3.

Table 18-8. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
PE4	B2	-	I/O	TTL	GPIO port E bit 4.
PE5	В3	-	I/O	TTL	GPIO port E bit 5.
PE6	A1	-	I/O	TTL	GPIO port E bit 6.
PE7	B1	-	I/O	TTL	GPIO port E bit 7.
PF0	M9	-	I/O	TTL	GPIO port F bit 0.
PF1	H12	-	I/O	TTL	GPIO port F bit 1.
PF2	J11	-	I/O	TTL	GPIO port F bit 2.
PF3	J12	-	I/O	TTL	GPIO port F bit 3.
PF4	L9	-	I/O	TTL	GPIO port F bit 4.
PF5	L8	-	I/O	TTL	GPIO port F bit 5.
PF6	M8	-	I/O	TTL	GPIO port F bit 6.
PF7	K4	-	I/O	TTL	GPIO port F bit 7.
PG0	K1	-	I/O	TTL	GPIO port G bit 0.
PG1	K2	-	I/O	TTL	GPIO port G bit 1.
PG2	J1	-	I/O	TTL	GPIO port G bit 2.
PG3	J2	-	I/O	TTL	GPIO port G bit 3.
PG4	K3	-	I/O	TTL	GPIO port G bit 4.
PG5	M7	-	I/O	TTL	GPIO port G bit 5.
PG6	L7	-	I/O	TTL	GPIO port G bit 6.
PG7	C10	-	I/O	TTL	GPIO port G bit 7.
PH0	C9	-	I/O	TTL	GPIO port H bit 0.
PH1	C8	-	I/O	TTL	GPIO port H bit 1.
PH2	D11	-	I/O	TTL	GPIO port H bit 2.
РН3	D10	-	I/O	TTL	GPIO port H bit 3.
РН4	B10	-	I/O	TTL	GPIO port H bit 4.
РН5	F10	-	I/O	TTL	GPIO port H bit 5.
РН6	G3	-	I/O	TTL	GPIO port H bit 6.
PH7	H3	-	I/O	TTL	GPIO port H bit 7.
PJ0	F3	-	I/O	TTL	GPIO port J bit 0.
PJ1	B6	-	I/O	TTL	GPIO port J bit 1.
PJ2	K6	-	I/O	TTL	GPIO port J bit 2.
RST	H11	fixed	1	TTL	System reset input.
SSI0Clk	M4	PA2 (1)	I/O	TTL	SSI module 0 clock
SSI0Fss	L4	PA3 (1)	I/O	TTL	SSI module 0 frame signal
SSI0Rx	L5	PA4 (1)	I	TTL	SSI module 0 receive
SSIOTx	M5	PA5 (1)	0	TTL	SSI module 0 transmit
SSI1Clk	J11 B11 B10	PF2 (9) PE0 (2) PH4 (11)	I/O	TTL	SSI module 1 clock.
SSI1Fss	J12 F10 A12	PF3 (9) PH5 (11) PE1 (2)	I/O	TTL	SSI module 1 frame signal.

Table 18-8. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
SSI1Rx	L9 G3 A4	PF4 (9) PH6 (11) PE2 (2)	I	TTL	SSI module 1 receive.
SSIlTx	H3 L8 B4	PH7 (11) PF5 (9) PE3 (2)	0	TTL	SSI module 1 transmit.
SWCLK	A9	PC0 (3)	I	TTL	JTAG/SWD CLK.
SWDIO	В9	PC1 (3)	I/O	TTL	JTAG TMS and SWDIO.
SWO	A10	PC3 (3)	0	TTL	JTAG TDO and SWO.
TCK	A9	PC0 (3)	ļ	TTL	JTAG/SWD CLK.
TDI	B8	PC2 (3)	I	TTL	JTAG TDI.
TDO	A10	PC3 (3)	0	TTL	JTAG TDO and SWO.
TMS	B9	PC1 (3)	I	TTL	JTAG TMS and SWDIO.
UORx	L3	PA0 (1)	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
UOTx	M3	PA1 (1)	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
Ulcts	A1 G1 L6	PE6 (9) PD0 (9) PA6 (9)	I	TTL	UART module 1 Clear To Send modem flow control input signal.
U1DCD	B1 G2 M6	PE7 (9) PD1 (9) PA7 (9)	I	TTL	UART module 1 Data Carrier Detect modem status input signal.
U1DSR	M9	PF0 (9)	I	TTL	UART module 1 Data Set Ready modem output control line.
U1DTR	M7 A2	PG5 (10) PD7 (9)	0	TTL	UART module 1 Data Terminal Ready modem status input signal.
UlRI	L7 K3 B5	PG6 (10) PG4 (10) PD4 (9)	I	TTL	UART module 1 Ring Indicator modem status input signal.
Ulrts	M8 H12	PF6 (10) PF1 (9)	0	TTL	UART module 1 Request to Send modem flow control output line.
U1Rx	G1 H2 M2 L3 E12 A6	PD0 (5) PD2 (1) PC6 (5) PA0 (9) PB0 (5) PB4 (7)	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
UlTx	G2 H1 L2 M3 D12 B7	PD1 (5) PD3 (1) PC7 (5) PA1 (9) PB1 (5) PB5 (7)	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
U2Rx	G1 K1 A6 C6	PD0 (4) PG0 (1) PB4 (4) PD5 (9)	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.

Table 18-8. Signals by Signal Name (continued)

Pin Name	Pin Number	Pin Mux / Pin Assignment	Pin Type	Buffer Type ^a	Description
U2Tx	B2 G2 K2 A3	PE4 (5) PD1 (4) PG1 (1) PD6 (9)	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.
VBAT	L12	fixed	-	Power	Power source for the Hibernation module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation module power-source supply.
VDD	K7 G12 K8 K9 H10 G10 E10 G11	fixed	-	Power	Positive supply for I/O and some logic.
VDDA	C7	fixed	-	Power	The positive supply for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions. VDDA pins must be supplied with a voltage that meets the specification in Table 20-2 on page 797, regardless of system implementation.
VDDC	D3 C3	fixed	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals. The voltage on this pin is 1.3 V and is supplied by the on-chip LDO. The VDDC pins should only be connected to the LDO pin and an external capacitor as specified in .
VREFA	A7	PB6	ı	Analog	This input provides a reference voltage used to specify the input voltage at which the ADC converts to a maximum value. In other words, the voltage that is applied to VREFA is the voltage with which an AINn signal is converted to 1023. The VREFA input is limited to the range specified in Table 20-22 on page 809.
WAKE	M10	fixed	1	TTL	An external input that brings the processor out of Hibernate mode when asserted.
xosc0	K11	fixed	I	Analog	Hibernation module oscillator crystal input or an external clock reference input. Note that this is either a 4.194304-MHz crystal or a 32.768-kHz oscillator for the Hibernation module RTC. See the CLKSEL bit in the HIBCTL register.
XOSC1	K12	fixed	0	Analog	Hibernation module oscillator crystal output. Leave unconnected when using a single-ended clock source.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

18.2.3 Signals by Function, Except for GPIO

Table 18-9. Signals by Function, Except for GPIO

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	AIN0	B1	I	Analog	Analog-to-digital converter input 0.
	AIN1	A1	I	Analog	Analog-to-digital converter input 1.
	AIN2	В3	I	Analog	Analog-to-digital converter input 2.
	AIN3	B2	I	Analog	Analog-to-digital converter input 3.
	AIN4	A2	I	Analog	Analog-to-digital converter input 4.
	AIN5	A3	I	Analog	Analog-to-digital converter input 5.
ADC	AIN6	C6	I	Analog	Analog-to-digital converter input 6.
	AIN7	B5	I	Analog	Analog-to-digital converter input 7.
	VREFA	A7	I	Analog	This input provides a reference voltage used to specify the input voltage at which the ADC converts to a maximum value. In other words, the voltage that is applied to VREFA is the voltage with which an AINn signal is converted to 1023. The VREFA input is limited to the range specified in Table 20-22 on page 809.
	C0+	A7	I	Analog	Analog comparator 0 positive input.
	C0-	A6	I	Analog	Analog comparator 0 negative input.
Analog Comparators	C0o	M1 L9 A7 B7 A2	0	TTL	Analog comparator 0 output.
Analog Comparators	C1+	M1	I	Analog	Analog comparator 1 positive input.
	C1-	B7	I	Analog	Analog comparator 1 negative input.
	Clo	A1 L2 M1 L8 D11	0	TTL	Analog comparator 1 output.

Table 18-9. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	CCP0	H1 L2 M2 K6 L9 E12 A11 B7 B5	I/O	TTL	Capture/Compare/PWM 0.
	CCP1	M1 L1 L6 M8 D12 A7 B4 A2	I/O	TTL	Capture/Compare/PWM 1.
General-Purpose Timers	CCP2	B2 G2 L1 L8 D12 A12 B7 A4 C6	I/O	TTL	Capture/Compare/PWM 2.
	CCP3	B2 M2 M1 M6 K3 H12 A11 B11	I/O	TTL	Capture/Compare/PWM 3.
	CCP4	L2 L1 M6 K4 A4 C6	I/O	TTL	Capture/Compare/PWM 4.
	CCP5	B3 H2 L1 C10 M7 A7 B7	I/O	TTL	Capture/Compare/PWM 5.

Table 18-9. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	HIB	M12	0	OD	An output that indicates the processor is in Hibernate mode.
	VBAT	L12	-	Power	Power source for the Hibernation module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation module power-source supply.
Hibernate	WAKE	M10	I	TTL	An external input that brings the processor out of Hibernate mode when asserted.
Tiberrate	xosc0	K11	I	Analog	Hibernation module oscillator crystal input or an external clock reference input. Note that this is either a 4.194304-MHz crystal or a 32.768-kHz oscillator for the Hibernation module RTC. See the CLKSEL bit in the HIBCTL register.
	XOSC1	K12	0	Analog	Hibernation module oscillator crystal output. Leave unconnected when using a single-ended clock source.
	I2C0SCL	A11	I/O	OD	I ² C module 0 clock.
	I2C0SDA	E11	I/O	OD	I ² C module 0 data.
12C	I2C1SCL	F3 K1 L3 L6	I/O	OD	I ² C module 1 clock.
	I2C1SDA	K2 M3 M6 B6	I/O	OD	I ² C module 1 data.
	SWCLK	A9	I	TTL	JTAG/SWD CLK.
	SWDIO	В9	I/O	TTL	JTAG TMS and SWDIO.
	SWO	A10	0	TTL	JTAG TDO and SWO.
JTAG/SWD/SWO	TCK	A9	I	TTL	JTAG/SWD CLK.
	TDI	B8	I	TTL	JTAG TDI.
	TDO	A10	0	TTL	JTAG TDO and SWO.
	TMS	B9	I	TTL	JTAG TMS and SWDIO.

Table 18-9. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	GND	C4 C5 J3 K5 L10 K10 J10 F11	-	Power	Ground reference for logic and I/O pins.
	GNDA	A5	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.
	LDO	E3	-	Power	Low drop-out regulator output voltage. This pin requires an external capacitor between the pin and GND of 1 μ F or greater. The LDO pin must also be connected to the VDDC pins at the board level in addition to the decoupling capacitor(s).
Power	VDD	K7 G12 K8 K9 H10 G10 E10 G11	-	Power	Positive supply for I/O and some logic.
	VDDA	C7	-	Power	The positive supply for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions. VDDA pins must be supplied with a voltage that meets the specification in Table 20-2 on page 797, regardless of system implementation.
	VDDC	D3 C3	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals. The voltage on this pin is 1.3 V and is supplied by the on-chip LDO. The VDDC pins should only be connected to the LDO pin and an external capacitor as specified in .

Table 18-9. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	SSI0Clk	M4	I/O	TTL	SSI module 0 clock
	SSI0Fss	L4	I/O	TTL	SSI module 0 frame signal
	SSI0Rx	L5	I	TTL	SSI module 0 receive
	SSIOTX	M5	0	TTL	SSI module 0 transmit
	SSI1Clk	J11 B11 B10	I/O	TTL SSI module 1 clock. TTL SSI module 1 frame signal.	SSI module 1 clock.
SSI	SSI1Fss	J12 F10 A12	I/O	TTL	SSI module 1 frame signal.
	SSI1Rx	L9 G3 A4	I	TTL	SSI module 1 receive.
	SSI1Tx	H3 L8 B4	0	TTL	SSI module 1 transmit.
	NMI	A8	I	TTL	Non-maskable interrupt.
System Control &	osc0	L11	I	Analog	Main oscillator crystal input or an external clock reference input.
Clocks	osc1	M11	0	Analog	Main oscillator crystal output. Leave unconnected when using a single-ended clock source.
	RST	H11	ı	TTL	System reset input.

Table 18-9. Signals by Function, Except for GPIO (continued)

Function	Pin Name	Pin Number	Pin Type	Buffer Type ^a	Description
	U0Rx	L3	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
	U0Tx	M3	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
	U1CTS	A1 G1 L6	I	TTL	UART module 1 Clear To Send modem flow control input signal.
	U1DCD	B1 G2 M6	I	TTL	UART module 1 Data Carrier Detect modem status input signal.
	U1DSR	M9	I	TTL	UART module 1 Data Set Ready modem output control line.
	U1DTR	M7 A2	0	TTL	UART module 1 Data Terminal Ready modem status input signal.
	Ulri	L7 K3 B5	I	TTL	UART module 1 Ring Indicator modem status input signal.
UART	U1RTS	M8 H12	0	TTL	UART module 1 Request to Send modem flow control output line.
	Ulrx	G1 H2 M2 L3 E12 A6	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
	Ultx	G2 H1 L2 M3 D12 B7	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
	U2Rx	G1 K1 A6 C6	I	TTL	UART module 2 receive. When in IrDA mode, this signal has IrDA modulation.
a. The TTL designation	U2Tx	B2 G2 K2 A3	0	TTL	UART module 2 transmit. When in IrDA mode, this signal has IrDA modulation.

a. The TTL designation indicates the pin has TTL-compatible voltage levels.

18.2.4 GPIO Pins and Alternate Functions

Table 18-10. GPIO Pins and Alternate Functions

Ю	Pin	Analog Function	Digital Function (GPIOPCTL PMCx Bit Field Encoding) ^a										
10	F		1	2	3	4	5	6	7	8	9	10	11
PA0	L3	-	U0Rx	-	-	-	-	-	-	I2C1SCL	U1Rx	-	-
PA1	МЗ	-	UOTx	-	-	-	-	-	-	I2C1SDA	UlTx	-	-
PA2	M4	-	SSI0Clk	-	-	-	-	-	-	-	-	-	-
PA3	L4	-	SSI0Fss	-	-	-	-	-	-	-	-	-	-

Table 18-10. GPIO Pins and Alternate Functions (continued)

Ю	Pin	Analog	Digital Function (GPIOPCTL PMCx Bit Field Encoding) ^a											
10	FIII	Function	1	2	3	4	5	6	7	8	9	10	11	
PA4	L5	-	SSI0Rx	-	-	-	-	-	-	-	-	-	-	
PA5	M5	-	SSIOTx	-	-	-	-	-	-	-	-	-	-	
PA6	L6	-	I2C1SCL	CCP1	-	-	-	-	-	-	U1CTS	-	-	
PA7	M6	-	I2C1SDA	CCP4	-	-	-	-	CCP3	-	U1DCD	-	-	
PB0	E12	-	CCP0	-	-	-	U1Rx	-	-	-	-	-	-	
PB1	D12	-	CCP2	-	-	CCP1	U1Tx	-	-	-	-	-	-	
PB2	A11	-	I2C0SCL	-	-	CCP3	CCP0	-	-	-	-	-	-	
PB3	E11	-	I2C0SDA	-	-	-	-	-	-	-	-	-	-	
PB4	A6	C0-	-	-	-	U2Rx	-	-	U1Rx	-	-	-	-	
PB5	В7	C1-	C0o	CCP5	-	CCP0	-	CCP2	U1Tx	-	-	-	-	
PB6	A7	VREFA C0+	CCP1	-	C00	-	-	CCP5	-	-	-	-	-	
PB7	A8	-	-	-	-	NMI	-	-	-	-	-	-	-	
PC0	A9	-	-	-	TCK SWCLK	-	-	-	-	-	-	-	-	
PC1	В9	-	-	-	TMS SWDIO	-	-	-	-	-	-	-	-	
PC2	В8	-	-	-	TDI	-	-	-	-	-	-	-	-	
PC3	A10	-	-	-	TDO SWO	-	-	-	-	-	-	-	-	
PC4	L1	-	CCP5	-	-	-	CCP2	CCP4	-	-	CCP1	-	-	
PC5	M1	C1+	CCP1	C1o	C00	-	CCP3	-	-	-	-	-	-	
PC6	M2	-	CCP3	-	-	-	U1Rx	CCP0	-	-	-	-	-	
PC7	L2	-	CCP4	-	-	CCP0	U1Tx	-	Clo	-	-	-	1	
PD0	G1	-	-	-	-	U2Rx	U1Rx	-	-	-	U1CTS	-	-	
PD1	G2	-	-	-	-	U2Tx	U1Tx	-	-	-	U1DCD	CCP2	-	
PD2	H2	-	U1Rx	-	-	CCP5	-	-	-	-	-	-	-	
PD3	H1	-	U1Tx	-	-	CCP0	-	-	-	-	-	-	-	
PD4	B5	AIN7	CCP0	CCP3	-	-	-	-	-	-	U1RI	-	-	
PD5	C6	AIN6	CCP2	CCP4	-	-	-	-	-	-	U2Rx	-	-	
PD6	A3	AIN5	-	-	-	-	-	-	-	-	U2Tx	-	-	
PD7	A2	AIN4	-	C00	CCP1	-	-	-	-	-	U1DTR	-	-	
PE0	B11	-	-	SSI1Clk	CCP3	-	-	-	-	-	-	-	-	
PE1	A12	-	-	SSI1Fss	-	CCP2	-	-	-	-	-	-	-	
PE2	A4	-	CCP4	SSI1Rx	-	-	CCP2	-	-	-	-	-	-	
PE3	B4	-	CCP1	SSI1Tx	-	-	-	-	-	-	-	-	-	
PE4	B2	AIN3	CCP3	-	-	-	U2Tx	CCP2	-	-	-	-	-	
PE5	В3	AIN2	CCP5	-	-	-	-	-	-	-	-	-	-	
PE6	A1	AIN1	-	C10	-	-	-	-	-	-	U1CTS	-	-	
PE7	B1	AIN0	-	-	-	-	-	-	-	-	U1DCD	-	-	
PF0	M9	-	-	-	-	-	-	-	-	-	U1DSR	-	-	

Table 18-10. GPIO Pins and Alternate Functions (continued)

Ю	Pin	Analog Function	Digital Function (GPIOPCTL PMCx Bit Field Encoding) ^a											
10	Pin		1	2	3	4	5	6	7	8	9	10	11	
PF1	H12	-	-	-	-	-	-	-	-	-	U1RTS	CCP3	-	
PF2	J11	-	-	-	-	-	-	-	-	-	SSI1Clk	-	-	
PF3	J12	-	-	-	-	-	-	-	-	-	SSI1Fss	-	-	
PF4	L9	-	CCP0	C0o	-	-	-	-	-	-	SSI1Rx	-	-	
PF5	L8	-	CCP2	C1o	-	-	-	-	-	-	SSI1Tx	-	-	
PF6	M8	-	CCP1	-	-	-	-	-	-	-	-	Ulrts	-	
PF7	K4	-	CCP4	-	-	-	-	-	-	-	-	-	-	
PG0	K1	-	U2Rx	-	I2C1SCL	-	-	-	-	-	-	-	-	
PG1	K2	-	U2Tx	-	I2C1SDA	-	-	-	-	-	-	-	-	
PG2	J1	-	1	ı	-	-	-	-	-	-	-	ı	-	
PG3	J2	-	-	-	-	-	-	-	-	-	-	-	-	
PG4	K3	-	CCP3	ı	-	-	-	-	-	-	-	U1RI	-	
PG5	M7	-	CCP5	1	-	-	-	-	-	-	-	U1DTR	-	
PG6	L7	-	1	1	-	-	-	-	-	-	-	U1RI	-	
PG7	C10	-	1	-	-	-	-	-	-	CCP5	-	-	-	
PH0	C9	-	1	1	-	-	-	-	-	-	-	1	-	
PH1	C8	-	1	1	-	-	-	-	-	-	-	1	-	
PH2	D11	-	1	Clo	-	-	-	-	-	-	-	ı	-	
PH3	D10	-	-	-	-	-	-	-	-	-	-	-	-	
PH4	B10	-	1	ı	-	-	-	-	-	-	-	ı	SSI1Clk	
PH5	F10	-	1	1	-	-	-	-	-	-	-	1	SSI1Fss	
РН6	G3	-	1	ı	-	-	-	-	-	-	-	1	SSI1Rx	
PH7	Н3	-	1	1	-	-	-	-	-	-	-	1	SSI1Tx	
PJ0	F3	-	-	-	-	-	-	-	-	-	-	-	I2C1SCL	
PJ1	B6	-	1	ı	-	-	-	-	-	-	-	ı	I2C1SDA	
РЈ2	K6	-	-	-	-	-	-	-	-	-	CCP0	-	-	

 $a. \ The \ digital \ signals \ that \ are \ shaded \ gray \ are \ the \ power-on \ default \ values \ for \ the \ corresponding \ GPIO \ pin.$

18.2.5 Possible Pin Assignments for Alternate Functions

Table 18-11. Possible Pin Assignments for Alternate Functions

# of Possible Assignments	Alternate Function	GPIO Function
	AIN0	PE7
	AIN1	PE6
	AIN2	PE5
	AIN3	PE4
	AIN4	PD7
	AIN5	PD6
	AIN6	PD5
Ī	AIN7	PD4
	C0+	PB6
	C0-	PB4
	C1+	PC5
	C1-	PB5
	I2C0SCL	PB2
	I2C0SDA	PB3
	NMI	PB7
one -	SSIOClk	PA2
	SSIOFss	PA3
	SSI0Rx	PA4
	SSIOTx	PA5
	SWCLK	PC0
	SWDIO	PC1
	SWO	PC3
	TCK	PC0
	TDI	PC2
	TDO	PC3
	TMS	PC1
	U0Rx	PA0
	UOTx	PA1
	U1DSR	PF0
	VREFA	PB6
4.	U1DTR	PG5 PD7
two	Ulrts	PF6 PF1
	SSI1Clk	PF2 PE0 PH4
	SSI1Fss	PF3 PH5 PE1
	SSI1Rx	PF4 PH6 PE2
three	SSI1Tx	PH7 PF5 PE3
	Ulcts	PE6 PD0 PA6
	U1DCD	PE7 PD1 PA7
	U1RI	PG6 PG4 PD4

Table 18-11. Possible Pin Assignments for Alternate Functions (continued)

# of Possible Assignments	Alternate Function	GPIO Function
	I2C1SCL	PJ0 PG0 PA0 PA6
four	I2C1SDA	PG1 PA1 PA7 PJ1
loui	U2Rx	PD0 PG0 PB4 PD5
	U2Tx	PE4 PD1 PG1 PD6
five	C0o	PC5 PF4 PB6 PB5 PD7
live	Clo	PE6 PC7 PC5 PF5 PH2
	CCP4	PC7 PC4 PA7 PF7 PE2 PD5
six	U1Rx	PD0 PD2 PC6 PA0 PB0 PB4
	UlTx	PD1 PD3 PC7 PA1 PB1 PB5
seven	CCP5	PE5 PD2 PC4 PG7 PG5 PB6 PB5
eight	CCP1	PC5 PC4 PA6 PF6 PB1 PB6 PE3 PD7
	CCP0	PD3 PC7 PC6 PJ2 PF4 PB0 PB2 PB5 PD4
nine	CCP2	PE4 PD1 PC4 PF5 PB1 PE1 PB5 PE2 PD5
	CCP3	PE4 PC6 PC5 PA7 PG4 PF1 PB2 PE0 PD4

18.3 Connections for Unused Signals

Table 18-12 on page 794 shows how to handle signals for functions that are not used in a particular system implementation for devices that are in a 100-pin LQFP package. Two options are shown in the table: an acceptable practice and a preferred practice for reduced power consumption and improved EMC characteristics. If a module is not used in a system, and its inputs are grounded, it is important that the clock to the module is never enabled by setting the corresponding bit in the **RCGCx** register.

Table 18-12. Connections for Unused Signals (100-Pin LQFP)

Function	Signal Name	Pin Number	Acceptable Practice	Preferred Practice
GPIO	All unused GPIOs	-	NC	GND
	HIB	51	NC	NC
Hibernate	VBAT	55	NC	GND
	WAKE	50	NC	GND
	XOSC0	52	NC	GND
	XOSC1	53	NC	NC
No Connects	NC	-	NC	NC
	OSC0	48	NC	GND
System Control	OSC1	49	NC	NC
2,535	RST	64	Pull up as shown in Figure 5-1 on page 177	Connect through a capacitor to GND as close to pin as possible

Table 18-13 on page 795 shows how to handle signals for functions that are not used in a particular system implementation for devices that are in a 108-ball BGA package. Two options are shown in the table: an acceptable practice and a preferred practice for reduced power consumption and improved EMC characteristics. If a module is not used in a system, and its inputs are grounded, it is important that the clock to the module is never enabled by setting the corresponding bit in the **RCGCx** register.

Table 18-13. Connections for Unused Signals (108-Ball BGA)

Function	Signal Name	Pin Number	Acceptable Practice	Preferred Practice
GPIO	All unused GPIOs	-	NC	GND
	HIB	M12	NC	NC
Hibernate	VBAT	L12	NC	GND
	WAKE	M10	NC	GND
	XOSC0	K11	NC	GND
	XOSC1	K12	NC	NC
No Connects	NC	-	NC	NC
	OSC0	L11	NC	GND
System Control	OSC1	M11	NC	NC
	RST	H11	Pull up as shown in Figure 5-1 on page 177	Connect through a capacitor to GND as close to pin as possible

19 Operating Characteristics

Table 19-1. Temperature Characteristics

Characteristic	Symbol	Value	Unit
Industrial operating temperature range	T _A	-40 to +85	°C
Unpowered storage temperature range	T _S	-65 to +150	°C

Table 19-2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal resistance (junction to ambient) ^a	Θ_{JA}	35 (100LQFP)	°C/W
		33 (108BGA)	
Junction temperature, -40 to +125 ^b	T _J	$T_A + (P \cdot \Theta_{JA})$	°C

a. Junction to ambient thermal resistance θ_{JA} numbers are determined by a package simulator.

Table 19-3. ESD Absolute Maximum Ratings^a

Parameter Name	Min	Nom	Max	Unit
V _{ESDHBM}	-	-	2.0	kV
V _{ESDCDM}	-	-	500	V

a. All Stellaris® parts are ESD tested following the JEDEC standard.

b. Power dissipation is a function of temperature.

20 Electrical Characteristics

20.1 Maximum Ratings

The maximum ratings are the limits to which the device can be subjected without permanently damaging the device. Device reliability may be adversely affected by exposure to absolute-maximum ratings for extended periods.

Note: The device is not guaranteed to operate properly at the maximum ratings.

Table 20-1. Maximum Ratings

Parameter	Parameter Name ^a	V	Unit	
Farameter	r arameter warne	Min	Max	Oille
V _{DD}	V _{DD} supply voltage	0	4	V
V _{DDA}	V _{DDA} supply voltage	0	4	V
V _{BAT}	V _{BAT} battery supply voltage	0	4	V
	Input voltage ^b	-0.3	5.5	V
V _{IN_GPIO}	Input voltage for PB0 and PB1 when configured as GPIO	-0.3	V _{DD} + 0.3	V
I _{GPIOMAX}	Maximum current per output pin	-	25	mA
V _{NON}	Maximum input voltage on a non-power pin when the microcontroller is unpowered	-	300	mV

a. Voltages are measured with respect to GND.

Important: This device contains circuitry to protect the inputs against damage due to high-static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are connected to an appropriate logic voltage level (see "Connections for Unused Signals" on page 794).

20.2 Recommended Operating Conditions

For special high-current applications, the GPIO output buffers may be used with the following restrictions. With the GPIO pins configured as 8-mA output drivers, a total of four GPIO outputs may be used to sink current loads up to 18 mA each. At 18-mA sink current loading, the V_{OL} value is specified as 1.2 V. The high-current GPIO package pins must be selected such that there are only a maximum of two per side of the physical package or BGA pin group with the total number of high-current GPIO outputs not exceeding four for the entire package.

Table 20-2. Recommended DC Operating Conditions

Parameter	Parameter Name	Min	Nom	Max	Unit
V_{DD}	V _{DD} supply voltage	3.0	3.3	3.6	V
V_{DDA}	V _{DDA} supply voltage	3.0	3.3	3.6	V
V _{DDC}	V _{DDC} supply voltage, run mode	1.235	1.3	1.365	V
V _{IH}	High-level input voltage	2.1	-	5.0	V
V _{IL}	Low-level input voltage	-0.3	-	1.2	V

b. Applies to static and dynamic signals including overshoot.

Table 20-2. Recommended DC Operating Conditions (continued)

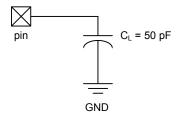
Parameter	Parameter Name	Min	Nom	Max	Unit	
V _{OH}	High-level output voltage	2.4	-	-	V	
V _{OL}	Low-level output voltage	-	-	0.4	V	
	High-level source current, V _{OH} =2.4 V ^a					
I _{OH}	2-mA Drive	-2.0	-	-	mA	
	4-mA Drive	-4.0	-	-	mA	
	8-mA Drive	-8.0	-	-	mA	
	Low-level sink current, V _{OL} =0.4 V ^a					
	2-mA Drive	2.0	-	-	mA	
l _{OL}	4-mA Drive	4.0	-	-	mA	
	8-mA Drive	8.0	-	-	mA	
	8-mA Drive, V _{OL} =1.2 V	18.0	-	-	mA	

a. I_O specifications reflect the maximum current where the corresponding output voltage meets the V_{OH}/V_{OL} thresholds. I_O current can exceed these limits (subject to absolute maximum ratings).

20.3 Load Conditions

Unless otherwise specified, the following conditions are true for all timing measurements.

Figure 20-1. Load Conditions



20.4 JTAG and Boundary Scan

Table 20-3. JTAG Characteristics

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
J1	F _{TCK}	TCK operational clock frequency ^a	0	-	10	MHz
J2	T _{TCK}	TCK operational clock period	100	-	-	ns
J3	T _{TCK_LOW}	TCK clock Low time	-	t _{TCK} /2	-	ns
J4	T _{TCK_HIGH}	TCK clock High time	-	t _{TCK} /2	-	ns
J5	T _{TCK_R}	TCK rise time	0	-	10	ns
J6	T _{TCK_F}	TCK fall time	0	-	10	ns
J7	T _{TMS_SU}	TMS setup time to TCK rise	20	-	-	ns
J8	T _{TMS_HLD}	TMS hold time from TCK rise	20	-	-	ns
J9	T _{TDI_SU}	TDI setup time to TCK rise	25	-	-	ns
J10	T _{TDI_HLD}	TDI hold time from TCK rise	25	-	-	ns

Table 20-3. JTAG Characteristics (continued)

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
		TCK fall to Data Valid from High-Z, 2-mA drive		23	35	ns
		TCK fall to Data Valid from High-Z, 4-mA drive		15	26	ns
J11	T_{TDO_ZDV}	TCK fall to Data Valid from High-Z, 8-mA drive	-	14	25	ns
		TCK fall to Data Valid from High-Z, 8-mA drive with slew rate control		18	29	ns
		TCK fall to Data Valid from Data Valid, 2-mA drive		21	35	ns
		TCK fall to Data Valid from Data Valid, 4-mA drive		14	25	ns
J12	T_{TDO_DV}	TCK fall to Data Valid from Data Valid, 8-mA drive	-	13	24	ns
		TCK fall to Data Valid from Data Valid, 8-mA drive with slew rate control		18	28	ns
		TCK fall to High-Z from Data Valid, 2-mA drive		9	11	ns
		TCK fall to High-Z from Data Valid, 4-mA drive		7	9	ns
J13	T_{TDO_DVZ}	TCK fall to High-Z from Data Valid, 8-mA drive	-	6	8	ns
		TCK fall to High-Z from Data Valid, 8-mA drive with slew rate control		7	9	ns

a. A ratio of at least 8:1 must be kept between the system clock and TCK.

Figure 20-2. JTAG Test Clock Input Timing

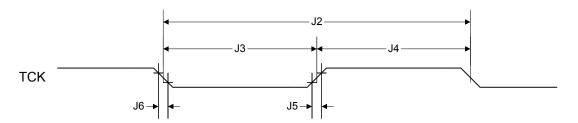
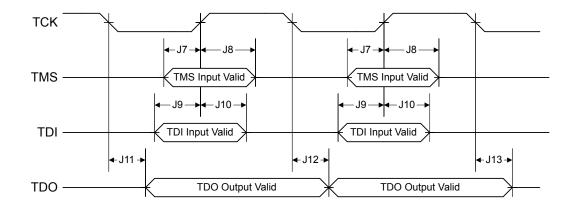


Figure 20-3. JTAG Test Access Port (TAP) Timing



20.5 Power and Brown-Out

Table 20-4. Power Characteristics

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
P1	V_{TH}	Power-On Reset threshold	-	2	-	V
P2	V _{BTH}	Brown-Out Reset threshold	2.85	2.9	2.95	V
P3	T _{POR}	Power-On Reset timeout	6	-	18	ms
P4	T _{BOR}	Brown-Out timeout	-	500	-	μs
P5	T _{IRPOR}	Internal reset timeout after POR	-	-	2	ms
P6	T _{IRBOR}	Internal reset timeout after BOR	-	-	2	ms
P7	T _{VDDRISE}	Supply voltage (V _{DD}) rise time (0V-3.0V)	-	-	10	ms
P8	T _{VDD2_3}	Supply voltage (V _{DD}) rise time (2.0V-3.0V)	-	-	6	ms

Figure 20-4. Power-On Reset Timing

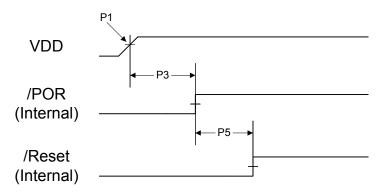
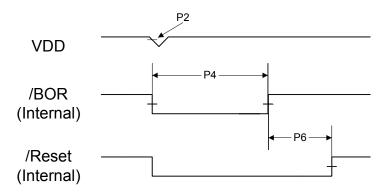


Figure 20-5. Brown-Out Reset Timing



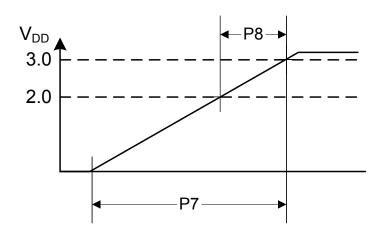


Figure 20-6. Power-On Reset and Voltage Parameters

20.6 Reset

Table 20-5. Reset Characteristics

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
R1	T_IRHWR	Internal reset timeout after hardware reset ($\overline{\mathbb{RST}}$ pin)	-	-	2	ms
R2	T _{IRSWR}	Internal reset timeout after software-initiated system reset	-	-	2	ms
R3	T_IRWDR	Internal reset timeout after watchdog reset	-	-	2	ms
R4	T _{IRMFR}	Internal reset timeout after MOSC failure reset	-	-	2	ms
R5	T_{MIN}	Minimum RST pulse width ^a	2	-	1	μs

a. This specification must be met in order to guarantee proper reset operation.

Figure 20-7. External Reset Timing (RST)

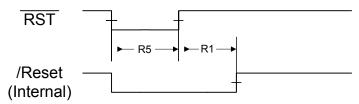


Figure 20-8. Software Reset Timing

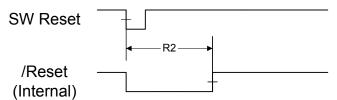


Figure 20-9. Watchdog Reset Timing

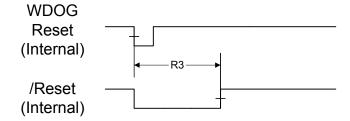
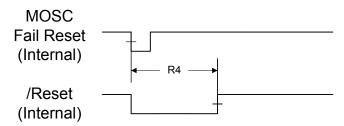


Figure 20-10. MOSC Failure Reset Timing



20.7 On-Chip Low Drop-Out (LDO) Regulator

Table 20-6. LDO Regulator Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
C _{LDO}	External filter capacitor size for internal power supply ^a	1.0	-	3.0	μF
V _{LDO}	LDO output voltage	1.235	1.3	1.365	V

a. The capacitor should be connected as close as possible to pin 86.

20.8 Clocks

The following sections provide specifications on the various clock sources and mode.

20.8.1 PLL Specifications

The following tables provide specifications for using the PLL.

Table 20-7. Phase Locked Loop (PLL) Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
F _{REF_XTAL}	Crystal reference ^a	3.579545	-	16.384	MHz
F _{REF_EXT}	External clock reference ^a	3.579545	-	16.384	MHz
F _{PLL}	PLL frequency ^b	-	400	-	MHz
T _{READY}	PLL lock time	0.562 ^c	-	1.38 ^d	ms

a. The exact value is determined by the crystal value programmed into the XTAL field of the **Run-Mode Clock Configuration** (RCC) register.

- c. Using a 16.384-MHz crystal
- d. Using 3.5795-MHz crystal

b. PLL frequency is automatically calculated by the hardware based on the XTAL field of the RCC register.

Table 20-8 on page 803 shows the actual frequency of the PLL based on the crystal frequency used (defined by the XTAL field in the **RCC** register).

Table 20-8. Actual PLL Frequency

XTAL	Crystal Frequency (MHz)	PLL Frequency (MHz)	Error
0x04	3.5795	400.904	0.0023%
0x05	3.6864	398.1312	0.0047%
0x06	4.0	400	-
0x07	4.096	401.408	0.0035%
0x08	4.9152	398.1312	0.0047%
0x09	5.0	400	-
0x0A	5.12	399.36	0.0016%
0x0B	6.0	400	-
0x0C	6.144	399.36	0.0016%
0x0D	7.3728	398.1312	0.0047%
0x0E	8.0	400	-
0x0F	8.192	398.6773333	0.0033%
0x10	10.0	400	-
0x11	12.0	400	-
0x12	12.288	401.408	0.0035%
0x13	13.56	397.76	0.0056%
0x14	14.318	400.90904	0.0023%
0x15	16.0	400	-
0x16	16.384	404.1386667	0.010%

20.8.2 PIOSC Specifications

Table 20-9. PIOSC Clock Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
F _{PIOSC25}	Internal 16-MHz precision oscillator frequency variance, factory calibrated at 25 °C	-	±0.25%	±1%	-
F _{PIOSCT}	Internal 16-MHz precision oscillator frequency variance, factory calibrated at 25 °C, across specified temperature range	-	-	±3%	-
F _{PIOSCUCAL}	Internal 16-MHz precision oscillator frequency variance, user calibrated at a chosen temperature	-	±0.25%	±1%	-

20.8.3 Internal 30-kHz Oscillator Specifications

Table 20-10. 30-kHz Clock Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
F _{IOSC30KHZ}	Internal 30-KHz oscillator frequency	15	30	45	KHz

20.8.4 Hibernation Clock Source Specifications

Table 20-11. Hibernation Clock Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
F _{HIBOSC}	Hibernation module oscillator frequency	-	4.194304	-	MHz
F _{HIBOSC_XTAL}	Crystal reference for hibernation oscillator	-	4.194304	-	MHz
T _{HIBOSC_START}	Hibernation oscillator startup time ^a	-	-	10	ms
F _{HIBOSC_EXT}	External clock reference for hibernation module	-	32.768	-	KHz
DC _{HIBOSC_EXT}	External clock reference duty cycle	45	-	55	%

a. This parameter is highly sensitive to PCB layout and trace lengths, which may make this parameter time longer. Care must be taken in PCB design to minimize trace lengths and RLC (resistance, inductance, capacitance).

Table 20-12. HIB Oscillator Input Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
F _{HIBOSC}	Hibernation module oscillator frequency	-	4.194304	-	MHz
TOL _{HIBOSC}	Hibernation oscillator frequency tolerance	-	Defined by customer application requirements	-	PPM

20.8.5 Main Oscillator Specifications

Table 20-13. Main Oscillator Clock Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
F _{MOSC}	Main oscillator frequency	1	-	16.384	MHz
T _{MOSC_PER}	Main oscillator period	61	-	1000	ns
T _{MOSC_SETTLE}	Main oscillator settling time ^a	17.5	-	20	ms
F _{REF_XTAL_BYPASS}	Crystal reference using the main oscillator (PLL in BYPASS mode) ^b	1	-	16.384	MHz
F _{REF_EXT_BYPASS}	External clock reference (PLL in BYPASS mode) ^b	0	-	50	MHz
DC _{MOSC_EXT}	External clock reference duty cycle	45	-	55	%

a. This parameter is highly sensitive to PCB layout and trace lengths, which may make this parameter time longer. Care must be taken in PCB design to minimize trace lengths and RLC (resistance, inductance, capacitance).

Table 20-14. Supported MOSC Crystal Frequencies

Crystal Frequency (MHz) Not Using the PLL	Crystal Frequency (MHz) Using the PLL			
1.000 MHz	reserved			
1.8432 MHz	reserved			
2.000 MHz	reserved			
2.4576 MHz	reserved			
3.5795	45 MHz			
3.686	4 MHz			
4 MHz				
4.096 MHz				

b. If the ADC is used, the crystal reference must be 16 MHz \pm .03% when the PLL is bypassed.

Table 20-14. Supported MOSC Crystal Frequencies (continued)

Crystal Frequency (MHz) Not Using the PLL	Crystal Frequency (MHz) Using the PLL			
4.915	2 MHz			
5 N	1Hz			
5.12	MHz			
6 MHz (re	set value)			
6.144	MHz			
7.372	8 MHz			
8 N	1Hz			
8.192	? MHz			
10.0	MHz			
12.0	MHz			
12.28	8 MHz			
13.56	13.56 MHz			
14.318	14.31818 MHz			
16.0 MHz				
16.38	4 MHz			

20.8.6 System Clock Specification with ADC Operation

Table 20-15. System Clock Characteristics with ADC Operation

Parameter	Parameter Name	Min	Nom	Max	Unit
j Sysauc	System clock frequency when the ADC module is operating (when PLL is bypassed). ^a	15.9952	16	16.0048	MHz

a. Clock frequency (plus jitter) must be stable inside specified range. ADC can be clocked from the PLL or directly from an external clock source, as long as frequency absolute precision is inside specified range.

20.9 Sleep Modes

Table 20-16. Sleep Modes AC Characteristics^a

Parameter No	Parameter	Parameter Name	Min	Nom	Max	Unit
D1	T _{WAKE_S}	Time to wake from interrupt in sleep mode, not using the PLL ^b	-	-	2	system clocks
D1	T _{WAKE_DS}	Time to wake from interrupt deep-sleep mode, not using the PLL ^b	-	-	7	system clocks
D2	T _{WAKE_PLL_S}	Time to wake from interrupt in sleep or deep-sleep mode when using the PLL ^b	-	-	T _{READY}	ms
D3	T _{ENTER_DS}	Time to enter deep-sleep mode from sleep request	-	0	35 ^c	ms

a. Values in this table assume the IOSC is the clock source during sleep or deep-sleep mode.

20.10 Hibernation Module

The Hibernation module requires special system implementation considerations because it is intended to power down all other sections of its host device, refer to "Hibernation Module" on page 267.

b. Specified from registering the interrupt to first instruction.

c. Nominal specification occurs 99.9995% of the time.

Table 20-17. Hibernation Module Battery Characteristics

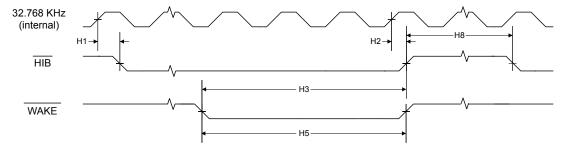
Parameter	Parameter Name	Min	Nominal	Max	Unit
V_{BAT}	Battery supply voltage	2.4	3.0	3.6	V
V_{LOWBAT}	Low battery detect voltage	1.8	-	2.2	V

Table 20-18. Hibernation Module AC Characteristics

Parameter No	Parameter	Parameter Name	Min	Nom	Max	Unit
H1	T _{HIB_LOW}	Internal 32.768 KHz clock reference rising edge to HTB asserted	20	-	-	μs
H2	T _{HIB_HIGH}	Internal 32.768 KHz clock reference rising edge to HTB deasserted	-	30	-	μs
НЗ	T _{WAKE_TO_HIB}	WAKE assert to HIB desassert (wake up time), internal Hibernation oscillator running during hibernation ^a	62	-	124	μs
H4	T _{WAKE_TO_HIB}	WAKE assert to HIB desassert (wake up time), internal Hibernation oscillator stopped during hibernation ^a	-	-	10	ms
H5	T _{WAKE_CLOCK}	WAKE assertion time, internal Hibernation oscillator running during hibernation	62	-	-	μs
H6	T _{WAKE_NOCLOCK}	WAKE assertion time, internal Hibernation oscillator stopped during hibernation ^b	10	-	-	ms
H7	T _{HIB_REG_ACCESS}	Time required for a write to a non-volatile register in the HIB module to complete	92	-	-	μs
H8	Т _{НІВ_ТО_НІВ}	HIB high time between assertions	100	-	-	ms
H9	T _{ENTER_HIB}	Time to enter Hibernate mode from hibernation request	-	0	35 ^c	ms

- a. Code begins executing after the time period specified by T_{IRPOR} following the deassertion of $\overline{\text{HIB}}$.
- b. This mode is used when the PINWEN bit is set and the RTCEN bit is clear in the HIBCTL register.
- c. Nominal specification occurs 99.998% of the time.

Figure 20-11. Hibernation Module Timing with Internal Oscillator Running in Hibernation



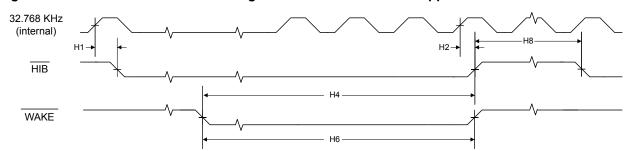


Figure 20-12. Hibernation Module Timing with Internal Oscillator Stopped in Hibernation

20.11 Flash Memory

Table 20-19. Flash Memory Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
PE _{CYC}	Number of guaranteed program/erase cycles before failure ^a	15,000	-	-	cycles
T _{RET}	Data retention, -40°C to +85°C	10	-	-	years
T _{PROG}	Word program time	-	-	1	ms
T _{BPROG}	Buffer program time	-	-	1	ms
T _{ERASE}	Page erase time	-	-	12	ms
T _{ME}	Mass erase time	-	-	16	ms

a. A program/erase cycle is defined as switching the bits from 1-> 0 -> 1.

20.12 Input/Output Characteristics

Note: All GPIO signals are 5-V tolerant when configured as inputs except for PB0 and PB1, which are limited to 3.6 V. See "Signal Description" on page 389 for more information on GPIO configuration.

Table 20-20. GPIO Module Characteristics^a

Parameter	Parameter Name	Min	Nom	Max	Unit
R _{GPIOPU}	GPIO internal pull-up resistor	100	-	300	kΩ
R _{GPIOPD}	GPIO internal pull-down resistor	200	-	500	kΩ
I _{LKG}	GPIO input leakage current ^b	-	-	2	μΑ
	GPIO rise time, 2-mA drive ^c		14	20	ns
т	GPIO rise time, 4-mA drive ^c		7	10	ns
T _{GPIOR}	GPIO rise time, 8-mA drive ^c		4	5	ns
	GPIO rise time, 8-mA drive with slew rate control ^c		6	8	ns
	GPIO fall time, 2-mA drive ^d		14	21	ns
т	GPIO fall time, 4-mA drive ^d		7	11	ns
T _{GPIOF}	GPIO fall time, 8-mA drive ^d	_	4	6	ns
	GPIO fall time, 8-mA drive with slew rate control ^d		6	8	ns

a. V_{DD} must be within the range specified in Table 20-2 on page 797.

b. The leakage current is measured with GND or V_{DD} applied to the corresponding pin(s). The leakage of digital port pins is measured individually. The port pin is configured as an input and the pullup/pulldown resistor is disabled.

c. Time measured from 20% to 80% of V_{DD} .

d. Time measured from 80% to 20% of V_{DD} .

20.13 Analog-to-Digital Converter (ADC)

Table 20-21. ADC Characteristics^a

Parameter	Parameter Name	Min	Nom	Max	Unit
	Maximum single-ended, full-scale analog input voltage, using internal reference	-	-	3.0	V
	Maximum single-ended, full-scale analog input voltage, using external reference	-	-	V _{REFA}	V
\	Minimum single-ended, full-scale analog input voltage	0.0	-	-	V
V _{ADCIN}	Maximum differential, full-scale analog input voltage, using internal reference	-	-	1.5	V
	Maximum differential, full-scale analog input voltage, using external reference	-	-	V _{REFA} /2	V
	Minimum differential, full-scale analog input voltage	0.0	-	-	V
N	Resolution		bits		
F _{ADC}	ADC internal clock frequency ^b	15.9952	16	16.0048	MHz
T _{ADCCONV}	Conversion time ^c		1		μs
F _{ADCCONV}	Conversion rate ^c		1000		k samples/s
T _{ADCSAMP}	Sample time	187.5	-	-	ns
T _{LT}	Latency from trigger to start of conversion	-	2	-	system clocks
Ι _L	ADC input leakage	-	-	2.0	μA
R _{ADC}	ADC equivalent resistance	-	-	10	kΩ
C _{ADC}	ADC equivalent capacitance	0.9	1.0	1.1	pF
EL	Integral nonlinearity (INL) error	-	-	±3	LSB
E _D	Differential nonlinearity (DNL) error	-	-	±3	LSB
E _O	Offset error	-	-	±20	LSB
E _G	Full-scale gain error	-	-	±30	LSB
E _{TS}	Temperature sensor accuracy ^d	-	-	±5	°C

a. The ADC reference voltage is 3.0 V. This reference voltage is internally generated from the 3.3 VDDA supply by a band gap circuit.

b. The ADC must be clocked from the PLL or directly from an external clock source to operate properly.

c. The conversion time and rate scale from the specified number if the ADC internal clock frequency is any value other than 16 MHz.

d. Note that this parameter does not include ADC error.

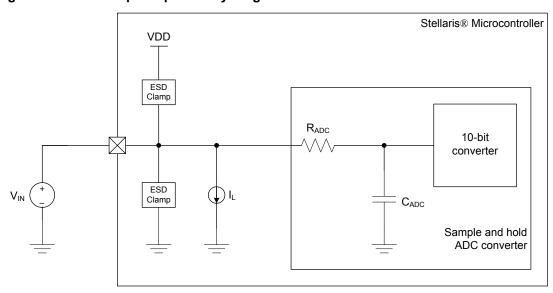


Figure 20-13. ADC Input Equivalency Diagram

Table 20-22. ADC Module External Reference Characteristics^a

Parameter	Parameter Name	Min	Nom	Max	Unit
V _{REFA}	External voltage reference for ADC ^b	2.97	-	3.03	V
IL	External voltage reference leakage current	-	-	2.0	μΑ

a. Care must be taken to supply a reference voltage of acceptable quality.

Table 20-23. ADC Module Internal Reference Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
V_{REFI}	Internal voltage reference for ADC	-	3.0	-	V

20.14 Synchronous Serial Interface (SSI)

Table 20-24. SSI Characteristics

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
S1	T _{CLK_PER}	SSIC1k cycle time ^a	40	-	-	ns
S2	T _{CLK_HIGH}	SSIC1k high time	-	0.5	-	t clk_per
S3	T _{CLK_LOW}	SSIC1k low time	-	0.5	-	t clk_per
S4	T _{CLKRF}	SSIC1k rise/fall time ^b	-	4	6	ns
S5	T _{DMD}	Data from master valid delay time	0	-	1	system clocks
S6	T _{DMS}	Data from master setup time	1	-	-	system clocks
S7	T _{DMH}	Data from master hold time	2	-	-	system clocks
S8	T _{DSS}	Data from slave setup time	1	-	-	system clocks
S9	T _{DSH}	Data from slave hold time	2	-	-	system clocks

a. In master mode, the system clock must be at least twice as fast as the SSIClk; in slave mode, the system clock must be at least 12 times faster than the SSIClk.

b. Ground is always used as the reference level for the minimum conversion value.

b. Note that the delays shown are using 8-mA drive strength.

Figure 20-14. SSI Timing for TI Frame Format (FRF=01), Single Transfer Timing Measurement

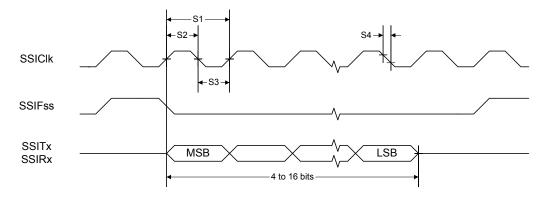
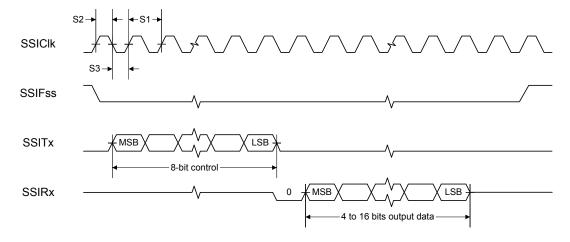


Figure 20-15. SSI Timing for MICROWIRE Frame Format (FRF=10), Single Transfer



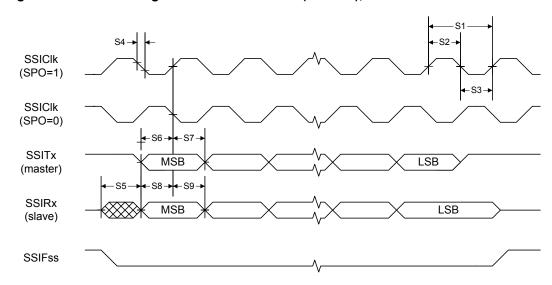


Figure 20-16. SSI Timing for SPI Frame Format (FRF=00), with SPH=1

20.15 Inter-Integrated Circuit (I²C) Interface

Table 20-25, I²C Characteristics

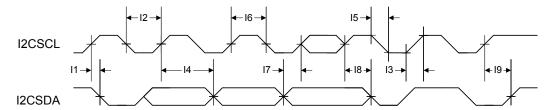
Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
I1 ^a	T _{SCH}	Start condition hold time	36	-	-	system clocks
I2 ^a	T _{LP}	Clock Low period	36	-	-	system clocks
I3 ^b	T _{SRT}	I2CSCL/I2CSDA rise time (V $_{IL}$ =0.5 V to V $_{IH}$ =2.4 V)	-	-	(see note b)	ns
I4 ^a	T _{DH}	Data hold time	2	-	-	system clocks
I5 ^c	T _{SFT}	<code>I2CSCL/I2CSDA</code> fall time (V $_{IH}$ =2.4 V to V $_{IL}$ =0.5 V)	-	9	10	ns
I6 ^a	T _{HT}	Clock High time	24	-	-	system clocks
I7 ^a	T _{DS}	Data setup time	18	-	-	system clocks
I8 ^a	T _{SCSR}	Start condition setup time (for repeated start condition only)	36	-	-	system clocks
I9 ^a	T _{SCS}	Stop condition setup time	24	-	-	system clocks

a. Values depend on the value programmed into the TPR bit in the I²C Master Timer Period (I2CMTPR) register; a TPR programmed for the maximum I2CSCL frequency (TPR=0x2) results in a minimum output timing as shown in the table above. The I²C interface is designed to scale the actual data transition time to move it to the middle of the I2CSCL Low period. The actual position is affected by the value programmed into the TPR; however, the numbers given in the above values are minimum values.

b. Because I2CSCL and I2CSDA operate as open-drain-type signals, which the controller can only actively drive Low, the time I2CSCL or I2CSDA takes to reach a high level depends on external signal capacitance and pull-up resistor values.

c. Specified at a nominal 50 pF load.

Figure 20-17. I²C Timing



20.16 Analog Comparator

Table 20-26. Analog Comparator Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
V_{INP}, V_{INN}	Input voltage range	GND	-	V _{DD}	V
V _{CM}	Input common mode voltage range	GND	-	V _{DD} -1.5	V
V _{OS}	Input offset voltage	-	±10	±25	mV
C _{MRR}	Common mode rejection ratio	50	-	-	dB
T _{RT}	Response time	-	-	1.0	μs
T _{MC}	Comparator mode change to Output Valid	-	-	10	μs

Table 20-27. Analog Comparator Voltage Reference Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
R _{HR}	Resolution in high range	-	V _{DDA} /31	-	V
R _{LR}	Resolution in low range	-	V _{DDA} /23	-	V
A _{HR}	Absolute accuracy high range	-	-	±R _{HR} /2	V
A _{LR}	Absolute accuracy low range	-	-	±R _{LR} /4	V

20.17 Current Consumption

This section provides information on typical and maximum power consumption under various conditions. Unless otherwise indicated, current consumption numbers include use of the on-chip LDO regulator and therefore include $I_{\rm DDC}$.

20.17.1 Nominal Power Consumption

The following table provides nominal figures for current consumption.

Table 20-28. Nominal Power Consumption

Parameter	Parameter Name	Conditions	Nom	Unit
I _{DD_RUN}	Run mode 1 (Flash loop)	V _{DD} = 3.3 V	63	mA
		Code= while(1){} executed out of Flash		
		Peripherals = All ON		
		System Clock = 50 MHz (with PLL)		
		Temp = 25°C		

Table 20-28. Nominal Power Consumption (continued)

Parameter	Parameter Name	Conditions	Nom	Unit
I _{DD_SLEEP}	Sleep mode	V _{DD} = 3.3 V	13	mA
_		Peripherals = All clock gated		
		System Clock = 50 MHz (with PLL)		
		Temp = 25°C		
I _{DD_DEEPSLEEP}	Deep-sleep mode	Peripherals = All OFF	550	μA
		System Clock = IOSC30KHZ/64 Temp = 25°C		
I _{HIB_NORTC}	Hibernate mode (external wake,	V _{BAT} = 3.0 V	26	μA
_	RTC disabled, I/O not powered ^a)	$V_{DD} = 0 V$		
		V _{DDA} = 0 V		
		Peripherals = All OFF		
		System Clock = OFF		
		Hibernate Module = 0 kHz		
I _{HIB_RTC}	Hibernate mode (RTC enabled,	V _{BAT} = 3.0 V	38	μA
	I/O not powered ^a)	$V_{DD} = 0 V$		
		V _{DDA} = 0 V		
		Peripherals = All OFF		
		System Clock = OFF		
		Hibernate Module = 32 kHz		

a. The VDD3ON mode must be disabled for the I/O ring to be unpowered.

20.17.2 Maximum Current Consumption

The current measurements specified in the table that follows are maximum values under the following conditions:

- V_{DD} = 3.6 V
- V_{DDC} = 1.3 V
- $V_{BAT} = 3.25 \text{ V}$
- V_{DDA} = 3.6 V
- Temperature = 85°C
- Clock source (MOSC) = 16.348-MHz crystal oscillator

Table 20-29. Detailed Current Specifications

Parameter	Parameter Name	Conditions	Max	Unit
I _{DD_RUN}	Run mode 1 (Flash loop)	V _{DD} = 3.6 V	129	mA
		Code= while(1){} executed out of Flash		
		Peripherals = All ON		
		System Clock = 80 MHz (with PLL)		
		Temperature = 85°C		

Table 20-29. Detailed Current Specifications (continued)

Parameter	Parameter Name	Conditions	Max	Unit
I _{DD_RUN}	Run mode 1 (SRAM loop)	V _{DD} = 3.6 V	112	mA
		Code= while(1){} executed out of SRAM		
		Peripherals = All ON		
		System Clock = 80 MHz (with PLL)		
		Temperature = 85°C		
I _{DD_RUN}	Run mode 2 (Flash loop)	V _{DD} = 3.6 V	76	mA
		Code= while(1){} executed out of Flash		
		Peripherals = All OFF		
		System Clock = 80 MHz (with PLL)		
		Temperature = 85°C		
I _{DD_RUN}	Run mode 2 (SRAM loop)	V _{DD} = 3.6 V	57	mA
		Code= while(1){} executed out of SRAM		
		Peripherals = All OFF		
		System Clock = 80 MHz (with PLL)		
		Temperature = 85°C		
I _{DD_SLEEP}	Sleep mode	V _{DD} = 3.6 V	42	mA
		Peripherals = All Clock Gated		
		System Clock = 80 MHz (with PLL)		
		Temperature = 85°C		
I _{DD_DEEPSLEEP}	Deep-Sleep mode	V _{DD} = 3.6 V	28	mA
		Peripherals = All Clock Gated		
		System Clock = IOSC30/64		
		Temperature = 85°C		

Table 20-30. Hibernation Detailed Current Specifications

Parameter	Parameter Name	Conditions	Max	Unit
I _{HIB_NORTC}	Hibernate mode (external wake,	V _{BAT} = 3.25 V	173	μA
	RTC disabled, I/O not powered ^a)	$V_{DD} = 0 V$		
		$V_{DDA} = 0 V$		
		Peripherals = All OFF		
		System Clock = OFF		
		Hibernate Module = 0 kHz		
		Temperature = 85°C		
I _{HIB_RTC}	Hibernate mode (RTC enabled, I/O	V _{BAT} = 3.25 V	234	μΑ
	not powered ^a)	$V_{DD} = 0 V$		
		$V_{DDA} = 0 V$		
		Peripherals = All OFF		
		System Clock = OFF		
		Hibernate Module = 32.768 kHz		
		Temperature = 85°C		

a. The VDD3ON mode must be disabled for the I/O ring to be unpowered.

A Register Quick Reference

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
The Co	rtex-M3	Process	or	l											
Ku, type i	₹/vv, , reset	- (see page	:01)				D.4	λΤΑ							
								TA							
R1. type F	R/W reset	- (see page	e 61)												
,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		(p-3-					DA	ATA .							
								TA.							
R2, type F	R/W, , reset	- (see page	e 61)												
							DA	λΤΑ							
							DA	ATA .							
R3, type F	R/W, , reset	- (see page	61)												
								ATA .							
							DA	ATA							
R4, type F	R/W, , reset	- (see page	61)												
								TA.							
DE time !	D/M ====1	(000 705	. 61)				D.P.	ATA							
Ko, type i	₹/vv, , reset	- (see page	:01)				D.4	TA.							
								TA							
R6, type F	R/W, , reset	- (see page	e 61)					•							
., 31	,,	()-	,				DA	ATA							
							DA	ATA .							
R7, type F	R/W, , reset	- (see page	e 61)												
							DA	ATA .							
							DA	ATA .							
R8, type F	R/W, , reset	- (see page	61)												
								ATA							
							DA	ATA							
R9, type F	R/W, , reset	- (see page	e 61)												
								ATA ATA							
R10 type	R/W. rese	et - (see pag	ne 61)				DF	un.							
ic.o, type	,, 1036	(See pay	, /				D.A	λΤΑ							
								TA							
R11, type	R/W, , rese	t - (see pag	je 61)												
							DA	ATA .							
							DA	ATA .							
R12, type	R/W, , rese	et - (see pag	je 61)												
								ATA							
							DA	ATA							
SP, type F	R/W, , reset	- (see page	: 62)												
								iP iP							
IR type !	R/W recot	0xFFFF.FF	FF (see pag	ne 63)				"							
Lix, type i	, , 16361	VALIT 1.1.T	. 1 (See pat	gc 00 <i>)</i>			J II	NK							
								NK							
PC, type I	R/W, , reset	: - (see page	e 64)												
			-				Р	С							
								С							

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PSR, type	e R/W, , rese	t 0x0100.0	0000 (see pa	age 65)											
N	Z	С	V	Q	ICI	/ IT	THUMB								
			/ IT									ISRNUM			
PRIMASK	(, type R/W,	, reset 0x0	0000.0000 (s	see page 69))										
															PRIMASK
FAULTMA	ASK, type R	W, , reset	0x0000.000	l 0 (see page	9 70)							1			
															FAULTMASK
PASEDDI	tuno B/M	rooot OvO	000 0000 (0	00 0000 71	\										FAULTMASK
DASEFRI	l, type R/W,	, reset uxu	000.000 (S	l l)										
									BASEPRI						
CONTRO	L, type R/W,	reset Ox	0000 0000 /	see nage 7	2)				D/(OLI IVI						
	_, . , p	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		Coo page .	_,										
														ASP	TMPL
Cortox	-M3 Perip	herale													
	า Timer (ร) Registe	ers											
	E000.E000		, itegiste	,13											
STCTRL,	type R/W, o	ffset 0x01	0, reset 0x0	000.0004											
,															COUNT
													CLK_SRC	INTEN	ENABLE
STRELOA	AD, type R/V	V, offset 0	k014, reset	0x0000.000	10										
											REL	.OAD			
							REL	OAD							
STCURRI	ENT, type R/	WC, offse	t 0x018, res	et 0x0000.	0000										
											CUR	RENT			
							CURI	RENT							
Cortex-	-M3 Perip	herals													
	Vectored		upt Cont	roller (N	VIC) Reg	isters									
EN0, type	R/W, offset	0x100, re	set 0x0000.	0000											
							IN	IT							
							IN	IT							
EN1, type	R/W, offset	0x104, re	set 0x0000.	0000											
												INT			
							II	İT							
DIS0, type	e R/W, offse	t 0x180, re	eset 0x0000	.0000											
							IN	IT							
							IN	IT							
DIS1, type	e R/W, offse	t 0x184, re	eset 0x0000	.0000											
												INT			
							- IN	IT							
PEND0, ty	ype R/W, off	set 0x200,	reset 0x00	00.0000				_							
								IT IT							
DEND	D.04'			00.000			IN	IT							
PEND1, ty	ype R/W, off	set ux204,	, reset 0x00	00.0000								INT			
							II.	IT				INT			
LINDENDA	0 tune B/M	offect 0:-7	20 roast 0	×0000 0000			II								
UNPEND	0, type R/W,	OHSEL UXZ	.oo, reset 0				IK	IT							
								i' IT							
							יוו	• • • • • • • • • • • • • • • • • • • •							

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
UNPEND	1, type R/W,	offset 0x2	284, reset 0	x0000.0000											
												INT			
							11	, NT							
ACTIVE0,	type RO, o	ffset 0x300	0, reset 0x0	0000.0000											
							II.	١T							
							II	NT							
ACTIVE1,	type RO, o	ffset 0x304	4, reset 0x0	0000.0000											
												INT			
							II.	NT							
PRI0, type	e R/W, offse	et 0x400, re	set 0x0000	0.0000											
	INTD								INTC						
	INTB								INTA						
PRI1, type	e R/W, offse	et 0x404, re	eset 0x0000	0.0000											
	INTD								INTC						
	INTB								INTA						
PRI2, type	e R/W, offse	et 0x408, re	eset 0x0000	0.0000				1							
	INTD								INTC						
	INTB								INTA						
PRI3, type	e R/W, offse	et 0x40C, re	eset 0x0000	0.0000											
	INTD								INTC						
	INTB								INTA						
PRI4, type	e R/W, offse	et 0x410, re	eset 0x0000	0.0000											
	INTD								INTC						
	INTB								INTA						
PRI5, type	e R/W, offse	et 0x414, re	eset 0x0000	0.0000				I				1			
	INTD								INTC						
DDIC turn		4.0-440	0×0000	0000					INTA						
РКІ6, тур	e R/W, offse	et UX418, re	eset uxuuut	J.0000				1	INTO						
	INTD								INTC						
DDI7 tuni	e R/W, offse	ot 0×41C re	neat Ov000	0000					11177						
FIXI7, typ	INTD	, UX410, II	eset uxuuut	1				1	INTC						
	INTB								INTA						
PRIS type	e R/W, offse	ot 0x420 re	set 0x0000	0,000											
, typ	INTD	=0, 10							INTC						
	INTB								INTA						
PRI9. tvp	e R/W, offse	et 0x424. re	eset 0x0000	0.0000											
, ,,,	INTD	,							INTC						
	INTB								INTA						
PRI10, tvi	pe R/W, offs	et 0x428, i	reset 0x000	0.0000				1							
, ,,,	INTD	-,-							INTC						
	INTB								INTA						
PRI11, typ	pe R/W, offs	et 0x42C,	reset 0x000	00.000											
	INTD								INTC						
	INTB								INTA						
PRI12, ty	pe R/W, offs	et 0x430, ı	reset 0x000	00.0000											
	INTD								INTC						
	INTB								INTA						
PRI13, ty	pe R/W, offs	et 0x434, ı	reset 0x000	0.0000											
	INTD								INTC						
	INTB								INTA						

30	29			26	25	24	23	22	21	20	19	18	17	16
14	13	28 12	27 11	10	9	8	7	6	5	4	3	2	1	0
type WO, o	ffset 0xF00), reset 0x0	000.0000								l			
											IN ⁻	ΓID		
M3 Perin	herals													
•		SCB) Re	gisters											
		,	_											
pe R/W, of	set 0x008,	reset 0x00	00.000											
												DISFOLD	DISWBUF	DISMCYC
pe RO, offs	et 0xD00, ı	reset 0x412	F.C230											
		IN	1P					VA	AR .			C	ON	
				PAR	TNO							RI	EV	
type R/W,	offset 0xD0	04, reset 0x	0000.0000											
		PENDSV		PENDSTSET	PENDSTCLR		ISRPRE	ISRPEND					VECPEND	
											VECACT			
ype R/W, o		8, reset 0x(0000.0000											
	BASE	OFFOFT						OFFSET						
- D/M	-4 0-200		05.0000											
e R/VV, OTTS	et uxbuc,	reset uxFA	.05.0000			VECT	TVEV							
					PRIGRALIE		INET					SYSPESPEO	VECTO PACT	VECTRESE
type P/W	offeet (IVD	10 reset 0	×0000 0000		rtioitooi							OTOREGREG	VECTOBACT	VEOTIVEDE
, type ratt,	Oliset OXD	10, 16361 0.												
										SEVONPEND		SLEEPDEEP	SLEEPEXIT	
. type R/W.	offset 0xD)14. reset 0	x0000.0200											
, ., ,		.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,												
					STKALIGN	BFHFNMIGN				DIV0	UNALIGNED		MAINPEND	BASETHE
type R/W, o	offset 0xD1	8, reset 0x	0000.0000					1			I.			
								USAGE						
BUS								MEM						
type R/W,	offset 0xD1	C, reset 0x	0000.0000											
SVC														
type R/W,	offset 0xD2	0, reset 0x	0000.0000											
TICK								PENDSV						
								DEBUG						
TRL, type	R/W, offset	0xD24, res	set 0x0000.	0000										
							a. (= :					USAGE	BUS	MEM
			l			MON	SVCA				USGA		BUSA	MEMA
AT, type R/V	V1C, offset	0xD28, res	set 0x0000.	0000	D# 15						l voss		IND (CT:-	
		DOTIVE	DUCTYE	IMPDE			NANAA DV			MOTIVE		INVPC		UNDEF
FAT 4	NAAC - 50				PRECISE	IROS	WIWARV			MSTKE	IVIUSTKE		DEKK	IERR
	vv1c, offs	et UXD2C, i	eset uxuuu 	0.0000										
I OKCED													VECT	
type P/M	offset fivin	34 reset											VLCI	
type R/W,	OHSEL UXD	o -1 , 1€5€L -				ΔD	DR							
DR. type R/	W. offset fi	xD38. rese	t -			, 10								
-, -, ,, , , , ,	,	,.000	-			AD	DR							
	wype WO, or WM3 Perip Control	M3 Peripherals Control Block (000.E000 pe R/W, offset 0x008, type R/W, offset 0x000, VECPEND ype R/W, offset 0xD00 BASE e R/W, offset 0xD00 type R/W, offset 0xD1 BUS type R/W, offset 0xD1 SVC type R/W, offset 0xD1 BUS type R/W, offset 0xD1 SVC type R/W, offset 0xD2 TICK TRL, type R/W, offset 0xD2 TICK TRL, type R/W, offset 0xD2 Tick TAT, type R/W1C, offset 0xD2 type R/W, offset 0xD2 type R/W, offset 0xD2	M3 Peripherals Control Block (SCB) Re 000.E000 pe R/W, offset 0x008, reset 0x00 pe R/W, offset 0xD00, reset 0x412 IM type R/W, offset 0xD00, reset 0x42 BASE OFFSET Pe R/W, offset 0xD0C, reset 0xFA type R/W, offset 0xD10, reset 0x type R/W, offset 0xD11, reset 0x type R/W, offset 0xD14, reset 0x Type R/W, offset 0xD15, reset 0x Type R/W, offset 0xD16, reset 0x TICK TRL, type R/W, offset 0xD20, reset 0x TICK TRL, type R/W, offset 0xD24, reset 0x TICK BUSP MEMP USAGEP IT, type R/W1C, offset 0xD22, reset 0x TYPE R/W1C, offset 0xD22, reset 0x TYPE R/W1C, offset 0xD22, reset 0x TYPE R/W1C, offset 0xD24, reset 0x TYPE R/W1C, offset 0xD26, reset 0x TYPE R/W1C, offset 0xD34, reset -	M3 Peripherals Control Block (SCB) Registers 000.E000 pe R/W, offset 0x008, reset 0x0000.0000 pe R/W, offset 0xD00, reset 0x412F.C230 IMP type R/W, offset 0xD08, reset 0x0000.0000 PENDSV UNPENDSV VECPEND RETBASE OFFSET Pe R/W, offset 0xD00, reset 0xFA05.0000 BASE OFFSET Pe R/W, offset 0xD10, reset 0x0000.0000 type R/W, offset 0xD10, reset 0x0000.0000 type R/W, offset 0xD14, reset 0x0000.0000 SVC type R/W, offset 0xD15, reset 0x0000.0000 TICK TRL, type R/W, offset 0xD20, reset 0x0000.0000 TICK TRL, type R/W, offset 0xD20, reset 0x0000.0000 BUSP MEMP USAGEP TICK TT, type R/W1C, offset 0xD28, reset 0x0000. BUST BUSTKE TAT, type R/W1C, offset 0xD20, reset 0x0000. TORCED	M3 Peripherals Control Block (SCB) Registers 000.E000 pe R/W, offset 0x000, reset 0x412F.C230 IMP PAR type R/W, offset 0xD04, reset 0x0000.0000 BASE OFFSET PER/W, offset 0xD00, reset 0xFA05.0000 BASE OFFSET PER/W, offset 0xD10, reset 0x0000.0000 Type R/W, offset 0xD10, reset 0x0000.0000 Type R/W, offset 0xD14, reset 0x0000.0000 Type R/W, offset 0xD15, reset 0x0000.0000 Type R/W, offset 0xD16, reset 0x0000.0000 TYPE R/W, offset 0xD20, reset 0x0000.0000 TYPE R/W, offset 0xD20, reset 0x0000.0000 TYPE R/W, offset 0xD24, reset 0x0000.0000	M3 Peripherals Control Block (SCB) Registers 000.E000 pe R/W, offset 0x008, reset 0x0000.0000 pe R/W, offset 0x008, reset 0x0000.0000 pe R/W, offset 0xD00, reset 0x412F.C230	M3 Peripherals Control Block (SCB) Registers 000.E000 pe RW, offset 0x008, reset 0x0000.0000 PeRW, offset 0x004, reset 0x412F.C230 IMP PARTNO type R/W, offset 0xD04, reset 0x0000.0000 PENDSV UMPENDSV PENDSTSET PENDSTCLR VECPEND RETBASE OFFSET PERMY, offset 0xD08, reset 0x0000.0000 PERW, offset 0xD08, reset 0x0000.0000 BASE OFFSET PRIGROUP type R/W, offset 0xD10, reset 0x0000.0000 VEC' PRIGROUP type R/W, offset 0xD10, reset 0x0000.0000 STKALIGN BEHENMICN type R/W, offset 0xD124, reset 0x0000.0000 SVC type R/W, offset 0xD124, reset 0x0000.0000 TICK TRL, type R/W, offset 0xD24, reset 0x0000.0000 BUSP MEMP USAGEP TICK PNDSV MON TICK IMPRE PRECISE IBUS TAT, type R/W1C, offset 0xD24, reset 0x0000.0000 TAT, type R/W1C, offset 0xD24, reset 0x0000.0000 TAT, type R/W1C, offset 0xD24, reset 0x0000.0000 TOCK AD AD	W3 Peripherals	WAS Peripherals Control Block (SCB) Registers 000.E000 pe R/W, offset 0x008, reset 0x0000.0000 pe R/W, offset 0x000, reset 0x0000.0000 pe R/W, offset 0x004, reset 0x0000.0000 VECTKEY prigram period 0x004, reset 0x0000.0000 VECTKEY prigram pe R/W, offset 0x010, reset 0x0000.0000 VECTKEY prigram pe R/W, offset 0x014, reset 0x0000.0000 VECTKEY prigram WAS Peripherals	Washed W	Wind Wind	Wind Wind	### WO, offset 0xF00, reset 0x0000,0000 #### WO, offset 0xF00, reset 0x0000,0000 ############################	

31	30	29	28	27	26	25	24	22	22	21	20	19	10	17	16
15	14	13	12	11	26 10	9	8	23 7	6	5	20 4	3	18	1	0
			12	- ''	10	3	0		0		-			<u>'</u>	0
	-M3 Peri _l y Protec		+ (MDII) I	Pogisto	re										
	E000.E000		t (IVIPU)	Register											
MPUTYPI	E, type RO,	offset 0xD	90, reset 0>	0080.0800											
											IRE	GION			
				GION											SEPARATE
MPUCTR	L, type R/W	, offset 0xI	D94, reset 0	x0000.000	0			1							
													PRIVDEFEN	HFNMIENA	ENABLE
MPUNUM	IBER, type I	R/W, offset	0xD98, res	et 0x0000. 	.0000			I				1			
														NUMBER	
MDUDAC	E tuma DAA	Laffact Out	DOC =====4	00000 000	\									NUMBER	
MIPUBAS	E, type R/W	, onset uxi	Dac, reser	JX0000.000	,u		۸۵	DR							
					ADDR		AL	.51			VALID			REGION	
MPURAS	E1, type R/\	N. offset O	xDA4, reset	0x0000.00											
3573	_ i, i, pe ivi	, 511361 07	, 16361	. 525500.00			ΔΓ	DR							
					ADDR		710				VALID			REGION	
MPUBAS	E2, type R/\	N. offset 0x	xDAC. rese	t 0x0000.0											
							AD	DR							
					ADDR						VALID			REGION	
MPUBAS	E3, type R/\	N, offset 0	xDB4, reset	0x0000.00	000										
							AD	DR							
					ADDR						VALID			REGION	
MPUATTE	R, type R/W	, offset 0xE	DA0, reset 0	x0000.000	0										
			XN			AP					TEX		S	С	В
			SF	, RD								SIZE			ENABLE
MPUATTE	R1, type R/V	V, offset 0x	DA8, reset	0x0000.00	00										
			XN			AP					TEX		S	С	В
			SF	RD								SIZE			ENABLE
MPUATTE	R2, type R/V	V, offset 0x	DB0, reset	0x0000.00	00										
			XN			AP					TEX		S	С	В
			SF	RD								SIZE			ENABLE
MPUATT	R3, type R/V	V, offset 0x	DB8, reset	0x0000.00	00										
			XN			AP					TEX		S	С	В
			SF	RD								SIZE			ENABLE
	n Control 400F.E000														
DID0, typ	e RO, offse	t 0x000, res	set - (see pa	age 193)											
		VER									CL	ASS			
			MA	JOR							IIM	NOR			
PBORCT	L, type R/W	offset 0x0)30, reset 0:	x0000.7FF	D (see page	195)									
														BORIOR	
RIS, type	RO, offset	0x050, rese	et 0x0000.0	000 (see page	age 196)										
							MOSCPUPRIS		PLLLRIS					BORRIS	
IMC, type	R/W, offset	t 0x054, res	set 0x0000.	0000 (see	page 198)										
							MOSCPUPIM		PLLLIM					BORIM	

0.4	20	00	00	0.7	00	0.5	0.4	00	00	04	00	40	40	47	40
31 15	30 14	29 13	28 12	27	26 10	25 9	24 8	23 7	22 6	21 5	20 4	19 3	18	17	16 0
		_				_	0	/	0	5	4	3	2		U
MISC, type	e R/W1C, o	offset 0x058	, reset uxu	1000.0000 (s	see page 20	JU)									
									DILLAMO					DODLUG	
							MOSCPUPMIS		PLLLMIS					BORMIS	
RESC, typ	e R/W, offs	set 0x05C, r	reset - (see	e page 202)				ı				ı			1
															MOSCFAIL
										WDT1	SW	WDT0	BOR	POR	EXT
RCC, type	R/W, offse	et 0x060, re	set 0x0780	.3AD1 (see	page 204)										
				ACG		SYS	SDIV		USESYSDIV						
		PWRDN		BYPASS			XTAL			OSC	SRC			IOSCDIS	MOSCDIS
PLLCFG, t	ype RO, o	ffset 0x064,	, reset - (se	ee page 208	3)										
						F							R		
GPIOHBC	TL, type R	/W, offset 0:	x06C, rese	t 0x0000.00	000 (see pa	ge 209)									
							PORTJ	PORTH	PORTG	PORTF	PORTE	PORTD	PORTC	PORTB	PORTA
RCC2, typ	e R/W, offs	set 0x070, r	eset 0x070	20.6810 (se	e page 211)									
USERCC2	DIV400				SYS	DIV2			SYSDIV2LSB						
		PWRDN2		BYPASS2						OSCSRC2					
MOSCCTL	, type R/W	, offset 0x0	7C, reset 0	0x0000.000	0 (see page	214)									
															CVAL
DSLPCLK	CFG, type	R/W, offset	0x144, res	set 0x0780.	0000 (see p	age 215)									
					DSDIV	ORIDE									
									1	DSOSCSRO)				
PIOSCCAL	L, type R/V	V, offset 0x1	150, reset (0x0000.000	0 (see page	217)		ļ.							
UTEN	, ,,		,												
						CAL	UPDATE					UT			
PIOSCSTA	T. type RC), offset 0x1	 54. reset 0)x0000.004	0 (see page	219)		l							
	, ,,,,		,		(111)	-,						DT			
						RES	SULT					CT			
DID1 type	PO offse	t 0x004, res	ent - (see n	ane 220)											
DID I, type		ER	set - (see p	age 220)		AM					DAD	TNO			
	PINCOUNT				F7	-NVI			TEMP		Pł		ROHS	OI	JAL
			-4 Ov004F ()))))	222				I LIVIE		FI	10	ROIIS	QC	/AL
DC0, type	KO, onset	0x008, res	et uxuu4F.t	Jusr (see p	age 222)		ODA	M07							
								MSZ SHSZ							
DC4 5:::	DO 6#= 1	0.010	-4 (a:	000\			rlA:	אטו וע							
DC1, type	KU, offset	0x010, res		iye 223) 											4000
	MAINIO	VEDIV	WDT1			MAVAE	COSDD	MPU	LUD	TEMPONIO	DI I	WDTO	CIAIO	CIAID	ADC0
DOC :		YSDIV	-4.0. 05		20=;	IVIAXAL	COSPD	MPU	HIB	TEMPSNS	PLL	WDT0	SWO	SWD	JTAG
DC2, type	KO, offset	0x014, res	et 0x0307.	5037 (see p	age 225)										
						COMP1	COMP0						TIMER2	TIMER1	TIMER0
	I2C1		12C0							SSI1	SSI0		UART2	UART1	UART0
	RO, offset	0x018, res										1			
32KHZ		CCP5	CCP4	CCP3	CCP2	CCP1	CCP0	ADC0AIN7	ADC0AIN6	ADC0AIN5	ADC0AIN4	ADC0AIN3	ADC0AIN2	ADC0AIN1	ADC0AIN0
				C10	C1PLUS	C1MINUS	C0O	C0PLUS	COMINUS						
DC4, type	RO, offset	0x01C, res	et 0x0004.	31FF (see p	page 229)										
													PICAL		
		UDMA	ROM				GPIOJ	GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
DC5, type	RO, offset	0x020, res	et 0x0000.	0000 (see p	age 231)										

															I
31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ось, туре	RO, offset	uxuz4, res	et uxuuuu.t	Juuu (see p	age 232)										
DC7 type	RO, offset	0v028 ree	ot OvEEEE I	FEEE (SOO I	nage 233)										
DO7, type	1					DMACH25	DMVCH34	DMVCH33	DMACH22	DMACH21	DMVCH30	DMACH10	DMACH18	DMACH17	DMACH16
DMACH15	DMACH14									DMACH5				DMACH1	
	RO, offset					DIVIN TOT TO	DIVIDAGE	DIVIDION	DIVIDIO	DIVIN TOT TO	BIVIJ (OI 14	DIVIN TOT TO	DIVINIONIE	DIVIDION	Divisionic
Doo, type	10, 011361	0,020,163	ot oxogo.		lage 201)										
								ADC0AIN7	ADC0AIN6	ADC0AIN5	ADC0AIN4	ADC0AIN3	ADC0AIN2	ADC0AIN1	ADC0AIN0
DC9, type	RO, offset	0x190. res	et 0x0000.0	OFF (see p	age 238)										
., ., .					,										
								ADC0DC7	ADC0DC6	ADC0DC5	ADC0DC4	ADC0DC3	ADC0DC2	ADC0DC1	ADC0DC0
NVMSTAT	, type RO,	offset 0x1A	.0, reset 0x	0000.0001	(see page 2	239)						l			
						,									
															FWB
RCGC0, tv	ype R/W, of	fset 0x100.	reset 0x00	000040 (se	e page 240))									
			WDT1	, ,											ADC0
						MAXAD	C0SPD		HIB			WDT0			
SCGC0, ty	ype R/W, of	fset 0x110,	reset 0x00	000040 (se	e page 242	()									
			WDT1												ADC0
						MAXAD	C0SPD		HIB			WDT0			
DCGC0, ty	ype R/W, of	fset 0x120,	reset 0x00	000040 (se	e page 244	l)									
			WDT1												ADC0
									HIB			WDT0			
RCGC1, ty	ype R/W, of	fset 0x104,	reset 0x00)000000 (se	e page 246	5)									
						COMP1	COMP0						TIMER2	TIMER1	TIMER0
	I2C1		I2C0							SSI1	SSI0		UART2	UART1	UART0
SCGC1, ty	ype R/W, of	fset 0x114,	reset 0x00	000000 (se	e page 249)									
						COMP1	COMP0						TIMER2	TIMER1	TIMER0
	I2C1		I2C0							SSI1	SSI0		UART2	UART1	UART0
DCGC1, ty	ype R/W, of	fset 0x124,	reset 0x00	000000 (se	e page 252	2)									
						COMP1	COMP0						TIMER2	TIMER1	TIMER0
	I2C1		I2C0							SSI1	SSI0		UART2	UART1	UART0
RCGC2, ty	ype R/W, of	fset 0x108,	reset 0x00	000000 (se	e page 255	5)									
		UDMA					GPIOJ	GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
SCGC2, ty	ype R/W, of	fset 0x118,	reset 0x00	000000 (se	e page 257)									
		UDMA					GPIOJ	GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
DCGC2, ty	ype R/W, of	fset 0x128,	reset 0x00	0000000 (se	ee page 259	9)									
		UDMA					GPIOJ	GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
SRCR0, ty	pe R/W, of	fset 0x040,	reset 0x00	000000 (se	e page 261)									
			WDT1												ADC0
									HIB			WDT0			
SRCR1, ty	pe R/W, of	fset 0x044,	reset 0x00	000000 (se	e page 263)									
						COMP1	COMP0						TIMER2	TIMER1	TIMER0
	I2C1		I2C0							SSI1	SSI0		UART2	UART1	UART0
				000000 /00	e nage 265)									
SRCR2, ty	pe R/W, of	fset 0x048,	reset uxuu	ooooo (se	c page 200	,									
SRCR2, ty	pe R/W, of	fset 0x048,	reset uxuu	(se	c page 200	, 									

31	30 14	29 13	28	27	26	25	24	23	22	21	20	19	18	17	16
15			12	11	10	9	8	7	6	5	4	3	2	1	0
	ation Mo 400F.C000														
HIBRTCC	, type RO, o	offset 0x00	0, reset 0x0	0000.0000	see page 2	78)									
							RT	cc							
							RT	CC							
HIBRTCM	0, type R/W	/, offset 0x	004, reset 0	xFFFF.FF	F (see pag	e 279)									
							RTO	CM0							
							RTO	СМО							
HIBRTCM	1, type R/W	/, offset 0x	008, reset 0	xFFFF.FF	FF (see pag	e 280)									
							RTO	CM1							
							RTO	CM1							
HIBRTCLI	D, type R/W	, offset 0x	00C, reset (0xFFFF.FFI	FF (see pag	je 281)									
						<u>, , , , , , , , , , , , , , , , , , , </u>	RT	CLD							
							RT	CLD							
HIBCTL, t	ype R/W, of	ffset 0x010), reset 0x8	000.0000 (s	see page 28	32)									
WRC															
							VDD3ON	VABORT	CLK32EN	LOWBATEN	PINWEN	RTCWEN	CLKSEL	HIBREQ	RTCEN
HIBIM, tyr	oe R/W, offs	set 0x014,	reset 0x000	0.0000 (se	e page 285)									
. 31		,		, , ,											
												EXTW	LOWBAT	RTCALT1	RTCALT0
HIBRIS, ty	pe RO, off:	set 0x018,	reset 0x000	00.0000 (se	e page 287	')									
												EXTW	LOWBAT	RTCALT1	RTCALT0
HIBMIS, tv	ype RO, off	set 0x01C,	reset 0x00	00.0000 (se	ee page 28	9)									
-,-,	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	,			1	,									
												EXTW	LOWBAT	RTCALT1	RTCALT0
HIBIC, typ	pe R/W1C, o	offset 0x02	0, reset 0x0	0000.0000 (see page 2	91)									
						,									
												EXTW	LOWBAT	RTCALT1	RTCALT0
HIBRTCT,	type R/W,	offset 0x02	24, reset 0x	0000.7FFF	(see page	292)									
·	,				(111)	,									
							TF	RIM							
HIBDATA,	type R/W,	offset 0x03	30-0x12C, r	eset - (see	page 293)										
	'			•	/		R'	TD							
								TD							
Internal	l Memor	v													
	lemory F		s (Flash	Control	Offset)										
	400F.D000		J (. 14311	23111101	J.136t)										
	R/W, offse		eset 0x0000	.0000											
, -, p-	,														OFFSET
							OFF	SET							
FMD. type	R/W, offse	t 0x004. re	eset 0x0000	.0000											
_, ., po	-, 550						DA	ATA							
								ATA							
FMC. type	R/W, offse	t 0x008. re	eset 0x0000	.0000											
, ., p.	, 000						WR	KEY							
												COMT	MERASE	ERASE	WRITE
FCRIS. tvi	pe RO, offs	et 0x00C	reset 0x000	0.0000											
, . , . ,		, 1													
														PRIS	ARIS
														1 1110	7 11 110

0.4	00			T 07		0.5	0.4	1 00	00	- 0.4	- 00	1 40	40	47	40
31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FCIM, typ	e R/W, offse	et 0x010, r	eset 0x000	0.0000											
, ,	,														
														PMASK	AMASK
FCMISC,	type R/W1C	, offset 0x	014, reset (0x0000.000	10										
														PMISC	AMISC
														FIVIIOC	AIVIIOC
FMC2, typ	oe R/W, offs	et 0x020, ı	eset 0x000	0.0000											
							WF	RKEY							
															WRBUF
EWB\/AI	type R/W, o	offect 0v03	n reeet Ov	0000 0000											
I WOVAL,	type itive, t	JIISEL UAUS	o, ieset ux	0000.0000											
							FV	/B[n]							
							FV	/B[n]							
FCTL, typ	e R/W, offs	et 0x0F8, r	eset 0x000	0.0000											
														LIODAOK	HODDEO
														USDACK	USDREQ
FWBn, ty	pe R/W, offs	et 0x100 -	0x17C, res	et 0x0000.	0000										
							D.	ATA							
							D	ATA							
Interna	I Memory	/													
Memor	y Registe	ers (Svs	tem Cor	ntrol Off	set)										
	400F.E000	(0,0			,										
RMCTL, t	ype R/W1C,	offset 0x0)F0, reset -												
															BA
EMDDEO	type R/W, o	ffeat 0v12	0 and 0v20	O rocat Ov											
i wii ikeo,	type id 11, c	11361 07 13	o and oxzo	0, 1636t 0X											
							READ_	ENABLE							
							READ_	ENABLE							
FMPPE0,	type R/W, o	ffset 0x13	4 and 0x40	0, reset 0xl	FFFF.FFFF										
							PROG	ENABLE							
								ENABLE							
							PROG_	EINABLE							
BOOTCF	G, type R/W	, offset 0x	1D0, reset	0xFFFF.FFF	fΕ										
NW															
	PORT			PIN		POL	EN							DBG1	DBG0
HOED DE		NA - 66 4 /													
	G0, type R/	vv, onset t	JX1EU, rese)(UXFFFF.F	ггг										
NW								DATA							
							D.	ATA							
USER RE	G1, type R/	W. offset (0x1E4. rese	et 0xFFFF.F	FFF										
NW	. , ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	,	,					DATA							
INVV								DATA							
							D.	ATA							
USER_RE	G2, type R/	W, offset (0x1E8, rese	et 0xFFFF.F	FFF										
NW								DATA							
							n	ATA							
USER_RE	G3, type R/	W, offset (0x1EC, res	et 0xFFFF.F	FFFF										
NW								DATA							
							D	ATA							
FMDDE4	type R/W, o	iffeet Noon	4 reset Nu	FEEE EEEE											
KLI,	Cype Nat		-, 16361 UX				D= · · ·								
							READ_	ENABLE							
							READ_	ENABLE							
FMPRE2.	type R/W, o	ffset 0x20	8, reset 0x	0000.0000	_										
							RFAD	ENABLE							
1							KEAD_	ENABLE							

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FMPRE3,	type R/W, o	offset 0x20C, i	reset 0x0	000.0000											
								ENABLE							
							READ_	ENABLE							
FMPPE1,	type R/W, o	ffset 0x404, r	reset 0xF	FFF.FFFF											
								_ENABLE							
							PROG_	_ENABLE							
FMPPE2,	type R/W, o	ffset 0x408, r	reset 0x0	000.0000			5500	ENIABLE							
								_ENABLE _ENABLE							
EMDDE3	tuno P/M o	ffset 0x40C, i	rocat OvO	000 0000			FROG_	LIVABLE							
T WIFFES,	type R/VV, C	iiset ux4uc, i	I GSGL UAU	000.0000			PROG	ENABLE							
								_ENABLE							
Micro F	Direct Me	mory Acc	ose (ul	DMA)											
		Control St			at from C	`hannal	Control	Table R	360)						
Base n/a		Control Si	liuctui	e (Onse	et iroin C	, iiaiiiiei	Control	Table D	a5 <i>e)</i>						
		R/W, offset 0:	x000, res	et -											
	7.31/-						Al	DDR							
							Al	DDR							
DMADSTE	ENDP, type	R/W, offset 0x	x004, res	et -											
							Al	DDR							
							Al	DDR							
DMACHC	TL, type R/\	N, offset 0x00	08, reset	-											
DST	TINC	DSTSIZ	ZE	SRO	CINC	SRC	SIZE							ARB	BSIZE
ARB	SIZE					XFEI	RSIZE					NXTUSEBURST		XFERMODI	E
												NXT			
Micro E	Direct Me	mory Acc	ess (µl	DMA)											
μDMA I		s (Offset fi			se Addre	ess)									
DMASTAT	Γ, type RO, o	offset 0x000,	reset 0x0	01F.0000											
													DMACHAN	S	
									ST	TATE					MASTEN
DMACFG,	, type WO, o	offset 0x004, i	reset -												
															MASTEN
DMACTLE	BASE, type	R/W, offset 0	x008, res	et 0x0000	.0000										
							Al	DDR							
		ADDF	۲												
DMAALTE	BASE, type	RO, offset 0x	00C, rese	et 0x0000.	0200										
								DDR							
							Al	DDR							
DMAWAIT	STAT, type	RO, offset 0x	(010, rese	et 0xFFFF.	FFC0										
								REQ[n]							
							WAIT	REQ[n]							
DMASWR	EQ, type W	O, offset 0x0	14, reset	-			6.								
								REQ[n]							
DMALICE	DUDETOFT	home Date of	f4 0:-01	0 ====+0	.0000 0000		SWI	REQ[n]							
DIMAUSE	DUKS I SET,	type R/W, off	iset UXU1	o, reset 0)	.0000.0000		0.5	T[n]							
								ET[n] ET[n]							
							30	[[1]]							

	T											1			
31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DMAUSE	BURSTCLR	type WO,	offset 0x0	1C, reset -											
							CLI								
							CLI	≺[n]							
DMAREQ	MASKSET,	type R/W,	offset 0x02	0, reset 0x0	0000.0000										
								T[n]							
							SE	T[n]							
DMAREQ	MASKCLR,	type WO,	offset 0x02	4, reset -											
							CLI								
							CLI	R[n]							
DMAENAS	SET, type R	/W, offset	0x028, rese	et 0x0000.00	000										
								T[n]							
							SE	T[n]							
DMAENA	CLR, type \	VO, offset	0x02C, res	et -											
							CLI								
							CLI	≺[n]							
DMAALTS	SET, type R	/W, offset 0)x030, rese	t 0x0000.00	00										
								T[n]							
B							SE	ı[n]							
DMAALTO	JLR, type V	VO, offset (0x034, rese	τ -											
							CLI								
D			• • • • • • • • • • • • • • • • • • • •				CLI	R[n]							
DMAPRIO	SEI, type i	R/W, offset	0x038, res	et uxuuuu.u	000										
							SE.								
DMADDIO	CLD turns	NO office	0.020	4			3E	T[n]							
DIVIAPRIO	ск, туре	wo, onset	0x03C, res	et-			CLI	D[m]							
							CLI								
DMAEDD	CI P type I	P/M offect	0x04C, res	ot 0×0000 0	1000		OLI	V(i)							
DWALKK	CER, type i	Ow, onset	0.040, 165												
															ERRCLR
DMACHAS	SGN type	R/W offset	0x500, res	et OxOOOO O	1000										LITTOLIT
DINACITA	ooit, type	WW, 011361	. 02000, 163	et 0x0000.0	.000		CHAS	GN[n]							
							CHAS								
DMΔPerin	hIDO tyne	RO offset	0xFE0, res	et OxOOOO (1030		01.7.0	0.1[1.]							
Dining Crip	, 	110, 011001	- OXI E0, 100												
											P	ID0			
DMAPerin	hID1. type	RO. offset	0xFE4, res	et 0x0000.0	00B2										
u vp		,													
											P	I ID1			
DMAPerin	hID2. type	RO. offset	0xFE8, res	et 0x0000.0	000B										
	, ., po	_, , ,													
											Р	I ID2			
DMAPerin	ohID3, tvpe	RO, offset	0xFEC, res	set 0x0000	0000										
	.,.,,,,,	.,,	.=,												
											P	I ID3			
DMAPerip	ohID4, type	RO, offset	0xFD0, res	et 0x0000.0	0004										
			,												
											P	I ID4			
DMAPCel	IID0, type F	RO, offset 0	xFF0, rese	t 0x0000.00	0D										
											C	ID0			
								l							

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
			xFF4, reset		F0			1			1	1			
											CI	D1			
DMAPCelli	D2, type R	O, offset 0	xFF8, reset	0x0000.00	05							_			
											CI	D2			
DMAPCelli	ID3, type R	O, offset 0	xFFC, rese	t 0x0000.00)B1										
											CI	D2			
	_		Outputs	(ODIO)							CI	D3			
GPIO Por GPIO Por	t B (APB) t B (AHB) t C (APB) t C (AHB) t D (AHB) t D (AHB) t E (APB) t E (AHB) t F (AHB) t G (APB) t G (AHB) t G (AHB) t H (APB) t H (APB)	base: 0x bas	44005.8000 44000.5000 44000.6000 44000.7000 44000.7000 44005.8000 44002.4000 44002.5000 44002.5000 44002.6000 44002.7000 44003.D000												
	, ,		4006.0000 000, reset 0		(see page	402)									
											DA	ATA			
GPIODIR, t	type R/W, c	ittset ux40	00, reset 0x0	J000.0000 (:	see page 4	03)									
											D	I IR			
GPIOIS, ty	pe R/W, off	set 0x404,	, reset 0x00	00.0000 (se	ee page 404	4)									
											Į:	S			
GPIOIBE, t	ype R/W, o	ffset 0x40	8, reset 0x0	0000.0000 (see page 4	05)						_			
											IE	BE			
GPIOIEV, t	ype R/W, o	ffset 0x40	C, reset 0x0	0000.0000 (see page 4	06)									
											ıc	 =V			
GPIOIM 6	ne R/W of	feet Ov410	, reset 0x00	100 0000 (se	e nage 40	7)					16	_ v			
Ci iCilvi, ty	Po 10 88, 01		, . 6361 0400		oo page 40	• ,									
											IN	I ΛΕ			
GPIORIS, t	ype RO, of	fset 0x414	1, reset 0x00	000.0000 (s	ee page 40	08)		1							
- /-															
											R	IIS			
GPIOMIS, 1	type RO, o	ffset 0x418	8, reset 0x0	000.0000 (s	ee page 40	09)									
											М	IIS			
GPIOICR, t	type W1C,	offset 0x4	1C, reset 0x	(0000.0000	(see page	411)									
											Į.	c			
GPIOAFSE	L, type R/\	V, offset 0	x420, reset	- (see page	412)										
											AFS	SEL			

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GPIODR2	2R, type R/W	, offset 0x	500, reset	0x0000.00F	F (see pag	e 414)		l				<u> </u>			
		•	,			,									
											DF	RV2			
GPIODR4	4R, type R/W	, offset 0x	504, reset	0x0000.000	0 (see page	e 415)									
		•	,		· · · ·	,									
											DF	RV4			
GPIODR	BR, type R/W	, offset 0x	508, reset	0x0000.000	0 (see page	e 416)		l							
		•	,		· · · ·	,									
											DF	I RV8			
GPIOODI	R, type R/W,	offset 0x5	iOC. reset 0	x0000.000) (see page	417)		l							
					(333)	,									
											0	DE			
GPIOPUE	R, type R/W,	offset 0x5	10. reset -	(see page 4	18)										
0. 10. 0.	ι, ι, μο ,		,	(ccc page	,										
											P	l UE			
GPIOPDE	R, type R/W,	offset 0x5	14. reset 0	x0000 0000	(see page	420)		l			· ·				
JJ. DI	., ., ,, ,, ,, ,, ,, ,, ,, ,, ,, ,, ,, ,		.,		,see page	,									
											P	l DE			
GPIOSI F	R, type R/W,	offset 0x5	18. reset 0s	k0000 0000	(see page	422)					•				
01 10021	t, typo 1011,	onoct oxo	10, 10001 02		(occ page	122)									
											S	l RL			
GPIODEN	N, type R/W,	offeet Ov5	1C reset -	(see page	123)			<u> </u>							
OI IODEI	i, type itivi,	Oliset Oxo	10, 16361 -	(see page -	120)										
											D	 EN			
CRIOL OC	CK tupo B/M	/ offeet Ov	E20 rooot	0×0000 000	11 (000 000	0.425)									
GFIOLOG	CK, type R/W	, onset ux	iozu, reset	0x0000.000	i (see pay	e 425)	10	CK							
								CK							
CDIOCB	tuno office	+ 0×E24 #	nant (non	nago 426)				- CK							
GPIOCK,	type -, offse	et ux524, re	eset - (see	page 426)											
												l R			
CDIOAM	CEL time D	\A\ =#==4 (Dv.F20 ====	4 0~0000 0	200 (222 22	ma 420\		<u> </u>				,r.			
GPIOAIVI	SEL, type R/	vv, onset t	JX526, rese	I UXUUUU.U	oou (see pa	ge 426)									
											ODIO	1			
GPIOPC	IL, type R/W				100)						GPIO	AMSEL			
			52C, reset	- (see page		400			DA	105	GPIO	AMSEL	Div	104	
	PM	C7	52C, reset	- (see page	PN	AC6				IC5	GPIO	AMSEL		1C4	
00100	PM PM	C7 C3			PN PN	/IC2				IC5 IC1	GPIO	AMSEL		1C4 1C0	
GPIOPer	PM	C7 C3			PN PN	/IC2					GPIO	AMSEL			
GPIOPeri	PM PM	C7 C3			PN PN	/IC2									
	PM PM iphID4, type	C7 C3 RO, offset	t 0xFD0, re	set 0x0000	PN PN .0000 (see	MC2 page 432)						AMSEL D4			
	PM PM	C7 C3 RO, offset	t 0xFD0, re	set 0x0000	PN PN .0000 (see	MC2 page 432)									
	PM PM iphID4, type	C7 C3 RO, offset	t 0xFD0, re	set 0x0000	PN PN .0000 (see	MC2 page 432)					Pl	D4			
GPIOPeri	PM iphID4, type iphID5, type	C7 C3 RO, offset	t 0xFD0, re	set 0x00000	PN PN .0000 (see .0000 (see	page 432)					Pl				
GPIOPeri	PM PM iphID4, type	C7 C3 RO, offset	t 0xFD0, re	set 0x00000	PN PN .0000 (see .0000 (see	page 432)					Pl	D4			
GPIOPeri	PM iphID4, type iphID5, type	C7 C3 RO, offset	t 0xFD0, re	set 0x00000	PN PN .0000 (see .0000 (see	page 432)					PI	D4 D5			
GPIOPeri	PM PM iphID4, type iphID5, type iphID6, type	C7 C3 RO, offset	t 0xFD0, red	set 0x00000 	PN PN .0000 (see .0000	page 432)					PI	D4			
GPIOPeri	PM iphID4, type iphID5, type	C7 C3 RO, offset	t 0xFD0, red	set 0x00000 	PN PN .0000 (see .0000	page 432)					PI	D4 D5			
GPIOPeri	PM PM iphID4, type iphID5, type iphID6, type	C7 C3 RO, offset	t 0xFD0, red	set 0x00000 	PN PN .0000 (see .0000	page 432)					PI	D4			
GPIOPeri GPIOPeri	PM PM iphID4, type iphID5, type iphID6, type iphID7, type	C7 C3 RO, offset RO, offset RO, offset	t 0xFD0, red	set 0x00000	PN PN .0000 (see	page 432) page 433) page 434) page 435)					PI	D4 D5			
GPIOPeri GPIOPeri GPIOPeri	PM PM iphID4, type iphID5, type iphID6, type	C7 C3 RO, offset RO, offset RO, offset	t 0xFD0, red	set 0x00000	PN PN .0000 (see	page 432) page 433) page 434) page 435)					PI	D4			
GPIOPeri GPIOPeri	PM PM iphID4, type iphID5, type iphID6, type iphID7, type	C7 C3 RO, offset RO, offset RO, offset	t 0xFD0, red	set 0x00000	PN PN .0000 (see	page 432) page 433) page 434) page 435)					PI	D4			

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GPIOPeri	phID1, type	RO, offset	t 0xFE4, rese	t 0x0000.	0000 (see p	page 437)									
											PI	D1			
GPIOPeri	phID2, type	RO, offset	t 0xFE8, rese	t 0x0000.	0018 (see p	page 438)									
											PI	D2			
GPIOPeri	phID3, type	RO, offset	t 0xFEC, rese	t 0x0000	.0001 (see	page 439)									
											PI	D3			
GPIOPCe	IIID0, type F	RO, offset	0xFF0, reset	0x0000.0	00D (see pa	age 440)									
											CI	D0			
GPIOPCe	IIID1, type F	RO, offset	0xFF4, reset	0x0000.0	0F0 (see pa	age 441)									
	, ,,	,	<u> </u>			,									
											CI	I D1			
GPIOPC	IIID2, type F	RO. offset	0xFF8, reset (0x0000.n	005 (see na	ae 442)		l							
JJ. 06	, type i	.5, 511361	0, 16361		- Jo (See pe	.50 +74)									
											C	D2			
CDIODC	IIIDa tuna I	20 offers	0.4550	00000 0	10D4 (222 p	nes 442)						D2			
GPIOPCE	IIID3, type r	to, onset	0xFFC, reset	UXUUUU.U	(see p	age 443)									
											01	D0			
											Ci	D3			
Timer 2	pase: 0x40 pase: 0x40 G, type R/W	003.2000	000, reset 0x0	000.000) (see page	461)									
														GPTMCFG	
GPTMTAI	MR, type R/	W, offset 0	x004, reset 0	x0000.00	00 (see pag	je 462)					-				
								TASNAPS	TAWOT	TAMIE	TACDIR	TAAMS	TACMR	TA	MR
GPTMTB	MR, type R/	W, offset 0	x008, reset 0	x0000.00	00 (see pad	ie 464)		l							
	, ,,,,,	,				, , ,									
								TBSNAPS	TBWOT	TBMIE	TBCDIR	TBAMS	TBCMR	ТВ	MR
GPTMCT	type P/W	offeet flyf	00C, reset 0x0	2000 0000) (see nage	466)		1.20.0.0	.5		1505	1.27	150		
0	_, type (a),	OHOUL OX	100, 10001 0x1		(occ page	100)									
	TBPWML	TBOTE		TRE	VENT	TBSTALL	TBEN		TAPWML	TAOTE	RTCEN	TΔE	VENT	TASTALL	TAEN
CDTMIME			18, reset 0x0				IBLIT		I/U VVIVIL	INOTE	KIOLI	1712	VEIVI	I/ (O I/ KEE	17 (11)
GF I WIIIWII	t, type raw,	Oliset uxu	TIO, TESEL UAU	000.000	(see page	409)									
				TDMIM	CDEIM	СВМІМ	ТВТОІМ				TABAIRA	DTCIM	CAEIM	CAMIM	TATOIM
		FF 4 0 04		TBMIM	CBEIM		TBTOIN				TAMIM	RTCIM	CAEIM	CAMIN	IATOIN
GPIMRIS	, type RO, o	orrset 0x01	C, reset 0x00	0000.000	(see page 4	1/1)									
				TD145:5	005515	001:5:5	TDT6 7::-				TAL-25	DECE	0455:5	041:5:5	T.T.C.T.
				TBMRIS	CBERIS		TBTORIS				TAMRIS	RTCRIS	CAERIS	CAMRIS	TATORIS
GPTMMIS	s, type RO,	offset 0x02	20, reset 0x00	00.0000	(see page 4	74)									
						CBMMIS	TBTOMIS				TAMMIS	RTCMIS	CAEMIS	CAMMIS	TATOMIS
GPTMICE	type W1C	, offset 0x0	024, reset 0x0	0000.0000	(see page	477)									
			Т	BMCINT	CBECINT	CBMCINT	TBTOCINT				TAMCINT	RTCCINT	CAECINT	CAMCINT	TATOCINT
GPTMTAI	LR, type R/	W, offset 0	x028, reset 0	xFFFF.FF	FF (see pa	ge 479)									
							TA	ILR							
							TA	ILR							

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	17	0
	LR, type R/	W, offset ()x02C, rese	t 0x0000.F	FFF (see pa	ge 480)						1			
							ТВ	ILR							
							ТВ	ILR							
GPTMTAI	MATCHR, ty	pe R/W, o	ffset 0x030	, reset 0xFl	FFF.FFFF (s	ee page 48	1)								
								MR							
								MR							
GPTMTBI	MATCHR, ty	pe R/W, o	ffset 0x034	, reset 0x0	000.FFFF (s	ee page 48		MD							
								MR MR							
GPTMTAF	PR, type R/\	V. offset 0	x038. reset	0x0000.00	00 (see pag	e 483)	10	IVIIX							
	, , , , po . c .	, 000. 0			(coo pag	,									
											TA	I PSR			
GPTMTB	PR, type R/\	N, offset 0	x03C, rese	t 0x0000.00	00 (see pag	je 484)									
											ТВ	PSR			
GPTMTAF	PMR, type R	R/W, offset	0x040, res	et 0x0000.0	1000 (see pa	ige 485)									
											TAT	CMD			
CDTMTD	DMD time 5)/M 0860-4	00044 ===	ot 0x0000 (0000 (000 ==	ngo 196)					IAF	SMR			
GPIWIIDI	PMR, type F	avv, onset	UXU44, res	et uxuuuu.t	Juuu (see pa	age 466)									
											TBF	 PSMR			
GPTMTAF	R, type RO,	offset 0x0	48, reset 0:	⊥ ĸFFFF.FFFI	(see page	487)		l							
							T/	AR							
							T/	AR							
GPTMTB	R, type RO,	offset 0x0	4C, reset 0	x0000.FFF	F (see page	488)									
							TI	3R							
							TI	3R							
GPTMTAV	/, type RW,	offset 0x0	50, reset 0x	(FFFF.FFFF	(see page	489)									
								4V							
COTMTO	/ tupe BW	offeet 0v0	E4 recet 0	-0000 EEE	: (200 page	400)	- 17	AV							
GFINIE	V, type RW,	Oliset uxu	54, Teset 0	KUUUU.FFFF	(see page	490)	т	3V							
								BV							
Watche	log Time	rs													
WDT0 ba	ase: 0x400	00.000													
	ase: 0x400														
WDTLOA	D, type R/W	, offset 0x	.000, reset	0xFFFF.FFI	F (see page	e 495)	WDT	LOAD							
								LOAD LOAD							
WDTVALI	UE, type RC), offset 0x	004. reset	0xFFFF.FF	FF (see pag	e 496)	****	LOAD							
	, -,	,			. (p-9	- 110,	WDT\	/ALUE							
							WDT\	/ALUE							
WDTCTL,	type R/W,	offset 0x00	08, reset 0x	0000.0000	(WDT0) and	1 0x8000.00	000 (WDT1)	(see page	497)						
WRC															
														RESEN	INTEN
WDTICR,	type WO, o	ffset 0x00	C, reset - (s	see page 49	9)										
								NTCLR							
WDTC:	h.m. DC		\ mac-+ ^ -	000 0000		0)	WDTII	NTCLR							
WDTRIS,	type RO, of	TSET UXU10	, reset 0x0	UUU.UOOO (S	see page 50	U)									
															WINTER
															WDTRIS

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
WDTMIS, t	type RO, of	fset 0x014	, reset 0x00	000.0000 (s	ee page 50	1)									
															WDTMIS
WDTTEST,	type R/W,	offset 0x4	18, reset 0x	0000.0000	(see page 5	502)									
							STALL								
WDTLOCK	(, type R/W	. offset 0x0	C00, reset 0	x0000.000	0 (see page	503)									
	, ,,,,	,	,		- (3-	,	WDT	LOCK							
								LOCK							
MDTD!	hID4 4	DO -#4	0FD0	-4.00000	2000 /	504)	***	LOOK							
WDTPeripi	nib4, type	KO, oliset	0xFD0, res	et uxuuuu.t	Juuu (see pa	age 504)		1				1			1
											Pl	D4			
WDTPerip	hID5, type	RO, offset	0xFD4, res	et 0x0000.0	0000 (see pa	age 505)									
											PI	D5			
WDTPerip	hID6, type	RO, offset	0xFD8, res	et 0x0000.0	0000 (see pa	age 506)									
											PI	D6			
WDTPerin	hID7, tvne	RO. offset	0xFDC, res	et 0x0000	0000 (see n	age 507)		1							
onp	,.,po	_,				3- 001)									
											D	D7			
												וט			
WDTPerip	hID0, type	RO, offset	0xFE0, res	et 0x0000.0	1005 (see pa	age 508)		1							
											PI	D0			
WDTPerip	hID1, type	RO, offset	0xFE4, res	et 0x0000.0	0018 (see pa	age 509)									
											P	D1			
WDTPerip	hID2, type	RO, offset	0xFE8, res	et 0x0000.0	0018 (see pa	age 510)									
											P	D2			
WDTPerin	hID3 type	RO offset	0xFEC, res	et OxOOOO	0001 (see n	ane 511)									
TTD II CIIP	піво, сурс	110, 011001	UXI EG, 103	- CT GAGGGG.	(300 p	age of the									
											D	D3			
					/							טט			
WDTPCell	ID0, type R	O, offset 0	xFF0, reset	0x0000.00	OD (see pa	ge 512)		1							
											С	D0			
WDTPCell	ID1, type R	O, offset 0	xFF4, reset	0x0000.00	F0 (see pag	ge 513)									
											С	D1			
WDTPCell	ID2, type R	O, offset 0	xFF8, reset	0x0000.00	06 (see pag	ge 514)							_	_	_
											С	D2			
WDTPCell	ID3, type R	O, offset 0	xFFC, rese	t 0x0000.00	DB1 (see na	ge 515)									
	, .ypo I	, 5501			(500 pa	320.01									
											C	D3			
											C	רס			
			erter (AD	(C)											
	se: 0x400					E0-1									
ADCACTS	S, type R/V	V, offset 0x	(000, reset	0x0000.000	00 (see page	e 535)		1							
												ASEN3	ASEN2	ASEN1	ASEN0
ADCRIS, ty	ype RO, of	fset 0x004,	reset 0x00	00.0000 (se	ee page 536	i)									
															INRDC
												INR3	INR2	INR1	INR0

												1			
31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ADCIM, ty	ype R/W, of	fset 0x008,	reset 0x00	00.0000 (se	ee page 538)						1	T======	T = = =	
													DCONSS2		
												MASK3	MASK2	MASK1	MASK0
ADCISC,	type R/W10	, offset 0x	00C, reset (0x0000.000	0 (see page	9 540)						1	T=	T =	T =
													DCINSS2		
												IN3	IN2	IN1	IN0
ADCOST	AT, type R/V	V1C, offset	0x010, res	et 0x0000.0	0000 (see pa	age 543)									
												OV3	OV2	OV1	OV0
ADCEMU	X, type R/W	l, offset 0xt	014, reset 0	x0000.0000	(see page	545)									
		M3			EN				EI	W1			EI	M0	
ADCUSTA	AT, type R/V	V1C, offset	0x018, rese	et 0x0000.0	0000 (see pa	age 549)									
												UV3	UV2	UV1	UV0
ADCSSPI	RI, type R/V	V, offset 0x	020, reset 0	x0000.321	0 (see page	550)									
		S	S3			S	S2			S	S1			S	S0
ADCSPC,	, type R/W,	offset 0x02	4, reset 0x0	0000.0000	see page 5	52)									
													PH	ASE	
ADCPSSI	l, type R/W,	offset 0x02	28, reset - (s	see page 5	53)										
												SS3	SS2	SS1	SS0
ADCSAC	, type R/W,	offset 0x03	0, reset 0x0	0000.0000	(see page 5	55)									
														AVG	
ADCDCIS	C, type R/V	V1C, offset	0x034, res	et 0x0000.0	0000 (see pa	age 556)									
								DCINT7	DCINT6	DCINT5	DCINT4	DCINT3	DCINT2	DCINT1	DCINT0
ADCCTL,	type R/W,	offset 0x03	8, reset 0x0	000.0000 (see page 55	58)									
															VREF
ADCSSM	UX0, type F	R/W, offset	0x040, rese	t 0x0000.0	000 (see pa	ge 559)									
		MUX7				MUX6				MUX5				MUX4	
		MUX3				MUX2				MUX1				MUX0	
ADCSSC	TL0, type R	/W, offset 0	x044, reset	0x0000.00	000 (see pag	ge 561)									
TS7	IE7	END7	D7	TS6	IE6	END6	D6	TS5	IE5	END5	D5	TS4	IE4	END4	D4
TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0
ADCSSFI	FO0, type F	RO, offset 0	x048, reset	- (see pag	e 564)										
										DA	ATA				
ADCSSFI	FO1, type F	RO, offset 0	x068, reset	- (see pag	e 564)										
										DA	ATA				
ADCSSFI	FO2, type F	RO, offset 0	x088, reset	- (see pag	e 564)										
				, - 13											
										DA	ATA				
ADCSSFI	FO3, type F	RO, offset fi	x0A8. rese	t - (see pag	e 564)										
	, ., po 1	,	,	(pag	,										
										D/	ATA				

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ADCSSF	STAT0, type	RO, offse	t 0x04C, res	et 0x0000	.0100 (see	page 565)									
			FULL				EMPTY		Н	PTR			TF	PTR	
ADCSSF	STAT1, type	RO, offse	t 0x06C, res	et 0x0000	.0100 (see	page 565)									
			FULL				EMPTY		H	PTR			TF	PTR	
ADCSSF	STAT2, type	RO, offse	t 0x08C, res	et 0x0000	.0100 (see	page 565)									
			FULL				EMPTY			PTR			т.	OTD	
ADCCCC	STAT3, type	PO offee		201 020000	0100 (222	nogo ESE)	EIVIPTT		П	- IR			11	PTR	
ADCOOF	STATS, type	KO, Olise	t uxuAG, res	Set uxuuuu	.0100 (see	page 505)									
			FULL				EMPTY		HI	PTR			TF	PTR	
ADCSSO	P0, type R/V	V, offset 0		0x0000.00	00 (see pad	ie 567)									
		<u>, </u>	S7DCOP				S6DCOP				S5DCOP				S4DCOF
			S3DCOP				S2DCOP				S1DCOP				SODCOF
ADCSSD	C0, type R/V	V, offset 0	x054, reset	0x0000.00	00 (see pag	je 569)									
	S7D0	CSEL			S6D	CSEL			S5D	CSEL			S4D	CSEL	
	S3D0	CSEL			S2D	CSEL			S1D	CSEL			SOD	CSEL	
ADCSSM	UX1, type R	/W, offset	0x060, rese	t 0x0000.0	000 (see pa	age 571)									
						<u> </u>				l					
		MUX3				MUX2				MUX1				MUX0	
ADCSSM	UX2, type R	/W, offset	UXU8U, rese	t 0x0000.0	ouu (see pa	age 5/1)									
		MUX3				MUX2				MUX1				MUX0	
ADCSSC	TL1, type R/		0x064, reset	0x0000.0	000 (see na					MOXI				WOXO	
7.2000	, ., po	.,			(000 pc	.90 0.2)									
TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0
ADCSSC	TL2, type R/	W, offset	0x084, reset	0x0000.0	000 (see pa	ige 572)									
TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0
ADCSSO	P1, type R/V	V, offset 0	x070, reset	0x0000.00	00 (see pag	je 574)									
			S3DCOP				S2DCOP				S1DCOP				SODCOP
ADCSSO	P2, type R/V	V, offset 0	x090, reset	0x0000.00	00 (see pag	je 574)									
			S3DCOP				S2DCOP				S1DCOP				SODCOP
ADCSSD	C1, type R/V	V offeet o		0×0000 00	OO (see nac	ne 575)	320007				310007				30000
ADOGGD	o i, type R/V	-, onset 0	AU 7, 1030l	CAUGUU.00	oo (ace pag	,5 5/ 5/									
	S3D0	CSEL			S2D	CSEL			S1D	CSEL			SOD	CSEL	
ADCSSD	C2, type R/V		x094, reset	0x0000.00											
	S3D0	CSEL			S2D	CSEL			S1D	CSEL			SOD	CSEL	
ADCSSM	UX3, type R	/W, offset	0x0A0, rese	et 0x0000.0	0000 (see p	age 577)									
														MUX0	
ADCSSC	TL3, type R/	W, offset	0x0A4, rese	t 0x0000.0	002 (see pa	age 578)									
												TS0	IE0	END0	D0
ADCSSO	P3, type R/V	v, offset 0	x0B0, reset	0x0000.00	00 (see pag	ge 579)									
															600000
															SODCOP

04	20	00	00	07	00	05	0.4	1 00	00	04	00	10	40	47	40
31 15	30 14	29 13	28 12	27 11	26 10	25 9	24 8	23 7	22 6	21 5	20 4	19 3	18	17	16 0
							0	/	0	5	4	3	2	ļ !	U
ADCSSDC	C3, type R/W	v, onset u	KUB4, reset	UXUUUU.UUL	(see pag	e 580)									
													200	CSEL	
ADCDCBI	C, type R/W	L offeet Ox	DOO rooot	0~0000 000	0 (222 222	o E91)							300	OOLL	
ADODORI	C, type K/W	, onset ux	Doo, reset	0.0000.000	(see pag	501)		DCTPIG7	DCTPICE	DCTDICS	DCTPIGA	DCTRIG3	DCTBIG2	DCTDIG1	DCTBIGO
								DCINT7	DCINT6	DCINT5	DCINT4	DCINT3	DCINT2	DCINT1	DCINT0
ADCDCCI	ΓL0, type R/	W offeat (OvEOO rese	t 0×0000 00	100 (see na	ne 586)		DOINT	DOINTO	DOINTS	DOINT	DOINTS	DOINTZ	DOINTT	DOINTO
ADODOOI	Lo, type id	v, onserv	UXE00, 1636		(see pa	gc 300)									
											CIE	С	IC	С	IM
ADCDCCT	ΓL1, type R/	W. offset (0xE04. rese	t 0x0000.00	000 (see pa	ge 586)					_				
	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	,			(222	J,									
											CIE	С	IC	С	IM
ADCDCCT	ΓL2, type R/	W, offset (0xE08, rese	t 0x0000.00	000 (see pa	ge 586)						l			
	, ,,,	,			(J,									
											CIE	С	IC	С	IM
ADCDCCT	ΓL3, type R/	W, offset (0xE0C, rese	et 0x0000.00	000 (see pa	age 586)		1							
						,									
											CIE	С	IC	С	IM
ADCDCCT	ΓL4, type R/	W, offset (0xE10, rese	t 0x0000.00	000 (see pa	ge 586)			1			I.			
											CIE	С	IC	С	IM
ADCDCCT	ΓL5, type R/	W, offset (0xE14, rese	t 0x0000.00	000 (see pa	ge 586)									
											CIE	С	IC	С	IM
ADCDCCT	ΓL6, type R/	W, offset (0xE18, rese	t 0x0000.00	000 (see pa	ge 586)									
											CIE	С	IC	С	IM
ADCDCCT	ΓL7, type R/	W, offset (0xE1C, rese	et 0x0000.00	000 (see pa	age 586)									
											CIE	С	IC	С	IM
ADCDCC	MP0, type R	/W, offset	0xE40, rese	et 0x0000.0	000 (see pa	age 588)									
										CO	MP1				
										CO	MP0				
ADCDCC	MP1, type R	/W, offset	0xE44, rese	et 0x0000.0	000 (see pa	age 588)									
											MP1				
										CO	MP0				
ADCDCC	MP2, type R	/W, offset	0xE48, rese	et 0x0000.0	000 (see pa	age 588)									
											MP1				
										CO	MP0				
ADCDCC	MP3, type R	/W, offset	0xE4C, res	et 0x0000.0	000 (see p	age 588)					MD4				
											MP1				
AD0200	MD4.4 =	AN - " :	0550	4.00222	000 (:					CO	MP0				
ADCDCC	MP4, type R	/vv, offset	ux⊑50, rese	et UXUU00.0	uuu (see pa	age 588)				00	MD1				
											MP1				
ADCDCC:	MDE 4	NN -# 1	0.4554	-4 0×0000 0	000 /5	F00\				CO	MP0				
ADCDCC	MP5, type R	/vv, offset	ux⊑54, rese	et UXUUUU.0	uuu (see pa	aye 588)				00	MD1				
											MP1 MP0				
ADCDCC:	MD6 6/m= D	/M off	0vEE0	ot 0×0000 0	000 (000 5	age E00)				CO	vii-O				
ADCDCCI	MP6, type R	/vv, omset	UXEDO, FES	et UXUUUU.U	ooo (see pa	aye odd)				CO	MP1				
											MP0				
											VII- U				

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ADCDCCI	MP7, type I	R/W, offset	0xE5C, res	et 0x0000.	0000 (see p	age 588)									
										СО	MP1				
										СО	MP0				
Univers	sal Asyn	chronou	ıs Receiv	ers/Tra	nsmitter	rs (UART	s)								
	oase: 0x40														
	oase: 0x40 oase: 0x40														
			0, reset 0x0	0000.0000	(see page 6	504)									
,	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,				(coo page c	,									
				OE	BE	PE	FE				D/	ATA			
UARTRSE	R/UARTECI	R. type RO.	offset 0x00					e aister) (se	e page 606)					
		, ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		(,		- paga ara	,					
												OE	BE	PE	FE
UARTRSE	R/UARTECI	R. tyne WO	, offset 0x0	04. reset 0	×0000.0000) (Write-On	ly Error Cle	ar Registe	r) (see page	e 606)					
		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		- (111110 G.I.I			. , (occ pag.						
											D	I ATA			
UARTER	type RO. o	ffset 0x018	, reset 0x00	000.0090 (see page 60	09)									
	.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		,		Joe page of	,									
							RI	TXFE	RXFF	TXFF	RXFE	BUSY	DCD	DSR	CTS
IIARTII DI	R type R/M	/ offset for	020, reset 0	×0000 000	(see nage	612)		.,,, =		.,,,,,		1 2301	200	2011	
JAN HEP	, cype raw	., 511361 0X1	, 16361 0		- (occ page	. 312)									
											II PI) DVSR			
IIADTIBD	D. type P/V	V offeet Ov	024, reset 0	~0000 000	M (see page	613)					10.1	7701			
UAKTIBK	D, type K/V	v, onset ox	024, 16561 0		(see page	013)									
							DIV	 /INT							
HADTEDE	D turns D/	M offeet 0	.020	0~000 00	00 /222 222	o C14)	DIV	IINI							
UAKIFBR	(D, type K/	w, onset o	(028, reset	UXUUUU.UU	oo (see pag	Je 614)									
												DIV	-DAC		
			222			045)						וויום	FRAC		
UARTLC	KH, type K/	W, offset ux	(02C, reset	0x0000.00	(see pag	ge 615)		1							
								ODO	10/1	EN	FEN	OTDO	FDO	DEN	DDI
								SPS	VVL	.EN	FEN	STP2	EPS	PEN	BRK
UARTCTL	., type R/W	, offset 0x0	30, reset 0x	(0000.0300	(see page	617)		ı				1	I		
CTSEN	RTSEN			RTS	DTR	RXE	TXE	LBE	LIN	HSE	EOT	SMART	SIRLP	SIREN	UARTEN
UARTIFLS	s, type R/W	, offset 0x0)34, reset 0:	x0000.001	2 (see page	621)									
											DV:=:			T)((=:	
											RXIFLSEL			TXIFLSEL	
UARTIM,	type R/W, o	offset 0x038	3, reset 0x0	000.0000 (see page 62	23)									
LME5IM		LMSBIM			OEIM	BEIM	PEIM	FEIM	RTIM	TXIM	RXIM	DSRIM	DCDIM	CTSIM	RIIM
UARTRIS	, type RO,	offset 0x03	C, reset 0x0	0000.0000	(see page 6	527)									
LME5RIS	LME1RIS	LMSBRIS			OERIS	BERIS	PERIS	FERIS	RTRIS	TXRIS	RXRIS	DSRRIS	DCDRIS	CTSRIS	RIRIS
UARTMIS	, type RO,	offset 0x04	0, reset 0x0	0000.0000	(see page 6	31)									
LME5MIS	LME1MIS	LMSBMIS			OEMIS	BEMIS	PEMIS	FEMIS	RTMIS	TXMIS	RXMIS	DSRMIS	DCDMIS	CTSMIS	RIMIS
UARTICR	, type W1C	, offset 0x0	44, reset 0	c0000.000	(see page	635)									
LME5IC	LME1IC	LMSBIC			OEIC	BEIC	PEIC	FEIC	RTIC	TXIC	RXIC	DSRMIC	DCDMIC	СТЅМІС	RIMIC
UARTDM	ACTL, type	R/W, offse	t 0x048, res	et 0x0000	.0000 (see	page 637)									
													DMAERR	TXDMAE	RXDMAE

0.4	20		00	07	00	0.5	0.4	1 00	00	04	- 00	1 40	40	47	40
31 15	30 14	29 13	28 12	27 11	26 10	25 9	24 8	23 7	22 6	21 5	20 4	19	18	17	16
	L, type R/W						0		0	3	-] 3		'	
UARTECT	L, type K/VV	, onset ux	lusu, reset		(see page	(000)									
										BI	.EN				MASTER
IIARTI SS	, type RO, o	offeet Nyng	A reset Ov	0000 0000 (eee nage 6	30)									WWWTER
OAKTEOO	, type ito, c	moet oxo.	74, 16361 02		see page o	55)									
							Т	SS							
LIADTITIN	/I, type RO,	offoot OvO	00 rocat 0	*0000 0000	(000 0000 (240)									
UAKILIIN	n, type KO,	onset uxu	30, reset 02		(see page (040)									
							TIN	/IER							
LIADTDari	mbID4 from	DO effec	4 0vFD0 ==		0000 /000	C11\	1111	/IER							
UARTPER	phID4, type	RO, onse	t uxrbu, re	set uxuuuu.	oooo (see	page 641)									
												ID4			
											Р	ID4			
UARTPeri	phID5, type	RO, offse	et 0xFD4, re	set 0x0000.	0000 (see	page 642)		1							
											_	<u> </u>			
											P	ID5			
UARTPeri	phID6, type	RO, offse	et 0xFD8, re	set 0x0000.	0000 (see	page 643)									
											P	ID6			
UARTPeri	phID7, type	RO, offse	et 0xFDC, re	eset 0x0000	.0000 (see	page 644)									
											P	ID7			
UARTPeri	phID0, type	RO, offse	t 0xFE0, re	set 0x0000.	0060 (see	page 645)									
											Р	ID0			
UARTPeri	phID1, type	RO, offse	et 0xFE4, re	set 0x0000.	0000 (see	page 646)									
											Р	ID1			
UARTPeri	phID2, type	RO, offse	t 0xFE8, re	set 0x0000.	0018 (see	page 647)									
											Р	ID2			
UARTPeri	phID3, type	RO, offse	t 0xFEC, re	eset 0x0000.	.0001 (see	page 648)									
											Р	ID3			
UARTPCe	IIID0, type F	RO, offset	0xFF0, res	et 0x0000.0	00D (see p	age 649)									
											С	ID0			
UARTPCe	IIID1, type F	RO, offset	0xFF4, res	et 0x0000.0	0F0 (see pa	age 650)									
											С	ID1			
UARTPCe	IIID2, type F	RO, offset	0xFF8, res	et 0x0000.0	005 (see pa	age 651)									
											С	ID2			
UARTPCe	IIID3, type F	RO, offset	0xFFC, res	et 0x0000.0	0B1 (see p	age 652)									
											С	ID3			
Synchr	onous Se	arial Int	erface (S	SSI)											
	e: 0x4000.		criace (c	,51,											
	e: 0x4000.														
SSICR0, ty	ype R/W, off	set 0x000	, reset 0x0	000.0000 (se	ee page 66	8)									
			S	CR				SPH	SPO	F	RF		D	SS	

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SSICR1, t	ype R/W, of	fset 0x004	, reset 0x0	000.0000 (s	ee page 670	0)		1					1	1	
											EOT	SOD	MS	SSE	LBM
SSIDR, ty	pe R/W, off	set 0x008,	reset 0x00	00.0000 (se	e page 672))									
							DA	ATA							
SSISR, ty	pe RO, offs	et 0x00C, i	reset 0x000	00.0003 (se	e page 673)										
											BSY	RFF	RNE	TNF	TFE
SSICPSR,	type R/W,	offset 0x0	10, reset 0x	0000.0000	(see page 6	75)		•							
											CPSI	DVSR			
SSIIM, typ	e R/W, offs	et 0x014, ı	reset 0x000	00.0000 (see	e page 676)			•							
												TXIM	RXIM	RTIM	RORIM
SSIRIS, ty	pe RO, offs	set 0x018,	reset 0x000	00.0008 (se	e page 677)										
												TXRIS	RXRIS	RTRIS	RORRIS
SSIMIS, ty	pe RO, offs	set 0x01C,	reset 0x00	00.0000 (se	ee page 679)								1	
												TXMIS	RXMIS	RTMIS	RORMIS
SSIICR, ty	pe W1C, of	fset 0x020), reset 0x0	000.0000 (s	see page 68	1)									
			, 			,									
														RTIC	RORIC
SSIDMAC	TL. type R/	W. offset 0	x024. rese	t 0x0000.00	00 (see pag	e 682)						l			
	, -, ,,	,	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		(,,									
														TXDMAE	RXDMAE
SSIPeriph	ID4. type R	O. offset 0	xFD0. rese	et 0x0000.0	000 (see pag	ne 683)						l			
	,,,,,,	.,				, , , ,									
											PI	I D4			
SSIPerinh	ID5. type R	O. offset 0	xFD4 rese	t 0x0000.0	000 (see pag	ne 684)		1							
oon enpi	iibo, typo it	0, 011501 0	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		oo (occ pa	gc 00+)									
											PI	D5			
SSIPerinh	ID6 type R	O offset (YFD8 rese	t 0×0000 0	000 (see pag	ne 685)									
con empir		, 5.11361 0	55, 1636		July (See pag	g 5 555)									
											PI	D6			
SSIPerinh	ID7 type R	O offset (YFDC res	et OxOOOO O	000 (see na	ne 686)									
oon empir	iiD1, type it	0, 011361 0	, xi DO, 1630		000 (see pa	gc 000)									
											PI	D7			
CCIDarinh	IDO tupo B	O offeet (VEEU room	+ 0~000 0	022 (see pag	70 697\									
SSIPERIPRI	IIDU, type K	o, onset u	IXFEU, rese	T UXUUUU.UI	Jzz (see pa	ge 667)									
											DI	D0			
0010!!-	ID4 to a D	0 - 55 4 0		4 00000 04	200 /	(000)					PI	D0			
SSIPeripn	IID1, type R	O, offset u	XFE4, rese	et 0x0000.00	000 (see paç	ge 688)		1				1			
				10.0000	101	005;					PI	D1			
SSIPeriph	ıı∪2, type R	U, offset 0	IXFE8, rese	et 0x0000.00	018 (see paç	ge 689)									
											PI	D2			
SSIPeriph	ID3, type R	O, offset 0	xFEC, rese	et 0x0000.0	001 (see pa	ge 690)									
											PI	D3			

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SSIPCellI	D0, type R0	O, offset 0x	FF0, reset	0x0000.000	OD (see pag	ge 691)									
											CI	ID0			
SSIPCellI	D1, type R0	O, offset 0x	FF4, reset	0x0000.00I	F0 (see pag	je 692)									
											CI	ID1			
SSIPCelli	D2, type R0	O, offset 0x	FF8, reset	0x0000.000	05 (see pag	je 693)									
											CI	ID2			
SSIPCellI	D3, type R0	O, offset 0x	FFC, reset	0x0000.00	B1 (see pa	ge 694)									
											CI	ID3			
Inter-In I ² C Mas		l Circuit	(I ² C) Into	erface											
	se: 0x400	2 0000													
	se: 0x400														
I2CMSA, 1	ype R/W, o	ffset 0x000	0, reset 0x0	000.0000											
											SA				R/S
I2CMCS, 1	ype RO, of	fset 0x004	, reset 0x00	000.0020 (R	Read-Only	Status Reg	ister)								
									BUSBSY	IDLE	ARBLST	DATACK	ADRACK	ERROR	BUSY
I2CMCS, 1	ype WO, o	ffset 0x004	l, reset 0x0	000.0020 (\	Write-Only	Control Re	gister)								
												ACK	STOP	START	RUN
I2CMDR, 1	type R/W, o	offset 0x00	8, reset 0x0	0000.0000											
											DA	ATA			
I2CMTPR,	type R/W,	offset 0x0	OC, reset 0x	k0000.0001											
												TPR			
I2CMIMR,	type R/W,	offset 0x01	10, reset 0x	0000.0000											
															IM
I2CMRIS,	type RO, o	ffset 0x014	l, reset 0x0	000.000											
															RIS
I2CMMIS,	type RO, o	offset 0x018	8, reset 0x0	000.0000											
															MIS
I2CMICR,	type WO, c	offset 0x01	C, reset 0x	0000.0000											
															IC
I2CMCR, 1	type R/W, o	offset 0x020	0, reset 0x0	0000.0000											
										SFE	MFE				LPBK
Inter-In I ² C Slav		l Circuit	(I ² C) Into	erface											
	/e se: 0x400;	2 0000													
	se: 0x400														
I2CSOAR	type R/W,	offset 0x8	00, reset 0x	0000.0000											
												OAR			

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
I2CSCSR,	type RO,	offset 0x804	, reset 0x00	000.0000 (R	lead-Only	Status Re	gister)								
1000000	WO	- ff 4 000 4	1 4 00	200 2000 (1	W-14- O-1-	0	\\						FBR	TREQ	RREQ
izcscsr,	type WO,	offset 0x804	i, reset uxu	000.0000 (\	Write-Only	Control R	(egister)								
															DA
I2CSDR, t	ype R/W, o	offset 0x808,	reset 0x00	00.0000											
											DA	TA			
I2CSIMR,	type R/W,	offset 0x800	c, reset 0x0	000.000											
													STOPIM	STARTIM	DATAIM
I2CSRIS, t	type RO, c	offset 0x810,	reset 0x000	00.0000											
													STOPRIS	STARTRIS	DATARIS
I2CSMIS.	type RO. 6	offset 0x814,	reset 0x00	00.0000									0101110	3	J, tiAitic
	,	,													
													STOPMIS	STARTMIS	DATAMIS
I2CSICR, 1	type WO,	offset 0x818,	, reset 0x00	000.0000											
													STOPIC	STARTIC	DATAIC
Analog															
Base 0x4		-													
ACMIS, ty	pe R/W1C	, offset 0x00	0, reset 0x0	0000.0000 (see page 7	/39)									
														IN1	IN0
ACRIS, ty	pe RO, off	set 0x004, re	eset 0x0000	0.0000 (see	page 740)										
, •				<u> </u>	, ,										
														IN1	IN0
ACINTEN,	type R/W	, offset 0x00	8, reset 0x0	0000.0000 (see page 7	'41)									
														IN1	IN0
ACREFCT	L, type R/	W, offset 0x0	010, reset 0	x0000.0000	(see page	9 742)									
						EN	RNG						VE	REF	
ACSTATO	type RO.	offset 0x020	reset 0x0	000.0000 (s	ee nage 7		KNG						VI	\LI	
7,0017,10,	, typo ito,	CHOCK GAGES	, 10001 020	(3	oc page 1	10)									
														OVAL	
ACSTAT1,	type RO,	offset 0x040	, reset 0x0	000.0000 (s	ee page 74	43)									
														OVAL	
ACCTL0, 1	type R/W,	offset 0x024	, reset 0x00	000.0000 (s	ee page 74	14)									
				TOEN		200		TOLVAL		TOEN	1017.47		DENI	Oltri	
ACCT! 4	D.	-#+ 0:-0::	#### O: 01	TOEN		RCP		TSLVAL		TSEN	ISLVAL	18	SEN	CINV	
ACCIL1, 1	type K/W,	offset 0x044	, reset ux00	JUU.UUUU (S	ee page 74	+4)									
				TOEN	ASE	RCP		TSLVAL		TSEN	ISI VAI	19	SEN	CINV	
				TOEN	ASF	RCP		TSLVAL		TSEN	ISLVAL		SEN	CINV	

B Ordering and Contact Information

B.1 Ordering Information

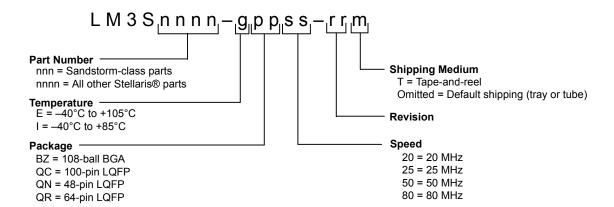


Table B-1. Part Ordering Information^a

Orderable Part Number	Description
LM3S1J11-IQC50-C5	Stellaris® LM3S1J11 Microcontroller Industrial Temperature 100-pin LQFP
LM3S1J11-IBZ50-C5	Stellaris LM3S1J11 Microcontroller Industrial Temperature 108-ball BGA
LM3S1J11-IQC50-C5T	Stellaris LM3S1J11 Microcontroller Industrial Temperature 100-pin LQFP Tape-and-reel
LM3S1J11-IBZ50-C5T	Stellaris LM3S1J11 Microcontroller Industrial Temperature 108-ball BGA Tape-and-reel

a. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

B.2 Part Markings

The Stellaris microcontrollers are marked with an identifying number. This code contains the following information:

- The first line indicates the part number, for example, LM3S9B90.
- In the second line, the first eight characters indicate the temperature, package, speed, revision, and product status. For example in the figure below, IQC80C0X indicates an Industrial temperature (I), 100-pin LQFP package (QC), 80-MHz (80), revision C0 (C0) device. The letter immediately following the revision indicates product status. An X indicates experimental and requires a waiver; an S indicates the part is fully qualified and released to production.
- The remaining characters contain internal tracking numbers.



B.3 Kits

The Stellaris Family provides the hardware and software tools that engineers need to begin development quickly.

- Reference Design Kits accelerate product development by providing ready-to-run hardware and comprehensive documentation including hardware design files
- Evaluation Kits provide a low-cost and effective means of evaluating Stellaris microcontrollers before purchase
- Development Kits provide you with all the tools you need to develop and prototype embedded applications right out of the box

See the website at www.ti.com/stellaris for the latest tools available, or ask your distributor.

B.4 Support Information

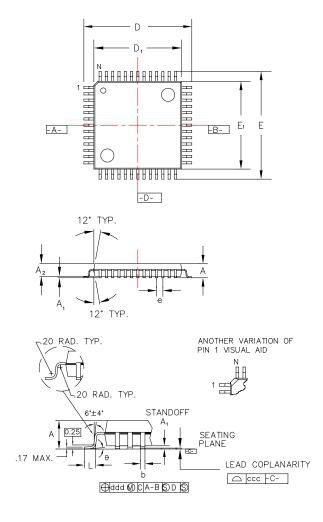
For support on Stellaris products, contact the TI Worldwide Product Information Center nearest you: http://www-k.ext.ti.com/sc/technical-support/product-information-centers.htm.

C Package Information

C.1 100-Pin LQFP Package

C.1.1 Package Dimensions

Figure C-1. Stellaris LM3S1J11 100-Pin LQFP Package Dimensions



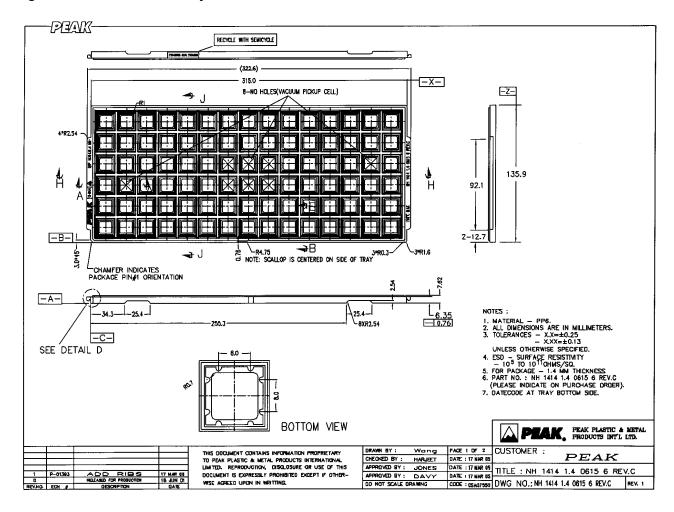
Note: The following notes apply to the package drawing.

- 1. All dimensions shown in mm.
- 2. Dimensions shown are nominal with tolerances indicated.
- 3. Foot length 'L' is measured at gage plane 0.25 mm above seating plane.

В	ody +2.00 mm Footprint, 1.4 mm packag	e thickness
Symbols	Leads	100L
Α	Max.	1.60
A ₁	-	0.05 Min./0.15 Max.
A ₂	±0.05	1.40
D	±0.20	16.00
D ₁	±0.05	14.00
E	±0.20	16.00
E ₁	±0.05	14.00
L	+0.15/-0.10	0.60
е	Basic	0.50
b	+0.05	0.22
θ	-	0°-7°
ddd	Max.	0.08
ccc	Max.	0.08
JEDEC Re	eference Drawing	MS-026
Variation	on Designator	BED

C.1.2 Tray Dimensions

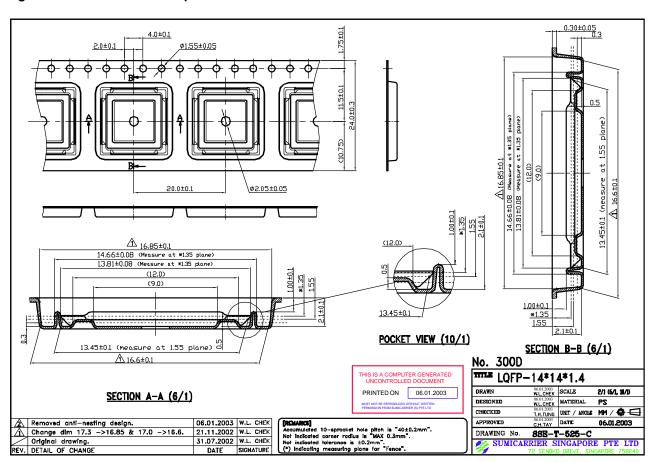
Figure C-2. 100-Pin LQFP Tray Dimensions



C.1.3 Tape and Reel Dimensions

Note: In the figure that follows, pin 1 is located in the top right corner of the device.

REV. DETAIL OF CHANGE



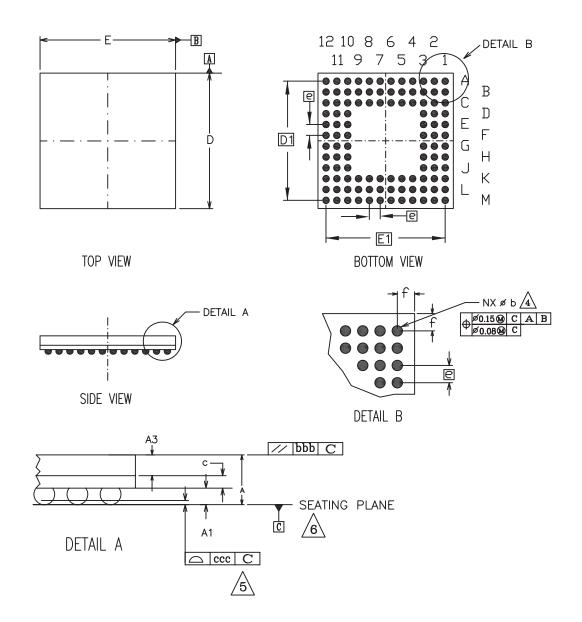
DATE SIGNATURE

Figure C-3. 100-Pin LQFP Tape and Reel Dimensions

C.2 108-Ball BGA Package

C.2.1 Package Dimensions

Figure C-4. Stellaris LM3S1J11 108-Ball BGA Package Dimensions



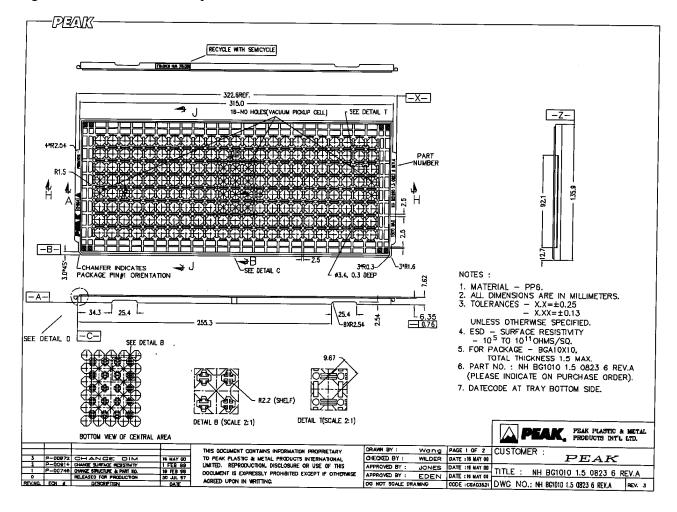
Note: The following notes apply to the package drawing.

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. 'e' REPRESENTS THE BASIC SOLDER BALL GRID PITCH.
- 3. 'M' REPRESENTS THE BASIC SOLDER BALL MATRIX SIZE.
 AND SYMBOL 'N' IS THE NUMBER OF BALLS AFTER DEPOPULATING.
- \triangle 'b' is measurable at the maximum solder ball diameter after reflow parallel to primary daium \boxed{c} .
- ⚠ DIMENSION 'ccc' IS MEASURED PARALLEL TO PRIMARY DATUM [].
- PRIMARY DATUM [] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 7. PACKAGE SURFACE SHALL BE MATTE FINISH CHARMILLES 24 TO 27.
- 8. SUBSTRATE MATERIAL BASE IS BT RESIN.
- 9. THE OVERALL PACKAGE THICKNESS "A" ALREADY CONSIDERS COLLAPSE BALLS
- 10. DIMENSIONING AND TOLERANCING PER ASME Y14.5M 1994.

Symbols	MIN	NOM	MAX						
A	1.22	1.36	1.50						
A1	0.29	0.34	0.39						
A3	0.65	0.70	0.75						
С	0.28	0.32	0.36						
D	9.85	10.00	10.15						
D1	8.80 BSC								
E	9.85	10.00	10.15						
E1	8.80 BSC								
b	0.43	0.48	0.53						
bbb	.20								
ddd	.12								
е	0.80 BSC								
f	-	0.60	-						
M	12								
n	108								
	REF: JI	EDEC MO-219F							

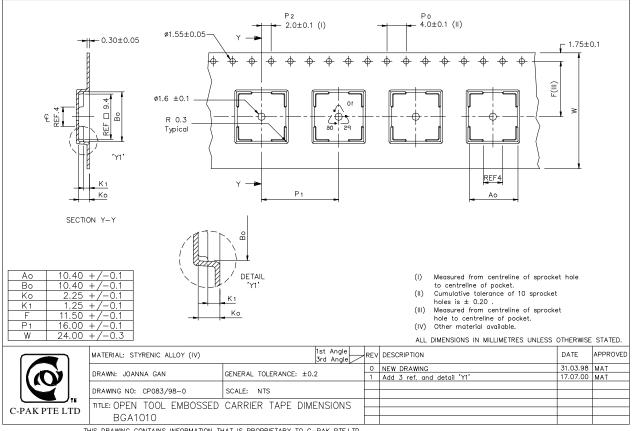
C.2.2 Tray Dimensions

Figure C-5. 108-Ball BGA Tray Dimensions



C.2.3 **Tape and Reel Dimensions**

Figure C-6. 108-Ball BGA Tape and Reel Dimensions



THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO C-PAK PTE.LTD.





18-Apr-2013

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
	(1)		Drawing		Qty	(2)		(3)		(4)	
LM3S1J11-IBZ50-C5	NRND	NFBGA	ZCR	108	184	Green (RoHS & no Sb/Br)	SNAGCU	Level-3-260C-168 HR	-40 to 85	LM3S1J11 IBZ50	
LM3S1J11-IBZ50-C5T	NRND	NFBGA	ZCR	108	1500	Green (RoHS & no Sb/Br)	SNAGCU	Level-3-260C-168 HR	-40 to 85	LM3S1J11 IBZ50	
LM3S1J11-IQC50-C5	NRND	LQFP	PZ	100	90	Green (RoHS & no Sb/Br)		Level-3-260C-168 HR	-40 to 85	LM3S1J11 IQC50	
LM3S1J11-IQC50-C5T	NRND	LQFP	PZ	100	1000	Green (RoHS & no Sb/Br)		Level-3-260C-168 HR	-40 to 85	LM3S1J11 IQC50	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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